

NEC

Preliminary User's Manual

V850ES/SA2™, V850ES/SA3™

32-Bit Single-Chip Microcontrollers

Hardware

V850ES/SA2:	V850ES/SA3:
μPD703201	μPD703204
μPD703201Y	μPD703204Y
μPD70F3201	μPD70F3204
μPD70F3201Y	μPD70F3204Y

[MEMO]

NOTES FOR CMOS DEVICES

① PRECAUTION AGAINST ESD FOR SEMICONDUCTORS

Note:

Strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred. Environmental control must be adequate. When it is dry, humidifier should be used. It is recommended to avoid using insulators that easily build static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work bench and floor should be grounded. The operator should be grounded using wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with semiconductor devices on it.

② HANDLING OF UNUSED INPUT PINS FOR CMOS

Note:

No connection for CMOS device inputs can be cause of malfunction. If no connection is provided to the input pins, it is possible that an internal input level may be generated due to noise, etc., hence causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using a pull-up or pull-down circuitry. Each unused pin should be connected to V_{DD} or GND with a resistor, if it is considered to have a possibility of being an output pin. All handling related to the unused pins must be judged device by device and related specifications governing the devices.

③ STATUS BEFORE INITIALIZATION OF MOS DEVICES

Note:

Power-on does not necessarily define initial status of MOS device. Production process of MOS does not define the initial operation status of the device. Immediately after the power source is turned ON, the devices with reset function have not yet been initialized. Hence, power-on does not guarantee out-pin levels, I/O settings or contents of registers. Device is not initialized until the reset signal is received. Reset operation must be executed immediately after power-on for devices having reset function.

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- Device availability
- Ordering information
- Product release schedule
- Availability of related technical literature
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- Network requirements

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PREFACE

Readers This manual is intended for users who wish to understand the functions of the V850ES/SA2 (μ PD703201, 703201Y, 70F3201, 70F3201Y) and V850ES/SA3 (μ PD703204, 703204Y, 70F3204, 70F3204Y) and design application systems using these products.

Purpose This manual is intended to give users an understanding of the hardware functions of the V850ES/SA2 and V850ES/SA3 shown in the Organization below.

Organization This manual is divided into two parts: Hardware (this manual) and Architecture (**V850ES Architecture User's Manual**).

Hardware

- Pin functions
- CPU function
- On-chip peripheral functions
- Flash memory programming
- Electrical specifications (target)

Architecture

- Data types
- Register set
- Instruction format and instruction set
- Interrupts and exceptions
- Pipeline operation

How to Read This Manual It is assumed that the readers of this manual have general knowledge in the fields of electrical engineering, logic circuits, and microcontrollers.

To understand the details of an instruction function

→ Refer to the **V850ES Architecture User's Manual** available separately.

Register format

→ The name of the bit whose number is in angle brackets (<>) in the figure of the register format of each register is defined as a reserved word in the device file.

To understand the overall functions of the V850ES/SA2 and V850ES/SA3

→ Read this manual according to the **CONTENTS**.

Conventions

Data significance:	Higher digits on the left and lower digits on the right
Active low representation:	$\overline{\text{xxx}}$ (overscore over pin or signal name)
Memory map address:	Higher addresses on the top and lower addresses on the bottom
Note:	Footnote for item marked with Note in the text
Caution:	Information requiring particular attention
Remark:	Supplementary information
Numeric representation:	Binary ... xxxx or xxxxB Decimal ... xxxx Hexadecimal ... xxxxB
Prefix indicating power of 2 (address space, memory capacity):	K (kilo): $2^{10} = 1,024$ M (mega): $2^{20} = 1,024^2$ G (giga): $2^{30} = 1,024^3$

Related Documents

The related documents indicated in this publication may include preliminary versions. However, preliminary versions are not marked as such.

Documents related to V850ES/SA2 and V850ES/SA3

Document Name	Document No.
V850ES Architecture User's Manual	U15943E
V850ES/SA2 and V850ES/SA3 Hardware User's Manual	This manual

Documents related to development tools

Document Name	Document No.	
IE-V850ES-G1 (In-Circuit Emulator)	To be prepared	
IE-703204-G1-EM1 (In-Circuit Emulator Option Board)	To be prepared	
CA850 C Compiler Package Ver. 2.40 or Later	Operation	U15024E
	C Language	U15025E
	Project Manager	U15026E
	Assembly Language	U15027E
ID850 Integrated Debugger Ver. 2.40	Operation Windows™ Based	U15181E
RX850 Real-Time OS Ver. 3.13 or Later	Basics	U13430E
	Installation	U13410E
	Technical	U13431E
RX850 Pro Real-Time OS Ver. 3.13	Basics	U13773E
	Installation	U13774E
	Technical	U13772E
RD850 Task Debugger Ver. 3.01		U13737E
RD850 Pro Task Debugger Ver. 3.01		U13916E
AZ850 System Performance Analyzer Ver. 3.0		U14410E
PG-FP4 Flash Memory Programmer		U15260E

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CHAPTER 1 INTRODUCTION

The V850ES/SA2 and V850ES/SA3 are low-power models of NEC's V850 Series of single-chip microcontrollers for real-time control.

1.1 Overview

The V850ES/SA2 and V850ES/SA3 are 32-bit single-chip microcontrollers that employ the V850ES CPU core and integrate peripheral functions such as ROM/RAM, timers/counters, serial interfaces, an A/D converter, a D/A converter, and a DMA controller.

These products are part of the V850/SA1™ line of low-power microcontrollers, but employ the V850ES as the CPU and have additional peripheral functions such as DMA, a D/A converter, and ROM correction.

The V850ES/SA2 and V850ES/SA3 feature instructions ideal for digital servo control applications, such as multiplication instructions using a hardware multiplier, saturated operation instructions, and bit manipulation instructions, as well as basic instructions with a short real-time response speed and a 1-clock pitch. These microcontrollers can be used in real-time control systems requiring low power consumption, such as DVC and portable audio systems, with a high cost effectiveness.

Table 1-1 shows the products in the V850ES/SA2 and V850ES/SA3 lineup.

Table 1-1. V850ES/SA2 and V850ES/SA3 Product Lineup

Product Name		I ² C	ROM		RAM Size	Package
Commercial Name	Part Number		Type	Size		
V850ES/SA2	μPD703201	None	Mask ROM	256 KB	16 KB	100-pin TQFP (14 × 14)
	μPD703201Y	Provided				
	μPD70F3201	None	Flash memory			
	μPD70F3201Y	Provided				
V850ES/SA3	μPD703204	None	Mask ROM	256 KB	16 KB	121-pin FBGA (12 × 12)
	μPD703204Y	Provided				
	μPD70F3204	None	Flash memory			
	μPD70F3204Y	Provided				

1.2 Features

- Number of instructions 83
- Minimum instruction execution time 59 ns (main clock (fx) = 17 MHz)
30.5 μ s (subclock (fx τ) = 32.768 kHz)
- General-purpose registers 32 bits \times 32 registers
- Instruction set Signed multiplication (16 \times 16 \rightarrow 32): 1 to 2 clocks
Signed multiplication (32 \times 32 \rightarrow 64): 1 to 5 clocks
Saturated operation (with overflow/underflow detection function)
32-bit shift instruction: 1 clock
Bit manipulation instruction
Load/store instruction with long/short format
- Memory space 64 MB linear address space (for program/data)
External expansion: Up to 4 MB for V850ES/SA2 and 16 MB for V850ES/SA3 (of which 1 MB is used as internal ROM/RAM space)
Memory block division function: 2, 2, 4, 8 MB (total: 4 blocks)
Programmable wait function
Idle state insertion function
- External bus interface Separate bus/multiplexed bus output selectable
8/16-bit data bus sizing function
4-space chip select function
Wait functions
 - Programmable wait function
 - External wait function
 Idle state function
Bus hold function
- Internal memory RAM: 16 KB
Mask ROM: 256 KB (μ PD703201, 703201Y, 703204, 703204Y)
Flash memory: 256 KB (μ PD70F3201, 70F3201Y, 70F3204, 70F3204Y)
- Interrupts/exceptions Non-maskable interrupts: 2 sources
Maskable interrupts: 36 sources (μ PD703201, 70F3201)
37 sources (μ PD703201Y, 70F3201Y)
37 sources (μ PD703204, 70F3204)
38 sources (μ PD703204Y, 70F3204Y)
Software exception: 32 sources
Exception trap: 1 source
- I/O lines Total: 82 (input ports: 14, I/O ports: 68) (V850ES/SA2)
102 (input ports: 18, I/O ports: 84) (V850ES/SA3)
- Timer/counter 16-bit timer/event counter: 2 ch (PWM output)
8-bit timer/event counter: 4 ch (connectable in cascade)
- Real-time counter (for watch) Subclock/main clock operation: 1 ch
Counter for weeks, days, hours, minutes, and seconds, up to 4,095 weeks.
- Watchdog timer: 1 ch

- Serial interface (SIO)
 - Asynchronous serial interface (UART)
 - Clocked serial interface (CSI)
 - I²C bus interface (I²C)
 - (μ PD703201Y, 703204Y, 70F3201Y, and 70F3204Y only)
 - CSI/UART: 1 ch
 - UART: 1 ch
 - CSI/I²C: 1ch
 - CSI: 2 ch (V850ES/SA2), 3 ch (V850ES/SA3)
- A/D converter
 - 10-bit resolution: 12 ch (V850ES/SA2)
 - 16 ch (V850ES/SA3)
- D/A converter
 - 8-bit resolution: 2 ch
- DMA controller:
 - 4 ch
- ROM correction:
 - 4 places specifiable
- Clock generator
 - Main clock/subclock operation
 - CPU clock: 7 steps (fx, fx/2, fx/4, fx/8, fx/16, fx/32, fx τ)
- Power save function
 - HALT/IDLE/STOP and backup mode
- Package
 - 100-pin plastic TQFP (fine pitch) (14 \times 14) (V850ES/SA2)
 - 121-pin plastic FBGA (12 \times 12) (V850ES/SA3)

1.3 Application Fields

Mobile systems requiring low power consumption

Example: DVC and portable audio systems

1.4 Ordering Information

1.4.1 V850ES/SA2

Part Number	Package	Internal ROM
μ PD703201GC-xxx-YEU	100-pin plastic TQFP (fine pitch) (14 × 14)	Mask ROM (256 KB)
μ PD703201YGC-xxx-YEU	100-pin plastic TQFP (fine pitch) (14 × 14)	Mask ROM (256 KB)
μ PD70F3201GC-YEU	100-pin plastic TQFP (fine pitch) (14 × 14)	Flash memory (256 KB)
μ PD70F3201YGC-YEU	100-pin plastic TQFP (fine pitch) (14 × 14)	Flash memory (256 KB)

- Remarks**
1. xxx indicates ROM code suffix.
 2. No ROMless model is available.

1.4.2 V850ES/SA3

Part Number	Package	Internal ROM
μ PD703204F1-xxx-EA6	121-pin plastic FBGA (12 × 12)	Mask ROM (256 KB)
μ PD703204YF1-xxx-EA6	121-pin plastic FBGA (12 × 12)	Mask ROM (256 KB)
μ PD70F3204F1-EA6	121-pin plastic FBGA (12 × 12)	Flash memory (256 KB)
μ PD70F3204YF1-EA6	121-pin plastic FBGA (12 × 12)	Flash memory (256 KB)

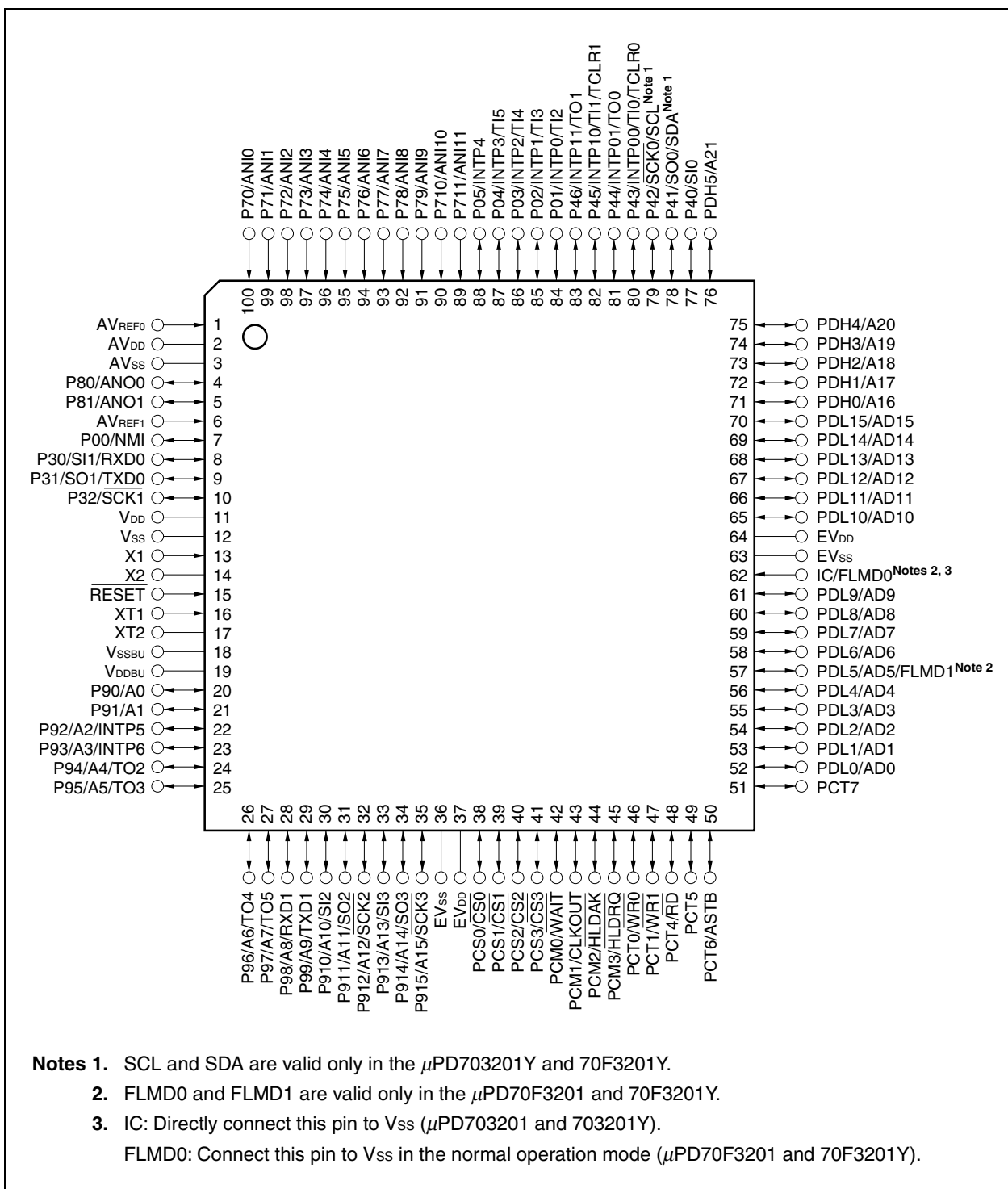
- Remarks**
1. xxx indicates ROM code suffix.
 2. No ROMless model is available.

1.5 Pin Configuration (Top View)

○ V850ES/SA2

100-pin plastic TQFP (fine pitch) (14 × 14)

- μ PD703201GC-xxx-YEU
- μ PD703201YGC-xxx-YEU
- μ PD70F3201GC-YEU
- μ PD70F3201YGC-YEU



- Notes 1.** SCL and SDA are valid only in the μ PD703201Y and 70F3201Y.
- 2.** FLMD0 and FLMD1 are valid only in the μ PD70F3201 and 70F3201Y.
- 3.** IC: Directly connect this pin to Vss (μ PD703201 and 703201Y).
 FLMD0: Connect this pin to Vss in the normal operation mode (μ PD70F3201 and 70F3201Y).

○ V850ES/SA3

121-pin plastic FGPA (12 × 12)

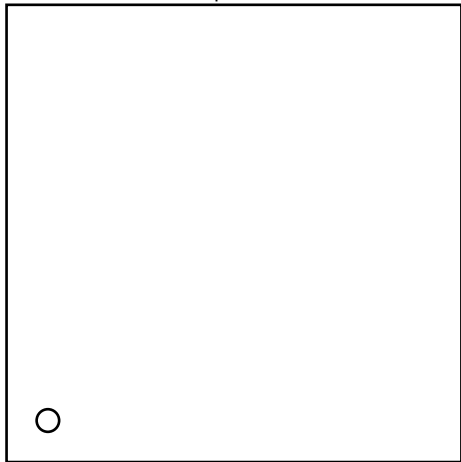
μPD703204F1-xxx-EA6

μPD70F3204F1-EA6

μPD703204YF1-xxx-EA6

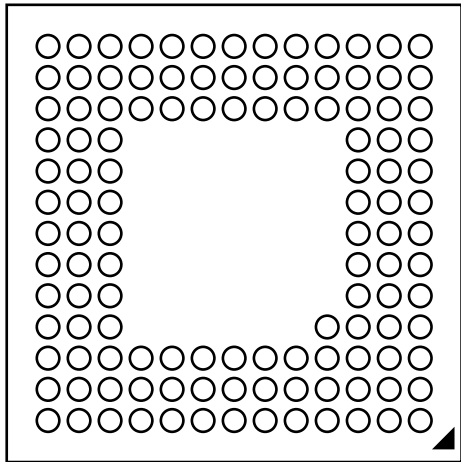
μPD70F3204YF1-EA6

Top View



A B C D E F G H J K L M N

Bottom View



N M L K J H G F E D C B A

Pin No.	Name	Pin No.	Name	Pin No.	Name
A1	P70/ANI0	B8	PCD3	D2	AV _{REF1}
A2	P71/ANI1	B9	P02/INTP1/TI3	D3	P00/NMI
A3	P73/ANI3	B10	P46/INTP11/TO1	D11	PDH0/A16
A4	P713/ANI13	B11	P42/ $\overline{\text{SCK0}}$ /SCL ^{Note}	D12	PDH2/A18
A5	P76/ANI6	B12	P40/SI0	D13	PDH1/A17
A6	P78/ANI8	B13	PDH4/A20	E1	P30/SI1/RXD0
A7	P711/ANI11	C1	P80/ANO0	E2	P31/SO1/TXD0
A8	P04/INTP3/TI5	C2	AV _{SS}	E3	P32/SCK1
A9	PCD2	C3	P74/ANI4	E11	PDL14/AD14
A10	P45/INTP10/TI1/TCLR1	C4	P714/ANI14	E12	PDH6/A22
A11	P43/INTP00/TI0/TCLR0	C5	P715/ANI15	E13	PDL15/AD15
A12	P41/SO0/SDA ^{Note}	C6	P79/ANI9	F1	V _{SS}
A13	PDH5/A21	C7	P05/INTP4	F2	X1
B1	AV _{DD}	C8	P03/INTP2/TI4	F3	V _{DD}
B2	AV _{REF0}	C9	PCD1	F11	PDL11/AD11
B3	P72/ANI2	C10	P01/INTP0/TI2	F12	PDL13/AD13
B4	P712/ANI12	C11	P44/INTP01/TO0	F13	PDL12/AD12
B5	P75/ANI5	C12	PDH3/A19	G1	$\overline{\text{RESET}}$
B6	P77/ANI7	C13	PDH7/A23	G2	XT1
B7	P710/ANI10	D1	P81/ANO1	G3	X2

Note SCL and SDA are valid only in the μPD703204Y and 70F3204Y.

Remark Directly connect the D4 pin to V_{SS}.

Pin No.	Name	Pin No.	Name	Pin No.	Name
G11	EV _{SS}	K13	PDL3/AD3	M7	PCS4
G12	PDL10/AD10	L1	P93/A3/INTP6	M8	PCM0/ $\overline{\text{WAIT}}$
G13	EV _{DD}	L2	P94/A4/TO2	M9	PCM2/ $\overline{\text{HLDAK}}$
H1	V _{SSBU}	L3	P911/A11/SO2	M10	PCT3
H2	V _{DDBU}	L4	P914/A14/SO3	M11	PCT4/ $\overline{\text{RD}}$
H3	XT2	L5	P915/A15/ $\overline{\text{SCK3}}$	M12	PCT7
H11	PDL8/AD8	L6	EV _{DD}	M13	PDL0/AD0
H12	IC/FLMD0 ^{Notes 1, 2}	L7	PCS0/ $\overline{\text{CS0}}$	N1	P96/A6/TO4
H13	PDL9/AD9	L8	PCS2/ $\overline{\text{CS2}}$	N2	P98/A8/RXD1
J1	P20/SI4	L9	PCM4	N3	P910/A10/SI2
J2	P91/A1	L10	PCT2	N4	P912/A12/ $\overline{\text{SCK2}}$
J3	P90/A0	L11	PCT0/ $\overline{\text{WR0}}$	N5	PCS7
J11	PDL5/AD5/FLMD1 ^{Note 1}	L12	PDL1/AD1	N6	PCS6
J12	PDL7/AD7	L13	PDL2/AD2	N7	PCS1/ $\overline{\text{CS1}}$
J13	PDL6/AD6	M1	P95/A5/TO3	N8	PCS3/ $\overline{\text{CS3}}$
K1	P22/ $\overline{\text{SCK4}}$	M2	P97/A7/TO5	N9	PCM5
K2	P92/A2/INTP5	M3	P99/A9/TXD1	N10	PCM3/ $\overline{\text{HLDRQ}}$
K3	P21/SO4	M4	P913/A13/SI3	N11	PCT1/ $\overline{\text{WR1}}$
K11	PCM1/CLKOUT	M5	EV _{SS}	N12	PCT5
K12	PDL4/AD4	M6	PCS5	N13	PCT6/ASTB

Notes 1. FLMD0 and FLMD1 are valid only in the μ PD70F3204 and 70F3204Y.

2. IC: Directly connect this pin to V_{SS} (μ PD703204 and 703204Y).

FLMD0: Connect this pin to V_{SS} in the normal operation mode (μ PD70F3204 and 70F3204Y).

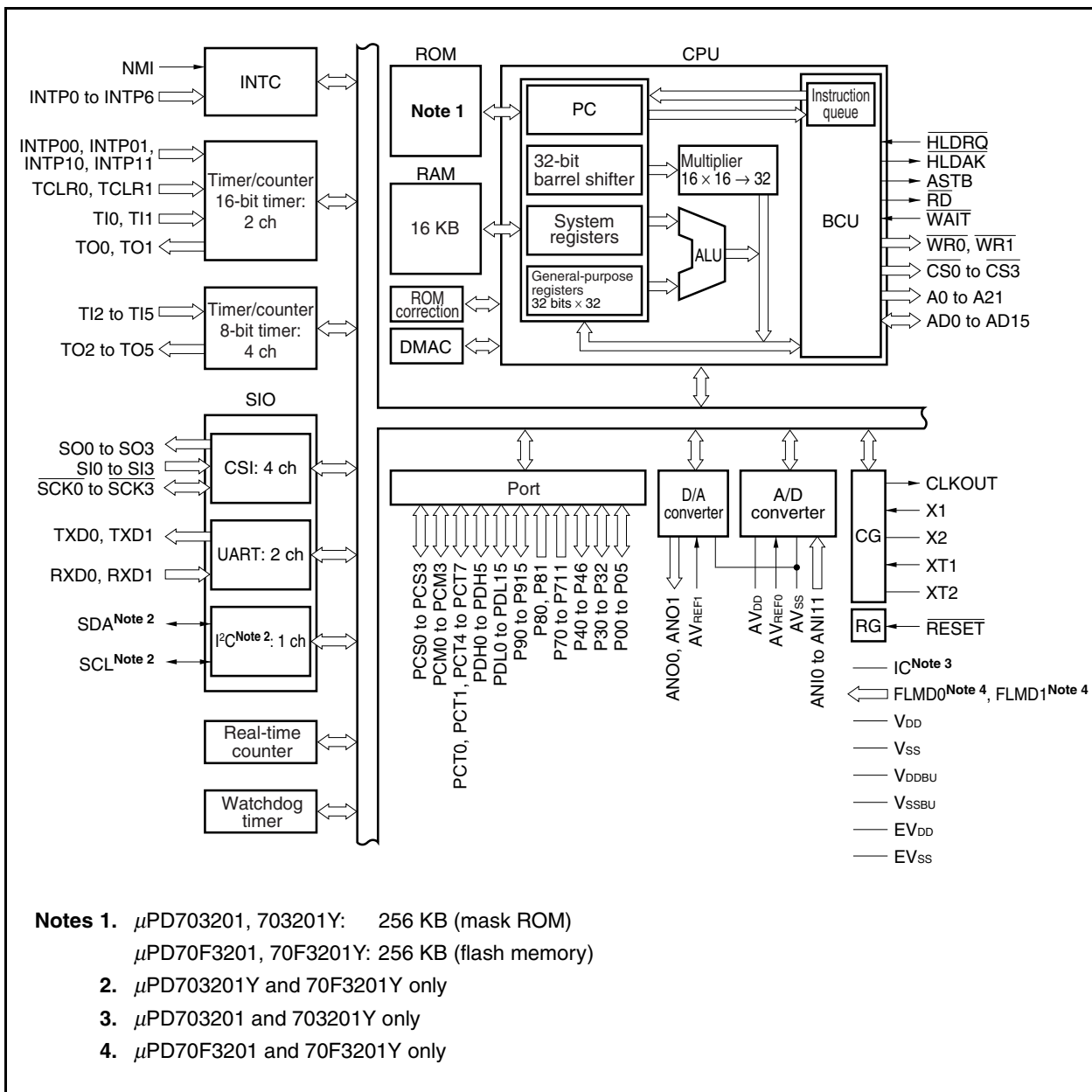
Pin Identification

A0 to A23:	Address bus	PCD1 to PCD3:	Port CD
AD0 to AD15:	Address/data bus	PCM0 to PCM5:	Port CM
ADTRG:	A/D trigger input	PCS0 to PCS7:	Port CS
ANI0 to ANI15:	Analog input	PCT0 to PCT7:	Port CT
ANO0, ANO1:	Analog output	PDH0 to PDH7:	Port DH
ASTB:	Address strobe	PDL0 to PDL15:	Port DL
AV _{DD} :	Analog V _{DD}	\overline{RD} :	Read strobe
AV _{REF0} , AV _{REF1} :	Analog reference voltage	\overline{RESET} :	Reset
AV _{SS} :	Analog V _{SS}	RXD0, RXD1:	Receive data
CLKOUT:	Clock output	$\overline{SCK0}$ to $\overline{SCK4}$:	Serial clock
$\overline{CS0}$ to $\overline{CS3}$:	Chip select	SCL:	Serial clock
EV _{DD} :	Power supply for port	SDA:	Serial data
EV _{SS} :	Ground for port	SI0 to SI4:	Serial input
FLMD0, FLMD1:	Flash programming mode	SO0 to SO4:	Serial output
\overline{HLDAK} :	Hold acknowledge	TCLR0, TCLR1:	Timer clear input
\overline{HLDRQ} :	Hold request	TI0 to TI5:	Timer input
IC:	Internally connected	TO0 to TO5:	Timer output
INTP0 to INTP6:	Interrupt request from peripherals	TXD0, TXD1:	Transmit data
INTP00, INTP01:	Interrupt request to timer	V _{DD} :	Power supply
INTP10, INTP11		V _{DDBU} :	Power supply for backup
NMI:	Non-maskable interrupt request	V _{SS} :	Ground
P00 to P05:	Port 0	V _{SSBU} :	Ground for backup
P20 to P22:	Port 2	\overline{WAIT} :	Wait
P30 to P32:	Port 3	$\overline{WR0}$:	Write strobe low level data
P40 to P46:	Port 4	$\overline{WR1}$:	Write strobe high level data
P70 to P715:	Port 7	X1, X2:	Crystal for main clock
P80, P81:	Port 8	XT1, XT2:	Crystal for subclock
P90 to P915:	Port 9		

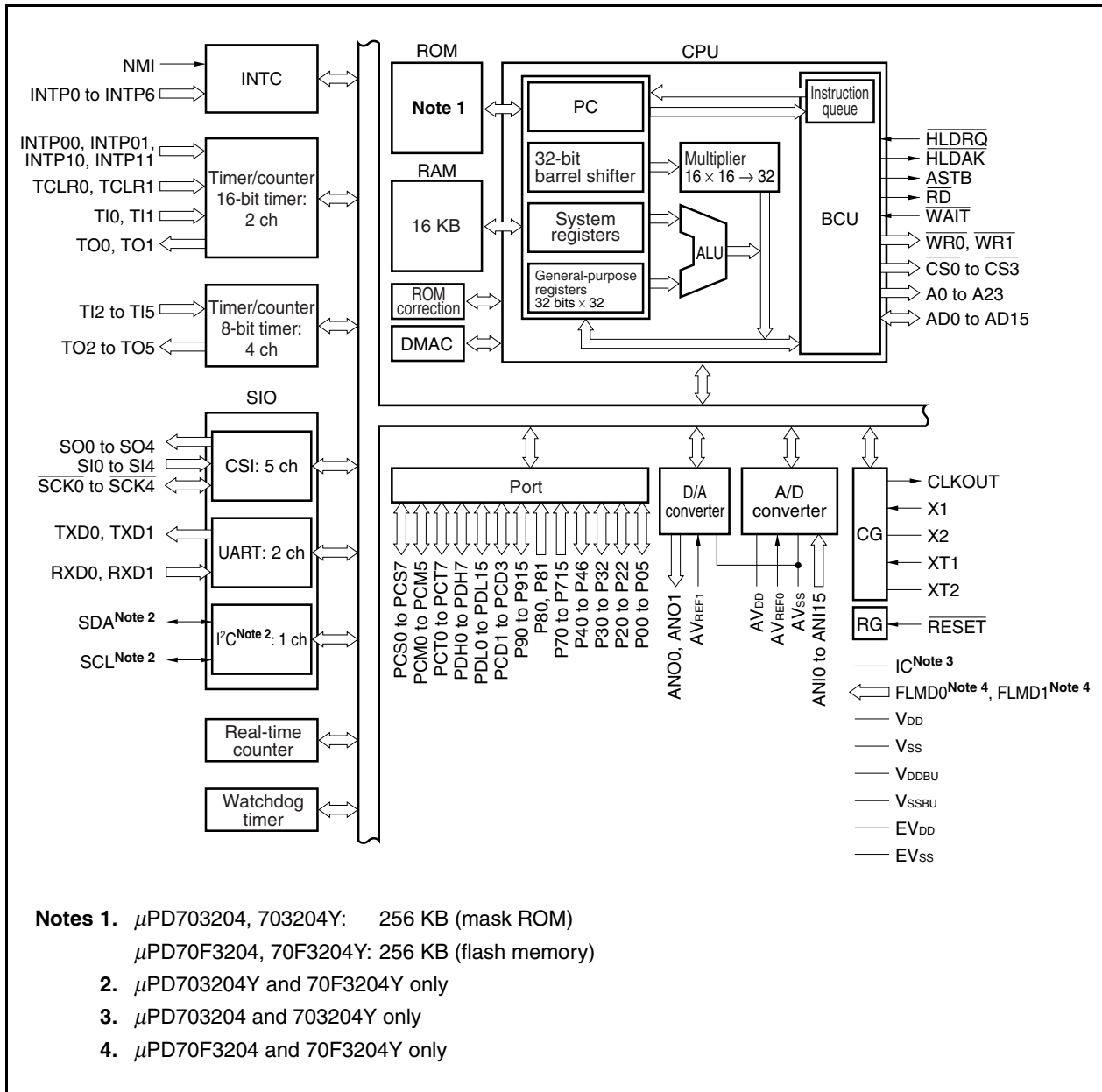
1.6 Function Block Configuration

1.6.1 Internal block diagram

- V850ES/SA2



• V850ES/SA3



1.6.2 Internal units

(1) CPU

The CPU can execute almost all instruction processing, such as address calculation, arithmetic logic operations, and data transfer, with 1 clock, using a 5-stage pipeline.

The CPU has dedicated hardware units such as a multiplier (16 bits \times 16 bits \rightarrow 32 bits) and a barrel shifter (32 bits) to speed up complicated instruction processing.

(2) Bus control unit (BCU)

The BCU starts the required external bus cycles in accordance with the physical address obtained by the CPU. If the CPU does not request the start of a bus cycle when an instruction is fetched from the external memory area, the BCU generates a prefetch address and prefetches an instruction code. The prefetched instruction code is loaded to the internal instruction queue.

(3) ROM

This is 256 KB mask ROM or flash memory mapped to addresses 0000000H to 003FFFFH. The CPU can access the ROM with 1 clock when an instruction is fetched.

(4) RAM

This is 16 KB RAM mapped to addresses 3FFB000H to 3FFEFFFH. It can be accessed by the CPU with 1 clock when data is accessed.

(5) Interrupt controller (INTC)

The INTC processes hardware interrupt requests (NMI, INTP0 to INTP6) from the internal peripheral hardware and external sources. Eight levels of priority can be specified for these interrupt requests. Multiple interrupts can also be processed.

(6) Clock generator (CG)

Two oscillators, one for the main clock (f_x) and the other for the subclock (f_{XT}), are provided. Seven types of clocks (f_x , $f_x/2$, $f_x/4$, $f_x/8$, $f_x/16$, $f_x/32$, and f_{XT}) can be generated, of which one is supplied to the CPU as the operation clock (f_{CPU}). The subclock can be selected only as the operation clock for the real-time counter.

(7) Timer/counter

A two-channel 16-bit timer/event counter and four-channel 8-bit timer/event counter are available, enabling pulse interval and frequency measurement and programmable pulse output.

Two 8-bit timer/event counter channels can be connected in cascade and used as a 16-bit timer.

(8) Real-time counter (for watch)

This counter counts the reference time (1 second) for the watch count from the subclock (32.768 kHz) or main clock. It can also be used as an interval timer that operates with the main clock. Week, day, hour, minute, and second counters are provided, and up to 4095 weeks can be counted.

(9) Watchdog timer

A watchdog timer that detects program hang-up and system errors is provided.

This watchdog timer can also be used as an interval timer.

When used as a watchdog timer, a non-maskable interrupt request (INTWDT) is generated if the watchdog timer overflows. When used as an interval timer, a maskable interrupt request is generated when the timer overflows.

(10) Serial interface (SIO)

The V850ES/SA2 and V850ES/SA3 have asynchronous serial interfaces (UART0 and UART1), clocked serial interfaces (V850ES/SA2: CSI0 to CSI3, V850ES/SA3: CSI0 to CSI4), and an I²C bus interface (I²C) as the serial interfaces. The V850ES/SA2 can use up to four channels, and the V850ES/SA3 can use up to five channels at the same time. Of these channels, one can be switched between UART and CSI, and another can be switched between CSI and I²C.

UART0 and UART1 transfer data using the TXD0, TXD1, RXD0, and RXD1 pins.

CSI0 to CSI3 transfer data using the SO0 to SO3, SI0 to SI3, and $\overline{\text{SCK0}}$ to $\overline{\text{SCK3}}$ pins.

CSI4 transfers data using the SO4, SI4, and $\overline{\text{SCK4}}$ pins (V850ES/SA3 only).

I²C transfers data using the SDA and SCL pins.

I²C is provided only in the μ PD703201Y, 703204Y, 70F3201Y, and 70F3204Y.

UART includes a dedicated baud rate generator.

(11) A/D converter

The V850ES/SA2 and V850ES/SA3 have a high-speed high-resolution, 10-bit A/D converter with 12 and 16 analog input pins, respectively. The A/D converter in both products is a successive approximation type.

(12) D/A converter

A two-channel 8-bit resolution R-string D/A converter is provided.

(13) DMA controller

A DMA controller with four channels is provided. This DMA controller transfers data between the internal RAM, on-chip peripheral I/O, and external memory, in response to interrupt requests from the on-chip peripheral I/O.

(14) ROM correction

This is a function to replace part of the program in the mask ROM with program in the internal RAM for execution. The program can be corrected at up to four places.

(15) Ports

Some port pins have a control function as well as a general-purpose port function, as shown below.

Port	I/O	Port Function	Control Function
P0	6-bit I/O	General-purpose port	NMI, external interrupt, timer input
P2 ^{Note}	3-bit I/O		Serial interface
P3	3-bit I/O		Serial interface
P4	7-bit I/O		Serial interface, timer I/O, timer trigger
P7	12-bit input (V850ES/SA2) 16-bit input (V850ES/SA3)		A/D converter analog input
P8	2-bit input		D/A converter analog output
P9	16-bit I/O		External address bus, serial interface, timer output, external interrupt
PCD ^{Note}	3-bit I/O		—
PCM	4-bit I/O (V850ES/SA2) 6-bit I/O (V850ES/SA3)		External bus interface
PCS	4-bit I/O (V850ES/SA2) 8-bit I/O (V850ES/SA3)		Chip select output
PCT	6-bit I/O (V850ES/SA2) 8-bit I/O (V850ES/SA3)		External bus interface
PDH	6-bit I/O (V850ES/SA2) 8-bit I/O (V850ES/SA3)		External address bus
PDL	16-bit I/O		External address/data bus

Note V850ES/SA3 only

CHAPTER 2 PIN FUNCTIONS

2.1 Pin Function List

This chapter explains the names and functions of the pins in the V850ES/SA2 and V850ES/SA3, classified into port pins and non-port pins.

Two power supplies are available for the pin I/O buffers: AV_{DD} and EV_{DD} . The relationship between the power supplies and pins is shown below.

Table 2-1. I/O Buffer Power Supply for Each Pin

Power Supply	Corresponding Pin
AV_{DD}	Port 7, port 8
EV_{DD}	Port 0, port 2, port 3, port 4, port 9, port CD, port CM, port CS, port CT, port DH, port DL, \overline{RESET}

The differences in the pins of the V850ES/SA2 and V850ES/SA3 are shown below.

Table 2-2. Differences in Pins of V850ES/SA2 and V850ES/SA3

Pin	V850ES/SA2				V850ES/SA3			
	μ PD703201	μ PD70F3201	μ PD703201Y	μ PD70F3201Y	μ PD703204	μ PD70F3204	μ PD703204Y	μ PD70F3204Y
P20/SI4, P21/SO4, P22/ $\overline{SCK4}$	None				Provided			
P712/ANI12 to P715/ANI15	None				Provided			
PCD1 to PCD3	None				Provided			
PCM4, PCM5	None				Provided			
PCS4 to PCS7	None				Provided			
PCT2, PCT3	None				Provided			
PDH6/A22, PDH7/A23	None				Provided			
SDA, SDA	None		Provided		None		Provided	
FLMD0, FLMD1	None	Provided	None	Provided	None	Provided	None	Provided
IC	Provided	None	Provided	None	Provided	None	Provided	None

(1) Port pins

(1/3)

Pin Name	I/O	On-Chip Pull-up Resistor	Function	Alternate-Function Pin
P00	I/O	Provided	Port 0. 6-bit I/O port. Can be set to input or output in 1-bit units.	NMI
P01				INTP0/TI2
P02				INTP1/TI3
P03				INTP2/TI4
P04				INTP3/TI5
P05				INTP4
[P20]	I/O	Provided	Port 2. 3-bit I/O port. Can be set to input or output in 1-bit units. Can be specified as an N-ch open drain port in 1-bit units (P21 and P22 only).	[SI4]
[P21]				[SO4]
[P22]				[SCK4]
P30	I/O	Provided	Port 3. 3-bit I/O port. Can be set to input or output in 1-bit units. Can be specified as an N-ch open drain port in 1-bit units (P31 and P32 only).	SI1/RXD0
P31				SO1/TXD0
P32				SCK1
P40	I/O	Provided	Port 4. 7-bit I/O port. Can be set to input or output in 1-bit units. Can be specified as an N-ch open drain port in 1-bit units (P41 and P42 only).	SI0
P41				SO0/SDA ^{Note}
P42				SCK0/SCL ^{Note}
P43				INTP00/TI0/TCLR0
P44				INTP01/TO0
P45				INTP10/TI1/TCLR1
P46				INTP11/TO1
P70	Input	None	Port 7. 12-bit input port (V850ES/SA2). 16-bit input port (V850ES/SA3).	ANI0
P71				ANI1
P72				ANI2
P73				ANI3
P74				ANI4
P75				ANI5
P76				ANI6
P77				ANI7
P78				ANI8
P79				ANI9
P710				ANI10
P711				ANI11
[P712]				[ANI12]
[P713]				[ANI13]
[P714]				[ANI14]
[P715]	[ANI15]			

Note μ PD703201Y, 703204Y, 70F3201Y, and 70F3204Y only

Remark []: Pins provided only in the V850ES/SA3

Pin Name	I/O	On-Chip Pull-up Resistor	Function	Alternate-Function Pin
P80	Input	None	Port 8. 2-bit input port	ANO0
P81				ANO1
P90	I/O	Provided	Port 9. 16-bit I/O port. Can be set to input or output in 1-bit units. Can be specified as an N-ch open drain port in 1-bit units (P911, P912, P914, and P915 only).	A0
P91				A1
P92				A2/INTP5
P93				A3/INTP6
P94				A4/TO2
P95				A5/TO3
P96				A6/TO4
P97				A7/TO5
P98				A8/RXD1
P99				A9/TXD1
P910				A10/SI2
P911				A11/SO2
P912				A12/SCK2
P913				A13/SI3
P914				A14/SO3
P915	A15/SCK3			
[PCD1]	I/O	None	Port CD. 3-bit I/O port. Can be set to input or output in 1-bit units.	–
[PCD2]				–
[PCD3]				–
PCM0	I/O	None	Port CM. 4-bit I/O port (V850ES/SA2). 6-bit I/O port (V850ES/SA3). Can be set to input or output in 1-bit units.	WAIT
PCM1				CLKOUT
PCM2				HLDAK
PCM3				HLDRQ
[PCM4]				–
[PCM5]				–
PCS0	I/O	None	Port 10. 4-bit I/O port (V850ES/SA2). 8-bit I/O port (V850ES/SA3). Can be set to input or output in 1-bit units.	CS0
PCS1				CS1
PCS2				CS2
PCS3				CS3
[PCS4]				–
[PCS5]				–
[PCS6]				–
[PCS7]				–
PCT0	I/O	None	Port CT. 6-bit I/O port (V850ES/SA2). 8-bit I/O port (V850ES/SA3). Can be set to input or output in 1-bit units.	WR0
PCT1				WR1
[PCT2]				–
[PCT3]				–
PCT4				RD
PCT5				–
PCT6				ASTB
PCT7				–

Remark []: Pins provided only in the V850ES/SA3

Pin Name	I/O	On-Chip Pull-up Resistor	Function	Alternate-Function Pin
PDH0	I/O	None	Port DH. 6-bit I/O port (V850ES/SA2). 8-bit I/O port (V850ES/SA3). Can be set to input or output in 1-bit units.	A16
PDH1				A17
PDH2				A18
PDH3				A19
PDH4				A20
PDH5				A21
[PDH6]				[A22]
[PDH7]				[A23]
PDL0	I/O	None	Port DL. 16-bit I/O port. Can be set to input or output in 1-bit units.	AD0
PDL1				AD1
PDL2				AD2
PDL3				AD3
PDL4				AD4
PDL5				AD5/FLMD1 ^{Note}
PDL6				AD6
PDL7				AD7
PDL8				AD8
PDL9				AD9
PDL10				AD10
PDL11				AD11
PDL12				AD12
PDL13				AD13
PDL14				AD14
PDL15				AD15

Note μ PD70F3201, 70F3201Y, 70F3204, and 70F3204Y only

Remark []: Pins provided only in the V850ES/SA3

(2) Non-port pins

(1/3)

Pin Name	I/O	On-Chip Pull-up Resistor	Function	Alternate-Function Pin
A0	Output	Provided	Address bus for external memory (when separate bus is used)	P90
A1				P91
A2				P92/INTP5
A3				P93/INTP6
A4				P94/TO2
A5				P95/TO3
A6				P96/TO4
A7				P97/TO5
A8				P98/RXD1
A9				P99/TXD1
A10				P910/SI2
A11				P911/SO2
A12				P912/SCK2
A13				P913/SI3
A14				P914/SO3
A15	P915/SCK3			
A16 to A21, [A22, A23]	Output	None	Address bus for external memory	PDH0 to PDH5, [PDH6, PDH7]
AD0 to AD4	I/O	None	Address/data bus for external memory	PDL0 to PDL4
AD5				PDL5/FLMD1 ^{Note}
AD6 to AD15				PDL6 to PDL15
ANI0	Input	None	Analog voltage input for A/D converter	P70
ANI1				P71
ANI2				P72
ANI3				P73
ANI4				P74
ANI5				P75
ANI6				P76
ANI7				P77
ANI8				P78
ANI9				P79
ANI10				P710
ANI11				P711
[ANI12]				[P712]
[ANI13]				[P713]
[ANI14]				[P714]
[ANI15]	[P715]			
ANO0	Output	None	Analog voltage output for D/A converter	P80
ANO1				P81
ASTB	Output	None	Address strobe signal output for external memory	PCT6

Note μ PD70F3201, 70F3201Y, 70F3204, and 70F3204Y only

Remark []: Pins provided only in the V850ES/SA3

Pin Name	I/O	On-Chip Pull-up Resistor	Function	Alternate-Function Pin
AV _{DD}	–	–	Positive power supply for A/D converter (same potential as V _{DD})	–
AV _{REF0}	Input	–	Reference voltage input for A/D converter	–
AV _{REF1}			Reference voltage input for D/A converter	–
AV _{SS}	–	–	Ground potential for A/D and D/A converters (same potential as V _{SS})	–
CLKOUT	Output	None	Internal system clock output	PCM1
$\overline{\text{CS}}0$ to $\overline{\text{CS}}3$	Output	None	Chip select output	PCS0 to PCS3
EV _{DD}	–	–	Positive power supply for external device (same potential as V _{DD})	–
EV _{SS}	–	–	Ground potential for external device (same potential as V _{SS})	–
FLMD0 ^{Note 1}	Input	None	Flash programming mode setting pin	–
FLMD1 ^{Note 1}				PDL5/AD5
$\overline{\text{HLD}}\overline{\text{AK}}$	Output	None	Bus hold acknowledge output	PCM2
$\overline{\text{HLD}}\overline{\text{RQ}}$	Input	None	Bus hold request input	PCM3
IC	–	–	Internally connected (connect this pin directly to V _{SS}) (μ PD703201, 703201Y, 703204, and 703204Y only)	–
INTP0 to INTP3	Input	Provided	External interrupt request input (maskable, analog noise elimination)	P01/TI2 to P04/TI5
INTP4				P05
INTP5				P92/A2
INTP6				P93/A3
INTP00	Input	Provided	Capture trigger input (TM0)	P43/TI0/TCLR0
INTP01				P44/TO0
INTP10			Capture trigger input (TM1)	P45/TI1/TCLR1
INTP11				P46/TO1
NMI	Input	Provided	External interrupt input (non-maskable, analog noise elimination)	P00
$\overline{\text{RD}}$	Output	None	Read strobe signal output for external memory	PCT4
$\overline{\text{RESET}}$	Input	–	System reset input	–
RXD0	Input	Provided	Serial receive data input (UART0)	P30/SI1
RXD1			Serial receive data input (UART1)	P98/A8
$\overline{\text{SCK}}0$	I/O	Provided	Serial clock I/O (CSI0)	P42/SCL ^{Note 2}
$\overline{\text{SCK}}1$			Serial clock I/O (CSI1)	P32
$\overline{\text{SCK}}2$			Serial clock I/O (CSI2)	P912/A12
$\overline{\text{SCK}}3$			Serial clock I/O (CSI3)	P915/A15
[$\overline{\text{SCK}}4$]			Serial clock I/O (CSI4)	[P22]
SCL ^{Note 2}	I/O	Provided	Serial clock I/O (I ² C)	P42/ $\overline{\text{SCK}}0$
SDA ^{Note 2}	I/O	Provided	Serial transmit/receive data I/O (I ² C)	P41/SO0
SI0	Input	Provided	Serial receive data input (CSI0)	P40
SI1			Serial receive data input (CSI1)	P30/RXD0
SI2			Serial receive data input (CSI2)	P910/A10
SI3			Serial receive data input (CSI3)	P913/A13
[SI4]			Serial receive data input (CSI4)	[P20]

Notes 1. μ PD70F3201, 70F3201Y, 70F3204, and 70F3204Y only

2. μ PD703201Y, 703204Y, 70F3201Y, and 70F3204Y only

Remark []: Pins provided only in the V850ES/SA3

Pin Name	I/O	On-Chip Pull-up Resistor	Function	Alternate-Function Pin
SO0	Output	Provided	Serial transmit data output (CSI0)	P41/SDA ^{Note}
SO1			Serial transmit data output (CSI1)	P31/TXD0
SO2			Serial transmit data output (CSI2)	P911/A11
SO3			Serial transmit data output (CSI3)	P914/A14
[SO4]			Serial transmit data output (CSI4)	[P21]
TCLR0	Input	Provided	Timer clear input (TM0)	P43/INTP00/TI0
TCLR1			Timer clear input (TM1)	P45/INTP10/TI1
TI0	Input	Provided	External event/clock input (TM0)	P43/INTP00/TCLR0
TI1			External event/clock input (TM1)	P45/INTP10/TCLR1
TI2			External event/clock input (TM2)	P01/INTP0
TI3			External event/clock input (TM3)	P02/INTP1
TI4			External event/clock input (TM4)	P03/INTP2
TI5			External event/clock input (TM5)	P04/INTP3
TO0	Output	Provided	Timer output (TM0)	P44/INTP01
TO1			Timer output (TM1)	P46/INTP11
TO2			Timer output (TM2)	P94/A4
TO3			Timer output (TM3)	P95/A5
TO4			Timer output (TM4)	P96/A6
TO5			Timer output (TM5)	P97/A7
TXD0	Output	Provided	Serial transmit data output (UART0)	P31/SO1
TXD1			Serial transmit data output (UART1)	P99/A9
V _{DD}	–	–	Positive power supply pin for internal circuits (except subclock oscillator, RTC, and internal RAM)	–
V _{DDBU}	–	–	Positive power supply pin for backup (for subclock oscillator, RTC, and internal RAM)	–
V _{SS}	–	–	Ground potential for internal circuits (except subclock oscillator, RTC, and internal RAM)	–
V _{SSBU}	–	–	Ground potential for backup (for subclock oscillator, RTC, and internal RAM)	–
$\overline{\text{WAIT}}$	Input	None	External wait input	PCM0
$\overline{\text{WR0}}$	Output	None	Write strobe for external memory (lower 8 bits)	PCT0
$\overline{\text{WR1}}$			Write strobe for external memory (higher 8 bits)	PCT1
X1	Input	None	Oscillator connection for main clock	–
X2	–			–
XT1	Input	None	Oscillator connection for subclock	–
XT2	–			–

Note μ PD703201Y, 703204Y, 70F3201Y, and 70F3204Y only

Remark []: Pins provided only in the V850ES/SA3

2.2 Pin Status

The operating status of each pin in each operation mode is shown below.

Table 2-3. Operating Status of Each Pin in Each Operation Mode

Bus Control Pins	Reset	HALT Mode or DMA Transfer	IDLE and STOP Modes	Idle State ^{Note 2}	Bus Hold
AD0 to AD15	Hi-Z ^{Note 1}	Operates	Hi-Z	Retained	Hi-Z
A16 to A23					
A0 to A8					
WAIT			–	–	–
CLKOUT			L	Operates	Operates
CS0 to CS3			H	Retained	Hi-Z
WR0, WR1				H	
RD					
ASTB					
HLD $\overline{\text{AK}}$					L
HLD $\overline{\text{RQ}}$			–	–	Operates

Notes 1. Because the bus control pins function alternately as port pins, they are initialized to the input mode (port mode).

2. Indicates the pin status in the idle state that is inserted after the T3 state.

Remark Hi-Z: High impedance
 Retained: Status in external bus cycle immediately before is retained.
 L: Low-level output
 H: High-level output
 –: Input not sampled (not acknowledged)

2.3 Description of Pin Functions

(1) P00 to P05 (Port 0) ... 3-state I/O

Port 0 is a 6-bit I/O port that can be set to the input or output in 1-bit units.

Besides functioning as I/O port pins, P00 to P05 also operate as NMI input, external interrupt request, and timer/counter input pins. Port or control mode can be selected as the operation mode for each bit, with the valid edge of each pin specified by using the INTR0 and INTF0 registers.

(a) Port mode

P00 to P05 can be set to the input or output mode in 1-bit units by using port mode register 0 (PM0).

(b) Control mode

(i) NMI (non-maskable interrupt request) ... Input

This pin inputs a non-maskable interrupt request.

(ii) INTP0 to INTP4 (interrupt request from peripherals) ... Input

These pins input an external interrupt request.

(iii) TI2 to TI5 (timer input 2 to 5) ... Input

These pins input an external count clock to timers 2 to 5.

(2) P20 to P22 (Port 2) (V850ES/SA3 only) ... 3-state I/O

Port 2 is a 3-bit I/O port that can be set to the input or output mode in 1-bit units.

Besides functioning as I/O port pins, P20 to P22 also operate as the I/O pins of the serial interface.

These pins can be set to the port or control mode in 1-bit units.

The output mode of P21 and P22 can also be set to normal output or N-ch open-drain output.

(a) Port mode

P20 to P22 can be set to the input or output mode in 1-bit units by using port mode register 2 (PM2).

(b) Control mode

(i) SI4 (serial input 4) ... Input

This pin inputs the serial receive data of CSI4.

(ii) SO4 (serial output 4) ... Output

This pin outputs the serial transmit data of CSI4.

(iii) $\overline{\text{SCK4}}$ (serial clock 4) ... 3-state I/O

This is the serial clock I/O pin of CSI4.

(3) P30 to P32 (Port 3) ... 3-state I/O

Port 3 is a 3-bit I/O port that can be set to the input or output mode in 1-bit units.

Besides functioning as I/O port pins, P30 to P32 also operate as the I/O pins of the serial interface.

These pins can be set to the port or control mode in 1-bit units.

The output mode of P31 and P32 can also be set to normal output or N-ch open-drain output.

(a) Port mode

P30 to P32 can be set to the input or output mode in 1-bit units by using port mode register 3 (PM3).

(b) Control mode**(i) SI1 (serial input 1) ... Input**

This pin inputs the serial receive data of CSI1.

(ii) SO1 (serial output 1) ... Output

This pin outputs the serial transmit data of CSI1.

(iii) $\overline{\text{SCK1}}$ (serial clock 1) ... 3-state I/O

This is the serial clock I/O pin of CSI1.

(iv) RXD0 (receive data 0) ... Input

This pin inputs the serial receive data of UART0.

(v) TXD0 (transmit data 0) ... Output

This pin outputs the serial transmit data of UART0.

(4) P40 to P46 (Port 4) ... 3-state I/O

Port 4 is a 7-bit I/O port that can be set to the input or output mode in 1-bit units.

Besides functioning as I/O port pins, P40 to P46 also operate as the I/O pins of the timer/counters and serial interface, and as the external interrupt request input pin. These pins can be set to the port or control mode in 1-bit units.

The output mode of P41 and P42 can also be set to normal output or N-ch open-drain output.

(a) Port mode

P40 to P46 can be set to the input or output mode in 1-bit units by using port mode register 4 (PM4).

(b) Control mode**(i) TI0, TI1 (timer input 0, 1) ... Input**

These pins input an external count clock to timers 0 and 1.

(ii) TO0, TO1 (timer output 0, 1) ... Output

These pins output a pulse signal from timers 0 and 1.

(iii) TCLR0, TCLR1 (timer clear Input 0, 1) ... 3-state I/O

These pins input an external clear signal to timers 0 and 1.

(iv) SIO (serial input 0) ... Input

This pin inputs the serial receive data of CSIO.

(v) SO0 (serial output 0) ... Output

This pin outputs the serial transmit data of CSIO.

(vi) $\overline{\text{SCK0}}$ (serial clock 0) ... 3-state I/O

This is the serial clock I/O pin of CSIO.

(vii) SDA (serial data) ... I/O

This pin inputs/outputs the serial transmit/receive data of I²C (μ PD703201Y, 70F3201Y, 703204Y, and 70F3204Y only).

(viii) SCL (serial clock) ... I/O

This pin inputs/outputs the serial clock to/from I²C (μ PD703201Y, 70F3201Y, 703204Y, and 70F3204Y only).

(ix) INTP00, INTP01, INTP10, INTP11 (interrupt request to timer) ... Input

These pins input an external interrupt request to timers 0 and 1.

(5) P70 to P711 (Port 7) (V850ES/SA2) ... Input**P70 to P715 (Port 7) (V850ES/SA3) ... Input****[V850ES/SA2]**

Port 7 is a 12-bit input port with all its bits fixed to the input mode.

Besides functioning as input port pins, P70 to P711 also operate as the analog input pins of the A/D converter in the control mode. However, the mode of these pins cannot be changed between the input port mode and analog input mode.

(a) Port mode

P70 to P711 function as input port pins.

(b) Control mode

P70 to P711 function as the ANI0 to ANI11 pins. The mode of these pins cannot be changed between the input port mode and analog input mode.

(i) ANI0 to ANI11 (analog input 0 to 11) ... Input

These are the analog input pins of the A/D converter.

To prevent these pins malfunctioning due to noise, connect a capacitor between these pins and AV_{SS}. Make sure that a voltage outside the range of AV_{SS} to AV_{REF0} is not applied to any pin that is being used as an input pin of the A/D converter. If there is a possibility that a noise greater than AV_{REF0} or lower than AV_{SS} will be superimposed on any of these pins, clamp the pins using a diode with a low V_F.

[V850ES/SA3]

Port 7 is a 16-bit input port with all its bits fixed to the input mode.

Besides functioning as input port pins, P70 to P715 also operate as the analog input pins of the A/D converter in the control mode. However, the mode of these pins cannot be changed between the input port mode and analog input mode.

(a) Port mode

P70 to P715 function as input port pins.

(b) Control mode

P70 to P715 function as the ANI0 to ANI15 pins. The mode of these pins cannot be changed between the input port mode and analog input mode.

(i) ANI0 to ANI15 (analog input 0 to 15) ... Input

These are the analog input pins of the A/D converter.

To prevent these pins malfunctioning due to noise, connect a capacitor between these pins and AV_{SS} . Make sure that a voltage outside the range of AV_{SS} to AV_{REF0} is not applied to any pin that is being used as an input pin of the A/D converter. If there is a possibility that a noise greater than AV_{REF0} or lower than AV_{SS} will be superimposed on any of these pins, clamp the pins using a diode with a low V_F .

(6) P80, P81 (Port 8) ... Input/Output

Port 8 is a 2-bit input port.

Besides functioning as input port pins, P80 and P81 also operate as the analog output pins of the D/A converter in the control mode. The mode of these pins, however, cannot be changed between the control mode and input port mode.

(a) Port mode

P80 and P81 function as input port pins.

(b) Control mode**(i) ANO0, ANO1 (analog output 0, 1) ... Output**

These pins are the analog output pins of the D/A converter.

(7) P90 to P915 (Port 9) ... 3-state I/O

Port 9 is a 16-bit I/O port that can be set to the input or output mode in 1-bit units.

Besides functioning as I/O port pins, P90 to P915 also operate as the I/O pins of the serial interface and timer/counters, the address bus pins to extend the memory externally, and external interrupt request input pins. These pins can be set to the port or control mode in 1-bit units.

The output mode of P911, P912, P914, and P915 can also be set to normal output or N-ch open-drain output.

(a) Port mode

P90 to P915 can be set to the input or output mode in 1-bit units by using port mode register 9 (PM9).

(b) Control mode**(i) SI2, SI3 (serial input 2, 3) ... Input**

These pins input the serial receive data of CSI2 and CSI3.

(ii) SO2, SO3 (serial output 2, 3) ... Output

These pins output the serial transmit data of CSI2 and CSI3.

(iii) $\overline{\text{SCK2}}$, $\overline{\text{SCK3}}$ (serial clock 2, 3) ... 3-state I/O

These pins are the serial clock I/O pins of CSI2 and CSI3.

(iv) RXD1 (receive data 1) ... Input

This pin inputs the serial receive data of UART1.

(v) TXD1 (transmit data 1) ... Output

This pin outputs the serial transmit data of UART1.

(vi) TO2 to TO5 (timer output 2 to 5) ... Output

These pins output a pulse signal from timers 2 to 5.

(vii) A0 to A15 (address bus 0 to 15) ... Output

These pins form a 16-bit address output bus to access an external memory. The output signal changes at the rising edge of the T1 state in the bus cycle. When the bus cycle is not active, they retain the address of the bus cycle immediately before.

(viii) INTP5, INTP6 (interrupt request from peripherals) ... Input

These pins input an external interrupt request.

(8) PCD1 to PCD3 (Port CD) (V850ES/SA3 only) ... 3-state I/O

Port CD is a 3-bit I/O port that can be set to the input or output mode in 1-bit units.

PCD1 to PCD3 can be set to the input or output mode in 1-bit units by using port mode register CD (PMCD).

(9) PCM0 to PCM3 (Port CM) (V850ES/SA2) ... 3-state I/O
PCM0 to PCM5 (Port CM) (V850ES/SA3) ... 3 state I/O

[V850ES/SA2]

Port CM is a 4-bit I/O port that can be set to the input or output mode in 1-bit units.

Besides functioning as I/O port pins, in the control mode PCM0 to PCM3 also operate as the bus hold control signal output and bus clock output pins, and as the control signal that inserts a wait state ($\overline{\text{WAIT}}$) in the bus cycle.

(a) Port mode

PCM0 to PCM3 can be set to the input or output mode in 1-bit units by using port mode register CM (PMCM).

(b) Control mode

(i) $\overline{\text{HLDAK}}$ (hold acknowledge) ... Output

This pin outputs an acknowledge signal indicating that the V850ES/SA2 has made the address bus, data bus, and control bus go into a high-impedance state, in response to a bus hold request.

While this signal is active, the address bus, data bus, and control bus are in the high-impedance state.

(ii) $\overline{\text{HLDRQ}}$ (hold request) ... Input

This pin is used by an external device to request the V850ES/SA2 to release the address bus, data bus, and control bus. A signal can be input to this pin asynchronously to CLKOUT. When this pin is active, the V850ES/SA2 makes the address bus, data bus, and control bus go into a high-impedance state immediately or after completion of the bus cycle under execution, if any, and then asserts the $\overline{\text{HLDAK}}$ signal and releases the bus.

(iii) CLKOUT (clock output) ... Output

This pin outputs the internally generated bus clock.

(iv) $\overline{\text{WAIT}}$ (wait) ... Input

This pin inputs a control signal that inserts a wait state in the bus cycle. It is sampled at the falling edge of the clock in the T2 and TW states of the bus cycle.

The wait function is turned ON/OFF by port mode control register CM (PMCCM).

[V850ES/SA3]

Port CM is a 6-bit I/O port that can be set to the input or output mode in 1-bit units.

Besides functioning as I/O port pins, in the control mode PCM0 to PCM5 also operate as the bus hold control signal output and bus clock output pins, and as the control signal that inserts a wait state ($\overline{\text{WAIT}}$) in the bus cycle.

(a) Port mode

PCM0 to PCM5 can be set to the input or output mode in 1-bit units by using port mode register CM (PMCM).

(b) Control mode**(i) $\overline{\text{HLDAK}}$ (hold acknowledge) ... Output**

This pin outputs an acknowledge signal indicating that the V850ES/SA3 has made the address bus, data bus, and control bus go into a high-impedance state, in response to a bus hold request.

While this signal is active, the address bus, data bus, and control bus are in the high-impedance state.

(ii) $\overline{\text{HLDRQ}}$ (hold request) ... Input

This pin is used by an external device to request the V850ES/SA3 to release the address bus, data bus, and control bus. A signal can be input to this pin asynchronously to CLKOUT. When this pin is active, the V850ES/SA3 makes the address bus, data bus, and control bus go into a high-impedance state immediately or after completion of the bus cycle under execution, if any, and then asserts the $\overline{\text{HLDAK}}$ signal and releases the bus.

(iii) CLKOUT (clock output) ... Output

This pin outputs the internally generated bus clock.

(iv) $\overline{\text{WAIT}}$ (wait) ... Input

This pin inputs a control signal that inserts a wait state in the bus cycle. It is sampled at the falling edge of the clock in the T2 and TW states of the bus cycle.

The wait function is turned ON/OFF by port mode control register CM (PMCCM).

(10) PCS0 to PSC3 (Port CS) (V850ES/SA2) ... 3-state I/O
PCS0 to PCS5 (Port CS) (V850ES/SA3) ... 3-state I/O

[V850ES/SA2]

Port CS is a 4-bit I/O port that can be set to the input or output mode in 1-bit units.

Besides functioning as I/O port pins, in the control mode PCS0 to PSC3 also operate as the control signal output pins when the memory and peripheral I/O are expanded externally.

(a) Port mode

PCS0 to PSC3 can be set to the input or output mode in 1-bit units by using port mode register CM (PMCS).

(b) Control mode

(i) $\overline{CS0}$ to $\overline{CS3}$ (chip select) ... Output

These are the chip select signals for the SRAM, external ROM, and external peripheral I/O area.

The \overline{CSn} signal is assigned to memory block n (n = 0 to 3).

Each of these signals is active while the bus cycle accessing the corresponding memory block is being executed, and inactive in the idle state (TI).

[V850ES/SA3]

Port CS is an 8-bit I/O port that can be set to the input or output mode in 1-bit units.

Besides functioning as I/O port pins, in the control mode PCS0 to PSC3 also operate as the control signal output pins when the memory and peripheral I/O are expanded externally.

(a) Port mode

PCS0 to PCS7 can be set to the input or output mode in 1-bit units by using port mode register CS (PMCS).

(b) Control mode

(i) $\overline{CS0}$ to $\overline{CS3}$ (chip select) ... Output

These are the chip select signals for the SRAM, external ROM, and external peripheral I/O area.

The \overline{CSn} signal is assigned to memory block n (n = 0 to 3).

Each of these signals is active while the bus cycle accessing the corresponding memory block is being executed, and inactive in the idle state (TI).

(11) PCT0, PCT1, PCT4 to PCT7 (Port CT) (V850ES/SA2) ... 3-state I/O
PCT0 to PCT7 (Port CT) (V850ES/SA3) ... 3-state I/O

[V850ES/SA2]

Port CT is a 6-bit port that can be set to the input or output mode in 1-bit units.

Besides functioning as I/O port pins, in the control mode PCT0, PCT1, and PCT4 to PCT7 also operate as the control signal output pins when the memory is expanded externally.

(a) Port mode

PCT0, PCT1, and PCT4 to PCT7 can be set to the input or output mode in 1-bit units by using port mode register CT (PMCT).

(b) Control mode

(i) $\overline{WR0}$ (write strobe low level data) ... Output

This is the write strobe signal output pin for the lower data of the external 16-bit data bus.

(ii) $\overline{WR1}$ (write strobe high level data) ... Output

This is the write strobe signal output pin for the higher data of the external 16-bit data bus.

(iii) \overline{RD} (read strobe) ... Output

This is the read strobe signal output pin for the external 16-bit data bus.

(iv) \overline{ASTB} (address strobe) ... Output

This is the latch strobe signal output pin of the external address bus. The output signal goes low at the falling edge of the T1 state in the bus cycle, and goes high at the falling edge of the T3 state. It is high when the bus cycle is not active.

[V850ES/SA3]

Port CT is an 8-bit port that can be set to the input or output mode in 1-bit units.

Besides functioning as I/O port pins, in the control mode PCT0 to PCT7 also operate as the control signal output pins when the memory is expanded externally.

(a) Port mode

PCT0 to PCT7 can be set to the input or output mode in 1-bit units by using port mode register CT (PMCT).

(b) Control mode

(i) $\overline{WR0}$ (write strobe low level data) ... Output

This is the write strobe signal output pin for the lower data of the external 16-bit data bus.

(ii) $\overline{WR1}$ (write strobe high level data) ... Output

This is the write strobe signal output pin for the higher data of the external 16-bit data bus.

(iii) $\overline{\text{RD}}$ (read strobe) ... Output

This is the read strobe signal output pin for the external 16-bit data bus.

(iv) ASTB (address strobe) ... Output

This is the latch strobe signal output pin of the external address bus. The output signal goes low at the falling edge of the T1 state in the bus cycle, and goes high at the falling edge of the T3 state. It is high when the bus cycle is not active.

(12) PDH0 to PDH5 (Port DH) (V850ES/SA2) ... 3-state I/O**PDH0 to PDH7 (Port DH) (V850ES/SA3) ... 3-state I/O****[V850ES/SA2]**

Port DH is a 6-bit port that can be set to the input or output mode in 1-bit units.

Besides functioning as I/O port pins, in the control mode PDH0 to PDH5 also operate as the address bus pins when the memory is expanded externally.

(a) Port mode

PDH0 to PDH5 can be set to the input or output mode in 1-bit units by using port mode register DH (PMDH).

(b) Control mode**(i) A16 to A21 (address bus 16 to 21) ... Output**

These pins form a 6-bit address output bus to access an external device. The output signal changes at the rising edge of the T1 state in the bus cycle. The address of the immediately preceding bus cycle is retained when the bus cycle is inactive.

[V850ES/SA3]

Port DH is an 8-bit port that can be set to the input or output mode in 1-bit units.

Besides functioning as I/O port pins, in the control mode PDH0 to PDH7 also operate as the address bus pins when the memory is expanded externally.

(a) Port mode

PDH0 to PDH7 can be set to the input or output mode in 1-bit units by using port mode register DH (PMDH).

(b) Control mode**(i) A16 to A23 (address bus 16 to 23) ... Output**

These pins form an 8-bit address output bus to access an external device. The output signal changes at the rising edge of the T1 state in the bus cycle. The address of the immediately preceding bus cycle is retained when the bus cycle is inactive.

(13) PDL0 to PDL15 (Port DL) ... 3-state I/O

Port DL is a 16-bit I/O port that can be set to the input or output mode in 1-bit units.

Besides functioning as I/O port pins, PDL0 to PDL15 also operate a time-division address/data bus (AD0 to AD15) when the memory is externally expanded. Each bit of the port can be individually set to the port or control mode.

In addition, one of the port pins functions as the FLMD1 pin when the flash memory of the μ PD70F3201, 70F3201Y, 70F3204, and 70F3204Y is programmed (when a high level is input to FLMD0). At this time, be sure to input a low level to the FLMD1 pin.

(a) Port mode

PDL0 to PDL15 can be set to the input or output mode in 1-bit units by using port mode register DL (PMDL).

(b) Control mode**(i) AD0 to AD15 (address/data bus 0 to 15) ... 3-state I/O**

This is a multiplexed address/data bus that is used to access an external device. In the multiplexed bus mode, it outputs an address or inputs/outputs data. In the separate bus mode, the bus inputs or outputs data.

(14) $\overline{\text{RESET}}$ (Reset) ... Input

The $\overline{\text{RESET}}$ signal is input asynchronously. If a signal having a specific low-level width is input to this pin, regardless of the operation clock, the system is reset as a priority over all other operations.

This pin is used to release the standby mode (HALT, IDLE, STOP, or backup) as well as for normal initialization/starting.

(15) X1, X2 (Crystal for main clock)

Connect an oscillator for system clock generation to these pins.

(16) XT1, XT2 (Crystal for subclock)

Connect an oscillator for subclock generation to these pins.

(17) AV_{DD} (Analog V_{DD})

This pin supplies positive power to the A/D converter and alternate-function port pins.

(18) AV_{SS} (Analog V_{SS})

This is a ground pin for the A/D converter and alternate-function port pins.

(19) AV_{REF0} (Analog reference voltage) ... Input

This pin supplies a reference voltage to the A/D converter.

(20) AV_{REF1} (Analog reference voltage) ... Input

This pin supplies a reference voltage to the D/A converter.

(21) V_{DDBU} (Power supply for backup)

This pin supplies positive power for backup.

(22) V_{SSBU} (Ground for backup)

This is a ground pin for backup.

(23) EV_{DD} (Power supply for port)

This pin supplies positive power for the I/O ports and pins with alternate functions.

(24) EV_{SS} (Ground for port)

This is a ground pin for the I/O ports and pins with alternate functions.

(25) V_{DD} (Power supply)

This pin supplies positive power. Connect all the V_{DD} pins to the positive power supply.

(26) V_{SS} (Ground)

This is the ground pin. Connect all the V_{SS} pins to ground.

(27) FLMD0, 1 (Flash programming mode)

These pins supply positive power for flash memory programming mode.

These pins are provided only in the μ PD70F3201, 70F3201Y, 70F3204, and 70F3204Y. In the normal operation mode, connect these pins to V_{SS}.

(28) IC (Internally connected)

These pins are internally connected and provided only in the μ PD70F3201, 70F3201Y, 70F3204, and 70F3204Y. In the normal operation mode, connect these pins to V_{SS}.

2.4 Types of Pin I/O Circuits, I/O Buffer Power Supplies, and Connection of Unused Pins

(1/2)

Pin	Alternate Function	I/O Circuit Type	Recommended Connection
P00	NMI	5-W	Input: Independently connect to EV_{DD} or EV_{SS} via a resistor. Output: Leave open.
P01 to P04	INTP0/TI2 to INTP3/TI5		
P05	INTP4		
[P20]	[SI4]	5-W	
[P21]	[SO4]	10-E	
[P22]	[SCK4]	10-F	
P30	SI1/RXD0	5-W	
P31	SO1/TXD0	10-E	
P32	SCK1	10-F	
P40	SI0	5-W	
P41	SO0/SDA ^{Note}	10-F	
P42	SCK0/SCL ^{Note}	10-F	
P43	INTP00/TI0/TCLR0	5-W	
P44	INTP01/TO0		
P45	INTP10/TI1/TCLR1		
P46	INTP11/TO1		
P70 to P711, [P712 to P715]	ANI0 to ANI11 [ANI12 to ANI15]	9	Independently connect to AV_{DD} or AV_{SS} via a resistor.
P80, P81	ANO0, ANO1	34	
P90, P91	A0, A1	5-A	Input: Independently connect to EV_{DD} or EV_{SS} via a resistor. Output: Leave open.
P92, P93	A2/INTP5, A3/INTP6	5-W	
P94 to P97	A4/TO2 to A7/TO5	5-A	
P98	A8/RXD1	5-W	
P99	A9/TXD1	5-A	
P910	A10/SI2	5-W	
P911	A11/SO2	10-E	
P912	A12/SCK2	10-F	
P913	A13/SI3	5-W	
P914	A14/SO3	10-E	
P915	A15/SCK3	10-F	
[PCD1 to PCD3]	–	5	
PCM0	WAIT		
PCM1	CLKOUT		
PCM2	HLDAR		
PCM3	HLDRQ		
[PCM4]	–		
[PCM5]	–		

Note μ PD703201Y, 703204Y, 70F3201Y, and 70F3204Y only

Remark []: Pins provided only in the V850ES/SA3

Pin	Alternate Function	I/O Circuit Type	Recommended Connection
PCS0 to PCS3	$\overline{CS0}$ to $\overline{CS3}$	5	Input: Independently connect to EV_{DD} or EV_{SS} via a resistor. Output: Leave open.
[PCS4 to PCS7]	–		
PCT0, PCT1	$\overline{WR0}$, $\overline{WR1}$		
[PCT2, PCT3]	–		
PCT4	\overline{RD}		
PCT5	–		
PCT6	ASTB		
PCT7	–		
PDH0 to PDH5, [PDH6, PDH7]	A16 to A21, [A22, A23]		
PDL0 to PDL4	AD0 to AD4		
PDL5	AD5/FLMD1 ^{Note 1}		
PDL6 to PDL15	AD6 to AD15		
AV_{DD}	–		
AV_{REF0}	–	–	Connect to AV_{SS} via a resistor.
AV_{REF1}	–	–	Connect to AV_{SS} via a resistor.
AV_{SS}	–	–	–
EV_{DD}	–	–	–
EV_{SS}	–	–	–
FLMD0 ^{Note 1}	–	–	–
IC ^{Note 2}	–	–	–
\overline{RESET}	–	2	–
V_{DD}	–	–	–
V_{DDBU}	–	–	–
V_{SS}	–	–	–
V_{SSBU}	–	–	–
X1	–	–	–
X2	–	–	–
XT1	–	16	Connect to V_{SSBU} via a resistor.
XT2	–	16	Leave open.

Notes 1. μ PD70F3201, 70F3201Y, 70F3204, and 70F3204Y only

2. μ PD703201, 703201Y, 703204, and 703204Y only

Remark []: Pins provided only in the V850ES/SA3

Figure 2-1. Pin I/O Circuits (1/2)

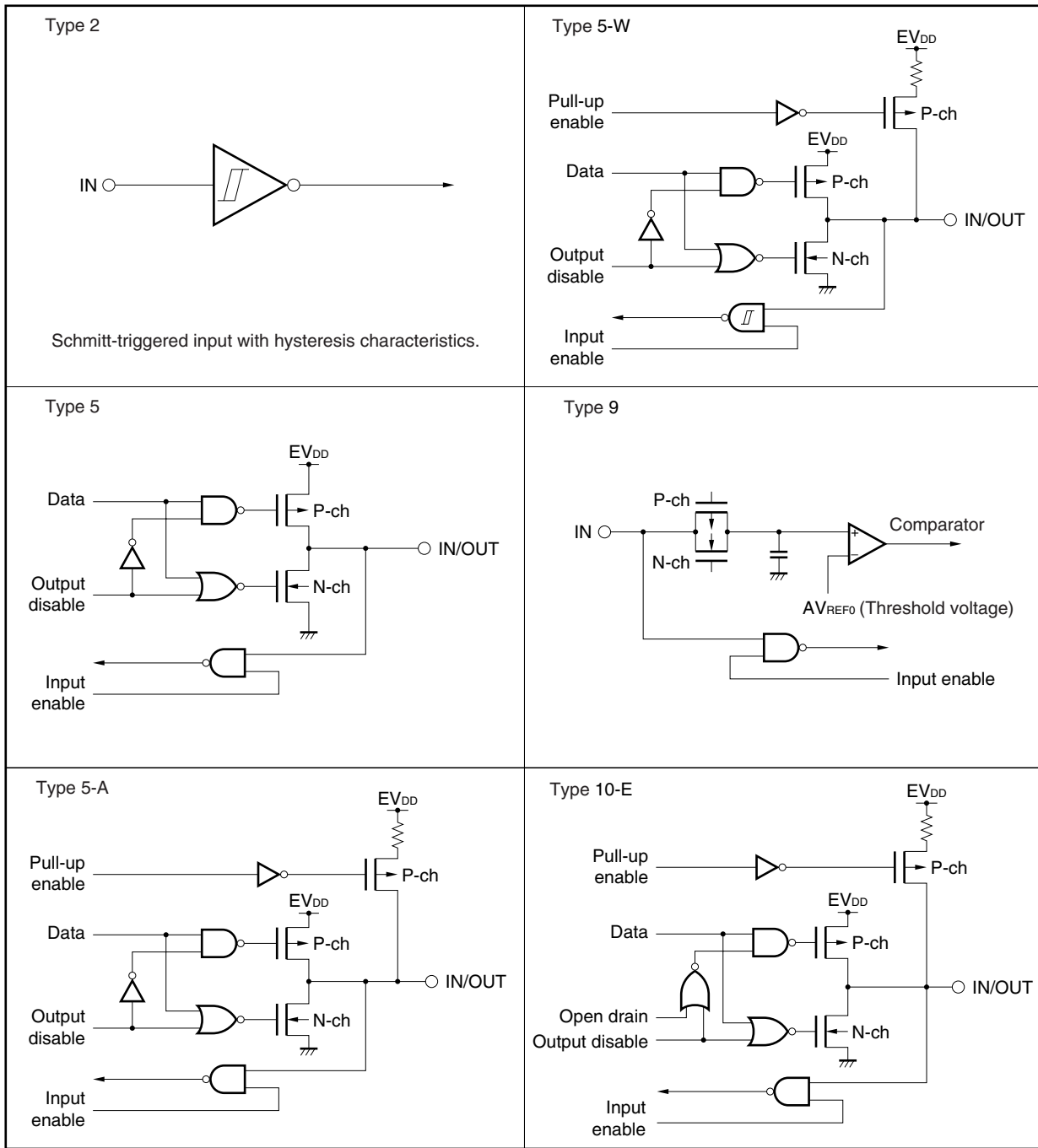
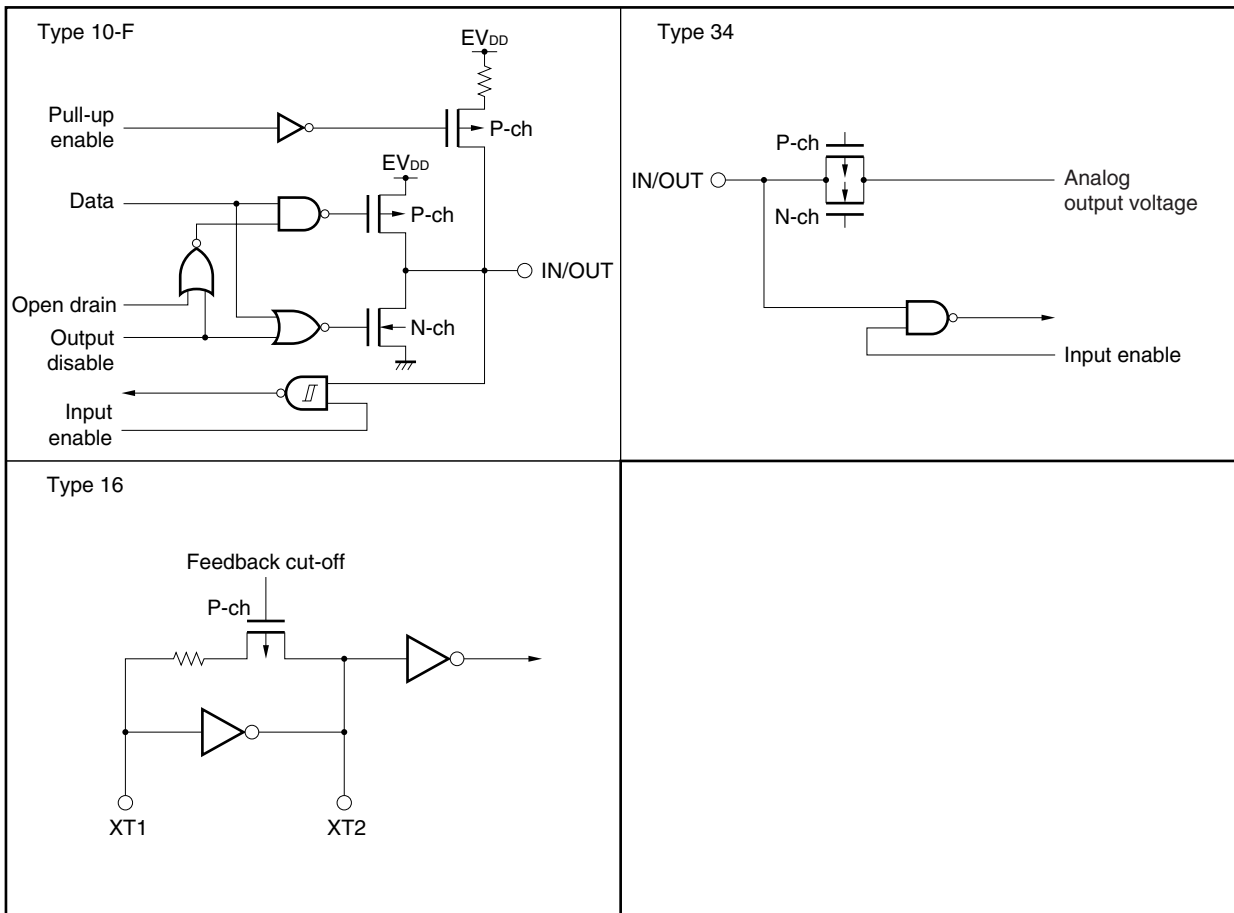


Figure 2-1. Pin I/O Circuits (2/2)



CHAPTER 3 CPU FUNCTION

The CPU of the V850ES/SA2 and V850ES/SA3 is based on RISC architecture and executes almost all instructions with one clock by using a 5-stage pipeline.

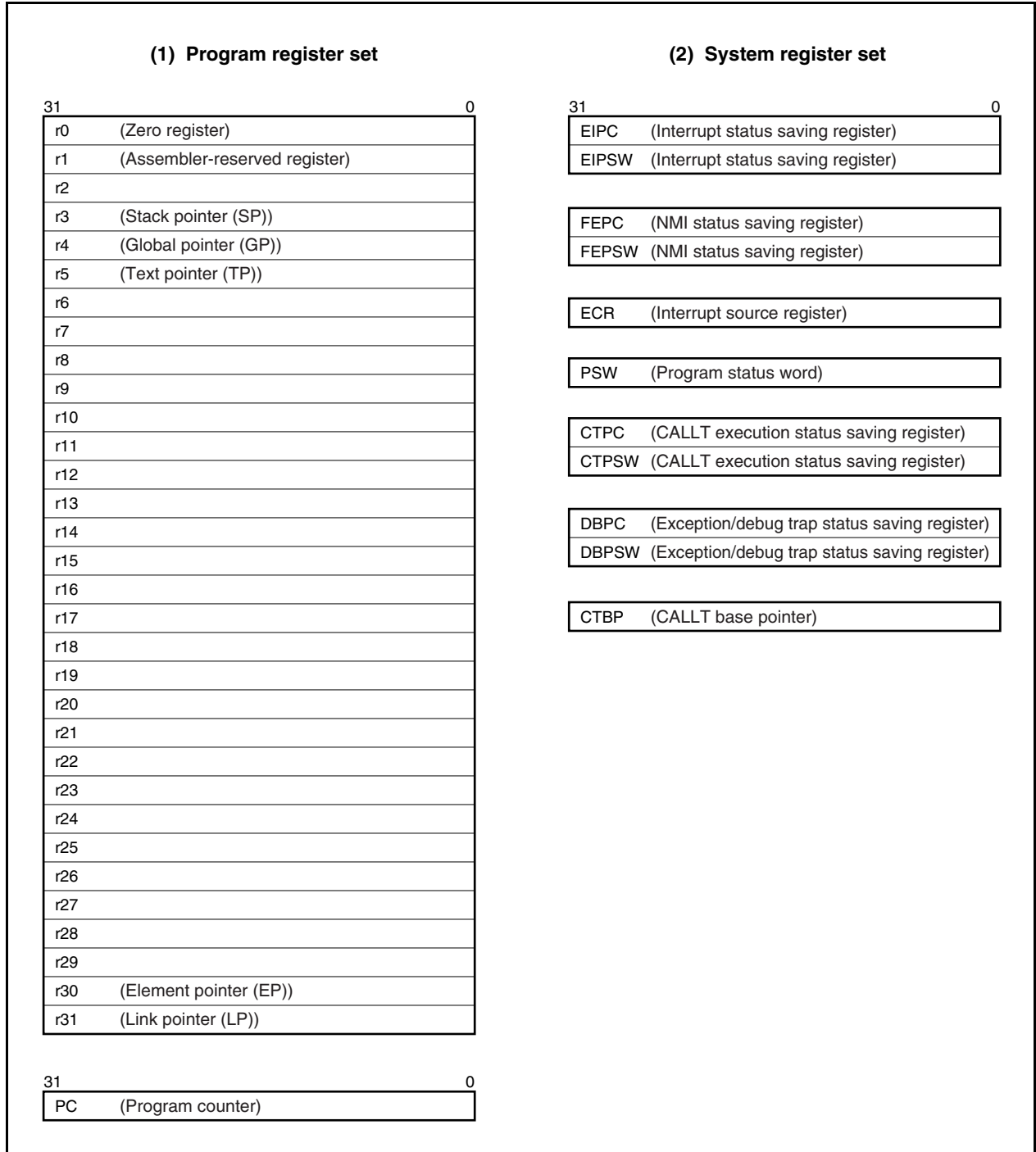
3.1 Features

- Minimum instruction execution time: 58.9 ns (at 17 MHz operation: 2.2 V to 2.7 V)
30.5 ns (with subclock ($f_{XT} = 32.768$ kHz operation))
- Memory space Program space: 64 MB linear
 Data space: 4 GB linear
 - Memory block division function: 2, 2, 4, 8 MB/total: 4 blocks
- General-purpose registers: 32 bits × 32 registers
- Internal 32-bit architecture
- 5-stage pipeline control
- Multiplication/division instruction
- Saturation operation instruction
- 32-bit shift instruction: 1 clock
- Load/store instruction with long/short format
- Four types of bit manipulation instructions
 - SET1
 - CLR1
 - NOT1
 - TST1

3.2 CPU Register Set

The registers of the V850ES/SA2 and V850ES/SA3 can be classified into two types: general-purpose program registers and dedicated system registers. All the registers are 32 bits wide.

For details, refer to the **V850ES Architecture User's Manual**.



3.2.1 Program register set

The program registers include general-purpose registers and a program counter.

(1) General-purpose registers (r0 to r31)

Thirty-two general-purpose registers, r0 to r31, are available. Any of these registers can be used to store a data variable or an address variable.

However, r0 and r30 are implicitly used by instructions and care must be exercised when these registers are used. r0 always holds 0 and is used for an operation that uses 0 or addressing of offset 0. r30 is used by the SLD and SST instructions as a base pointer when these instructions access the memory. r1, r3 to r5, and r31 are implicitly used by the assembler and C compiler. When using these registers, save their contents for protection, and then restore the contents after using the registers. r2 is sometimes used by the real-time OS. If the real-time OS does not use r2, it can be used as a register for variables.

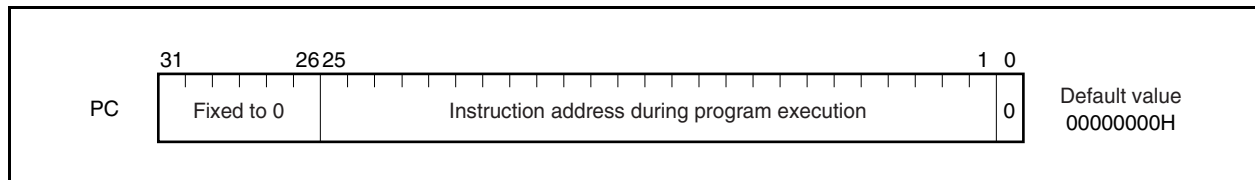
Table 3-1. Program Registers

Name	Usage	Operation
r0	Zero register	Always holds 0.
r1	Assembler-reserved register	Used as working register to create 32-bit immediate data
r2	Register for address/data variable (if real-time OS does not use r2)	
r3	Stack pointer	Used to create a stack frame when a function is called
r4	Global pointer	Used to access a global variable in the data area
r5	Text pointer	Used as register that indicates the beginning of a text area (area where program codes are located)
r6 to r29	Register for address/data variable	
r30	Element pointer	Used as base pointer to access memory
r31	Link pointer	Used when the compiler calls a function
PC	Program counter	Holds the instruction address during program execution

(2) Program counter (PC)

The program counter holds the instruction address during program execution. The lower 32 bits of this register are valid. Bits 31 to 26 are fixed to 0. A carry from bit 25 to 26 is ignored even if it occurs.

Bit 0 is fixed to 0. This means that execution cannot branch to an odd address.



3.2.2 System register set

The system registers control the status of the CPU and hold interrupt information.

These registers can be read or written by using system register load/store instructions (LDSR and STSR), using the system register numbers listed below.

Table 3-2. System Register Numbers

Register Number	System Register Name	Operand Specification	
		LDSR instruction	STSR instruction
0	Interrupt status saving register (EIPC) ^{Note 1}	√	√
1	Interrupt status saving register (EIPSW)	√	√
2	NMI status saving register (FEPC)	√	√
3	NMI status saving register (FEPSW)	√	√
4	Interrupt source register (ECR)	×	√
5	Program status word (PSW)	√	√
6 to 15	Reserved for future function expansion (operation is not guaranteed if these registers are accessed)	×	×
16	CALLT execution status saving register (CTPC)	√	√
17	CALLT execution status saving register (CTPSW)	√	√
18	Exception/debug trap status saving register (DBPC)	√ ^{Note 2}	√
19	Exception/debug trap status saving register (DBPSW)	√ ^{Note 2}	√
20	CALLT base pointer (CTBP)	√	√
21 to 31	Reserved for future function expansion (operation is not guaranteed if these registers are accessed)	×	×

Notes 1. Because only one set of this register is available, the contents of this register must be saved by program if multiple interrupts are enabled.

2. These registers can be accessed only when the DBTRAP instruction is executed.

Caution Even if EIPC or FEPC, or bit 0 of CTPC is set to 1 by the LDSR instruction, bit 0 is ignored when execution is returned to the main routine by the RETI instruction after interrupt servicing (this is because bit 0 of the PC is fixed to 0). Set an even value to EIPC, FEPC, and CTPC (bit 0 = 0).

Remark √: Can be accessed
×: Access prohibited

(1) Interrupt status saving registers (EIPC and EIPSW)

EIPC and EIPSW are used to save the status when an interrupt occurs.

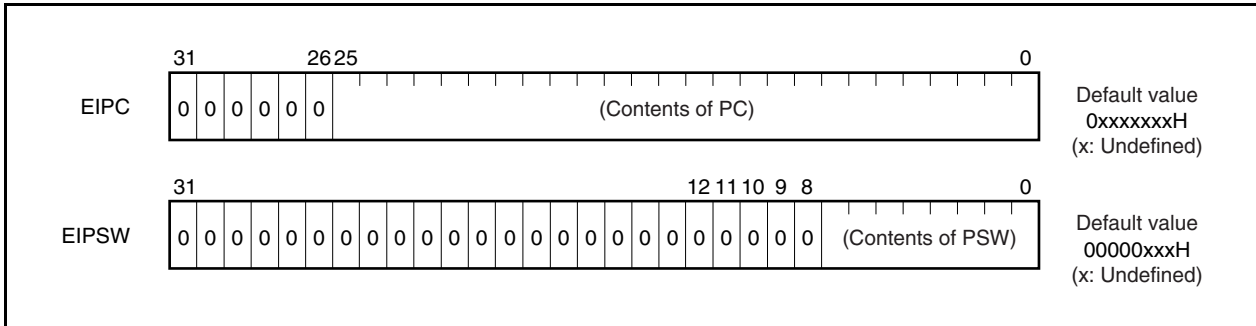
If a software exception or a maskable interrupt occurs, the contents of the program counter (PC) are saved to EIPC, and the contents of the program status word (PSW) are saved to EIPSW (these contents are saved to the NMI status saving registers (FEPC and FEPSW) if a non-maskable interrupt occurs).

The address of the instruction next to the one of the instruction under execution, except some instructions, is saved to EIPC when a software exception or a maskable interrupt occurs.

The current contents of the PSW are saved to EIPSW.

Because only one set of interrupt status saving registers is available, the contents of these registers must be saved by program when multiple interrupts are enabled.

Bits 31 to 26 of EIPC and bits 31 to 8 of EIPSW are reserved for future function expansion (these bits are always fixed to 0).



(2) NMI status saving registers (FEPC and FEPSW)

FEPC and FEPSW are used to save the status when a non-maskable interrupt (NMI) occurs.

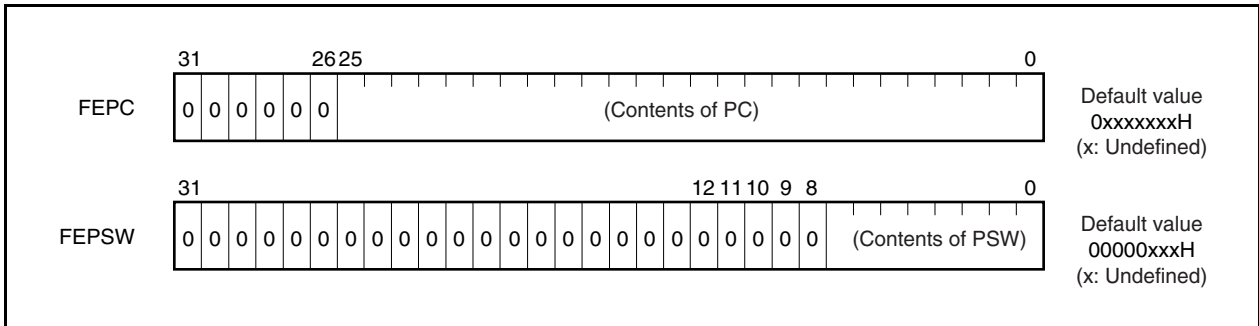
If an NMI occurs, the contents of the program counter (PC) are saved to FEPC, and those of the program status word (PSW) are saved to FEPSW.

The address of the instruction next to the one of the instruction under execution, except some instructions, is saved to FEPC when an NMI occurs.

The current contents of the PSW are saved to FEPSW.

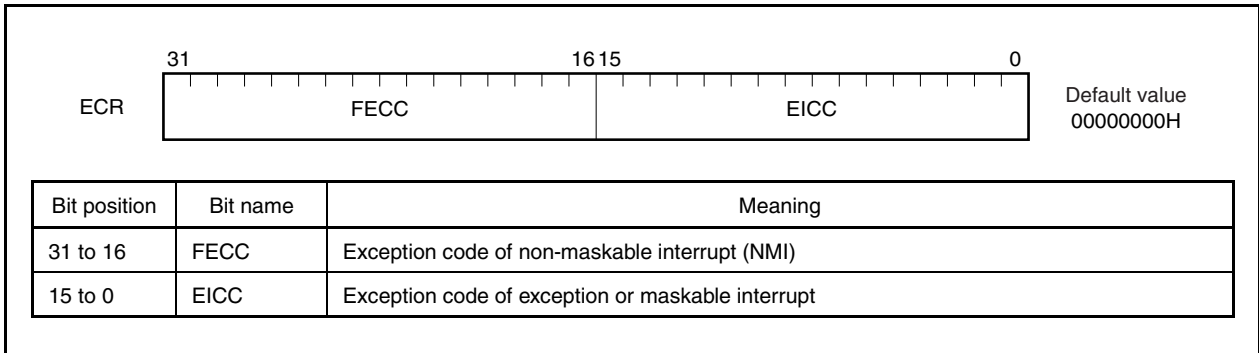
Because only one set of NMI status saving registers is available, the contents of these registers must be saved by program when multiple interrupts are enabled.

Bits 31 to 26 of FEPC and bits 31 to 8 of FEPSW are reserved for future function expansion (these bits are always fixed to 0).



(3) Interrupt source register (ECR)

The interrupt source register (ECR) holds the source of an exception or interrupt if an exception or interrupt occurs. This register holds the exception code of each interrupt source. Because this register is a read-only register, data cannot be written to this register using the LDSR instruction.



(4) Program status word (PSW)

The program status word (PSW) is a collection of flags that indicate the status of the program (result of instruction execution) and the status of the CPU.

If the contents of a bit of this register are changed by using the LDSR instruction, the new contents are validated immediately after completion of LDSR instruction execution. If the ID flag is set to 1, however, interrupt request acknowledgement is disabled even while the LDSR instruction is being executed.

Bits 31 to 8 of this register are reserved for future function expansion (these bits are fixed to 0).



Bit position	Flag name	Meaning
31 to 8	RFU	Reserved field. Fixed to 0.
7	NP	Indicates that a non-maskable interrupt (NMI) is being serviced. This bit is set to 1 when an NMI request is acknowledged, disabling multiple interrupts. 0: NMI is not being serviced. 1: NMI is being serviced.
6	EP	Indicates that an exception is being processed. This bit is set to 1 when an exception occurs. Even if this bit is set, interrupt requests are acknowledged. 0: Exception is not being processed. 1: Exception is being processed.
5	ID	Indicates whether a maskable interrupt can be acknowledged. 0: Interrupt enabled 1: Interrupt disabled
4	SAT ^{Note}	Indicates that the result of a saturation operation has overflowed and is saturated. Because this is a cumulative flag, it is set to 1 when the result of a saturation operation instruction is saturated, and is not cleared to 0 even if the subsequent operation result is not saturated. Use the LDSR instruction to clear this bit. This flag is neither set to 1 nor cleared to 0 by execution of an arithmetic operation instruction. 0: Not saturated 1: Saturated
3	CY	Indicates whether a carry or a borrow occurs as a result of an operation. 0: Carry or borrow does not occur. 1: Carry or borrow occurs.
2	OV ^{Note}	Indicates whether an overflow occurs during operation. 0: Overflow does not occur. 1: Overflow occurs.
1	S ^{Note}	Indicates whether the result of an operation is negative. 0: The result is positive or 0. 1: The result is negative.
0	Z	Indicates whether the result of an operation is 0. 0: The result is not 0. 1: The result is 0.

Remark Also read **Note** on the next page.

Note The result of the operation that has performed saturation processing is determined by the contents of the OV and S flags. The SAT flag is set to 1 only when the OV flag is set to 1 when a saturation operation is performed.

Status of Operation Result	Flag Status			Result of Operation of Saturation Processing
	SAT	OV	S	
Maximum positive value is exceeded.	1	1	0	7FFFFFFFH
Maximum negative value is exceeded.	1	1	1	80000000H
Positive (maximum value is not exceeded)	Holds value before operation	0	0	Operation result itself
Negative (maximum value is not exceeded)			1	

(5) CALLT execution status saving registers (CTPC and CTPSW)

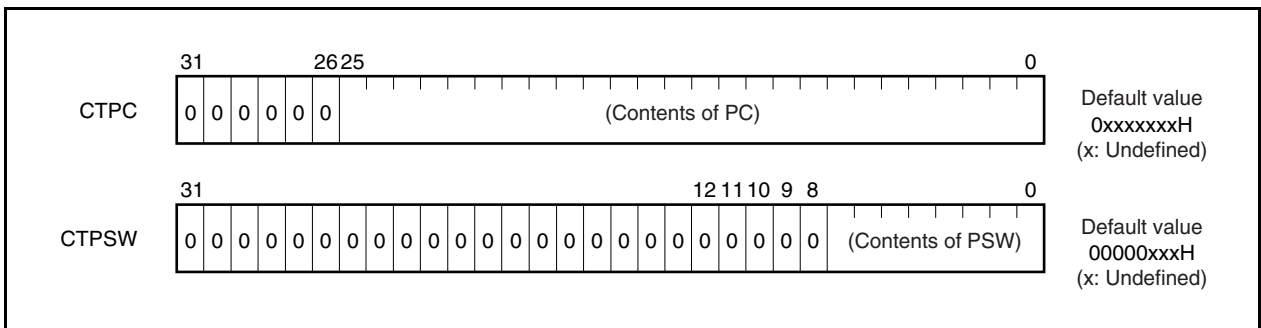
CTPC and CTPSW are CALLT execution status saving registers.

When the CALLT instruction is executed, the contents of the program counter (PC) are saved to CTPC, and those of the program status word (PSW) are saved to CTPSW.

The contents saved to CTPC are the address of the instruction next to CALLT.

The current contents of the PSW are saved to CTPSW.

Bits 31 to 26 of CTPC and bits 31 to 8 of CTPSW are reserved for future function expansion (fixed to 0).



(6) Exception/debug trap status saving registers (DBPC and DBPSW)

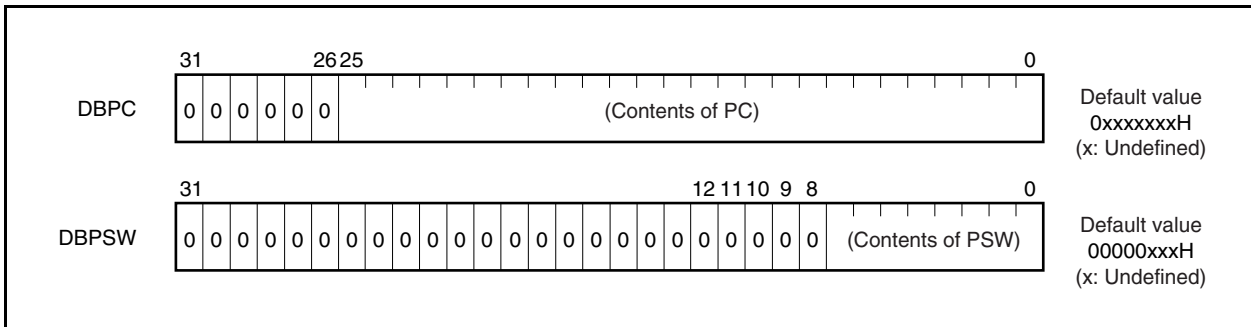
DBPC and DBPSW are exception/debug trap status registers.

If an exception trap or debug trap occurs, the contents of the program counter (PC) are saved to DBPC, and those of the program status word (PSW) are saved to DBPSW.

The contents to be saved to DBPC are the address of the instruction next to the one that is executed when an exception trap or debug trap occurs.

The current contents of the PSW are saved to DBPSW.

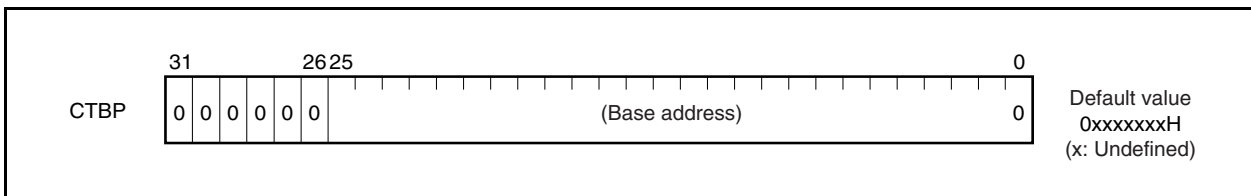
Bits 31 to 26 of DBPC and bits 31 to 8 of DBPSW are reserved for future function expansion (fixed to 0).



(7) CALLT base pointer (CTBP)

The CALLT base pointer (CTBP) is used to specify a table address or generate a target address (bit 0 is fixed to 0).

Bits 31 to 26 of this register are reserved for future function expansion (fixed to 0).



3.3 Operation Modes

3.3.1 Operation modes

The V850ES/SA2 and V850ES/SA3 have the following operation modes.

(1) Normal operation mode

In this mode, each pin related to the bus interface is set to the port mode after system reset has been released. Execution branches to the reset entry address of the internal ROM, and then instruction processing is started. By setting the PMCDH, PMCDL, PMCCM, PMCCS, and PMCCT registers to the control mode using instructions, an external device can be connected to the external memory area.

(2) Flash memory programming mode (μ PD70F3201, 70F3201Y, 70F3204, and 70F3204Y)

In this mode, the internal flash memory can be programmed by using a flash programmer.

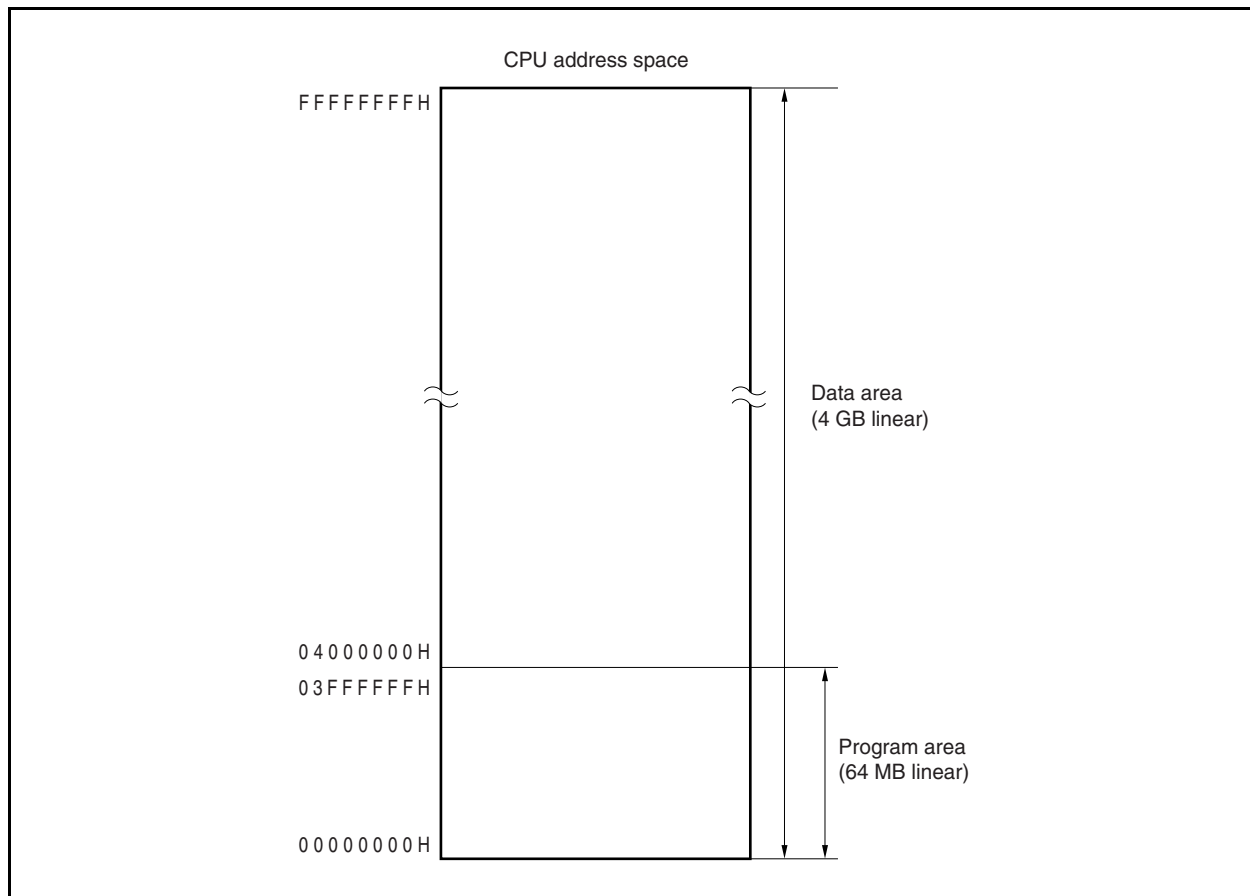
3.4 Address Space

3.4.1 CPU address space

The CPU of the V850ES/SA2 and V850ES/SA3 has 32-bit architecture and supports up to 4 GB of linear address space (data space) for operand addressing (data access). It also supports up to 64 MB of linear address space (program space) for instruction addressing. Note, however, that both the program and data spaces have areas that are prohibited from being used. For details, refer to **Figure 3-2**.

Figure 3-1 shows the CPU address space.

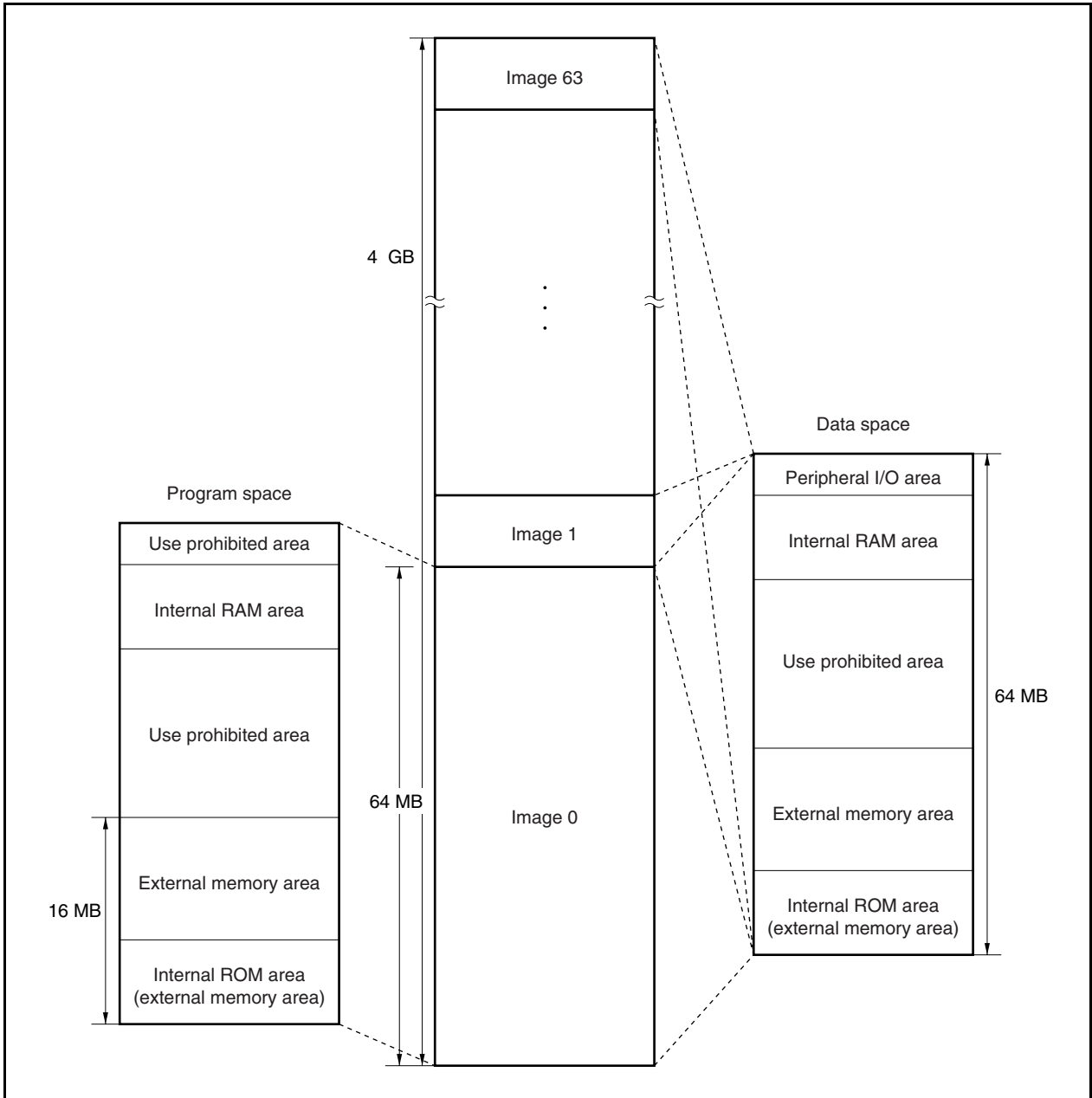
Figure 3-1. CPU Address Space



3.4.2 Image

For instruction addressing, up to 16 MB of linear address space (program space) and an internal RAM area are supported. Up to 4 GB of linear address space (data space) is supported for operand addressing (data access). In the 4 GB address space, it seems that there are sixty-four 64 MB physical address spaces. This means that the same 64 MB physical address space is accessed, regardless of the values of bits 31 to 26.

Figure 3-2. Image on Address Space

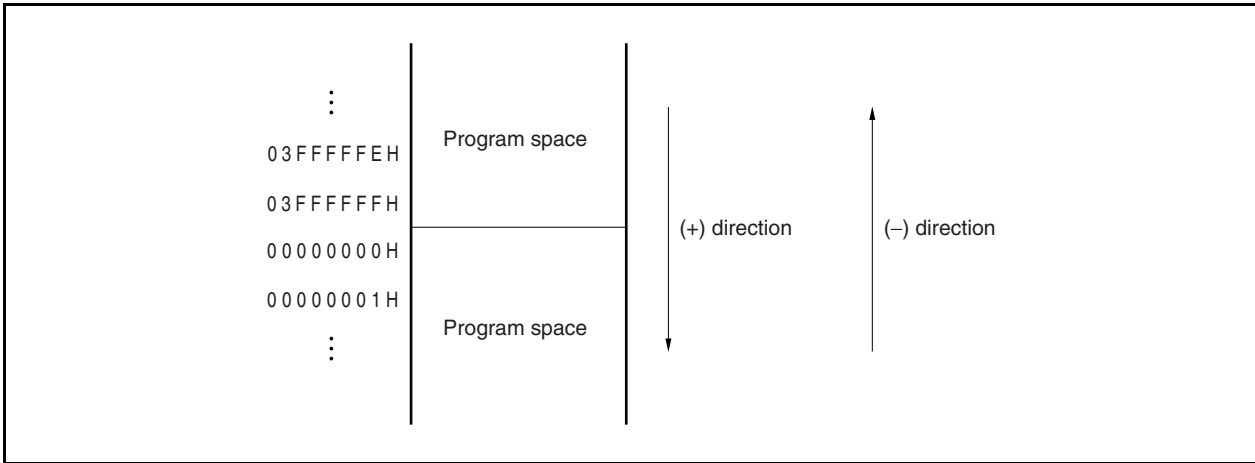


3.4.3 Wrap-around of CPU address space

(1) Program space

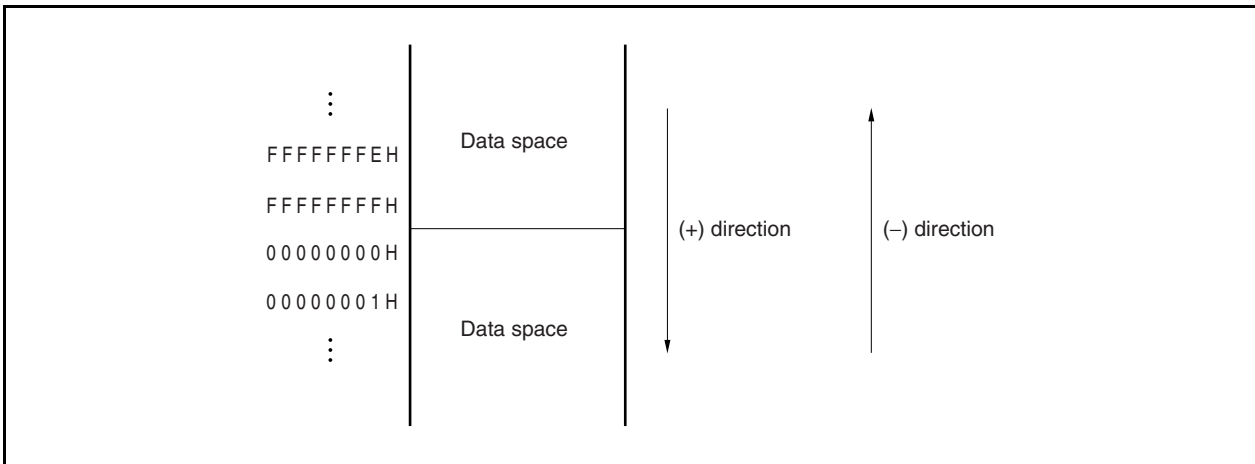
Of the 32 bits of the PC (program counter), the higher 6 bits are fixed to 0 and only the lower 26 bits are valid. The higher 6 bits ignore a carry or borrow from bit 25 to 26 during branch address calculation. Therefore, the lowest address of the program space, 00000000H, and the highest address, 03FFFFFFH, are contiguous addresses. That the lowest address and the highest address of the program space are contiguous in this way is called wrap-around.

Caution Because the 4 KB area of addresses 03FFF000H to 03FFFFFFH is a peripheral I/O area, instructions cannot be fetched from this area. Therefore, do not execute an operation in which the result of a branch address calculation affects this area.



(2) Data space

The result of an operand address calculation operation that exceeds 32 bits is ignored. Therefore, the lowest address of the data space, 00000000H, and the highest address, FFFFFFFFH, are contiguous, and wrap-around occurs at the boundary of these addresses.



3.4.4 Memory map

The V850ES/SA2 and V850ES/SA3 reserve the areas shown in Figure 3-3.

Figure 3-3. Data Memory Map (Physical Addresses)

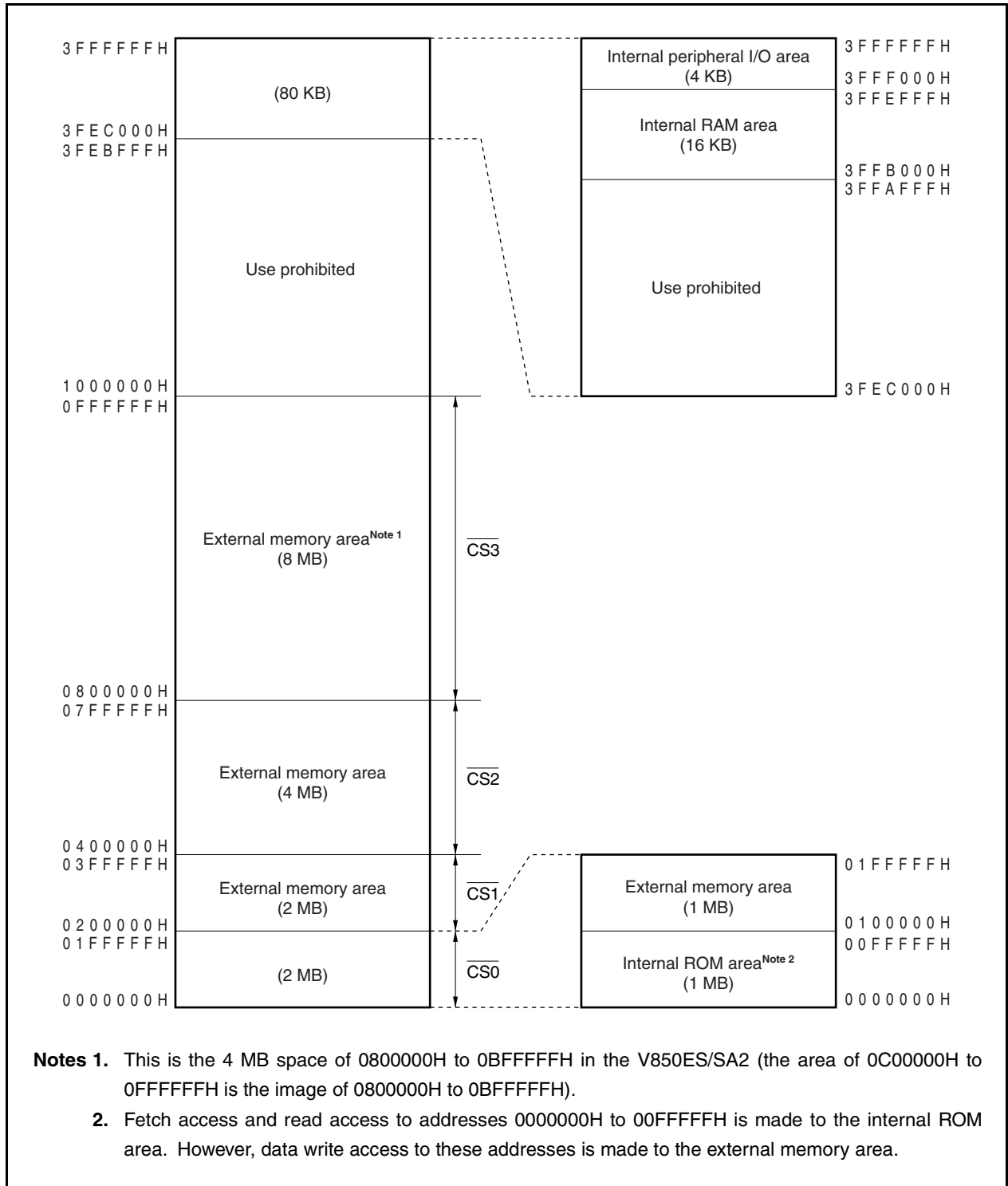
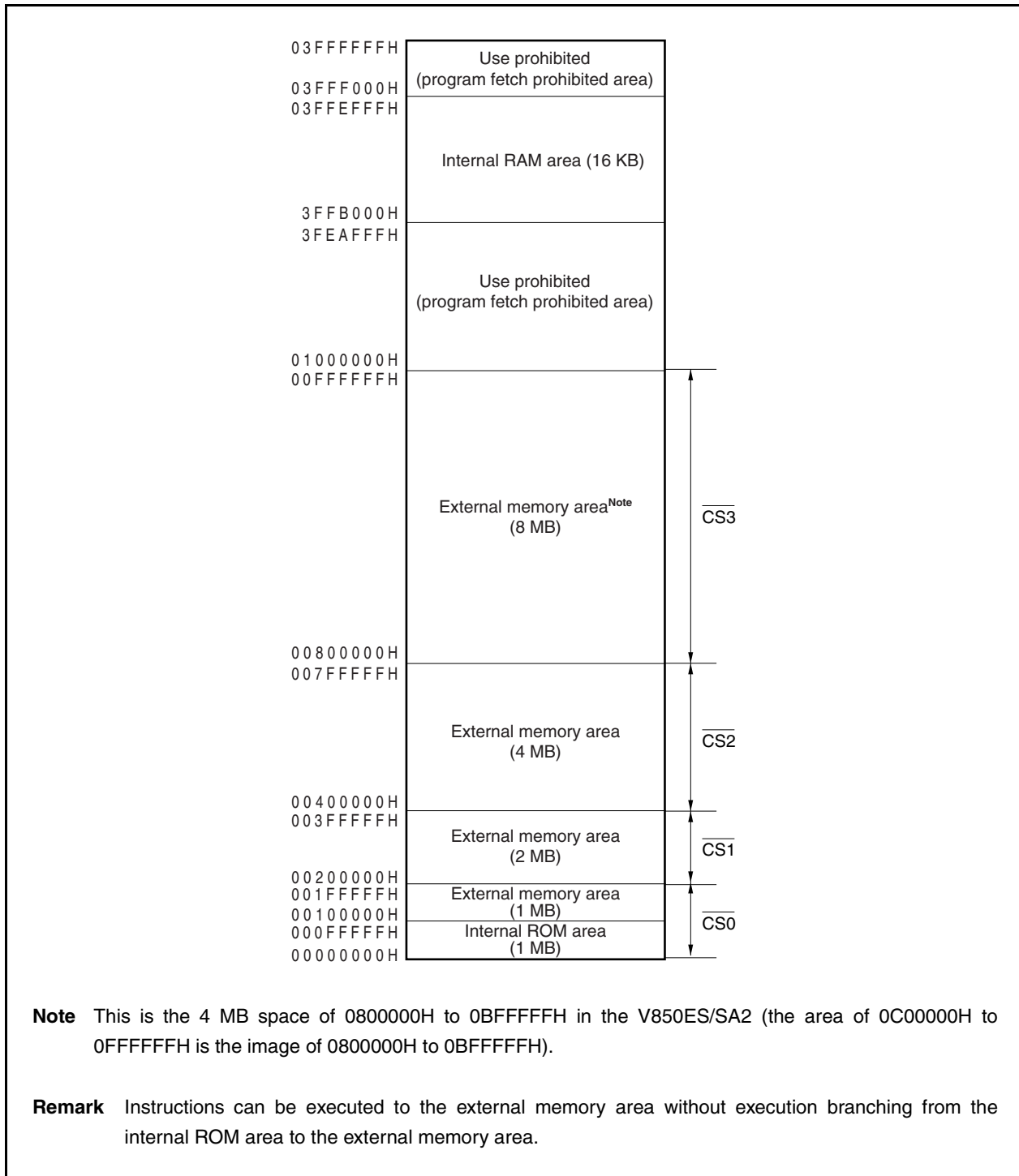


Figure 3-4. Program Memory Map



3.4.5 Areas

(1) Internal ROM area

(a) Memory map

1 MB of addresses 0000000H to 00FFFFFFH is reserved as the internal ROM area.

<1> **μPD703201, 703201Y, 703204, and 703204Y**

256 KB are mapped to the following addresses as the physical internal ROM (mask ROM).

- 000000H to 03FFFFH

<2> **μPD70F3201, 70F3201Y, 70F3204, and 70F3204Y**

256 KB are mapped to the following addresses as the physical internal ROM (flash memory).

- 000000H to 03FFFFH

- Interrupt/exception table

The V850ES/SA2 and V850ES/SA3 speed up the interrupt response time by fixing handler addresses corresponding to interrupts/exceptions.

A collection of these handler addresses is called an interrupt/exception table, which is mapped to the internal ROM area. When an interrupt/exception is acknowledged, execution jumps to a handler address and the program in the area starting from that address is executed. Table 3-3 shows the interrupt/exception sources and corresponding addresses.

Table 3-3. Interrupt/Exception Table

First Address of Interrupt/Exception Table	Interrupt/Exception Source	First Address of Interrupt/Exception Table	Interrupt/Exception Source
00000000H	RESET	00000190H	INTTM4
00000010H	NMI	000001A0H	INTTM5
00000040H	TRAP0n (n = 0 to F)	000001B0H	INTCSI0
00000050H	TRAP1n (n = 0 to F)	000001C0H	INTIIC ^{Note 1}
00000060H	ILGOP/DBG0	000001D0H	INTCSI1
00000080H	INTWDTM	000001E0H	INTSRE0
00000090H	INTP0	000001F0H	INTSR0
000000A0H	INTP1	00000200H	INTST0
000000B0H	INTP2	00000210H	INTCSI2
000000C0H	INTP3	00000220H	INTSRE1
000000D0H	INTP4	00000230H	INTSR1
000000E0H	INTP5	00000240H	INTST1
000000F0H	INTP6	00000250H	INTCSI3
00000100H	INTRTC	00000260H	INTCSI4 ^{Note 2}
00000110H	INTCC00	00000270H	INTAD
00000120H	INTCC01	00000280H	INTDMA0
00000130H	INTOVF0	00000290H	INTDMA1
00000140H	INTCC10	000002A0H	INTDMA2
00000150H	INTCC11	000002B0H	INTDMA3
00000160H	INTOVF1	000002C0H	INTROV
00000170H	INTTM2	000002D0H	INTBRG
00000180H	INTTM3	–	–

Notes 1. μ PD703201, 703204, 70F3201Y, and 70F3204Y only

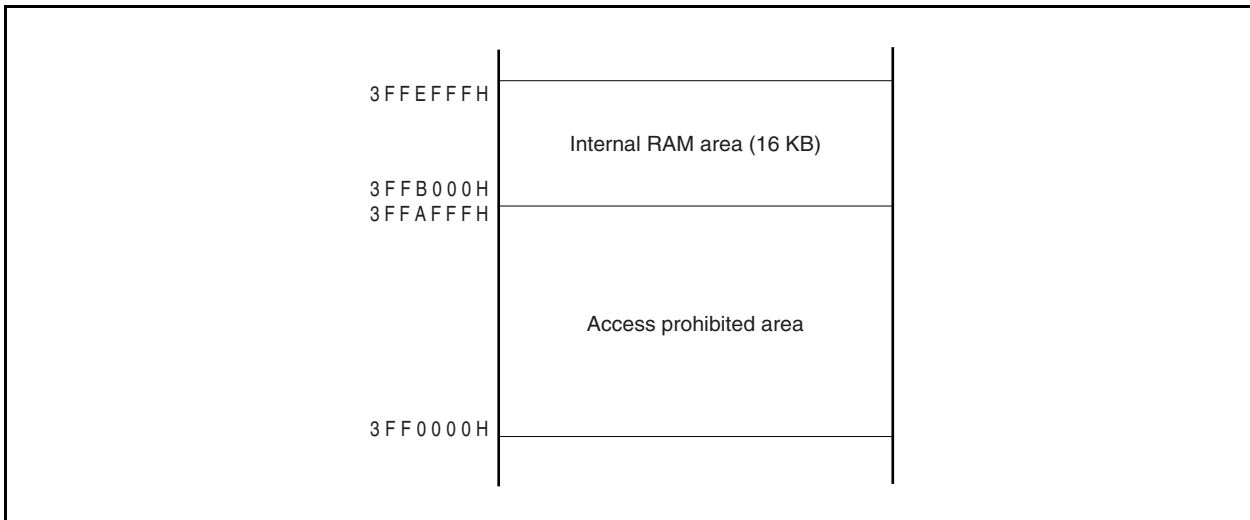
2. V850ES/SA3 only

(2) Internal RAM area

60 KB of addresses 3FF0000H to 3FFFFFFFFH are reserved as the internal RAM area.

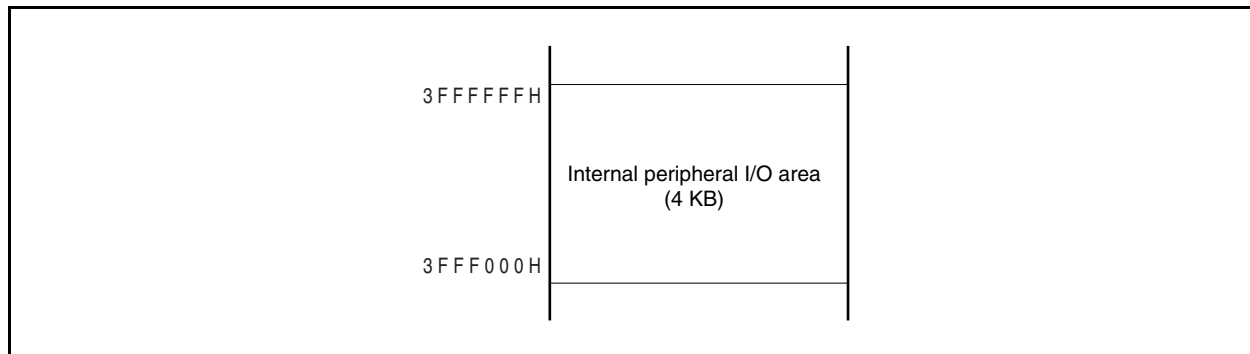
The V850ES/SA2 and V850ES/SA3 map 16 KB of addresses 3FFB000H to 3FFFFFFFFH as physical internal RAM.

Figure 3-5. Internal RAM Area (16 KB)



(3) Internal peripheral I/O area

4 KB of addresses 3FFF000H to 3FFFFFFH are allocated as the internal peripheral I/O area.

Figure 3-6. Internal Peripheral I/O Area

Peripheral I/O registers that have functions to specify the operation mode for and monitor the status of the internal peripheral I/O are mapped to the internal peripheral I/O area. Program cannot be fetched from this area.

- Cautions**
1. When a register is accessed in word units, a word area is accessed twice in halfword units in the order of lower area and higher area, with the lower 2 bits of the address ignored.
 2. If a register that can be accessed in byte units is accessed in halfword units, the higher 8 bits are undefined when the register is read, and data is written to the lower 8 bits.
 3. Addresses not defined as registers are reserved for future expansion. The operation is undefined and not guaranteed when these addresses are accessed.

(4) External memory area

15 MB (0100000H to 0FFFFFFH) are allocated as the external memory area. For details, refer to **CHAPTER 5 BUS CONTROL FUNCTION**.

3.4.6 Recommended use of address space

The architecture of the V850ES/SA2 and V850ES/SA3 requires that a register that serves as a pointer be secured for address generation when operand data in the data space is accessed. The address stored in this pointer ± 32 KB can be directly accessed by an instruction for operand data. Because the number of general-purpose registers that can be used as a pointer is limited, however, by keeping the performance from dropping during address calculation when a pointer value is changed, as many general-purpose registers as possible can be secured for variables, and the program size can be reduced.

(1) Program space

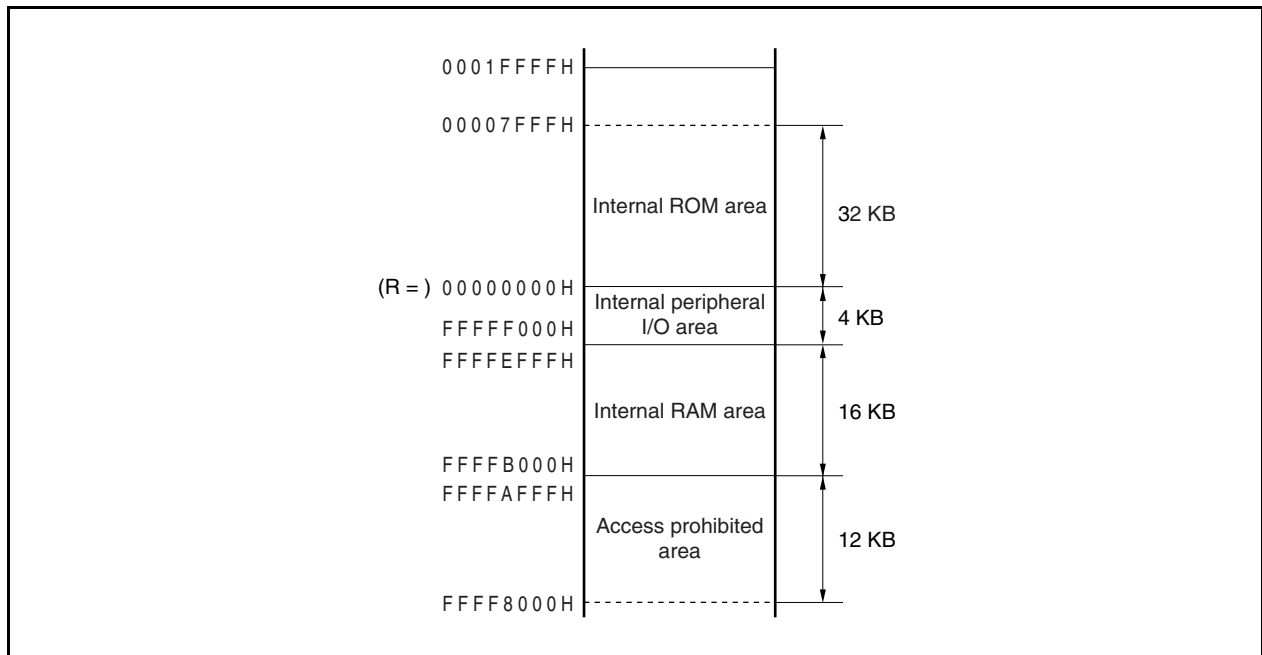
Of the 32 bits of the PC (program counter), the higher 6 bits are fixed to 0, and only the lower 26 bits are valid. Regarding the program space, therefore, a 64 MB space of contiguous addresses starting from 00000000H unconditionally corresponds to the memory map.

To use the internal RAM area as the program space, access addresses 3FFC000H to 3FFEFFFFH.

(2) Data space

With the V850ES/SA2 and V850ES/SA3, it seems that there are sixty-four 64 MB address spaces on the 4 GB CPU address space. Therefore, the least significant bit (bit 25) of a 26-bit address is sign-extended to 32 bits and allocated as an address.

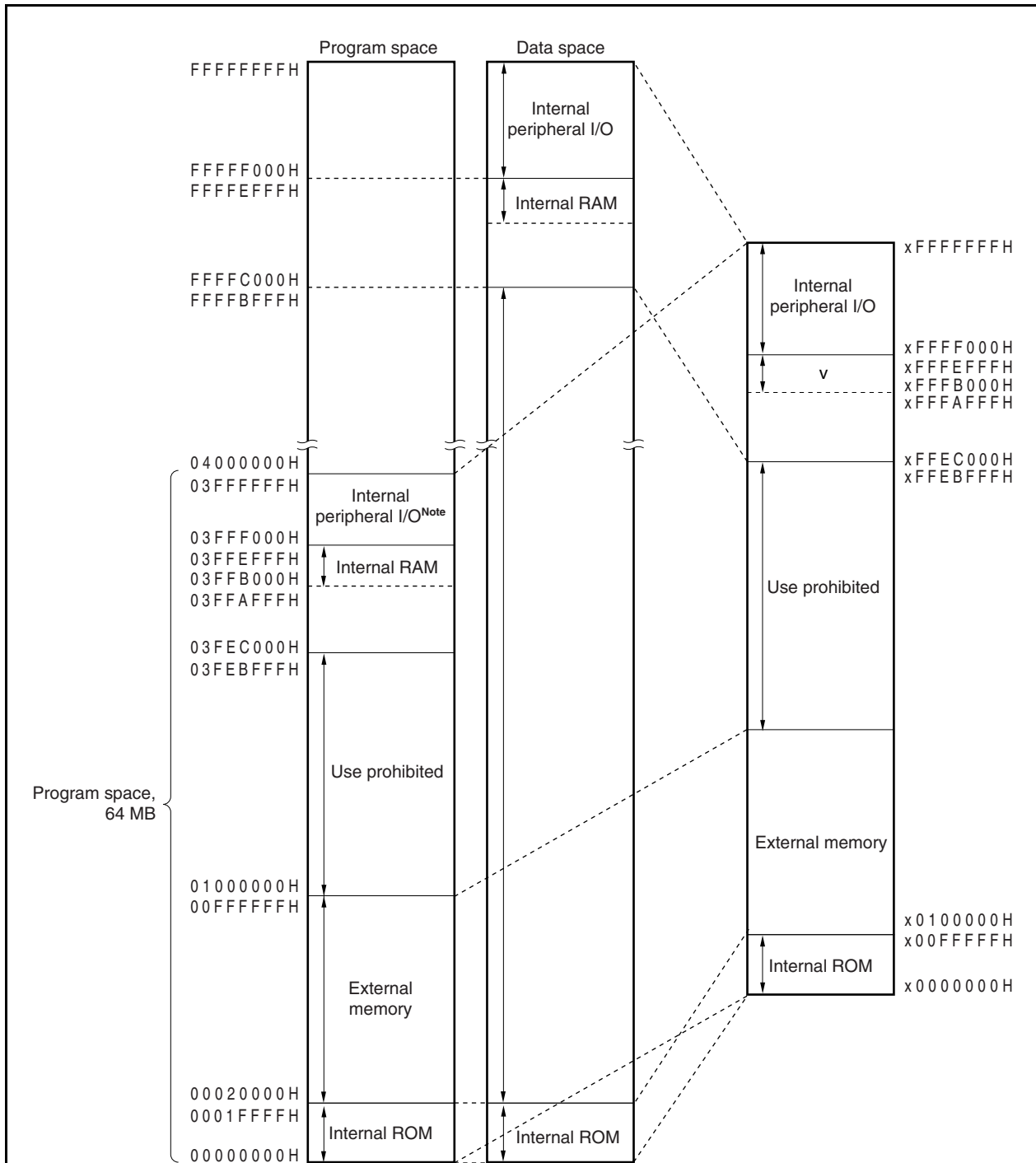
Example: An application example of wrap-around is shown below.



If R = r0 (zero register) is specified for the LD/ST disp16 [R] instruction, a range of addresses 00000000H ± 32 KB can be addressed by sign-extended disp16. All the resources, including the internal hardware, can be addressed by one pointer.

The zero register (r0) is a register fixed to 0 by hardware, and practically eliminates the need for registers dedicated to pointers.

Figure 3-7. Recommended Memory Map



Note Access to this area is prohibited. To access the internal I/O in this area, specify addresses FFFF000H to FFFFFFFH.

- Remarks**
1. ↓ indicates the recommended area.
 2. This figure is the recommended memory map of the μ PD703204.

3.4.7 Peripheral I/O registers

(1/8)

Address	Function Register Name	Symbol	R/W	Manipulatable Bits			Default Value	
				1	8	16		
FFFFF004H	Port DL	PDL	R/W			√	Undefined	
FFFFF004H	Port DLL	PDLL		√	√			
FFFFF005H	Port DLH	PDLH		√	√			
FFFFF006H	Port DH	PDH		√	√			
FFFFF008H	Port CS	PCS		√	√			
FFFFF00AH	Port CT	PCT		√	√			
FFFFF00CH	Port CM	PCM		√	√			
FFFFF00EH	Port CD ^{Note}	PCD		√	√			
FFFFF024H	Port mode register DL	PMDL				√		FFFFH
FFFFF024H	Port mode register DLL	PMDLL		√	√			FFH
FFFFF025H	Port mode register DLH	PMDLH		√	√			
FFFFF026H	Port mode register DH	PMDH		√	√			
FFFFF028H	Port mode register CS	PMCS		√	√			
FFFFF02AH	Port mode register CT	PMCT		√	√			
FFFFF02CH	Port mode register CM	PMCM	√	√				
FFFFF02EH	Port mode register CD ^{Note}	PMCD	√	√				
FFFFF044H	Port mode control register DL	PMCDL			√	0000H		
FFFFF044H	Port mode control register DLL	PMCDLL	√	√		00H		
FFFFF045H	Port mode control register DLH	PMCDLH	√	√				
FFFFF046H	Port mode control register DH	PMCDH	√	√				
FFFFF048H	Port mode control register CS	PMCCS	√	√				
FFFFF04AH	Port mode control register CT	PMCCCT	√	√				
FFFFF04CH	Port mode control register CM	PMCCM	√	√				
FFFFF066H	Bus size configuration register	BSC			√	5555H		
FFFFF06EH	System wait control register	VSWC		√		77H		
FFFFF080H	DMA source address register 0L	DSA0L			√	Undefined		
FFFFF082H	DMA source address register 0H	DSA0H			√			
FFFFF084H	DMA destination address register 0L	DDA0L			√			
FFFFF086H	DMA destination address register 0H	DDA0H			√			
FFFFF088H	DMA source address register 1L	DSA1L			√			
FFFFF08AH	DMA source address register 1H	DSA1H			√			
FFFFF08CH	DMA destination address register 1L	DDA1L			√			
FFFFF08EH	DMA destination address register 1H	DDA1H			√			
FFFFF090H	DMA source address register 2L	DSA2L			√			
FFFFF092H	DMA source address register 2H	DSA2H			√			
FFFFF094H	DMA destination address register 2L	DDA2L			√			
FFFFF096H	DMA destination address register 2H	DDA2H			√			
FFFFF098H	DMA source address register 3L	DSA3L			√			
FFFFF09AH	DMA source address register 3H	DSA3H			√			
FFFFF09CH	DMA destination address register 3L	DDA3L			√			
FFFFF09EH	DMA destination address register 3H	DDA3H			√			

Note V850ES/SA3 only

Address	Function Register Name	Symbol	R/W	Manipulatable Bits			Default Value
				1	8	16	
FFFFF0C0H	DMA transfer count register 0	DBC0	R/W			√	Undefined
FFFFF0C2H	DMA transfer count register 1	DBC1				√	
FFFFF0C4H	DMA transfer count register 2	DBC2				√	
FFFFF0C6H	DMA transfer count register 3	DBC3				√	
FFFFF0D0H	DMA addressing control register 0	DADC0			√	0000H	
FFFFF0D2H	DMA addressing control register 1	DADC1			√		
FFFFF0D4H	DMA addressing control register 2	DADC2			√		
FFFFF0D6H	DMA addressing control register 3	DADC3			√		
FFFFF0E0H	DMA channel control register 0	DCHC0		√	√		00H
FFFFF0E2H	DMA channel control register 1	DCHC1		√	√		
FFFFF0E4H	DMA channel control register 2	DCHC2		√	√		
FFFFF0E6H	DMA channel control register 3	DCHC3		√	√		
FFFFF100H	Interrupt mask register 0	IMR0				√	FFFFH
FFFFF100H	Interrupt mask register 0L	IMR0L		√	√		FFH
FFFFF101H	Interrupt mask register 0H	IMR0H		√	√		
FFFFF102H	Interrupt mask register 1	IMR1				√	FFFFH
FFFFF102H	Interrupt mask register 1L	IMR1L		√	√		FFH
FFFFF103H	Interrupt mask register 1H	IMR1H		√	√		
FFFFF104H	Interrupt mask register 2	IMR2				√	FFFFH
FFFFF104H	Interrupt mask register 2L	IMR2L		√	√		FFH
FFFFF105H	Interrupt mask register 2H	IMR2H		√	√		
FFFFF110H	Interrupt control register	WDTIC		√	√		47H
FFFFF112H	Interrupt control register	PIC0		√	√		
FFFFF114H	Interrupt control register	PIC1		√	√		
FFFFF116H	Interrupt control register	PIC2		√	√		
FFFFF118H	Interrupt control register	PIC3		√	√		
FFFFF11AH	Interrupt control register	PIC4		√	√		
FFFFF11CH	Interrupt control register	PIC5		√	√		
FFFFF11EH	Interrupt control register	PIC6		√	√		
FFFFF120H	Interrupt control register	RTCIC		√	√		
FFFFF122H	Interrupt control register	CCIC00		√	√		
FFFFF124H	Interrupt control register	CCIC01		√	√		
FFFFF126H	Interrupt control register	OVFIC0		√	√		
FFFFF128H	Interrupt control register	CCIC10		√	√		
FFFFF12AH	Interrupt control register	CCIC11		√	√		
FFFFF12CH	Interrupt control register	OVFIC1		√	√		
FFFFF12EH	Interrupt control register	TMIC2		√	√		
FFFFF130H	Interrupt control register	TMIC3		√	√		
FFFFF132H	Interrupt control register	TMIC4		√	√		
FFFFF134H	Interrupt control register	TMIC5		√	√		
FFFFF136H	Interrupt control register	CSIC0		√	√		
FFFFF138H	Interrupt control register ^{Note}	IICIC		√	√		

Note μ PD70F3201, 70F3204, 70F3201Y, and 70F3204Y only

Address	Function Register Name	Symbol	R/W	Manipulatable Bits			Default Value
				1	8	16	
FFFFF13AH	Interrupt control register	CSIIC1	R/W	√	√		47H
FFFFF13CH	Interrupt control register	SREIC0		√	√		
FFFFF13EH	Interrupt control register	SRIC0		√	√		
FFFFF140H	Interrupt control register	STIC0		√	√		
FFFFF142H	Interrupt control register	CSIIC2		√	√		
FFFFF144H	Interrupt control register	SREIC1		√	√		
FFFFF146H	Interrupt control register	SRIC1		√	√		
FFFFF148H	Interrupt control register	STIC1		√	√		
FFFFF14AH	Interrupt control register	CSIIC3		√	√		
FFFFF14CH	Interrupt control register ^{Note}	CSIIC4		√	√		
FFFFF14EH	Interrupt control register	ADIC		√	√		
FFFFF150H	Interrupt control register	DMAIC0		√	√		
FFFFF152H	Interrupt control register	DMAIC1		√	√		
FFFFF154H	Interrupt control register	DMAIC2		√	√		
FFFFF156H	Interrupt control register	DMAIC3		√	√		
FFFFF158H	Interrupt control register	ROVIC		√	√		
FFFFF15AH	Interrupt control register	BRGIC		√	√		
FFFFF1FAH	In-service priority register	ISPR	R	√	√		00H
FFFFF1FCH	Command register	PRCMD	W		√		Undefined
FFFFF1FEH	Power save control register	PSC	R/W	√	√		00H
FFFFF200H	A/D converter mode register	ADM		√	√		
FFFFF201H	Analog input channel specification register	ADS			√		
FFFFF202H	Power fail comparison mode register	PFM		√	√		
FFFFF203H	Power fail comparison threshold value register	PFT			√		
FFFFF204H	A/D conversion result register	ADCR	R			√	Undefined
FFFFF204H	A/D conversion result register L	ADCRL					
FFFFF205H	A/D conversion result register H	ADCRH			√		
FFFFF280H	D/A converter conversion value setting register 0	DACS0	R/W		√		00H
FFFFF282H	D/A converter conversion value setting register 1	DACS1			√		
FFFFF288H	D/A converter mode register	DAM		√	√		
FFFFF400H	Port 0	P0	R	√	√		Undefined
FFFFF204H	Port 2 ^{Note}	P2		√	√		
FFFFF206H	Port 3	P3		√	√		
FFFFF208H	Port 4	P4		√	√		
FFFFF20EH	Port 7	P7				√	
FFFFF20EH	Port 7L	P7L		√	√		
FFFFF20FH	Port 7H	P7H		√	√		
FFFFF410H	Port 8	P8	√	√			
FFFFF412H	Port 9	P9	R/W			√	
FFFFF412H	Port 9L	P9L		√	√		
FFFFF413H	Port 9H	P9H		√	√		

Note V850ES/SA3 only

Address	Function Register Name	Symbol	R/W	Manipulatable Bits			Default Value
				1	8	16	
FFFFF420H	Port mode register 0	PM0	R/W	√	√		FFH
FFFFF424H	Port mode register 2 ^{Note}	PM2		√	√		
FFFFF426H	Port mode register 3	PM3		√	√		
FFFFF428H	Port mode register 4	PM4		√	√		
FFFFF432H	Port mode register 9	PM9				√	FFFFH
FFFFF432H	Port mode register 9L	PM9L		√	√		FFH
FFFFF433H	Port mode register 9H	PM9H		√	√		
FFFFF440H	Port mode control register 0	PMC0		√	√		00H
FFFFF444H	Port mode control register 2 ^{Note}	PMC2		√	√		
FFFFF446H	Port mode control register 3	PMC3		√	√		
FFFFF448H	Port mode control register 4	PMC4		√	√		
FFFFF452H	Port mode control register 9	PMC9				√	0000H
FFFFF452H	Port mode control register 9L	PMC9L		√	√		00H
FFFFF453H	Port mode control register 9H	PMC9H		√	√		
FFFFF466H	Port function control register 3	PFC3		√	√		0000H
FFFFF468H	Port function control register 4	PFC4		√	√		
FFFFF472H	Port function control register 9	PFC9			√		
FFFFF472H	Port function control register 9L	PFC9L	√	√		00H	
FFFFF473H	Port function control register 9H	PFC9H	√	√			
FFFFF484H	Data wait control register 0	DWC0			√	7777H	
FFFFF488H	Address wait control register	AWC			√	FFFFH	
FFFFF48AH	Bus cycle control register	BCC			√	AAAAH	
FFFFF600H	Timer 0	TM0	R		√	0000H	
FFFFF602H	Capture/compare register 00	CC00	R/W		√		
FFFFF604H	Capture/compare register 01	CC01			√		
FFFFF606H	Timer control register 00	TMC00		√	√		00H
FFFFF608H	Timer control register 01	TMC01		√	√	20H	
FFFFF609H	Valid edge select register 0	SES0		√		00H	
FFFFF610H	Timer 1	TM1	R		√	0000H	
FFFFF612H	Capture/compare register 10	CC10	R/W		√		
FFFFF614H	Capture/compare register 11	CC11			√		
FFFFF616H	Timer control register 10	TMC10		√	√		00H
FFFFF618H	Timer control register 11	TMC11		√	√	20H	
FFFFF619H	Valid edge select register 1	SES1		√		00H	
FFFFF640H	Timer/counter 23	TM23	R		√	0000H	
FFFFF640H	Timer/counter 2	TM2			√	00H	
FFFFF641H	Timer/counter 3	TM3			√		
FFFFF642H	Compare register 23	CR23	R/W		√	0000H	
FFFFF642H	Compare register 2	CR2			√	00H	
FFFFF643H	Compare register 3	CR3			√		

Note V850ES/SA3 only

Address	Function Register Name	Symbol	R/W	Manipulatable Bits			Default Value
				1	8	16	
FFFFF644H	Timer clock select register 23	TCL23	R/W			√	0000H
FFFFF644H	Timer clock select register 2	TCL2			√		00H
FFFFF645H	Timer clock select register 3	TCL3			√		
FFFFF646H	Timer mode control register 23	TMC23	R/W			√	0000H
FFFFF646H	Timer mode control register 2	TMC2		√	√		00H
FFFFF647H	Timer mode control register 3	TMC3		√	√		
FFFFF650H	Timer counter 45	TM45	R			√	0000H
FFFFF650H	Timer counter 4	TM4			√		00H
FFFFF651H	Timer counter 5	TM5			√		
FFFFF652H	Compare register 45	CR45	R/W			√	0000H
FFFFF652H	Compare register 4	CR4			√		00H
FFFFF653H	Compare register 5	CR5			√		
FFFFF654H	Timer clock select register 45	TCL45	R/W			√	0000H
FFFFF654H	Timer clock select register 4	TCL4			√		00H
FFFFF655H	Timer clock select register 5	TCL5			√		
FFFFF656H	Timer mode control register 45	TMC45	R/W			√	0000H
FFFFF656H	Timer mode control register 4	TMC4		√	√		00H
FFFFF657H	Timer mode control register 5	TMC5		√	√		
FFFFF6C0H	Oscillation stabilization time selection register	OSTS	R/W		√		04H
FFFFF6C1H	Watchdog timer time selection register	WDCS			√		00H
FFFFF6C2H	Watchdog timer mode register	WDTM		√	√		
FFFFF6E0H	RTC operation control register	RTCC	R/W			√	808XH
FFFFF6E0H	RTC operation control register 0	RTCC0		√	√		80H
FFFFF6E1H	RTC operation control register 1	RTCC1		√	√		8XH
FFFFF6E2H	Sub-count register	SUBC	R			√	XXXXH
FFFFF6E2H	Sub-count register L	SUBCL			√		XXH
FFFFF6E3H	Sub-count register H	SUBCH			√		
FFFFF6E4H	Minute/second count register	SECMIN	R			√	XXXXH
FFFFF6E4H	Second count register	SEC			√		XXH
FFFFF6E5H	Minute count register	MIN			√		
FFFFF6E6H	Day/hour count register	HOURLDAY	R			√	0XXXH
FFFFF6E6H	Hour count register	HOUR			√		XXH
FFFFF6E7H	Day count register	DAY			√		0XH
FFFFF6E8H	Week count register	WEEK	R			√	0XXXH
FFFFF6E8H	Week count register L	WEEKL			√		XXH
FFFFF6E9H	Week count register H	WEEKH			√		0XH
FFFFF6EAH	Minute/second count setting register	SECMINB	W			√	0000H
FFFFF6EAH	Second count setting register	SECB			√		00H
FFFFF6EBH	Minute count setting register	MINB			√		
FFFFF6ECH	Day/hour count setting register	HOURLDAYB	W			√	0000H
FFFFF6ECH	Hour count setting register	HOURB			√		00H
FFFFF6EDH	Day count setting register	DAYB			√		

Address	Function Register Name	Symbol	R/W	Manipulatable Bits				Default Value
				1	8	16	32	
FFFFF6EEH	Week count setting register	WEEKB	W			√		0000H
FFFFF6EEH	Week count setting register L	WEEKBL			√			00H
FFFFF6EFH	Week count setting register H	WEEKBH			√			
FFFFF802H	System status register	SYS	R/W	√	√			
FFFFF804H	Backup power status register	BPS		√	√			Note
FFFFF810H	DMA trigger factor register 0	DTFR0		√	√			00H
FFFFF812H	DMA trigger factor register 1	DTFR1		√	√			
FFFFF814H	DMA trigger factor register 2	DTFR2		√	√			
FFFFF816H	DMA trigger factor register 3	DTFR3		√	√			
FFFFF820H	Power save mode register	PSMR		√	√			
FFFFF828H	Processor clock control register	PCC		√	√			03H
FFFFF840H	Correction address register 0	CORAD0					√	00000000H
FFFFF840H	Correction address register 0L	CORAD0L				√		0000H
FFFFF842H	Correction address register 0H	CORAD0H				√		
FFFFF844H	Correction address register 1	CORAD1					√	00000000H
FFFFF844H	Correction address register 1L	CORAD1L				√		0000H
FFFFF846H	Correction address register 1H	CORAD1H				√		
FFFFF848H	Correction address register 2	CORAD2					√	00000000H
FFFFF848H	Correction address register 2L	CORAD2L				√		0000H
FFFFF84AH	Correction address register 2H	CORAD2H				√		
FFFFF84CH	Correction address register 3	CORAD3					√	00000000H
FFFFF84CH	Correction address register 3L	CORAD3L				√		0000H
FFFFF84EH	Correction address register 3H	CORAD3H				√		
FFFFF880H	Correction control register	CORCN		√	√			00H
FFFFF8B0H	Prescaler mode register	PRSM			√			
FFFFF8B1H	Prescaler compare register	PRSCM			√			
FFFFFA00H	UART0 operation mode register	ASIM0	√	√			01H	
FFFFFA02H	Receive buffer register 0	RXB0	R		√		FFH	
FFFFFA03H	UART0 reception error status register	ASIS0			√		00H	
FFFFFA04H	Transmit buffer register 0	TXB0	R/W		√		FFH	
FFFFFA05H	UART0 transmit status register	ASIF0	R	√	√		00H	
FFFFFA06H	Clock select register 0	CKSR0	R/W		√			
FFFFFA07H	Baud rate generator compare register 0	BRGC0			√		FFH	
FFFFFA10H	UART1 operation mode register	ASIM1		√	√		01H	
FFFFFA12H	Receive buffer register 1	RXB1	R		√		FFH	
FFFFFA13H	UART1 reception error status register	ASIS1			√		00H	
FFFFFA14H	Transmit buffer register 1	TXB1	R/W		√		FFH	
FFFFFA15H	UART1 transmit status register	ASIF1	R	√	√		00H	
FFFFFA16H	Clock select register 1	CKSR1	R/W		√			
FFFFFA17H	Baud rate generator compare register 1	BRGC1			√		FFH	

Note Value on power application

Address	Function Register Name	Symbol	R/W	Manipulatable Bits			Default Value
				1	8	16	
FFFFFC00H	External interrupt falling edge specification register 0	INTF0	R/W	√	√		00H
FFFFFC12H	External interrupt falling edge specification register 9	INTF9				√	0000H
FFFFFC12H	External interrupt falling edge specification register 9L	INTF9L		√	√		00H
FFFFFC20H	External interrupt rising edge specification register 0	INTR0		√	√		
FFFFFC32H	External interrupt rising edge specification register 9	INTR9				√	0000H
FFFFFC32H	External interrupt rising edge specification register 9L	INTR9L		√	√		00H
FFFFFC40H	Pull-up resistor option register 0	PU0		√	√		
FFFFFC44H	Pull-up resistor option register 2 ^{Note}	PU2		√	√		
FFFFFC46H	Pull-up resistor option register 3	PU3		√	√		
FFFFFC48H	Pull-up resistor option register 4	PU4		√	√		
FFFFFC52H	Pull-up resistor option register 9	PU9				√	0000H
FFFFFC52H	Pull-up resistor option register 9L	PU9L		√	√		00H
FFFFFC53H	Pull-up resistor option register 9H	PU9H		√	√		
FFFFFC64H	Port function register 2 ^{Note}	PF2		√	√		
FFFFFC66H	Port function register 3	PF3		√	√		
FFFFFC68H	Port function register 4	PF4		√	√		
FFFFFC72H	Port function register 9	PF9			√	0000H	
FFFFFC73H	Port function register 9H	PF9H	√	√		00H	
FFFFFD00H	Clocked serial interface mode register 0	CSIM0	√	√			
FFFFFD01H	Clocked serial interface clock selection register 0	CSIC0		√			
FFFFFD02H	Serial I/O shift register 0	SIO0	R		√		
FFFFFD03H	Reception-only serial I/O shift register 0	SIOE0			√		
FFFFFD04H	Clocked serial interface transmit buffer register 0	SOTB0	R/W		√		
FFFFFD10H	Clocked serial interface mode register 1	CSIM1		√	√		
FFFFFD11H	Clocked serial interface clock selection register 1	CSIC1			√		
FFFFFD12H	Serial I/O shift register 1	SIO1	R		√		
FFFFFD13H	Reception-only serial I/O shift register 1	SIOE1			√		
FFFFFD14H	Clocked serial interface transmit buffer register 1	SOTB1	R/W		√		
FFFFFD20H	Clocked serial interface mode register 2	CSIM2		√	√		
FFFFFD21H	Clocked serial interface clock selection register 2	CSIC2			√		
FFFFFD22H	Serial I/O shift register 2	SIO2	R		√		
FFFFFD23H	Reception-only serial I/O shift register 2	SIOE2			√		
FFFFFD24H	Clocked serial interface transmit buffer register 2	SOTB2	R/W		√		
FFFFFD30H	Clocked serial interface mode register 3	CSIM3		√	√		
FFFFFD31H	Clocked serial interface clock selection register 3	CSIC3			√		
FFFFFD32H	Serial I/O shift register 3	SIO3	R		√		
FFFFFD33H	Reception-only serial I/O shift register 3	SIOE3			√		
FFFFFD34H	Clocked serial interface transmit buffer register 3	SOTB3	R/W		√		
FFFFFD40H	Clocked serial interface mode register 4 ^{Note}	CSIM4		√	√		
FFFFFD41H	Clocked serial interface clock selection register 4 ^{Note}	CSIC4			√		
FFFFFD42H	Serial I/O shift register 4 ^{Note}	SIO4	R		√		
FFFFFD43H	Reception-only serial I/O shift register 4 ^{Note}	SIOE4			√		

Note V850ES/SA3 only

Address	Function Register Name	Symbol	R/W	Manipulatable Bits			Default Value
				1	8	16	
FFFFD44H	Clocked serial interface transmit buffer register 4 ^{Note 1}	SOTB4	R/W		√		00H
FFFFD80H	IIC shift register ^{Note 2}	IIC			√		
FFFFD82H	IIC control register ^{Note 2}	IICC		√	√		
FFFFD83H	Slave address register ^{Note 2}	SVA			√		
FFFFD84H	IIC clock select register ^{Note 2}	IICCL		√	√		
FFFFD85H	IIC function expansion register ^{Note 2}	IICX		√	√		
FFFFD86H	IIC status register ^{Note 2}	IICS	R	√	√		
FFFF4BEH	External interface mode control register	EXIMC	R/W	√	√		

Notes 1. V850ES/SA3 only

2. μ PD70F3201, 70F3204, 70F3201Y, and 70F3204Y only

3.4.8 Special registers

Special registers are registers that are protected from being written with illegal data due to a program hang-up. The V850ES/SA2 and V850ES/SA3 have the following four special registers.

- Power save control register (PSC)
- Processor clock control register (PCC)
- Watchdog timer mode register (WDTM)
- Backup power status register (BPS)

In addition, a command register (PRCMD) is provided to protect against a write access to the special registers so that the application system does not inadvertently stop due to a program hang-up. A write access to the special registers is made in a specific sequence, and an illegal store operation is reported to the system status register (SYS).

(1) Setting data to special registers

Set data to the special registers in the following sequence:

- <1> Disable DMA operation.
- <2> Prepare data to be set to the special register in a general-purpose register.
- <3> Write the data prepared in <2> to the command register (PRCMD).
- <3> Write the setting data to the special register (by using the following instructions).
 - Store instruction (ST/SST instruction)
 - Bit manipulation instruction (SET1/CLR1/NOT1 instruction)
- <5> to <9> Insert NOP instructions (5 instructions).
- <10> Enable DMA operation if necessary.

[Example] With PSC register

```

    ST.Br11, PSMR[r0] ; Set PSMR register.
<1>CLR10, DCHCn[r0] ; Disable DMA operation. n = 0 to 3
<2>MOV0x02, r10
<3>ST.Br10, PRCMD[r0] ; Write PRCMD register.
<4>ST.Br10, PSC[r0] ; Set PSC register.
<5>NOP ; Dummy instruction
<6>NOP ; Dummy instruction
<7>NOP ; Dummy instruction
<8>NOP ; Dummy instruction
<9>NOP ; Dummy instruction
<10>SET10, DCHCn[r0] ; Enable DMA operation. n = 0 to 3
(next instruction)

```

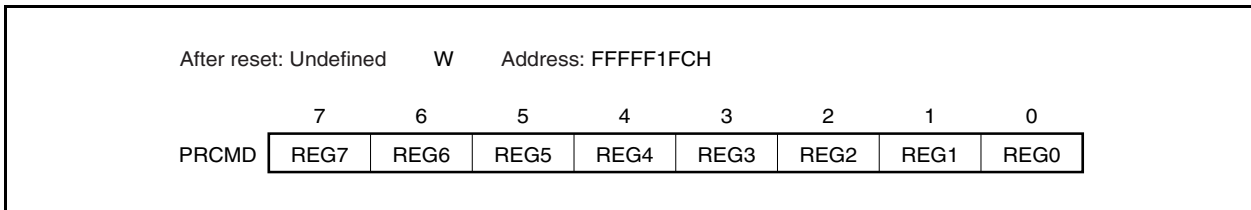
There is no special sequence to read a special register.

- Cautions**
1. When a store instruction is executed to store data in the command register, an interrupt is not acknowledged. This is because it is assumed that steps <3> and <4> above are performed by successive store instructions. If another instruction is placed between <3> and <4>, and if an interrupt is acknowledged by that instruction, the above sequence may not be established, causing malfunction.
 2. Although dummy data is written to the PRCMD register, use the same general-purpose register used to set the special register (<4> in Example) to write data to the PRCMD register (<3> in Example). The same applies when a general-purpose register is used for addressing.
 3. Five NOP instructions or more must be inserted immediately after setting the IDLE mode or software STOP mode (by setting the STP bit of the PSC register to 1).

(2) Command register (PRCMD)

The command register (PRCMD) is an 8-bit register that protects the registers that may seriously affect the application system from being written, so that the system does not inadvertently stop due to a program hang-up. The first write access to a special register (power save control register (PSC)) is valid after data has been written in advance to the PRCMD register. In this way, the value of the special register can be rewritten only in a specific sequence, so as to protect the register from an illegal write access.

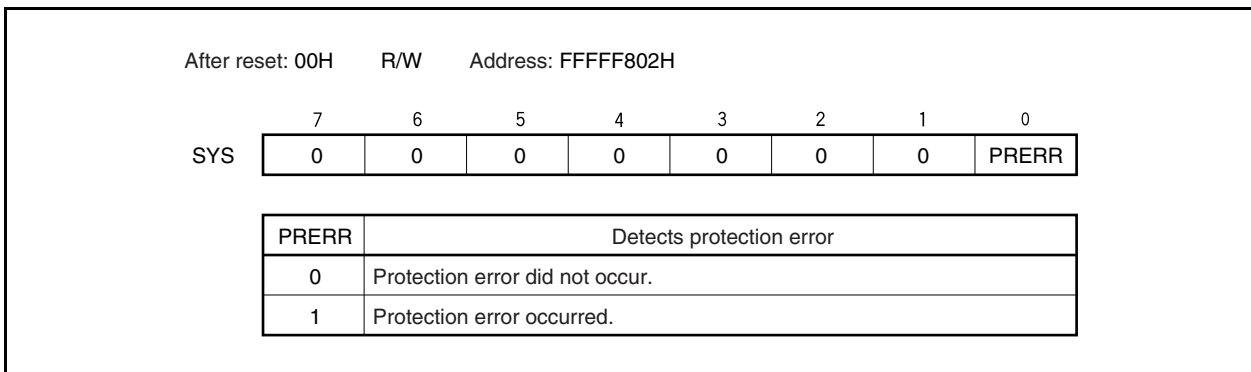
The PRCMD register is write-only, in 8-bit units (undefined data is read when this register is read).



(3) System status register (SYS)

Status flags that indicate the operation status of the overall system are allocated to this register.

This register can be read or written in 8-bit or 1-bit units.



The PRERR flag operates under the following conditions.

(a) Set condition (PRERR = 1)

- (i) When data is written to a special register without writing anything to the PRCMD register (when <4> is executed without executing <3> in **3.4.8 (1) Setting special register**)
- (ii) When data is written to a peripheral I/O register other than a special register (including execution of a bit manipulation instruction) after writing data to the PRCMD register (if <4> in **3.4.8 (1) Setting special register** is not the setting of a special register)

Remark Even if a peripheral I/O register is read (including execution of a bit manipulation instruction) between a write access to the PRCMD register and a write access to a special register other than the WDTM register (PCC, PSC, and BPS registers) (such as an access to the internal RAM), the PRERR flag is not set and data can be written to the special register.

(b) Clear condition (PRERR = 0)

- (i) When 0 is written to the PRERR flag of the SYS register
- (ii) When the system is reset

Cautions 1. If 0 is written to the PRERR bit of the SYS register, which is not a special register, immediately after a write access to the PRCMD register, the PRERR bit is cleared to 0 (the write access takes precedence).

2. If data is written to the PRCMD register, which is not a special register, immediately after a write access to the PRCMD register, the PRERR bit is set to 1.

3.4.9 Notes

Be sure to set the following register first when using the V850ES/SA2 and V850ES/SA3:

- System wait control register (VSWC)

After setting the VSWC register, set the other registers as necessary.

When using the external bus, initialize each register in the following order after setting the above register.

<1> Set each pin to the control mode by using the port-related registers.

(1) System wait control register (VSWC)

The system wait control register (VSWC) controls wait of bus access to the internal peripheral I/O registers.

Three clocks are required to access an internal peripheral I/O register (without a wait cycle). The V850ES/SA2 and V850ES/SA3 require wait cycles according to the operating frequency. Set the following value to the VSWC register in accordance with the frequency used.

The VSWC register can be read or written in 8-bit units (address: FFFFF06EH, default value: 77H).

Operating Frequency (f_{CLK})	Set Value of VSWC
$2 \text{ MHz} \leq f_{CLK} < 16.6 \text{ MHz}$	00H
$16.6 \text{ MHz} \leq f_{CLK} < 17 \text{ MHz}$	01H

CHAPTER 4 PORT FUNCTIONS

4.1 Features

4.1.1 V850ES/SA2

- Input ports: 14 pins
- I/O ports: 68 pins
- I/O pins function alternately as other peripheral functions
- Can be set to input or output mode in 1-bit units.

4.1.2 V850ES/SA3

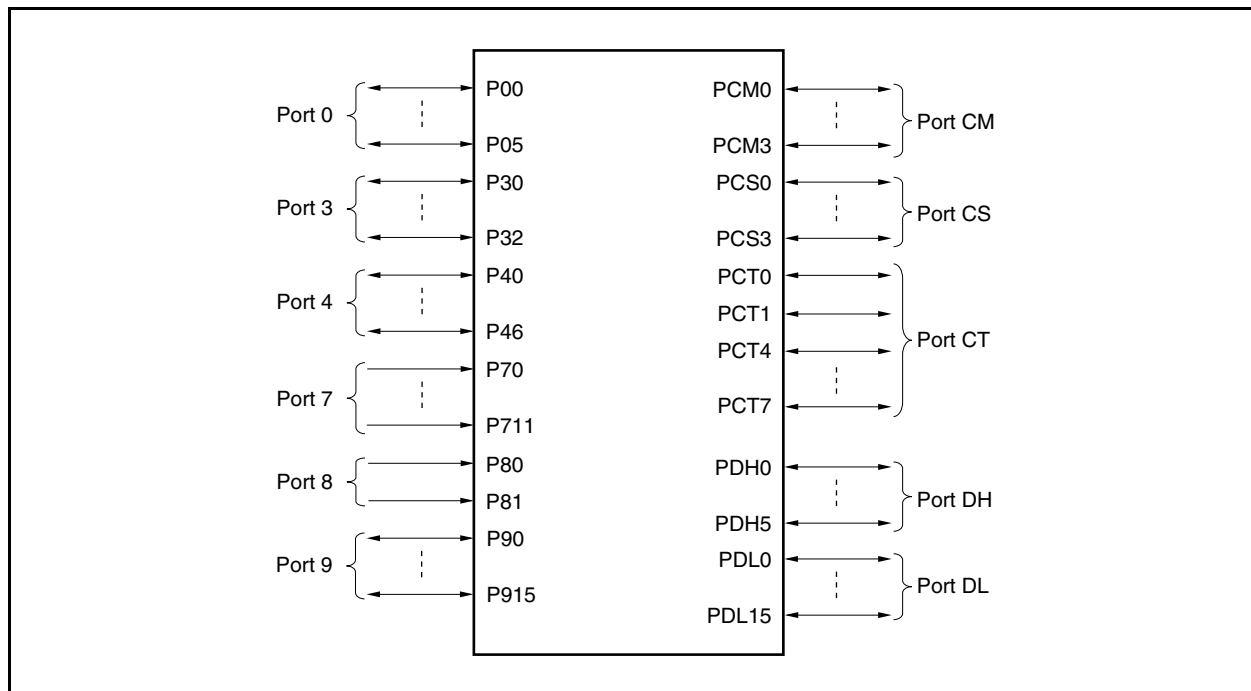
- Input ports: 18 pins
- I/O ports: 84 pins
- I/O pins function alternately as other peripheral functions
- Can be set to input or output mode in 1-bit units.

4.2 Basic Configuration of Port

4.2.1 V850ES/SA2

The V850ES/SA2 has a total of 82 input/output port pins (of which 14 are input-only port pins): ports 0, 3, 4, 7 to 9, CM, CS, CT, DH, and DL. The port configuration is shown below.

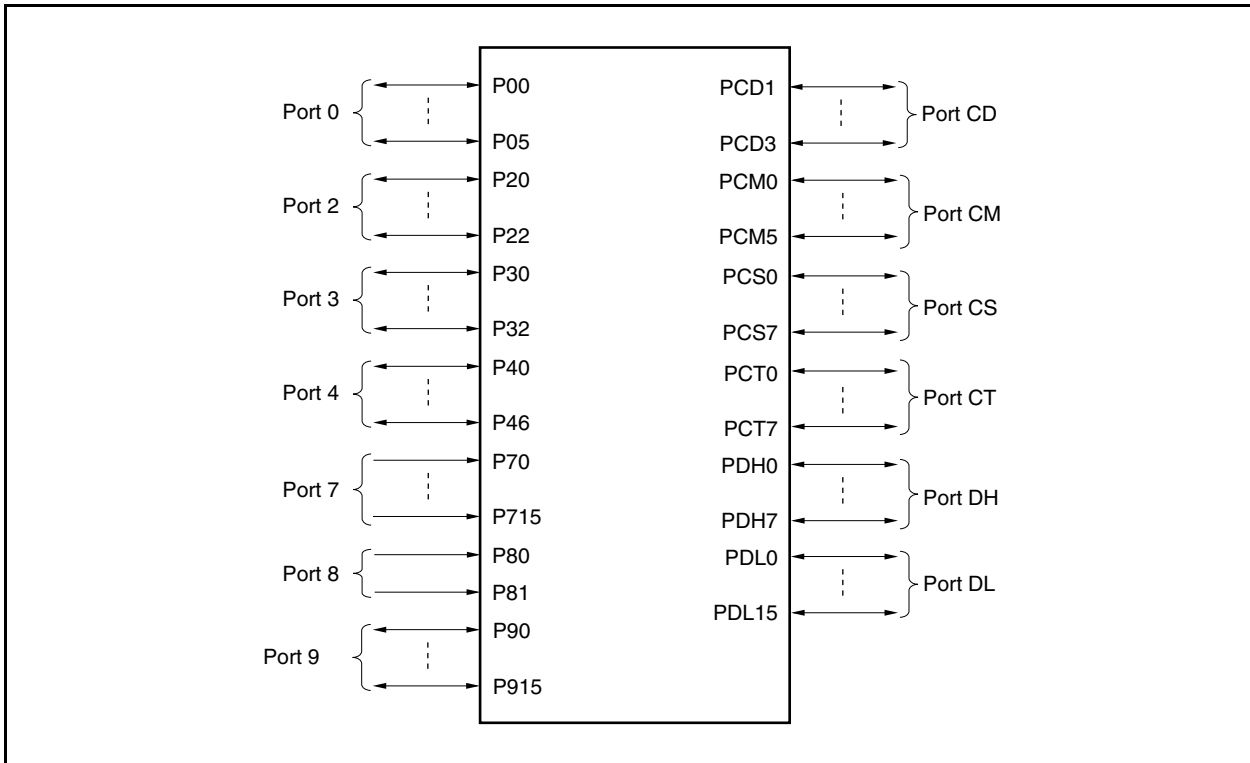
Figure 4-1. Port Configuration (V850ES/SA2)



4.2.2 V850ES/SA3

The V850ES/SA3 has a total of 102 input/output port pins (of which 18 are input-only port pins): ports 0, 2 to 4, 7 to 9, CD, CM, CS, CT, DH, and DL. The port configuration is shown below.

Figure 4-2. Port Configuration (V850ES/SA3)



4.3 Port Configuration

Table 4-1. Port Configuration (V850ES/SA2)

Item	Configuration
Control registers	Port mode register (PMn: n = 0, 3, 4, 9, CM, CS, CT, DH, DL) Pull-up resistor option register (PUn: n = 0, 3, 4, 9)
Ports	I/O: 68 pins, Input: 14 pins
Pull-up resistor	Software-controlled: 32 resistors

Table 4-2. Port Configuration (V850ES/SA3)

Item	Configuration
Control registers	Port mode register (PMn: n = 0, 3, 4, 9, CM, CS, CT, DH, DL) Pull-up resistor option register (PUn: n = 0, 2, 3, 4, 9)
Ports	I/O: 84 pins, Input: 18 pins
Pull-up resistor	Software-controlled: 35 resistors

4.3.1 Port 0

Port 0 can be set to the input or output mode in 1-bit units.

The number of I/O port bits of each product is the same.

Commercial Name	Number of I/O Port Bits
V850ES/SA2	6-bit I/O port
V850ES/SA3	6-bit I/O port

(1) Function of port 0

- Input/output data can be specified in 1-bit units by using port register 0 (P0).
- Can be set to the input or output mode in 1-bit units by using port mode register 0 (PM0).
- Can be set to the port mode or control mode (alternate function) in 1-bit units by using port mode control register 0 (PMC0).
- An internal pull-up resistor can be connected in 1-bit units by using pull-up resistor option register 0 (PU0).
- The valid edge of the external interrupt (alternate function) can be set in 1-bit units by using external interrupt falling edge specification register 0 (INTF0) and external interrupt rising edge specification register 0 (INTR0).

Port 0 has an alternate function as the following pins

Table 4-3. Alternate-Function Pins of Port 0

Pin Name		Alternate-Function Pin	I/O	PULL ^{Note}	Remark
Port 0	P00	NMI	I/O	Provided	-
	P01	INTP0/TI2			
	P02	INTP1/TI3			
	P03	INTP2/TI4			
	P04	INTP3/TI5			
	P05	INTP4			

Note Software pull-up function

(2) Registers

(a) Port register 0 (P0)

Port register 0 (P0) is an 8-bit register that controls reading the pin level and writing the output level. This register can be read or written in 8-bit or 1-bit units.

After reset: Undefined R/W Address: FFFFF400H

	7	6	5	4	3	2	1	0
P0	0	0	P05	P04	P03	P02	P01	P00

P0n	Controls output data (in output mode) (n = 0 to 5)
0	Outputs 0.
1	Outputs 1.

Remarks 1. In input mode: When port 0 (P0) is read, the pin level at that time is read. When written, the data written to P0 is written. The input pin is not affected.
 In output mode: When port 0 (P0) is read, the value of P0 is read. When a value is written to P0, it is immediately output.

2. After reset, an undefined value (pin input level) is read from P0 in the input mode. When P0 is read in the output mode, 00H (value of the output latch) is read.

(b) Port mode register 0 (PM0)

This is an 8-bit register that specifies the input or output mode.
 This register can be read or written in 8-bit or 1-bit units.

After reset: FFH R/W Address: FFFFF420H

	7	6	5	4	3	2	1	0
PM0	1	1	PM05	PM04	PM03	PM02	PM01	PM00

PM0n	Controls input/output mode (n = 0 to 5)
0	Output mode
1	Input mode

(c) Port mode control register 0 (PMC0)

This is an 8-bit register that specifies the port mode or control mode.

This register can be read or written in 8-bit or 1-bit units.

After reset: 00H R/W Address: FFFFF440H

	7	6	5	4	3	2	1	0
PMC0	0	0	PMC05	PMC04	PMC03	PMC02	PMC01	PMC00

PMC05	Specifies operation mode of P05 pin	
0	I/O port	
1	INTP4 input	

PMC04	Specifies operation mode of P04 pin	
0	I/O port	
1	INTP3/TI5 input	

PMC03	Specifies operation mode of P03 pin	
0	I/O port	
1	INTP2/TI4 input	

PMC02	Specifies operation mode of P02 pin	
0	I/O port	
1	INTP1/TI3 input	

PMC01	Specifies operation mode of P01 pin	
0	I/O port	
1	INTP0/TI2 output	

PMC00	Specifies operation mode of P00 pin	
0	I/O port	
1	NMI input	

Caution A register for selects external interrupts (INTP0 to INTP3) and timer inputs (TM2 to TM5) is not provided.

When using port 0 to input an external interrupt, specify the valid edge of the interrupt request by using the INTR0/INTF0 register. When using the port for timer input, specify the valid edge of TIn by using the TCLn register.

- INTR0: External interrupt rising edge specification register 0 (Refer to 4.3.1 (2) (f).)
- INTF0: External interrupt falling edge specification register 0 (Refer to 4.3.1 (2) (e).)
- TCLn: Timer n clock select register (refer to the description of the timers/counters)

(d) Pull-up resistor option register 0 (PU0)

This is an 8-bit register that specifies connection of an internal pull-up resistor.

This register can be read or written in 8-bit or 1-bit units.

After reset: 00H	R/W	Address: FFFFC40H							
		7	6	5	4	3	2	1	0
PU0		0	0	PU05	PU04	PU03	PU02	PU01	PU00
	PU0n	Controls connection of internal pull-up resistor (n = 0 to 5)							
	0	Not connected							
	1	Connected							

(e) External interrupt falling edge specification register 0 (INTF0)

This 8-bit register specifies detection of the falling edge of the external interrupt pins.

It can be read or written in 8-bit or 1-bit units.

Caution Set the port mode after clearing the INTF0n and INTR0n bits to 0 when switching from the external interrupt function (alternate function) to the port function because an edge may be detected.

After reset: 00H	R/W	Address: FFFFC00H							
		7	6	5	4	3	2	1	0
INTF0		0	0	INTF05	INTF04	INTF03	INTF02	INTR01	INTR00

Remark For how to specify a valid edge, refer to **Table 4-4**.

(f) External interrupt rising edge specification register 0 (INTR0)

This 8-bit register specifies detection of the rising edge of the external interrupt pins. It can be read or written in 8-bit or 1-bit units.

Caution Set the port mode after clearing the INTF0n and INTR0n bits to 0 when switching from the external interrupt function (alternate function) to the port function because an edge may be detected.

After reset: 00H R/W Address: FFFFC20H

INTR0	7	6	5	4	3	2	1	0
	0	0	INTR05	INTR04	INTR03	INTR02	INTR01	INTR00

Remark For how to specify a valid edge, refer to **Table 4-4**.

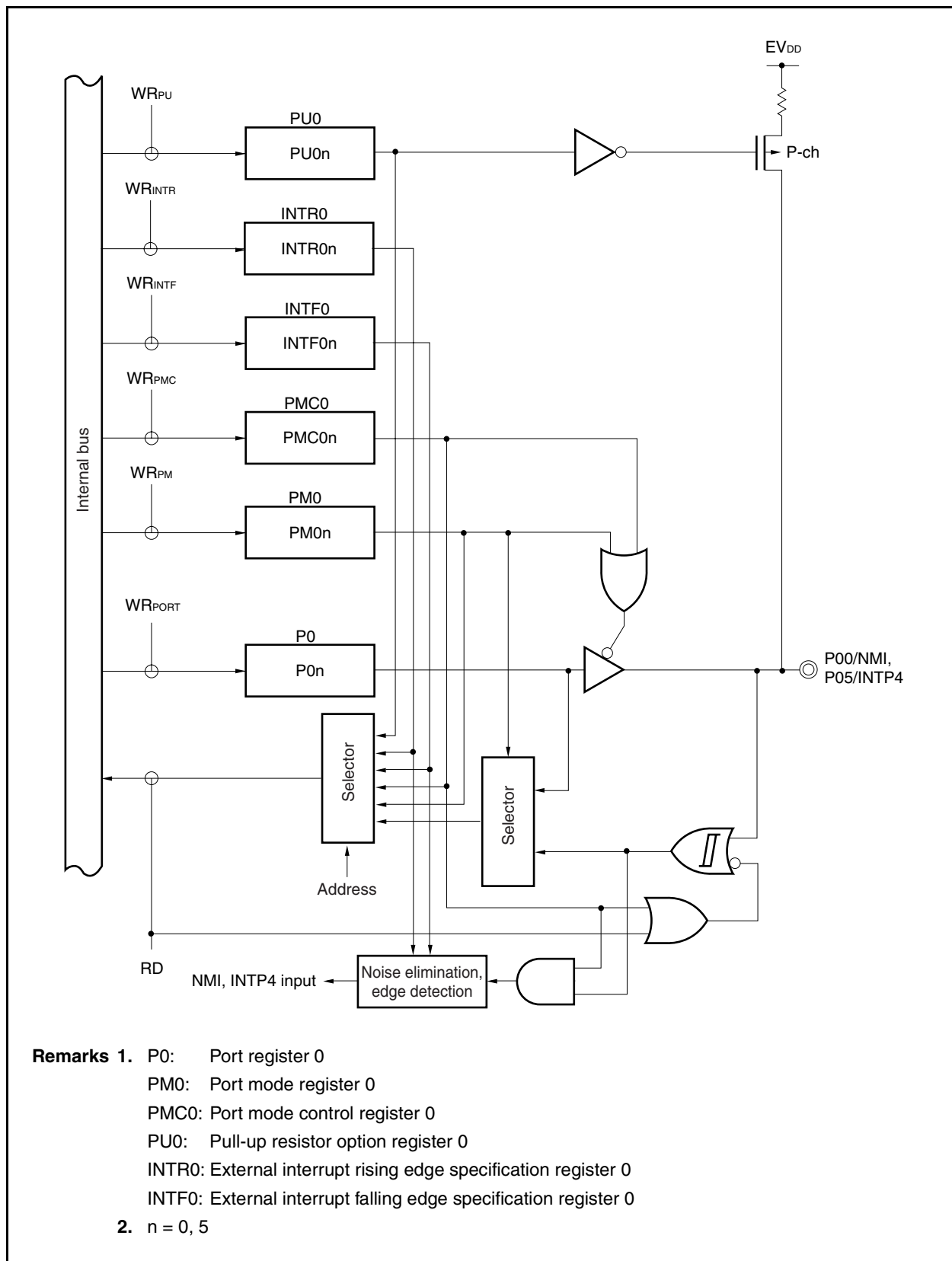
Table 4-4. Specifying Valid Edge

INTF0n	INTR0n	Specifies valid edge (n = 0 to 5)
0	0	Detects no edge.
0	1	Rising edge
1	0	Falling edge
1	1	Both edges

Remark n = 0: Control of NMI pin
n = 1 to 5: Control of INTP0 to INTP4 pins

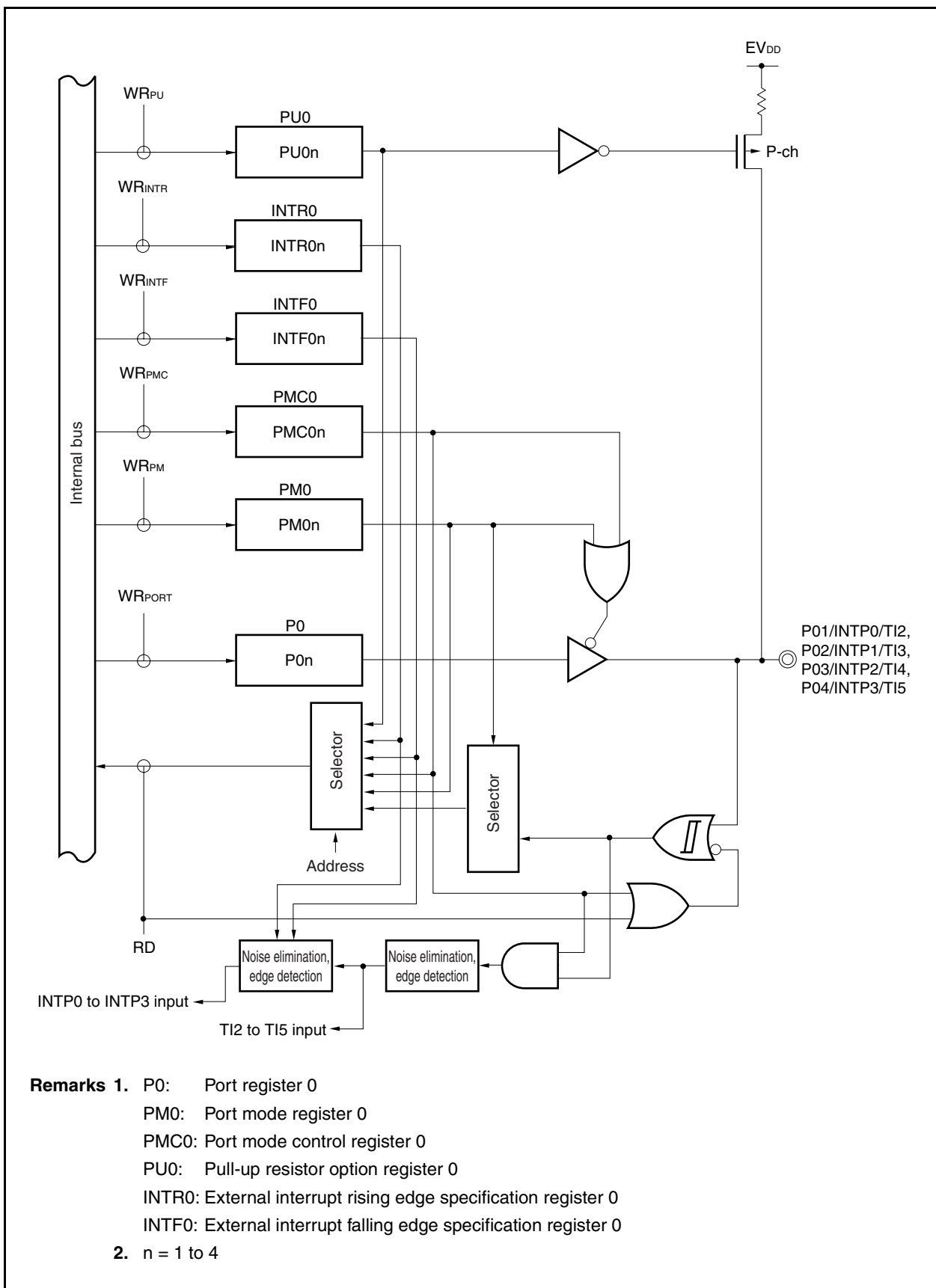
(3) Block diagram

Figure 4-3. Block Diagram of P00 and P05



- Remarks 1.** P0: Port register 0
 PM0: Port mode register 0
 PMC0: Port mode control register 0
 PU0: Pull-up resistor option register 0
 INTR0: External interrupt rising edge specification register 0
 INTF0: External interrupt falling edge specification register 0
- 2.** n = 0, 5

Figure 4-4. Block Diagram of P01 to P04



4.3.2 Port 2

Port 2 can be set to the input or output mode in 1-bit units.
 The number of I/O port bits differs depending on the product.

Commercial Name	Number of I/O Port Bits
V850ES/SA2	–
V850ES/SA3	3-bit I/O port

(1) Functions of port 2 (V850ES/SA3)

- Input/output data can be specified in 1-bit units by using port register 2 (P2).
- Can be set to the input or output mode in 1-bit units by using port mode register 2 (PM2).
- Can be set to the port mode or control mode (alternate function) in 1-bit units by using port mode control register 2 (PMC2).
- N-ch open-drain output can be set in 1-bit units by using port function register 2 (PF2).
- An internal pull-up resistor can be connected in 1-bit units by using pull-up resistor option register 2 (PU2).

Port 2 has an alternate function as the following pins.

Table 4-5. Alternate-Function Pins of Port 2 (V850ES/SA3)

Pin Name		Alternate-Function Pin	I/O	PULL ^{Note}	Remark
Port 2	P20	SI4	I/O	Provided	–
	P21	SO4			N-ch open-drain output selectable
	P22	$\overline{\text{SCK4}}$			

Note Software pull-up function

(2) Registers

(a) Port register 2 (P2)

Port register 2 (P2) is an 8-bit register that controls reading the pin level and writing the output level. This register can be read or written in 8-bit or 1-bit units.

After reset: Undefined R/W Address: FFFFF404H

	7	6	5	4	3	2	1	0
P2	0	0	0	0	0	P22	P21	P20

P2n	Controls output data (in output mode) (n = 0 to 2)
0	Outputs 0.
1	Outputs 1.

Remarks 1. In input mode: When port 2 (P2) is read, the pin level at that time is read. When written, the data written to P2 is written. The input pin is not affected.
 In output mode: When port 2 (P2) is read, the value of P2 is read. When a value is written to P2, it is immediately output.

2. After reset, an undefined value (pin input level) is read from P2 in the input mode. When P2 is read in the output mode, 00H (value of the output latch) is read.

(b) Port mode register 2 (PM2)

This is an 8-bit register that specifies the input or output mode.
 This register can be read or written in 8-bit or 1-bit units.

After reset: FFH R/W Address: FFFFF424H

	7	6	5	4	3	2	1	0
PM2	1	1	1	1	1	PM22	PM21	PM20

PM2n	Controls input/output mode (n = 0 to 2)
0	Output mode
1	Input mode

(c) Port mode control register 2 (PMC2)

This is an 8-bit register that specifies the port mode or control mode.

This register can be read or written in 8-bit or 1-bit units.

After reset: 00H		R/W	Address: FFFFF444H					
PMC2	7	6	5	4	3	2	1	0
	0	0	0	0	0	PMC22	PMC21	PMC20
PMC22	Specifies operation mode of P22 pin							
0	I/O port							
1	$\overline{\text{SCK4}}$ I/O							
PMC21	Specifies operation mode of P21 pin							
0	I/O port							
1	SO4 output							
PMC20	Specifies operation mode of P20 pin							
0	I/O port							
1	SI4 input							

(d) Port function register 2 (PF2)

This 8-bit register specifies normal output or N-ch open-drain output.

It can be read or written in 8-bit or 1-bit units.

After reset: 00H		R/W	Address: FFFFC64H					
PF2	7	6	5	4	3	2	1	0
	0	0	0	0	0	PF22	PF21	0
PF2n	Controls normal output or N-ch open-drain output (n = 1, 2)							
0	Normal output							
1	N-ch open-drain output							

Cautions

1. The N-ch open-drain output voltage is the normal voltage, not the medium voltage.
2. PF2n = 1 is enabled only in the following cases. Otherwise, the setting is prohibited.
 - n = 1: SO4
 - n = 2: $\overline{\text{SCK4}}$

(e) Pull-up resistor option register 2 (PU2)

This is an 8-bit register that specifies connection of an internal pull-up resistor.

This register can be read or written in 8-bit or 1-bit units.

After reset: 00H		R/W	Address: FFFFC44H					
	7	6	5	4	3	2	1	0
PU2	0	0	0	0	0	PU22	PU21	PU20
	Controls connection of internal pull-up resistor (n = 0 to 2)							
0	Not connected							
1	Connected							

(3) Block diagram

Figure 4-5. Block Diagram of P20

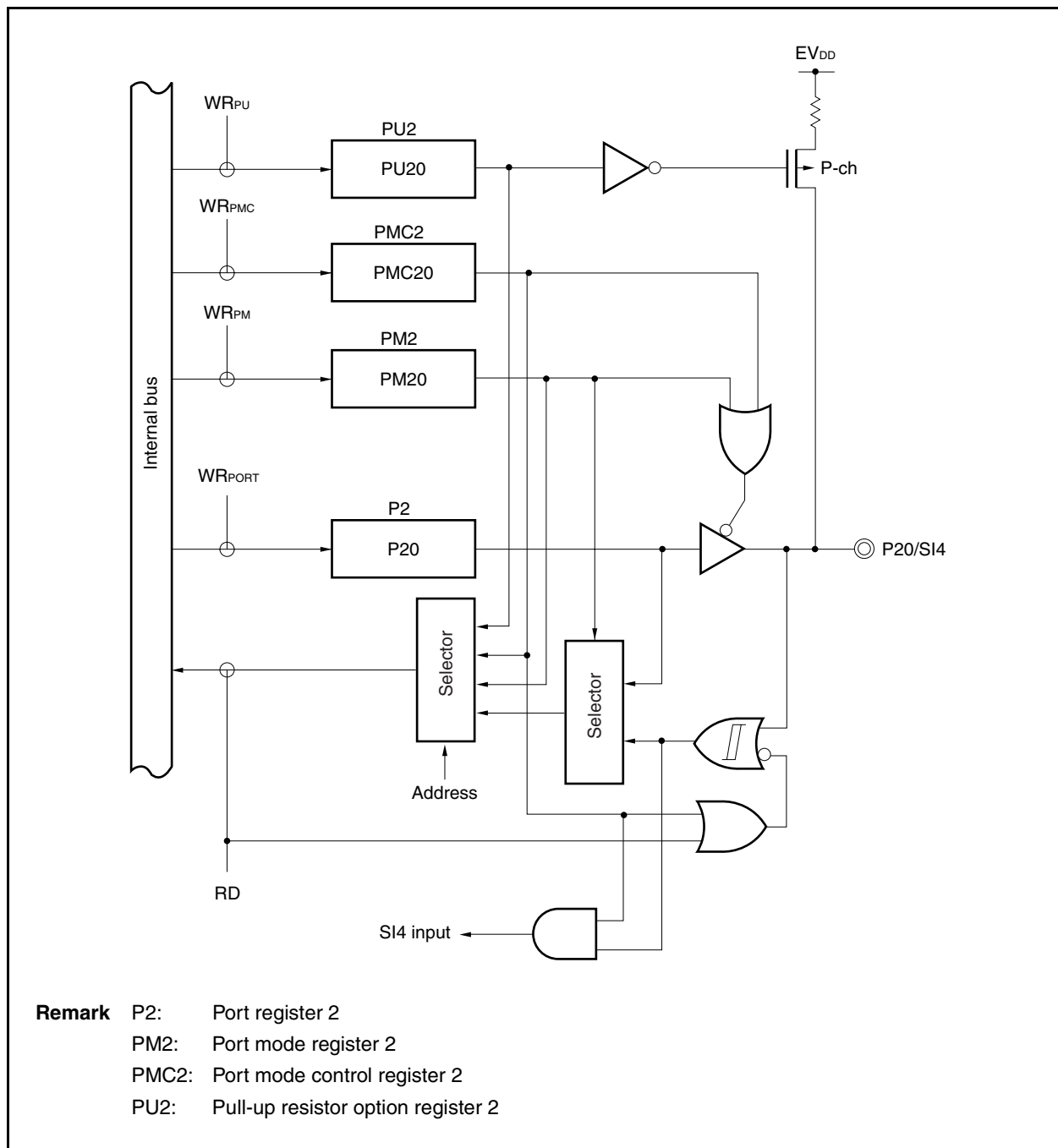


Figure 4-6. Block Diagram of P21

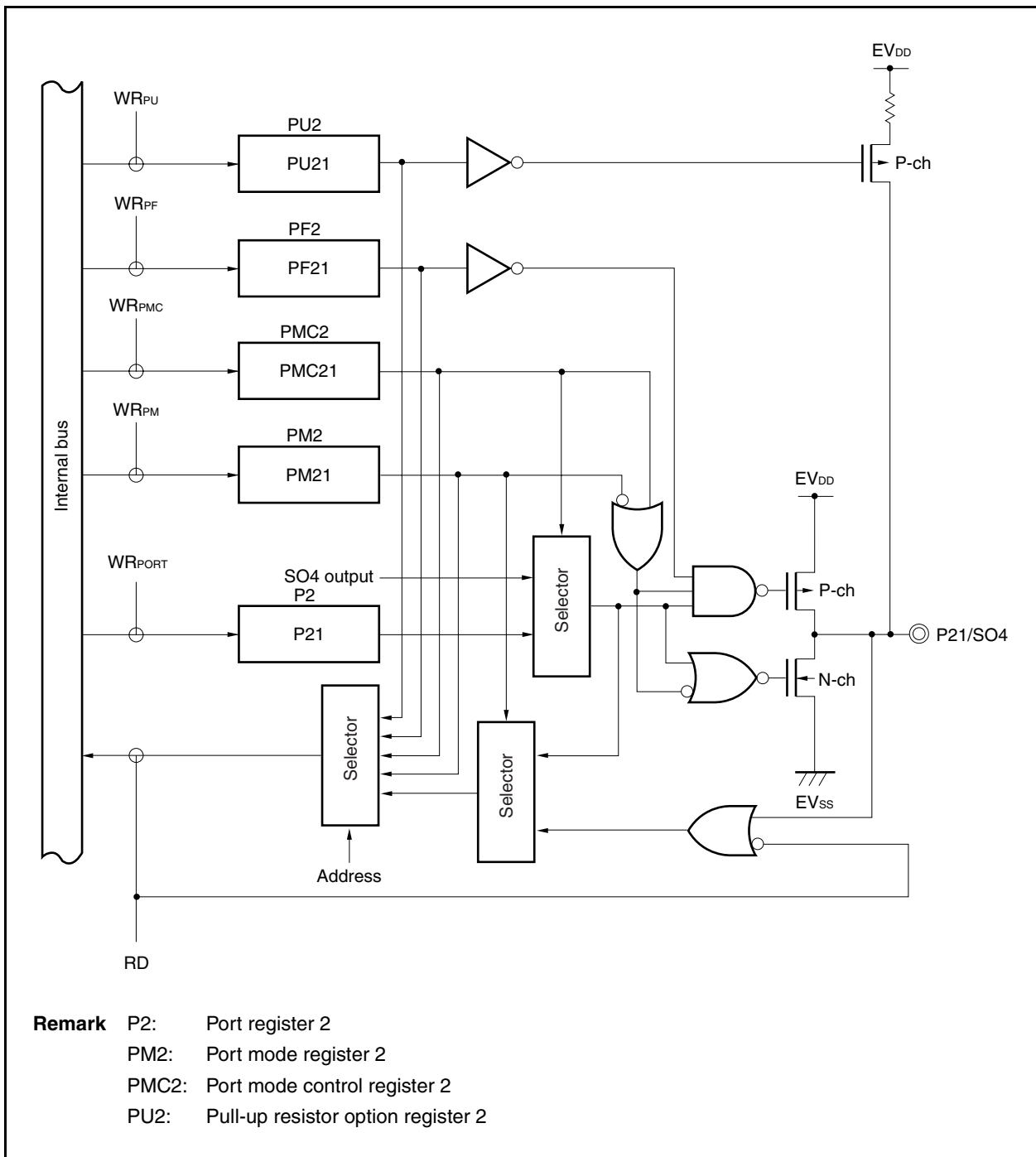
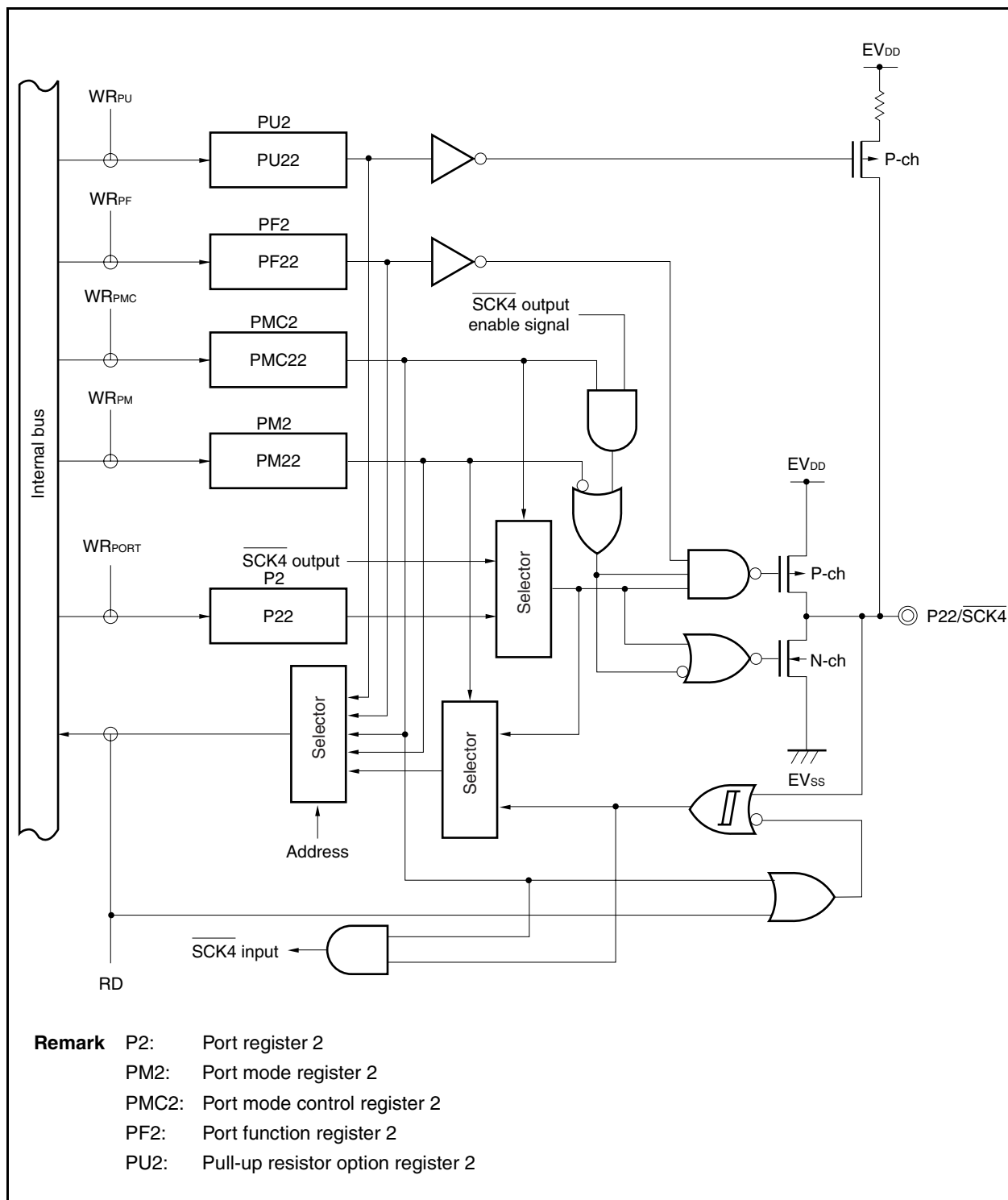


Figure 4-7. Block Diagram of P22



4.3.3 Port 3

Port 3 can be set to the input or output mode in 1-bit units.

The number of I/O port bits of each product is the same.

Commercial Name	Number of I/O Port Bits
V850ES/SA2	3-bit I/O port
V850ES/SA3	3-bit I/O port

(1) Functions of port 3

- Input/output data can be specified in 1-bit units by using port register 3 (P3).
- Can be set to the input or output mode in 1-bit units by using port mode register 3 (PM3).
- Can be set to the port mode or control mode (alternate function) in 1-bit units by using port mode control register 3 (PMC3).
- Control mode 1 or control mode 2 can be specified in 1-bit units by using port function control register 3 (PFC3).
- N-ch open-drain output can be set in 1-bit units by using port function register 3 (PF3).
- An internal pull-up resistor can be connected in 1-bit units by using pull-up resistor option register 3 (PU3).

Port 3 has an alternate function as the following pins.

Table 4-6. Alternate-Function Pins of Port 3

Pin Name		Alternate-Function Pin	I/O	PULL ^{Note}	Remark
Port 3	P30	SI1/RXD0	I/O	Provided	–
	P31	SO1/TXD0			N-ch open-drain output selectable
	P32	SCK $\bar{0}$			

Note Software pull-up function

(2) Registers

(a) Port register 3 (P3)

Port register 3 (P3) is an 8-bit register that controls reading the pin level and writing the output level. This register can be read or written in 8-bit or 1-bit units.

After reset: Undefined R/W Address: FFFFF406H

	7	6	5	4	3	2	1	0
P3	0	0	0	0	0	P32	P31	P30

P3n	Controls output data (in output mode) (n = 0 to 2)
0	Outputs 0.
1	Outputs 1.

Remarks 1. In input mode: When port 3 (P3) is read, the pin level at that time is read. When written, the data written to P3 is written. The input pin is not affected.
 In output mode: When port 3 (P3) is read, the value of P3 is read. When a value is written to P3, it is immediately output.

2. After reset, an undefined value (pin input level) is read from P3 in the input mode. When P3 is read in the output mode, 00H (value of the output latch) is read.

(b) Port mode register 3 (PM3)

This is an 8-bit register that specifies the input or output mode.
 This register can be read or written in 8-bit or 1-bit units.

After reset: FFH R/W Address: FFFFF426H

	7	6	5	4	3	2	1	0
PM3	1	1	1	1	1	PM32	PM31	PM30

PM3n	Controls input/output mode (n = 0 to 2)
0	Output mode
1	Input mode

(c) Port mode control register 3 (PMC3)

This is an 8-bit register that specifies the port mode or control mode.

This register can be read or written in 8-bit or 1-bit units.

After reset: 00H		R/W	Address: FFFFF446H					
	7	6	5	4	3	2	1	0
PMC3	0	0	0	0	0	PMC32	PMC31	PMC30
PMC32	Specifies operation mode of P32 pin							
0	I/O port							
1	SCK1 I/O							
PMC31	Specifies operation mode of P31 pin							
0	I/O port							
1	SO1/TXD0 output							
PMC30	Specifies operation mode of P30 pin							
0	I/O port							
1	SI1/RXD0 input							

(d) Port function control register 3 (PFC3)

This 8-bit register specifies control mode 1 or control mode 2.

It can be read or written in 8-bit or 1-bit units.

After reset: 00H		R/W	Address: FFFFF466H					
	7	6	5	4	3	2	1	0
PFC3	0	0	0	0	0	0	PFC31	PFC30
PFC31	Specifies operation mode of P31 pin in control mode							
0	SO1 output							
1	TXD0 output							
PFC30	Specifies operation mode of P30 pin in control mode							
0	SI1 input							
1	RXD0 input							

(e) Port function register 3 (PF3)

This 8-bit register specifies normal output or N-ch open-drain output.

It can be read or written in 8-bit or 1-bit units.

After reset: 00H R/W Address: FFFFC66H

	7	6	5	4	3	2	1	0
PF3	0	0	0	0	0	PF32	PF31	0

PF3n	Controls normal output or N-ch open-drain output (n = 1, 2)
0	Normal output
1	N-ch open-drain output

Cautions

1. The N-ch open-drain output voltage is the normal voltage, not the medium voltage.
2. PF3n = 1 is enabled only in the following cases. Otherwise, the setting is prohibited.
 - n = 1: SO1
 - n = 2: $\overline{\text{SCK1}}$

(f) Pull-up resistor option register 3 (PU3)

This is an 8-bit register that specifies connection of an internal pull-up resistor.

This register can be read or written in 8-bit or 1-bit units.

After reset: 00H R/W Address: FFFFC46H

	7	6	5	4	3	2	1	0
PU3	0	0	0	0	0	PU32	PU31	PU30

PU3n	Controls connection of internal pull-up resistor (n = 0 to 2)
0	Not connected.
1	Connected.

(3) Block diagram

Figure 4-8. Block Diagram of P30

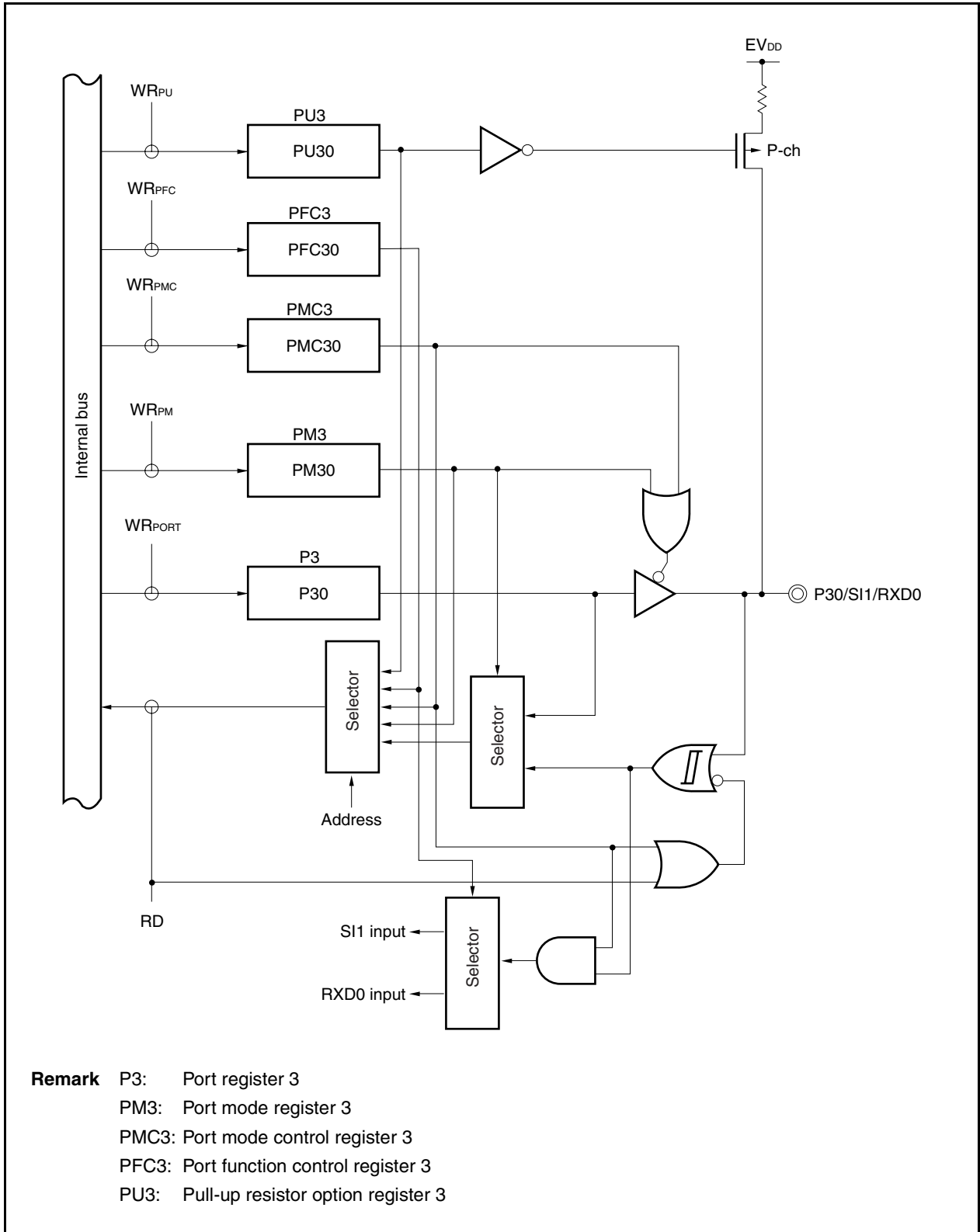


Figure 4-9. Block Diagram of P31

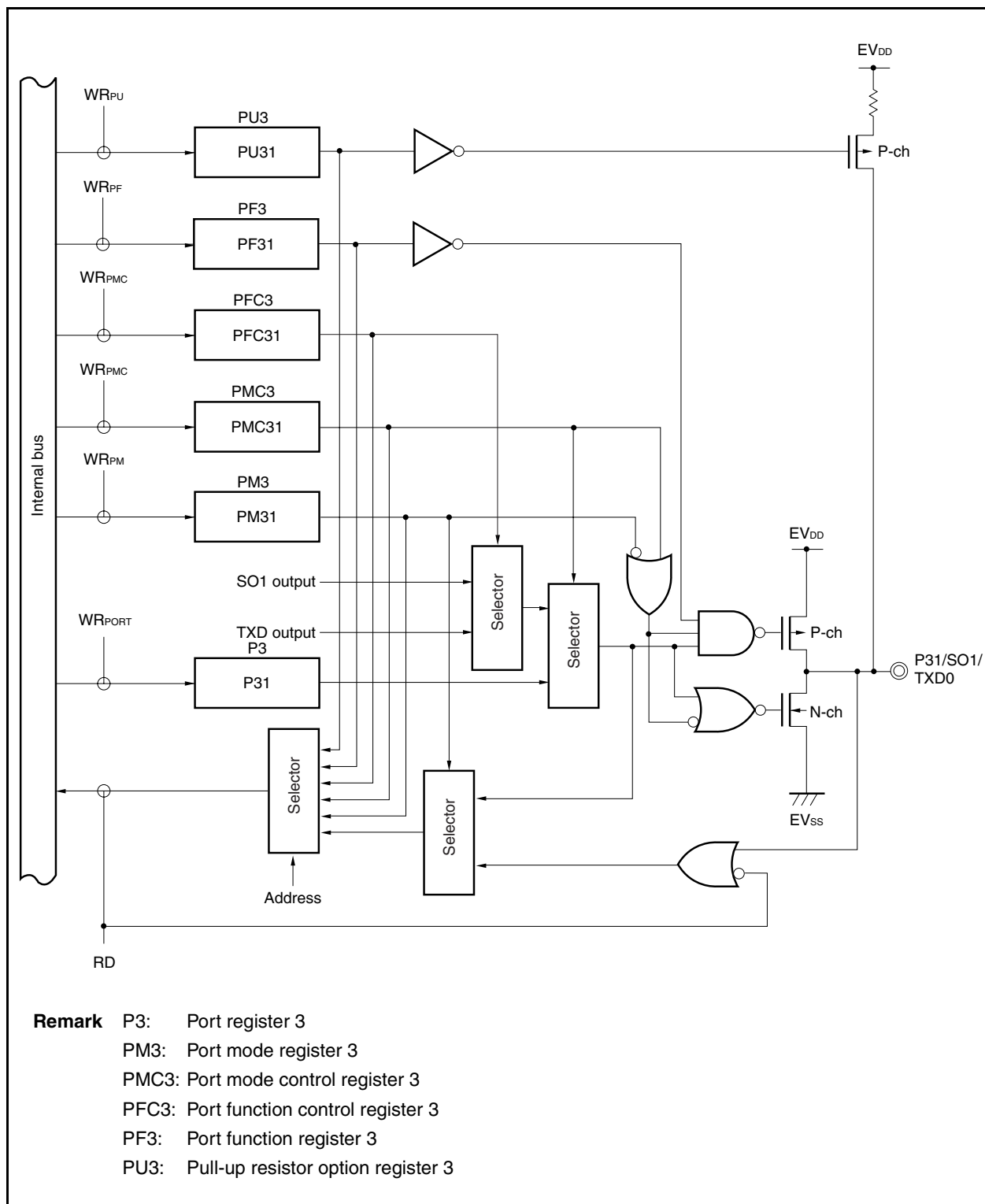
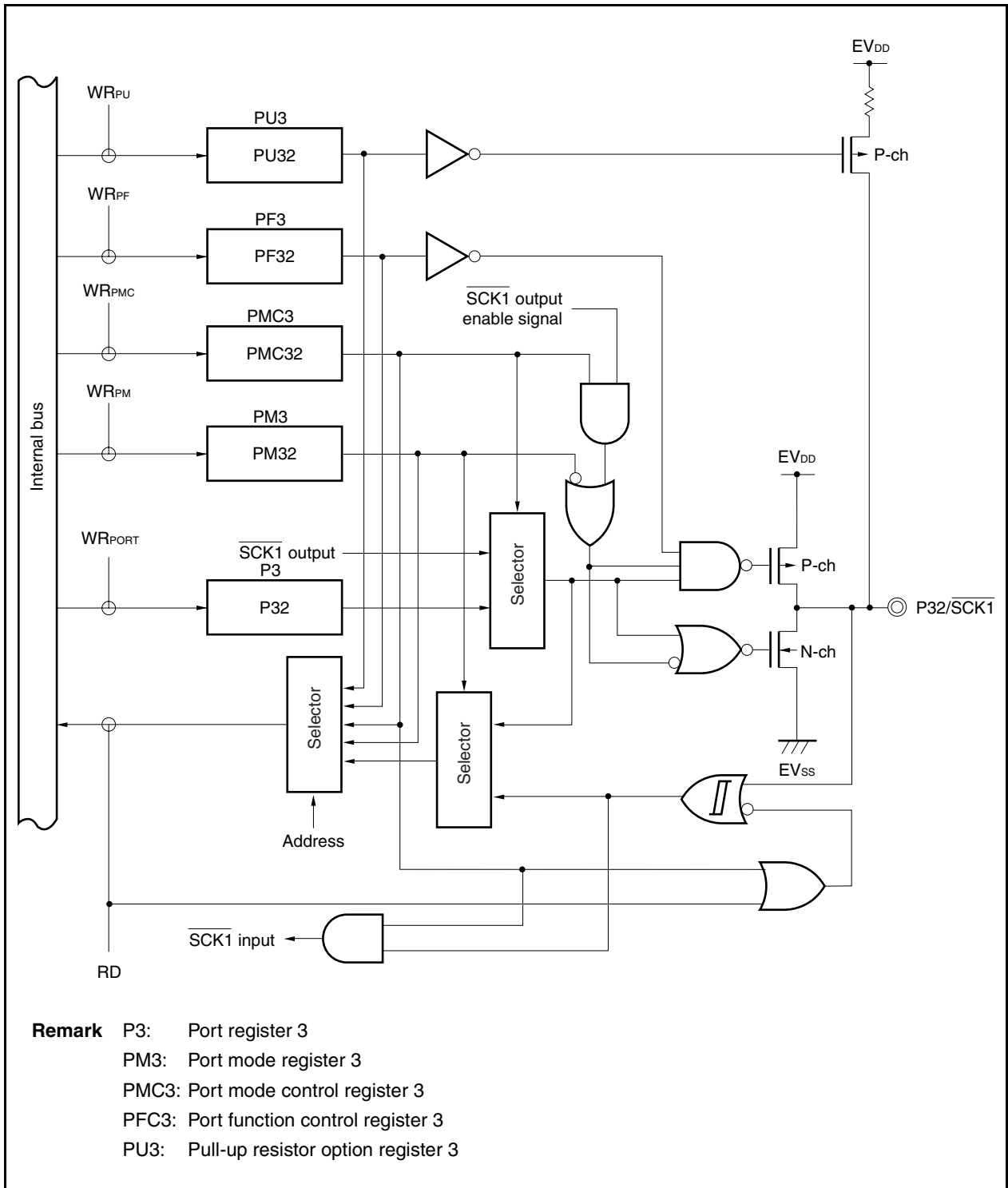


Figure 4-10. Block Diagram of P32



4.3.4 Port 4

Port 4 can be set to the input or output mode in 1-bit units.

The number of I/O port bits each product is the same.

Commercial Name	Number of I/O Port Bits
V850ES/SA2	7-bit I/O port
V850ES/SA3	7-bit I/O port

(1) Functions of port 4

- Input/output data can be specified in 1-bit units by using port register 4 (P4).
- Can be set to the input or output mode in 1-bit units by using port mode register 4 (PM4).
- Can be set to the port mode or control mode (alternate function) in 1-bit units by using port mode control register 4 (PMC4).
- Control mode 1 or control mode 2 can be specified in 1-bit units by using port function control register 4 (PFC4).
- N-ch open-drain output can be set to 1-bit units by using port function register 4 (PF4).
- The internal pull-up resistor can be connected in 1-bit units by using pull-up resistor option register 4 (PU4).

Port 4 has an alternate function as the following pins.

Table 4-7. Alternate-Function Pins of Port 4

Pin Name	Alternate-Function Pin	I/O	PULL ^{Note 1}	Remark	
Port 4	P40	SI0	I/O	Provided	-
	P41	SO0/SDA ^{Note 2}			
	P42	$\overline{\text{SCK0}}$ /SCL ^{Note 2}			
	P43	INTP00/TI0/TCLR0			
	P44	INTP01/TO0			
	P45	INTP01/TI1/TCLR1			
	P46	INTP11/TO1			

Notes 1. Software pull-up function

2. μ PD703201Y, 703204Y, 70F3201Y, and 70F3204Y only

(2) Registers

(a) Port register 4 (P4)

Port register 4 (P4) is an 8-bit register that controls reading the pin level and writing the output level. This register can be read or written in 8-bit or 1-bit units.

After reset: Undefined R/W Address: FFFFF408H

	7	6	5	4	3	2	1	0
P4	0	P46	P45	P44	P43	P42	P41	P40

P4n	Controls output data (in output mode) (n = 0 to 6)
0	Outputs 0.
1	Outputs 1.

Remarks 1. In input mode: When port 4 (P4) is read, the pin level at that time is read. When written, the data written to P4 is written. The input pin is not affected.
 In output mode: When port 4 (P4) is read, the value of P4 is read. When a value is written to P4, it is immediately output.

2. After reset, an undefined value (pin input level) is read from P4 in the input mode. When P4 is read in the output mode, 00H (value of the output latch) is read.

(b) Port mode register 4 (PM4)

This is an 8-bit register that specifies the input or output mode.
 This register can be read or written in 8-bit or 1-bit units.

After reset: FFH R/W Address: FFFFF428H

	7	6	5	4	3	2	1	0
PM4	1	PM46	PM45	PM44	PM43	PM42	PM41	PM40

PM4n	Controls input/output mode (n = 0 to 6)
0	Output mode
1	Input mode

(c) Port mode control register 4 (PMC4)

This is an 8-bit register that specifies the port mode or control mode.

This register can be read or written in 8-bit or 1-bit units.

After reset: 00H R/W Address: FFFFF448H

	7	6	5	4	3	2	1	0
PMC4	0	PMC46	PMC45	PMC44	PMC43	PMC42	PMC41	PMC40

PMC46	Specifies operation mode of P46 pin
0	I/O port
1	INTP11/TO1 I/O
PMC45	Specifies operation mode of P45 pin
0	I/O port
1	INTP10/TI1/TCLR1 input ^{Note}
PMC44	Specifies operation mode of P44 pin
0	I/O port
1	INTP01/TO0 I/O
PMC43	Specifies operation mode of P43 pin
0	I/O port
1	INTP00/TI0/TCLR0 input ^{Note}
PMC42	Specifies operation mode of P42 pin
0	I/O port
1	SCK0 I/O
PMC41	Specifies operation mode of P41 pin
0	I/O port
1	SO0 output
PMC40	Specifies operation mode of P40 pin
0	I/O port
1	SI0 input

Cautions 1. To use INTP0n, perform the following setting:

- CMSn0 bit of TMCn1 register = 0
- ETIn bit of TMCn1 register = 1
- Setting of valid edge by SESn register

2. To use TI_n, perform the following setting:

- CMSn0 bit of TMCn1 register = 1
- ETIn bit of TMCn1 register = 1
- Setting of valid edge by SESn register

3. To use TCLR_n, perform the following setting:

- ECLRn bit of TMCn1 register = 1
- Setting of valid edge by SESn register

Remark n = 0 or 1

(d) Port function control register 4 (PFC4)

This 8-bit register specifies control mode 1 or control mode 2.

It can be read or written in 8-bit or 1-bit units.

After reset: 00H R/W Address: FFFFF468H

	7	6	5	4	3	2	1	0
PFC4	0	PFC46	0	PFC44	0	PFC42	PFC41	0

PFC46	Specifies operation mode of P46 pin in control mode
0	INTP11 input
1	TO1 output ^{Note 1}

PFC44	Specifies operation mode of P44 pin in control mode
0	INTP01 input
1	TO0 input ^{Note 1}

PFC42	Specifies operation mode of P42 pin in control mode
0	$\overline{\text{SCK0}}$ I/O
1	SCL I/O ^{Note 2}

PFC41	Specifies operation mode of P41 pin in control mode
0	SO0 output
1	SDA I/O ^{Note 2}

Notes 1. Setting of PCF44 and PCF46 = 1 is enabled only when TOn output is enabled (ENTOn of TMCn1 register = 1: n = 0 or 1). Otherwise, this setting is prohibited.

2. μ PD703201Y, 703204Y, 70F3201Y, and 70F3204Y only

Caution The PFC4n bit is valid only when the PMC4n bit = 1 (n = 1, 2, 4, or 6).

(e) Port function register 4 (PF4)

This 8-bit register specifies normal output or N-ch open-drain output.

It can be read or written in 8-bit or 1-bit units.

After reset: 00H R/W Address: FFFFFFFC68H

	7	6	5	4	3	2	1	0
PF4	0	0	0	0	0	PF42	PF41	0

PF4n	Controls normal output or N-ch open-drain output (n = 1, 2)
0	Normal output
1	N-ch open-drain output

Cautions

1. The N-ch open-drain output voltage is the normal voltage, not the medium voltage.
2. PF4n = 1 is enabled only in the following cases. Otherwise, the setting is prohibited.
 n = 1: S00, SDA
 n = 2: SCK0, SCL
3. Be sure to set N-ch open-drain output when using I²C.

(f) Pull-up resistor option register 4 (PU4)

This is an 8-bit register that specifies connection of an internal pull-up resistor.

This register can be read or written in 8-bit or 1-bit units.

After reset: 00H R/W Address: FFFFFFFC48H

	7	6	5	4	3	2	1	0
PU4	0	PU46	PU45	PU44	PU43	PU42	PU41	PU40

PU4n	Controls connection of internal pull-up resistor (n = 0 to 6)
0	Not connected.
1	Connected.

(3) Block diagram

Figure 4-11. Block Diagram of P40

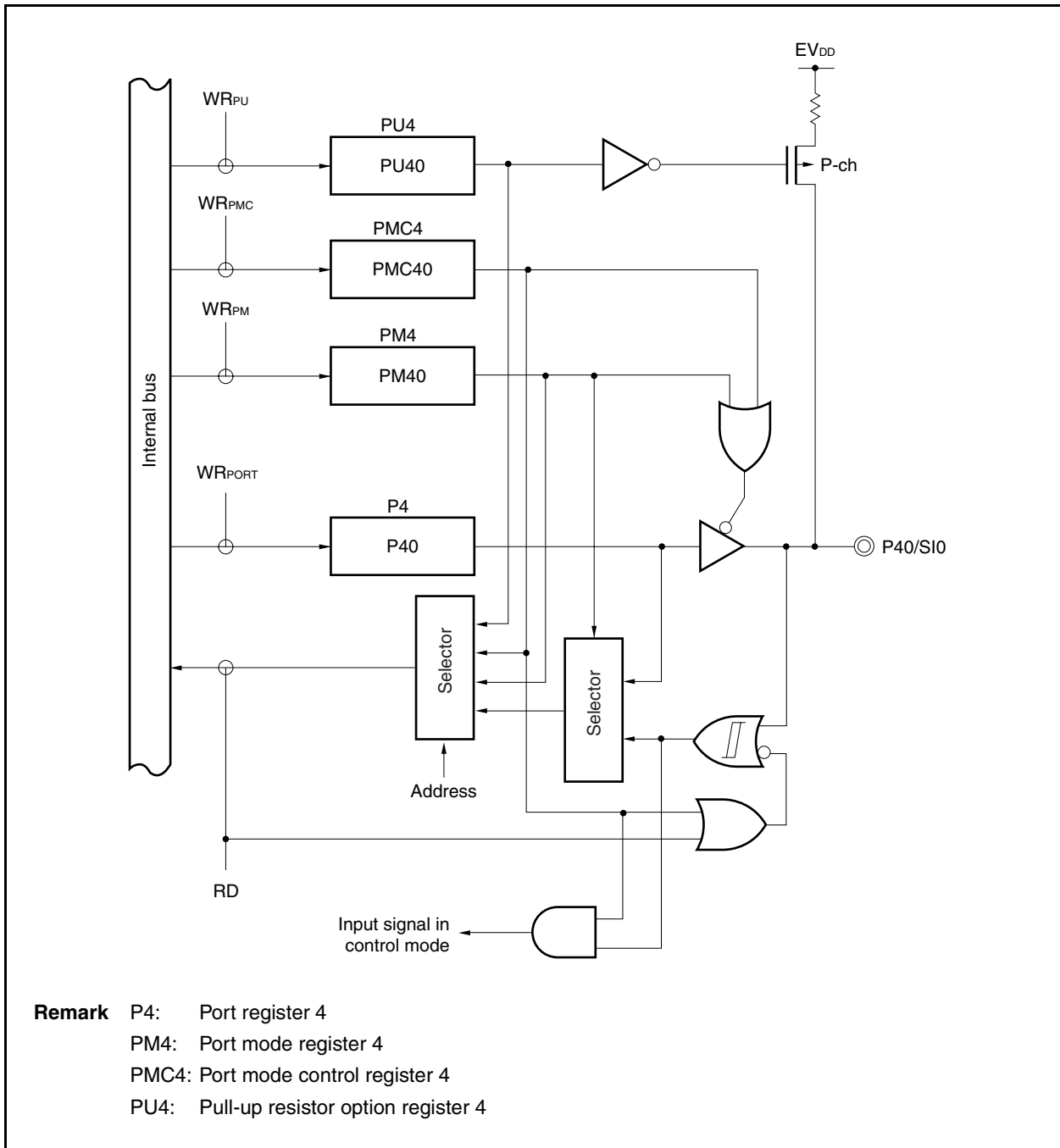


Figure 4-12. Block Diagram of P41

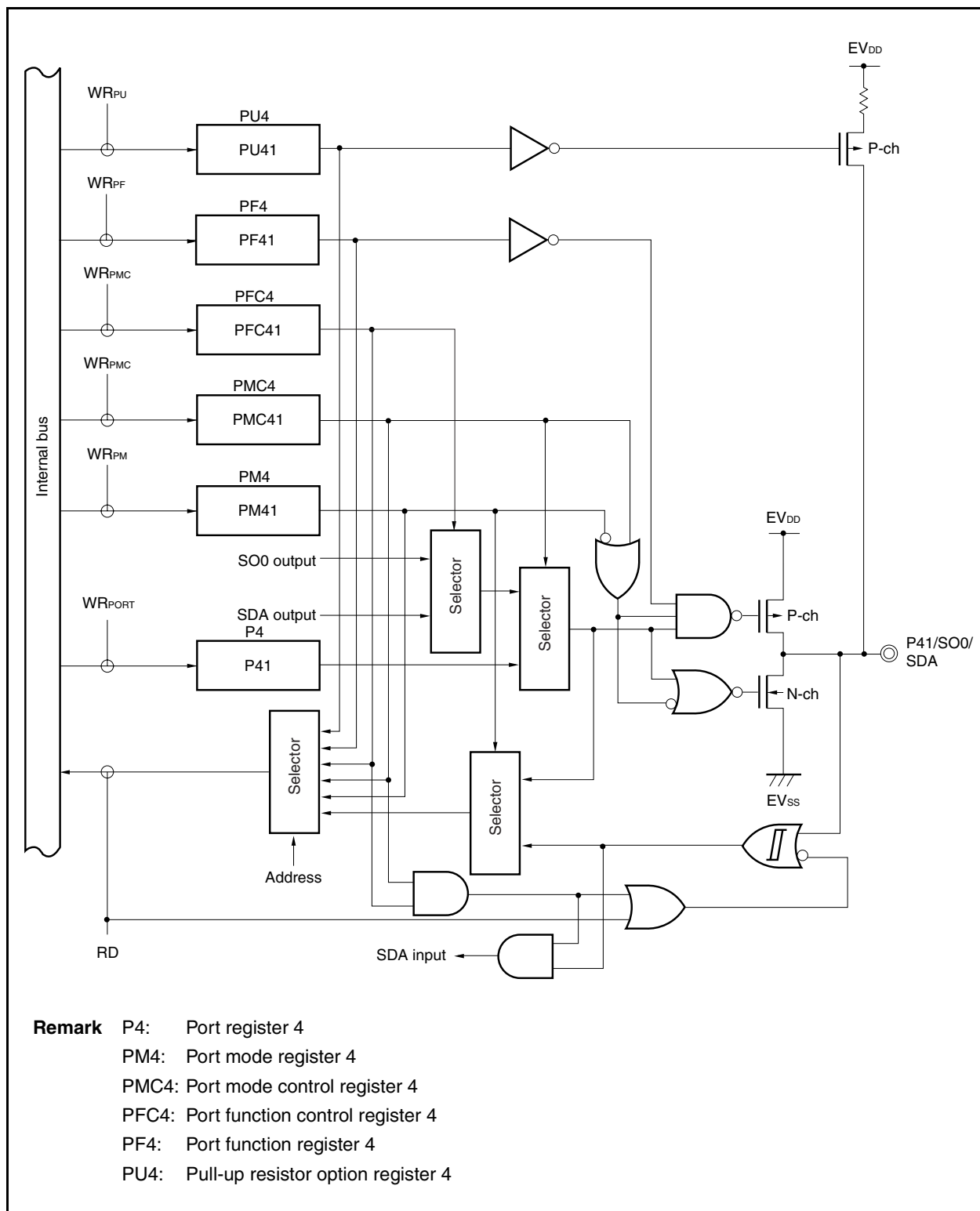
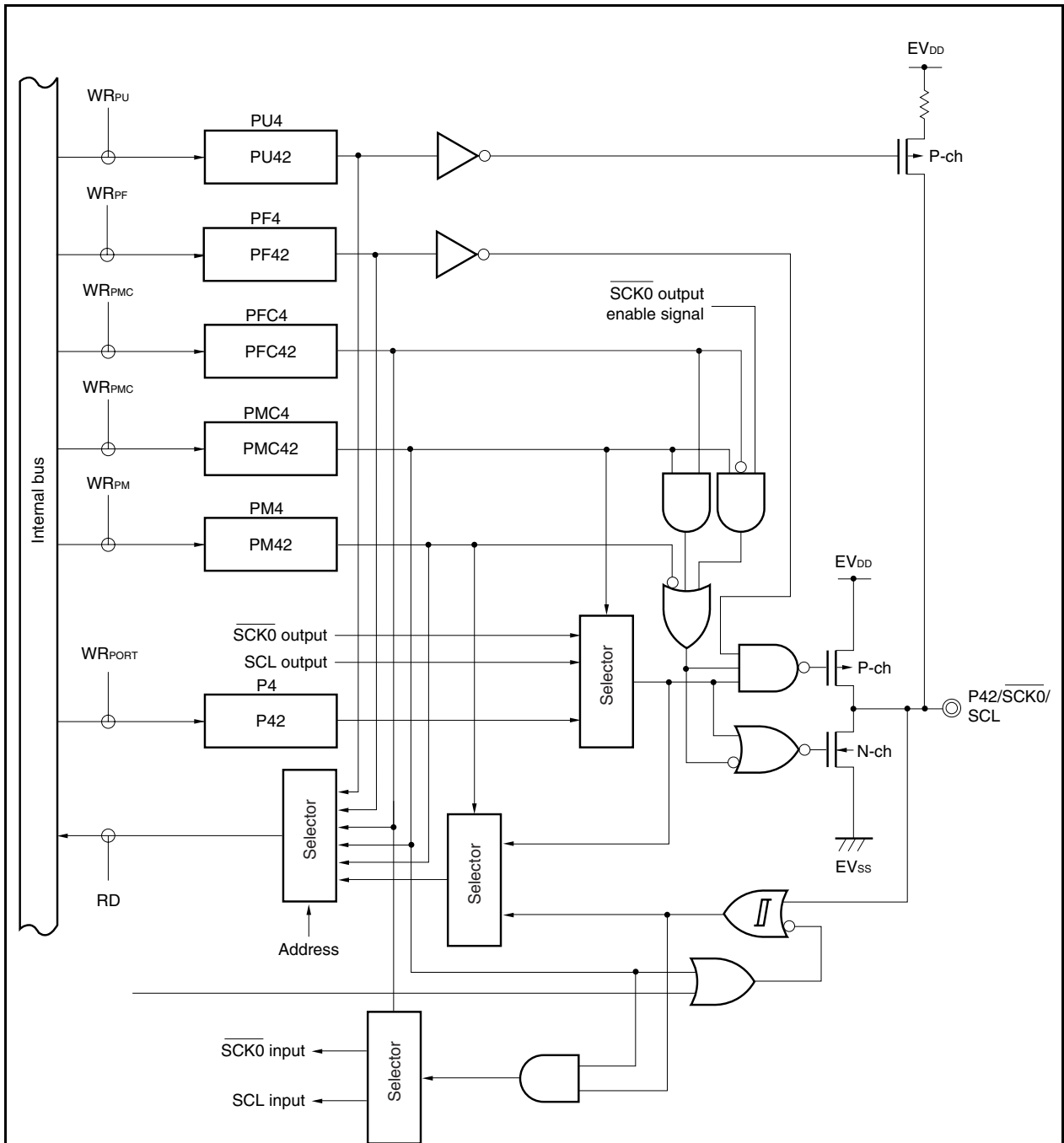


Figure 4-13. Block Diagram of P42



Remark P4: Port register 4
 PM4: Port mode register 4
 PMC4: Port mode control register 4
 PFC4: Port function control register 4
 PF4: Port function register 4
 PU4: Pull-up resistor option register 4

Figure 4-14. Block Diagram of P43 and P45

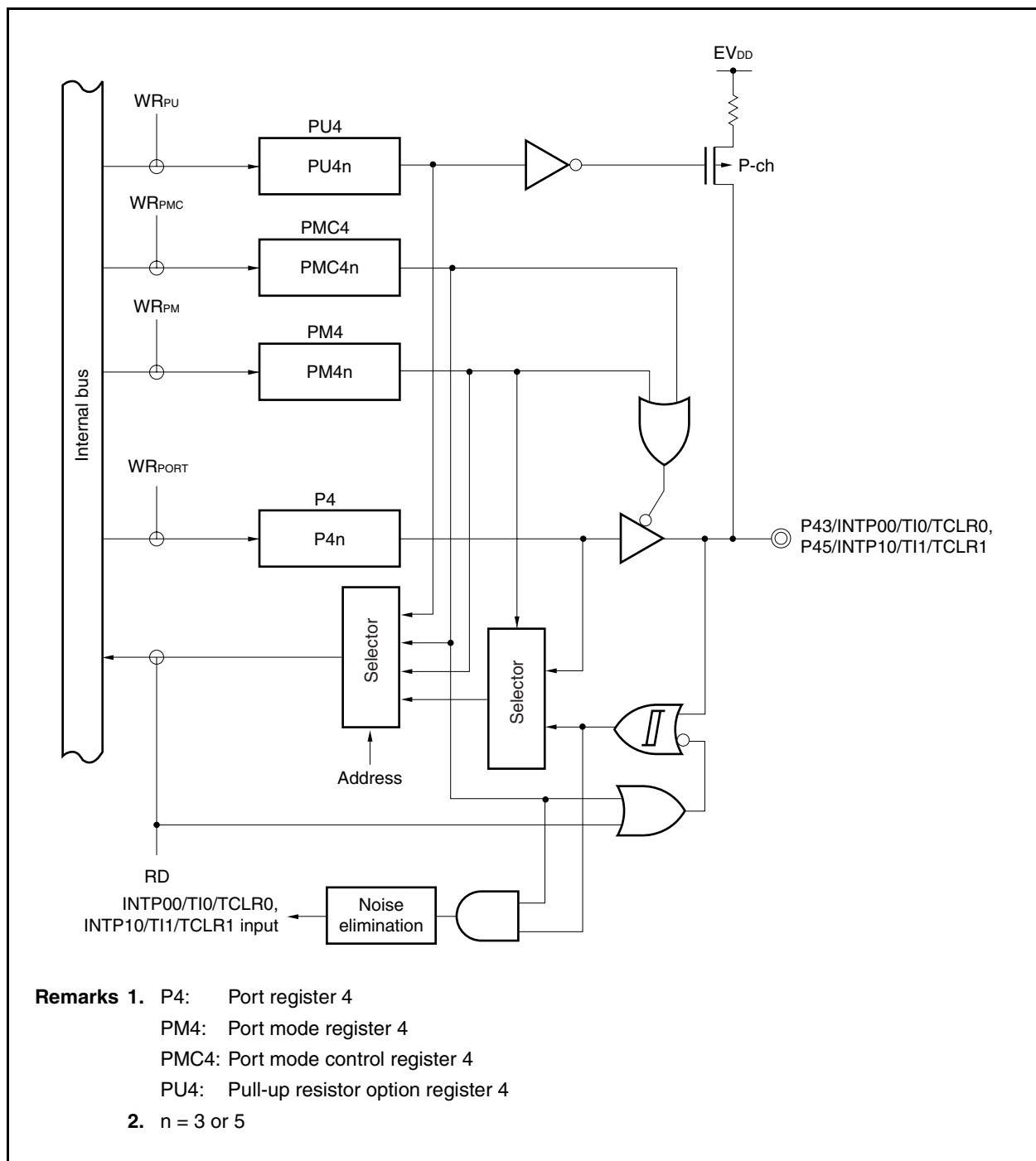
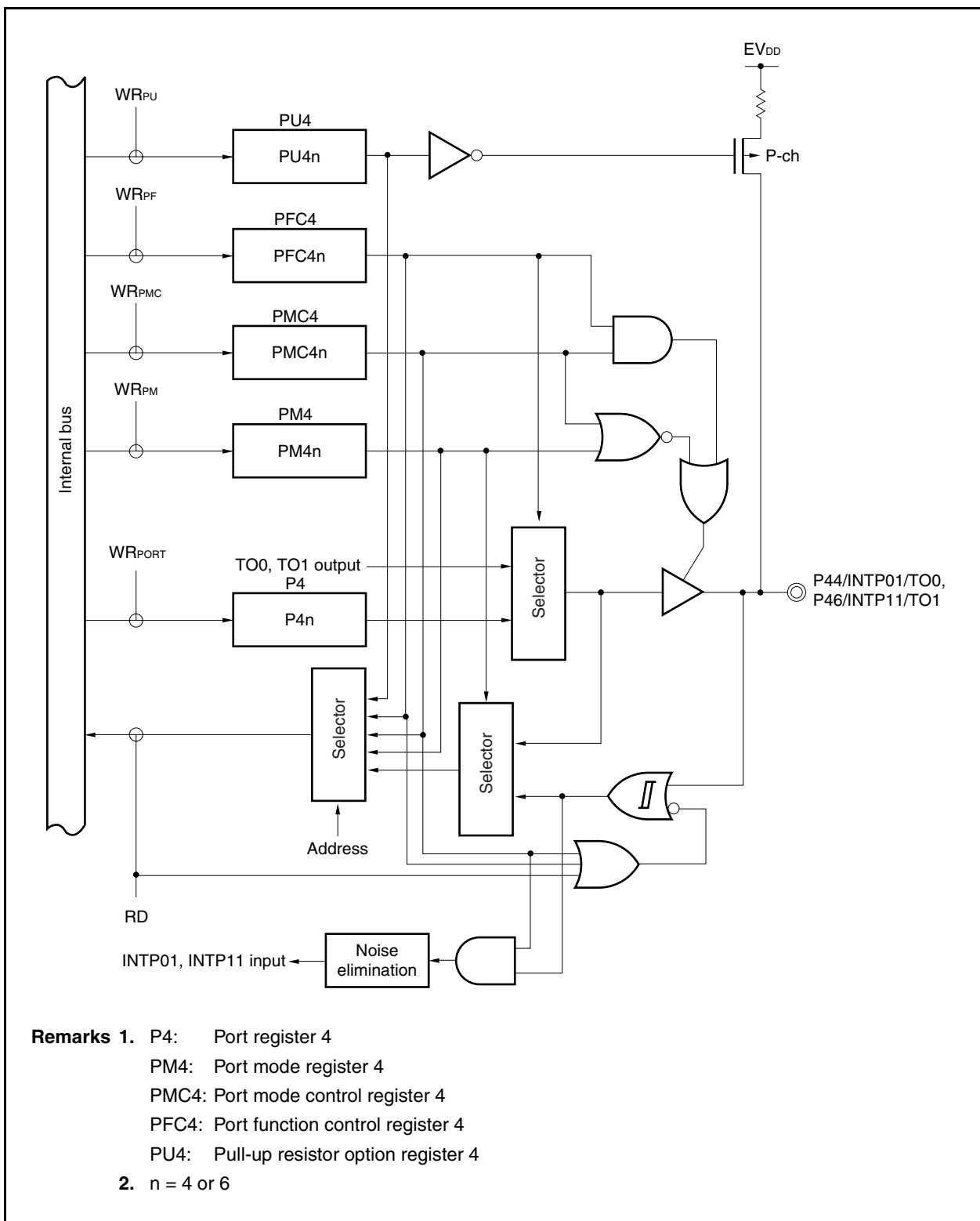


Figure 4-15. Block Diagram of P44 and P46



4.3.5 Port 7

All the pins of port 7 are fixed to the input mode.

The number of input port bits differs depending on the product.

Commercial Name	Number of I/O Port Bits
V850ES/SA2	12-bit input port
V850ES/SA3	16-bit input port

(1) Function of port 7

- Input data can be specified in 1-bit units by using port register 7 (P7).

Port 7 has an alternate function as the following pins.

Table 4-8. Alternate-Function Pins of Port 7

Pin Name	Alternate-Function Pin	I/O	PULL ^{Note 1}	Remark	
Port 7	P70	ANI0	Input	None	-
	P71	ANI1			
	P72	ANI2			
	P73	ANI3			
	P74	ANI4			
	P77	ANI5			
	P76	ANI6			
	P77	ANI7			
	P78	ANI8			
	P79	ANI9			
	P710	ANI10			
	P711	ANI11			
	P712 ^{Note 2}	ANI12 ^{Note 2}			
	P713 ^{Note 2}	ANI13 ^{Note 2}			
	P714 ^{Note 2}	ANI14 ^{Note 2}			
P715 ^{Note 2}	ANI15 ^{Note 2}				

Notes 1. Software pull-up function

2. V850ES/SA3 only

(2) Register

(a) Port register 7 (P7)

Port register 7 is a 16-bit register that is used to read the pin level.

This register is read-only, in 16-bit units.

If the higher 8 bits of the P7 register are used as P7H, and the lower 8 bits as P7L, however, this register can be read in 8-bit or 1-bit units.

After reset: Undefined R Address: FFFFF40EH, FFFFF40FH

	15	14	13	12	11	10	9	8
P7	P715 ^{Note}	P714 ^{Note}	P713 ^{Note}	P712 ^{Note}	P711	P710	P79	P78
	7	6	5	4	3	2	1	0
	P77	P76	P75	P74	P73	P72	P71	P70

P7n	Reads input data (V850ES/SA2: n = 0 to 12, V850ES/SA3: n = 0 to 15)
0	Inputs low level.
1	Inputs high level.

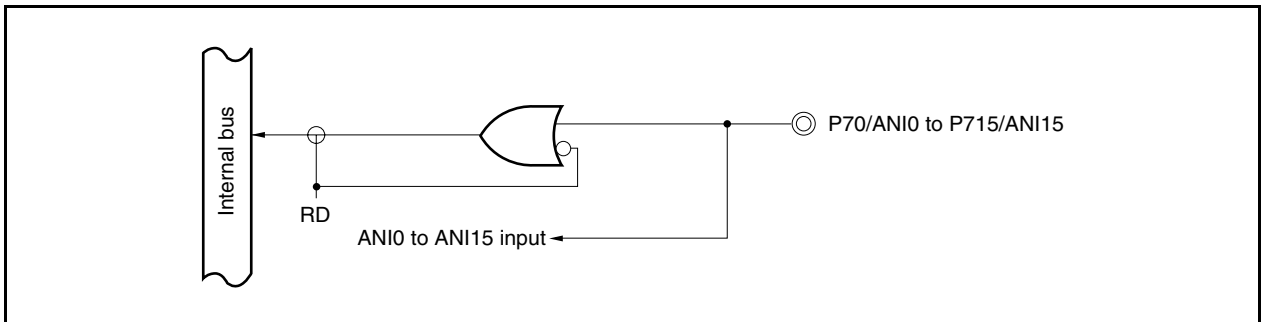
Note Bits 15 to 12 are valid only in the V850ES/SA3. These bits are undefined in the V850ES/SA2.

Caution Do not read the P7 register during A/D conversion.

- Remarks**
1. If port 7 (P7) is read, the pin levels at that time can be read.
 2. After reset, an undefined value (pin input level) is read when P7 is read.

(3) Block diagram

Figure 4-16. Block Diagram of P70 to P715



4.3.6 Port 8

Port 8 can control input/output in 1-bit units.

The number of I/O port bits of each product is the same.

Commercial Name	Number of I/O Port Bits
V850ES/SA2	2-bit I/O port
V850ES/SA3	2-bit I/O port

(1) Function of port 8

- Input data can be specified in 1-bit units by using port register 8 (P8).

Port 8 has an alternate function as the following pins.

Table 4-9. Alternate-Function Pins of Port 8

Pin Name	Alternate-Function Pin	I/O	PULL ^{Note}	Remark	
Port 8	P80	ANO0	Input	None	-
	P81	ANO1			

Note Software pull-up function

(2) Register

(a) Port register 8 (P8)

Port register 8 (P8) is an 8-bit register that is used to read the pin level.

This register is read-only, in 8-bit or 1-bit units.

After reset: Undefined R Address: FFFFF410H

	7	6	5	4	3	2	1	0
P8	0	0	0	0	0	0	P81	P80

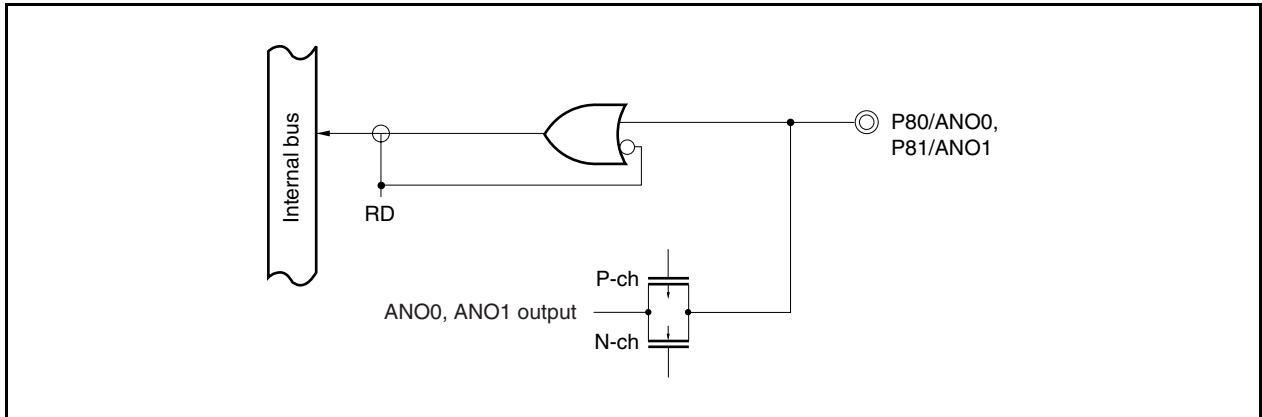
P8n	Reads input data (n = 0 or 1)
0	Inputs low level.
1	Inputs high level.

Remarks

1. If port 8 (P8) is read, the pin levels at that time can be read.
2. After reset, an undefined value (pin input level) is read when P8 is read.

(3) Block diagram

Figure 4-17. Block Diagram of P80 and P81



4.3.7 Port 9

Port 9 can be set to the input or output mode in 1-bit units.

The number of I/O port bits each product is the same.

Commercial Name	Number of I/O Port Bits
V850ES/SA2	16-bit I/O port
V850ES/SA3	16-bit I/O port

(1) Functions of port 9

- Input/output data can be specified in 1-bit units by using port register 9 (P9).
- Can be set to the input or output mode in 1-bit units by using port mode register 9 (PM9).
- Can be set to the port mode or control mode (alternate function) in 1-bit units by using port mode control register 9 (PMC9).
- N-ch open-drain output can be set in 1-bit units by using port function register 9 (PF9).
- Control mode 1 or control mode 2 can be specified in 1-bit units by using port function control register 9 (PFC9).
- The internal pull-up resistor can be connected in 1-bit units by using pull-up resistor option register 9 (PU9).
- The valid edge of the external interrupt (alternate function) can be set in 1-bit units by using external interrupt falling edge specification register 9 (INTF9) and external interrupt rising edge specification register 9 (INTR9).

Port 9 has an alternate function as the following pins.

Table 4-10. Alternate-Function Pins of Port 9

Pin Name	Alternate-Function Pin	I/O	PULL ^{Note}	Remark	
Port 9	P90	A0	I/O	None	-
	P91	A1			
	P92	A2/INTP5			
	P93	A3/INTP6			
	P94	A4/TO2			
	P95	A5/TO3			
	P96	A6/TO4			
	P97	A7/TO5			
	P98	A8/RXD1			
	P99	A9/TXD1			
	P910	A10/SI2			
	P911	A11/SO2			
	P912	A12/ $\overline{\text{SCK2}}$			
	P913	A13/SI3			
	P914	A14/SO3			
P915	A15/ $\overline{\text{SCK3}}$				

Note Software pull-up function

(2) Registers

(a) Port register 9 (P9)

Port register 9 (P9) is a 16-bit register that controls reading a pin level and writing an output level. This register can be read or written in 8-bit or 1-bit units.

If the higher 8 bits of the P9 register is used as P9H and the lower 8 bits as P9L, however, P9H and P9L can be manipulated in 8-bit or 1-bit units.

After reset: Undefined R/W Address: FFFFF412H, FFFFF413H

	15	14	13	12	11	10	9	8
P9	P915	P914	P913	P912	P911	P910	P99	P98
	7	6	5	4	3	2	1	0
	P97	P96	P95	P94	P93	P92	P91	P90

P9n	Controls output data (in output mode) (n = 0 to 15)
0	Outputs 0.
1	Outputs 1.

Remarks 1. In input mode: When port 9 (P9) is read, the pin level at that time is read. When written, the data written to P9 is written. The input pin is not affected.
 In output mode: When port 9 (P9) is read, the value of P9 is read. When a value is written to P9, it is immediately output.

2. After reset, an undefined value (pin input level) is read from P9 in the input mode. When P9 is read in the output mode, 00H (value of the output latch) is read.

(b) Port mode register 9 (PM9)

This is a 16-bit register that specifies the input or output mode.

This register can be read or written only in 16-bit units.

If the higher 8 bits of the PM9 register is used as PM9H and the lower 8 bits as PM9L, however, PM9H and PM9L can be manipulated in 8-bit or 1-bit units.

After reset: FFFFH R/W Address: FFFFF432H, FFFFF433H

	15	14	13	12	11	10	9	8
PM9	PM915	PM914	PM913	PM912	PM911	PM910	PM99	PM98
	7	6	5	4	3	2	1	0
	PM97	PM96	PM95	PM94	PM93	PM92	PM91	PM90

PM9n	Controls input/output mode (n = 0 to 15)
0	Output mode
1	Input mode

(c) Port mode control register 9 (PMC9)

This is a 16-bit register that specifies the port mode or control mode.

This register can be read or written only in 16-bit units.

If the higher 8 bits of the PMC9 register is used as PMC9H and the lower 8 bits as PMC9L, however, PMC9H and PMC9L can be manipulated in 8-bit or 1-bit units.

(1/2)

After reset: 0000H		R/W	Address: FFFF452H, FFFF453H					
PMC9	15	14	13	12	11	10	9	8
	PMC915	PMC914	PMC913	PMC912	PMC911	PMC910	PMC99	PMC98
	7	6	5	4	3	2	1	0
	PMC97	PMC96	PMC95	PMC94	PMC93	PMC92	PMC91	PMC90
PMC915	Specifies operation mode of P915 pin							
0	I/O port							
1	A15/ $\overline{\text{SCK3}}$ I/O							
PMC914	Specifies operation mode of P914 pin							
0	I/O port							
1	A14/SO3 output							
PMC913	Specifies operation mode of P612 pin							
0	I/O port							
1	A13/SI3 I/O							
PMC912	Specifies operation mode of P611 pin							
0	I/O port							
1	A12/ $\overline{\text{SCK2}}$ I/O							
PMC911	Specifies operation mode of P610 pin							
0	I/O port							
1	A11/SO2 output							
PMC910	Specifies operation mode of P69 pin							
0	I/O port							
1	A10/SI2 input							
PMC99	Specifies operation mode of P99 pin							
0	I/O port							
1	A9/TXD1 I/O							

PMC98	Specifies operation mode of P98 pin	
0	I/O port	
1	A8/RXD1 I/O	
PMC97	Specifies operation mode of P97 pin	
0	I/O port	
1	A7/TO5 output	
PMC96	Specifies operation mode of P96 pin	
0	I/O port	
1	A6/TO4 output	
PMC95	Specifies operation mode of P95 pin	
0	I/O port	
1	A5/TO3 output	
PMC94	Specifies operation mode of P94 pin	
0	I/O port	
1	A4/TO2 output	
PMC93	Specifies operation mode of P93 pin	
0	I/O port	
1	A3/INTP6 I/O	
PMC92	Specifies operation mode of P92 pin	
0	I/O port	
1	A2/INTP5 I/O	
PMC91	Specifies operation mode of P91 pin	
0	I/O port	
1	A1 output	
PMC90	Specifies operation mode of P90 pin	
0	I/O port	
1	A0 output	

(d) Port function control register 9 (PFC9)

This 16-bit register specifies control mode 1 or control mode 2.

It can be read or written only in 16-bit units.

If the higher 8 bits of the PFC9 register are used as PFC9H and the lower 8 bits as PFC9L, however, PFC9H and PFC9L can be manipulated in 8-bit or 1-bit units.

Caution To perform separate address bus output (A0 to A15), set the PFC9 register to 0000H, and then set the PMC9 register to FFFFH in 16-bit units.

(1/2)

After reset: 0000H		R/W		Address: FFFFF472H, FFFFF473H				
PFC9	15	14	13	12	11	10	9	8
	PFC910	PFC910	PFC910	PFC910	PFC910	PFC910	PFC99	PFC98
	7	6	5	4	3	2	1	0
	PFC97	PFC96	PFC95	PFC94	PFC93	PFC92	0	0
PFC915	Specifies operation mode of P915 pin in control mode							
0	A15 output (with separate bus)							
1	SCK3 I/O							
PFC914	Specifies operation mode of P914 pin in control mode							
0	A14 output (with separate bus)							
1	SO3 output							
PFC913	Specifies operation mode of P913 pin in control mode							
0	A13 output (with separate bus)							
1	SI3 input							
PFC912	Specifies operation mode of P912 pin in control mode							
0	A12 output (with separate bus)							
1	SCK2 I/O							
PFC911	Specifies operation mode of P911 pin in control mode							
0	A11 output (with separate bus)							
1	SO2 output							
PFC910	Specifies operation mode of P910 pin in control mode							
0	A10 output (with separate bus)							
1	SI2 input							
PFC99	Specifies operation mode of P99 pin in control mode							
0	A9 output (with separate bus)							
1	TXD1 output							

PFC98	Specifies operation mode of P98 pin in control mode
0	A8 output (with separate bus)
1	RXD1 input
PFC97	Specifies operation mode of P97 pin in control mode
0	A7 output (with separate bus)
1	TO5 output
PFC96	Specifies operation mode of P96 pin in control mode
0	A6 output (with separate bus)
1	TO4 output
PFC95	Specifies operation mode of P95 pin in control mode
0	A5 output (with separate bus)
1	TO3 output
PFC94	Specifies operation mode of P94 pin in control mode
0	A4 output (with separate bus)
1	TO2 output
PFC93	Specifies operation mode of P93 pin in control mode
0	A3 output (with separate bus)
1	INTP6 input
PFC92	Specifies operation mode of P92 pin in control mode
0	A2 output (with separate bus)
1	INTP5 input

(e) Port function register 9 (PF9)

This 16-bit register specifies normal output or N-ch open-drain output.

The PF9 register can be read or written only in 16-bit units. If the higher 8 bits of the PF9 register are used as PF9H and the lower 8 bits as PF9L, however, PF9H and PF9L can be manipulated in 8-bit or 1-bit units.

After reset: 0000H R/W Address: PF9: FFFFC72H, PF9H: FFFFC73H

	15	14	13	12	11	10	9	8
PF9	PF915	PF914	0	PF912	PF911	0	0	0

	7	6	5	4	3	2	1	0
	0	0	0	0	0	0	0	0

PF9n	Controls normal output or N-ch open-drain output (n = 11, 12, 14, or 15)
0	Normal output
1	N-ch open-drain output

- Cautions**
- 1. The N-ch open-drain output voltage is the normal voltage, not the medium voltage.**
 - 2. PF9n = 1 is enabled only in the following cases. Otherwise, the setting is prohibited.**
 - n = 1: SO2
 - n = 2: SCK2
 - n = 4: SO3
 - n = 5: SCK3

(f) Pull-up resistor option register 9 (PU9)

This is a 16-bit register that specifies connection of an internal pull-up resistor.

This register can be read or written only in 16-bit units.

If the higher 8 bits of the PU9 register are used as PU9H and the lower 8 bits as PU9L, however, PU9H and PU9L can be manipulated in 8-bit or 1-bit units.

After reset: 0000H R/W Address: FFFFC52H, FFFFC53H

	15	14	13	12	11	10	9	8
PU9	PU915	PU914	PU913	PU912	PU911	PU910	PU99	PU98

	7	6	5	4	3	2	1	0
	PU97	PU96	PU95	PU94	PU93	PU92	PU91	PU90

PU9n	Controls connection of internal pull-up resistor (n = 0 to 15)
0	Not connected
1	Connected

(g) External interrupt falling edge specification register 9 (INTF9)

This 16-bit register specifies detection of the falling edge of the external interrupt pins. It can be read or written only in 16-bit units. If the higher 8 bits of the INTF9 register are used as INTF9H and the lower 8 bits as INTF9L, however, INTF9H and INTF9L can be manipulated in 8-bit or 1-bit units.

Caution Set the port mode after clearing the INTF9n and INTR9n bits to 0 when switching from the external interrupt function (alternate function) to the port function because an edge may be detected.

After reset: 0000H	R/W	Address: INTF9: FFFFC12H, INTF9L: FFFFC12H							
INTF9	15	14	13	12	11	10	9	8	
	0	0	0	0	0	0	0	0	
	7	6	5	4	3	2	1	0	
	0	0	0	0	INTF93	INTF92	0	0	

Remark For how to specify a valid edge, refer to **Table 4-11**.

(h) External interrupt rising edge specification register 9 (INTR9)

This 16-bit register specifies detection of the rising edge of the external interrupt pins. It can be read or written only in 16-bit units. If the higher 8 bits of the INTR9 register are used as INTR9H and the lower 8 bits as INTR9L, however, INTR9H and INTR9L can be manipulated in 8-bit or 1-bit units.

Caution Set the port mode after clearing the INTF9n and INTR9n bits to 0 when switching from the external interrupt function (alternate function) to the port function because an edge may be detected.

After reset: 0000H	R/W	Address: INTR9: FFFFC32H, INTR9L: FFFFC32H							
INTR9	15	14	13	12	11	10	9	8	
	0	0	0	0	0	0	0	0	
	7	6	5	4	3	2	1	0	
	0	0	0	0	INTR93	INTR92	0	0	

Remark For how to specify a valid edge, refer to **Table 4-11**.

Table 4-11. Specifying Valid Edge

INTF9n	INTR9n	Specifies valid edge (n = 2 or 3).
0	0	Detects no edge.
0	1	Rising edge
1	0	Falling edge
1	1	Both edges

Caution When INTP5 and INTP6 are not used, be sure to clear INTF9n and INTR9n to “00”.

Remark n = 2 or 3: Control of INTP5 or INTP6 pin

(3) Block diagram

Figure 4-18. Block Diagram of P90 and P91

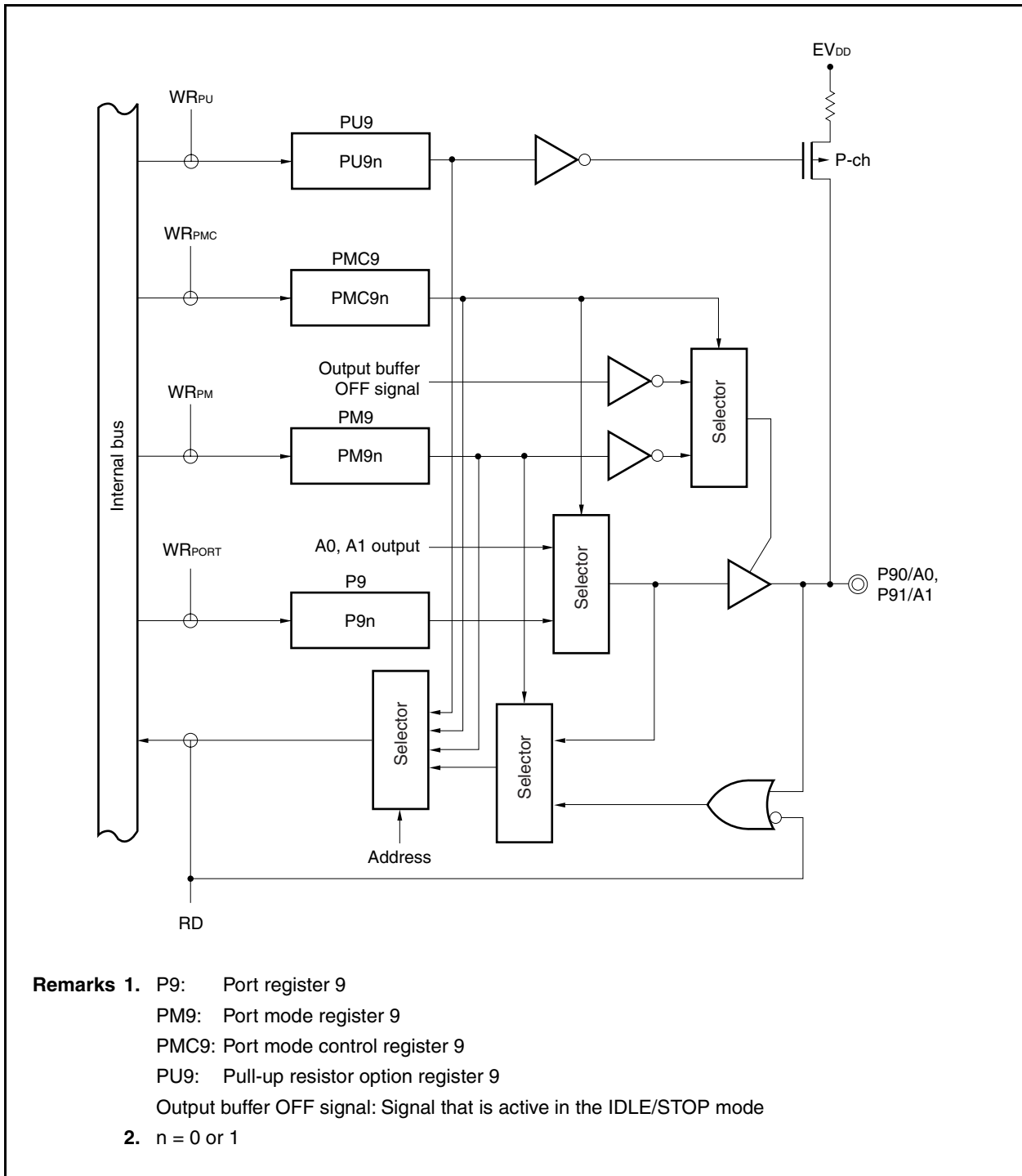
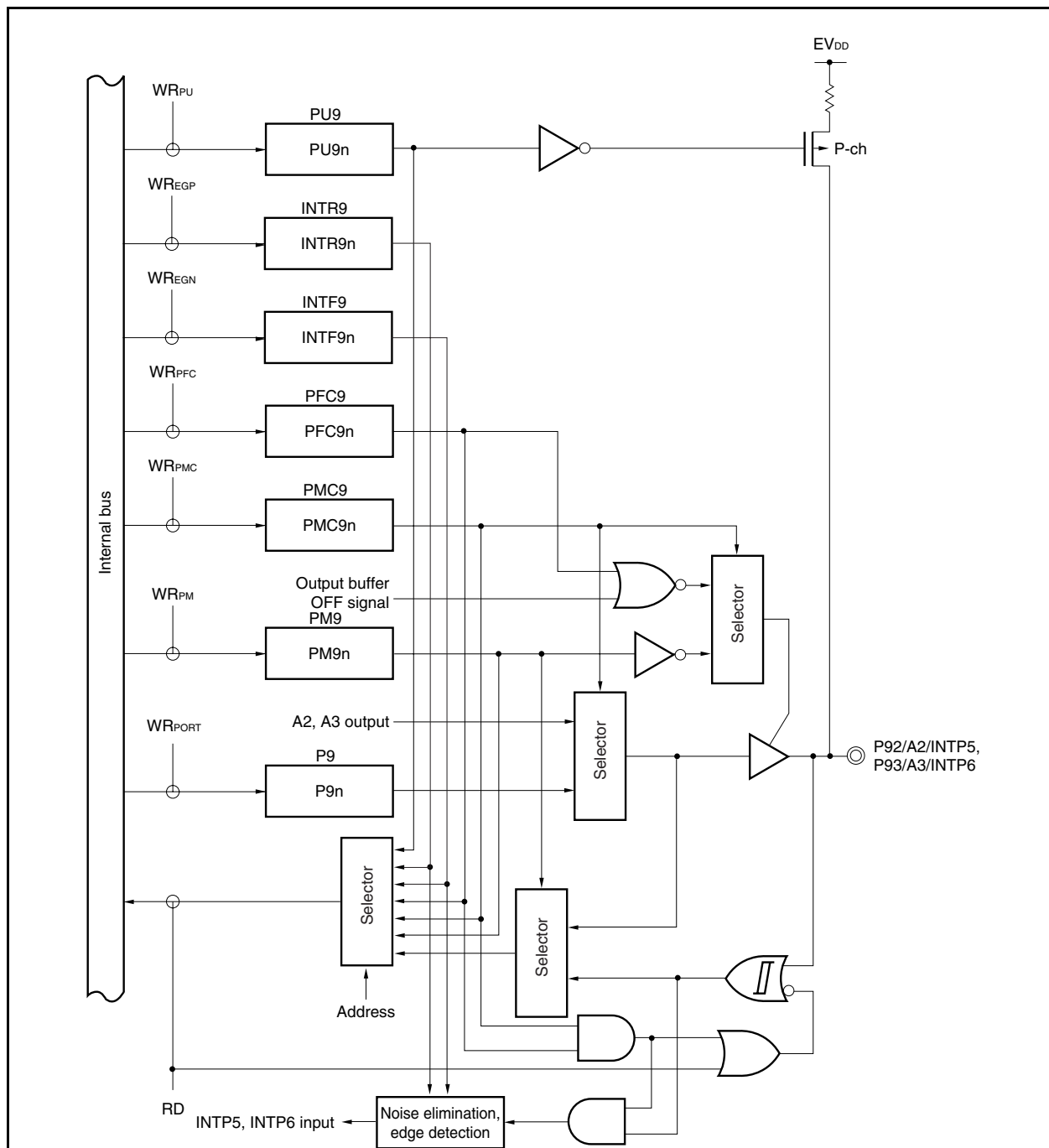


Figure 4-19. Block Diagram of P92 and P93



- Remarks 1.** P9: Port register 9
 PM9: Port mode register 9
 PMC9: Port mode control register 9
 PFC9: Port function control register 9
 PU9: Pull-up resistor option register 9
 INTR9: External interrupt rising edge specification register 9
 INTF9: External interrupt falling edge specification register 9
 Output buffer OFF signal: Signal that is active in the IDLE/STOP mode
- 2.** n = 2 or 3

Figure 4-20. Block Diagram of P94 to P97 and P99

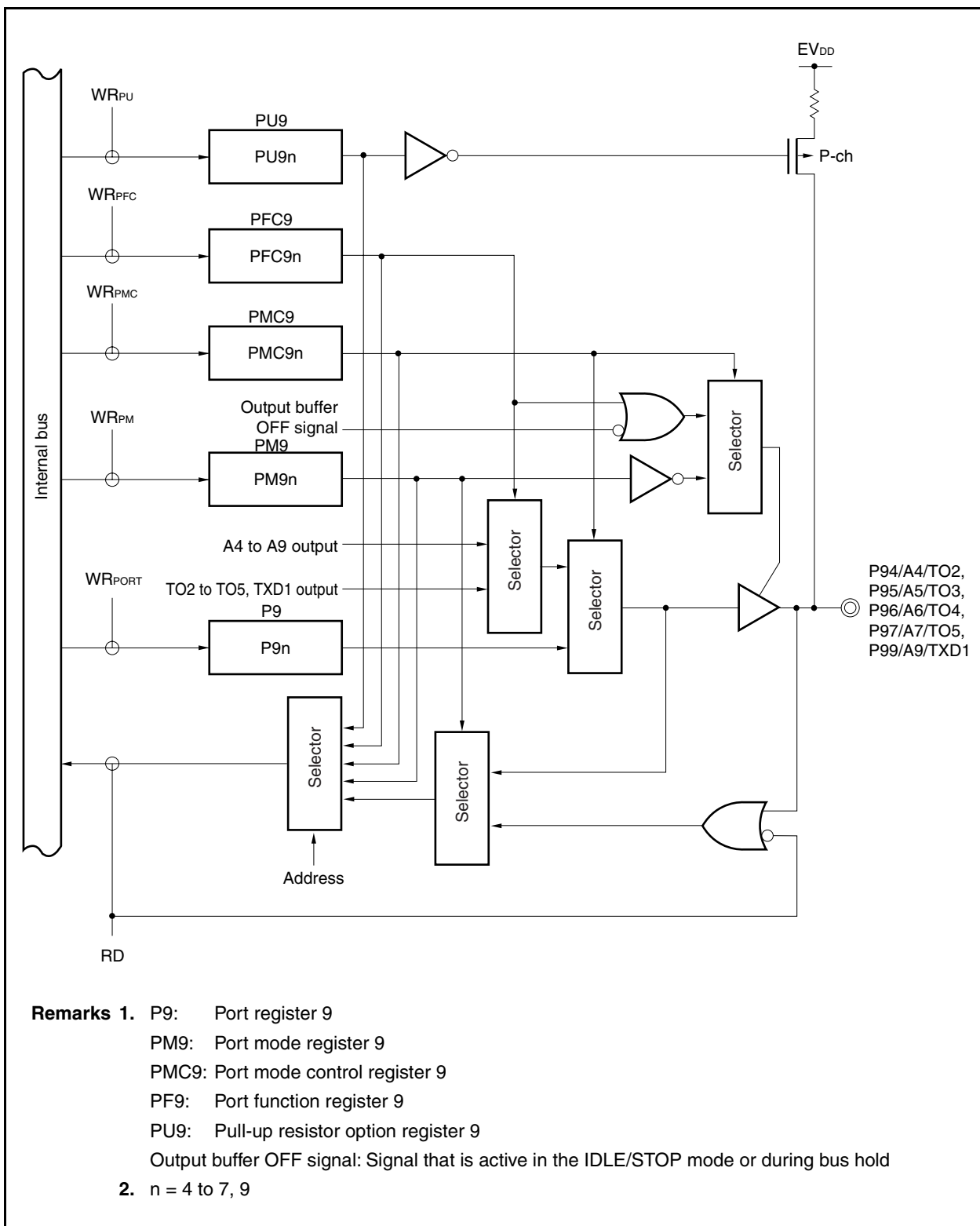


Figure 4-21. Block Diagram of P98, P910, and P913

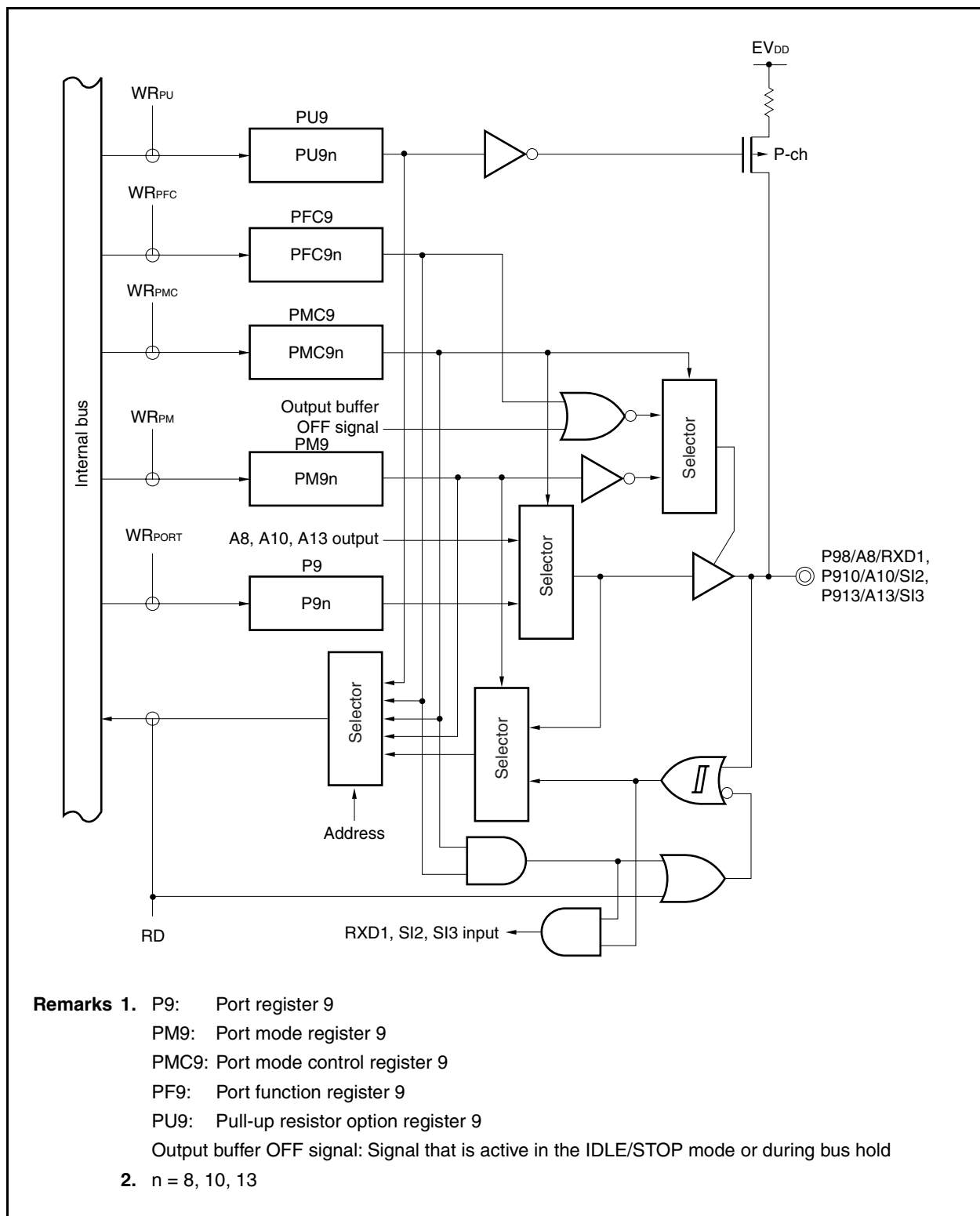
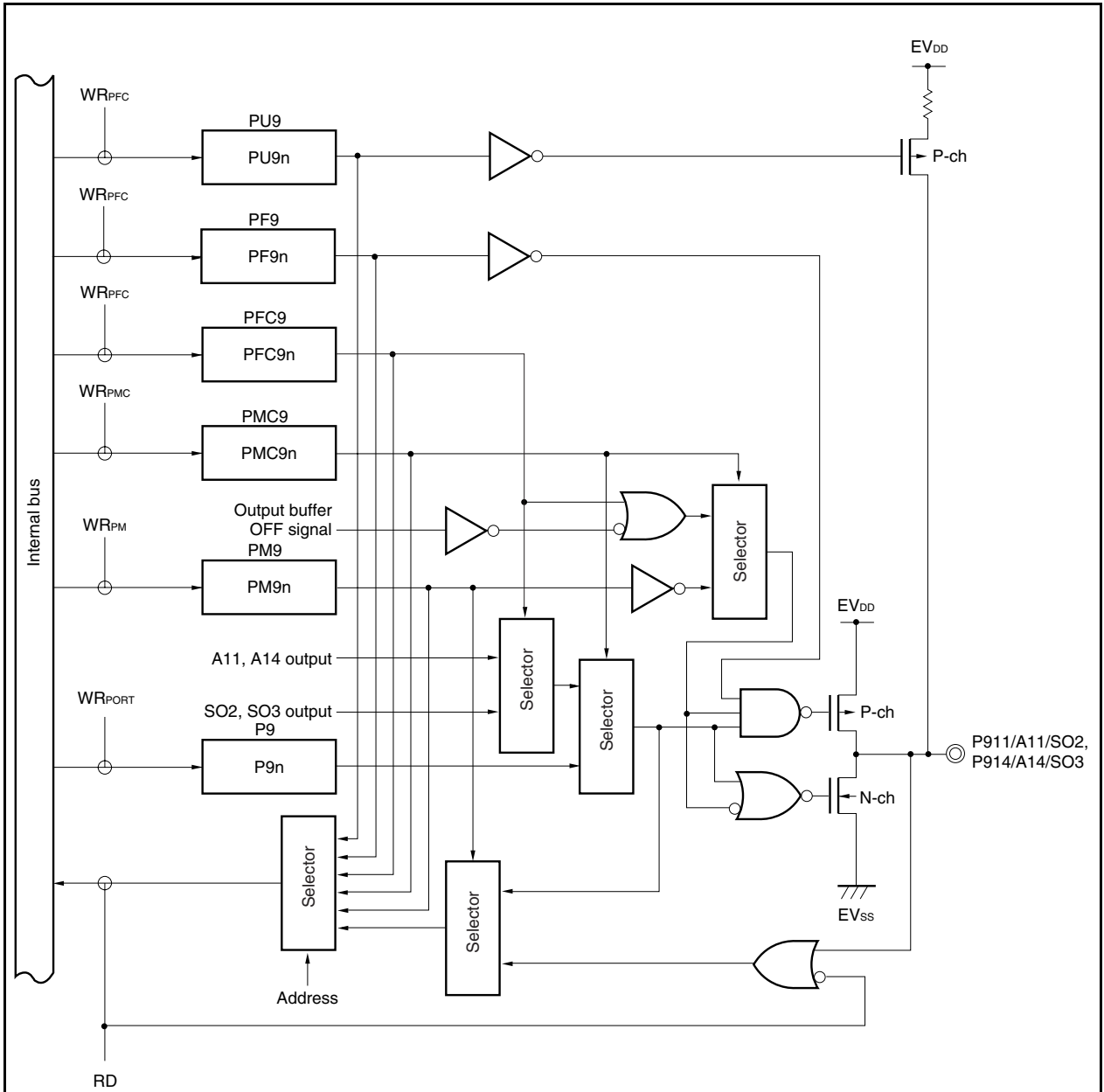
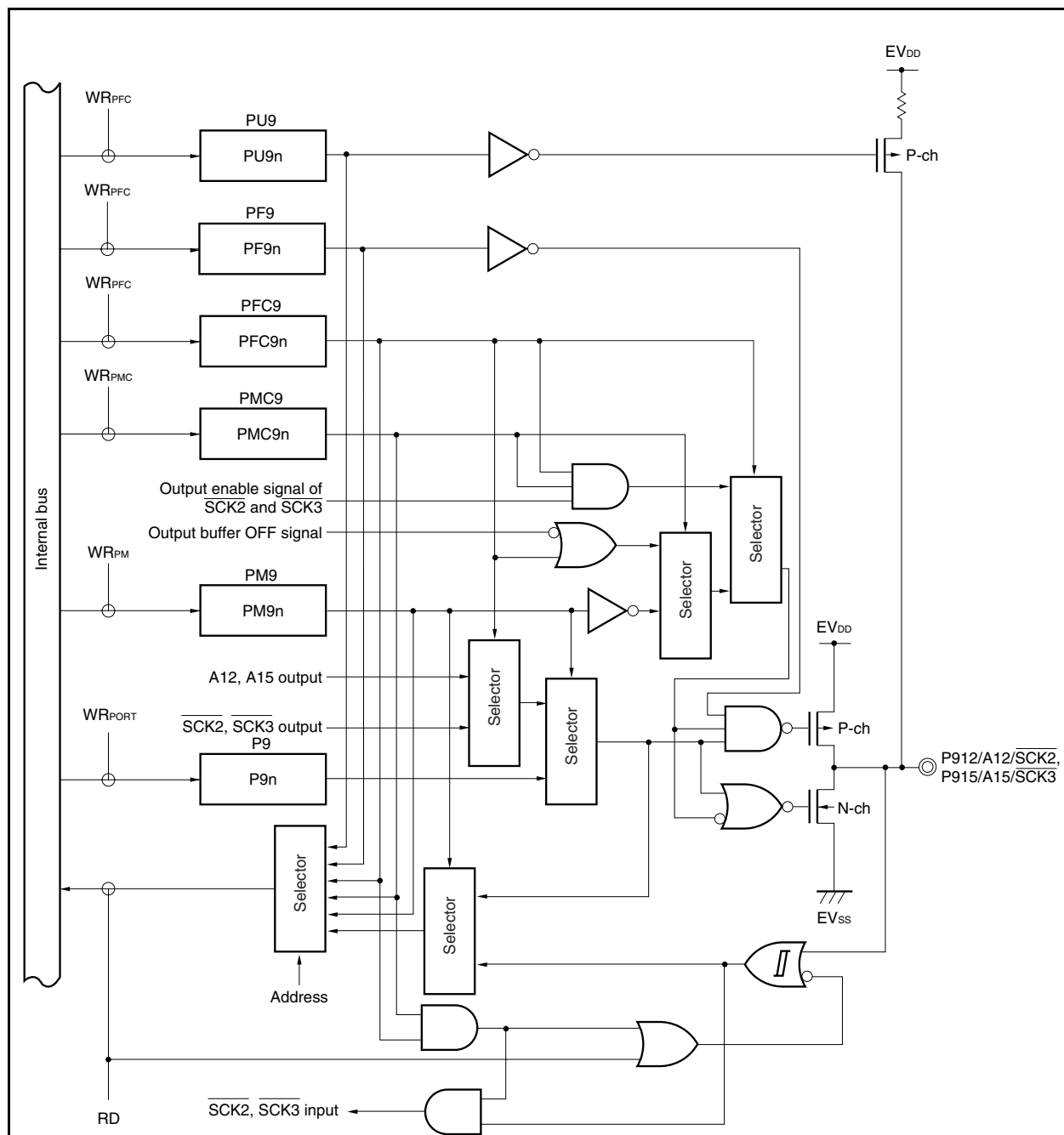


Figure 4-22. Block Diagram of P911 and P914



- Remarks 1.** P9: Port register 9
 PM9: Port mode register 9
 PMC9: Port mode control register 9
 PFC9: Port function control register 9
 PF9: Port function register 9
 PU9: Pull-up resistor option register 9
 Output buffer OFF signal: Signal that is active in the IDLE/STOP mode or during bus hold
- 2.** n = 11, 14

Figure 4-23. Block Diagram of P912 and P915



- Remarks 1.** P9: Port register 9
 PM9: Port mode register 9
 PMC9: Port mode control register 9
 PFC9: Port function control register 9
 PF9: Port function register 9
 PU9: Pull-up resistor option register 9
 Output buffer OFF signal: Signal that is active in the IDLE/STOP mode or during bus hold
- 2.** n = 12 or 15

4.3.8 Port CD

Port CD can be set to the input or output mode in 1-bit units.

The number of I/O port bits differs depending on the product.

Commercial Name	Number of I/O Port Bits
V850ES/SA2	–
V850ES/SA3	3-bit I/O port

(1) Functions of port CD (V850ES/SA3)

- Input/output data can be specified in 1-bit units by using port register CD (PCD).
- Can be set to the input or output mode in 1-bit units by using port mode register CD (PMCD).

Port CD has no alternate-function pins.

Table 4-12. Alternate-Function Pins of Port CD (V850ES/SA3)

Pin Name		Alternate-Function Pin	I/O	PULL ^{Note}	Remark
Port CD	PCD1	–	I/O	None	–
	PCD2	–			
	PCD3	–			

Note Software pull-up function

(2) Registers

(a) Port register CD (PCD)

Port register CD (PCD) is an 8-bit register that controls reading the pin level and writing the output level. This register can be read or written in 8-bit or 1-bit units.

After reset: Undefined R/W Address: FFFFF00EH

	7	6	5	4	3	2	1	0
PCD	0	0	0	0	PCD3	PCD2	PCD1	0

PCDn	Controls output data (in output mode) (n = 1 to 3)
0	Outputs 0.
1	Outputs 1.

Remarks 1. In input mode: When port CD (PCD) is read, the pin level at that time is read. When written, the data written to PCD is written. The input pin is not affected.
 In output mode: When port CD (PCD) is read, the value of PCD is read. When a value is written to PCD, it is immediately output.

2. After reset, an undefined value (pin input level) is read from PCD in the input mode. When PCD is read in the output mode, 00H (value of the output latch) is read.

(b) Port mode register CD (PMCD)

This is an 8-bit register that specifies the input or output mode. This register can be read or written only in 16-bit units.

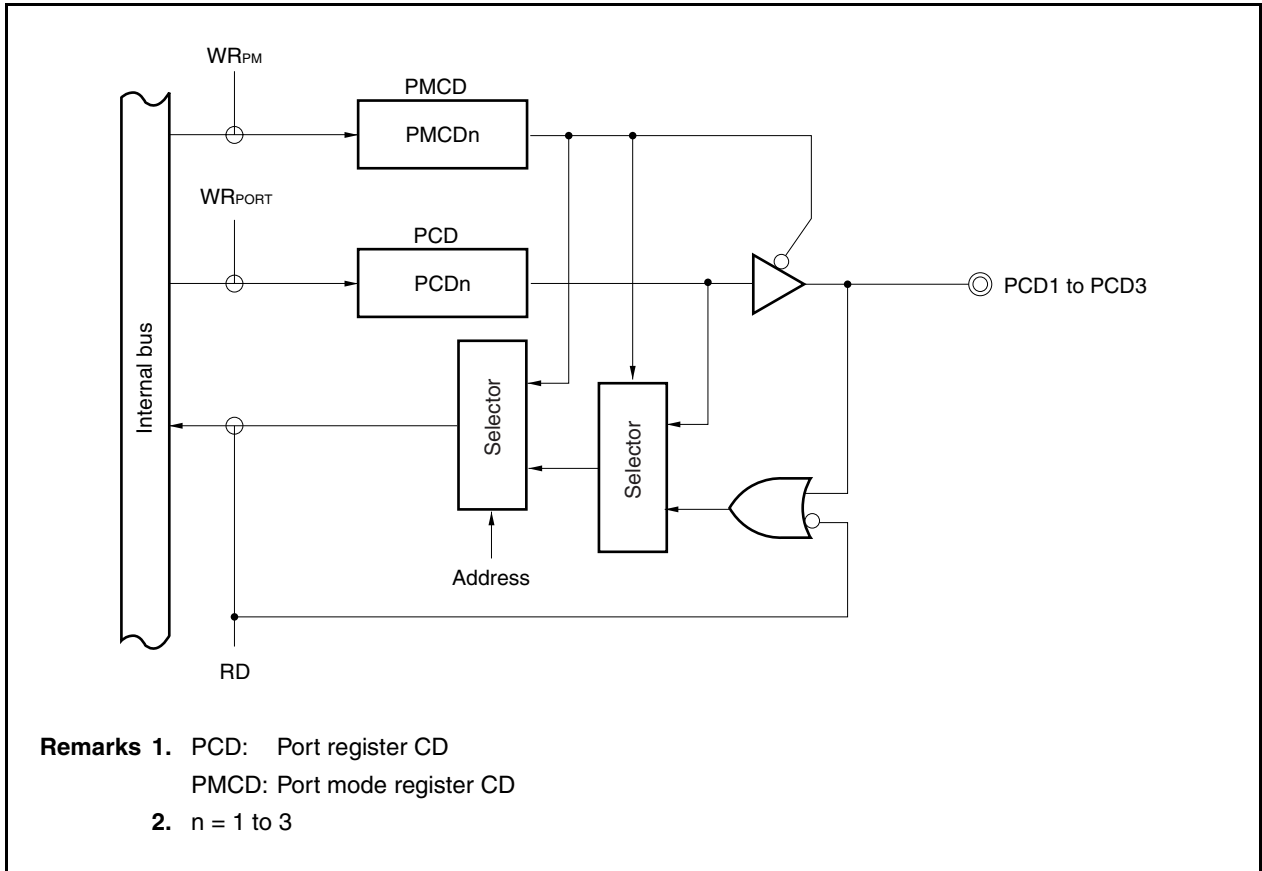
After reset: FFH R/W Address: FFFFF02EH

	7	6	5	4	3	2	1	0
PMCD	1	1	1	1	PMCD3	PMCD2	PMCD1	1

PMCDn	Controls input/output mode (n = 1 to 3)
0	Output mode
1	Input mode

(3) Block diagram

Figure 4-24. Block Diagram of PCD1 to PCD3



4.3.9 Port CM

Port CM can be set to the input or output mode in 1-bit units.

The number of I/O port bits differs depending on the product.

Commercial Name	Number of I/O Port Bits
V850ES/SA2	4-bit I/O port
V850ES/SA3	6-bit I/O port

(1) Functions of port CM

- Input/output data can be specified in 1-bit units by using port register CM (PCM).
- Can be set to the input or output mode in 1-bit units by using port mode register CM (PMCM).
- Can be set to the port mode or control mode (alternate function) in 1-bit units by using port mode control register CM (PMCCM).

Port CM has an alternate function as the following pins.

Table 4-13. Alternate-Function Pins of Port CM

Pin Name		Alternate-Function Pin	I/O	PULL ^{Note 1}	Remark
Port CM	PCM0	WAIT	I/O	None	-
	PCM1	CLKOUT			
	PCM2	HLDAK			
	PCM3	HLDQR			
	PCM4 ^{Note 2}	-			
	PCM5 ^{Note 2}	-			

Notes 1. Software pull-up function

2. V850ES/SA3 only

(2) Registers

(a) Port register CM (PCM)

Port register PCM (PCM) is an 8-bit register that controls reading the pin level and writing the output level. This register can be read or written in 8-bit or 1-bit units.

After reset: Undefined R/W Address: FFFF00CH

	7	6	5	4	3	2	1	0
PCM	0	0	PCM5 ^{Note}	PCM4 ^{Note}	PCM3	PCM2	PCM1	PCM0

PCMn	Controls output data (in output mode) (V850ES/SA2: n = 0 to 3, V850ES/SA3: n = 0 to 5)
0	Outputs 0.
1	Outputs 1.

Note Bits 5 and 4 are provided in the V850ES/SA3 only. Be sure to clear these bits to 0 in the V850ES/SA2.

Remarks 1. In input mode: When port CM (PCM) is read, the pin level at that time is read. When written, the data written to PCM is written. The input pin is not affected.
 In output mode: When port CM (PCM) is read, the value of PCM is read. When a value is written to PCM, it is immediately output.

2. After reset, an undefined value (pin input level) is read from PCM in the input mode. When PCM is read in the output mode, 00H (value of the output latch) is read.

(b) Port mode register CM (PMCM)

This is an 8-bit register that specifies the input or output mode. This register can be read or written in 8-bit or 1-bit units.

After reset: FFH R/W Address: FFFF02CH

	7	6	5	4	3	2	1	0
PMCM	1	1	PMCM5 ^{Note}	PMCM4 ^{Note}	PMCM3	PMCM2	PMCM1	PMCM0

PMCMn	Controls input/output mode (V850ES/SA2: n = 0 to 3, V850ES/SA3: n = 0 to 5)
0	Output mode
1	Input mode

Note Bits 5 and 4 are provided in the V850ES/SA3 only. Be sure to set these bits to 1 in the V850ES/SA2.

(c) Port mode control register CM (PMCCM)

This is an 8-bit register that specifies the port mode or control mode.

It can be read or written in 8-bit or 1-bit units.

After reset: 00H		R/W	Address: FFFFF04CH					
	7	6	5	4	3	2	1	0
PMCCM	0	0	0	0	PMCCM3	PMCCM2	PMCCM1	PMCCM0
	PMCCM3 Specifies operation mode of PCM3 pin							
	0	I/O port						
	1	$\overline{\text{HLDQR}}$ input						
	PMCCM2 Specifies operation mode of PCM2 pin							
	0	I/O port						
	1	$\overline{\text{HLDK}}$ input						
	PMCCM1 Specifies operation mode of PCM1 pin							
	0	I/O port						
	1	CLKOUT output						
	PMCCM0 Specifies operation mode of PCM0 pin							
	0	I/O port						
	1	$\overline{\text{WAIT}}$ input						

(3) Block diagram

Figure 4-25. Block Diagram of PCM0 and PCM3

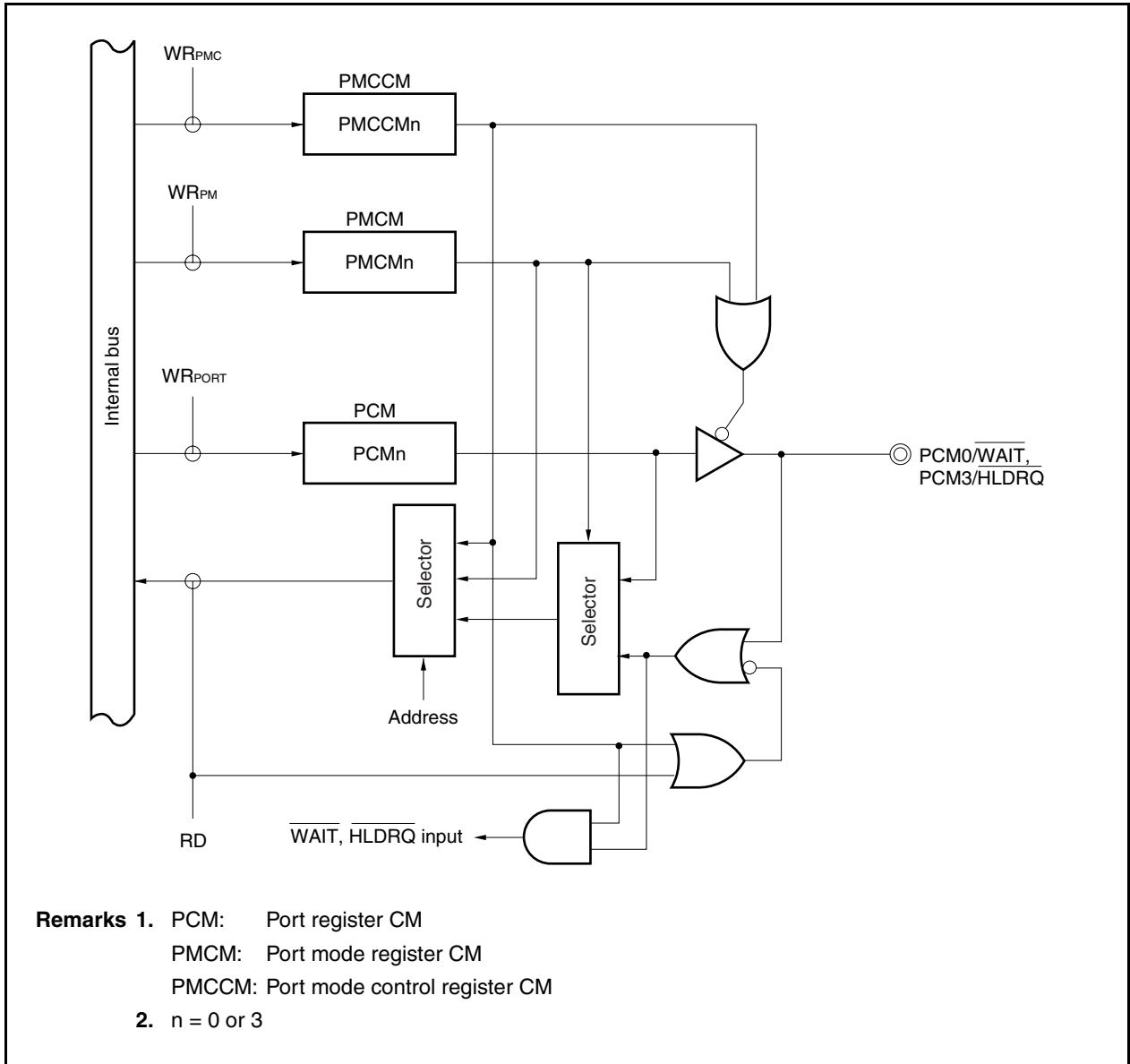


Figure 4-26. Block Diagram of PCM1 and PCM2

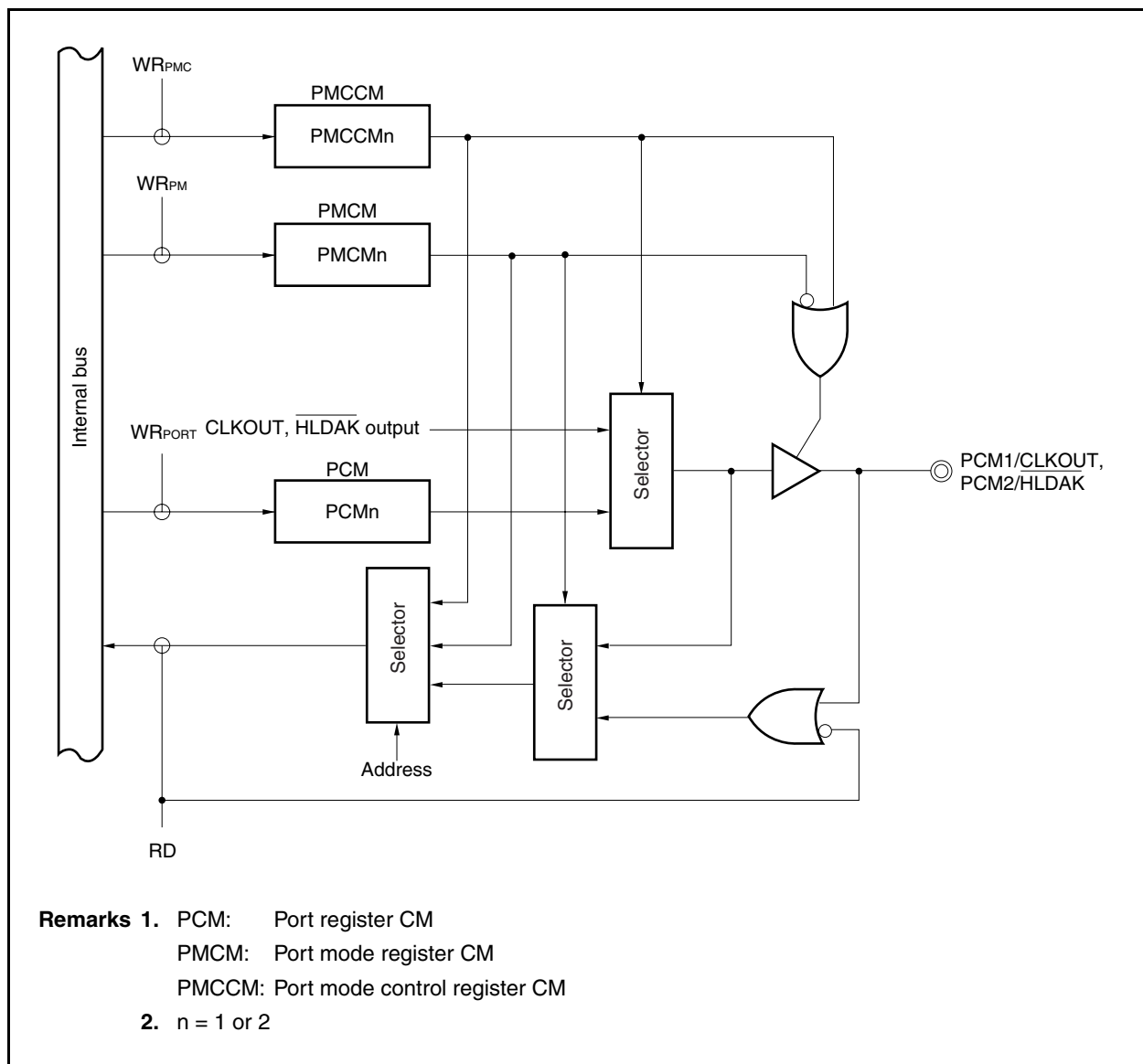
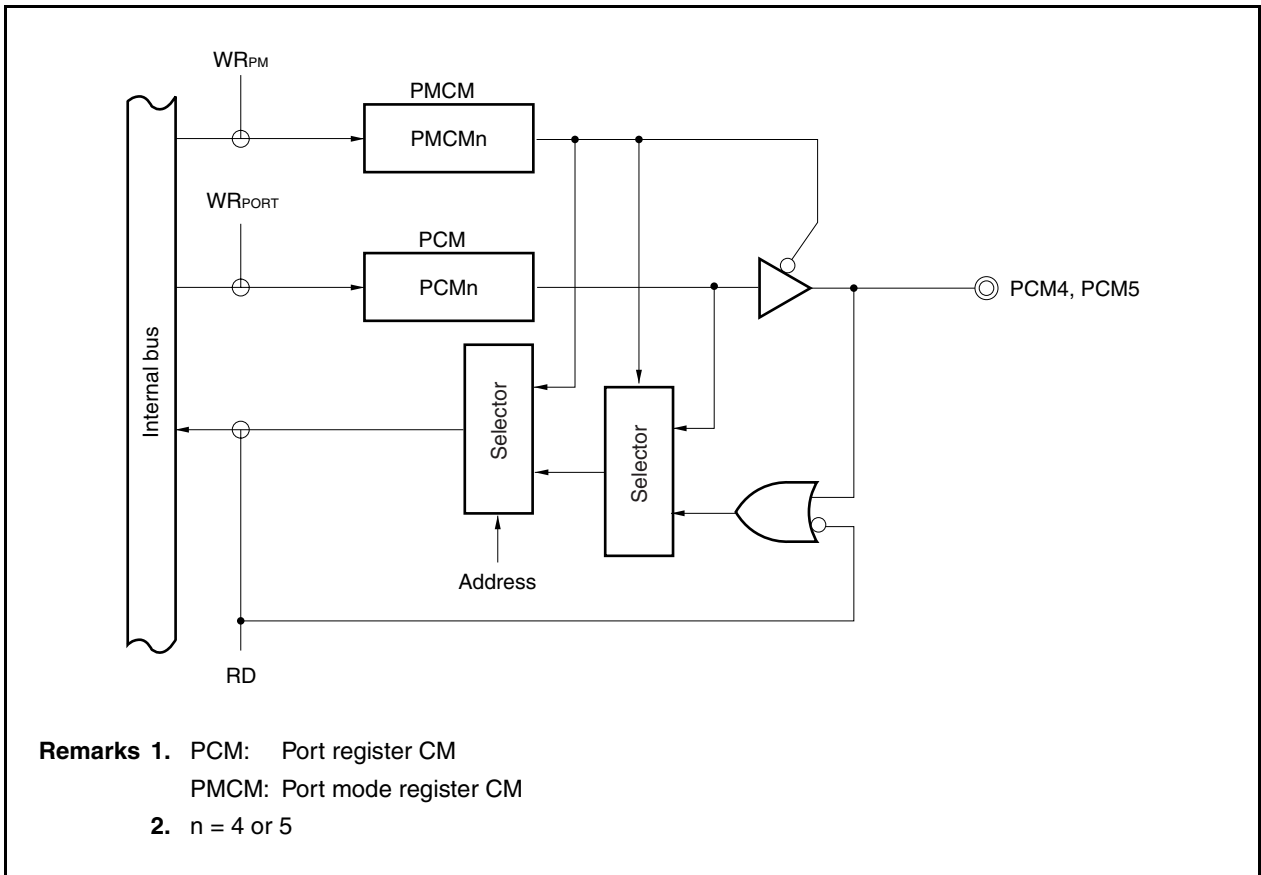


Figure 4-27. Block Diagram of PCM4 and PCM5



4.3.10 Port CS

Port CS can be set to the input or output mode in 1-bit units.

The number of I/O port bits differs depending on the product.

Commercial Name	Number of I/O Port Bits
V850ES/SA2	4-bit I/O port
V850ES/SA3	8-bit I/O port

(1) Functions of port CS

- Input/output data can be specified in 1-bit units by using port register CS (PCS).
- Can be set to the input or output mode in 1-bit units by using port mode register CS (PMCS).
- Can be set to the port mode or control mode (alternate function) in 1-bit units by using port mode control register CS (PMCCS).

Port CS has an alternate function as the following pins.

Table 4-14. Alternate-Function Pins of Port CS

Pin Name		Alternate-Function Pin	I/O	PULL ^{Note 1}	Remark
Port CS	PCS0	$\overline{CS0}$	I/O	None	-
	PCS1	$\overline{CS1}$			
	PCS2	$\overline{CS2}$			
	PCS3	$\overline{CS3}$			
	PCS4 ^{Note 2}	-			
	PCS5 ^{Note 2}	-			
	PCS6 ^{Note 2}	-			
	PCS7 ^{Note 2}	-			

Notes 1. Software pull-up function

2. V850ES/SA3 only

(2) Registers

(a) Port register CS (PCS)

Port register CS (PCS) is an 8-bit register that controls reading the pin level and writing the output level. This register can be read or written in 8-bit or 1-bit units.

After reset: Undefined R/W Address: FFFF008H

	7	6	5	4	3	2	1	0
PCS	PCS7 ^{Note}	PCS6 ^{Note}	PCS5 ^{Note}	PCS4 ^{Note}	PCS3	PCS2	PCS1	PCS0

PCS _n	Controls output data (in output mode) (V850ES/SA2: n = 0 to 3, V850ES/SA3: n = 0 to 7)
0	Outputs 0.
1	Outputs 1.

Note Bits 7 to 4 are provided in the V850ES/SA3 only. Be sure to clear these bits to 0 in the V850ES/SA2.

Remarks 1. In input mode: When port CS (PCS) is read, the pin level at that time is read. When written, the data written to PCS is written. The input pin is not affected.
 In output mode: When port CS (PCS) is read, the value of PCS is read. When a value is written to PCS, it is immediately output.

2. After reset, an undefined value (pin input level) is read from PCS in the input mode. When PCS is read in the output mode, 00H (value of the output latch) is read.

(b) Port mode register CS (PMCS)

This is an 8-bit register that specifies the input or output mode. This register can be read or written in 8-bit or 1-bit units.

After reset: FFH R/W Address: FFFF028H

	7	6	5	4	3	2	1	0
PMCS	PMCS7 ^{Note}	PMCS6 ^{Note}	PMCS5 ^{Note}	PMCS4 ^{Note}	PMCS3	PMCS2	PMCS1	PMCS0

PMCS _n	Controls input/output mode (V850ES/SA2: n = 0 to 3, V850ES/SA3: n = 0 to 7)
0	Output mode
1	Input mode

Note Bits 7 to 4 are provided in the V850ES/SA3 only. Be sure to set these bits to 1 in the V850ES/SA2.

(c) Port mode control register CS (PMCCS)

This is an 8-bit register that specifies the port mode or control mode.

It can be read or written in 8-bit or 1-bit units.

After reset: 00H		R/W	Address: FFFF048H					
	7	6	5	4	3	2	1	0
PMCCS	0	0	0	0	PMCCS3	PMCCS2	PMCCS1	PMCCS0
PMCCSn	Specifies operation mode of PCSn pin (n = 0 to 3)							
0	I/O port							
1	$\overline{\text{CSn}}$ output							

(3) Block diagram

Figure 4-28. Block Diagram of PCS0 to PCS3

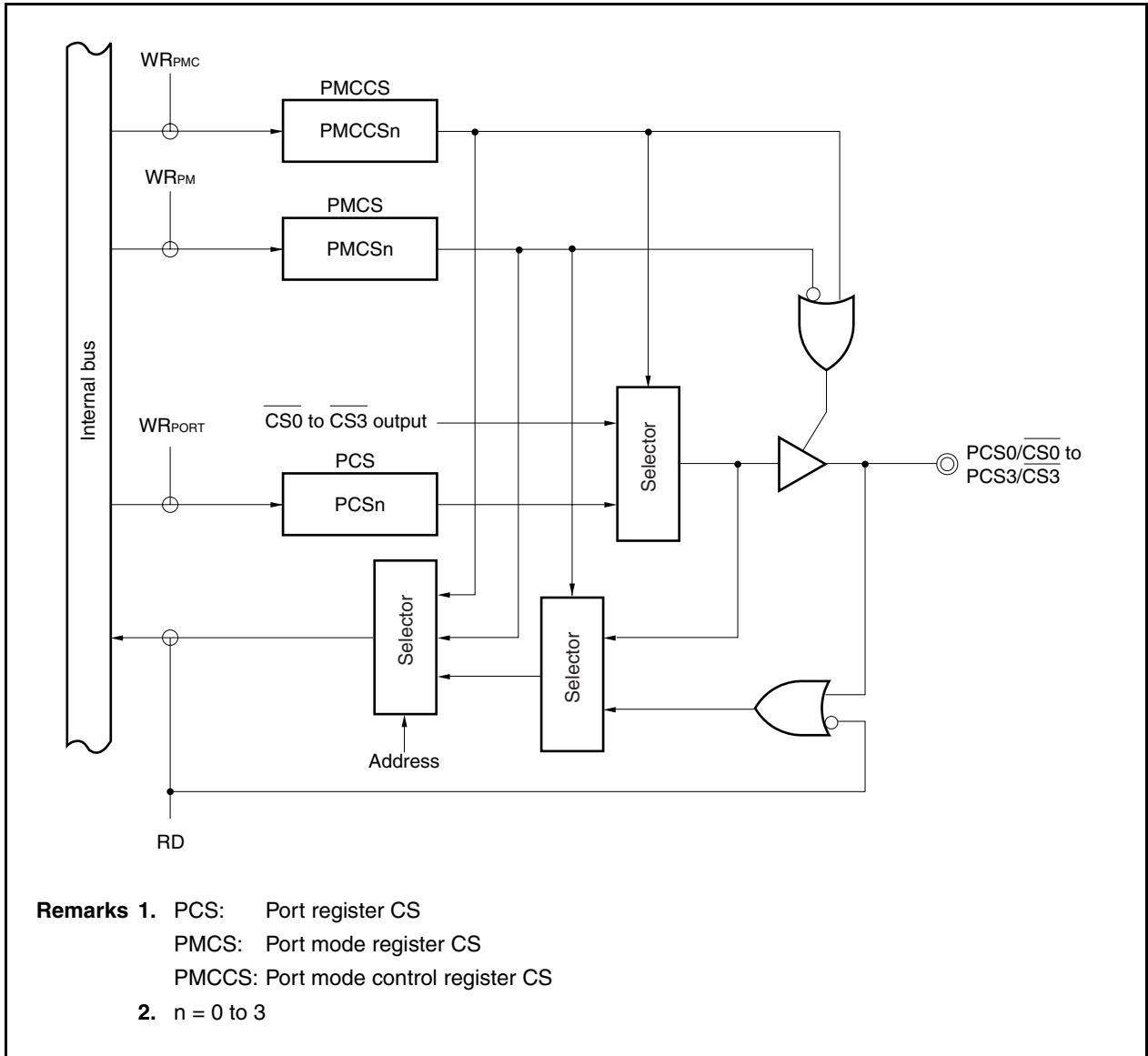
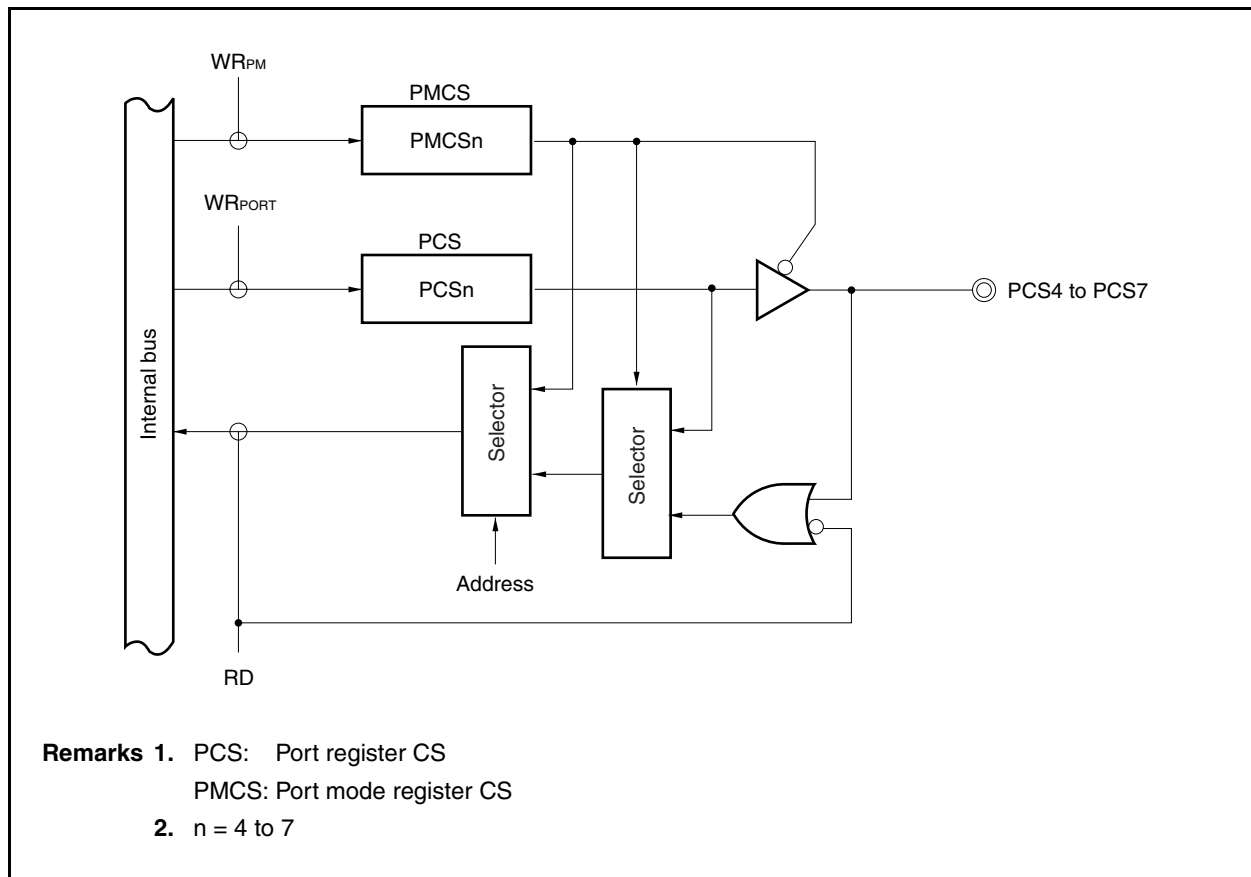


Figure 4-29. Block Diagram of PCS4 to PCS7



4.3.11 Port CT

Port CT can be set to the input or output mode in 1-bit units.
 The number of I/O port bits differs depending on the product.

Commercial Name	Number of I/O Port Bits
V850ES/SA2	6-bit I/O port
V850ES/SA3	8-bit I/O port

(1) Functions of port CT

- Input/output data can be specified in 1-bit units by using port register CT (PCT).
- Can be set to the input or output mode in 1-bit units by using port mode register CT (PMCT).
- Can be set to the port mode or control mode (alternate function) in 1-bit units by using port mode control register CT (PMCCT).

Table 4-15. Alternate-Function Pins of Port CT

Pin Name		Alternate-Function Pin	I/O	PULL ^{Note 1}	Remark
Port CT	PCT0	$\overline{WR0}$	I/O	None	-
	PCT1	$\overline{WR1}$			
	PCT2 ^{Note 2}	-			
	PCT3 ^{Note 2}	-			
	PCT4	\overline{RD}			
	PCT5	-			
	PCT6	ASTB			
	PCT7	-			

Notes 1. Software pull-up function

2. V850ES/SA3 only

(2) Registers

(a) Port register CT (PCT)

Port register PCT (PCT) is an 8-bit register that controls reading the pin level and writing the output level. This register can be read or written in 8-bit or 1-bit units.

After reset: Undefined R/W Address: FFFF00AH

	7	6	5	4	3	2	1	0
PCT	PCT7	PCT6	PCT5	PCT4	PCT3 ^{Note}	PCT2 ^{Note}	PCT1	PCT0

PCTn	Controls output data (in output mode) (V850ES/SA2: n = 0, 1, 4 to 7, V850ES/SA3: n = 0 to 7)
0	Outputs 0.
1	Outputs 1.

Note Bits 3 and 2 are provided in the V850ES/SA3 only. Be sure to clear these bits to 0 in the V850ES/SA2.

Remarks 1. In input mode: When port CT (PCT) is read, the pin level at that time is read. When written, the data written to PCT is written. The input pin is not affected.
 In output mode: When port CT (PCT) is read, the value of PCT is read. When a value is written to PCT, it is immediately output.

2. After reset, an undefined value (pin input level) is read from PCT in the input mode. When PCT is read in the output mode, 00H (value of the output latch) is read.

(b) Port mode register CT (PMCT)

This is an 8-bit register that specifies the input or output mode. This register can be read or written in 8-bit or 1-bit units.

After reset: FFH R/W Address: FFFF02AH

	7	6	5	4	3	2	1	0
PMCT	PMCT7	PMCT6	PMCT5	PMCT4	PMCT3 ^{Note}	PMCT2 ^{Note}	PMCT1	PMCT0

PMCTn	Controls input/output mode (V850ES/SA2: n = 0, 1, 4 to 7, V850ES/SA3: n = 0 to 7)
0	Output mode
1	Input mode

Note Bits 3 and 2 are provided in the V850ES/SA3 only. Be sure to set these bits to 1 in the V850ES/SA2.

(c) Port mode control register CT (PMCCT)

This is an 8-bit register that specifies the port mode or control mode.

It can be read or written in 8-bit or 1-bit units.

After reset: 00H	R/W	Address: FFFFF04AH						
7	6	5	4	3	2	1	0	
PMCCT	0	PMCCT6	0	PMCCT4	0	0	PMCCT1	PMCCT0
PMCCT6		Specifies operation mode of PCT6 pin						
0	I/O port							
1	ASTB output							
PMCCT4		Specifies operation mode of PCT4 pin						
0	I/O port							
1	\overline{RD} output							
PMCCT1		Specifies operation mode of PCT1 pin						
0	I/O port							
1	$\overline{WR1}$ output							
PMCCT0		Specifies operation mode of PCT0 pin						
0	I/O port							
1	$\overline{WR0}$ output							

(3) Block diagram

Figure 4-30. Block Diagram of PCT0, PCT1, PCT4, and PCT6

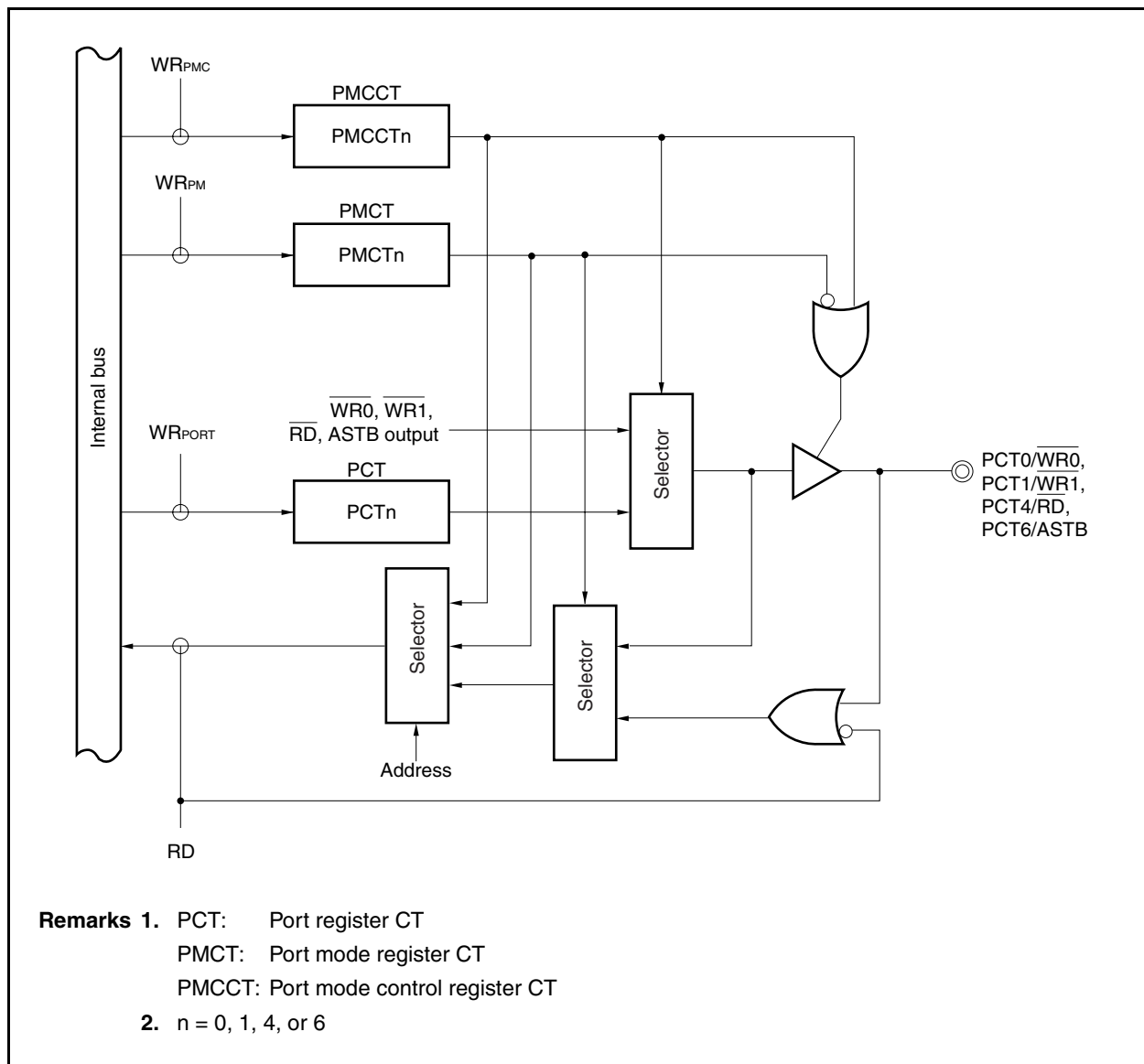
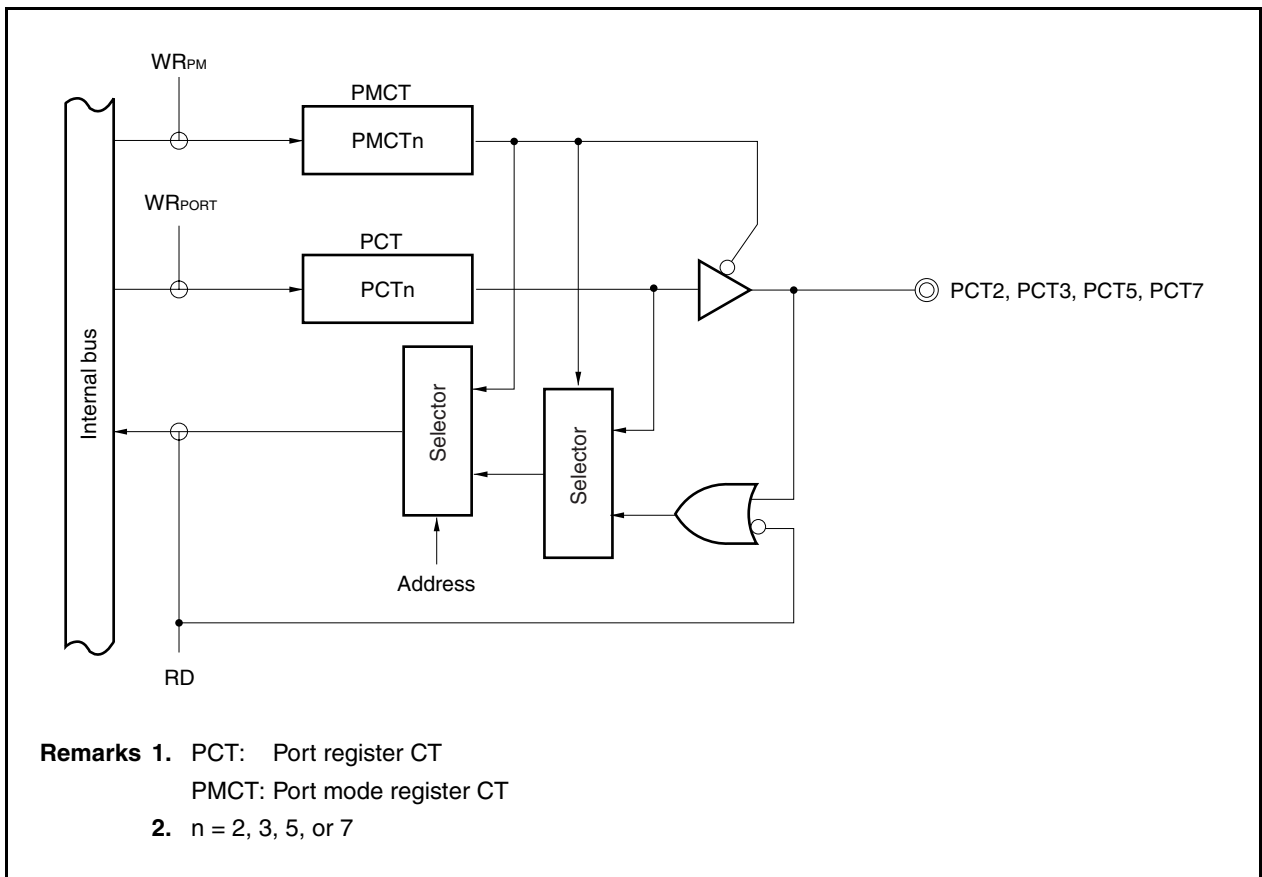


Figure 4-31. Block Diagram of PCT2, PCT3, PCT5, and PCT7



4.3.12 Port DH

Port DH can be set to the input or output mode in 1-bit units.

The number of I/O port bits differs depending on the product.

Commercial Name	Number of I/O Port Bits
V850ES/SA2	6-bit I/O port
V850ES/SA3	8-bit I/O port

(1) Functions of port DH

- Input/output data can be specified in 1-bit units by using port register DH (PDH).
- Can be set to the input or output mode in 1-bit units by using port mode register DH (PMDH).
- Can be set to the port mode or control mode (alternate function) in 1-bit units by using port mode control register DH (PMCDH).

Port DH has an alternate function as the following pins.

Table 4-16. Alternate-Function Pins of Port DH

Pin Name		Alternate-Function Pin	I/O	PULL ^{Note 1}	Remark
Port DH	PDH0	A16	I/O	None	-
	PDH1	A17			
	PDH2	A18			
	PDH3	A19			
	PDH4	A20			
	PDH5	A21			
	PDH6 ^{Note 2}	A22 ^{Note 2}			
	PDH7 ^{Note 2}	A23 ^{Note 2}			

Notes 1. Software pull-up function

2. V850ES/SA3 only

(2) Registers

(a) Port register DH (PDH)

Port register PDH (PDH) is an 8-bit register that controls reading the pin level and writing the output level. This register can be read or written in 8-bit or 1-bit units.

After reset: Undefined R/W Address: FFFFF006H

	7	6	5	4	3	2	1	0
PDH	PDH7 ^{Note}	PDH6 ^{Note}	PDH5	PDH4	PDH3	PDH2	PDH1	PDH0

PDHn	Controls output data (in output mode) (V850ES/SA2: n = 0 to 5, V850ES/SA3: n = 0 to 7)
0	Outputs 0.
1	Outputs 1.

Note Bits 7 and 6 are provided in the V850ES/SA3 only. Be sure to clear these bits to 0 in the V850ES/SA2.

Remarks 1. In input mode: When port DH (PDH) is read, the pin level at that time is read. When written, the data written to PDH is written. The input pin is not affected.
 In output mode: When port DH (PDH) is read, the value of PDH is read. When a value is written to PDH, it is immediately output.

2. After reset, an undefined value (pin input level) is read from PDH in the input mode. When PDH is read in the output mode, 00H (value of the output latch) is read.

(b) Port mode register DH (PMDH)

This is an 8-bit register that specifies the input or output mode. This register can be read or written in 8-bit or 1-bit units.

After reset: FFH R/W Address: FFFFF026H

	7	6	5	4	3	2	1	0
PMDH	PMDH7 ^{Note}	PMDH6 ^{Note}	PMDH5	PMDH4	PMDH3	PMDH2	PMDH1	PMDH0

PMDHn	Controls input/output mode (V850ES/SA2: n = 0 to 5, V850ES/SA3: n = 0 to 7)
0	Output mode
1	Input mode

Note Bits 7 and 6 are provided in the V850ES/SA3 only. Be sure to set these bits to 1 in the V850ES/SA2.

(c) Port mode control register DH (PMCDH)

This is an 8-bit register that specifies the port mode or control mode.

It can be read or written in 8-bit or 1-bit units.

After reset: 00H R/W Address: FFFFF046H

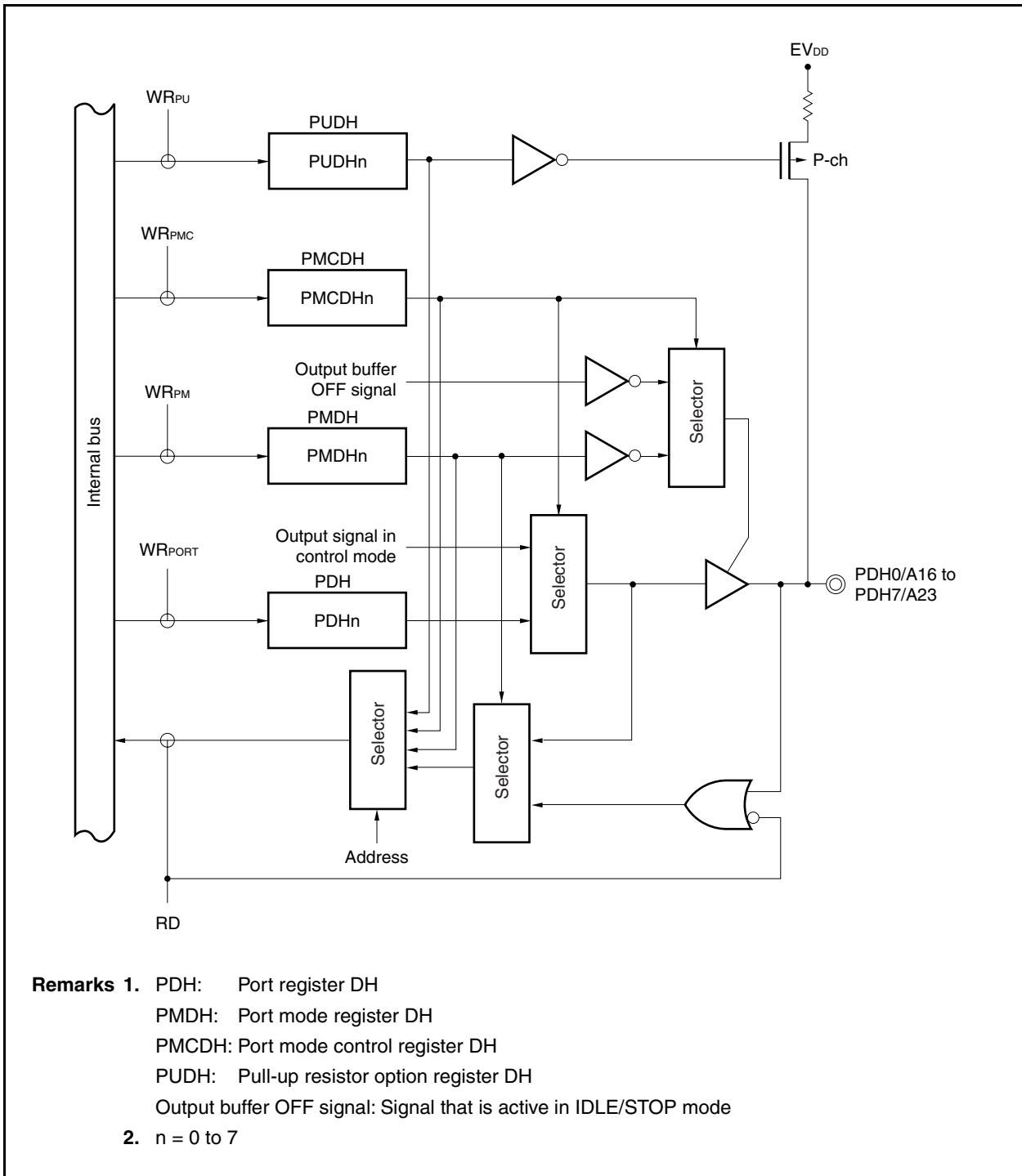
	7	6	5	4	3	2	1	0
PMCDH	PMCDH7 ^{Note}	PMCDH6 ^{Note}	PMCDH5	PMCDH4	PMCDH3	PMCDH2	PMCDH1	PMCDH0

PMCDHn	Specifies operation mode of PDHn pin (V850ES/SA2: n = 0 to 5, V850ES/SA3: n = 0 to 7)
0	I/O port
1	Am output (address bus output) (V850ES/SA2: m = 16 to 21, V850ES/SA3: m = 16 to 23)

Note Bits 7 and 6 are provided in the V850ES/SA3 only. Be sure to clear these bits to 0 in the V850ES/SA2.

(3) Block diagram

Figure 4-32. Block Diagram of PDH0 to PDH7



4.3.13 Port DL

Port DL can be set to the input or output mode in 1-bit units.

The number of I/O port bits of each product is the same.

Commercial Name	Number of I/O Port Bits
V850ES/SA2	16-bit I/O port
V850ES/SA3	16-bit I/O port

(1) Functions of port DL

- Input/output data can be specified in 1-bit units by using port register DL (PDL).
- Can be set to the input or output mode in 1-bit units by using port mode register DL (PMDL).
- Can be set to the port mode or control mode (alternate function) in 1-bit units by using port mode control register DL (PMCDL).

Port DL has an alternate function as the following pins.

Table 4-17. Alternate-Function Pins of Port DL

Pin Name	Alternate-Function Pin	I/O	PULL ^{Note 1}	Remark	
Port DL	PDL0	AD0	I/O	None	-
	PDL1	AD1			
	PDL2	AD2			
	PDL3	AD3			
	PDL4	AD4			
	PDL5	AD5/FLMD1 ^{Note 2}			
	PDL6	AD6			
	PDL7	AD7			
	PDL8	AD8			
	PDLDL	AD9			
	PDL10	AD10			
	PDL11	AD11			
	PDL12	AD12			
	PDL13	AD13			
	PDL14	AD14			
	PDL15	AD15			

Notes 1. Software pull-up function

2. Because these pins are used for setting in the flash programming mode, they do not have to be manipulated by using a port control register. For details, refer to **CHAPTER 18 FLASH MEMORY** (μ PD70F3201, 70F3201Y, 70F3204, and 70F3204Y only).

(2) Registers

(a) Port register DL (PDL)

Port register DL (PDL) is a 16-bit register that controls reading the pin level and writing the output level. This register can be read or written in 8-bit or 1-bit units.

If the higher 8 bits of the PDL register are used as PDLH, and the lower 8 bits as PDL, however, PDLH and PDL can be used as an 8-bit I/O port whose input or output can be manipulated in 8-bit or 1-bit units.

After reset: Undefined R/W Address: FFFFF004H, FFFFF005H

	15	14	13	12	11	10	9	8
PDL	PDL15	PDL14	PDL13	PDL12	PDL11	PDL10	PDL9	PDL8
	7	6	5	4	3	2	1	0
	PDL7	PDL6	PDL5	PDL4	PDL3	PDL2	PDL1	PDL0

PDLn	Controls output data (in output mode) (n = 0 to 15)
0	Outputs 0.
1	Outputs 1.

Remarks 1. In input mode: When port DL (PDL) is read, the pin level at that time is read. When written, the data written to PDL is written. The input pin is not affected.
 In output mode: When port DL (PDL) is read, the value of PDL is read. When a value is written to PDL, it is immediately output.

2. After reset, an undefined value (pin input level) is read from PDL in the input mode. When PDL is read in the output mode, 0000H (value of the output latch) is read.

(b) Port DL mode register (PMDL)

This is a 16-bit register that specifies the input or output mode.

This register can be read or written only in 16-bit units.

If the higher 8 bits of the PMDL register are used as PMDLH, and the lower 8 bits as PMDLL, however, PMDLH and PMDLL can be read or written in 8-bit or 1-bit units.

After reset: FFFFH R/W Address: FFFFF024H, FFFFF025H

	15	14	13	12	11	10	9	8
PMDL	PMDL15	PMDL14	PMDL13	PMDL12	PMDL11	PMDL10	PMDL9	PMDL8
	7	6	5	4	3	2	1	0
	PMDL7	PMDL6	PMDL5	PMDL4	PMDL3	PMDL2	PMDL1	PMDL0

PMDLn	Controls input/output mode (n = 0 to 15)
0	Output mode
1	Input mode

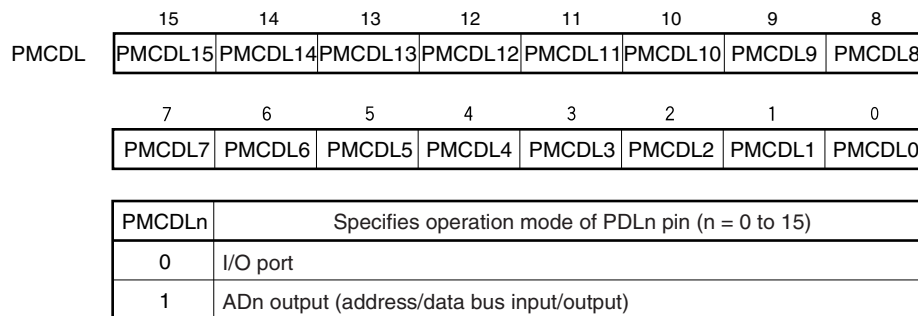
(c) Port DL mode control register (PMCDL)

This is a 16-bit register that specifies the port mode or control mode.

It can be read or written only in 16-bit units.

If the higher 8 bits of the PMCDL register are used as PMCDLH, and the lower 8 bits as PMCDLL, however, PMCDLH and PMCDLL can be read or written in 8-bit units.

After reset: 0000H R/W Address: FFFFF044H, FFFFF045H



Caution Do not specify AD8 to AD15 when the SMSEL bit of the EXIMC register = 1 (separate mode) and when the BS30 to BS00 bits of the BSC register = 0 (8-bit bus width).

(3) Block diagram

Figure 4-33. Block Diagram of PDL0 to PDL15

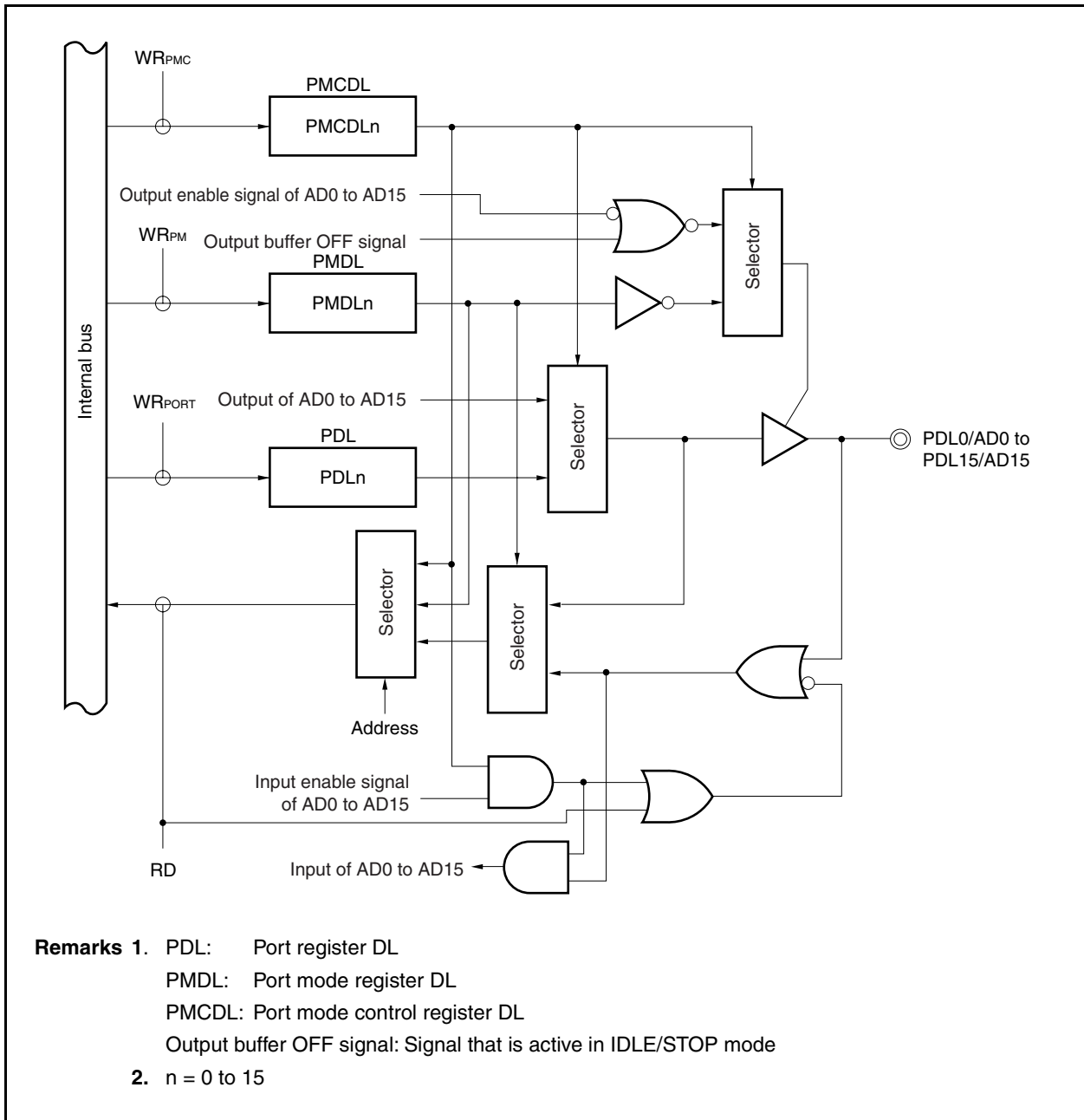


Table 4-18. Using Alternate Function of Port Pins (1/6)

Pin Name	Alternate Function		Pnx Bit of Pn Register	PMnx Bit of PMn Register	PMCnx Bit of PMCn Register	PFCnx Bit of PFCn Register	Other Bits (Register)
	Name	I/O					
P00	NMI	Input	P00 = Setting not needed	PM00 = Setting not needed	PMC00 = 1	–	INTR00 (INTR0), INTF00 (INTF0)
P01	INTP0	Input	P01 = Setting not needed	PM01 = Setting not needed	PMC01 = 1	–	INTR01 (INTR0), INTF01 (INTF0)
	TI2	Input	P01 = Setting not needed	PM01 = Setting not needed	PMC01 = 1	–	–
P02	INTP1	Input	P02 = Setting not needed	PM02 = Setting not needed	PMC02 = 1	–	INTR02 (INTR0), INTF02 (INTF0)
	TI3	Input	P02 = Setting not needed	PM02 = Setting not needed	PMC02 = 1	–	–
P03	INTP2	Input	P03 = Setting not needed	PM03 = Setting not needed	PMC03 = 1	–	INTR03 (INTR0), INTF00 (INTF0)
	TI4	Input	P03 = Setting not needed	PM03 = Setting not needed	PMC03 = 1	–	–
P04	INTP3	Input	P04 = Setting not needed	PM04 = Setting not needed	PMC04 = 1	–	INTR04 (INTR0), INTF04 (INTF0)
	TI5	Input	P04 = Setting not needed	PM04 = Setting not needed	PMC04 = 1	–	–
P05	INTP4	Input	P05 = Setting not needed	PM05 = Setting not needed	PMC05 = 1	–	INTR05 (INTR0), INTF05 (INTF0)
	ADTRG	Input	P05 = Setting not needed	PM05 = Setting not needed	PMC05 = 1	–	–
P20	SI4	Input	P20 = Setting not needed	PM20 = Setting not needed	PMC20 = 1	–	–
P21	SO4	Output	P21 = Setting not needed	PM21 = Setting not needed	PMC21 = 1	–	PF21 = don't care (PF2)
P22	$\overline{\text{SCK}}4$	I/O	P22 = Setting not needed	PM22 = Setting not needed	PMC22 = 1	–	PF22 = don't care (PF2)
P30	SI1	Input	P30 = Setting not needed	PM30 = Setting not needed	PMC30 = 1	PFC30 = 0	–
	RXD0	Input	P30 = Setting not needed	PM30 = Setting not needed	PMC30 = 1	PFC30 = 1	–
P31	SO1	Output	P31 = Setting not needed	PM31 = Setting not needed	PMC31 = 1	PFC31 = 0	PF31 = 0 (PF3)
	TXD0	Output	P31 = Setting not needed	PM31 = Setting not needed	PMC31 = 1	PFC31 = 1	PF31 = don't care (PF3)
P32	$\overline{\text{SCK}}1$	I/O	P32 = Setting not needed	PM32 = Setting not needed	PMC32 = 1	–	PF32 = don't care (PF3)
P40	SI0	Input	P40 = Setting not needed	PM40 = Setting not needed	PMC40 = 1	–	–
P41	SO0	Output	P41 = Setting not needed	PM41 = Setting not needed	PMC41 = 1	PFC41 = 0	PF41 = don't care (PF4)
	SDA ^{Note}	I/O	P41 = Setting not needed	PM41 = Setting not needed	PMC41 = 1	PFC41 = 1	PF41 = 1 (PF4)
P42	$\overline{\text{SCK}}0$	I/O	P42 = Setting not needed	PM42 = Setting not needed	PMC42 = 1	PFC42 = 0	PF42 = don't care (PF4)
	SCL ^{Note}	I/O	P42 = Setting not needed	PM42 = Setting not needed	PMC42 = 1	PFC42 = 1	PF42 = 1 (PF4)

Note μ PD703201Y, 703204Y, 70F3201Y, and 70F3204Y only

Table 4-18. Using Alternate Function of Port Pins (2/6)

Pin Name	Alternate Function		Pnx Bit of Pn Register	PMnx Bit of PMn Register	PMCnx Bit of PMCn Register	PFCnx Bit of PFCn Register	Other Bits (Register)
	Name	I/O					
P43	INTP00	Input	P43 = Setting not needed	PM43 = Setting not needed	PMC43 = 1	–	ETI0 = 0 (TMC01), Note
	TI0	Input	P43 = Setting not needed	PM43 = Setting not needed	PMC43 = 1	–	ETI0 = 1 (TMC01), Note
	TCLR0	Input	P43 = Setting not needed	PM43 = Setting not needed	PMC43 = 1	–	ECLR0 = 1 (TMC01), Note
P44	INTP01	Input	P44 = Setting not needed	PM44 = Setting not needed	PMC44 = 1	PFC44 = 0	–
	TO0	Output	P44 = Setting not needed	PM44 = Setting not needed	PMC44 = 1	PFC44 = 1	–
P45	INTP10	Input	P45 = Setting not needed	PM45 = Setting not needed	PMC45 = 1	–	ETI1 = 0 (TMC11), Note
	TI1	Input	P45 = Setting not needed	PM45 = Setting not needed	PMC45 = 1	–	ETI1 = 1 (TMC11), Note
	TCLR1	Input	P45 = Setting not needed	PM45 = Setting not needed	PMC45 = 1	–	ECLR1 = 1 (TMC11), Note
P46	INTP11	Input	P46 = Setting not needed	PM46 = Setting not needed	PMC46 = 1	PFC46 = 0	–
	TO1	Output	P46 = Setting not needed	PM46 = Setting not needed	PMC46 = 1	PFC46 = 1	–
P70	ANI0	Input	P70 = Setting impossible	–	–	–	–
P71	ANI1	Input	P71 = Setting impossible	–	–	–	–
P72	ANI2	Input	P72 = Setting impossible	–	–	–	–
P73	ANI3	Input	P73 = Setting impossible	–	–	–	–
P74	ANI4	Input	P74 = Setting impossible	–	–	–	–
P75	ANI5	Input	P75 = Setting impossible	–	–	–	–
P76	ANI6	Input	P76 = Setting impossible	–	–	–	–
P77	ANI7	Input	P77 = Setting impossible	–	–	–	–
P78	ANI8	Input	P78 = Setting impossible	–	–	–	–
P79	ANI9	Input	P79 = Setting impossible	–	–	–	–
P710	ANI10	Input	P710 = Setting impossible	–	–	–	–

Note Set the valid edge by using the timer n valid edge selection register (SESn).

Table 4-18. Using Alternate Function of Port Pins (3/6)

Pin Name	Alternate Function		Pnx Bit of Pn Register	PMnx Bit of PMn Register	PMCnx Bit of PMCn Register	PFCnx Bit of PFCn Register	Other Bits (Register)
	Name	I/O					
P711	ANI11	Input	P711 = Setting impossible	–	–	–	–
P712	ANI12	Input	P712 = Setting impossible	–	–	–	–
P713	ANI13	Input	P713 = Setting impossible	–	–	–	–
P714	ANI14	Input	P714 = Setting impossible	–	–	–	–
P715	ANI15	Input	P715 = Setting impossible	–	–	–	–
P80	ANO0	Output	P80 = Setting impossible	–	–	–	–
P81	ANO1	Output	P780 = Setting impossible	–	–	–	–
P90	A0	Output	P90 = Setting not needed	PM90 = Setting not needed	PMC90 = 1	PFC90 = 0	Note
P91	A1	Output	P91 = Setting not needed	PM91 = Setting not needed	PMC91 = 1	PFC91 = 0	–
P92	A2	Output	P92 = Setting not needed	PM92 = Setting not needed	PMC92 = 1	PFC92 = 0	Note
	INTP5	Input	P92 = Setting not needed	PM92 = Setting not needed	PMC92 = 1	PFC92 = 1	INTR92 (INTR9), INTF92 (INTF9)
P93	A3	Output	P93 = Setting not needed	PM93 = Setting not needed	PMC93 = 1	PFC93 = 0	Note
	INTP6	Input	P93 = Setting not needed	PM93 = Setting not needed	PMC93 = 1	PFC93 = 1	INTR93 (INTR9), INTF93 (INTF9)
P94	A4	Output	P94 = Setting not needed	PM94 = Setting not needed	PMC94 = 1	PFC94 = 0	Note
	TO2	Output	P94 = Setting not needed	PM94 = Setting not needed	PMC94 = 1	PFC94 = 1	–
P95	A5	Output	P95 = Setting not needed	PM95 = Setting not needed	PMC95 = 1	PFC95 = 0	Note
	TO3	Output	P95 = Setting not needed	PM95 = Setting not needed	PMC95 = 1	PFC95 = 1	–
P96	A6	Output	P96 = Setting not needed	PM96 = Setting not needed	PMC96 = 1	PFC96 = 0	Note
	TO4	Output	P96 = Setting not needed	PM96 = Setting not needed	PMC96 = 1	PFC96 = 1	–
P97	A7	Output	P97 = Setting not needed	PM97 = Setting not needed	PMC97 = 1	PFC97 = 0	Note
	TO5	Output	P97 = Setting not needed	PM97 = Setting not needed	PMC97 = 1	PFC97 = 1	–
P98	A8	Output	P98 = Setting not needed	PM98 = Setting not needed	PMC98 = 1	PFC98 = 0	Note
	RXD1	Input	P98 = Setting not needed	PM98 = Setting not needed	PMC98 = 1	PFC98 = 1	–

Note To set the A0 to A15 pins, clear the PFC9 register to 0000H and set the PMC9 register to FFFFH in 16-bit units.

Table 4-18. Using Alternate Function of Port Pins (4/6)

Pin Name	Alternate Function		Pnx Bit of Pn Register	PMnx Bit of PMn Register	PMCnx Bit of PMCn Register	PFCnx Bit of PFCn Register	Other Bits (Register)
	Name	I/O					
P99	A9	Output	P99 = Setting not needed	PM99 = Setting not needed	PMC99 = 1	PFC99 = 0	Note
	TXD1	Output	P99 = Setting not needed	PM99 = Setting not needed	PMC99 = 1	PFC99 = 1	–
P910	A10	Output	P910 = Setting not needed	PM910 = Setting not needed	PMC910 = 1	PFC910 = 0	Note
	SI2	Input	P910 = Setting not needed	PM910 = Setting not needed	PMC910 = 1	PFC910 = 1	–
P911	A11	Output	P911 = Setting not needed	PM911 = Setting not needed	PMC911 = 1	PFC911 = 0	Note
	SO2	Output	P911 = Setting not needed	PM911 = Setting not needed	PMC911 = 1	PFC911 = 1	PF911 = don't care (PF9)
P912	A12	Output	P912 = Setting not needed	PM912 = Setting not needed	PMC912 = 1	PFC912 = 0	Note
	$\overline{\text{SCK2}}$	Output	P912 = Setting not needed	PM912 = Setting not needed	PMC912 = 1	PFC912 = 1	PF912 = don't care (PF9)
P913	A13	Output	P913 = Setting not needed	PM913 = Setting not needed	PMC913 = 1	PFC913 = 0	Note
	SI3	Input	P913 = Setting not needed	PM913 = Setting not needed	PMC913 = 1	PFC913 = 1	–
P914	A14	Output	P914 = Setting not needed	PM914 = Setting not needed	PMC914 = 1	PFC914 = 0	Note
	SO3	Output	P914 = Setting not needed	PM914 = Setting not needed	PMC914 = 1	PFC914 = 1	PF914 = don't care (PF9)
P915	A15	Output	P915 = Setting not needed	PM915 = Setting not needed	PMC915 = 1	PFC915 = 0	Note
	$\overline{\text{SCK3}}$	Output	P915 = Setting not needed	PM915 = Setting not needed	PMC915 = 1	PFC915 = 1	PF915 = don't care (PF9)

Note To set the A0 to A15 pins, clear the PFC9 register to 0000H and set the PMC9 register to FFFFH in 16-bit units.

Table 4-18. Using Alternate Function of Port Pins (5/6)

Pin Name	Alternate Function		Pnx Bit of Pn Register	PMnx Bit of PMn Register	PMCnx Bit of PMCn Register	PFCnx Bit of PFCn Register	Other Bits (Register)
	Name	I/O					
PCM0	$\overline{\text{WAIT}}$	Input	PCM0 = Setting not needed	PMCM0 = Setting not needed	PMCCM0 = 1	–	–
PCM1	CLKOUT	Output	PCM1 = Setting not needed	PMCM1 = Setting not needed	PMCCM1 = 1	–	–
PCM2	$\overline{\text{HLD\!AK}}$	Output	PCM2 = Setting not needed	PMCM2 = Setting not needed	PMCCM2 = 1	–	–
PCM3	$\overline{\text{HLD\!QR}}$	Input	PCM3 = Setting not needed	PMCM3 = Setting not needed	PMCCM3 = 1	–	–
PCS0	$\overline{\text{CS0}}$	Output	PCS0 = Setting not needed	PMCS0 = Setting not needed	PMCCS0 = 1	–	–
PCS1	$\overline{\text{CS1}}$	Output	PCS1 = Setting not needed	PMCS1 = Setting not needed	PMCCS1 = 1	–	–
PCS2	$\overline{\text{CS2}}$	Output	PCS2 = Setting not needed	PMCS2 = Setting not needed	PMCCS2 = 1	–	–
PCS3	$\overline{\text{CS3}}$	Output	PCS3 = Setting not needed	PMCS3 = Setting not needed	PMCCS3 = 1	–	–
PCT0	$\overline{\text{WR0}}$	Output	PCT0 = Setting not needed	PMCT0 = Setting not needed	PMCCT0 = 1	–	–
PCT1	$\overline{\text{WR1}}$	Output	PCT1 = Setting not needed	PMCT1 = Setting not needed	PMCCT1 = 1	–	–
PCT4	$\overline{\text{RD}}$	Output	PCT4 = Setting not needed	PMCT4 = Setting not needed	PMCCT4 = 1	–	–
PCT6	ASTB	Output	PCT6 = Setting not needed	PMCT6 = Setting not needed	PMCCT6 = 1	–	–

Table 4-18. Using Alternate Function of Port Pins (6/6)

Pin Name	Alternate Function		Pnx Bit of Pn Register	PMnx Bit of PMn Register	PMCnx Bit of PMCn Register	PFCnx Bit of PFCn Register	Other Bits (Register)
	Name	I/O					
PDH0	A16	Output	PDH0 = Setting not needed	PMDH0 = Setting not needed	PMCDH0 = 1	–	–
PDH1	A17	Output	PDH1 = Setting not needed	PMDH1 = Setting not needed	PMCDH1 = 1	–	–
PDH2	A18	Output	PDH2 = Setting not needed	PMDH2 = Setting not needed	PMCDH2 = 1	–	–
PDH3	A19	Output	PDH3 = Setting not needed	PMDH3 = Setting not needed	PMCDH3 = 1	–	–
PDH4	A20	Output	PDH4 = Setting not needed	PMDH4 = Setting not needed	PMCDH4 = 1	–	–
PDH5	A21	Output	PDH5 = Setting not needed	PMDH5 = Setting not needed	PMCDH5 = 1	–	–
PDH6	A22	Output	PDH6 = Setting not needed	PMDH6 = Setting not needed	PMCDH6 = 1	–	–
PDH7	A23	Output	PDH7 = Setting not needed	PMDH7 = Setting not needed	PMCDH7 = 1	–	–
PDL0	AD0	I/O	PDL0 = Setting not needed	PMDL0 = Setting not needed	PMCDL0 = 1	–	–
PDL1	AD1	I/O	PDL1 = Setting not needed	PMDL1 = Setting not needed	PMCDL1 = 1	–	–
PDL2	AD2	I/O	PDL2 = Setting not needed	PMDL2 = Setting not needed	PMCDL2 = 1	–	–
PDL3	AD3	I/O	PDL3 = Setting not needed	PMDL3 = Setting not needed	PMCDL3 = 1	–	–
PDL4	AD4	I/O	PDL4 = Setting not needed	PMDL4 = Setting not needed	PMCDL4 = 1	–	–
PDL5	AD5	I/O	PDL5 = Setting not needed	PMDL5 = Setting not needed	PMCDL5 = 1	–	–
PDL6	AD6	I/O	PDL6 = Setting not needed	PMDL6 = Setting not needed	PMCDL6 = 1	–	–
PDL7	AD7	I/O	PDL7 = Setting not needed	PMDL7 = Setting not needed	PMCDL7 = 1	–	–
PDL8	AD8	I/O	PDL8 = Setting not needed	PMDL8 = Setting not needed	PMCDL8 = 1	–	–
PDL9	AD9	I/O	PDL9 = Setting not needed	PMDL9 = Setting not needed	PMCDL9 = 1	–	–
PDL10	AD10	I/O	PDL10 = Setting not needed	PMDL10 = Setting not needed	PMCDL10 = 1	–	–
PDL11	AD11	I/O	PDL11 = Setting not needed	PMDL11 = Setting not needed	PMCDL11 = 1	–	–
PDL12	AD12	I/O	PDL12 = Setting not needed	PMDL12 = Setting not needed	PMCDL12 = 1	–	–
PDL13	AD13	I/O	PDL13 = Setting not needed	PMDL13 = Setting not needed	PMCDL13 = 1	–	–
PDL14	AD14	I/O	PDL14 = Setting not needed	PMDL14 = Setting not needed	PMCDL14 = 1	–	–
PDL15	AD15	I/O	PDL15 = Setting not needed	PMDL15 = Setting not needed	PMCDL15 = 1	–	–

4.4 Operation of Port Function

The operation of a port differs depending on whether the port is in the input or output mode, as described below.

4.4.1 Writing data to I/O port

(1) In output mode

A value can be written to the output latch by using a transfer instruction. The contents of the output latch are output from the pin. Once data has been written to the output latch, it is retained until new data is written to the output latch.

(2) In input mode

A value can be written to the output latch by using a transfer instruction. Because the output buffer is off, however, the status of the pin does not change.

Once data has been written to the output latch, it is retained until new data is written to the output latch.

Caution A 1-bit memory manipulation instruction manipulates 1 bit but accesses a port in 8-bit units. If this instruction is executed to manipulate a port with a mixture of input and output bits, the contents of the output latch of a pin set in the input mode, in addition to the bit to be manipulated, become undefined.

4.4.2 Reading data from I/O port

(1) In output mode

The contents of the output latch can be read by using a transfer instruction. The contents of the output latch do not change.

(2) In input mode

The status of the pin can be read by using a transfer instruction. The contents of the output latch do not change.

4.4.3 Operation with I/O port

(1) In output mode

An operation is performed on the contents of the output latch and the result is written to the output latch. The contents of the output latch are output from the pin.

Once data has been written to the output latch, it is retained until new data is written to the output latch.

(2) Input mode

The contents of the output latch become undefined. Because the output buffer is off, however, the status of the pin does not change.

Caution A 1-bit memory manipulation instruction manipulates 1 bit but accesses a port in 8-bit units. If this instruction is executed to manipulate a port with a mixture of input and output bits, the contents of the output latch of a pin set to the input mode, in addition to the bit to be manipulated, become undefined.

CHAPTER 5 BUS CONTROL FUNCTION

The V850ES/SA2 and V850ES/SA3 are provided with an external bus interface function by which external memories such as ROM and RAM, and I/O can be connected.

5.1 Features

- Output is selectable from a multiplexed bus with a minimum of 3 bus cycles and a separate bus with a minimum of 2 bus cycles.
- Four-space chip select function
- 8-bit/16-bit data bus selectable (for each area selected by chip select function)
- Wait function
 - Programmable wait function of up to 7 states (selectable for each area selected by chip select function)
 - External wait function using $\overline{\text{WAIT}}$ pin
- Idle state function
- Bus hold function

5.2 Bus Control Pins

The pins used to connect an external device are listed in the table below.

Table 5-1. Bus Control Pins (Multiplexed Bus)

Bus Control Pin	Alternate-Function Pin	I/O	Function
AD0 to AD15	PDL0 to PDL15	I/O	Address/data bus
A16 to A23 ^{Note}	PDH0 to PDH7	Output	Address bus
$\overline{\text{WAIT}}$	PCM0	Input	External wait control
CLKOUT	PCM1	Output	Internal system clock
$\overline{\text{CS0}}$ to $\overline{\text{CS3}}$	PCS0 to PCS3	Output	Chip select
$\overline{\text{WR0}}$, $\overline{\text{WR1}}$	PCT0, PCT1	Output	Write strobe signal
$\overline{\text{RD}}$	PCT4	Output	Read strobe signal
ASTB	PCT6	Output	Address strobe signal
$\overline{\text{HLDRQ}}$	PCM3	Input	Bus hold control
$\overline{\text{HLDAK}}$	PCM2	Output	

Note A16 to A21 in the V850ES/SA2

Table 5-2. External Control Pins (Separate Bus)

Bus Control Pin	Alternate-Function Pin	I/O	Function
AD0 to AD15	PDL0 to PDL15	I/O	Data bus
A0 to A15	P90 to P915	Output	Address bus
A16 to A23 ^{Note}	PDH0 to PDH7	Output	Address bus
$\overline{\text{WAIT}}$	PCM0	Input	External wait control
CLKOUT	PCM1	Output	Internal system clock
$\overline{\text{CS0}}$ to $\overline{\text{CS3}}$	PCS0 to PCS3	Output	Chip select
$\overline{\text{WR0}}$, $\overline{\text{WR1}}$	PCT0, PCT1	Output	Write strobe signal
$\overline{\text{RD}}$	PCT4	Output	Read strobe signal
$\overline{\text{HLDRQ}}$	PCM3	Input	Bus hold control
$\overline{\text{HLDK}}$	PCM2	Output	

Note A16 to A21 in the V850ES/SA2

5.2.1 Pin status when internal ROM, internal RAM, or peripheral I/O is accessed

Table 5-3. Pin Status When Internal ROM, Internal RAM, or Peripheral I/O Is Accessed

Access Destination	Address Bus	Data Bus	Control Signal
D0 to D15	Undefined	Hi-Z	Inactive
A0 to A15	Undefined	Hi-Z	Inactive
A16 to A23	Note	Hi-Z	Inactive

Note When a peripheral I/O is accessed, the address bus outputs the address of the internal peripheral I/O that is accessed.

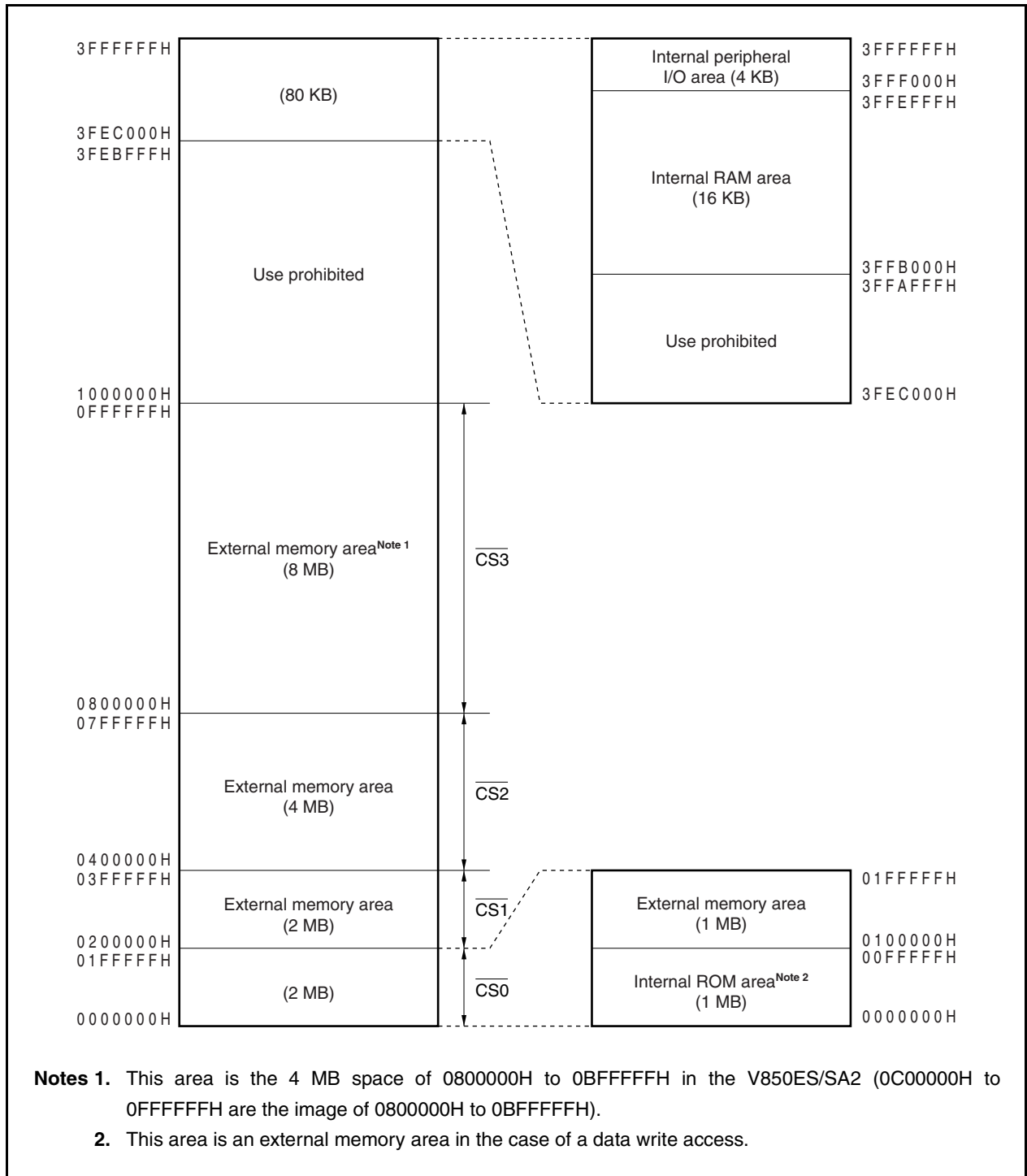
5.2.2 Pin status in each operation mode

For the pin status of the V850ES/SA2 and V850ES/SA3 in each operation mode, refer to **2.2 Pin Status**.

5.3 Memory Block Function

The 64 MB memory space is divided into memory blocks of (lower) 2 MB, 2MB, 4MB, and 8MB. The programmable wait function and bus cycle operation mode for each of these blocks can be independently controlled in one-block units.

Figure 5-1. Data Memory Map



5.3.1 Chip select control function

Of the 64 MB (linear) address space, the lower 16 MB (0000000H to 0FFFFFFFH) include four chip select functions, $\overline{CS0}$ to $\overline{CS3}$. The areas that can be selected by $\overline{CS0}$ to $\overline{CS3}$ are fixed.

By using these chip select functions, the memory block can be divided to enable effective use of the memory space. The allocation of the memory blocks is shown in the table below.

	V850ES/SA2	V850ES/SA3
$\overline{CS0}$	0000000H to 01FFFFFFH (2 MB)	0000000H to 01FFFFFFH (2 MB)
$\overline{CS1}$	0200000H to 03FFFFFFH (2 MB)	0200000H to 03FFFFFFH (2 MB)
$\overline{CS2}$	0400000H to 07FFFFFFH (4 MB)	0400000H to 07FFFFFFH (4 MB)
$\overline{CS3}$	0800000H to 0BFFFFFFH (4 MB)	0800000H to 0FFFFFFFH (8 MB)

5.4 External Bus Interface Mode Control Function

The V850ES/SA2 and V850ES/SA3 include the following two external bus interface modes.

- Multiplexed bus mode
- Separate bus mode

These two modes can be selected by using the external bus interface mode control register (EXIMC).

(1) External bus interface mode control register (EXIMC)

This register can be read or written in 8-bit or 1-bit units.

\overline{RESET} input clears this value to 00H.

After reset: 00H		R/W	Address: FFFFFFFBEH							
			7	6	5	4	3	2	1	0
EXIMC			0	0	0	0	0	0	0	SMSEL
	SMSEL	Mode selection								
	0	Multiplexed bus mode								
	1	Separate bus mode								

5.5 Bus Access

5.5.1 Number of clocks for access

The following table shows the number of basic clocks required for accessing each resource.

Area (Bus Width) / Bus Cycle Type	Internal ROM (32 bits)	Internal RAM (32 bits)	External Memory (16 bits)
Instruction fetch (normal access)	1	1 or 2	3 + n ^{Note}
Instruction fetch (branch)	2	1 or 2	3 + n ^{Note}
Operand data access	3	1	3 + n ^{Note}

Note 2 + n clocks (n: Number of wait states) when the separate bus mode is selected.

Remark Unit: Clocks/access

5.5.2 Bus size setting function

The bus size of each external memory area selected by \overline{CSn} can be set (to 8 bits or 16 bits) by using the BSC register.

The external memory area of the V850ES/SA2 (0100000H to 0BFFFFFFH) is selected by $\overline{CS0}$ to $\overline{CS3}$.

The external memory area of the V850ES/SA3 (0100000H to 0FFFFFFFH) is selected by $\overline{CS0}$ to $\overline{CS3}$.

(1) Bus size configuration register (BSC)

This register can be read or written in 16-bit units.

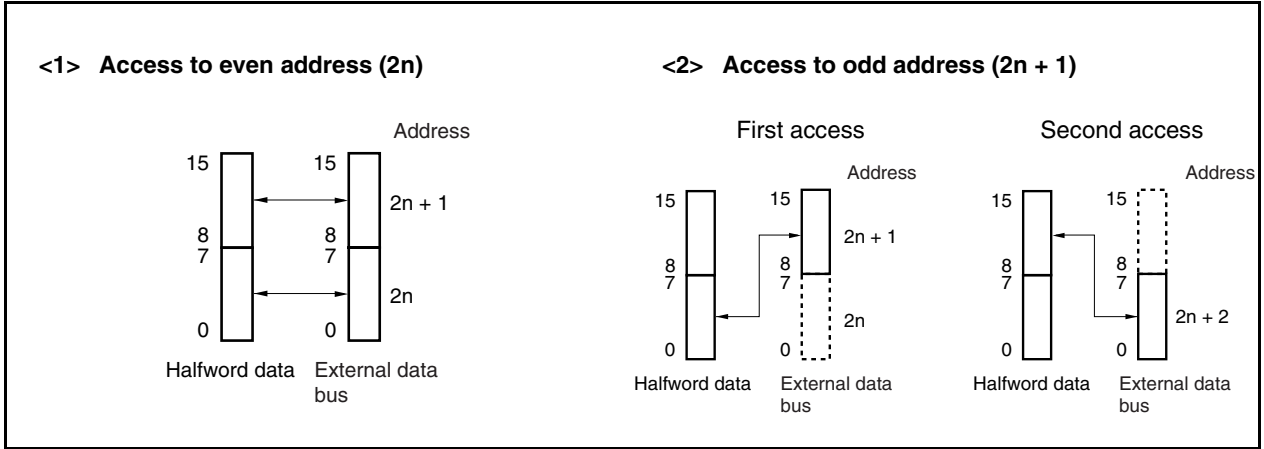
Caution Write to the BSC register after reset, and then do not change the set values. Also, do not access an external memory area other than the one for this initialization routine until the initial settings of the BSC register are complete. However, external memory areas whose initial settings are complete may be accessed.

After reset: 5555H		R/W	Address: FFFFF066H					
	15	14	13	12	11	10	9	8
BSC	0	1	0	1	0	1	0	1
	7	6	5	4	3	2	1	0
	0	BS30	0	BS20	0	BS10	0	BS00
\overline{CSn} signal	$\overline{CS3}$		$\overline{CS2}$		$\overline{CS1}$		$\overline{CS0}$	
BSn0	Data bus width of CSn space (n = 0 to 3)							
0	8 bits							
1	16 bits							

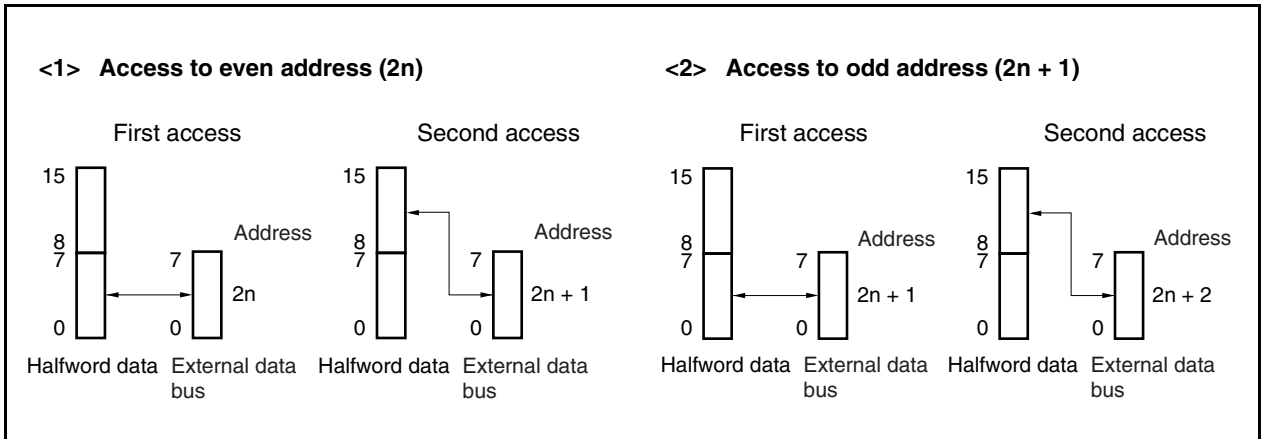
Caution Be sure to set bits 14, 12, 10, and 8 to 1, and clear bits 15, 13, 11, 9, 7, 5, 3, and 1 to 0.

(2) Halfword access (16 bits)

(a) With 16-bit data bus width



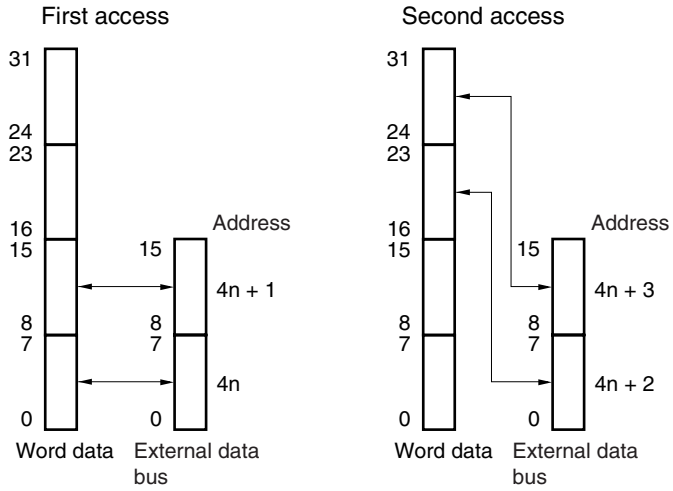
(b) 8-bit data bus width



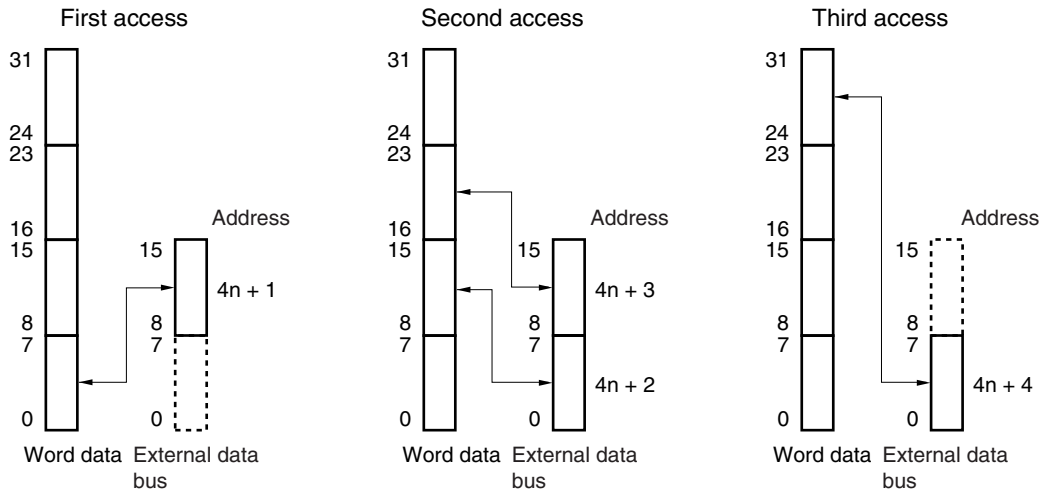
(3) Word access (32 bits)

(a) 16-bit data bus width (1/2)

<1> Access to address (4n)

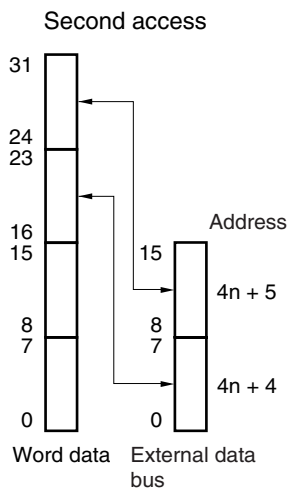
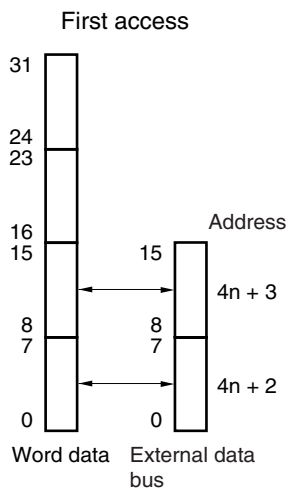


<2> Access to address (4n + 1)

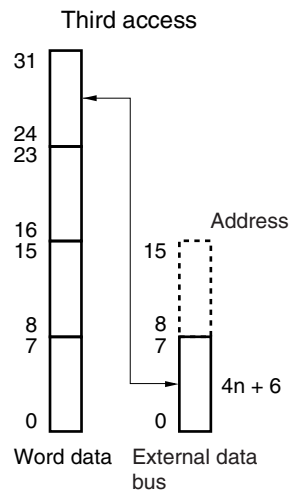
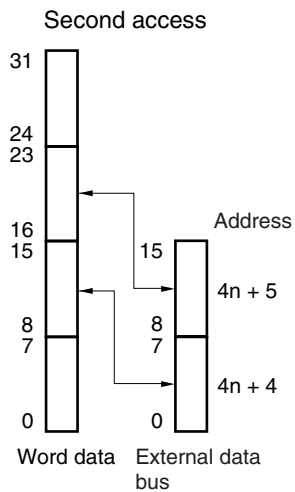
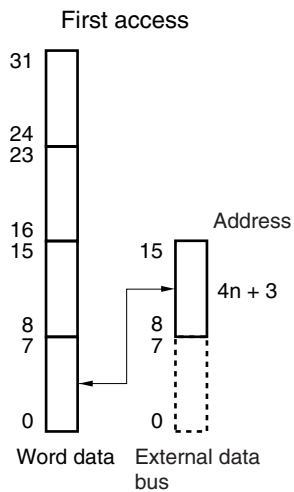


(a) 16-bit data bus width (2/2)

<3> Access to address (4n + 2)

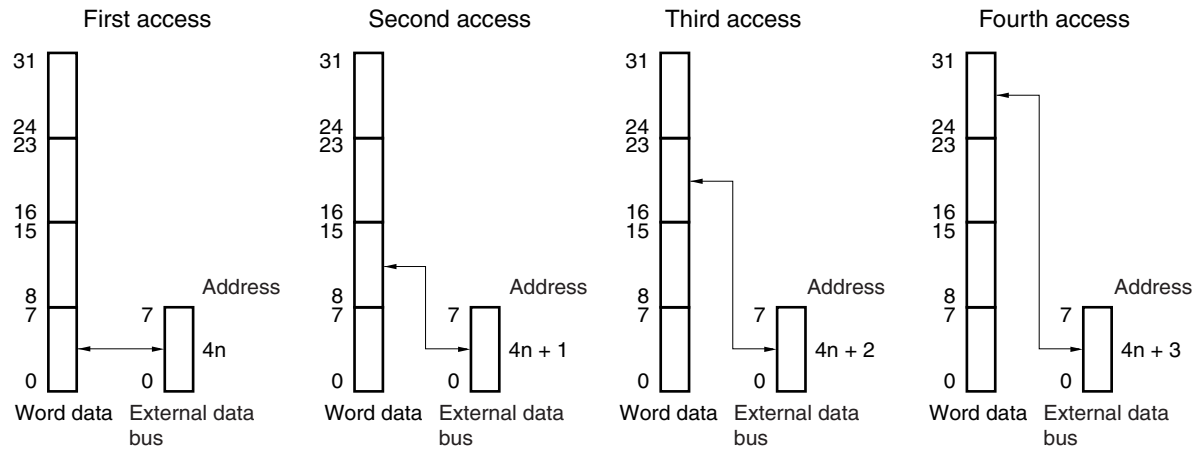


<4> Access to address (4n + 3)

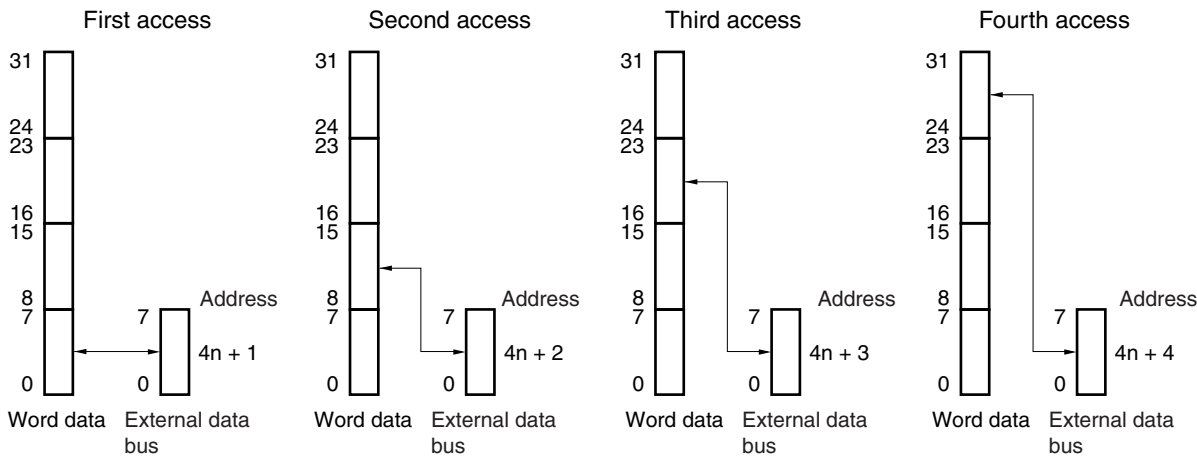


(b) 8-bit data bus width (1/2)

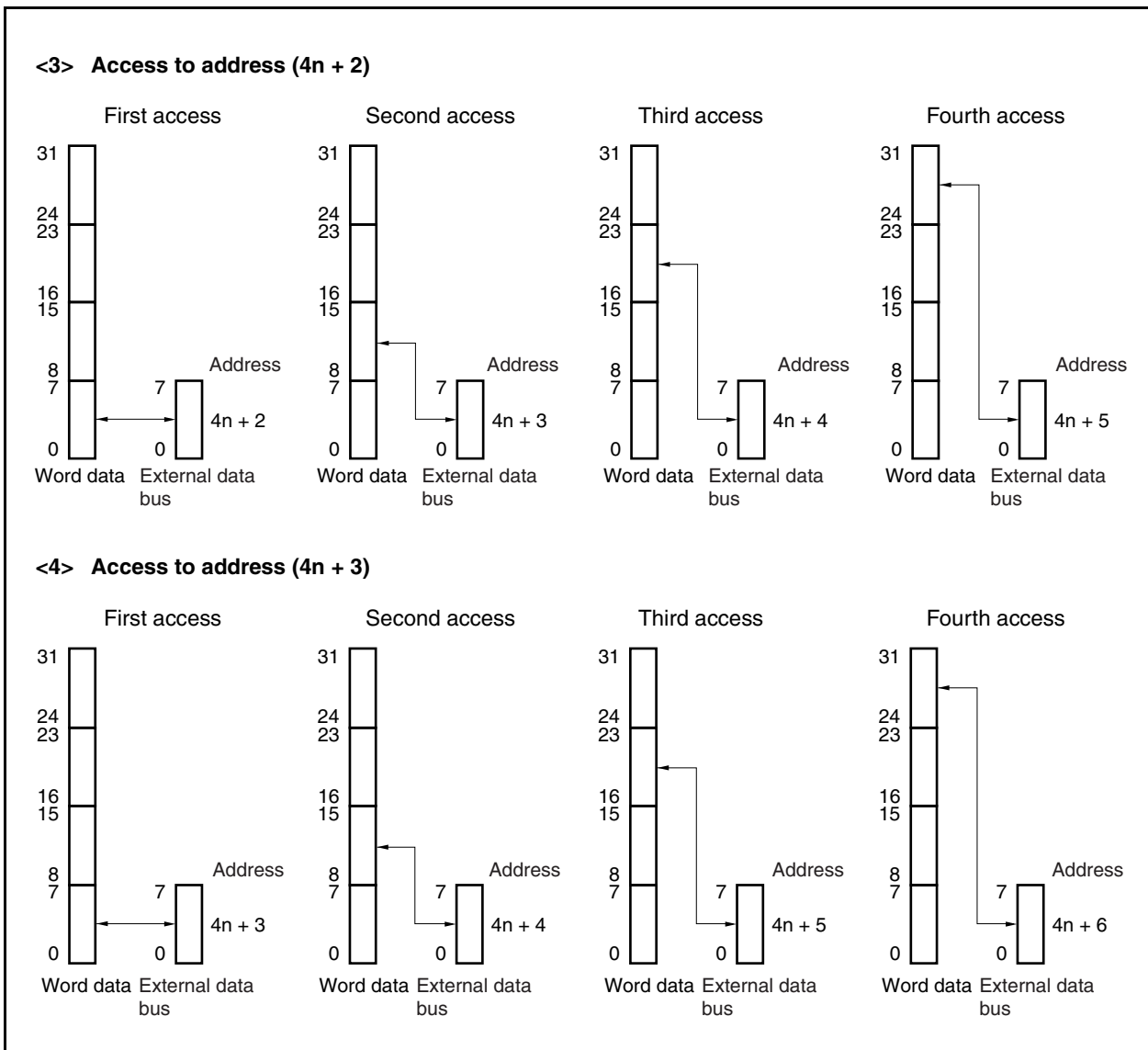
<1> Access to address (4n)



<2> Access to address (4n + 1)



(b) 8-bit data bus width (2/2)



5.6 Wait Function

5.6.1 Programmable wait function

(1) Data wait control register 0 (DWC0)

To realize interfacing with a low-speed memory or I/O, up to seven data wait states can be inserted in the bus cycle that is executed for each CS space.

The number of wait states can be programmed by using data wait control register 0 (DWC0). Immediately after system reset, 7 data wait states are inserted for all the blocks.

The DWC0 register can be read or written in 16-bit units.

- Cautions**
- 1. The internal ROM and internal RAM areas are not subject to programmable wait, and are always accessed without a wait state. The internal peripheral I/O area is also not subject to programmable wait, and only wait control from each peripheral function is performed.**
 - 2. Write to the DWC0 register after reset, and then do not change the set values. Also, do not access an external memory area other than the one for this initialization routine until the initial settings of the DWC0 register are complete. However, external memory areas whose initial settings are complete may be accessed.**

After reset: 7777H R/W Address: FFFFF484H

	15	14	13	12	11	10	9	8
DWC0	0	DW32	DW31	DW30	0	DW22	DW21	DW20
\overline{CSn} signal	$\overline{CS3}$			$\overline{CS2}$				

	7	6	5	4	3	2	1	0
	0	DW12	DW11	DW10	0	DW02	DW01	DW00
\overline{CSn} signal	$\overline{CS1}$			$\overline{CS0}$				

DWn2	DWn1	DWn0	Number of wait states inserted in CSn space (n = 0 to 3)
0	0	0	None
0	0	1	1
0	1	0	2
0	1	1	3
1	0	0	4
1	0	1	5
1	1	0	6
1	1	1	7

Caution Be sure to clear bits 15, 11, 7, and 3 to 0.

5.6.2 External wait function

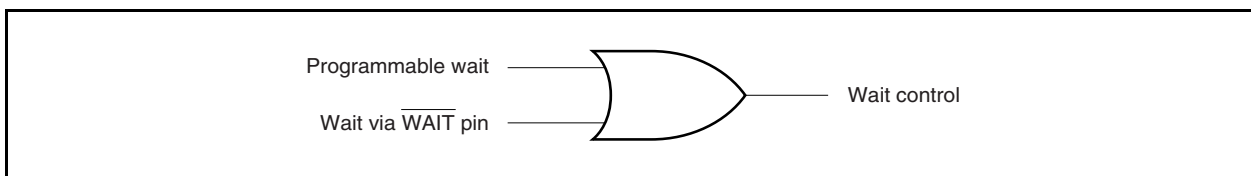
To synchronize an extremely slow external device, I/O, or asynchronous system, any number of wait states can be inserted in the bus cycle by using the external wait pin ($\overline{\text{WAIT}}$).

Access to each area of the internal ROM, internal RAM, and internal peripheral I/O is not subject to control by the external wait function, in the same manner as the programmable wait function.

The $\overline{\text{WAIT}}$ signal can be input asynchronously to CLKOUT, and is sampled at the falling edge of the clock in the T2 and TW states of the bus cycle in the multiplexed bus mode. In the separate bus mode, it is sampled at the rising edge of the clock immediately after the T1 and TW states of the bus cycle. If the setup/hold time of the sampling timing is not satisfied, a wait state is inserted in the next state, or not inserted at all.

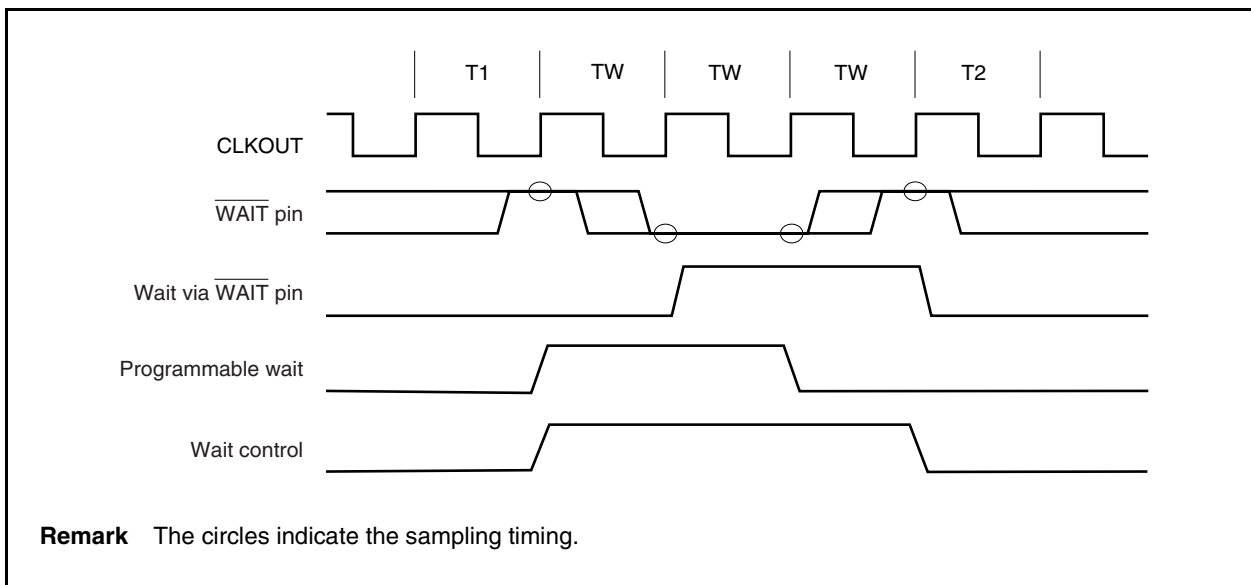
5.6.3 Relationship between programmable wait and external wait

Wait cycles are inserted as the result of an OR operation between the wait cycles specified by the set value of the programmable wait and the wait cycles controlled by the $\overline{\text{WAIT}}$ pin. In other words, the number of wait cycles is determined by the side with the greatest number of cycles.



For example, if the timing of the programmable wait and the $\overline{\text{WAIT}}$ pin signal is as illustrated below, three wait states will be inserted in the bus cycle.

Figure 5-3. Example of Inserting Wait States in Separate Bus Mode



5.6.4 Programmable address wait function

Address-setup or address-hold waits to be inserted in each bus cycle can be set by using the address wait control register (AWC). Address wait insertion is set for each chip select area ($\overline{CS0}$ to $\overline{CS3}$).

If an address setup wait is inserted, it seems that the high-clock period of T1 state is extended by 1 clock. If an address hold wait is inserted, it seems that the low-clock period of T1 state is extended by 1 clock.

(1) Address wait control register (AWC)

This register can be read or written in 16-bit units.

After reset: FFFFH		R/W		Address: FFFF488H				
	15	14	13	12	11	10	9	8
AWC	1	1	1	1	1	1	1	1
	7	6	5	4	3	2	1	0
	AHW3		ASW3		AHW2		ASW2	
	AHW1		ASW1		AHW0		ASW0	
\overline{CSn} signal	$\overline{CS3}$		$\overline{CS2}$		$\overline{CS1}$		$\overline{CS0}$	

AHWn	Specifies insertion of address hold wait (n = 0 to 3)
0	Not inserted
1	Inserted

ASWn	Specifies insertion of address setup wait (n = 0 to 3)
0	Not inserted
1	Inserted

Caution Be sure to set bits 15 to 8 to 1.

5.7 Idle State Insertion Function

To facilitate interfacing with low-speed memories, one idle state (TI) can be inserted after the T3 state in the bus cycle that is executed for each space selected by the chip select function in the multiplexed address/data bus mode. In the separate bus mode, one idle state (TI) can be inserted after the T2 state. By inserting an idle state, the data output float delay time of the memory can be secured during read access (an idle state cannot be inserted during write access).

Whether the idle state is to be inserted can be programmed by using the bus cycle control register (BCC).

An idle state is inserted for all the areas immediately after system reset.

(1) Bus cycle control register (BCC)

This register can be read or written in 16-bit units.

- Cautions**
- 1. The internal ROM, internal RAM, and internal peripheral I/O areas are not subject to idle state insertion.**
 - 2. Write to the BCC register after reset, and then do not change the set values. Also, do not access an external memory area other than the one for this initialization routine until the initial settings of the BCC register are complete. However, external memory areas whose initial settings are complete may be accessed.**

After reset: AAAAH		R/W		Address: FFFFF48AH				
	15	14	13	12	11	10	9	8
BCC	1	0	1	0	1	0	1	0
	7	6	5	4	3	2	1	0
	BC31	0	BC21	0	BC11	0	BC01	0
$\overline{\text{CSn}}$ signal	$\overline{\text{CS3}}$		$\overline{\text{CS2}}$		$\overline{\text{CS1}}$		$\overline{\text{CS0}}$	
BCn1	Specifies insertion of idle state (n = 0 to 3)							
0	Not inserted							
1	Inserted							

Caution Be sure to set bits 15, 13, 11, and 9 to 1, and clear bits 14, 12, 10, 8, 6, 4, 2, and 0 to 0.

5.8 Bus Hold Function

5.8.1 Functional outline

The $\overline{\text{HLDAK}}$ and $\overline{\text{HLDRQ}}$ functions are valid if the PCM2 and PCM3 pins are set in the control mode.

When the $\overline{\text{HLDRQ}}$ pin is asserted (low level), indicating that another bus master has requested bus mastership, the external address/data bus goes into a high-impedance state and is released (bus hold status). If the request for the bus mastership is cleared and the $\overline{\text{HLDRQ}}$ pin is deasserted (high level), driving these pins is started again.

During the bus hold period, execution of the program in the internal ROM and internal RAM is continued until a peripheral I/O register or the external memory is accessed.

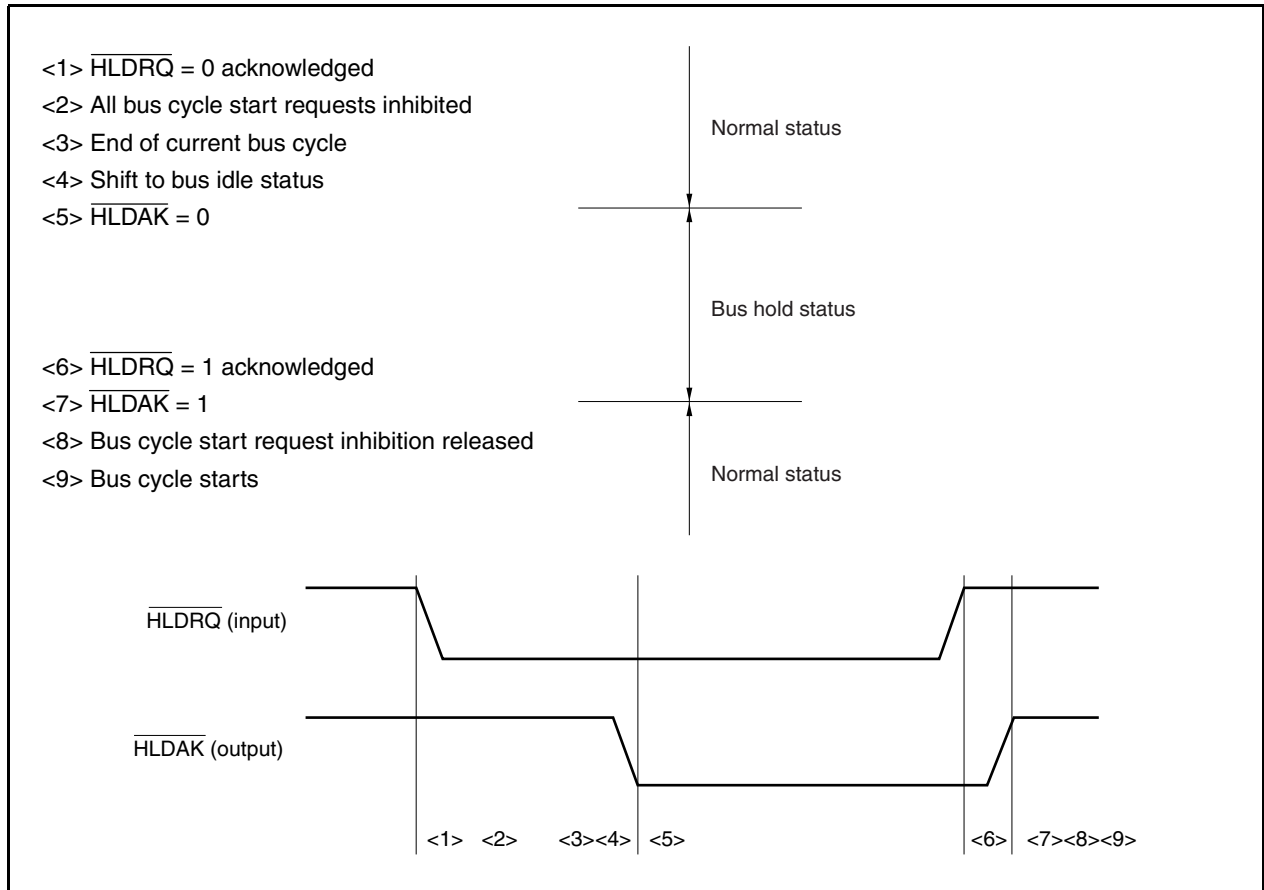
The bus hold status is indicated by assertion of the $\overline{\text{HLDAK}}$ pin (low level). The bus hold function enables the configuration multi-processor type systems in which two or more bus masters exist.

Note that the bus hold request is not acknowledged during a multiple-access cycle initiated by the bus sizing function or a bit manipulation instruction.

Status	Data Bus Width	Access Type	Timing in Which Bus Hold Request Not Acknowledged
CPU bus lock	16 bits	Word access to even address	Between first and second access
		Word access to odd address	Between first and second access Between second and third access
		Halfword access to odd address	Between first and second access
	8 bits	Word access	Between first and second access
			Between second and third access
			Between third and fourth access
		Halfword access	Between first and second access
Read-modify-write access of bit manipulation instruction	–	–	Between read access and write access

5.8.2 Bus hold procedure

The bus hold status transition procedure is shown below.



5.8.3 Operation in power save mode

Because the internal system clock is stopped in the software STOP and IDLE modes, the bus hold status is not entered even if the $\overline{\text{HLDNRQ}}$ pin is asserted.

In the HALT mode, the $\overline{\text{HLDNRK}}$ pin is asserted as soon as the $\overline{\text{HLDNRQ}}$ pin has been asserted, and the bus hold status is entered. When the $\overline{\text{HLDNRQ}}$ pin is later deasserted, the $\overline{\text{HLDNRK}}$ pin is also deasserted, and the bus hold status is cleared.

5.9 Bus Priority


Bus hold, instruction fetch (branch), instruction fetch (successive), and operand data accesses are executed in the external bus cycle.

Bus hold has the highest priority, followed by operand data access, instruction fetch (branch), and instruction fetch (successive).

An instruction fetch may be inserted between the read access and write access in a read-modify-write access.

If an instruction is executed for two or more accesses, an instruction fetch and bus hold are not inserted between accesses due to bus size limitations.

Table 5-4. Bus Priority

Priority	External Bus Cycle	Bus Master
High	Bus hold	External device
	DMA transfer	DMAC
	Operand data access	CPU
	Instruction fetch (branch)	CPU
	Instruction fetch (successive)	CPU
Low		

5.10 Boundary Operation Conditions

5.10.1 Program space

- (1) If a branch instruction exists at the upper limit of the internal RAM area, a prefetch operation straddling over the internal peripheral I/O area (invalid fetch) does not occur.
- (2) Instruction execution to the external memory area cannot be continued without a branch from the internal ROM area to the external memory area.

5.10.2 Data space

The V850ES/SA2 and V850ES/SA3 have an address misalign function.

With this function, data can be placed at all addresses, regardless of the format of the data (word data or halfword data). However, if the word data or halfword data is not aligned at the boundary, a bus cycle is generated at least twice, causing the bus efficiency to drop.

(1) Halfword-length data access

A byte-length bus cycle is generated twice if the least significant bit of the address is 1.

(2) Word-length data access

- (a) A byte-length bus cycle, halfword-length bus cycle, and byte-length bus cycle are generated in that order if the least significant bit of the address is 1.
- (b) A halfword-length bus cycle is generated twice if the lower 2 bits of the address are 10.

5.11 Bus Timing

Figure 5-4. Multiplexed Bus Read Timing (Bus Size: 16 Bits, 16-Bit Access)

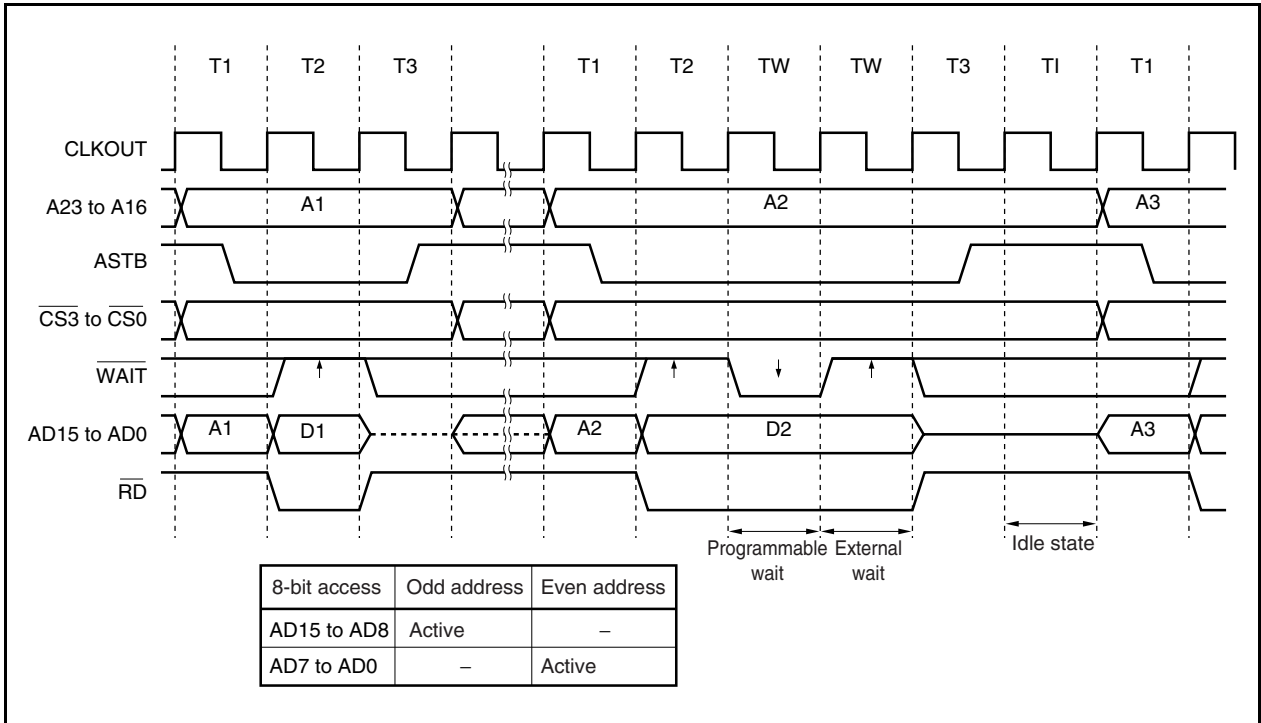


Figure 5-5. Multiplexed Bus Read Timing (Bus Size: 8 Bits)

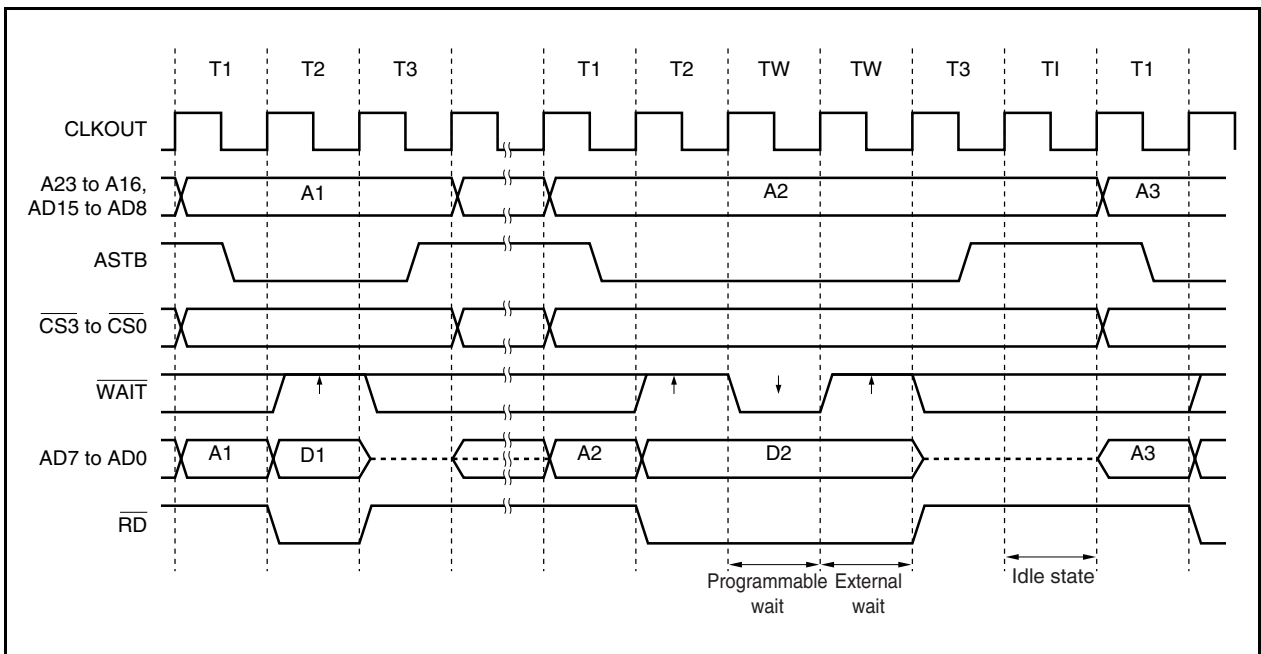


Figure 5-6. Multiplexed Bus Write Timing (Bus Size: 16 Bits, 16-Bit Access)

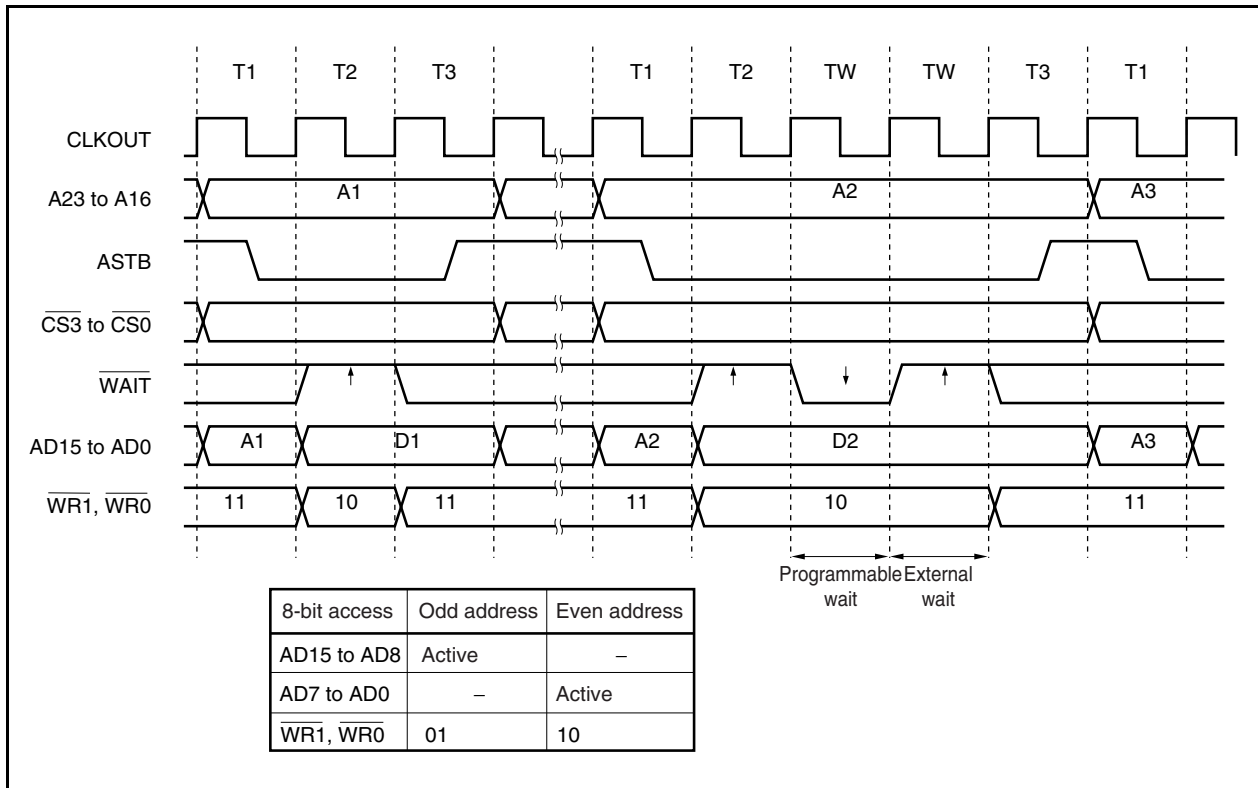


Figure 5-7. Multiplexed Bus Write Timing (Bus Size: 8 Bits)

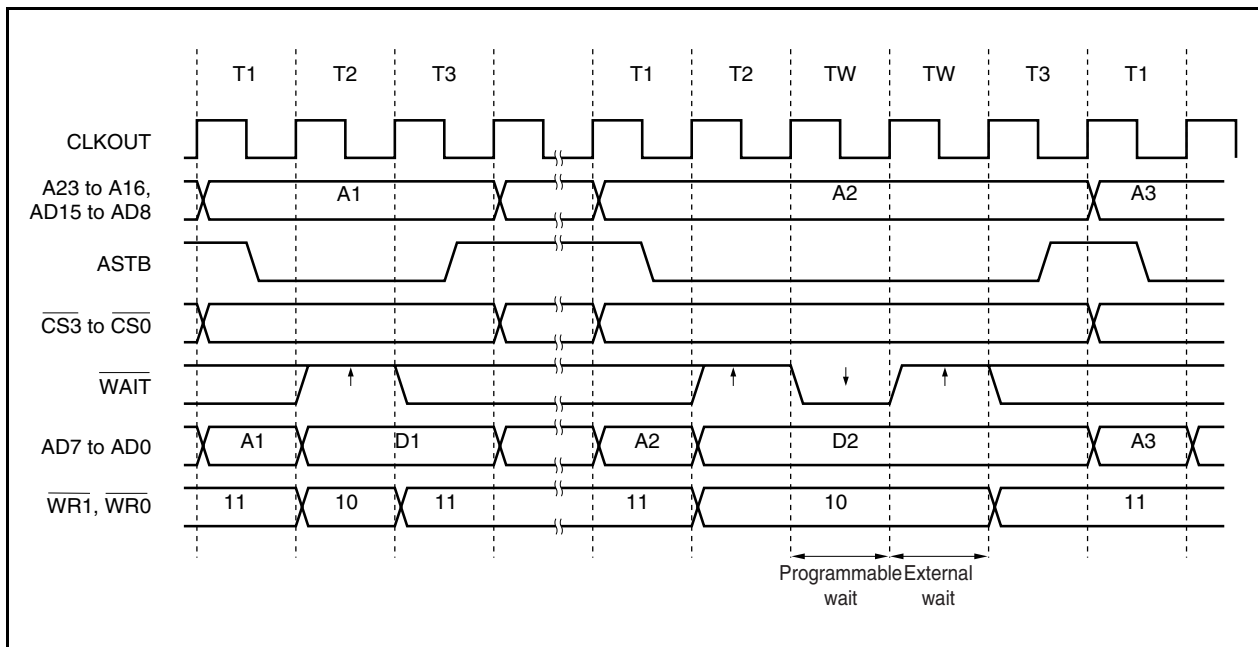


Figure 5-8. Multiplexed Bus Hold Timing (Bus Size: 16 Bits, 16-Bit Access)

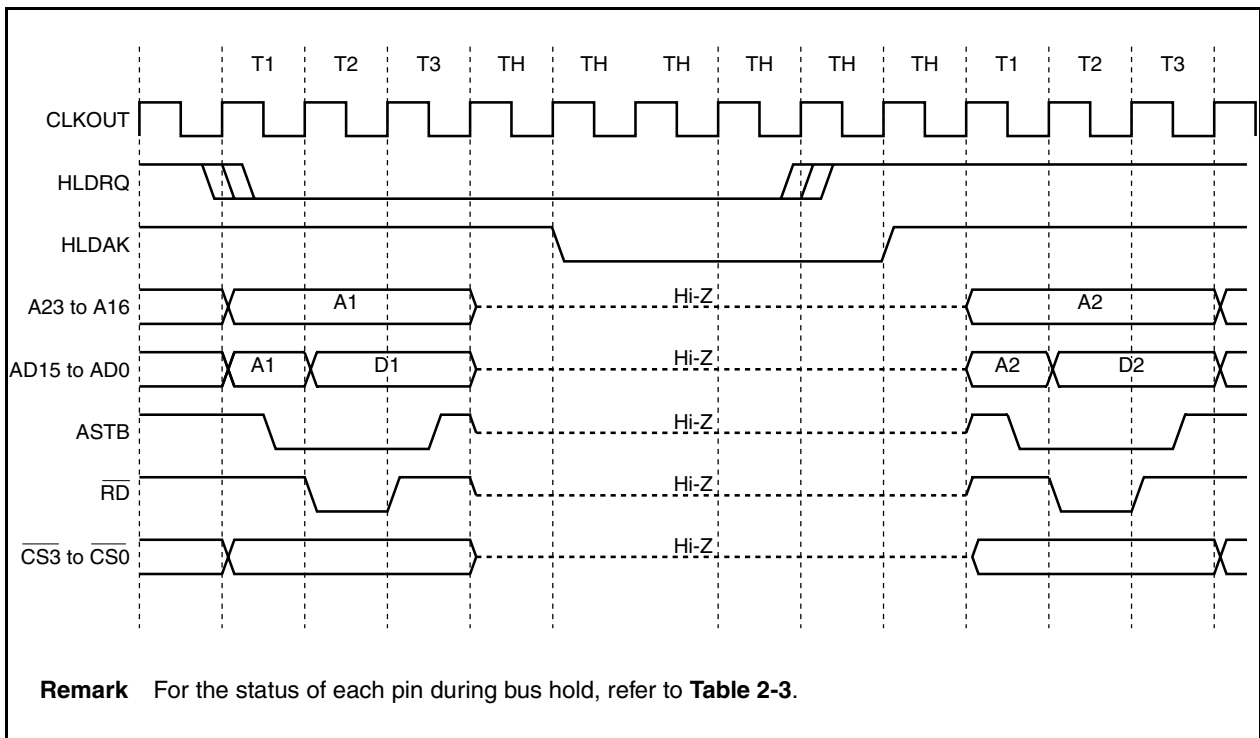


Figure 5-9. Separate Bus Read Timing (Bus Size: 16 Bits, 16-Bit Access)

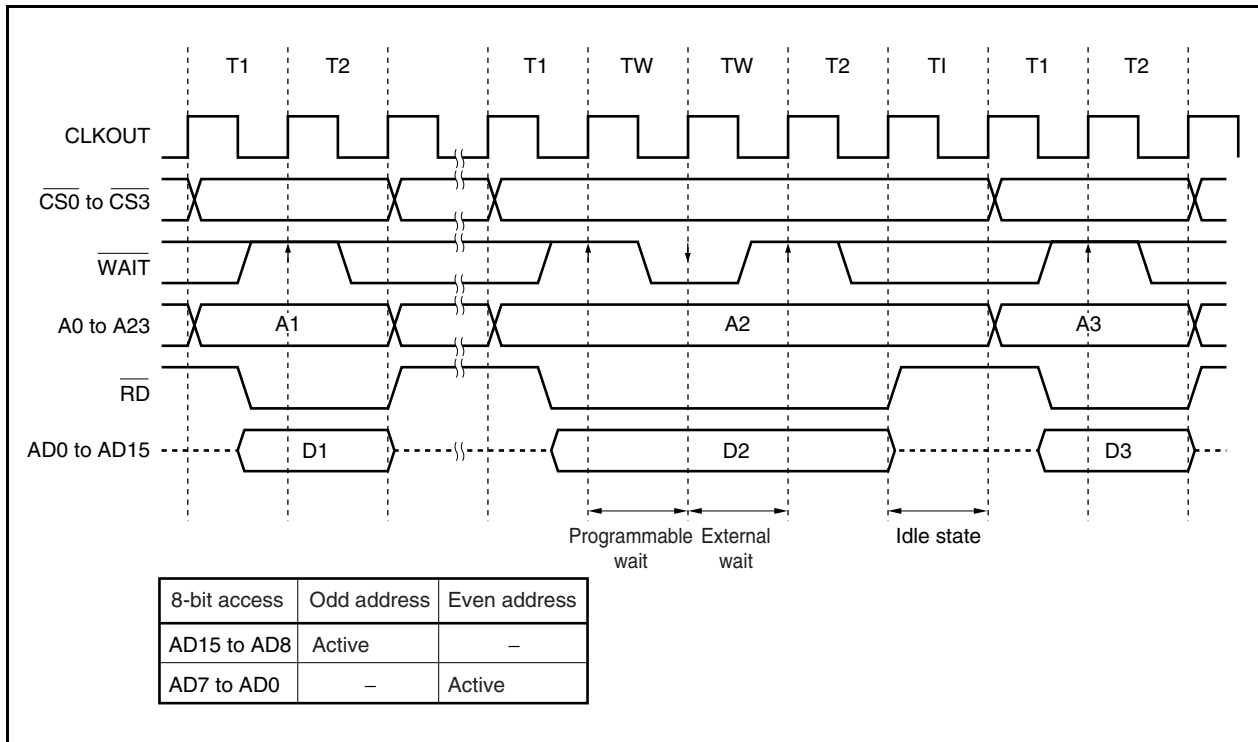


Figure 5-10. Separate Bus Read Timing (Bus Size: 8 Bits)

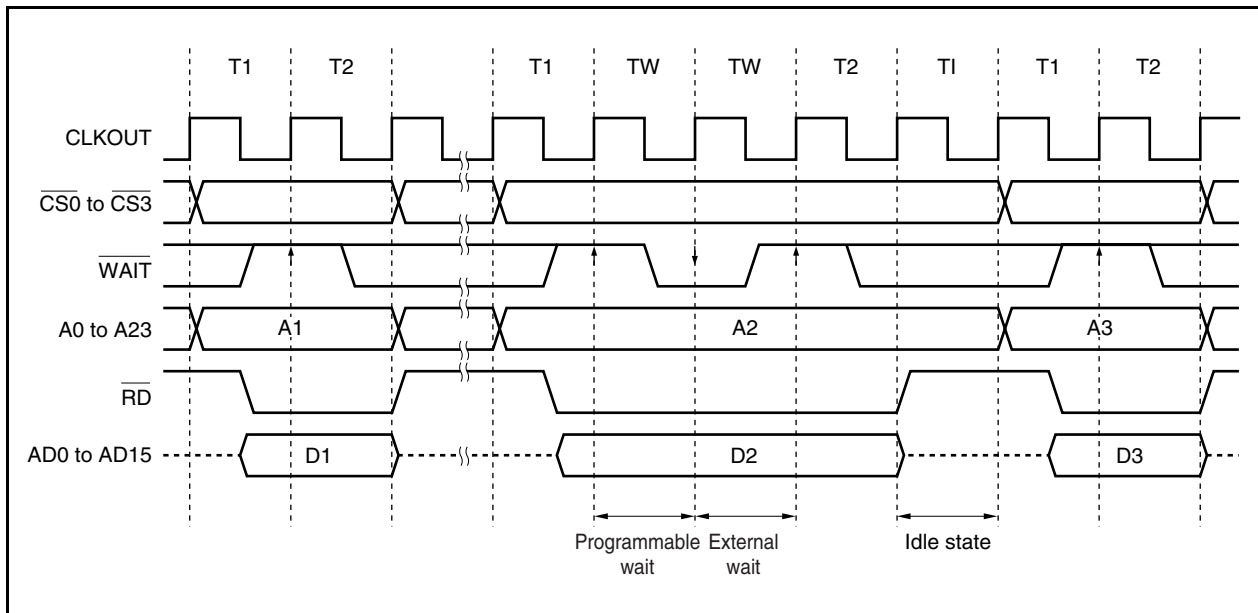


Figure 5-11. Separate Bus Write Timing (Bus Size: 16 Bits, 16-Bit Access)

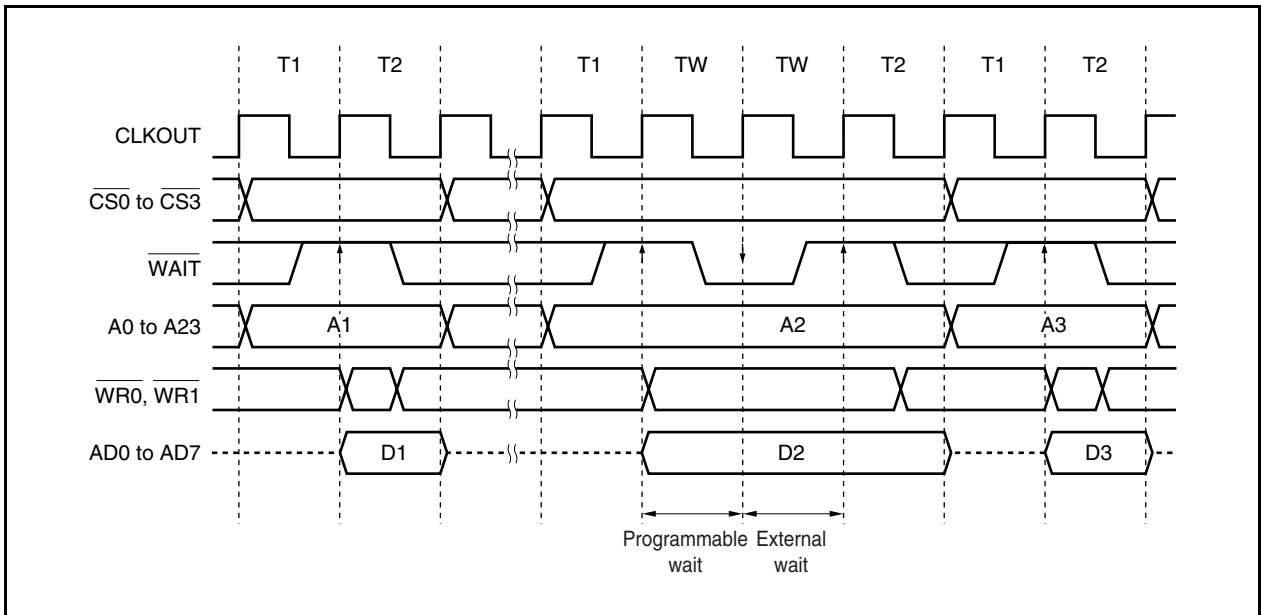


Figure 5-12. Separate Bus Write Timing (Bus Size: 8 Bits)

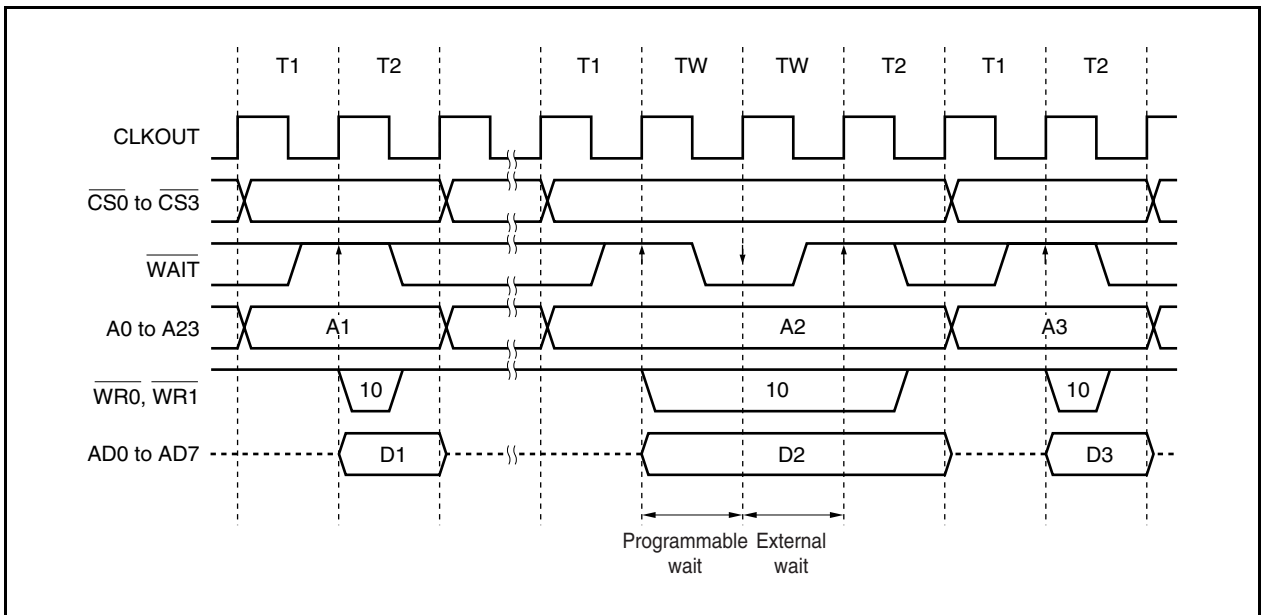


Figure 5-13. Separate Bus Hold Timing (Bus Size: 8 Bits, During Write)

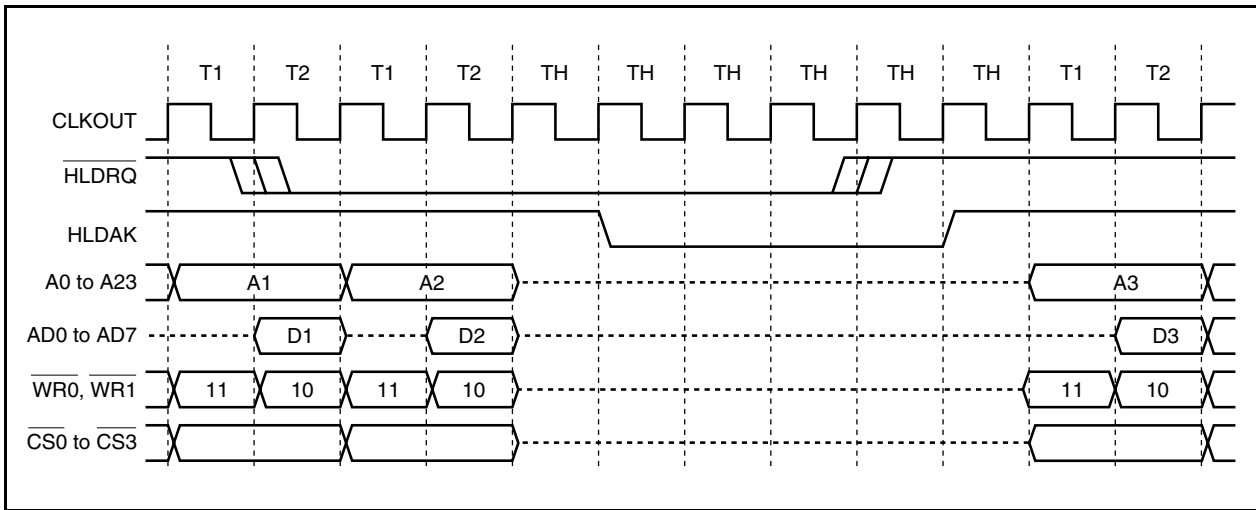
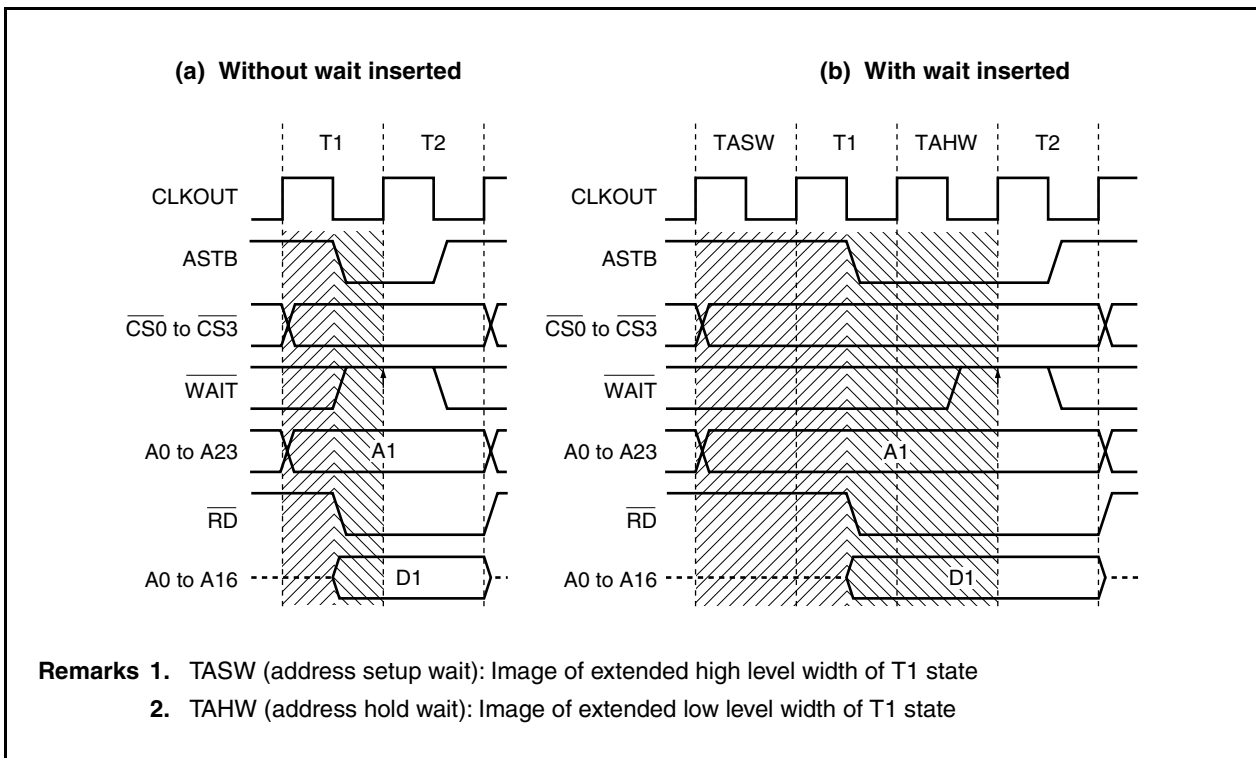


Figure 5-14. Address Wait Timing (Separate Bus Read, Bus Size: 16 Bits, 16-Bit Access)



CHAPTER 6 CLOCK GENERATION FUNCTION

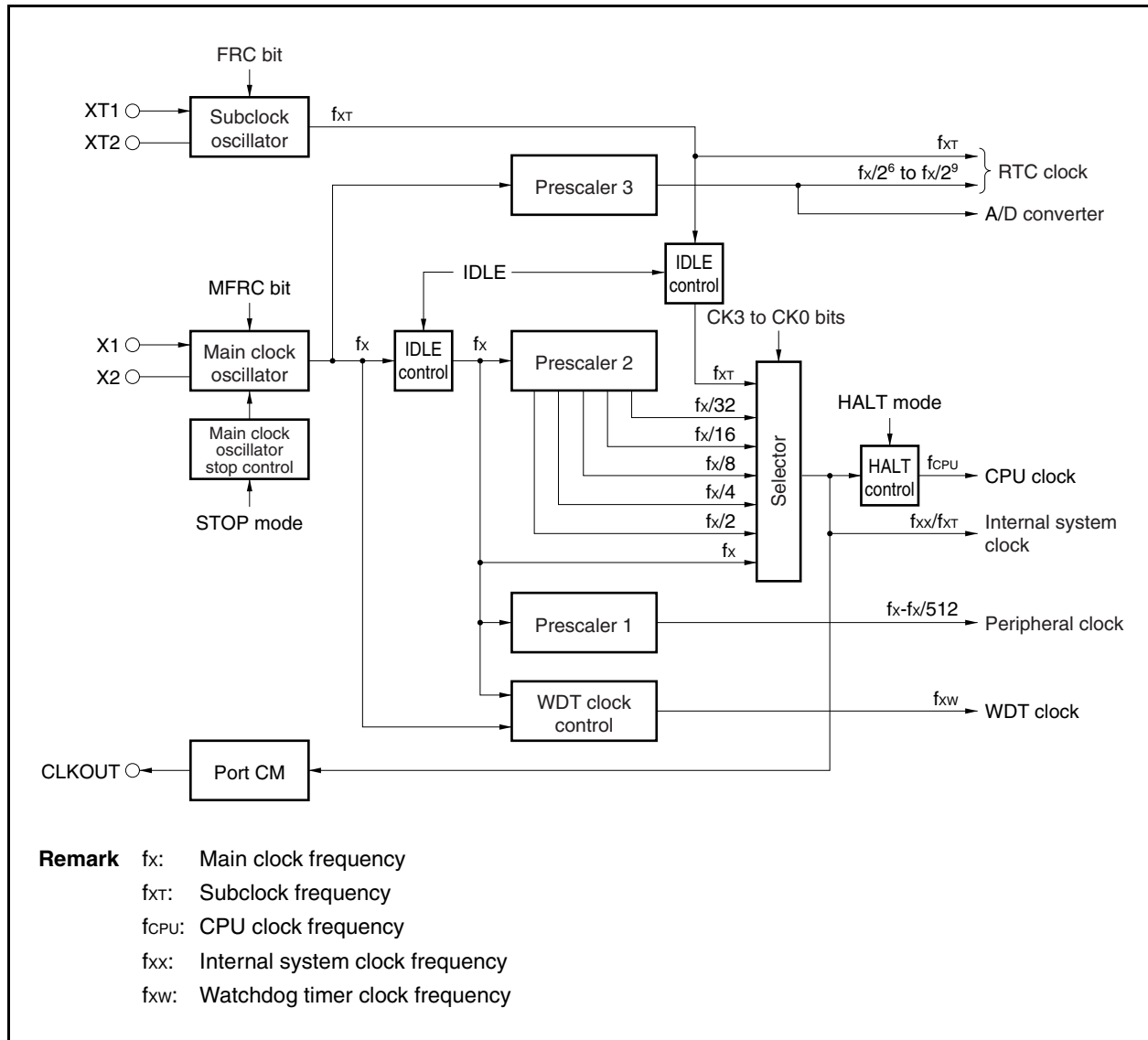
6.1 Overview

The features of the clock generation function are as follows.

- Main clock oscillator (f_x)
 - 2 to 17 MHz (at 2.2 to 2.7 V operation)
- Subclock oscillator (f_{xT})
 - 32.768 kHz
- Generation of internal system clock (f_{xx})
 - Seven steps (f_x , $f_x/2$, $f_x/4$, $f_x/8$, $f_x/16$, $f_x/32$, f_{xT})
- Generation of peripheral clock
- Clock output function

6.2 Configuration

Figure 6-1. Clock Generator



(1) Main clock oscillator

This circuit oscillates the following frequency (f_x):

- 2 to 17 MHz (at 2.2 to 2.7 V operation)

(2) Subclock oscillator

This circuit oscillates a frequency of 32.768 kHz (f_{XT}).

(3) Main clock resonator stop control

This circuit generates a control signal that stops oscillation of the main clock resonator.

It stops the oscillation of the main clock resonator in the software STOP mode or when the MCK bit = 1 (valid only when the CLS bit = 1).

(4) Prescaler 1

This circuit generates the clock (f_x to $f_x/512$) to be supplied to the internal peripheral functions.

The clock is supplied to the following blocks:

TM0 to TM5, CSI0 to CSI4, UART0, UART1, I²C, ADC, DAC

(5) Prescaler 2

This circuit divides the main clock (f_x).

The clock generated by prescaler 2 (f_x to $f_x/32$) is supplied to the selector that generates the internal system clock (f_{xx}).

f_{xx} is the clock that is supplied to the CPU, INTC, DMAC, and ROMC blocks, and can be output from the CLKOUT pin.

(6) Prescaler 3

This circuit divides the clock (f_x) generated by the main resonator to a specific frequency (32.768 kHz) and supplies it to the RTC and ADC.

For details, refer to **6.5 Prescaler 3**.

(7) Watchdog timer clock control

This circuit divides the main clock frequency (f_x) by two to generate the clock (f_{xw}) to be supplied to the watchdog timer.

6.3 Control Registers

(1) Processor clock control register (PCC)

The processor clock control register (PCC) is a special register. Data can be written to it only in combination of specific sequences (refer to **3.4.8 Special registers**).

This register can be read or written in 8-bit or 1-bit units. The CLS bit is a read-only bit.

After reset: 03H R/W Address: FFFFF828H

	7	<6>	5	<4>	<3>	2	1	0
PCC	FRC	MCK	MFRC	CLS ^{Note}	CK3	CK2	CK1	CK0

FRC	Selects internal feedback resistor of subclock
0	Used
1	Not used

MCK	Operation of main clock
0	Operating
1	Stopped
<ul style="list-style-type: none"> • Even if the MCK bit is set to 1 while the system is operating with the main clock as the CPU clock, the operation of the main system clock does not stop. It stops after the CPU clock has been changed to the subclock. • When the main clock is stopped and the device is operating on the subclock, clear the MCK bit to 0 and wait until the oscillation stabilization time has been secured by the program before switching back to the main clock. 	

MFRC	Selects internal feedback resistor of main clock
0	Used
1	Not used

CLS	Status of CPU clock (f_{CPU})
0	Main clock operation
1	Subclock operation

CK3	CK2	CK1	CK0	Selects clock (f_x/f_{CPU})
0	0	0	0	f_x
0	0	0	1	$f_x/2$
0	0	1	0	$f_x/4$
0	0	1	1	$f_x/8$
0	1	0	0	$f_x/16$
0	1	0	1	$f_x/32$
0	1	1	X	Setting prohibited
1	X	X	X	f_{XT} (subclock: 32.768 kHz)

Note The CLS bit is a read-only bit.

Caution Do not change the CPU clock (by using the CK2 to CK0 bits of the PCC register) while CLKOUT is being output.

Remark X: Don't care.

Examples of settings to change between the main clock and subclock are shown below

(a) Example of setting when changing from main clock to subclock

- <1> Checking internal system clock: Check if the following condition is satisfied.
- Internal system clock (f_{xx}) > Subclock (32.768 kHz) × 4
- If this condition is not satisfied, change the setting of the CK2, CK1, and CK0 bits so that the condition is satisfied. At this time, do not change the setting of the CK3 bit.
- <2> CK3 bit ← “1”:
- Use of a bit manipulation instruction is recommended. Do not change the setting of the CK2, CK1, and CK0 bits.
- <3> Subclock operation:
- The following time is required between when the CK3 bit is set and when the subclock operation is started:
- Maximum: (1/Subclock frequency)
- Therefore, read the CLS bit and confirm that the subclock operation has started.
- <4> MCK ← “0”:
- Clear MCK to 0 only when stopping the main clock.

(b) Example of setting when changing subclock to main clock

- <1> MCK ← “1”:
- Oscillation of the main clock is started.
- <2> Software wait:
- Insert wait states by program and wait until the oscillation stabilization time of the main clock elapses.
- <3> CK3 ← “0”:
- Use of a bit manipulation instruction is recommended. Do not change the setting of the CK2, CK1, and CK0 bits.
- <3> Main clock operation:
- The following time is required between when the CK3 bit is set and when the main clock specified by the CK2, CK1, and CK0 bits is selected.
- Maximum: (1/Subclock frequency)
- Therefore, read the CLS bit and confirm that the main clock operation has started.

(2) Power save control register (PSC)

The power save control register (PSC) is a special register. Data can be written to this register only in combination of specific sequences (refer to **3.4.8 Special registers**).

This register can be read or written in 8-bit or 1-bit units.

After reset: 00H	R/W	Address: FFFFF1FEH						
PSC	7	6	5	4	3	2	1	0
	0	0	0	0	0	0	STP	0
	STP	Setting of software STOP mode						
	0	Normal mode						
	1	Software STOP mode						

(3) Power save mode register (PSMR)

This is an 8-bit register that controls the operation status and clock operation in the power save mode.

It can be read or written in 8-bit or 1-bit units.

RESET input clears this register to 00H.

After reset: 00H	R/W	Address: FFFFF820H						
PSMR	7	6	5	4	3	2	1	0
	0	0	0	0	0	0	0	PSM
	PSM	Specifies operation in software standby mode (valid when bit 1 (STP) of the PSC register is set to 1)						
	0	IDLE mode						
	1	Software STOP mode						

Cautions

1. Be sure to clear bits 1 to 7 of the PSMR register to 0.
2. The PSM bit is valid only when the STP bit of the PSC register is set to 1.

(4) Oscillation stabilization time select register (OSTS)

This is an 8-bit register that controls the operation status and clock in the power save mode.

Refer to **9.1.3 (1) Oscillation stabilization time select register (OSTS)**.

6.4 Operation

6.4.1 Operation of each clock

The following table shows the operation status of each clock.

Table 6-1. Operation Status of Each Clock

	CLS bit = 0 MCK bit = 0					CLS bit = 1 MCK bit = 0		CLS bit = 1 MCK bit = 1		<8>
	<1>	<2>	<3>	<4>	<5>	<6>	<7>	<6>	<7>	
Main resonator (fx)	×	√	√	√	×	√	√	×	×	×
Sub-resonator (fxT)	√	√	√	√	√	√	√	√	√	√
CPU clock (fCPU)	×	×	×	×	×	√	×	√	×	×
Internal system clock (fxx)	×	×	√	×	×	√	×	√	×	×
Peripheral clock (fx to fx/512)	×	×	√	×	×	√	×	×	×	×
WDT clock (fxw)	×	√	√	×	×	Note	×	×	×	×
RTC clock (main)	√	√	√	√	√	√	√	√	√	√
RTC clock (sub)	×	√	√	√	×	√	√	×	×	×

Note The watchdog timer clock (fxw) is operable but it stops operating in the watchdog timer if the CLS bit of the processor clock control register (PCC) is set to 1.

Remarks CLS bit: Bit 6 of PCC register

MCK bit: Bit 4 of PCC register

√: Operable

×: Stops

<1>: $\overline{\text{RESET}}$ pin input

<2>: During oscillation stabilization time count

<3>: HALT mode

<4>: IDLE mode

<5>: Software STOP mode

<6>: Subclock operation mode

<7>: Sub-IDLE mode

<8>: Backup mode

6.4.2 Clock output function

The clock output function allows the CLKOUT pin to output the internal system clock (fxx).

The internal system clock (fxx) is selected by using the CK2 to CK0 bits of the processor clock control register (PCC).

The CLKOUT pin functions alternately as the PCM1 pin and operates as a clock output pin when the control register of port CM is manipulated (refer to **4.3.17 Port CM**).

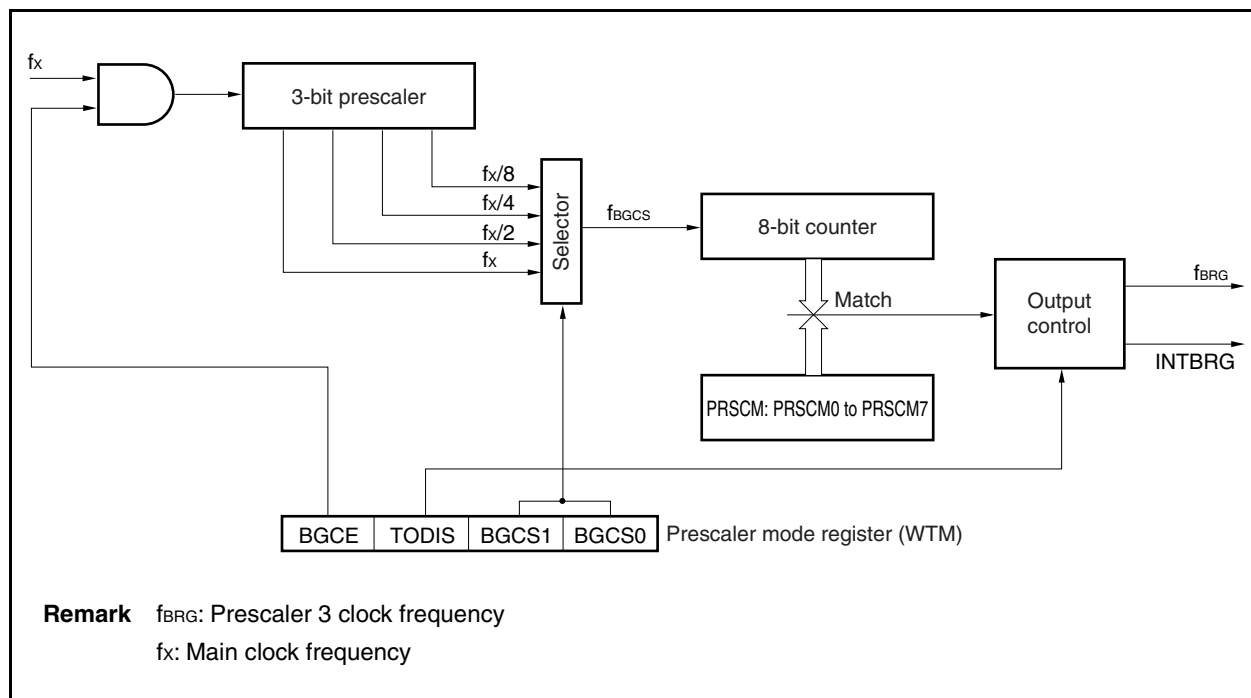
The status of the CLKOUT pin is the same as the internal system clock in Table 6-1, and can output the clock when it is √ (operable). When it is × (stops), it outputs a low level. Immediately after reset <1> and in the operation status of <2>, the alternate function of the CLKOUT pin is used (PCM1: input mode), and therefore the pin goes into a high-impedance state.

6.5 Prescaler 3

Prescaler 3 has the following functions.

- Generation of baud rate for count clock of watch timer (source clock: main clock oscillation)
- Generation of baud rate for count clock of A/D converter (source clock: main clock oscillator)
- Interval timer (INTBRG)

Figure 6-2. Block Diagram of Prescaler 3



6.5.1 Control register

(1) Prescaler mode register (PRSM)

The PRSM register controls generation of the baud rate signal of the watch timer and A/D converter. This register can be read or written in 8-bit or 1-bit units.

After reset: 00H R/W Address: FFFF8B0H

	7	6	5	4	3	2	1	0
PRSM	0	0	0	BGCE	0	TODIS	BGCS1	BGCS0

BGCE	TODIS	Baud rate output	Baud rate interrupt signal (INTBRG)
0	X	Fixed to 0	Fixed to 0
1	0	Operates	Operates
1	1	Fixed to 0	Operates

BGCS1	BGCS0		Selects input clock (f_{BRG})	
			10 MHz	4 MHz
0	0	f_x	100 ns	250 ns
0	1	$f_x/2$	200 ns	500 ns
1	0	$f_x/4$	400 ns	1 μ s
1	1	$f_x/8$	800 ns	2 μ s

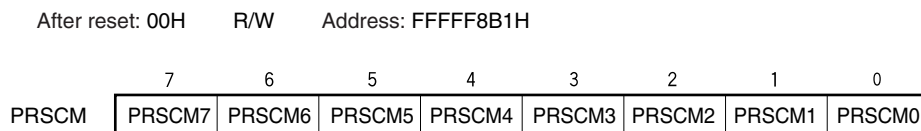
Cautions

1. Do not change the values of BGCS1 and BGCS0 during transmission/reception.
2. Set the PRSM register before setting the BGCE bit to 1.
3. Set the PRSM and PRSCM registers in accordance with the main clock frequency to be used, so that the frequency of f_{BRG} is 32.768 kHz.

(2) Prescaler compare register (PRSCM)

This is an 8-bit compare register.

It can be read or written in 8-bit or 1-bit units.



- Cautions**
1. Do not change the value of the PRSCM register during transmission/reception.
 2. Set the PRSCM register before setting the BRGCE bit of the PRSM register to 1.
 3. Set the PRSM and PRSCM registers in accordance with the main clock frequency to be used, so that the frequency of f_{BRG} is 32.768 kHz.

6.5.2 Generation of baud rate**(1) Count clock of watch timer**

The clock (f_{BRG}) input to the watch timer can be corrected to 32.768 kHz or equivalent frequency.

The relationship between the main oscillation clock (f_x), the set value of input clock selection bit BGCSn (m), the set value of the PRSCM register (N), and the output clock (f_{BRG}) is as follows:

Example: Where $f_x = 4.00$ MHz, $m = 0$ (BGCS1 = BGCS0 = 0), $N = 3DH$, $f_{BRG} = 32.768$ kHz

$$f_{BRG} = f_x / 2^m \times N \times 2$$

Remark f_{BRG} : Count clock

N: Value of compare register in prescaler 3 (1 to FFH)

N = 256 if the value of the compare register is "00H".

(2) Interval timer

This timer generates a baud rate interrupt request (INTBRG) at preset time intervals.

The interval time can be set by using the BGCS1 and BGCS0 bits of the prescaler mode register (PRSM) and the prescaler compare register (PRSCM).

The interval time can be calculated by the following expression.

$$\text{Interval time} = f_x / 2^m \times N$$

CHAPTER 7 TIMER/COUNTER FUNCTION

7.1 16-Bit Timer/Event Counters (TM0 and TM1)

7.1.1 Features

The 16-bit timer/event counters (TM0 and TM1) can perform the following operations.

- Interval timer function
- PWM output
- External signal cycle measurement

7.1.2 Function overview

- 16-bit timer/counter
- Capture/compare common registers: 2×2 channels
- Interrupt request sources
 - Capture/match interrupt requests: 2×2 channels
 - Overflow interrupt requests: 1×2 channels
- Timer/counter count clock sources: 2
(Selection of external pulse input or internal system clock division)
- Either free-running mode or overflow stop mode can be selected as the operation mode when the timer/counter overflows
- Timer/counter can be cleared by a match of the timer/counter and a compare register
- External pulse outputs: 1×2 channels

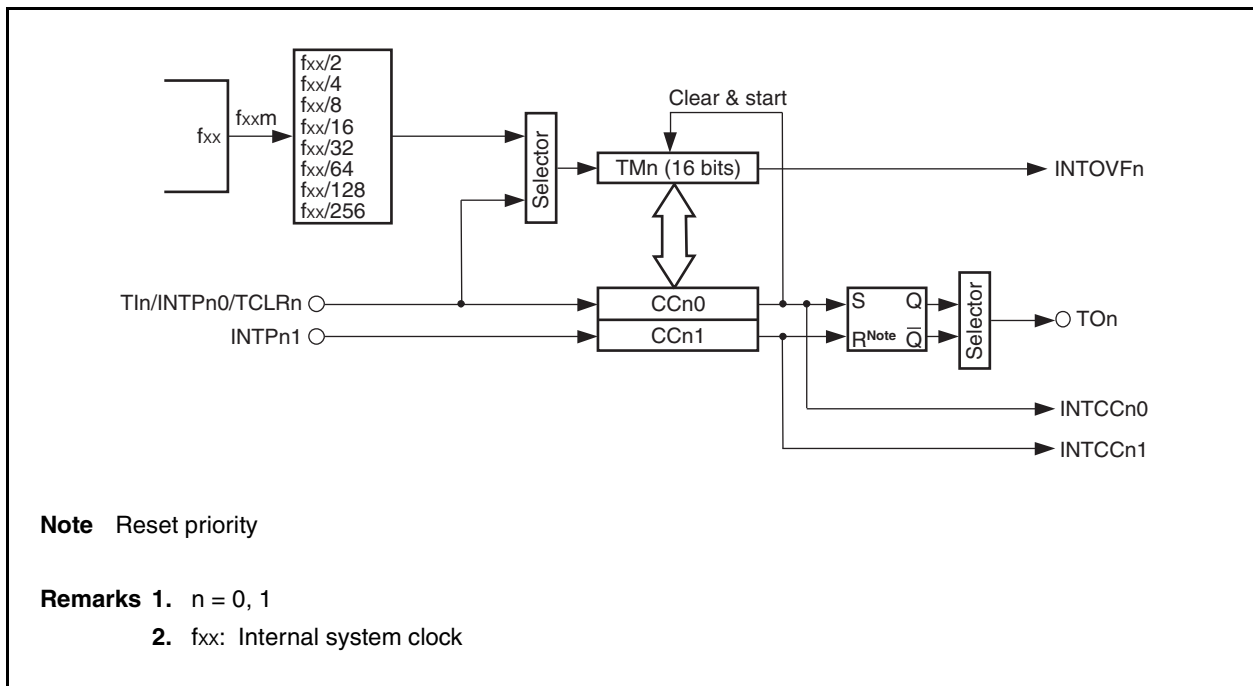
7.1.3 Basic configuration of 16-bit timer/event counters (TM0 and TM1)

Table 7-1. 16-Bit Timer/Event Counter Configuration

Timer	Count Clock	Register	Read/Write	Generated Interrupt Signal	Capture Trigger	Timer Output S/R
TM0, TM1	f _{xx} /2, f _{xx} /4, f _{xx} /8, f _{xx} /16, f _{xx} /32, f _{xx} /64, f _{xx} /128, f _{xx} /256	TM0	Read	INTOVF0	–	–
		CC00	Read/write	INTCC00	INTP00	TO0 (S)
		CC01	Read/write	INTCC01	INTP01	TO0 (R)
		TM1	Read	INTOVF1	–	–
		CC10	Read/write	INTCC10	INTP10	TO1 (S)
		CC11	Read/write	INTCC11	INTP11	TO1 (R)

Remark f_{xx}: Internal system clock
S/R: Set/reset

Figure 7-1. Block Diagram of 16-Bit Timer/Event Counter



(1) Timers 0 and 1 (TM0 to TM1)

TMn functions as a 16-bit free-running timer or as an event counter for an external signal. Besides being used for cycle measurement, TMn can be used for pulse output (n = 0, 1).

TMn is read-only, in 16-bit units.

Cautions 1. The TMn register can only be read. If the TMn register is written, the subsequent operation is undefined.

2. If the TMCAEn bit of the TMCn0 register is cleared (0), a reset is performed asynchronously.

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
TM0																	FFFFFF600H	0000H
TM1																	FFFFFF610H	0000H

TMn performs the count-up operations of an internal count clock or external count clock. Timer start and stop are controlled by the TMCEn bit of timer mode control register n0 (TMCn0) (n = 0, 1).

The internal or external count clock is selected by the ETIn bit of timer mode control register n1 (TMCn1) (n = 0, 1).

(a) Selection of the external count clock

TMn operates as an event counter.

When the ETIn bit of timer mode control register n1 (TMCn1) is set (1), TMn counts the valid edges of the external clock input (TIn), synchronized with the internal count clock. The valid edge is specified by valid edge select register n (SESn) (n = 0, 1).

Caution When the INTPn0/TIn/TCLRn pin is used as TIn (external clock input pin), disable the INTPn0 interrupt or set CCn0 to compare mode (n = 0, 1).

(b) Selection of the internal count clock

TMn operates as a free-running timer.

When the internal clock is specified as the count clock by timer mode control register n1 (TMCn1), TMn is counted up for each input clock cycle specified by the CSn0 to CSn2 bits of the TMCn0 register (n = 0, 1).

Division by the prescaler can be selected for the count clock from among $f_{xx}/2$, $f_{xx}/4$, $f_{xx}/8$, $f_{xx}/16$, $f_{xx}/32$, $f_{xx}/64$, $f_{xx}/128$, and $f_{xx}/256$ by the TMCn0 register (fxx: Internal system clock).

An overflow interrupt can be generated if the timer overflows. Also, the timer can be stopped following an overflow by setting the OSTn bit of the TMCn1 register to 1.

Caution The count clock cannot be changed while the timer is operating.

The conditions when the TMn register becomes 0000H are shown below.

(a) Asynchronous reset

- TMCAEn bit of TMCn0 register = 0
- Reset input

(b) Synchronous reset

- TMCEn bit of TMCn0 register = 0
- The CCn0 register is used as a compare register, and the TMn and CCn0 registers match when clearing the TMn register is enabled (CCLRn bit of the TMCn1 register = 1)

(2) Capture/compare registers n0 and n1 (CCn0 and CCn1) (n = 0, 1)

These capture/compare registers (n0 and n1) are 16-bit registers.

They can be used as capture registers or compare registers according to the CMSn0 and CMSn1 bit specifications of timer mode control register n1 (TMCn1) (n = 0, 1).

These registers can be read or written in 16-bit units. (However, write operations can only be performed in compare mode.)

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
CC0n																	FFFFF602H, FFFFF604H	0000H
CC1n																	FFFFF612H, FFFFF614H	0000H

Remark n = 0, 1

(a) Setting these registers as capture registers (CMSn0 and CMSn1 of TMCn1 = 0)

When these registers are set as capture registers, the valid edges of the corresponding external interrupt signals INTPn0 and INTPn1 are detected as capture triggers. The timer TMn is synchronized with the capture trigger, and the value of TMn is latched in the CCn0 and CCn1 registers (capture operation).

The valid edge of the INTPn0 pin is specified (rising, falling, or both rising and falling edges) according to the IESn01 and IESn00 bits of the SESn register, and the valid edge of the INTPn1 pin is specified according to the IESn11 and IESn10 bits of the SESn register (n = 0, 1).

The capture operation is performed asynchronously to the count clock. The latched value is held in the capture register until another capture operation is performed (n = 0, 1).

When the TMCAEn bit of timer mode control register n0 (TMCn0) is 0, 0000H is read (n = 0, 1).

If these registers are specified as capture registers, an interrupt is generated by detecting the valid edge of signals INTPn0 and INTPn1 (n = 0, 1).

Caution If the capture operation conflicts with the timing of disabling the TMn register from counting (when the TMCEn bit of the TMCn0 register = 0), the captured data becomes undefined. In addition, the INTCCn0 and INTCCn1 interrupts do not occur (n = 0, 1).

(b) Setting these registers as compare registers (CMSn0 and CMSn1 of TMCn1 = 1)

When these registers are set as compare registers, the TMn and register values are compared for each count clock, and an interrupt is generated by a match. If the CCLRn bit of timer mode control register n1 (TMCn1) is set (1), the TMn value is cleared (0) at the same time as a match with the CCn0 register (it is not cleared (0) by a match with the CCn1 register) (n = 0, 1).

Compare registers are equipped with a set/reset function. The corresponding timer output (TON) is set or reset, in synchronization with the generation of a match signal (n = 0, 1).

The interrupt selection source differs according to the function of the selected register.

- Cautions**
- 1. When writing to capture/compare registers n0 and n1, always set the TMCAEn bit to 1 first. If the TMCAEn bit is 0, the data that is written will be invalid.**
 - 2. Write to capture/compare registers n0 and n1 after setting them as compare registers via TMCn0 and TMCn1 register settings. If they are set as capture registers (CMSn0 and CMSn1 bits of TMCn1 register = 0), no data is written even if a write operation is performed to CCn0 and CCn1.**
 - 3. When these registers are set as compare registers, INTPn0 and INTPn1 cannot be used (n = 0, 1).**

7.1.4 Control registers

(1) Timer mode control registers 00 and 10 (TMC00 and TMC10)

The TMCn0 registers control the operation of TMn (n = 0, 1).

These registers can be read or written in 8-bit or 1-bit units.

Be sure to set bits 3 and 2 to 0. If they are set to 1, the operation is not guaranteed.

Cautions 1. The TMCAEn bit cannot be set at the same time as the other bits. The other bits and the registers of the other TMn units should always be set after the TMCAEn bit has been set. Also, to use external pins related to the timer function when the 16-bit timer/event counter is used, be sure to set (1) the TMCAEn bit after setting the external pins to control mode.

2. When conflict occurs between an overflow and a TMCn0 register write, the OVFn bit value becomes the value written during the TMCn0 register write (n = 0, 1).

(1/2)

After reset: 00H	R/W	Address: TMC00 FFFFF606H	TMC10 FFFFF616H
------------------	-----	--------------------------	-----------------

	<7>	6	5	4	3	2	1	<0>
TMCn0 (n = 0,1)	OVFn	CSn2	CSn1	CSn0	0	0	TMCEn	TMCAEn

OVFn	TMn register overflow detection
0	No overflow occurs
1	Overflow occurs

When TMn has counted up from FFFFH to 0000H, the OVFn bit becomes 1 and an overflow interrupt request (INTOVFn) is generated at the same time. However, if TMn is cleared to 0000H after a match at FFFFH when the CCn0 register is set to compare mode (CMSn0 bit of TMCn1 register = 1) and clearing is enabled for a match when TMn and CCn0 are compared (CCLRn bit of TMCn1 register = 1), then TMn is considered to be cleared and the OVFn bit does not become 1. Also, no INTOVFn interrupt is generated.

The OVFn bit retains the value 1 until 0 is written directly or until an asynchronous reset is performed because the TMCAEn bit is 0. An interrupt operation due to an overflow is independent of the OVFn bit, and the interrupt request flag (OVFIFn) for INTOVFn is not affected even if the OVFn bit is manipulated. If an overflow occurs while the OVFn bit is being read, the flag value changes, and the change is reflected when the next read operation occurs.

CSn2	CSn1	CSn0	Internal count clock selection
0	0	0	f _{xx} /2
0	0	1	f _{xx} /4
0	1	0	f _{xx} /8
0	1	1	f _{xx} /16
1	0	0	f _{xx} /32
1	0	1	f _{xx} /64
1	1	0	f _{xx} /128
1	1	1	f _{xx} /256

TMCEn	TMn register operation control
0	Count disabled (stops at 0000H and does not operate).
1	Counting operation is performed.

When TMCEn = 0, the external pulse output (TON) becomes inactive (the active level of TON output is set by the ALVn bit of the TMCn1 register).

TMCAEn	Internal count clock control
0	The entire TMn unit is asynchronously reset. The supply of clocks to the TMn unit stops.
1	Clocks are supplied to the TMn unit.

- When the TMCAEn bit is set to 0, the TMn unit can be asynchronously reset.
- When TMCAEn = 0, the TMn unit is in a reset state. Therefore, to operate TMn, the TMCAEn bit must be set to 1.
- When the TMCAEn bit is changed from 1 to 0, all registers of the TMn unit are initialized. When TMCAEn is set to 1 again, the TMn unit registers must be set again.

(2) Timer mode control registers 01 and 11 (TMC01 and TMC11)

The TMCn1 registers control the operation of TMn (n = 0, 1).

These registers can be read or written in 8-bit units.

- Cautions 1.** The various bits of the TMCn1 register must not be changed during timer operation. If they are to be changed, they must be changed after setting the TMCEn bit of the TMCn0 register to 0. If these bits are overwritten during timer operation, operation cannot be guaranteed (n = 0, 1).
- 2.** If the ENTOn and ALVn bits are changed at the same time, a glitch (spike shaped noise) may be generated in the TOn pin output. Either create a circuit configuration that will not malfunction even if a glitch is generated or make sure that the ENTOn and ALVn bits do not change at the same time (n = 0, 1).
- 3.** TOn output is not changed by an external interrupt signal (INTPn0 or INTPn1). To use the TOn signal, specify that the capture/compare registers are compare registers (CMSn0 and CMSn1 bits of TMCn1 register = 1) (n = 0, 1).

(1/2)

After reset: 00H		R/W	Address: TMC01 FFFFF608H		TMC11 FFFFF618H			
	7	6	5	4	3	2	1	0
TMCn1 (n = 0,1)	OSTn	ENTOn	ALVn	ETIn	CCLRn	ECLRn	CMSn1	CMSn0
	OSTn	Setting of operation when TMn register overflows						
	0	After the overflow, counting continues (free-running mode).						
	1	After the overflow, the timer maintains the value 0000H, and counting stops (overflow stop mode).						
	When OSTn = 1, the TMCEn bit of TMCn0 remains at 1. Counting is restarted by writing 1 to the TMCEn bit.							
	ENTOn	External pulse output (TOn) enable/disable						
	0	External pulse output is disabled.						
	1	External pulse output is enabled.						
	<ul style="list-style-type: none"> When OSTn = 0, output of the ALVn bit inactive level to the TOn pin is fixed. The TOn pin level is not changed even if a match signal from the corresponding compare register is generated. When OSTn = 1, a compare register match causes TOn output to change. However, if capture mode is set, TOn output does not change. The ALVn bit inactive level is output from the time when timer output is enabled until a match signal is first generated. If either CCn0 or CCn1 is specified as a capture register, the ENTOn bit must be set to 0. 							

ALVn	External pulse output (TOn) active level specification
0	Low level
1	High level
The initial value of the ALVn bit is 1.	

ETIn	Count clock external/internal switch specification
0	Specifies the input clock (internal).
1	Specifies the external clock (TIn0).
<ul style="list-style-type: none"> • When ETIn = 0, the count clock can be selected according to the CSn2 to CSn0 bits of TMCn0. • When ETIn = 1, the valid edge can be selected according to the TESn1 and TESn0 bit specifications of SESn. 	

CCLRn	TMn register clear enable/disable specification during compare operation
0	Clearing is disabled
1	Clearing is enabled (if CCn0 and TMn match during a compare operation, TMn is cleared)

ECLRn	TMn register clear enable/disable specification by external clear input (TCLRn)
0	Clearing is disabled
1	Clearing is enabled (after clearing, counting is restarted)

CMSn1	Capture/compare register (CCn1) operation mode selection
0	The register operates as a capture register.
1	The register operates as a compare register.

CMSn0	Capture/compare register (CCn0) operation mode selection
0	The register operates as a capture register.
1	The register operates as a compare register.

Remark A reset takes precedence for the flip-flop of the TOn output (n = 0, 1).

(3) Valid edge select registers 0 and 1 (SES0 and SES1)

These registers specify the valid edge of an external interrupt request (INTP00, INTP01, INTP10, INTP11, TI0, and TI1) from an external pin.

The rising edge, the falling edge, or both rising and falling edges can be specified as the valid edge independently for each pin.

Each of these registers can be read or written in 8-bit units.

Caution The various bits of the SESn register must not be changed during timer operation. If they are to be changed, they must be changed after setting the TMCEn bit of the TMCn0 register to 0. If the SESn register is overwritten during timer operation, operation cannot be guaranteed.

After reset: 00H		R/W	Address: SES0 FFFFF609H		SES1 FFFFF619H			
	7	6	5	4	3	2	1	0
SESn	TESn1	TESn0	CESn1	CESn0	IESn11	IESn10	IESn01	IESn00
(n = 0,1)								
	TESn1	TESn0	Valid edge of TIn pin					
	0	0	Falling edge					
	0	1	Rising edge					
	1	0	Setting prohibited					
	1	1	Both rising and falling edges					
	CESn1	CESn0	Valid edge of TCLRn pin					
	0	0	Falling edge					
	0	1	Rising edge					
	1	0	Setting prohibited					
	1	1	Both rising and falling edges					
	IESn11	IESn10	Valid edge of INTPn1 pin					
	0	0	Falling edge					
	0	1	Rising edge					
	1	0	Setting prohibited					
	1	1	Both rising and falling edges					
	IESn01	IESn00	Valid edge of INTPn0 pin					
	0	0	Falling edge					
	0	1	Rising edge					
	1	0	Setting prohibited					
	1	1	Both rising and falling edges					

7.1.5 16-bit timer/event counter operation

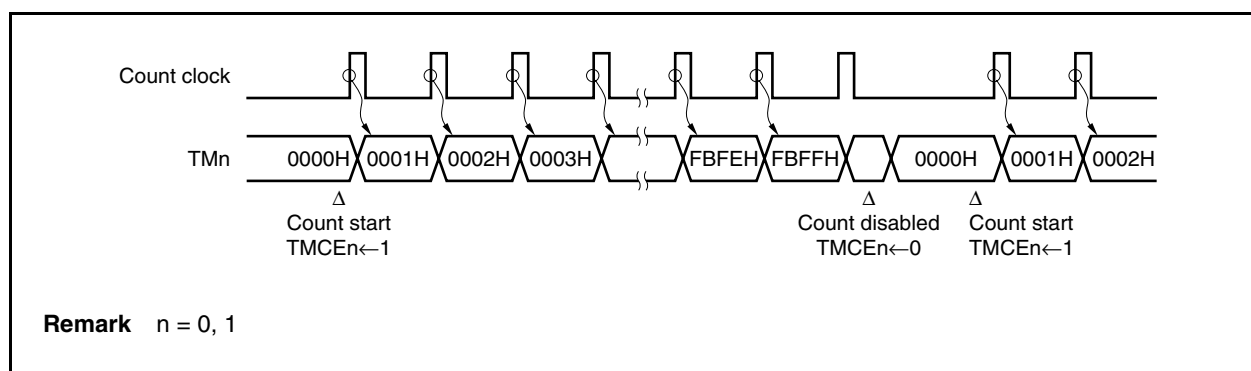
(1) Count operation

The 16-bit timer/event counter can function as a 16-bit free-running timer or as an external signal event counter. The setting for the type of operation is specified by timer mode control registers n0 and n1 (TMCn0 and TMCn1) ($n = 0, 1$).

When it operates as a free-running timer, if the CCn0 or CCn1 register and the TMn register count value match, an interrupt signal is generated and the timer output signal (TON) can be set or reset. Also, a capture operation that holds the TMn register count value in the CCn0 or CCn1 register is performed, in synchronization with the valid edge that was detected from the external interrupt request input pin as an external trigger. The capture value is held until the next capture trigger is generated.

Caution When using the INTPn0/TIn0 pin as an external clock input pin (TIn0), be sure to disable the INTPn0 interrupt or set CCn0 to compare mode ($n = 0, 1$).

Figure 7-2. Basic Operation of 16-Bit Timer/Event Counter



(2) Overflow

When the TMn register has counted the count clock from FFFFH to 0000H, the OVF_n bit of the TMCn0 register is set (1), and an overflow interrupt (INTOV_n) is generated at the same time (n = 0, 1). However, if the CCn0 register is set to compare mode (CMS_{n0} bit = 1) and to the value FFFFH when match clearing is enabled (CCLR_n bit = 1), then the TMn register is considered to be cleared and the OVF_n bit is not set (1) when the TMn register changes from FFFFH to 0000H. Also, the overflow interrupt (INTOV_n) is not generated.

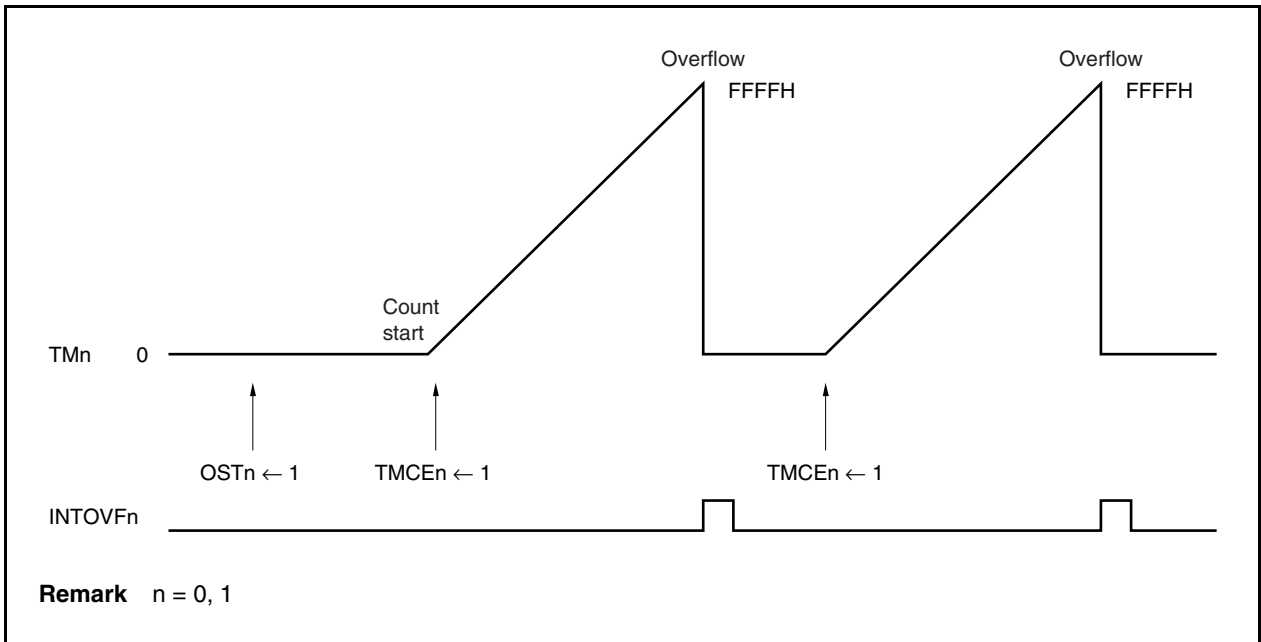
When the TMn register is changed from FFFFH to 0000H because the TMCEn bit changes from 1 to 0, the TMn register is considered to be cleared, but the OVF_n bit is not set (1) and no INTOV_n interrupt is generated.

Also, timer operation can be stopped after an overflow by setting the OST_n bit of the TMCn1 register to 1. When the timer is stopped due to an overflow, the count operation is not restarted until the TMCEn bit of the TMCn0 register is set (1).

Operation is not affected even if the TMCEn bit is set (1) during a count operation.

Remark n = 0, 1

Figure 7-3. Operation After Overflow (When OST_n = 1)



(3) Capture operation

The TMn register has two capture/compare registers. These are the CCn0 register and the CCn1 register. A capture operation or a compare operation is performed according to the settings of both the CMSn1 and CMSn0 bits of the TMCn1 register. If the CMSn1 and CMSn0 bits of the TMCn1 register are set to 0, the register operates as a capture register.

A capture operation that captures and holds the TMn count value asynchronously to the count clock is performed in synchronization with an external trigger. The valid edge that is detected from an external interrupt request input pin (INTPn0 or INTPn1) is used as an external trigger (capture trigger). The TMn count value during counting is captured and held in the capture register, in synchronization with that capture trigger signal. The capture register value is held until the next capture trigger is generated.

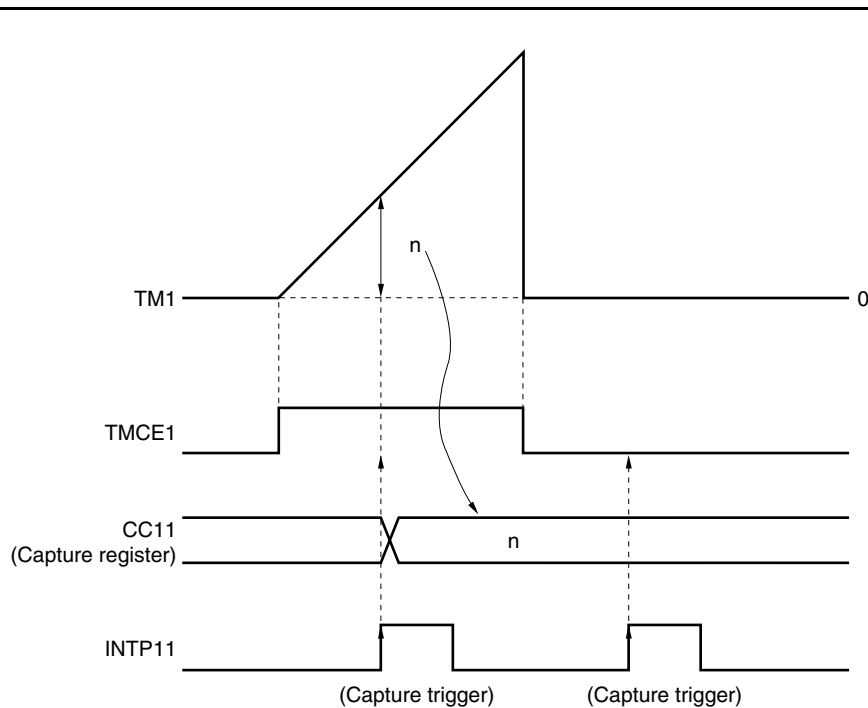
Also, an interrupt request (INTCCn0 or INTCCn1) is generated by INTPn0 or INTPn1 signal input.

The valid edge of the capture trigger is set by valid edge select register n (SESn).

If both the rising and falling edges are set as capture triggers, the input pulse width from an external source can be measured. Also, if only one of the edges is set as the capture trigger, the input pulse cycle can be measured.

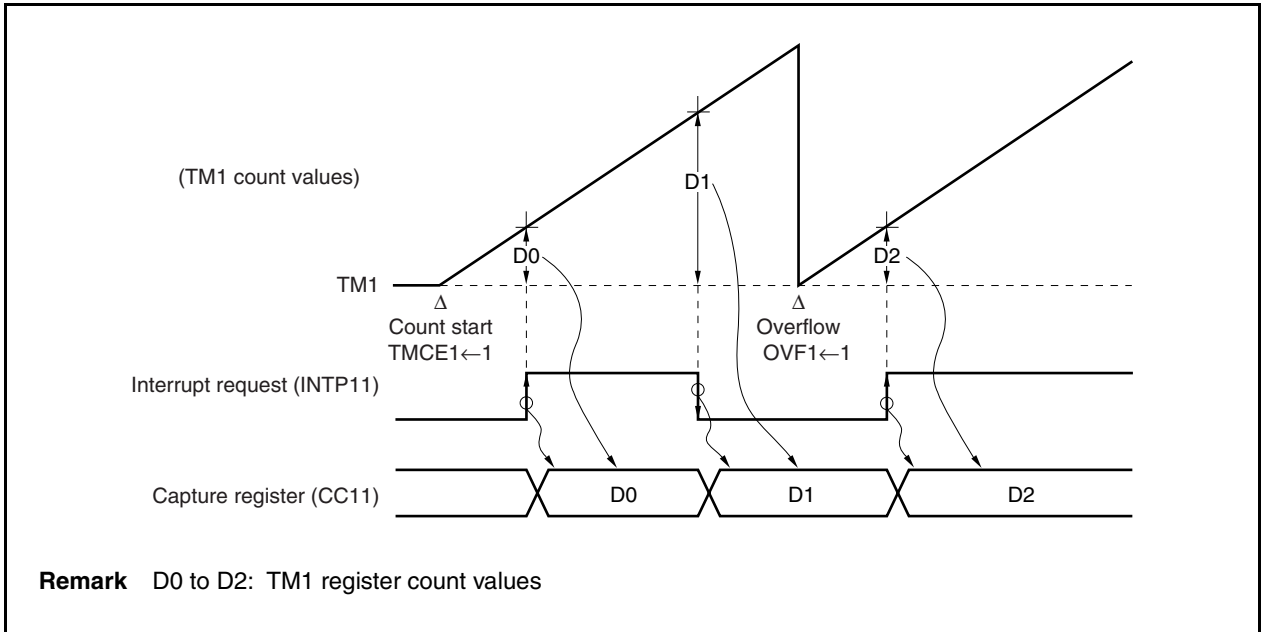
Remark n = 0, 1

Figure 7-4. Capture Operation Example (TM1)



- Remarks**
1. When the TMCE1 bit is 0, no capture operation is performed even if INTP11 is input.
 2. Valid edge of INTP11: Rising edge

Figure 7-5. TM1 Capture Operation Example (When Both Edges Are Specified)



(4) Compare operation

The TMn register has two capture/compare registers. These are the CCn0 register and the CCn1 register. A capture operation or a compare operation is performed according to the settings of both the CMSn1 and CMSn0 bits of the TMCn1 register. If the CMSn1 and CMSn0 bits of the TMCn1 register are set to 1, the register operates as a compare register.

A compare operation that compares the value that was set in the compare register and the TMn register count value is performed.

If the TMn register count value matches the value of the compare register, which had been set in advance, a match signal is sent to the output controller. The match signal causes the timer output pin (TON) to change and an interrupt request signal (INTCCn) to be generated at the same time.

If the CCn0 or CCn1 registers are set to 0000H, the 0000H after the TMn register counts up from FFFFH to 0000H is judged as a match. In this case, the TMn register value is cleared (0) at the next count timing, however, this 0000H is not judged as a match. Also, the 0000H when the TMn register begins counting is not judged as a match.

If match clearing is enabled (CCLRn bit = 1) for the CCn0 register, the TMn register is cleared when a match with the TMn register occurs during a compare operation.

Remark n = 0, 1

Figure 7-6. Compare Operation Example (When CCLR1 = 1 and CC10 Is Other Than 0000H)

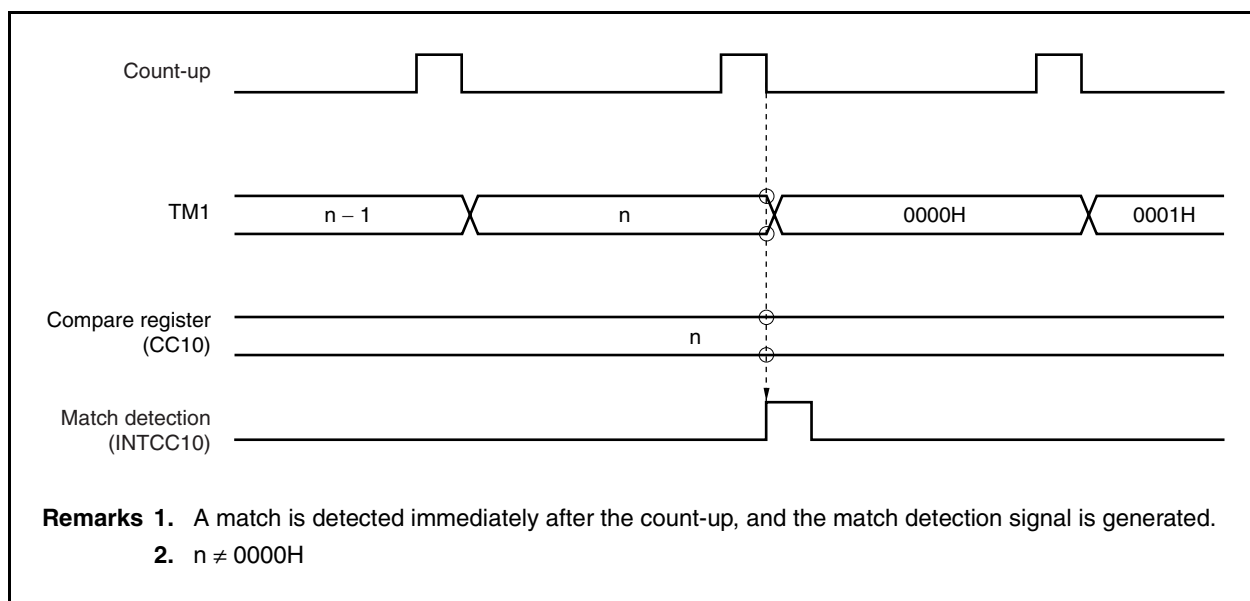
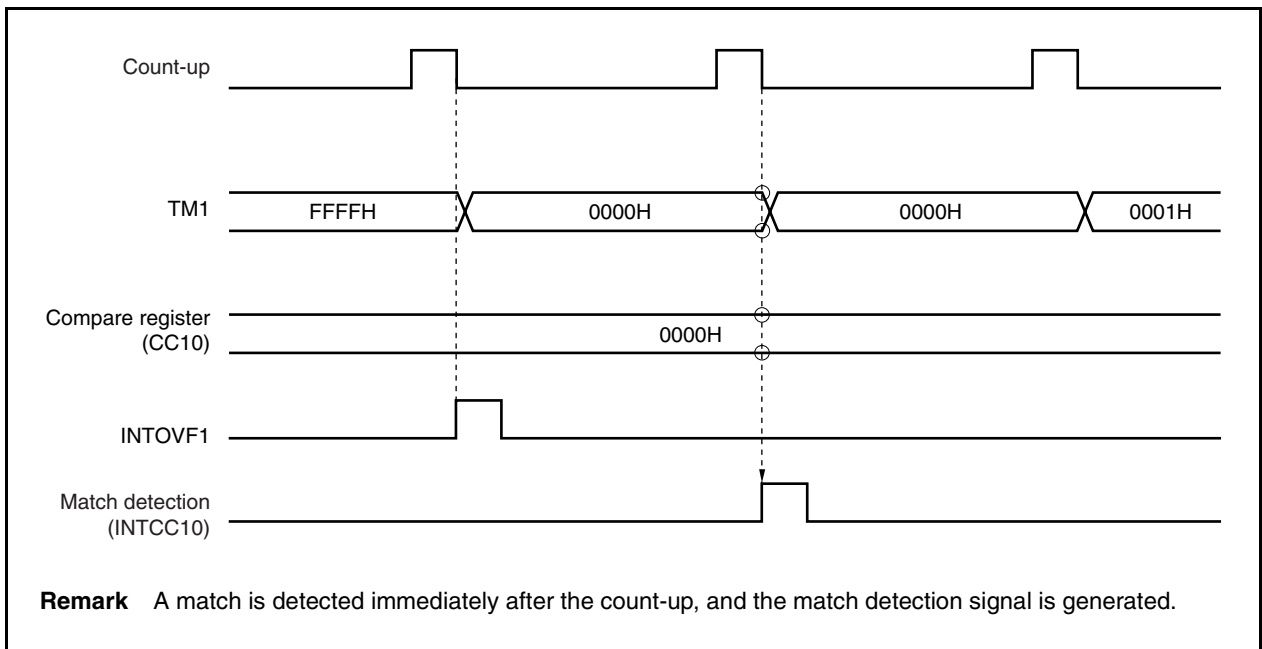


Figure 7-7. Compare Operation Example (When CCLR1 = 1 and CC10 Is 0000H)



(5) External pulse output

The 16-bit timer/event counter has two timer output pins (TOn).

An external pulse output (TOn) is generated when a match of the two compare registers (CCn0 and CCn1) and the TMn register is detected.

If a match is detected when the TMn register count value and the CCn0 value are compared, the output level of the TOn pin is set. Also, if a match is detected when the TMn register count value and the CCn1 value are compared, the output level of the TOn pin is reset.

The output level of the TOn pin can be specified by the TMCn1 register.

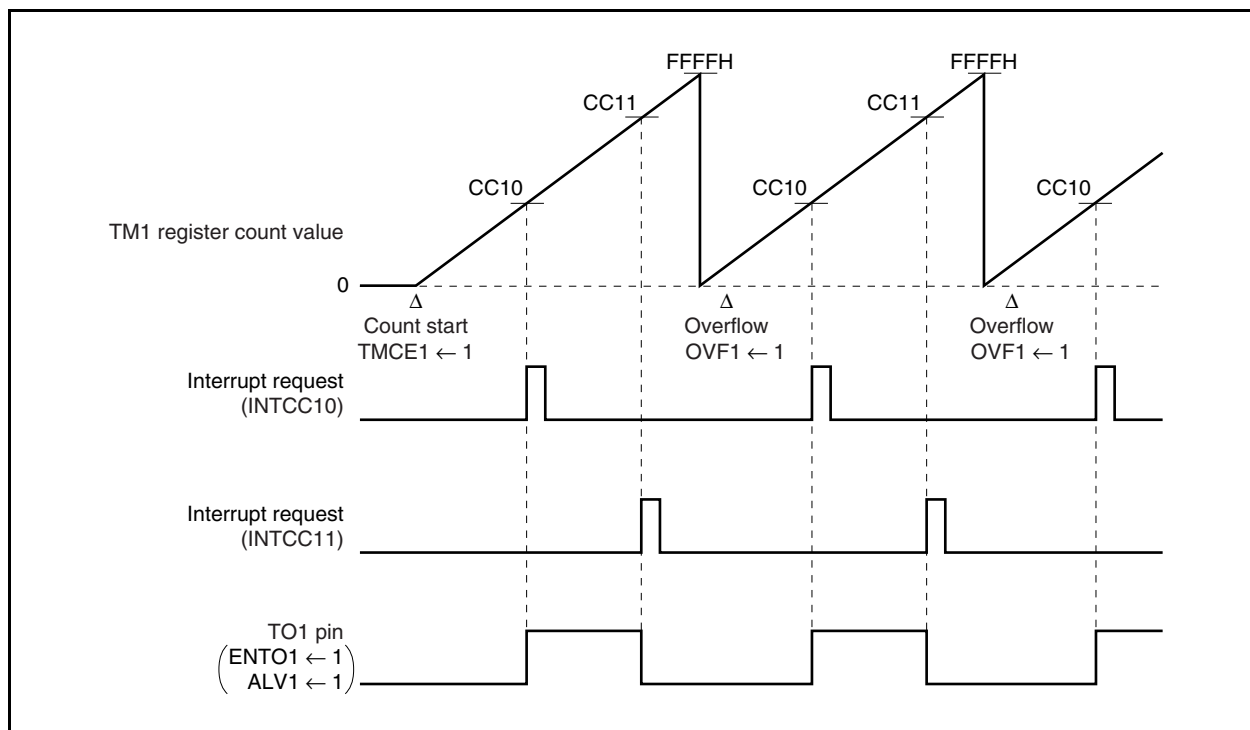
Remark n = 0, 1

Table 7-2. TOn Output Control

ETIn	ALVn	TOn Output	
		External Pulse Output	Output Level
0	0	Disable	High level
0	1	Disable	Low level
1	0	Enable	When the CCn0 register is matched: low level When the CCn1 register is matched: high level
1	1	Enable	When the CCn0 register is matched: high level When the CCn1 register is matched: low level

Remark n = 0, 1

Figure 7-8. TM1 Compare Operation Example (Set/Reset Output Mode)



7.1.6 Application examples (16-bit timer/event counter)

(1) Interval timer

By setting the TMCn0 and TMCn1 registers as shown in Figure 7-9, the 16-bit timer/event counter operates as an interval timer that repeatedly generates interrupt requests with the value that was preset in the CCn0 register as the interval.

When the counter value of the TMn register matches the setting value of the CCn0 register, the TMn register is cleared (0000H) and an interrupt request signal (INTCCn0) is generated at the same time that the count operation resumes.

Remark n = 0, 1

Figure 7-9. Contents of Register Settings When 16-Bit Timer/Event Counter Is Used as Interval Timer

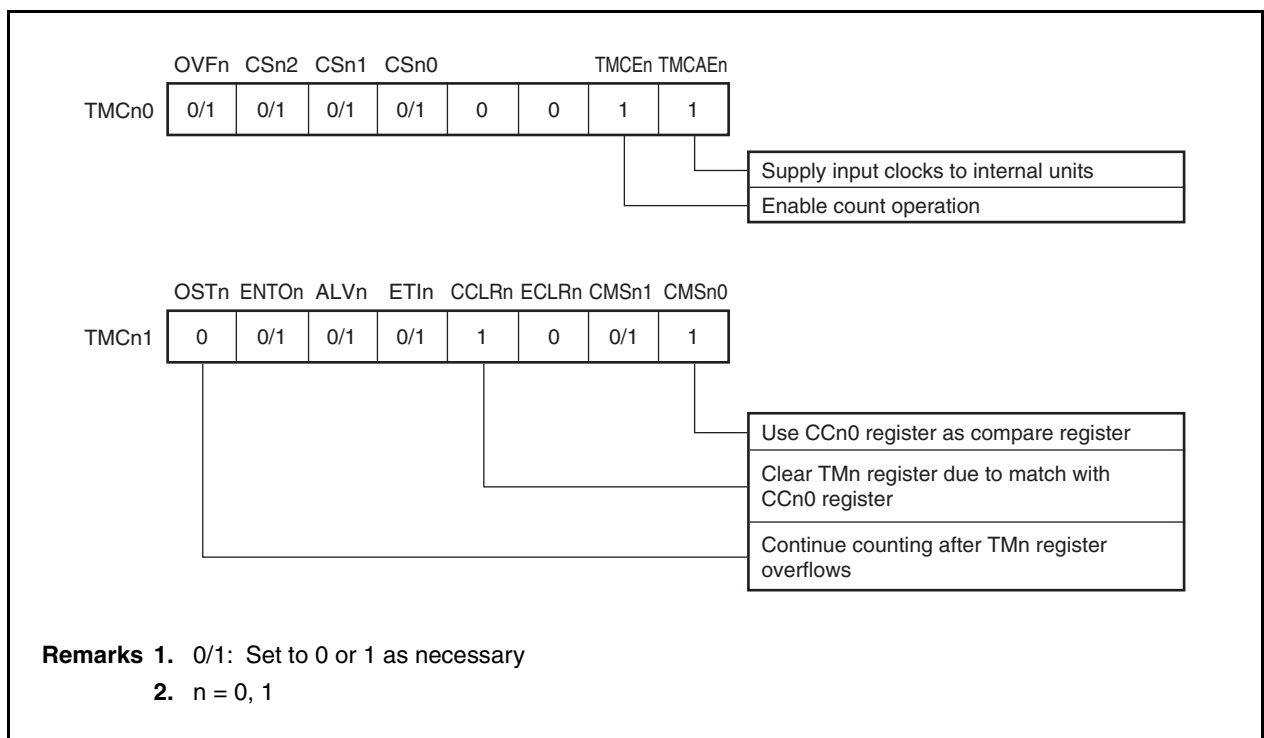
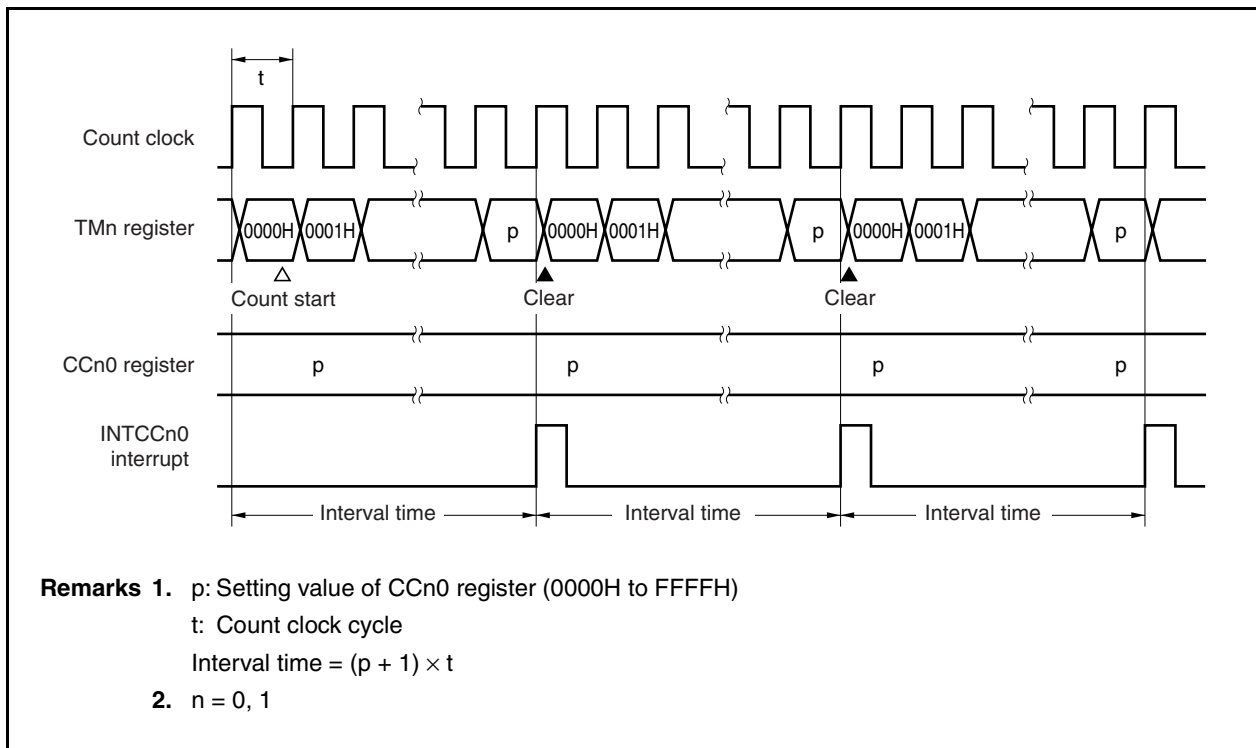


Figure 7-10. Interval Timer Operation Timing Example



(2) PWM output

By setting the TMCn0 and TMCn1 registers as shown in Figure 7-11, the 16-bit timer/event counter can output a PWM signal, whose frequency is determined according to the setting of the CSn2 to CSn0 bits of the TMCn0 register, with the values that were preset in the CCn0 and CCn1 registers determining the intervals.

When the counter value of the TMn register matches the setting value of the CCn0 register, the TOn output becomes active. Then, when the counter value of the TMn register matches the setting value of the CCn1 register, the TOn output becomes inactive. The TMn register continues counting. When it overflows, its count value is cleared to 0000H, and the register continues counting. In this way, a PWM signal whose frequency is determined according to the setting of the CSn2 to CSn0 bits of the TMCn0 register can be output. When the setting value of the CCn0 register and the setting value of the CCn1 register are the same, the TOn output remains inactive and does not change.

The active level of the TOn output can be set by the ALVn bit of the TMCn1 register.

Remark n = 0, 1

Figure 7-11. Contents of Register Settings When 16-Bit Timer/Event Counter Is Used for PWM Output

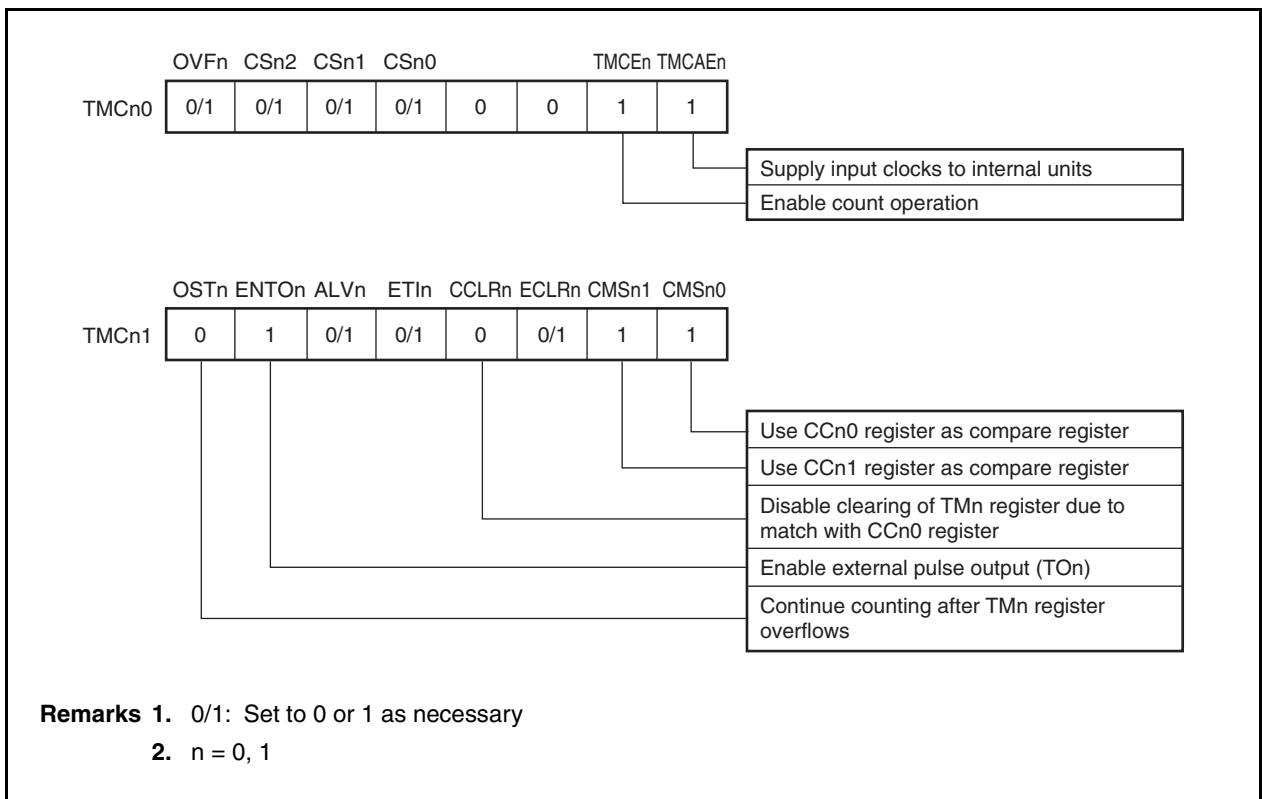
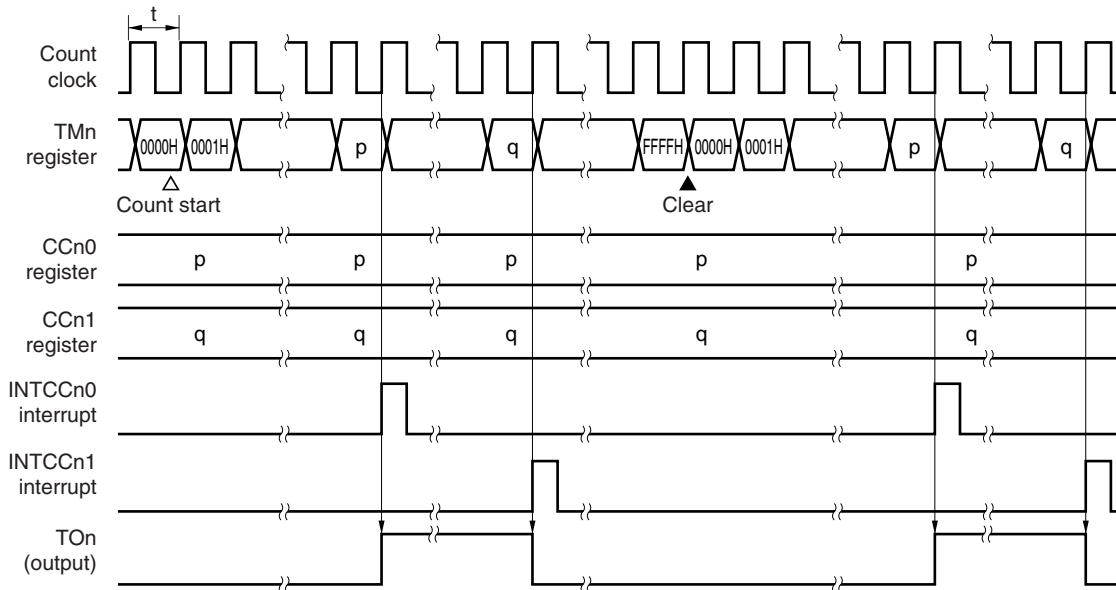


Figure 7-12. PWM Output Timing Example



Remarks 1. p: Setting value of CCn0 register (0000H to FFFFH)

q: Setting value of CCn1 register (0000H to FFFFH)

$p \neq q$

t: Count clock cycle

PWM cycle = $65,536 \times t$

$$\text{Duty} = \frac{q - p}{65,536}$$

2. In this example, the active level of the TOn output is set to the high level.

3. $n = 0, 1$

(3) One-shot pulse output

By setting the TMCn0 and TMCn1 registers as shown in Figure 7-13, the 16-bit timer/event counter can output a one-shot pulse from the TOn pin by using the valid edge of the TCLRn pin as an external trigger.

The valid edge of the TCLRn pin is selected according to the CESn0 and CESn1 bits of the SESn register. The rising edge, falling edge, or both rising and falling edges can be selected as the valid edge of both pins.

The TMn register is cleared and started by setting a valid edge to the TCLRn pin. TOn output becomes active at the count value set in advance to the CCn0 register. After that, the TOn output becomes inactive at the count value set in advance to CCn1 register. The active level of the TOn output can be set by the ALVn bit of the TMCn1 register. When the setting value of the CCn0 register and the setting value of the CCn1 register are the same, the TOn output remains inactive and does not change.

The active level of the TOn output can be set by the ALVn bit of the TMCn1 register.

Remark n = 0, 1

**Figure 7-13. Contents of Register Settings
When 16-Bit Timer/Event Counter Is Used for One-Shot Pulse Output**

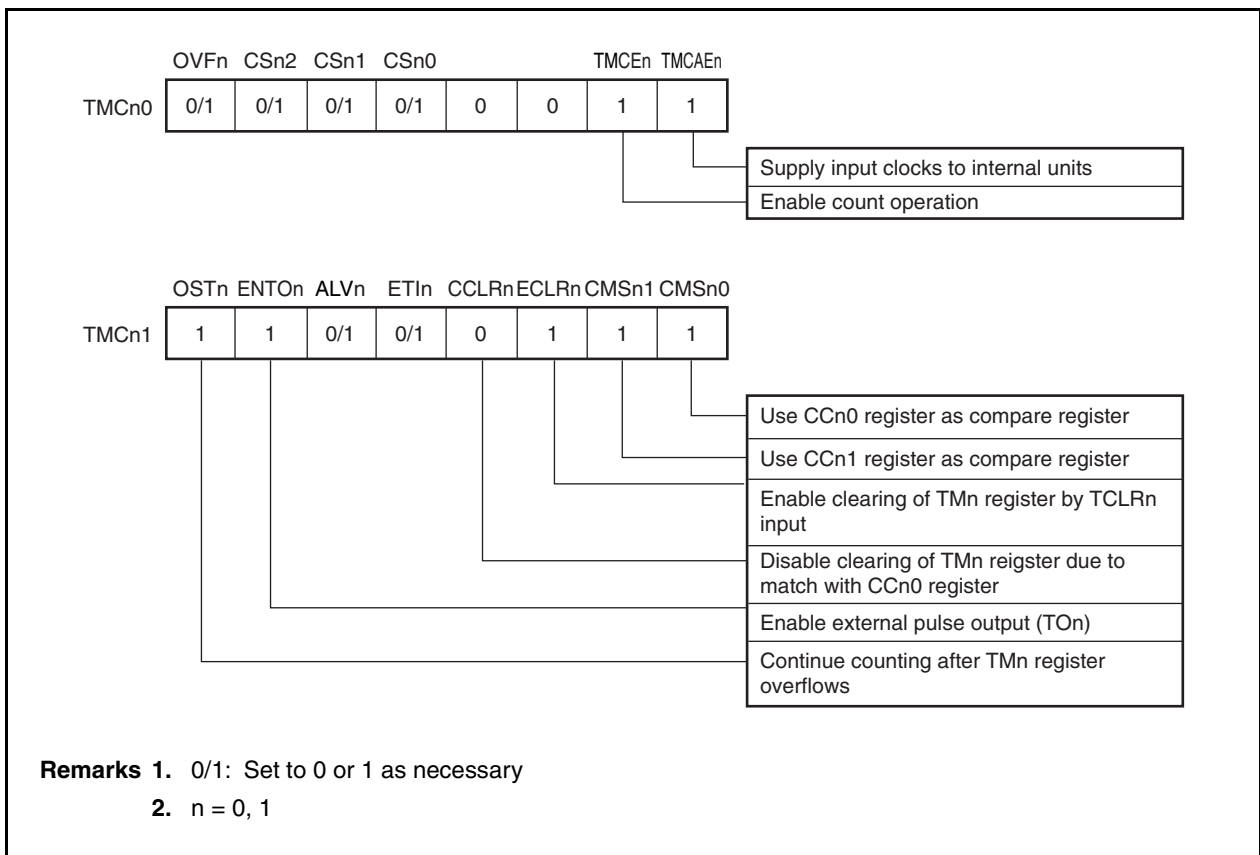
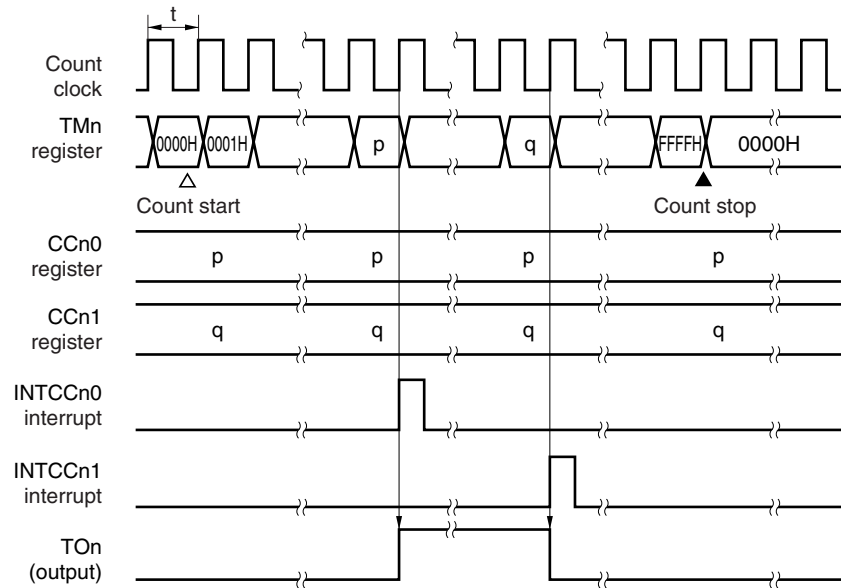


Figure 7-14. One-Shot Pulse Output Operation Timing Example



- Remarks 1.** p: Setting value of CCn0 register (0000H to FFFFH)
q: Setting value of CCn1 register (0000H to FFFFH)
 $p \neq q$
t: Count clock cycle
- 2.** In this example, the valid edge of the TCLRn input is set to the rising edge and the active level of the TOn output is set to the high level.
- 3.** $n = 0, 1$

(4) Cycle measurement

By setting the TMCn0 and TMCn1 registers as shown in Figure 7-15, the 16-bit timer/event counter can measure the cycle of signals input to the INTPn0 or INTPn1 pin.

The valid edge of the INTPn0 pin is selected according to the IESn01 and IESn00 bits of the SESn register, and the valid edge of the INTPn1 pin is selected according to the IESn11 and IESn10 bits of the SESn register. Either the rising edge, the falling edge, or both edges can be selected as the valid edges of both pins.

If the CCn0 register is set as a capture register, the valid edge input of the INTPn0 pin is set as the trigger for capturing the TMn register value in the CCn0 register. When this value is captured, an INTCCn0 interrupt is generated.

Similarly, if the CCn1 register is set as a capture register, the valid edge input of the INTPn1 pin is set as the trigger for capturing the TMn register value in the CCn1 register. When this value is captured, an INTCCn1 interrupt is generated.

The cycle of signals input to the INTPn0 pin is calculated by obtaining the difference between the TMn register's count value (D_x) that was captured in the CCn0 register according to the x-th valid edge input of the INTPn0 pin and the TMn register's count value ($D_{(x+1)}$) that was captured in the CCn0 register according to the (x+1)-th valid edge input of the INTPn0 pin and multiplying the value of this difference by the cycle of the clock control signal.

The cycle of signals input to the INTPn1 pin is calculated by obtaining the difference between the TMn register's count value (D_x) that was captured in the CCn1 register according to the x-th valid edge input of the INTPn1 pin and the TMn register's count value ($D_{(x+1)}$) that was captured in the CCn1 register according to the (x+1)-th valid edge input of the INTPn1 pin and multiplying the value of this difference by the cycle of the clock control signal.

Remark n = 0, 1

Figure 7-15. Contents of Register Settings When 16-Bit Timer/Event Counter Is Used for Cycle Measurement

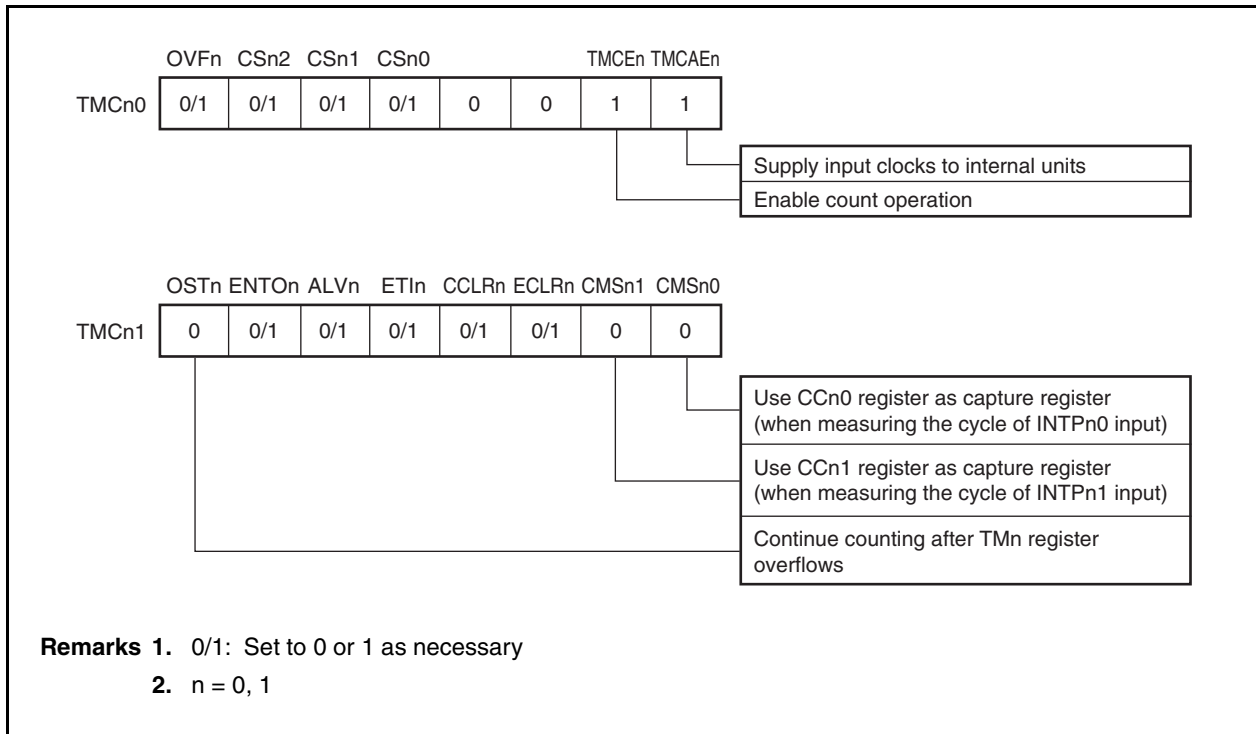
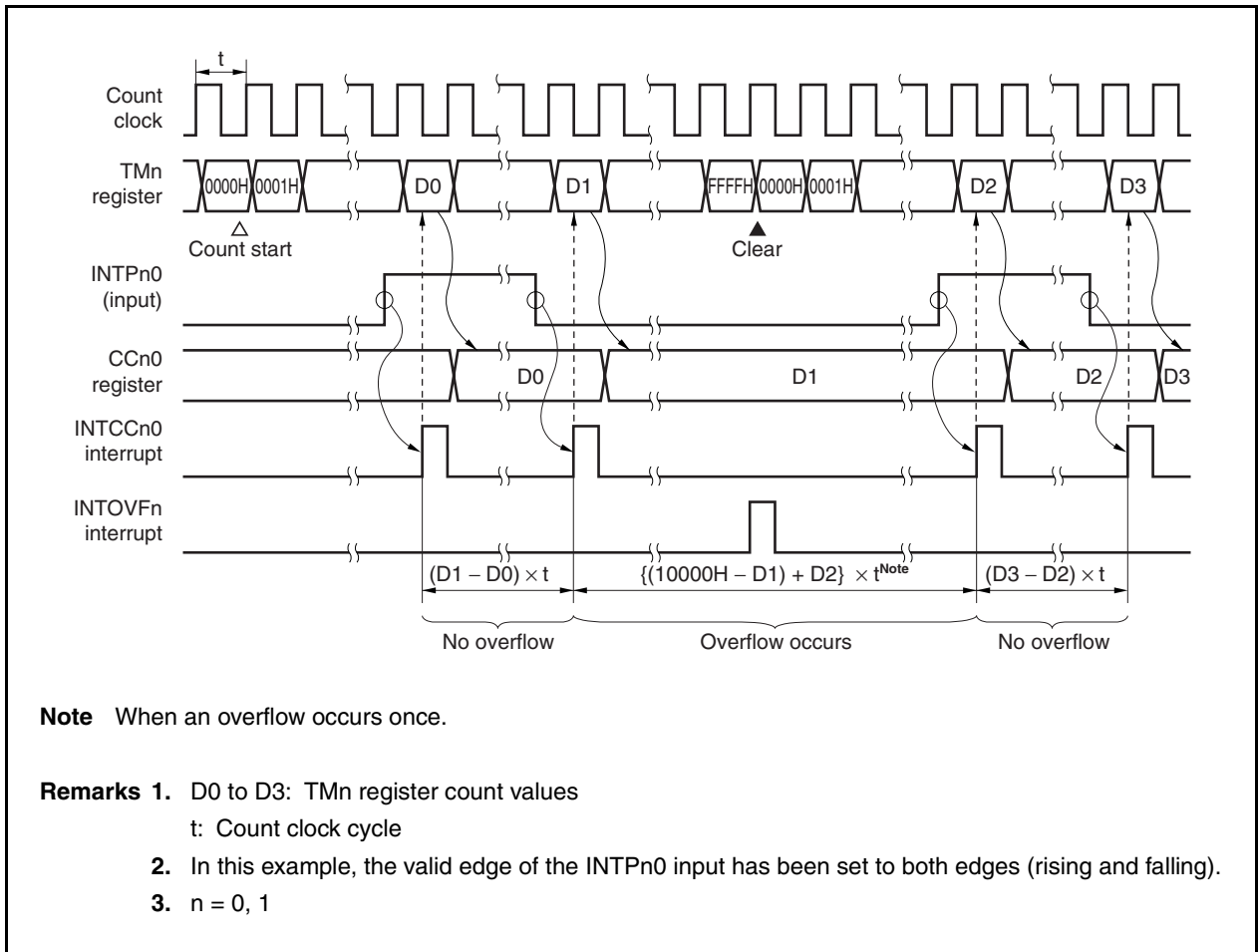


Figure 7-16. Cycle Measurement Operation Timing Example



7.1.7 Cautions (16-bit timer/event counter)

Various cautions concerning the 16-bit timer/event counter are shown below.

- (1) If a conflict occurs between the reading of the CCn0 register and a capture operation when the CCn0 register is used in capture mode, an external trigger (INTPn0) valid edge is detected and an external interrupt request signal (INTCCn0) is generated, however, the timer value is not stored in the CCn0 register.
- (2) If a conflict occurs between the reading of the CCn1 register and a capture operation when the CCn1 register is used in capture mode, an external trigger (INTPn1) valid edge is detected and an external interrupt request signal (INTCCn1) is generated, however, the timer value is not stored in the CCn1 register.
- (3) The following bits and registers must not be rewritten during operation (TMCEn = 1).
 - CSn2 to CSn0 bits of TMCn0 register
 - TMCn1 register
 - SESn register
- (4) The TMCAEn bit of the TMCn0 register is a TMn reset signal. To use TMn, first set (1) the TMCAEn bit.
- (5) The analog noise elimination time + two cycles of the input clock are required to detect the valid edge of the external interrupt request signal (INTPn0 or INTPn1) or the external clock input (TIn). Therefore, edge detection will not be performed normally for changes that are less than the analog noise elimination time + two cycles of the input clock.
- (6) The operation of an external interrupt request signal (INTCCn0 or INTCCn1) is automatically determined according to the operating state of the capture/compare register. When the capture/compare register is used for a capture operation, the external interrupt request signal is used for valid edge detection. When the capture/compare register is used for a compare operation, the external interrupt request signal is used for an interrupt indicating a match with the TMn register.
- (7) If the ENTOn and ALVn bits are changed at the same time, a glitch (spike shaped noise) may be generated in the TOn pin output. Either create a circuit configuration that will not malfunction even if a glitch is generated or make sure that the ENTOn and ALVn bits are not changed at the same time.

Remark n = 0, 1

7.2 8-Bit Timer/Event Counters 2 to 5 (TM2 to TM5)

7.2.1 Function outline

8-bit timer/event counter n has the following two modes (n = 2 to 5).

- Mode using 8-bit timer/event counter alone (individual mode)
- Mode using cascade connection (16-bit resolution: cascade connection mode)

These two modes are described below.

(1) Mode using 8-bit timer/event counter alone (individual mode)

8-bit timer/event counter n operates as an 8-bit timer/event counter.

The following functions can be used.

- Interval timer
- External event counter
- Square wave output
- PWM output

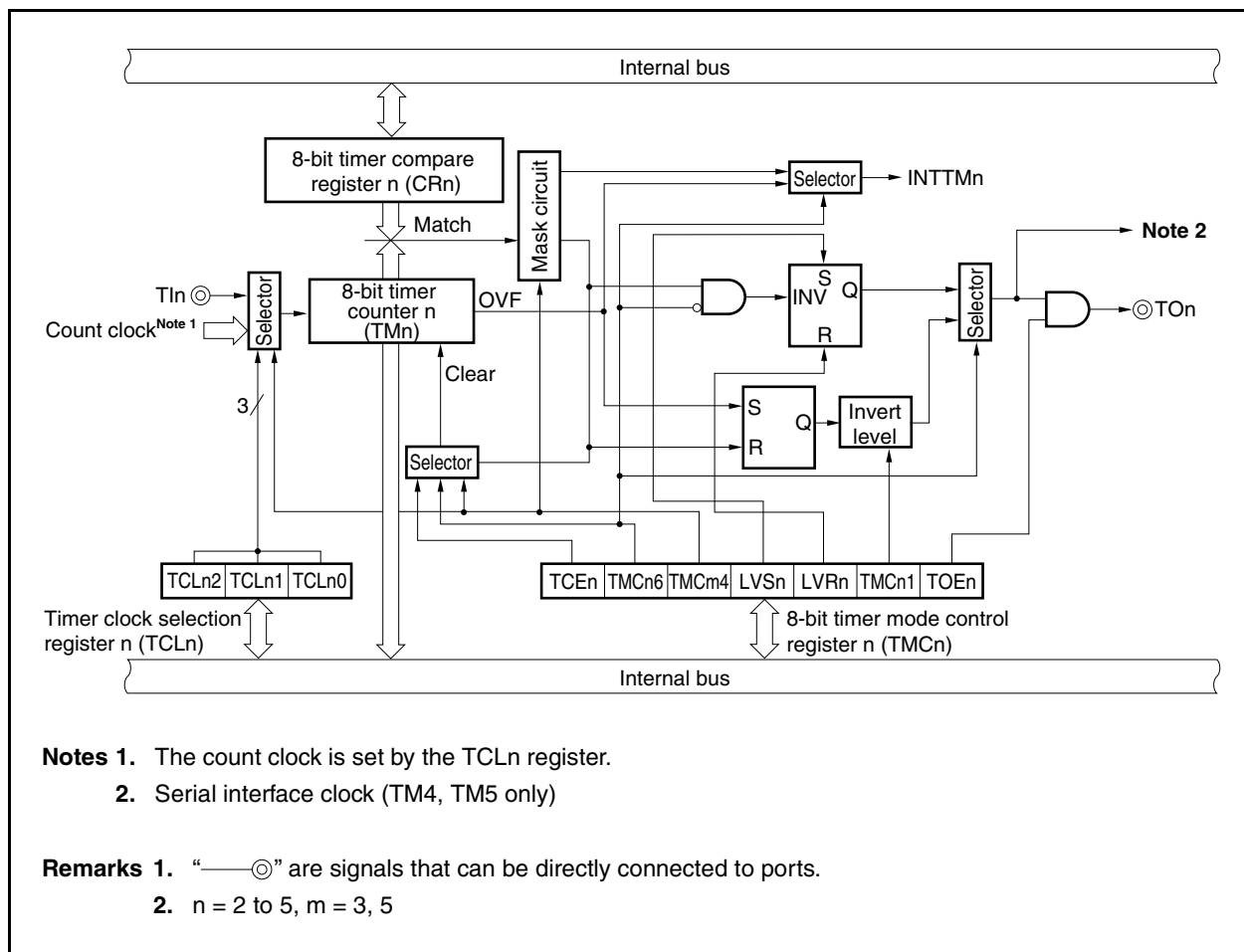
(2) Mode using cascade connection (16-bit resolution: cascade connection mode)

TM2 and TM3, and TM4 and TM5 can be used as 16-bit timer/event counters when they are connected in cascade. The following functions can be used.

- Interval timer with 16-bit resolution
- External event counter with 16-bit resolution
- Square wave output with 16-bit resolution

The block diagram of 8-bit timer/event counter n is shown next.

Figure 7-17. Block Diagram of 8-Bit Timer/Event Counter n



7.2.2 Configuration of 8-bit timer/event counter n

8-bit timer/event counter n consists of the following hardware (n = 2 to 5).

Table 7-3. Configuration of 8-Bit Timer/Event Counter n

Item	Configuration
Timer registers	8-bit timer counters 2 to 5 (TM2 to TM5) 16-bit timer counters 23 and 45 (TM23, TM45): Only when using cascade connection
Registers	8-bit timer compare registers 2 to 5 (CR2 to CR5) 16-bit timer compare registers 23 and 45 (CR23, CR45): Only when using cascade connection
Timer output	TO2 to TO5
Control registers ^{Note}	Timer clock selection registers 2 to 5 (TCL2 to TCL5) Timer clock selection registers 23 and 45 (TCL23, TCL45): Only when using cascade connection 8-bit timer mode control registers 2 to 5 (TMC2 to TMC5) 16-bit timer mode control registers 23 and 45 (TMC23, TMC45): Only when using cascade connection

Note When using the functions of the TIn and TOn pins, refer to **Table 4-18 Using Port Pins for Alternate Function**.

(1) 8-bit timer counters 2 to 5 (TM2 to TM5)

The TMn register is an 8-bit read-only register that counts the count pulses.

The counter is incremented in synchronization with the rising edge of the count clock.

TM2 and TM3, and TM4 and TM5 can be used as 16-bit timers when they are connected in cascade. When these timers are used as 16-bit timers, their values can be read by using a 16-bit memory manipulation instruction. However, because these registers are connected by an internal 8-bit bus, the TMm register and TMm+1 register must be read divided into two times. Therefore, read these registers twice and compare the values, taking into consideration that the reading occurs during a count change.

In the following cases, the count value becomes 00H.

- $\overline{\text{RESET}}$ input
- When the TCEn bit of 8-bit timer mode control register n (TMCn) is cleared
- TMn register and CRn register match in the mode in which clear & start occurs on a match between the TMn register and 8-bit timer compare register n (CRn)

Caution When connected in cascade, these registers become 00H even when the TCEm bit in the lowest timer (TMm) is cleared.

Remark n = 2 to 5
m = 2, 4

(2) 8-bit timer compare registers 2 to 5 (CR2 to CR5)

The CRn register can be read and written by an 8-bit memory manipulation instruction.

In a mode other than the PWM mode, the value set to the CRn register is always compared to the count value of 8-bit counter n (TMn), and if the two values match, an interrupt request signal (INTTMn) is generated.

In the PWM mode, TMn register overflow causes the TOn pin output to change to the active level, and when the values of the TMn register and the CRn register match, the TOn pin output changes to the inactive level.

The value of the CRn register can be set in the range of 00H to FFH.

When TM2 and TM3, and TM4 and TM5 are connected in cascade as 16-bit timers, the CRm register and CRm+1 register function as 16-bit timer compare registers 23 and 45 (CR23 and CR45). The counter value and register value are compared in 16-bit lengths, and if they match, an interrupt request (INTTMm) is generated.

Cautions 1. In the mode in which clear & start occurs upon a match of the TMn register and CRn register (TMCn6 =0), do not write a different value to the CRn register during the count operation.

2. In the PWM mode, set the CRn register rewrite interval to three or more count clocks (clock selected with timer clock selection register n (TCLn)).

3. Before changing the value of the CRn register when using a cascade connection, be sure to stop the timer operation.

Remark n = 2 to 5
m = 2, 4

7.2.3 Registers controlling 8-bit timer/event counters 2 to 5

The following two registers are used to control 8-bit timer/event counter n.

- Timer clock selection register n (TCLn)
- 8-bit timer mode control register n (TMCn)

Remark To use the functions of the TIn and TOn pins, refer to **Table 4-18 Using Port Pins for Alternate Function**.

(1) Timer clock selection registers 2 to 5 (TCL2 to TCL5)

These registers set the count clock of 8-bit timer/event counter n and the valid edge of the TIn pin input.

The TCLn register is set by an 8-bit memory manipulation instruction.

RESET input clears this register to 00H.

After reset: 00H R/W Address: TCL2 FFFFF644H, TCL3 FFFFF645H

	7	6	5	4	3	2	1	0
TCLn	0	0	0	0	0	TCLn2	TCLn1	TCLn0

(n = 2, 3)

TCLn2	TCLn1	TCLn0	Count clock selection		
			Clock	f _{xx}	
				17 MHz	13.5 MHz
0	0	0	Falling edge of TIn	–	–
0	0	1	Rising edge of TIn	–	–
0	1	0	f _{xx} /4	235 ns	296 ns
0	1	1	f _{xx} /8	470 ns	593 ns
1	0	0	f _{xx} /16	941 ns	1.19 μs
1	0	1	f _{xx} /32	1.88 μs	2.37 μs
1	1	0	f _{xx} /128	7.53 μs	9.48 μs
1	1	1	f _{xx} /512	30.1 μs	37.9 μs

Caution Before overwriting the TCLn register with different data, stop the timer operation.

Remark When TCL2 and TCL3 are connected in cascade, the TCL3 register settings are invalid.

After reset: 00H R/W Address: TCL4 FFFFF654H, TCL5 FFFFF655H

	7	6	5	4	3	2	1	0
TCLn	0	0	0	0	0	TCLn2	TCLn1	TCLn0

(n = 4, 5)

TCLn2	TCLn1	TCLn0	Count clock selection		
			Clock	f _{xx}	
				17 MHz	13.5 MHz
0	0	0	Falling edge of TIn	–	–
0	0	1	Rising edge of TIn	–	–
0	1	0	f _{xx} /4	235 ns	296 ns
0	1	1	f _{xx} /8	470 ns	593 ns
1	0	0	f _{xx} /16	941 ns	1.19 μs
1	0	1	f _{xx} /32	1.88 μs	2.37 μs
1	1	0	f _{xx} /128	7.53 μs	9.48 μs
1	1	1	f _{xx} /256	15.1 μs	19.0 μs

Caution Before overwriting the TCLn register with different data, stop the timer operation.

Remark When TCL4 and TCL5 are connected in cascade, the TCL5 register settings are invalid.

(2) 8-bit timer mode control registers 2 to 5 (TMC2 to TMC5)

The TMCn register performs the following six settings.

- Controls counting by 8-bit timer counters 2 to 5 (TM2 to TM5)
- Selects the operation mode of the TMn register
- Selects the individual mode or cascade connection mode
- Sets the status of the timer output flip-flop
- Controls the timer output flip-flop or selects the active level in the PWM (free-running) mode
- Controls timer output

The TMCn register is set by an 8-bit or 1-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input clears these registers to 00H.

Remark n = 2 to 5

7.3 Operation of 8-Bit Timer/Event Counters 2 to 5

7.3.1 Operation as interval timer (8 bits)

8-bit timer/event counter n operates as an interval timer that repeatedly generates interrupts at the interval of the count value preset in 8-bit timer compare register n (CR n).

If the count value in 8-bit timer counter n (TM n) matches the value set in the CR n register, the value of the TM n register is cleared to 0 and counting is continued, and at the same time, an interrupt request signal (INTTM n) is generated.

Setting method

- <1> Set each register.
 - TCL n register: Selects the count clock (t).
 - CR n register: Compare value (N)
 - TMC n register: Stops count operation and selects the mode in which clear & start occurs on a match between the TM n register and CR n register (TMC n register = 0000xxx0B, x: don't care).
- <2> When the TCEn bit of the TMC n register is set to 1, the count operation starts.
- <3> When the values of the TM n register and CR n register match, INTTM n is generated (TM n register is cleared to 00H).
- <4> Then, INTTM n is repeatedly generated at the same interval. To stop counting, set TCEn = 0.

$$\text{Interval time} = (N + 1) \times t: N = 00\text{H to FFH}$$

Caution During interval timer operation, do not rewrite the value of the CR n register.

Figure 7-18. Timing of Interval Timer Operation (1/2)

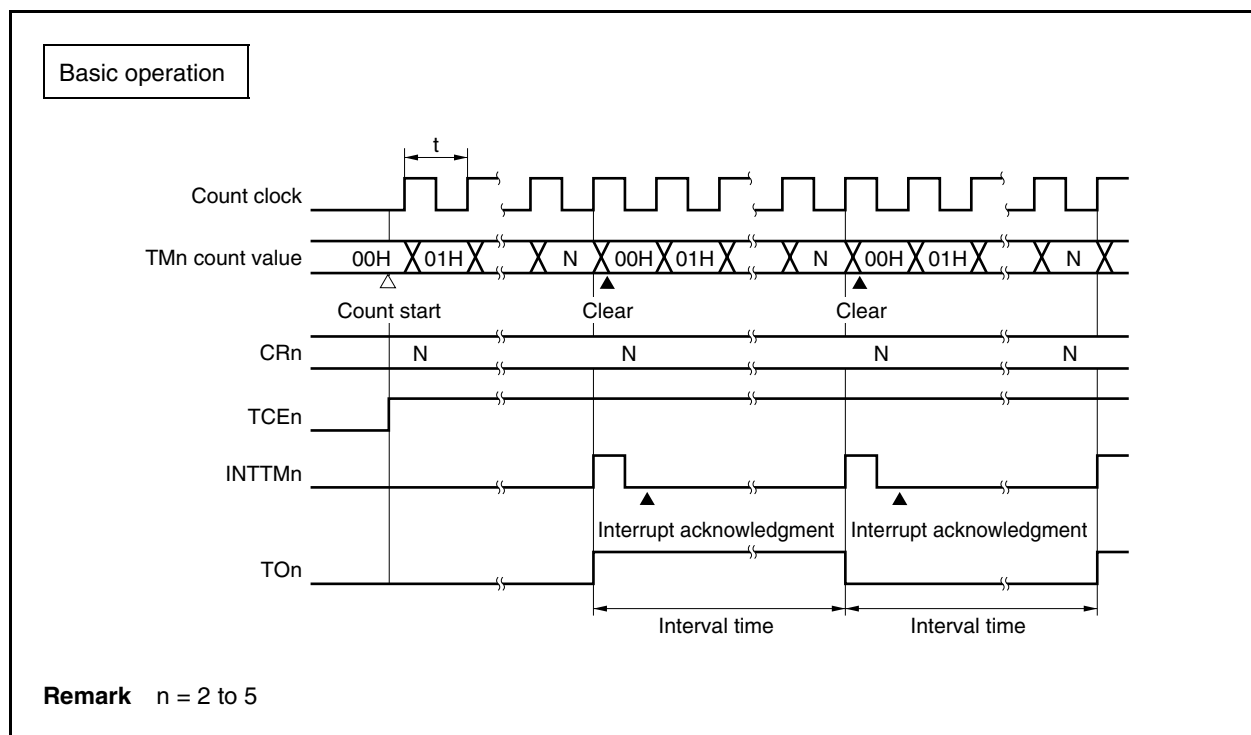
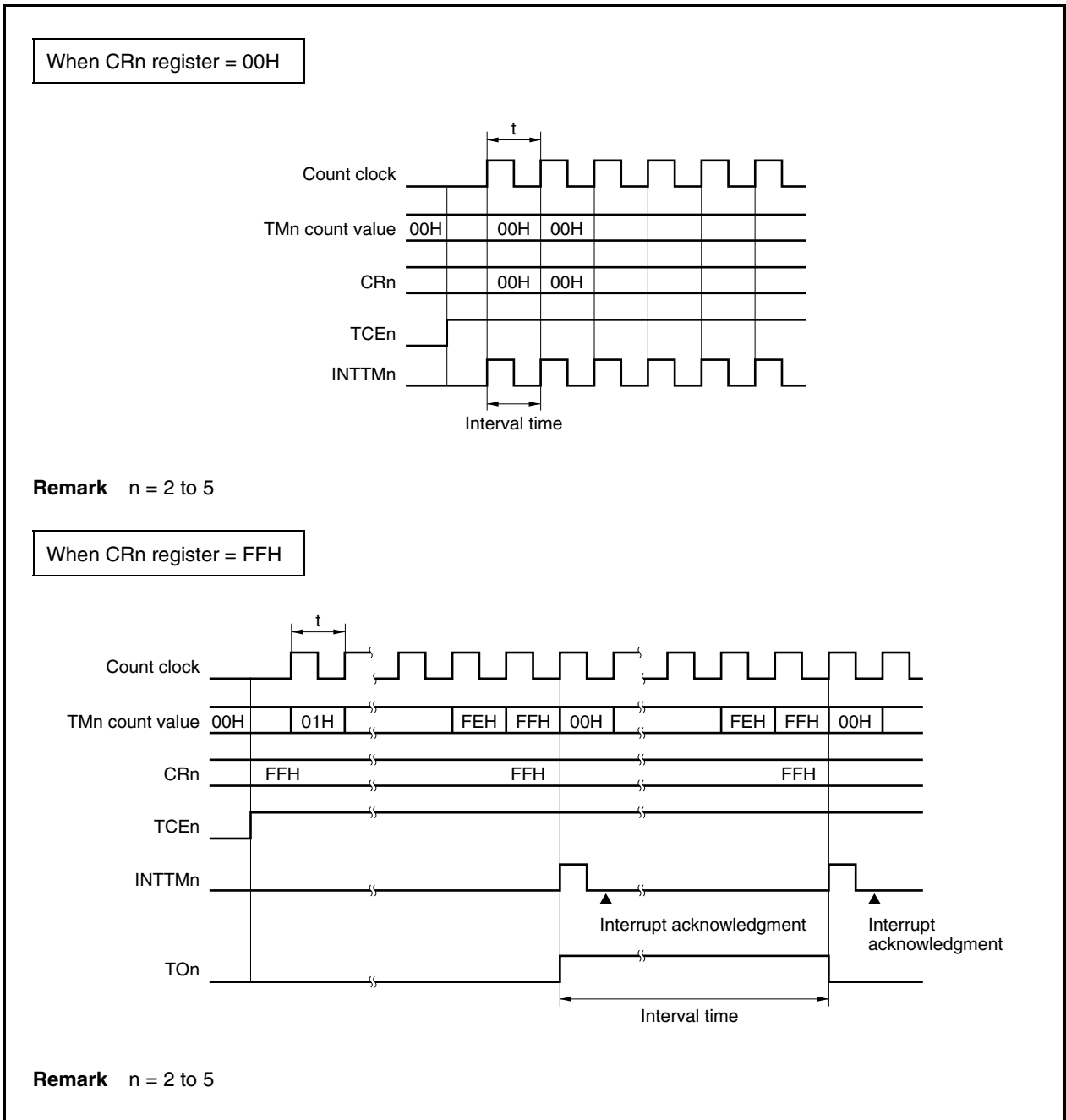


Figure 7-18. Timing of Interval Timer Operation (2/2)



7.3.2 Operation as external event counter (8 bits)

The external event counter counts the number of clock pulses input to the TIn pin from an external source by using 8-bit timer counter n (TMn).

Each time the valid edge specified by timer clock selection register n (TCLn) is input to the TIn pin, the TMn register is incremented. Either the rising edge or the falling edge can be specified as the valid edge.

When the count value of the TMn register matches the value of 8-bit timer compare register n (CRn), the TMn register is cleared to 0 and an interrupt request signal (INTTMn) is generated.

Setting method

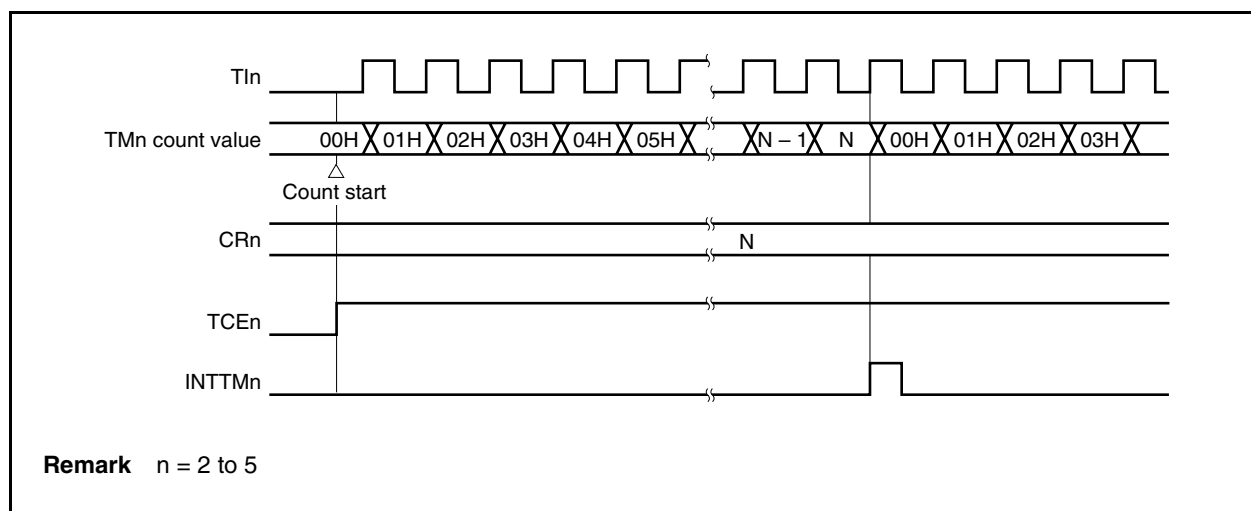
- <1> Set each register.
 - TCLn register: Selects the TIn input edge.
Falling edge of TIn pin → TLCn = 00H
Rising edge of TIn pin → TCLn = 01H
 - CRn register: Compare value (N)
 - TMCn register: Stops count operation, selects the mode in which clear & start occurs on a match between the TMn register and CRn register, disables timer output F/F inversion operation, and disables timer output.
(TMCn register = 0000xx00B, x: don't care)
- <2> When the TCEn bit of the TMCn register is set to 1, the counter counts the number of pulses input from TIn.
- <3> When the values of the TMn register and CRn register match, INTTMn is generated (TMn register is cleared to 00H).
- <4> Then, INTTMn is generated each time the values of the TMn register and CRn register match.

INTTMn is generated when the valid edge of TIn is input N + 1 times: N = 00 to FFH

Caution During external event counter operation, do not rewrite the value of the CRn register.

Remark n = 2 to 5

Figure 7-19. Timing of External Event Counter Operation (with Rising Edge Specified)



7.3.3 Square-wave output operation (8-bit resolution)

A square wave with any frequency can be output at an interval specified by the value preset in 8-bit timer compare register n (CRn).

By setting the TOEn bit of 8-bit timer mode control register n (TMCn) to 1, the output status of the TOn pin is inverted at an interval specified by the count value preset in the CRn register. In this way, a square wave of any frequency can be output (duty = 50%) (n = 2 to 5).

Setting method

<1> Set each register.

- TCLn register: Selects the count clock (t).
- CRn register: Compare value (N)
- TMCn register: Stops count operation, selects the mode in which clear & start occurs on a match between the TMn register and CRn register.

LVSn	LVRn	Timer Output F/F Status Setting
1	0	High-level output
0	1	Low-level output

Enables timer output F/F inversion operation, and enables timer output.
(TMCn register = 00001011B or 00000111B)

<2> When the TCEn bit of the TMCn register is set to 1, counting starts.

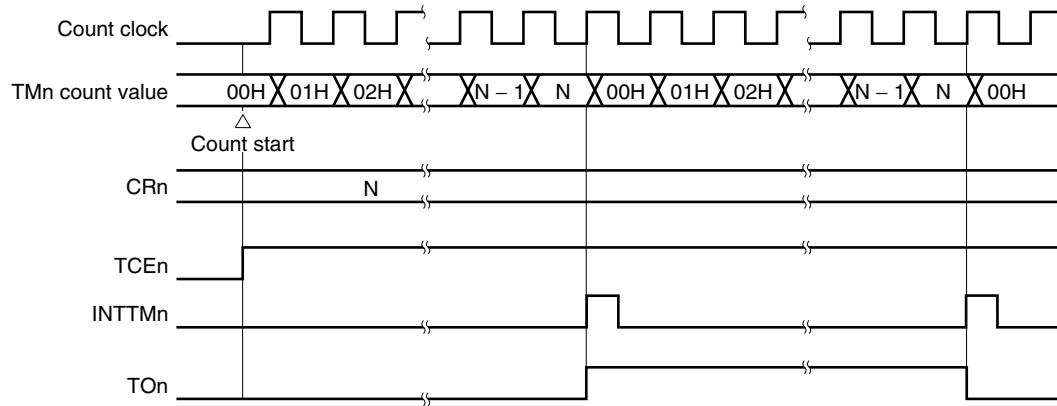
<3> When the values of the TMn register and CRn register match, the timer output F/F is inverted. Moreover, INTTMn is generated and the TMn register is cleared to 00H.

<4> Then, the timer F/F is inverted during the same interval and a square wave is output from the TOn pin.

$$\text{Frequency} = t/2 (N + 1); N = 00H \text{ to } FFH$$

Caution Do not rewrite the value of the CRn register during square-wave output.

Figure 7-20. Timing of Square-Wave Output Operation



Note The initial value of the TOn output can be set using the LVS_n and LVR_n bits of the TMC_n register.

Remark n = 0, 1

7.3.4 8-bit PWM output operation

By setting the TMCn6 bit of 8-bit timer mode control register n (TMCn) to 1, 8-bit timer/event counter n performs PWM output.

Pulses with the duty factor determined by the value set in 8-bit timer compare register n (CRn) are output from the TOn pin.

Set the width of the active level of the PWM pulse in the CRn register. The active level can be selected using the TMCn1 bit of the TMCn register.

The count clock can be selected using timer clock selection register n (TCLn).

PWM output can be enabled/disabled by the TOEn bit of the TMCn register.

Caution The CRn register rewrite interval must be three or more operation clocks (set by the TCLn register).

(1) Basic operation of PWM output

Setting method

<1> Set each register.

- TCLn register: Selects the count clock (t).
- CRn register: Compare value (N)
- TMCn register: Stops count operation, selects PWM mode, and leave timer output F/F unchanged.

TMCn1	Active Level Selection
0	Active high
1	Active low

Timer output enabled

(TMCn register = 01000001B or 01000011B)

<2> When the TCEn bit of the TMCn register is set to 1, counting starts.

PWM output operation

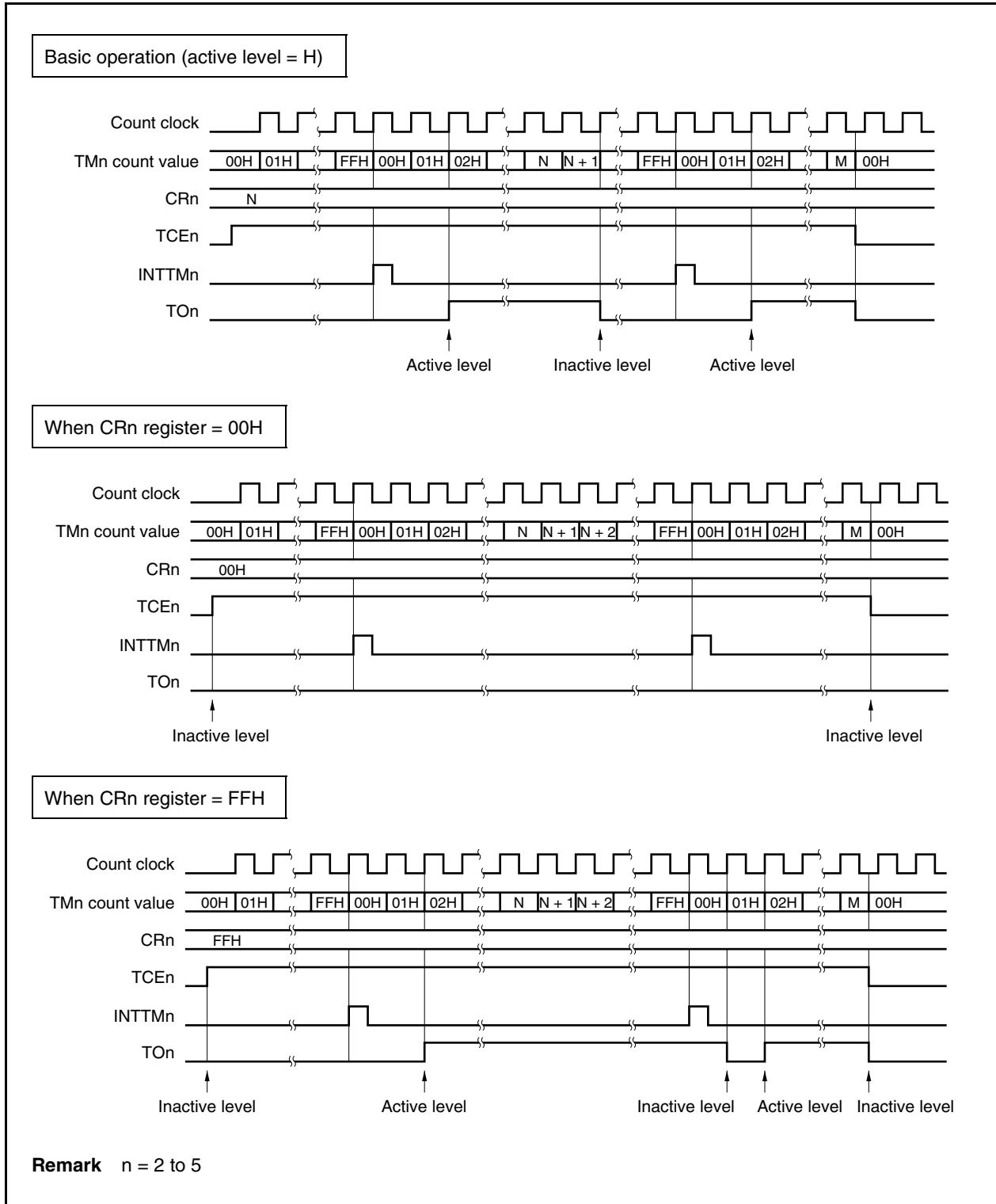
- <1> When counting starts, PWM output (output from the TOn pin) outputs the inactive level until an overflow occurs.
- <2> When an overflow occurs, the active level set by setting method <1> is output. The active level is output until the value of the CRn register and the count value of 8-bit timer counter n (TMn) match.
- <3> When the value of the CRn register and the count value match, the inactive level is output and continues to be output until an overflow occurs again.
- <4> Then, steps <2> and <3> are repeated until counting is stopped.
- <5> When counting is stopped by setting TCEn to 0, PWM output becomes inactive.

$$\text{Cycle} = 2^8/t, \text{ active level width} = N/t: N = 00 \text{ to FFH}$$

Remark n = 2 to 5

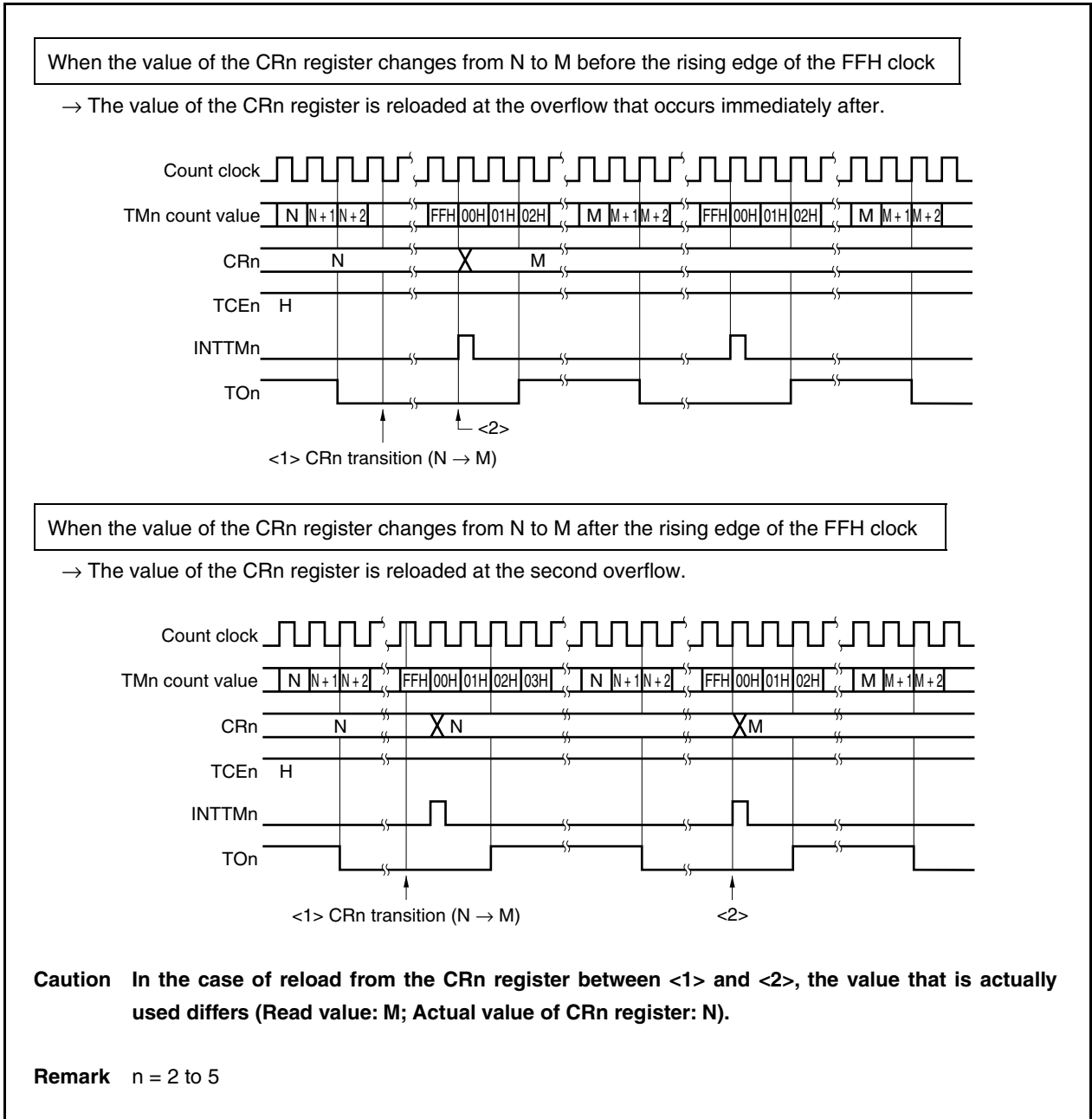
(a) Basic operation of PWM output

Figure 7-21. Timing of PWM Output Operation



(b) Operation based on CRn register transitions

Figure 7-22. Timing of Operation Based on CRn Register Transitions



Caution In the case of reload from the CRn register between <1> and <2>, the value that is actually used differs (Read value: M; Actual value of CRn register: N).

Remark n = 2 to 5

7.3.5 Operation as interval timer (16 bits)

The V850ES/SA2 and V850ES/SA3 are provided with a 16-bit register that can be used only during cascade connection.

The 16-bit resolution timer/event counter mode is selected by setting the TMC34 and TMC54 bits of 8-bit timer mode control registers 3 and 5 (TMC3 and TMC5) to 1.

8-bit timer/event counter *n* operates as an interval timer by repeatedly generating interrupts using the count value preset in 16-bit timer compare registers 23 and 45 (CR23 and CR45) as the interval.

In the following description, TM2 and TM3 are used. Read TM2 and TM3 as TM4 and TM5 when using TM4 and TM5.

Setting method (when TM2 and TM3 are connected in cascade)

- <1> Set each register.
- TCL2 register: Selects the count clock (t)
(The TCL3 register does not need to be set in cascade connection)
 - CR2 register: Compare value (N) ... Lower 8 bits (settable from 00H to FFH)
 - CR3 register: Compare value (N) ... Higher 8 bits (settable from 00H to FFH)
 - TMC2, TMC3 register: Selects the mode in which clear & start occurs on a match between TM23 register and CR23 register (×: don't care)

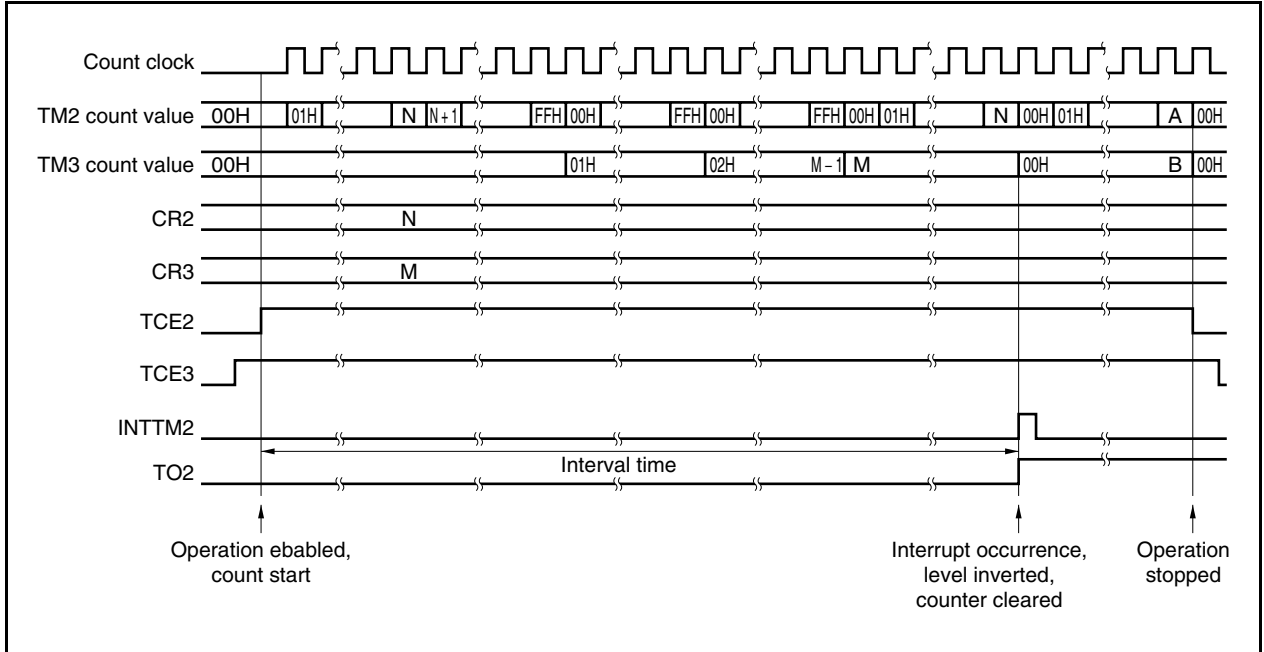
$$\left(\begin{array}{l} \text{TMC2 register} = 0000\text{xx}00\text{B} \\ \text{TMC3 register} = 0001\text{xx}00\text{B} \end{array} \right)$$
- <2> Set the TCE3 bit of the TMC3 register to 1. Then set the TCE2 bit of the TMC2 register to 1 to start the count operation.
- <3> When the values of the TM23 register and CR23 register connected in cascade match, INTTM2 is generated (the TM23 register is cleared to 0000H).
- <4> INTTM2 is then generated repeatedly at the same interval.

$$\text{Interval time} = (N + 1) \times t; N = 0000\text{H to FFFFH}$$

- Cautions**
1. To write using 8-bit access during cascade connection, set the TCE3 bit to 1 at operation start and then set the TCE2 bit to 1. When operation is stopped, set the TCE2 bit to 0 and then set the TCE3 bit to 0.
 2. During cascade connection, TI2 input, TO2 output, and INTTM2 input are used while TI3 input, TO3 output, and INTTM3 input are not, so set bits LVS3, LVR3, TMC31, and TOE3 to 0.
 3. Do not change the value of the CR23 register during timer operation.

Figure 7-23 shows a timing example of the cascade connection mode with 16-bit resolution.

Figure 7-23. Cascade Connection Mode with 16-Bit Resolution (When TM2 and TM3 Are Connected)



7.3.6 Operation as external event counter (16 bits)

The V850ES/SA2 and V850ES/SA3 are provided with a 16-bit register that can be used only during cascade connection.

The 16-bit resolution timer/event counter mode is selected by setting the TMC34 and TMC54 bits of 8-bit timer mode control registers 3 and 5 (TMC3 and TMC5) to 1.

The external event counter counts the number of clock pulses input to the TI2 and TI4 pins from an external source using 16-bit timer counters 23 and 45 (TM23 and TM45).

In the following description, TM2 and TM3 are used. Read TM2 and TM3 as TM4 and TM5 when using TM4 and TM5.

Setting method (when TM2 and TM3 are connected in cascade)

- <1> Set each register.
- TCL2 register: Selects the TI2 input edge.
(The TCL3 register does not have to be set during cascade connection.)
Falling edge of TI2 → TCL2 = 00H
Rising edge of TI2 → TCL2 = 01H
 - CR2 register: Compare value (N) ... Lower 8 bits (settable from 00H to FFH)
 - CR3 register: Compare value (N) ... Higher 8 bits (settable from 00H to FFH)
 - TMC2, TMC3 registers: Stops count operation, selects the clear & stop mode entered on a match between the TM23 register and CR23 register, disables timer output F/F inversion, and disables timer output.
(×: don't care)

TMC2 register = 0000xx00B
TMC3 register = 0001xx00B
- <2> Set the TCE3 bit of the TMC3 register to 1. Then set the TCE2 bit of the TMC2 register to 1 and count the number of pulses input from TI2.
- <3> When the values of the TM23 register and CR23 register connected in cascade match, INTTM2 is generated (the TM23 register is cleared to 0000H).
- <4> INTTM2 is then generated each time the values of the TM23 register and CR23 register match.

INTTM2 is generated when the valid edge of TI2 is input N + 1 times: N = 0000 to FFFFH

- Cautions**
1. During external event counter operation, do not rewrite the value of the CRn register.
 2. To write using 8-bit access during cascade connection, set the TCE3 bit to 1 and then set the TCE2 bit to 1. When operation is stopped, set the TCE2 bit to 0 and then set the TCE3 bit to 0.
 3. During cascade connection, TI2 input and INTTM2 input are used while TI3 input, TO3 output, and INTTM3 input are not, so set bits LVS3, LVR3, TMC31, and TOE3 to 0.
 4. Do not change the value of the CR23 register during external counter operation.

7.3.7 Square-wave output operation (16-bit resolution)

The V850ES/SA2 and V850ES/SA3 are provided with a 16-bit register that can be used only during cascade connection.

The 16-bit resolution timer/event counter mode is selected by setting the TMC34 and TCM54 bits of 8-bit timer mode control registers 3 and 5 (TMC3 and TMC5) to 1.

8-bit timer/event counter n outputs a square wave of any frequency using the interval preset in 16-bit timer compare registers 23 and 45 (CR23 and CR45).

In the following description, TM2 and TM3 are used. Read TM2 and TM3 as TM4 and TM5 when using TM4 and TM5.

Setting method (when TM2 and TM3 are connected in cascade)

<1> Set each register.

- TCL2 register: TCL2 selects the count clock (t)
(The TCL3 register does not have to be set in cascade connection)
- CR2 register: Compare value (N) ... Lower 8 bits (settable from 00H to FFH)
- CR3 register: Compare value (N) ... Higher 8 bits (settable from 00H to FFH)
- TMC2, TCM3 registers: Stops count operation, selects the mode in which clear & start occurs on a match between the TM23 register and CR23 register.

LVS2	LVR2	Timer Output F/F Status Settings
1	0	High-level output
0	1	Low-level output

Enables timer output F/F inversion, and enables timer output.

TMC2 register = 00001011B or 00000111B
TMC3 register = 00010000B

- <2> Set the TCE3 bit of the TMC3 register to 1. Then set the TCE2 bit of the TMC2 register to 1 to start the count operation.
- <3> When the values of the TM23 register and the CR23 register connected in cascade match, the TO2 timer output F/F is inverted. Moreover, INTTM2 is generated and the TM23 register is cleared to 0000H.
- <4> Then, the timer F/F is inverted during the same interval and a square wave is output from the TO2 pin.

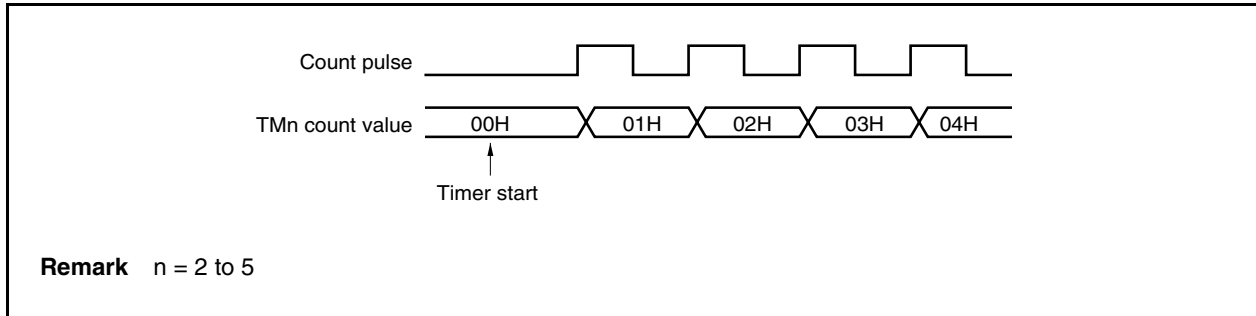
$$\text{Frequency} = t/2 (N + 1); N = 0000H \text{ to } FFFFH$$

7.3.8 Cautions

(1) Error on starting timer

An error of up to 1 clock occurs before the match signal is generated after the timer has been started. This is because 8-bit timer counter n (TMn) is started asynchronously to the count pulse.

Figure 7-24. Start Timing of Timer n



CHAPTER 8 REAL-TIME COUNTER FUNCTION

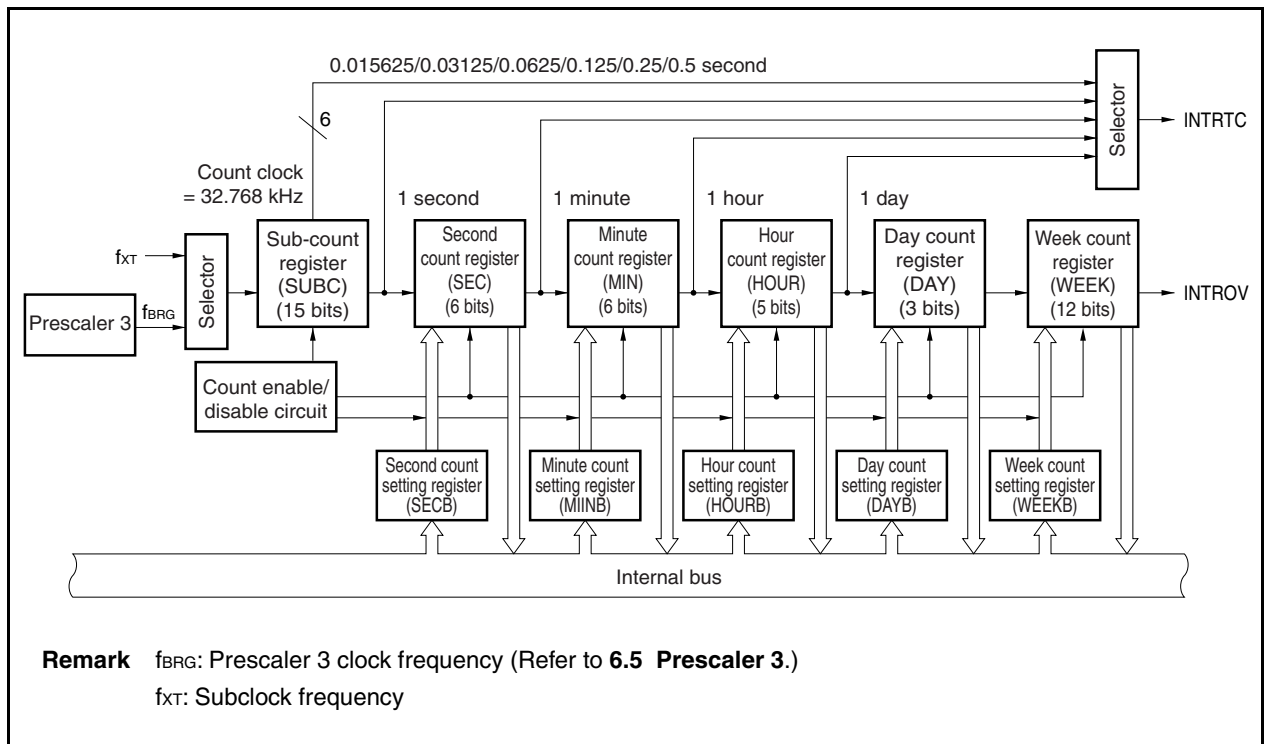
8.1 Function

The real-time counter has the following functions.

- Week, day, hour, minute, and second counters that can count up to 4,095 weeks
- Week, day, hour, minute, and second counters can be read while they are operating/stopped
- Generates overflow interrupt request signal (INTROV) from week counter.
- Generates interval interrupt request signal (INTRTC) at intervals of 0.015625, 0.03125, 0.0625, 0.125, 0.25, 0.5, or 1 second, 1 minute, 1 hour, or 1 day.
- Can operate only on voltage supplied to V_{DDBU} pin when subclock (f_{XT}) is selected.

The configuration of the real-time counter function is shown below.

Figure 8-1. Block Diagram of Real-Time Counter



8.2 Real-Time Counter Control Registers

The registers listed in the table below control the real-time counter.

Table 8-1. Control Registers of Real-Time Counter

Register Name	Function	Instruction Unit	Reset Value	R/W
RTCC0	RTC control register 0	8/1-bit instruction	80H	R/W
RTCC1	RTC control register 1	8/1-bit instruction	8xH	R/W
SUBC	Sub-count register	8/16-bit instruction	Undefined	R
SEC	Second count register	8-bit instruction	Undefined	R
MIN	Minute count register	8-bit instruction	Undefined	R
HOUR	Hour count register	8-bit instruction	Undefined	R
DAY	Day count register	8-bit instruction	Undefined	R
WEEK	Week count register	8/16-bit instruction	Undefined	R
SECB	Second count setting register	8-bit instruction	00H	W
MINB	Minute count setting register	8-bit instruction	00H	W
HOURB	Hour count setting register	8-bit instruction	00H	W
DAYB	Day count setting register	8-bit instruction	00H	W
WEEKB	Week count setting register	8/16-bit instruction	0000H	W

(1) RTC control register 0 (RTCC0)

The RTCC0 register is an 8-bit register that controls the operation of the real-time counter. This register can be read or written in 8-bit or 1-bit units.

$\overline{\text{RESET}}$ input clears this register to 00H.

After reset: 80H R/W Address: FFFF6E0H

	7	6	5	4	3	2	1	0
RTCC0	RTCAE	CKS	0	0	0	0	0	0

RTCAE	Enables/disables RTC operation
0	Stops RTC clock operation and resets sub-count value.
1	Enables RTC clock operation.
CKS	Selects input clock
0	Selects subclock (f_{XT}) as input clock.
1	Selects main clock (f_x) divided by prescaler 3 (f_{BRG}) ^{Note} as input clock.

Note Refer to 6.5 Prescaler 3.

(2) RTC control register 1 (RTCC1)

The RTCC1 register is an 8-bit register that controls the operation of the real-time counter. This register can be read or written in 8-bit or 1-bit units.

RESET input sets this register to 8xH.

After reset: 8xH^{Note 1} R/W Address: FFFFF6E1H

	7	6	5	4	3	2	1	0
RTCC1	RTCE	INTS3	INTS2	INTS1	INTS0	0	0	RTCF ^{Note 2}

RTCE	Enables/disables RTC count-up operation
0	Disables RTC count operation.
1	Enables RTC count operation.

INTS3	INTS2	INTS1	INTS0	Specifies interrupt request signal generation timing
0	0	0	0	Does not generate interrupt request signal.
0	0	0	1	Generates interrupt request signal every 0.015625 second.
0	0	1	0	Generates interrupt request signal every 0.03125 second.
0	0	1	1	Generates interrupt request signal every 0.0625 second.
0	1	0	0	Generates interrupt request signal every 0.125 second.
0	1	0	1	Generates interrupt request signal every 0.25 second.
0	1	1	0	Generates interrupt request signal every 0.5 second.
0	1	1	1	Generates interrupt request signal every 1 second.
1	0	0	0	Generates interrupt request signal every 1 minute.
1	0	0	1	Generates interrupt request signal every 1 hour.
1	0	1	0	Generates interrupt request signal every 1 day.
Other than above				Setting prohibited

RTCF	RTC operation flag
0	Count operation is stopped
1	Count-up operation is in progress.

Notes 1. 80H or 81H, depending on the value of the RTCF bit.

2. The RTCF bit is a read-only bit.

Remark The timing of generating an interrupt request set by the INTS3 to INTS0 bits is determined by the setting of the CKS bit, as follows.

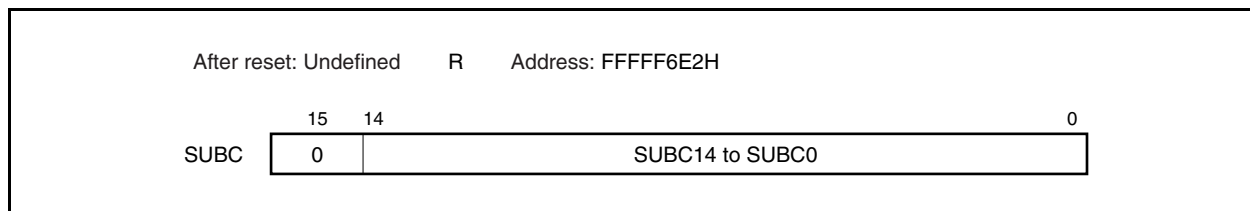
When CKS bit = 0 $f_{XT} = 32.768 \text{ kHz}$

When CKS bit = 1 $f_{BRG} = 32.768 \text{ kHz}$

(3) Sub-count register (SUBC)

The SUBC register is a 15-bit register that counts the reference time of the real-time counter. It counts 1 second using the 32.768 kHz clock. This register is read-only, in 16-bit or 8-bit units.

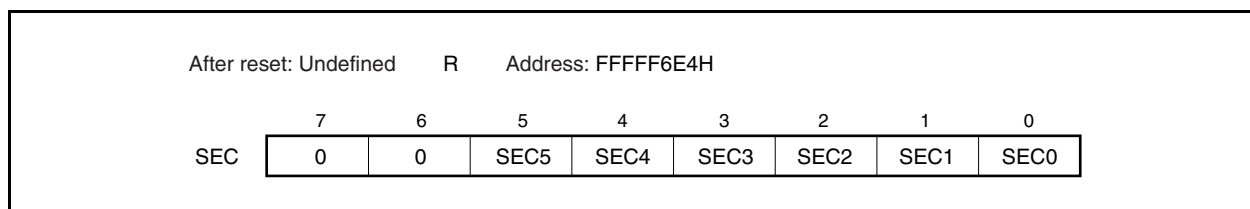
This register is not initialized by $\overline{\text{RESET}}$ input or when $\text{RTCE} = 0$.



(4) Second count register (SEC)

This 8-bit register uses a value of 0 to 59 (decimal) to indicate the count value in seconds. This register is read-only, in 8-bit units.

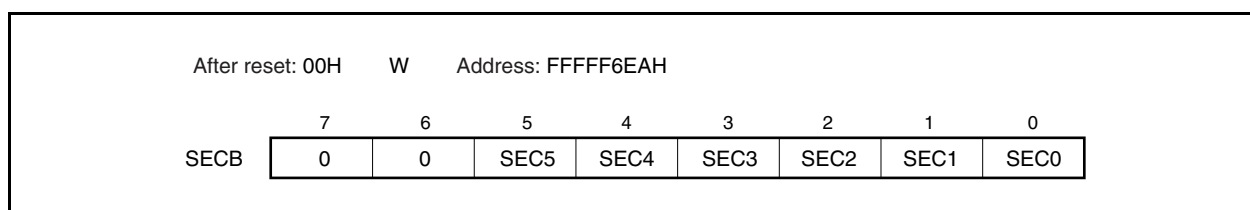
This register is not initialized by $\overline{\text{RESET}}$ input or when $\text{RTCE} = 0$.



(5) Second count setting register (SECB)

This is an 8-bit register for setting the second count. This register is read-only, in 8-bit units. Set a count value in a range of 0 to 59 (decimal) to this register. Do not set a count value of 60 (decimal) or greater.

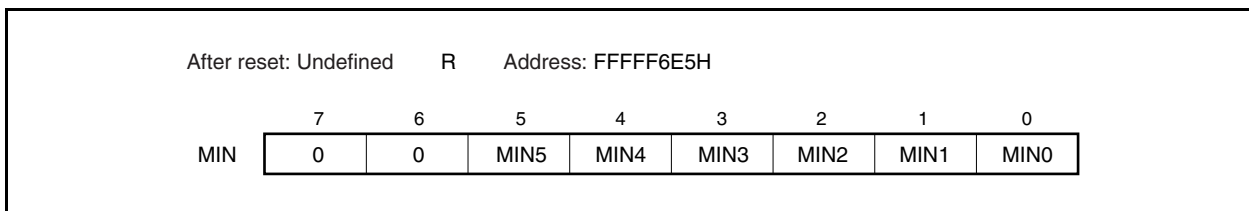
$\overline{\text{RESET}}$ input clears this register to 00H.



(6) Minute count register (MIN)

This 8-bit uses a value of 0 to 59 (decimal) to indicate the count value in minutes. This register is read-only, in 8-bit units.

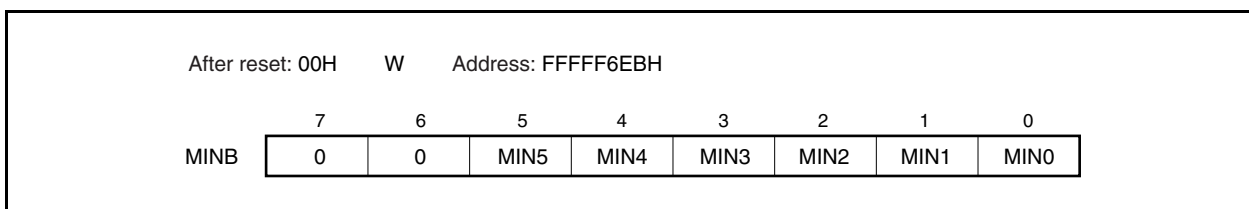
This register is not initialized by $\overline{\text{RESET}}$ input or when $\text{RTCE} = 0$.



(7) Minute count setting register (MINB)

This is an 8-bit register for setting the minute count. This register is read-only, in 8-bit units. Set a count value in a range of 0 to 59 (decimal) to this register. Do not set a count value of 60 (decimal) or greater.

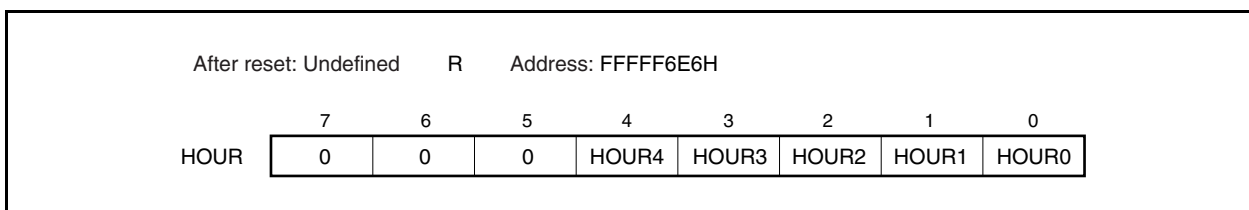
$\overline{\text{RESET}}$ input clears this register to 00H.



(8) Hour count register (HOUR)

This 8-bit register uses a value of 0 to 23 (decimal) to indicate the count value in hours. This register is read-only, in 8-bit units.

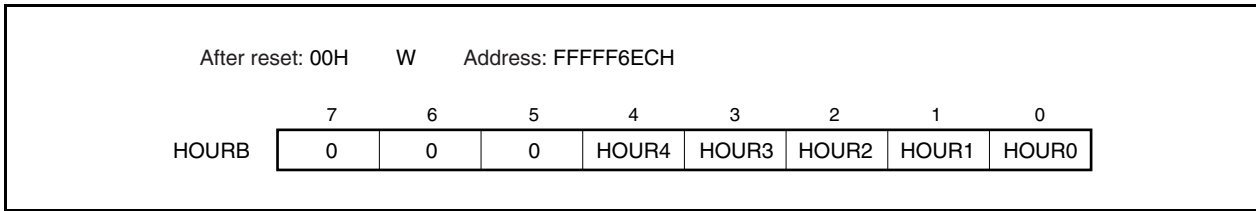
This register is not initialized by $\overline{\text{RESET}}$ input or when $\text{RTCE} = 0$.



(9) Hour count setting register (HOURB)

This is an 8-bit register for setting the hour count. This register is read-only, in 8-bit units. Set a count value in a range of 0 to 23 (decimal) to this register. Do not set a count value of 24 (decimal) or greater.

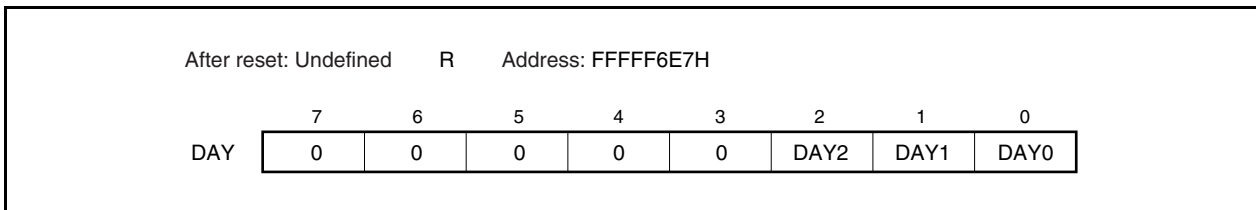
$\overline{\text{RESET}}$ input clears this register to 00H.



(10) Day count register (DAY)

This 8-bit register used a value of 0 to 6 (decimal) to indicate the count value in days. This register is read-only, in 8-bit units.

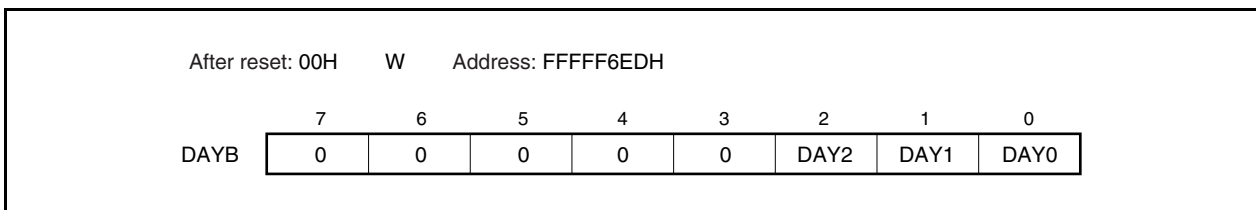
This register is not initialized by $\overline{\text{RESET}}$ input or when RTCE = 0.



(11) Day count setting register (DAYB)

This is an 8-bit register for setting the day count. This register is read-only, in 8-bit units. Set a count value in a range of 0 to 6 (decimal) to this register. Do not set a count value of 7 (decimal) or greater.

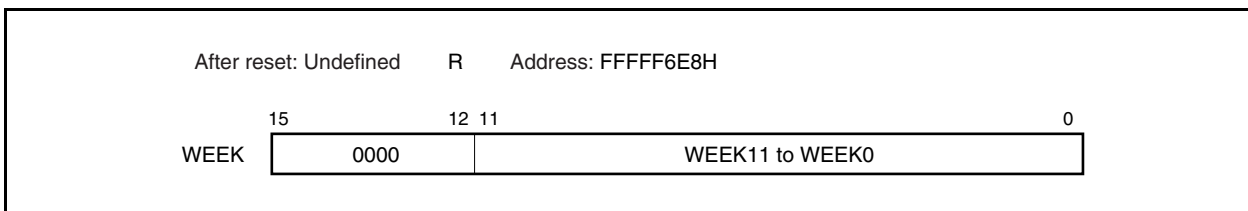
$\overline{\text{RESET}}$ input clears this register to 00H.



(12) Week count register (WEEK)

This 16-bit register uses a value of 0 to 4,095 (decimal) to indicate the count value in weeks. This register is read-only, in 8-bit or 16-bit units.

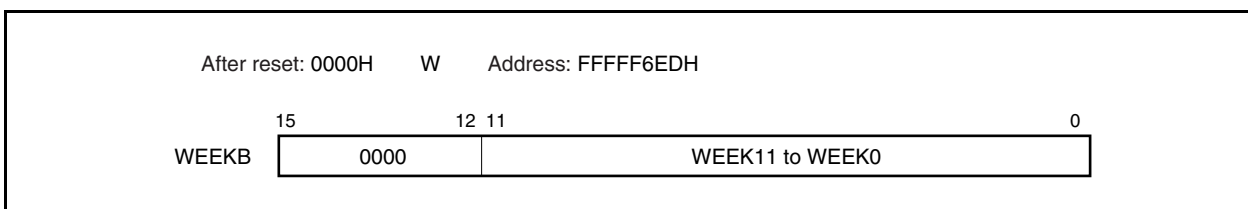
This register is not initialized by $\overline{\text{RESET}}$ input or when $\text{RTCE} = 0$.



(13) Week count setting register (WEEKB)

This is a 16-bit register for setting the week count. This register is read-only, in 8-bit or 16-bit units. Set a count value in a range of 0 to 4,095 (decimal) to this register.

$\overline{\text{RESET}}$ input clears this register to 0000H.



8.3 Operation

8.3.1 Initializing counter and count-up

- <1> When the $\overline{\text{RESET}}$ input signal is asserted (0), the values of RTC control registers 0 and 1 (RTCC0 and RTCC1) are initialized. Real-time counter clock operation is enabled when RTCAE of the RTCC0 register is set to 1, and real-time counter count operation is enabled when RTCE of the RTCC1 register is set to 1.
- <2> The sub-count register (SUBC) is reset if the real-time count clock operation is stopped when RTCAE is 0.
- <3> The real-time counter clock operation is stopped when the CKS bit of the RTCC0 register is selected and RTCAE is set to 1.
- <4> After 3 internal clocks, the values of all the count setting registers are reflected on the corresponding count registers at all once, and each count register starts counting up.
- <5> Each time a count register overflows, the higher count register starts counting up.
- <6> At the clock after the one at which the overflow conditions of all the count registers have been satisfied, all the count registers are cleared to "0". The INTROV signal is asserted active for the duration of one cycle of the real-time count clock after the week count register (WEEK) overflows.

8.3.2 Rewriting counter

- <1> When the $\overline{\text{RESET}}$ input signal is asserted (0), the values of the RTCC0 and RTCC1 registers are initialized. Real-time counter clock operation is enabled when RTCAE is set to 1, and real-time counter count operation is enabled when RTCE is set to 1.
- <2> Write a value to each count setting register.
- <3> The value of all the count setting registers are reflected on the corresponding count registers all at once two internal clocks after RTCE is set to 1, and the real-time counter starts counting up 3 internal clocks after that.

8.3.3 Controlling interrupt request signal output

This section explains how to control interrupt request signals, taking INTS0 to INTS3 = 0111B (every second) and INTS0 to INTS3 = 1000B (every minute) as an example.

- <1> When the $\overline{\text{RESET}}$ input signal is asserted (0), the values of the RTCC0 and RTCC1 registers are initialized. Real-time counter clock operation is enabled when RTCAE is set to 1, and real-time counter count operation is enabled when RTCE is set to 1.
- <2> Clear RTCAE to 0 and select the CKS bit.
- <3> The internal clock operation is started when RTCAE = 1.
- <4> After 3 internal clocks, the value of all the count setting registers are reflected on the corresponding count registers at all once, and the real-time counter starts counting up.
- <5> Set the INTS0 to INTS3 bits to 0111B (1000B).
- <6> Because INTS0 to INTS3 = 0111B, the INTRTC signal is asserted each time 1 second is counted (because INTS0 to INTS3 = 1000B, the INTRTC signal is asserted each time 1 minute is counted).
- <7> The INTROV signal is asserted when the overflow conditions of all the count registers have been satisfied.

8.3.4 Notes

- (1) When the reset signal is input, the CKS bit of RTC control register 0 (RTCC0) is cleared to 0. Therefore, the real-time counter operates with the subclock (f_{XT}). Note the following points.
 - To continue the real-time counter operation even during the reset period, select f_{XT} (CKS = 0) as the count clock. If the prescaler 3 clock (f_{BRG}) (CKS = 1) is selected, the count clock is changed to f_{XT} (CKS = 0) by the reset input, in which case the operation cannot be guaranteed.
 - If the real-time counter is not used, clear RTCAE of the RTCC0 register to 0 after the reset signal has been cleared.
- (2) Perform initialization after clearing RTCAE to 0 when the reset signal has been cleared for the first time. For initialization, set each count setting register, count clock, and interrupt request signal generation timing using the procedure described in (4) and (5) below, and clear the OVFIF bit of the OVFIC register and the RTCIF bit of the RTCIC register to 0.
- (3) Read each count register using the following procedure:
 - <1> Read the second, minute, hour, day, and week count registers in that order, and then read the second count register again.
 - <2> Compare the value of the second count register read first with the value of the second count register read second.
If the two values do not match, the chances are that the counter counted up while it was being read. If so, repeat steps <1> and <2> again.

- (4) Write data to each count setting register using the following procedure:
- To clear the sub-count register (SUBC)
 - <1> Using the procedure described in (3) above, read the values of all the count registers (this may be omitted), and clear RTCAE to 0.
 - <2> Write a value to one of the count setting registers. Write the value read in step <1> to the other count setting registers.
 - <3> Set RTCAE to 1. The values of the count setting registers will be transferred to the count registers, and the real-time counter will start counting (after 2 or 3 count clocks).
 - To not clear the sub-count register (SUBC) (to hold the value)
 - <1> Clear RTCE of RTC control register 1 (RTCC1) to 0, and check if RTCF of the RTCC1 register is cleared to 0 (count stops).
 - <2> Read the values of all the count registers (this may be omitted).
 - <3> Write a value to one of the count setting registers. Write the value read in <2> to the other count setting registers.
 - <4> Set RTCE to 1. The values of the count setting registers will be transferred to the count registers, and the real-time counter will start counting (after 2 or 3 count clocks).
- (5) To change the interrupt request signal generation timing, be sure to set the RTCMK bit of the RTCIC register to 1. After changing the timing, clear the RTCIF bit of the RTCIC register to 0.
- (6) To change the count clock, be sure to clear RTACE to 0.
- (7) Note the following points when setting the backup mode. If the backup mode is set in any other way, the operation cannot be guaranteed.
- Select the subclock (CKS bit = 0) as the count clock.
 - Do not generate the interrupt request signals (INTS3 to INTS0 bits = 0000B).
- Clear the backup mode before the week count register overflows. If the week count register overflows in the backup mode, the operation is not guaranteed.

CHAPTER 9 WATCHDOG TIMER FUNCTIONS

9.1 Functions

The watchdog timer has the following operation modes.

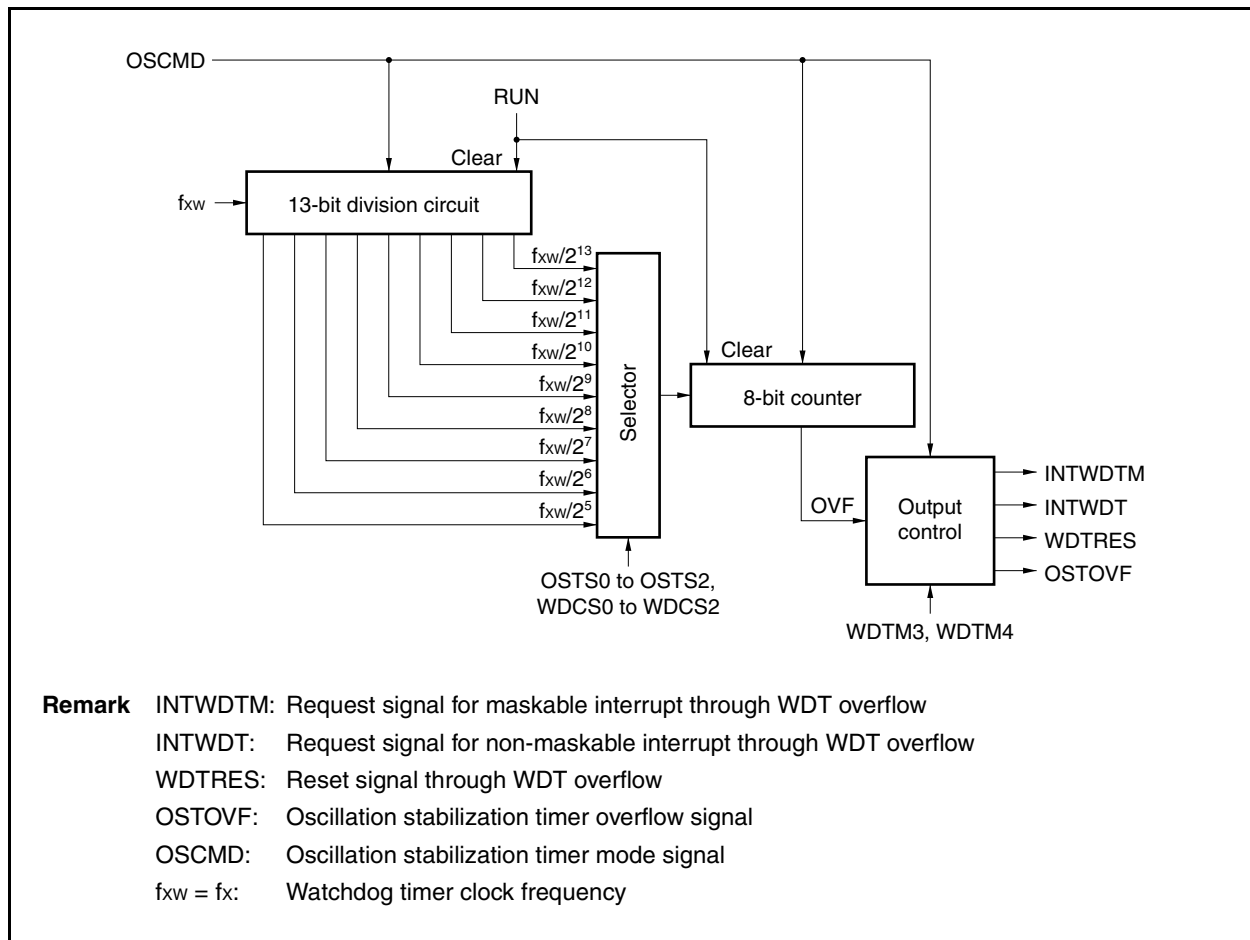
- Watchdog timer
- Interval timer
- Selecting the oscillation stabilization time

The following functions are realized from the above-listed operation modes.

- Generation of non-maskable interrupt request signal (INTWDT) upon overflow of watchdog timer
- Generation of system reset signal upon overflow of watchdog timer
- Generation of maskable interrupt request signal (INTWDTM) upon overflow of interval timer
- Securing of oscillation stabilization time for main system clock

Remark Select whether to use the watchdog timer in the watchdog timer mode or the interval timer mode using watchdog timer mode register (WDTM).

Figure 9-1. Block Diagram of Watchdog Timer



9.2 Configuration

The watchdog timer consists of the following hardware.

Table 9-1. Configuration of Watchdog Timer

Item	Configuration
Control register	Oscillation stabilization time selection register (OSTS) Watchdog timer clock selection register (WDCS) Watchdog timer mode register (WDTM)

9.3 Watchdog Timer Control Registers

The registers that control the watchdog timer are as follows.

- Oscillation stabilization time selection register (OSTS)
- Watchdog timer clock selection register (WDCS)
- Watchdog timer mode register (WDTM)

(1) Oscillation stabilization time selection register (OSTS)

This register selects the oscillation stabilization time following reset or release of the stop mode.

The OSTS register is set by an 8-bit or 1-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input sets OSTS to 01H.

After reset: 04H	R/W	Address: FFFFF6C0H					
OSTS	7 6 5 4 3 2 1 0	0 0 0 0 0 OSTS2 OSTS1 OSTS0					
	OSTS2	OSTS1	OSTS0	Selection of oscillation stabilization time			
				fx			
				17 MHz	13.5 MHz	8 MHz	
	0	0	0	$2^{14}/f_x$	Setting prohibited	Setting prohibited	2.048 ms
	0	0	1	$2^{16}/f_x$	3.855 ms	4.855 ms	8.192 ms
	0	1	0	$2^{17}/f_x$	7.710 ms	9.709 ms	16.38 ms
	0	1	1	$2^{18}/f_x$	15.42 ms	19.42 ms	32.77 ms
	1	0	0	$2^{19}/f_x$	30.84 ms	38.84 ms	65.54 ms
	1	0	1	$2^{20}/f_x$	61.68 ms	77.67 ms	131.1 ms
	1	1	0	$2^{21}/f_x$	123.4 ms	155.3 ms	262.1 ms
	1	1	1	$2^{22}/f_x$	246.7 ms	310.7 ms	524.3 ms

Caution Set the oscillation stabilization time to 1.5 ms or longer.

(2) Watchdog timer clock selection register (WDCS)

This register sets the overflow time of the watchdog timer and the interval timer.

The WDCS register is set by an 8-bit or 1-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input clears WDCS to 00H.

After reset: 00H R/W Address: FFFF6C1H

	7	6	5	4	3	2	1	0
WDCS	0	0	0	0	0	WDCS2	WDCS1	WDCS0

WDCS2	WDCS1	WDCS0	Overflow time of watchdog timer/interval timer	f_x		
				17 MHz	13.5 MHz	8 MHz
				0	0	0
0	0	1	$2^{15}/f_x$	1.928 ms	2.427 ms	4.096 ms
0	1	0	$2^{16}/f_x$	3.855 ms	4.855 ms	8.192 ms
0	1	1	$2^{17}/f_x$	7.710 ms	9.709 ms	16.38 ms
1	0	0	$2^{18}/f_x$	15.42 ms	19.42 ms	32.77 ms
1	0	1	$2^{19}/f_x$	30.84 ms	38.84 ms	65.54 ms
1	1	0	$2^{20}/f_x$	61.68 ms	77.67 ms	131.1 ms
1	1	1	$2^{22}/f_x$	246.7 ms	310.7 ms	524.3 ms

Remark $f_{xw} = f_x$: Watchdog timer clock frequency

(3) Watchdog timer mode register (WDTM)

This register sets the watchdog timer operation mode and enables/disables count operations.

This register is a special register that can be written only in a special sequence (refer to **3.4.8 Special registers**).

The WDTM register is set by an 8-bit or 1-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input clears WDTM to 00H.

After reset: 00H R/W Address: FFFFF6C2H

<7>	6	5	4	3	2	1	0
WDTM	RUN	0	0	WDTM4	WDTM3	0	0

RUN	Selection of watchdog timer operation mode ^{Note 1}
0	Stops counting
1	Clears counter and starts counting

WDTM4	WDTM3	Selection of watchdog timer operation mode ^{Note 2}
0	0	Interval timer mode
0	1	(Upon overflow, maskable interrupt INTWDTM is generated.)
1	0	Watchdog timer mode 1 (Upon overflow, non-maskable interrupt INTWDT is generated.)
1	1	Watchdog timer mode 2 (Upon overflow, reset operation WDTRES is started.)

Notes 1. Once the RUN bit is set (to 1), it cannot be cleared (to 0) by software.
Therefore, when counting is started, it cannot be stopped except through $\overline{\text{RESET}}$ input.

2. Once the WDTM3 and WDTM4 bits are set (to 1), they cannot be cleared (to 0) by software and can be cleared only through $\overline{\text{RESET}}$ input.

9.4 Operation

9.4.1 Operation as watchdog timer

Watchdog timer operation to detect a program loop is selected by setting bit 4 (WDTM4) of the watchdog timer mode register (WDTM) to 1.

The count clock (program loop detection time interval) of the watchdog timer can be selected with bits WDSC0 to WDSC2 of the watchdog timer clock selection register (WDSC). The count operation is started by setting bit 7 (RUN) of the WDTM register to 1. When, after the count operation is started, the RUN bit is again set to 1 within the set program loop detection time interval, the watchdog timer is cleared and the count operation starts again.

If the program loop detection time is exceeded without the RUN bit being set to 1, a reset (WDTRES) or a non-maskable interrupt request signal (INTWDT) is generated, depending on the value of bit WDTM3 of the WDTM register.

The count operation of the watchdog timer stops in the software STOP mode and IDLE mode. Therefore, set the RUN bit to 1 before the software STOP mode or IDLE mode is entered in order to clear the watchdog timer.

Because the watchdog timer operates in the HALT mode, do not use the watchdog timer when using the HALT mode.

Caution Once the WDTM4 bit is cleared to 0 (thereby selecting the interval timer mode), the watchdog timer mode is not entered as long as RESET is not input.
When the subclock is selected for the CPU clock, the count operation of the watchdog timer stops (the value of the watchdog timer is maintained).

Table 9-2. Program Loop Detection Time of Watchdog Timer

Clock	Program Loop Detection Time		
	$f_x = 17 \text{ MHz}$	$f_x = 13.5 \text{ MHz}$	$f_{xx} = 8 \text{ MHz}$
$2^{14}/f_x$	964 μs	1.214 ms	2.048 ms
$2^{15}/f_x$	1.928 ms	2.427 ms	4.096 ms
$2^{16}/f_x$	3.855 ms	4.855 ms	8.192 ms
$2^{17}/f_x$	7.710 ms	9.709 ms	16.38 ms
$2^{18}/f_x$	15.42 ms	19.42 ms	32.77 ms
$2^{19}/f_x$	30.84 ms	33.84 ms	65.54 ms
$2^{20}/f_x$	61.68 ms	77.67 ms	131.1 ms
$2^{22}/f_x$	246.7 ms	310.7 ms	524.3 ms

Remark $f_{xw} = f_x$: Watchdog timer clock frequency

9.4.2 Operation as interval timer

The watchdog timer can be made to operate as an interval timer that repeatedly generates interrupts using the count value set in advance as the interval, by setting bit 4 (WDTM4) of the watchdog timer mode register (WDTM) to 0.

When the watchdog timer operates as an interval timer, the interrupt mask flag (WDTMK) and priority specification flags (WDTPR0 to WDTPR2) of the WDTIC register are valid and maskable interrupt request signals (INTWDTM) can be generated. The default priority of the INTWDTM signal is set to the highest level among the maskable interrupt request signals.

The interval timer continues to operate in the HALT mode, but it stops operating in the software STOP mode and the IDLE mode. Therefore, set the RUN bit of the WDTM register to 1 before the software STOP mode or IDLE mode is entered in order to clear the interval timer.

- Cautions**
1. Once the WDTM4 bit is set to 1 (thereby selecting the watchdog timer mode), the interval timer mode is not entered as long as $\overline{\text{RESET}}$ is not input.
 2. When the subclock is selected for the CPU clock, the count operation of the watchdog timer stops (the value of the watchdog timer is maintained).

Table 9-3. Interval Time of Interval Timer

Clock	Interval Time		
	$f_x = 17 \text{ MHz}$	$f_x = 13.5 \text{ MHz}$	$f_{xx} = 8 \text{ MHz}$
$2^{14}/f_x$	964 μs	1.214 ms	2.048 ms
$2^{15}/f_x$	1.928 ms	2.427 ms	4.096 ms
$2^{16}/f_x$	3.855 ms	4.855 ms	8.192 ms
$2^{17}/f_x$	7.710 ms	9.709 ms	16.38 ms
$2^{18}/f_x$	15.42 ms	19.42 ms	32.77 ms
$2^{19}/f_x$	30.84 ms	33.84 ms	65.54 ms
$2^{20}/f_x$	61.68 ms	77.67 ms	131.1 ms
$2^{22}/f_x$	246.7 ms	310.7 ms	524.3 ms

Remark $f_{xw} = f_x$: Watchdog timer clock frequency

9.4.3 Oscillation stabilization time selection function

The wait time until the oscillation stabilizes after the STOP mode is released is controlled by the oscillation stabilization time register (OSTS).

The OSTS register is set by an 8-bit memory manipulation instruction.

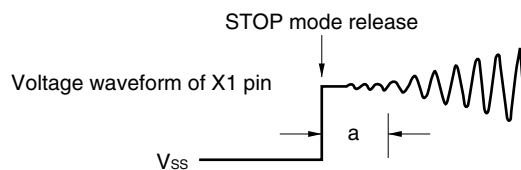
$\overline{\text{RESET}}$ input sets OSTS to 04H.

After reset: 04H R/W Address: FFFFF6C0H

	7	6	5	4	3	2	1	0
OSTS	0	0	0	0	0	OSTS2	OSTS1	OSTS0

OSTS2	OSTS1	OSTS0	Selection of oscillation stabilization time					
						f _x		
						17 MHz	13.5 MHz	8 MHz
0	0	0	2 ¹⁴ /f _x	Setting prohibited	Setting prohibited	2.048 ms		
0	0	1	2 ¹⁶ /f _x	3.855 ms	4.855 ms	8.192 ms		
0	1	0	2 ¹⁷ /f _x	7.710 ms	9.709 ms	16.38 ms		
0	1	1	2 ¹⁸ /f _x	15.42 ms	19.42 ms	32.77 ms		
1	0	0	2 ¹⁹ /f _x	30.84 ms	38.84 ms	65.54 ms		
1	0	1	2 ²⁰ /f _x	61.68 ms	77.67 ms	131.1 ms		
1	1	0	2 ²¹ /f _x	123.4 ms	155.3 ms	262.1 ms		
1	1	1	2 ²² /f _x	246.7 ms	310.7 ms	524.3 ms		

Cautions 1. The wait time following release of the software STOP mode does not include the time until the clock oscillation starts (“a” in the figure below) following release of the software STOP mode, regardless of whether the STOP mode is released through $\overline{\text{RESET}}$ input or the occurrence of an interrupt request signal.



2. Be sure to set bits 3 to 7 to 0.
3. Set the oscillation stabilization time to 1.5 ms or longer.
4. The oscillation stabilization time following reset release is 2¹⁹/f_x (because the initial value of the OSTS register = 04H).

Remark f_x = Main clock frequency

CHAPTER 10 A/D CONVERTER

10.1 Function

The A/D converter converts analog input signals into digital values with a resolution of 10 bits. In the V850ES/SA2, it has a 12-channel (ANI0 to ANI11) configuration, and in the V850ES/SA3, it has a 16-channel (ANI0 to ANI15) configuration.

The features of the A/D converter are shown below.

- 10-bit resolution
- 12 channels (V850ES/SA2)
16 channels (V850ES/SA3)
- Successive approximation method
- Power fail detection function
- Operating voltage: $AV_{DD} = AV_{REF0} = 2.2$ to 2.7 V
- Analog input voltage: AV_{SS} to AV_{REF0}
- Conversion rate: 9.5 to $150 \mu\text{s}$

The block diagram is shown below.

Figure 10-1. Block Diagram of A/D Converter

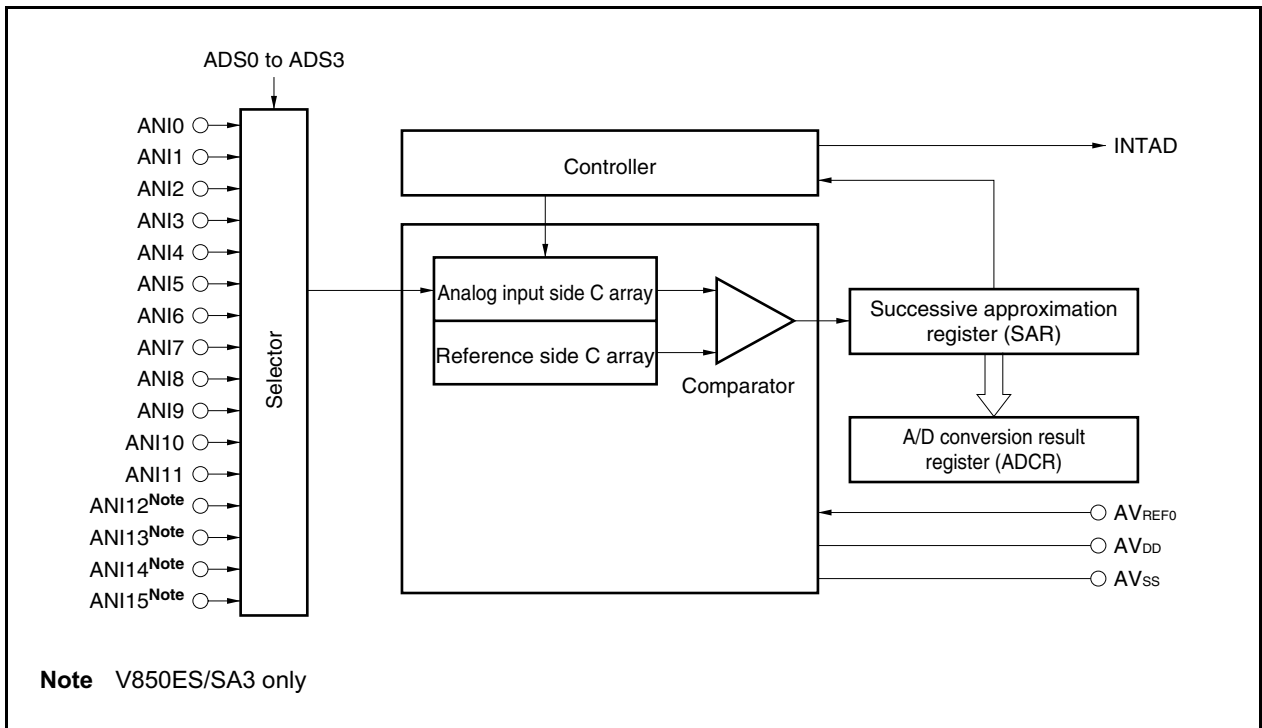
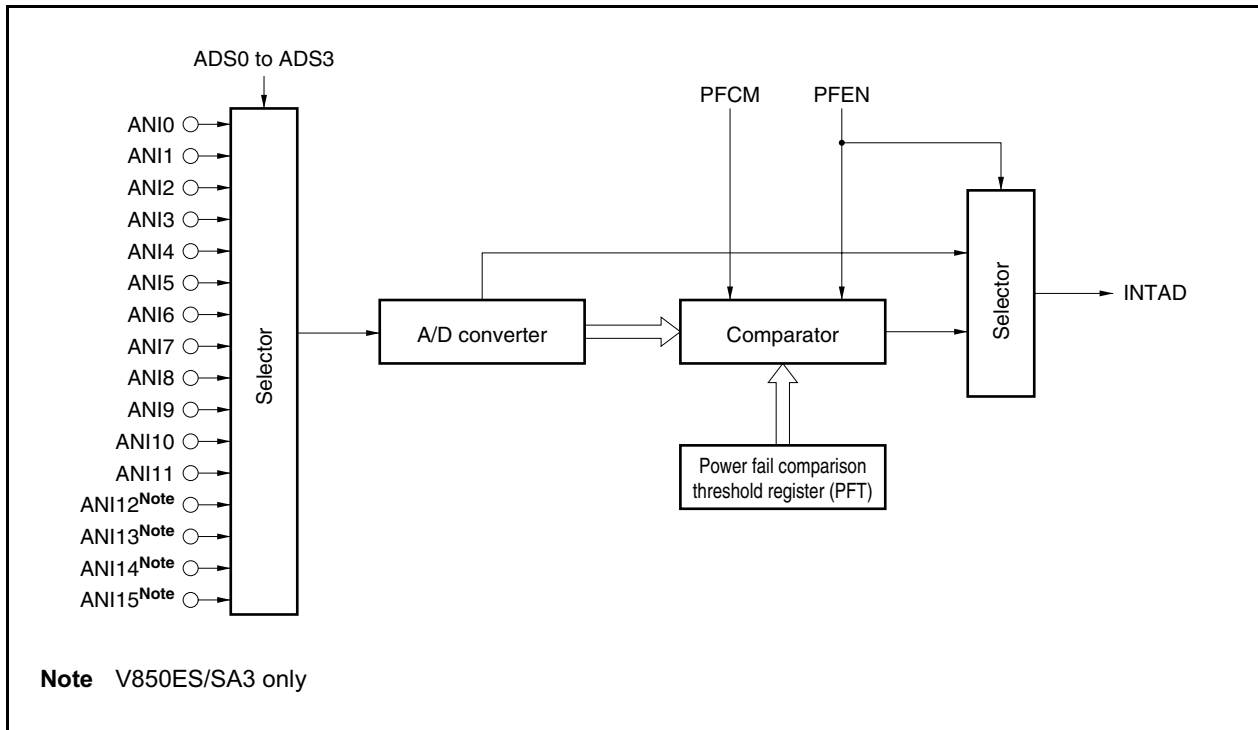


Figure 10-2. Block Diagram of Power Fail Detection Function



10.2 Configuration

The A/D converter consists of the following hardware.

Table 10-1. Configuration of A/D Converter

Item	Configuration
Analog input	12 channels (AN10 to AN11): V850ES/SA2 16 channels (AN10 to AN15): V850ES/SA3
Registers	Successive approximation register (SAR) A/D conversion result register (ADCR) A/D conversion result register H (ADCRH): Only higher 8 bits can be read Power fail comparison threshold register (PFT)
Control registers	A/D converter mode register (ADM) Analog input channel specification register (ADS) Power fail comparison mode register (PFM)

(1) Successive approximation register (SAR)

This register compares the voltage value of the analog input signal with the voltage tap (compare voltage) value from the series resistor string, and holds the comparison result starting from the most significant bit (MSB).

When the comparison result has been saved down to the least significant bit (LSB) (A/D conversion completion), the contents of the SAR are transferred to the A/D conversion result register.

(2) A/D conversion result register (ADCR), A/D conversion result register (ADCRH)

Each time A/D conversion has been completed, the result of the conversion is loaded to this register from the successive approximation register, and the higher 10 bits of this register hold the result of the A/D conversion (the lower 6 bits are fixed to 0).

The ADCR register is read by a 16-bit memory manipulation instruction. $\overline{\text{RESET}}$ input sets ADCR to 0000H.

When using only the higher 8 bits of the A/D conversion result, the ADCRH register is read by an 8-bit memory manipulation instruction. $\overline{\text{RESET}}$ input clears ADCRH to 00H.

Caution When data is written to the A/D converter mode register (ADM) or analog input channel specification register (ADS), the contents of the ADCR register may become undefined. Read the conversion result after completion of conversion and before writing data to the ADM and ADS registers. Otherwise, the correct conversion result may not be read.

(3) Power fail comparison threshold register (PFT)

This register sets the threshold when comparing with the A/D conversion result register.

The 8-bit data set in the PFT register and the higher 8 bits (ADCRH) of the A/D conversion result register are compared.

The PFT register is read and written by an 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input clears PFT to 00H.

(4) Sample & hold circuit

The sample & hold circuit samples each of the analog input signals sequentially sent from the input circuit and sends the sampled data to the voltage comparator. This circuit holds the sampled analog input voltage during A/D conversion.

(5) Voltage comparator

The voltage comparator compares the analog input signal with the output voltage of the series resistor string.

(6) Series resistor string

The series resistor string is connected between AV_{REF0} and AV_{SS} and generates a voltage for comparison with the analog input signal.

(7) ANI0 to ANI15 pins^{Note}

These are analog input pins for the 16 channels^{Note} of the A/D converter that are used to input analog signals to be converted into digital signals. Pins other than those selected as analog input with the analog input channel specification register (ADS) can be used as input ports.

Note The V850ES/SA2 provides only 12 channels, ANI0 to ANI11.

Caution Make sure that the voltage input to ANI0 to ANI15 does not exceed the rated values. If a voltage higher than AV_{REF0} or lower than AV_{SS} (even within the absolute maximum ratings) is input to a channel, the conversion value of the channel is undefined and the conversion values of the other channels may also be affected.

(8) AV_{REF0} pin

This is the reference voltage input pin of the A/D converter. The signals input to the ANI0 to ANI15 or ANI0 to ANI11 pins are converted into digital signals based on the voltage applied across AV_{REF0} and AV_{SS} .

(9) AV_{DD} pin

This is the analog power supply pin of the A/D converter. Always use the same potential as the V_{DD} pin even when not using the A/D converter.

(10) AV_{SS} pin

This is the ground potential pin of the A/D converter. Always use the same potential as the V_{SS} pin even when not using the A/D converter.

10.3 Control Registers

The A/D converter is controlled by the following registers.

- A/D converter mode register (ADM)
- Analog input channel specification register (ADS)
- Power fail comparison mode register (PFM)

(1) A/D converter mode register (ADM)

This register sets the conversion time of the analog input signal to be converted into a digital signal as well as conversion start and stop.

The ADM register is set by an 8-bit or 1-bit memory manipulation instruction.

RESET input clears ADM to 00H.

After reset: 00H R/W Address: FFFFF200H

	7	6	5	4	3	2	1	0
ADM	ADCS	0	FR3	FR2	FR1	FR0	0	0

ADCS	A/D conversion control
0	Stops conversion
1	Enables conversion

FR3	FR2	Number of A/D conversion clocks
0	0	19 clocks
0	1	Setting prohibited
1	0	Setting prohibited
1	1	33 clocks

FR1	FR0	A/D conversion clock
0	0	$f_{xx}/16$
0	1	$f_{xx}/8$
1	0	$f_{xx}/4$
1	1	Clock of prescaler 3 (f_{BRG})

Notes 1. Set the FR3 and FR2 bits as follows:

- $V_{DD} = AV_{DD} = 2.0$ to 2.7 V: FR3, FR2 = 00B
- $V_{DD} = AV_{DD} = 1.8$ to 2.0 V: RR3, FR2 = 11B

2. f_{BRG} output (refer to **6.3 Prescaler 3**) is alternated with the main clock divider of the real-time counter. To use f_{BRG} output as the conversion clock of the A/D converter, therefore, clear the CKS bit of RTC control register 0 (RTCC0) (refer to **8.2 (1)**) to 0.

An A/D conversion operation can be used to output the f_{BRG} clock in the IDLE mode. To reduce the current consumption, clear the BGCE bit of the prescaler mode register (PRSM) (refer to **6.5.1 (1)**) and ADCS bit of the ADM register to 0.

Caution Be sure to clear bits 6, 1, and 0 to 0.

Remark Refer to **Table 10-2** for an example of setting the A/D conversion time.

Table 10-2. Example of A/D Conversion Time Setting

FR3	FR2	FR1	FR0	A/D Conversion Time	$f_{xx} = 17 \text{ MHz}$	$f_{xx} = 13.5 \text{ MHz}$	$f_{xx} = 8 \text{ MHz}$	$f_{xx} = 2 \text{ MHz}$
0	0	0	0	$304/f_{xx}$	$17.9 \mu\text{s}$	$22.5 \mu\text{s}$	$38 \mu\text{s}$	Setting prohibited
0	0	0	1	$152/f_{xx}$	Setting prohibited	$11.3 \mu\text{s}$	$19 \mu\text{s}$	$76 \mu\text{s}$
0	0	1	0	$76/f_{xx}$	Setting prohibited	Setting prohibited	$9.5 \mu\text{s}$	$38 \mu\text{s}$
0	0	1	1	$190/f_{xx}$ ^{Note 1}	$11.2 \mu\text{s}$	$14.1 \mu\text{s}$	$23.75 \mu\text{s}$	$95 \mu\text{s}$
1	1	0	0	$528/f_{xx}$	Setting prohibited	$39.1 \mu\text{s}$	$66 \mu\text{s}$	Setting prohibited
1	1	0	1	$264/f_{xx}$	Setting prohibited	Setting prohibited	$33 \mu\text{s}$	$132 \mu\text{s}$
1	1	1	0	$132/f_{xx}$	Setting prohibited	Setting prohibited	Setting prohibited	$66 \mu\text{s}$
1	1	1	1	$660/f_{xx}$ ^{Note 2}	Setting prohibited	$48.9 \mu\text{s}$	$82.5 \mu\text{s}$	Setting prohibited
Other than above				Setting prohibited				

Notes 1. When PRSM = 10H, PRSCM = 05H (Refer to 6.5 Prescaler 3.)

2. When PRSM = 11H, PRSCM = 05H (Refer to 6.5 Prescaler 3.)

Cautions 1. Set the A/D conversion time within the following ranges. The operation is not guaranteed if these ranges are exceeded.

- $V_{DD} = AV_{DD} = 2.0 \text{ to } 2.7 \text{ V}$: $9.5 \text{ to } 150 \mu\text{s}$
- $V_{DD} = AV_{DD} = 1.8 \text{ to } 2.7 \text{ V}$: $26.4 \text{ to } 150 \mu\text{s}$

2. Set the FR3 and FR2 bits as follows:

- $V_{DD} = AV_{DD} = 2.0 \text{ to } 2.7 \text{ V}$: FR3, FR2 = 00B
- $V_{DD} = AV_{DD} = 1.8 \text{ to } 2.0 \text{ V}$: FR3, FR2 = 11B

(2) Analog input channel specification register (ADS)

This register specifies the analog voltage input port to be A/D converted.

The ADS register is set by an 8-bit or 1-bit memory manipulation.

RESET input clears ADS to 00H.

After reset: 00H R/W Address: FFFF201H

	7	6	5	4	3	2	1	0
ADS	0	0	0	0	ADS3	ADS2	ADS1	ADS0

ADS3	ADS2	ADS1	ADS0	Specification of analog input channel
0	0	0	0	ANI0
0	0	0	1	ANI1
0	0	1	0	ANI2
0	0	1	1	ANI3
0	1	0	0	ANI4
0	1	0	1	ANI5
0	1	1	0	ANI6
0	1	1	1	ANI7
1	0	0	0	ANI8
1	0	0	1	ANI9
1	0	1	0	ANI10
1	0	1	1	ANI11
1	1	0	0	ANI12 ^{Note}
1	1	0	1	ANI13 ^{Note}
1	1	1	0	ANI14 ^{Note}
1	1	1	1	ANI15 ^{Note}
Other than above				Setting prohibited

Note The ANI12 to ANI15 channels are available only in the V850ES/SA3. In the V850ES/SA2, setting these channels is prohibited.

(3) Power fail comparison mode register (PFM)

This register sets the power fail monitoring mode.

It compares the value of the power fail comparison threshold register (PFT) and the value of the A/D conversion result register (ADCRH).

The PFM register is set by an 8-bit or 1-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input clears PFM to 00H.

After reset: 00H		R/W	Address: FFFFF202H					
	7	6	5	4	3	2	1	0
PFM	PFEN	PFCM	0	0	0	0	0	0
	PFEN	Selection of power fail comparison enable/disable						
	0	Disables power fail comparison						
	1	Enables power fail comparison						
	PFCM	Selection of power fail comparison mode						
	0	Generates interrupt request signal (INTAD) when ADCR \geq PFT						
	1	Generates interrupt request signal (INTAD) when ADCR $<$ PFT						

10.4 Operation

10.4.1 Conversion operation

- Setting ADCS of the A/D converter mode register (ADM) to 1 starts conversion of the signal input to the channel specified by the analog input channel specification register (ADS). Upon completion of the conversion, the conversion result is stored in the A/D conversion result register (ADCR) and a new conversion starts.
- If ADM, ADS, the power fail comparison threshold register (PFT), or the power fail comparison mode register (PFM) is written during conversion, conversion is interrupted and the conversion operation starts again from the beginning.
- If ADCS is set to 0 during conversion, conversion is interrupted and the conversion operation is stopped.
- For whether or not the conversion end interrupt request signal (INTAD) is generated, refer to **10.4.2**.

10.4.2 Conversion operation (power fail monitoring function)

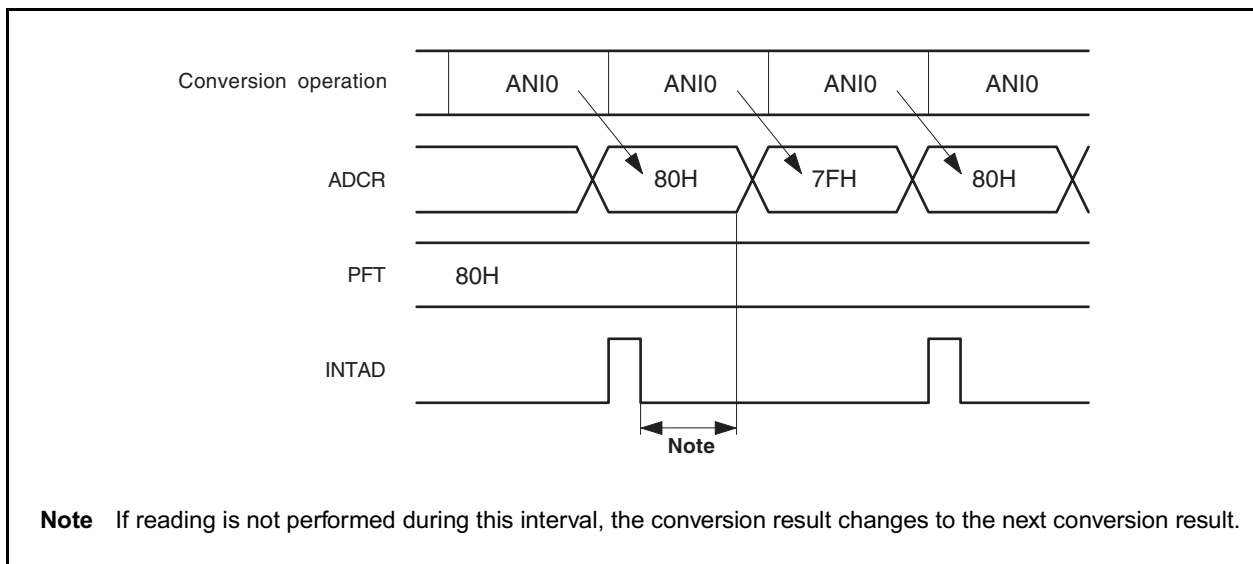
The conversion end interrupt request signal (INTAD) can be controlled as follows using the PFM and PFT registers.

Table 10-3. INTAD Signal Control

PFM Register		Operation
PFEN Bit	PFCM Bit	
0	Don't care	INTAD signal is output each time A/D conversion ends
1	0	INTAD signal is output only if conversion result (ADCRH) \geq PFT
1	1	INTAD signal is output only if conversion result (ADCRH) $<$ PFT

Remark When PFEN = 1, because the conversion result is overwritten after INTAD has been output unless the conversion result is read by the time the next conversion ends, in some cases it may appear as if the actual operation differs from the operation described above (refer to **Figure 10-3**).

Figure 10-3. Power Fail Monitoring Function (PFCM = 0)



CHAPTER 11 D/A CONVERTER

11.1 Functions

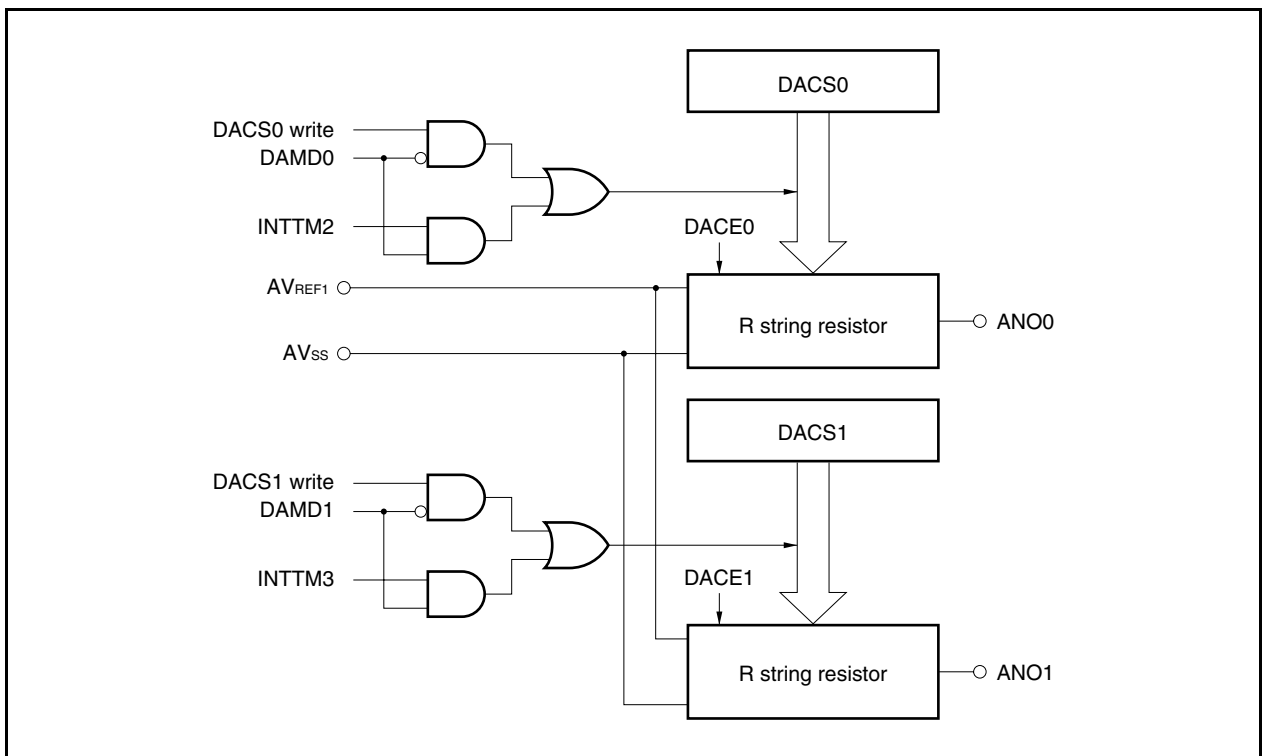
The D/A converter has the following functions.

- 8-bit resolution × 2 channels (DAC0, DAC1)
- R string method
- Conversion time: 20 μs max. ($AV_{REF1} = 2.2$ to 2.7 V)
- Analog output voltage: $AV_{REF1} \times m/256$ ($m = 0$ to 255; value set to DACSn register)
- Operation modes: Normal mode, real-time output mode

Remark $n = 0, 1$

The D/A converter configuration is shown below.

Figure 11-1. Block Diagram of D/A Converter



11.2 Configuration

The D/A converter consists of the following hardware.

Table 11-1. Configuration of D/A Converter

Item	Configuration
Control registers	D/A converter mode register (DAM) D/A conversion value setting registers 0 and 1 (DACS0 and DACS1)

11.3 D/A Converter Control Registers

The registers that control the D/A converter are as follows.

- D/A converter mode register (DAM)
- D/A conversion value setting registers 0 and 1 (DACS0 and DACS1)

(1) D/A converter mode register (DAM)

This register controls the operation of the D/A converter.

DAM is set by an 8-bit or 1-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input clears DAM to 00H.

After reset: 00H		R/W	Address: FFFF284H					
	7	6	5	4	3	2	1	0
DAM	0	0	0	0	DAMD1	DACE1	DAMD0	DACE0
DAMDn	Selection of D/A converter operation mode (n = 0, 1)							
0	Normal mode							
1	Real-time output mode ^{Note}							
DACEn	D/A converter operation enable/disable control (n = 0, 1)							
0	Disables operation							
1	Enables operation							

Note The output trigger in the real-time output mode (DAMDn bit = 1) is as follows.

- When n = 0: INTTM2 signal (refer to 7.2 8-Bit Timer/Event Counters 2 to 5)
- When n = 1: INTTM3 signal (refer to 7.2 8-Bit Timer/Event Counters 2 to 5)

(2) D/A conversion value setting registers 0 and 1 (DACS0 and DACS1)

These registers set the analog voltage value output to the ANO0 and ANO1 pins.

These registers are set by an 8-bit memory manipulation instruction.

RESET input clears DACS0 and DACS1 to 00H.

After reset: 00H R/W Address: DACS0: FFFFF280H, DACS1: FFFFF282H

	7	6	5	4	3	2	1	0
DACS _n	DA7	DA6	DA5	DA4	DA3	DA2	DA1	DA0

Caution In the real-time output mode (DAMD_n bit = 1), set the DACS_n register before the INTTM2/INTTM3 signals are generated. D/A conversion starts when the INTTM2/INTTM3 signals are generated.

Remark n = 0, 1

11.4 Operation

11.4.1 Operation in normal mode

D/A conversion is performed using a write operation to D/A conversion value setting register n (DACSn) as the trigger.

The setting method is described below.

- <1> Set the DAMDn bit of the D/A converter mode register (DAM) to 0 (normal mode).
- <2> Set the analog voltage value to be output to the ANOn pin to the DACSn register.
Steps <1> and <2> above constitute the initial settings.
- <3> Set the DACEn bit of the DAM register to 1 (D/A conversion enable).
D/A conversion starts when this setting is performed.
- <4> To perform subsequent D/A conversions, write to the DACSn register.
The previous D/A conversion result is held until the next D/A conversion is performed.

Remark n = 0, 1

11.4.2 Operation in real-time output mode

D/A conversion is performed using the interrupt request signals (INTTM2 and INTTM3) of 8-bit timer/event counters 2 and 3 (TM2 and TM3) as triggers.

The setting method is described below.

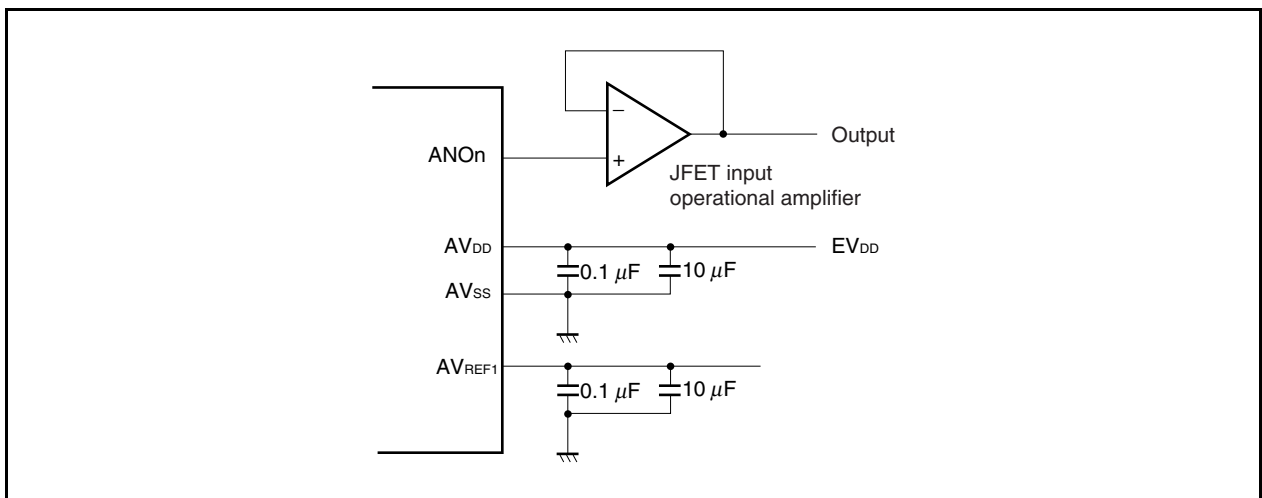
- <1> Set the DAMDn bit of the DAM register to 1 (real-time output mode).
- <2> Set the analog voltage value to be output to the ANOn pin to the DACSn register.
- <3> Set the DACEn bit of the DAM register to 1 (D/A conversion enable).
Steps <1> to <3> above constitute the initial settings.
- <4> Operate 8-bit timer/event counters 2 and 3 (TM2 and TM3).
- <5> D/A conversion starts when the INTTM2 and INTTM3 signals are generated.
- <6> The INTTM2 and INTTM3 signals are generated when subsequent D/A conversions are performed.
Before performing the next D/A conversion (generation of INTTM2 and INTTM3 signals), set the analog voltage value to be output to the ANOn pin to the DACSn register.

11.4.3 Cautions

Observe the following cautions when using the D/A converter of the V850ES/SA2 and V850ES/SA3.

- (1) Do not change the set value of the DACSn register while the trigger signal is being issued in the real-time output mode.
- (2) Before changing the operation mode, be sure to clear DACEn to 0.
- (3) When using the P80/ANO0 and P81/ANO1 pins as port pins, make sure that their input level does not change much.
- (4) Make sure that $V_{DD} = EV_{DD} = AV_{DD} = AV_{REF1} = 2.2$ to 2.7 V. If this range is exceeded, the operation is not guaranteed.
- (5) Apply power to AV_{DD} at the same timing as V_{DD} .
- (6) No current can be output from the ANOn pin ($n = 0, 1$) because the output impedance of the D/A converter is high. When connecting a resistor of $5\text{ M}\Omega$ or less, insert a JFET input operational amplifier between the resistor and the ANOn pin.

Figure 11-2. External Pin Connection Example



CHAPTER 12 SERIAL INTERFACE FUNCTION

12.1 Features

The serial interface function provides three types of serial interfaces combining a total of seven or eight transmit/receive channels. Five or six of these channels can be used simultaneously.

The three interface formats are as follows.

- (1) Asynchronous serial interface (UART_m): 2 channels
- (2) Clocked serial interface (CSIn): 4 channels (V850ES/SA2)
5 channels (V850ES/SA3)
- (3) I²C bus interface (I²C)^{Note}: 1 channel

UART_m, in which one byte of serial data is transmitted/received following a start bit, supports full-duplex communication.

CSIn performs data transfer using three types of signals: a serial clock ($\overline{\text{SCK}}_n$), serial input (SIn), and serial output (SOn) (3-wire serial I/O).

I²C transfers 8-bit data with two or more devices by using two lines, serial clock (SCL) and serial data bus (SDA)^{Note}.

Note μ PD703201Y, 703204Y, 70F3201Y, 70F3204Y

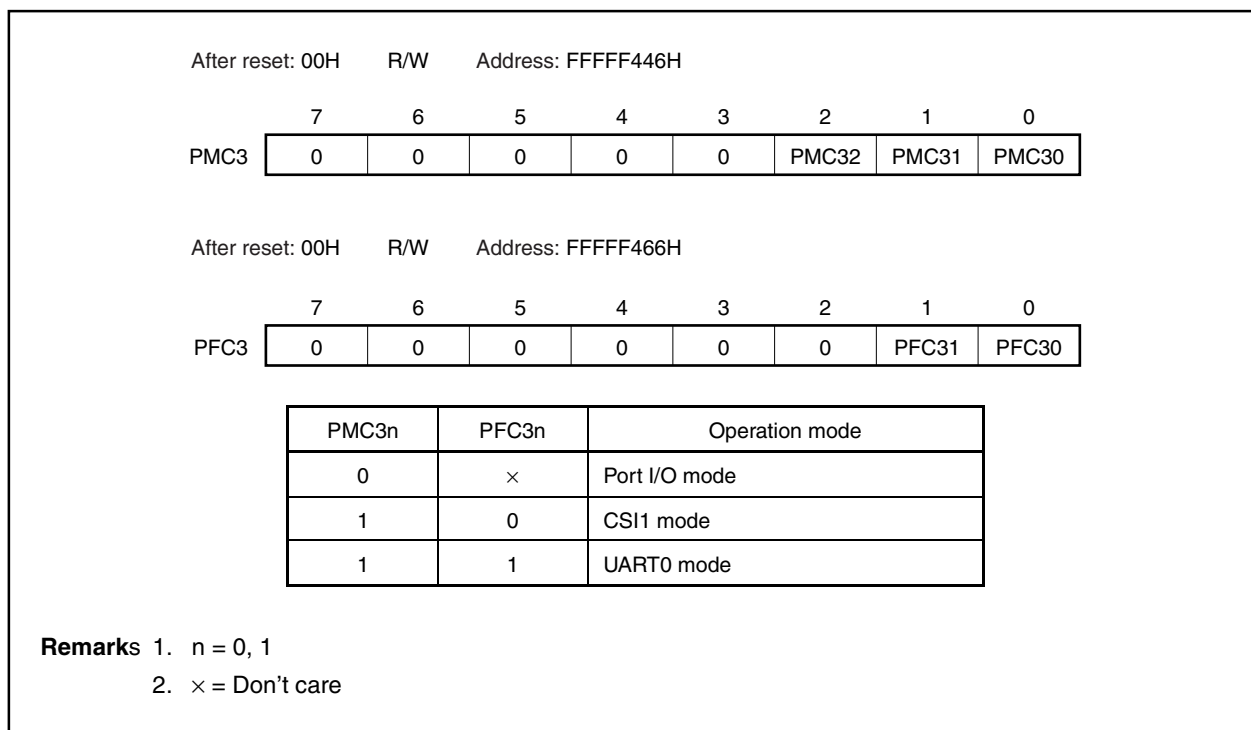
Remark n: n = 0 to 3 (V850ES/SA2), n = 0 to 4 (V850ES/SA3)
m: 0, 1

12.1.1 Selecting CSI1 or UART0 mode

CSI1 and UART0 of the V850ES/SA2 and V850ES/SA3 share pins, and therefore these interfaces cannot be used at the same time. Select CSI1 or UART0 in advance by using port mode control register 3 (PMC3) and port function control register 3 (PFC3) (refer to 4.3.3 Port 3).

Caution CSI1 or UART0 transmission/reception operations are not guaranteed if the mode is changed during transmission or reception. Be sure to disable the operation of the unit that is not used.

Figure 12-1. Selecting CSI1 or UART0 Mode



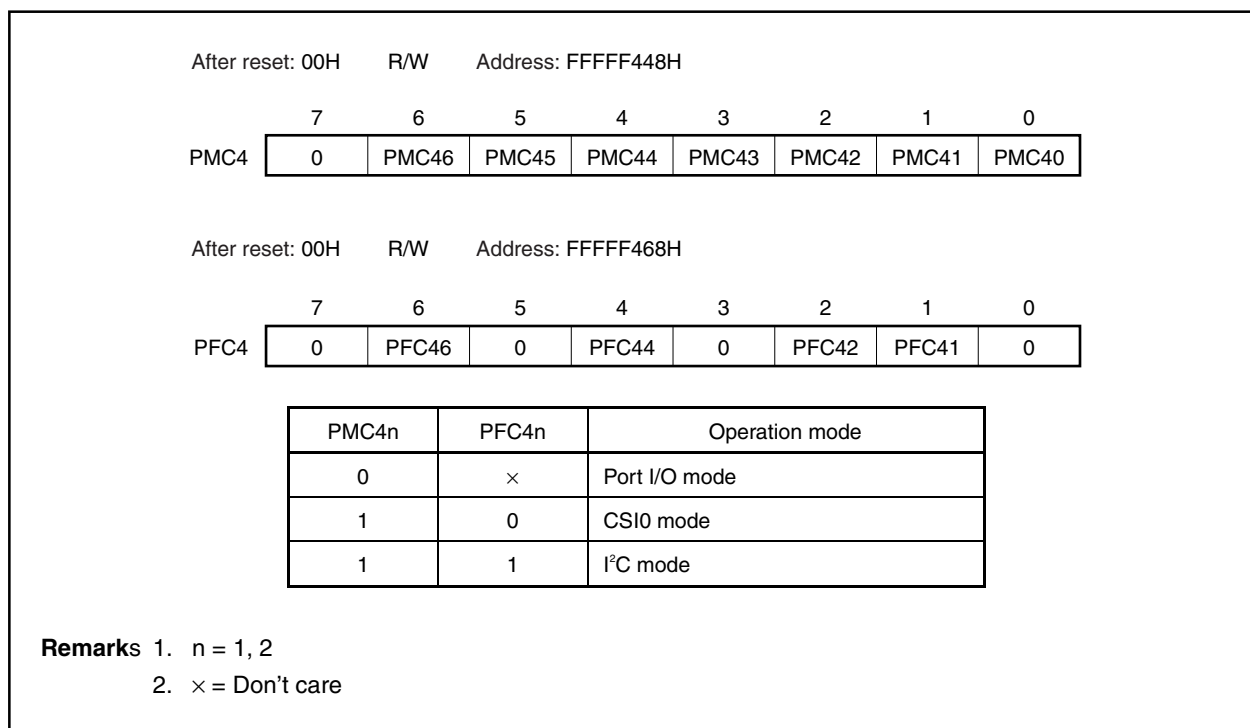
12.1.2 Selecting CSI0 or I²C mode

CSI0 and I²C of the V850ES/SA2 and V850ES/SA3 share pins, and therefore these interfaces cannot be used at the same time. Select CSI0 or I²C in advance by using port mode control register 4 (PMC4) and port function control register 4 (PFC4) (refer to 4.3.5 Port 4).

Cautions 1. CSI0 or I²C transmission/reception operations are not guaranteed if the mode is changed during transmission or reception. Be sure to disable the operation of the unit that is not used.

2. I²C: μ PD703201Y, 703204Y, 70F3201Y, and 70F3204Y only

Figure 12-2. Selecting CSI0 or I²C Mode



12.2 Asynchronous Serial Interface n (UARTn)

12.2.1 Features

- Transfer rate: 300 bps to 312.5 kbps (using a dedicated baud rate generator and an internal system clock of 17 MHz)
- Full-duplex communications
 - On-chip receive buffer register n (RXBn)
 - On-chip transmit buffer register n (TXBn)
- Two-pin configuration^{Note}
 - TXDn: Transmit data output pin
 - RXDn: Receive data input pin
- Reception error detection functions
 - Parity error
 - Framing error
 - Overrun error
- Interrupt sources: 3 types
 - Reception error interrupt (INTSREn): Interrupt is generated according to the logical OR of the three types of reception errors
 - Reception completion interrupt (INTSRn): Interrupt is generated when receive data is transferred from the shift register to receive buffer register n after serial transfer is completed during a reception enabled state
 - Transmission completion interrupt (INTSTn): Interrupt is generated when the serial transmission of transmit data (8 or 7 bits) from the shift register is completed
- The character length of transmit/receive data is specified by the ASIMn register
- Character length: 7 or 8 bits
- Parity functions: Odd, even, 0, or none
- Transmission stop bits: 1 or 2 bits
- On-chip dedicated baud rate generator

Remark n = 0, 1

12.2.2 Configuration

UARTn is controlled by asynchronous serial interface mode register n (ASIMn), asynchronous serial interface status register n (ASISn), and asynchronous serial interface transmission status register n (ASIFn). Receive data is maintained in receive buffer register n (RXBn), and transmit data is written to transmit buffer register n (TXBn).

Figure 12-3 shows the configuration of asynchronous serial interface n (UARTn).

(1) Asynchronous serial interface mode register n (ASIMn)

The ASIMn register is an 8-bit register for specifying the operation of the asynchronous serial interface.

(2) Asynchronous serial interface status register n (ASISn)

The ASISn register consists of a set of flags that indicate the error contents when a reception error occurs. The various reception error flags are set (1) when a reception error occurs and are reset (0) when the ASISn register is read.

(3) Asynchronous serial interface transmission status register n (ASIFn)

The ASIFn register is an 8-bit register that indicates the status when a transmit operation is performed.

This register consists of a transmit buffer data flag, which indicates the hold status of TXBn data, and the transmit shift register data flag, which indicates whether transmission is in progress.

(4) Reception control parity check

The receive operation is controlled according to the contents set in the ASIMn register. A check for parity errors is also performed during a receive operation, and if an error is detected, a value corresponding to the error contents is set in the ASISn register.

(5) Receive shift register

This is a shift register that converts the serial data that was input to the RXDn pin into parallel data. One byte of data is received, and if a stop bit is detected, the receive data is transferred to receive buffer register n (RXBn).

This register cannot be directly manipulated.

(6) Receive buffer register n (RXBn)

RXBn is an 8-bit buffer register for holding receive data. When 7 characters are received, 0 is stored in the MSB.

During a reception enabled state, receive data is transferred from the receive shift register to RXBn, synchronized with the end of the shift-in processing of one frame.

Also, the reception completion interrupt request (INTSRn) is generated by the transfer of data to RXBn.

(7) Transmit shift register

This is a shift register that converts the parallel data that was transferred from transmit buffer register n (TXBn) into serial data.

When one byte of data is transferred from TXBn, the shift register data is output from the TXDn pin.

This register cannot be directly manipulated.

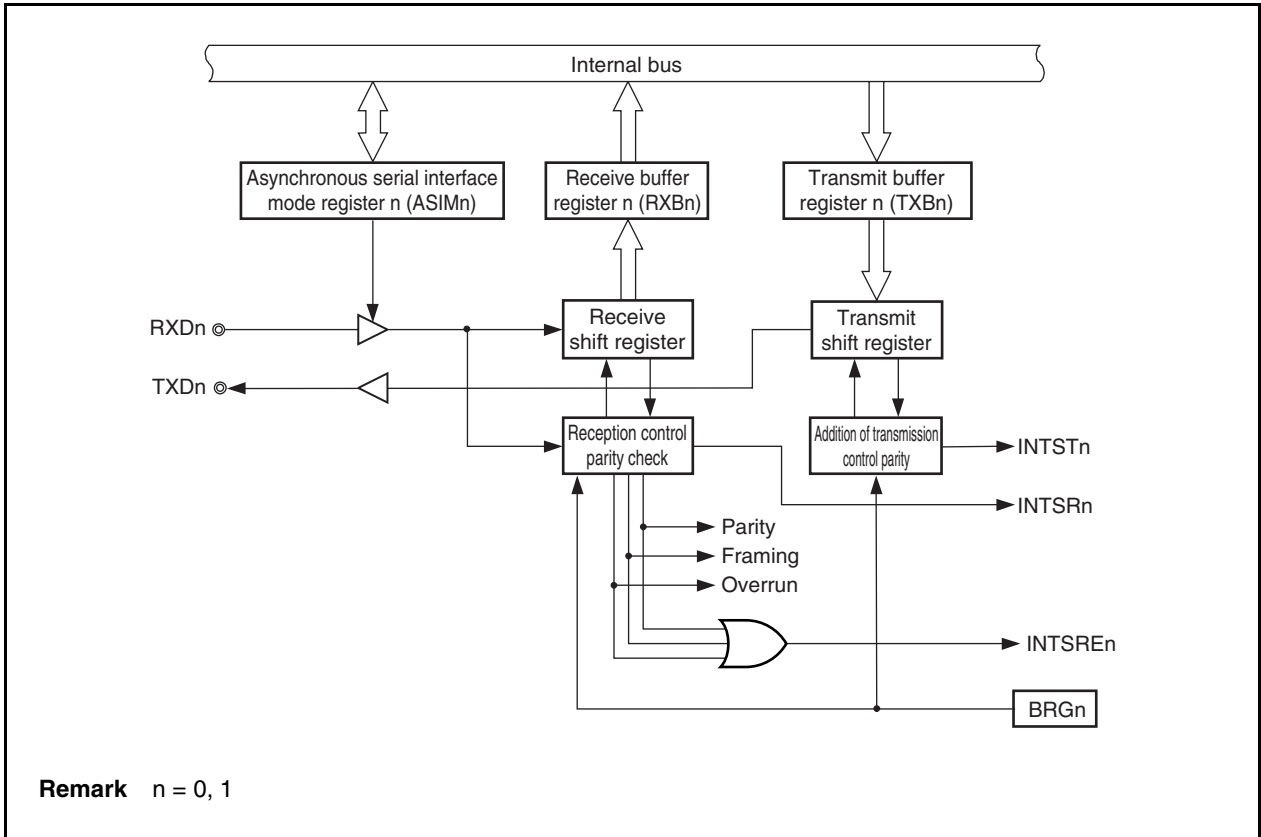
(8) Transmit buffer register n (TXBn)

TXBn is an 8-bit buffer for transmit data. A transmit operation is started by writing transmit data to TXBn. The transmission completion interrupt request (INTSTn) is generated synchronized with the completion of transmission of one frame.

(9) Addition of transmission control parity

A transmit operation is controlled by adding a start bit, parity bit, or stop bit to the data that is written to the TXBn register, according to the contents that were set in the ASIMn register.

Figure 12-3. Asynchronous Serial Interface n Block Diagram



12.2.3 Control registers

(1) Asynchronous serial interface mode register n (ASIMn)

The ASIMn register is an 8-bit register that controls the UARTn transfer operation. This register can be read or written in 8-bit or 1-bit units.

Caution When using UARTn, be sure to set the external pins related to UARTn functions to the control mode before setting clock select register n (CKSRn) and baud rate generator control register n (BRGCn), and then set the UARTCAEn bit to 1. Then set the other bits.

(1/3)

After reset: 01H R/W Address: FFFFFFFA00H, FFFFFFFA10H

	7	<6>	<5>	4	3	2	1	0
ASIMn	UARTCAEn	TXEn	RXEn	PSn1	PSn0	CLn	SLn	ISRMn

UARTCAEn	Controls the operating clock
0	Stops clock supply to UARTn.
1	Supplies clock to UARTn.
<ul style="list-style-type: none"> • If UARTCAEn = 0, UARTn is asynchronously reset. • If UARTCAEn = 0, UARTn is reset. To operate UARTn, first set UARTCAEn to 1. • If the UARTCAEn bit is changed from 1 to 0, all the registers of UARTn are initialized. To set UARTCAEn to 1 again, be sure to re-set the registers of UARTn. • The output of the TXDn pin goes high when transmission is disabled, regardless of the setting of the UARTCAEn bit. 	

TXEn	Enables/disables transmission
0	Disables transmission
1	Enables transmission
<ul style="list-style-type: none"> • Set the TXEn bit to 1 after setting the UARTCAEn bit to 1 at startup. Set the UARTCAEn bit to 0 after setting the TXEn bit to 0 to stop. • To initialize the transmission unit, clear (0) the TXEn bit, and after letting 2 Clock cycles (base clock) elapse, set (1) the TXEn bit again. If the TXEn bit is not set again, initialization may not be successful. (For details of the base clock, refer to 12.2.6 (1) (a) Base clock (Clock).) 	

RXEn	Enables/disables reception
0	Disables reception
1	Enables reception

- Set the RXEn bit to 1 after setting the UARTCAEn bit to 1 at startup. Set the UARTCAEn bit to 0 after setting the RXEn bit to 0 to stop.
- To initialize the reception unit status, clear (0) the RXEn bit, and after letting 2 Clock cycles (base clock) elapse, set (1) the RXEn bit again. If the RXEn bit is not set again, initialization may not be successful. (For details of the base clock, refer to **12.2.6 (1) (a) Base clock (Clock).**)

PSn1	PSn0	Transmit operation	Receive operation
0	0	Parity bit not output	Receive with no parity
0	1	Output 0 parity	Receive as 0 parity
1	0	Output odd parity	Judge as odd parity
1	1	Output even parity	Judge as even parity

- To overwrite the PS1 and PS0 bits, first clear (0) the TXEn and RXEn bits.
- If "0 parity" is selected for reception, no parity judgment is performed. Therefore, no error interrupt is generated because the PE bit of the ASISn register is not set.

Remarks 1. When reception is disabled, the receive shift register does not detect a start bit. No shift-in processing or transfer processing to receive buffer register n (RXBn) is performed, and the contents of the RXBn register are retained.

When reception is enabled, the receive shift operation starts, synchronized with the detection of the start bit, and when the reception of one frame is completed, the contents of the receive shift register are transferred to the RXBn register. A reception completion interrupt (INTSRn) is also generated in synchronization with the transfer to the RXBn register.

2. (Even parity)

If the transmit data contains an odd number of bits with the value "1", the parity bit is set (1). If it contains an even number of bits with the value "1", the parity bit is cleared (0). This controls the number of bits with the value "1" contained in the transmit data and the parity bit so that it is an even number.

During reception, the number of bits with the value "1" contained in the receive data and the parity bit is counted, and if the number is odd, a parity error is generated.

(Odd parity)

In contrast to even parity, odd parity controls the number of bits with the value "1" contained in the transmit data and the parity bit so that it is an odd number.

During reception, the number of bits with the value "1" contained in the receive data and the parity bit is counted, and if the number is even, a parity error is generated.

(0 parity)

During transmission, the parity bit is cleared (0) regardless of the transmit data.

During reception, no parity error is generated because no parity bit is checked.

(No parity)

No parity bit is added to transmit data.

During reception, the receive data is considered to have no parity bit. No parity error is generated because there is no parity bit.

CLn	Specifies character length of 1 frame of transmit/receive data
0	7 bits
1	8 bits

- To overwrite the CL bit, first clear (0) the TXEn and RXEn bits.

SLn	Specifies stop bit length of transmit data
0	1 bit
1	2 bits

- To overwrite the SL bit, first clear (0) the TXEn bit.
- Since reception is always performed with a stop bit length of 1, the SL bit setting does not affect receive operations.

ISRMn	Enables/disables generation of reception completion interrupt requests when an error occurs
0	Generate a reception error interrupt request (INTSREn) as an interrupt when an error occurs. In this case, no reception completion interrupt request (INTSRn) is generated.
1	Generate a reception completion interrupt request (INTSRn) as an interrupt when an error occurs. In this case, no reception error interrupt request (INTSREn) is generated.

- To overwrite the ISRM bit, first clear (0) the RXEn bit.

(2) Asynchronous serial interface status register n (ASISn)

The ASISn register, which consists of 3 error flag bits (PEn, FEn and OVEN), indicates the error status when UARTn reception is complete.

The status flag, which indicates a reception error, always indicates the status of the error that occurred most recently. That is, if the same error occurred several times before the receive data was read, this flag would hold only the status of the error that occurred last.

The ASISn register is cleared to 00H by a read operation. When a reception error occurs, receive buffer register n (RXBn) should be read and the error flag should be cleared after the ASISn register is read.

This register is read-only, in 8-bit units.

Caution When the UARTCAEn bit or RXEn bit of the ASIMn register is set to 0, or when the ASISn register is read, the PEn, FEn, and OVEN bits of the ASISn register are cleared (0).

After reset: 00H R Address: FFFFFFFA03H, FFFFFFFA13H								
ASISn	7	6	5	4	3	2	1	0
	0	0	0	0	0	PEn	FEn	OVEn

PEn	Status flag that indicates a parity error
0	When the ASIMn register's UARTCAEn and RXEn bits are both set to 0, or when the ASISn register has been read
1	When reception was completed, the transmit data parity did not match the parity bit
<ul style="list-style-type: none"> • The operation of the PEn bit differs according to the settings of the PS1 and PS0 bits of the ASIMn register. 	

FEn	Status flag that indicates a framing error
0	When the ASIMn register's UARTCAEn and RXEn bits are both set to 0, or when the ASISn register has been read
1	When reception was completed, no stop bit was detected
<ul style="list-style-type: none"> • For receive data stop bits, only the first bit is checked regardless of the stop bit length. 	

OVEn	Status flag that indicates an overrun error
0	When the ASIMn register's UARTCAEn and RXEn bits are both 0, or when the ASISn register has been read.
1	UARTn completed the next receive operation before reading the RXBn receive data.
<ul style="list-style-type: none"> • When an overrun error occurs, the next receive data value is not written to the RXBn register and the data is discarded. 	

(3) Asynchronous serial interface transmission status register n (ASIFn)

The ASIFn register, which consists of 2 status flag bits, indicates the status during transmission.

By writing the next data to the TXBn register after data is transferred from the TXBn register to the transmit shift register, transmit operations can be performed continuously without suspension even during an interrupt interval. When transmission is performed continuously, data should be written after referencing the TXBFn bit of the ASIFn register to prevent writing to the TXBn register by mistake.

This register is read-only, in 8-bit or 1-bit units.

After reset: 00H R Address: FFFFFFFA05H, FFFFFFFA15H

	7	6	5	4	3	2	<1>	<0>
ASIFn	0	0	0	0	0	0	TXBFn	TXSFn

TXBFn	Transmit buffer data flag
0	Data to be transferred next to the TXBn register does not exist (when the ASIMn register's POWERn or TXEn bit is 0, or when data has been transferred to the transmit shift register)
1	Data to be transferred next exists in the TXBn register (data exists in the TXBn register when the TXBn register has been written to)
<ul style="list-style-type: none"> When transmission is performed continuously, data should be written to the TXBn register after confirming that this flag is 0. If writing to the TXBn register is performed when this flag is 1, transmit data cannot be guaranteed. 	

TXSFn	Transmit shift register data flag (indicating the transmission status of UARTn)
0	Initial status or a waiting transmission (when the ASIMn register's UARTCAEn or TXEn bit is set to 0, or following transfer completion, the next data transfer from the TXBn register is not performed)
1	Transmission in progress (when data has been transferred from the TXBn register)
<ul style="list-style-type: none"> When the transmission unit is initialized, initialization should be executed after confirming that this flag is 0 following the occurrence of a transmission completion interrupt. If initialization is performed when this flag is 1, transmit data cannot be guaranteed. 	

(4) Receive buffer register n (RXBn)

The RXBn register is an 8-bit buffer register for storing parallel data that had been converted by the receive shift register.

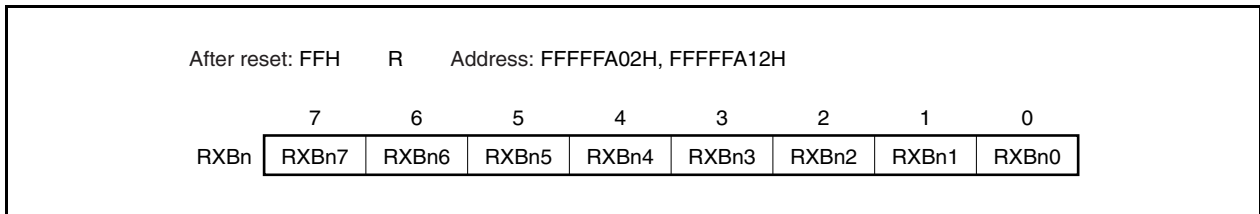
When reception is enabled (RXEn bit = 1 in the ASIMn register), receive data is transferred from the receive shift register to the RXBn register, synchronized with the completion of the shift-in processing of one frame. Also, a reception completion interrupt request (INTSRn) is generated by the transfer to the RXBn register. For information about the timing for generating this interrupt request, refer to **12.2.5 (4) Receive operation**.

If reception is disabled (RXEn bit = 0 in the ASIMn register), the contents of the RXBn register are retained, and no processing is performed for transferring data to the RXBn register even when the shift-in processing of one frame is completed. Also, no reception completion interrupt is generated.

When 7 bits is specified for the data length, bits 6 to 0 of the RXBn register are transferred for the receive data and the MSB (bit 7) is always 0. However, if an overrun error (OVEn) occurs, the receive data at that time is not transferred to the RXBn register.

Except when a reset is input, the RXBn register becomes FFH even when UARTCAEn = 0 in the ASIMn register.

This register is read-only, in 8-bit units.



(5) Transmit buffer register n (TXBn)

The TXBn register is an 8-bit buffer register for setting transmit data.

When transmission is enabled (TXEn bit = 1 in the ASIMn register), the transmit operation is started by writing data to TXBn register.

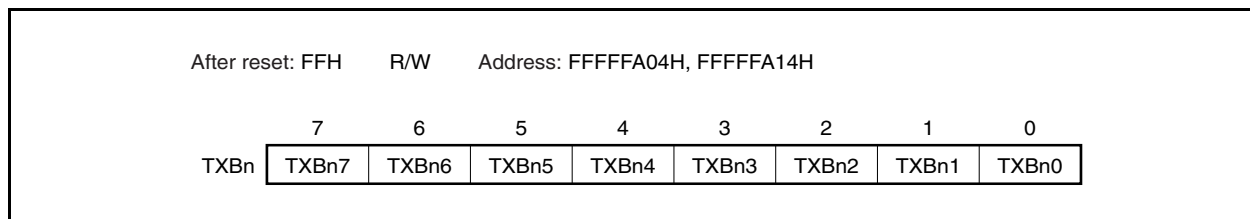
When transmission is disabled (TXEn bit = 0 in the ASIMn register), even if data is written to TXBn register, the value is ignored.

The TXBn register data is transferred to the transmit shift register, and a transmission completion interrupt request (INTSTn) is generated, synchronized with the completion of the transmission of one frame from the transmit shift register. For information about the timing for generating this interrupt request, refer to **12.2.5 (2)**

Transmit operation.

When TXBFn bit = 1 in the ASIFn register, the TXBn register must not be written.

This register can be read or written in 8-bit units.



12.2.4 Interrupt requests

The following three types of interrupt requests are generated from UARTn.

- Reception error interrupt (INTSREn)
- Reception completion interrupt (INTSRn)
- Transmission completion interrupt (INTSTn)

The default priorities among these three types of interrupt requests is, from high to low, reception error interrupt, reception completion interrupt, and transmission completion interrupt.

Table 12-1. Generated Interrupts and Default Priorities

Interrupt	Priority
Reception error	1
Reception completion	2
Transmission completion	3

(1) Reception error interrupt (INTSREn)

When reception is enabled, a reception error interrupt is generated according to the logical OR of the three types of reception errors explained for the ASISn register. Whether a reception error interrupt (INTSREn) or a reception completion interrupt (INTSRn) is generated when an error occurs can be specified using the ISRMn bit of the ASIMn register.

When reception is disabled, no reception error interrupt is generated.

(2) Reception completion interrupt (INTSRn)

When reception is enabled, a reception completion interrupt is generated when data is shifted in to the receive shift register and transferred to the receive buffer register (RXBn).

A reception completion interrupt request can be specified to be generated in place of a reception error interrupt using the ISRMn bit of the ASIMn register even when a reception error has occurred.

When reception is disabled, no reception completion interrupt is generated.

(3) Transmission completion interrupt (INTSTn)

A transmission completion interrupt is generated when one frame of transmit data containing 7-bit or 8-bit characters is shifted out from the transmit shift register.

12.2.5 Operation

(1) Data format

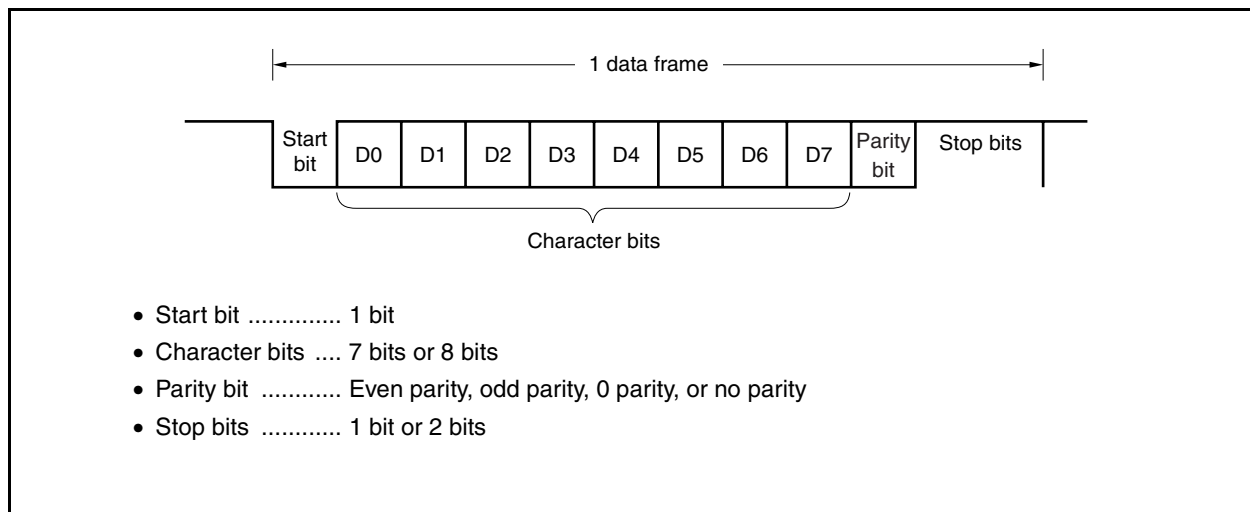
Full-duplex serial data transmission and reception can be performed.

The transmit/receive data format consists of one data frame containing a start bit, character bits, a parity bit, and stop bits as shown in Figure 12-4.

The character bit length within one data frame, the type of parity, and the stop bit length are specified by asynchronous serial interface mode register n (ASIMn).

Also, data is transferred LSB first.

Figure 12-4. Asynchronous Serial Interface Transmit/Receive Data Format



(2) Transmit operation

When the UARTCAEn bit is set to 1 in the ASIMn register, a high level is output from the TXDn pin. Then, when the TXEn bit is set to 1 in the ASIMn register, transmission is enabled, and the transmit operation is started by writing transmit data to transmit buffer register n (TXBn).

(a) Transmission enabled state

This state is set by the TXEn bit in the ASIMn register.

- TXEn = 1: Transmission enabled state
- TXEn = 0: Transmission disabled state

Since UARTn does not have a CTS (transmission enabled signal) input pin, a port should be used to confirm whether the destination is in a reception enabled state.

(b) Starting a transmit operation

In the transmission enabled state, a transmit operation is started by writing transmit data to transmit buffer register n (TXBn). When a transmit operation is started, the data in TXBn is transferred to the transmit shift register. Then, the transmit shift register outputs data to the TXDn pin (the transmit data is transferred sequentially starting with the start bit). The start bit, parity bit, and stop bits are added automatically.

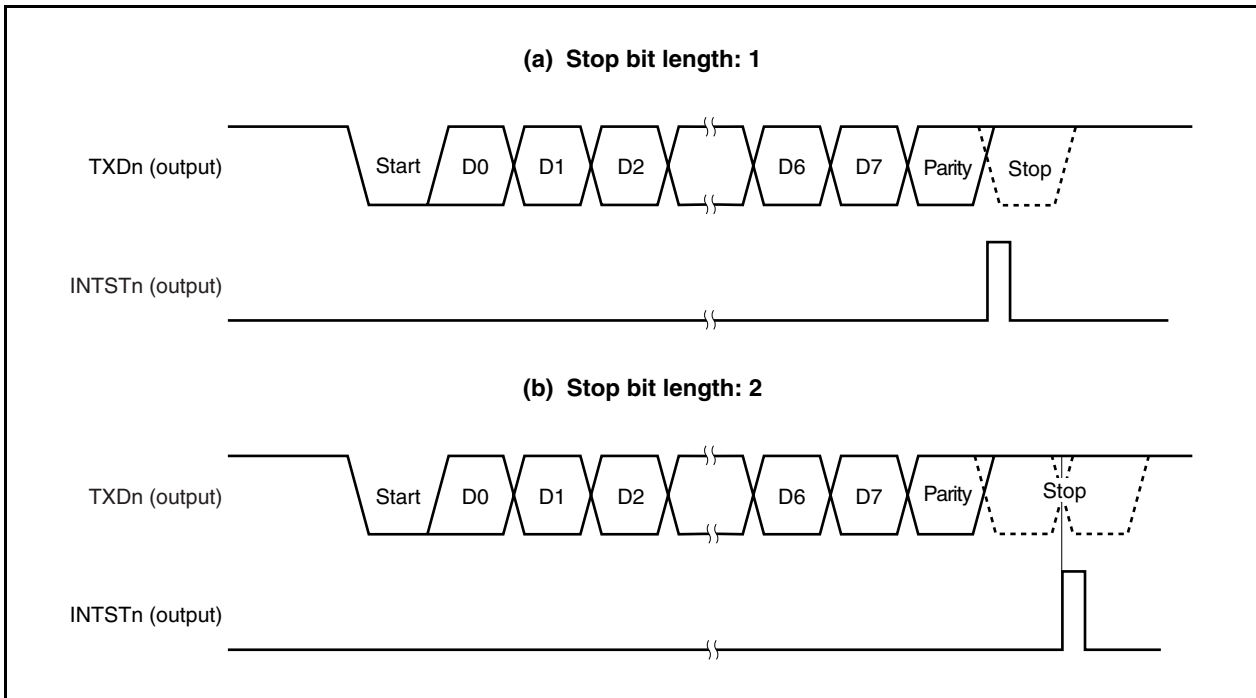
(c) Transmission interrupt request

When the transmit shift register becomes empty, a transmission completion interrupt request (INTSTn) is generated. The timing for generating the INTSTn interrupt differs according to the specification of the stop bit length. The INTSTn interrupt is generated at the same time that the last stop bit is output.

If the data to be transmitted next has not been written to the TXBn register, the transmit operation is suspended.

Caution Normally, when the transmit shift register becomes empty, a transmission completion interrupt (INTSTn) is generated. However, no transmission completion interrupt (INTSTn) is generated if the transmit shift register becomes empty due to the input of RESET.

Figure 12-5. Asynchronous Serial Interface Transmission Completion Interrupt Timing



(3) Continuous transmission operation

UARTn can write the next transmit data to the TXBn register at the timing that the transmit shift register starts the shift operation. This enables an efficient transmission rate to be realized by continuously transmitting data even during the INTSTn interrupt servicing after the transmission of one data frame. In addition, reading the TXSFn bit of the ASIFn register after the occurrence of a transmission completion interrupt enables the TXBn register to be efficiently written twice (2 bytes) without waiting for the transmission of 1 data frame.

When continuous transmission is performed, data should be written after referencing the ASIFn register to confirm the transmission status and whether or not data can be written to the TXBn register.

TXBFn	Whether or Not Writing to TXBn Register Is Enabled
0	Writing is enabled
1	Writing is not enabled

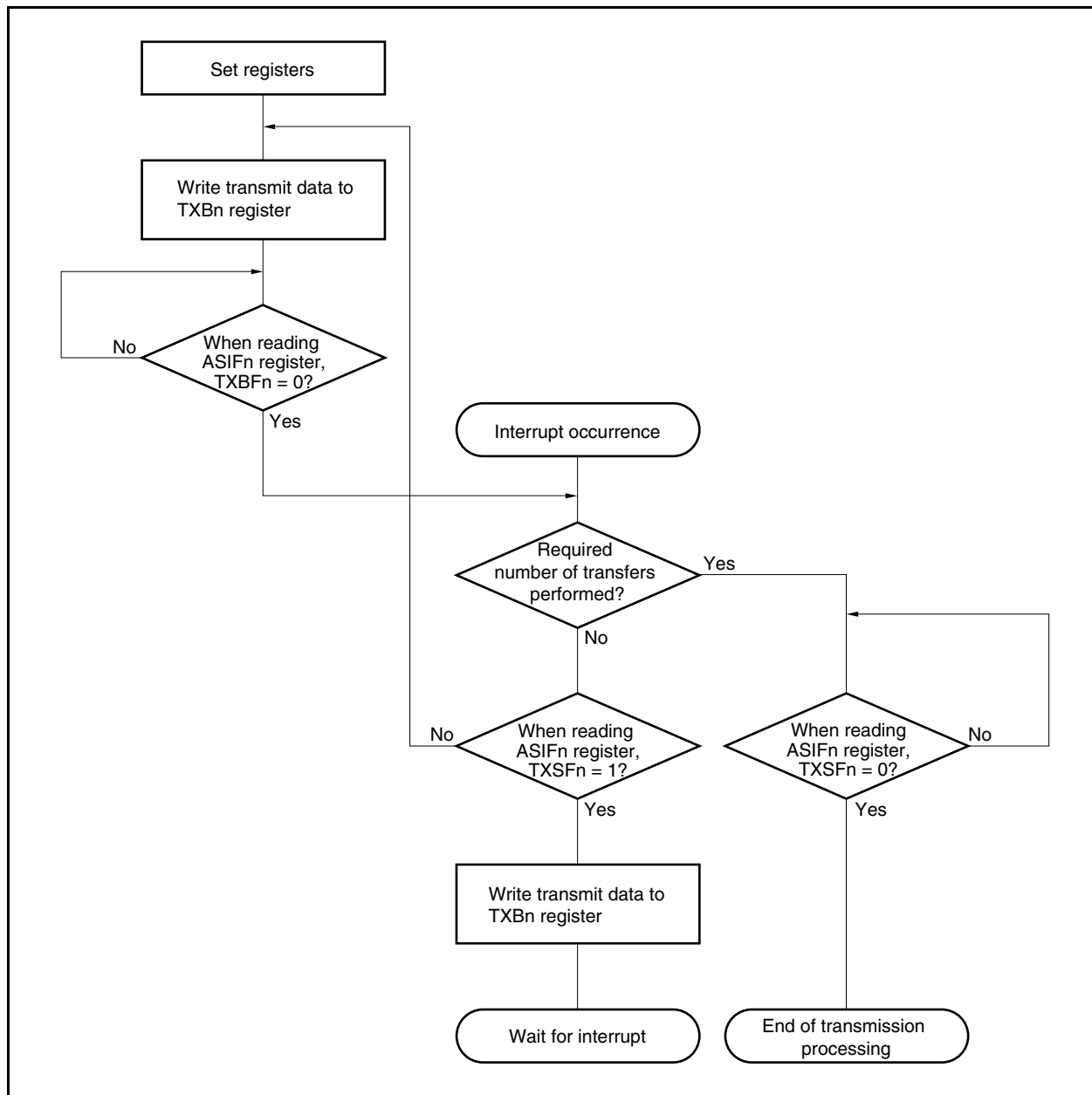
Caution When transmission is performed continuously, write the first transmit data (first byte) to the TXBn register and confirm that the TXBFn bit is 0, and then write the next transmit data (second byte) to TXBn register. If writing to the TXBn register is performed when the TXBFn bit is 1, transmit data cannot be guaranteed.

While transmission is being performed continuously, whether writing to the TXBn register later is enabled can be judged by confirming the TXSFn bit after the occurrence of a transmission completion interrupt.

TXSFn	Transmission Status
0	Transmission is completed. However, the cautions concerning the TXBFn bit must be observed. Writing transmit data can be performed twice (2 bytes).
1	Under transmission. Transmit data can be written once (1 byte).

- Cautions 1.** When initializing the transmission unit when continuous transmission is completed, confirm that the TXBFn bit is 0 after the occurrence of the transmission completion interrupt, and then execute initialization. If initialization is performed when the TXBFn bit is 1, transmit data cannot be guaranteed.
- 2.** While transmission is being performed continuously, an overrun error may occur if the next transmission is completed before the INTSTn interrupt servicing following the transmission of 1 data frame is executed. An overrun error can be detected by embedding a program that can count the number of transmit data and referencing the TXSFn bit.

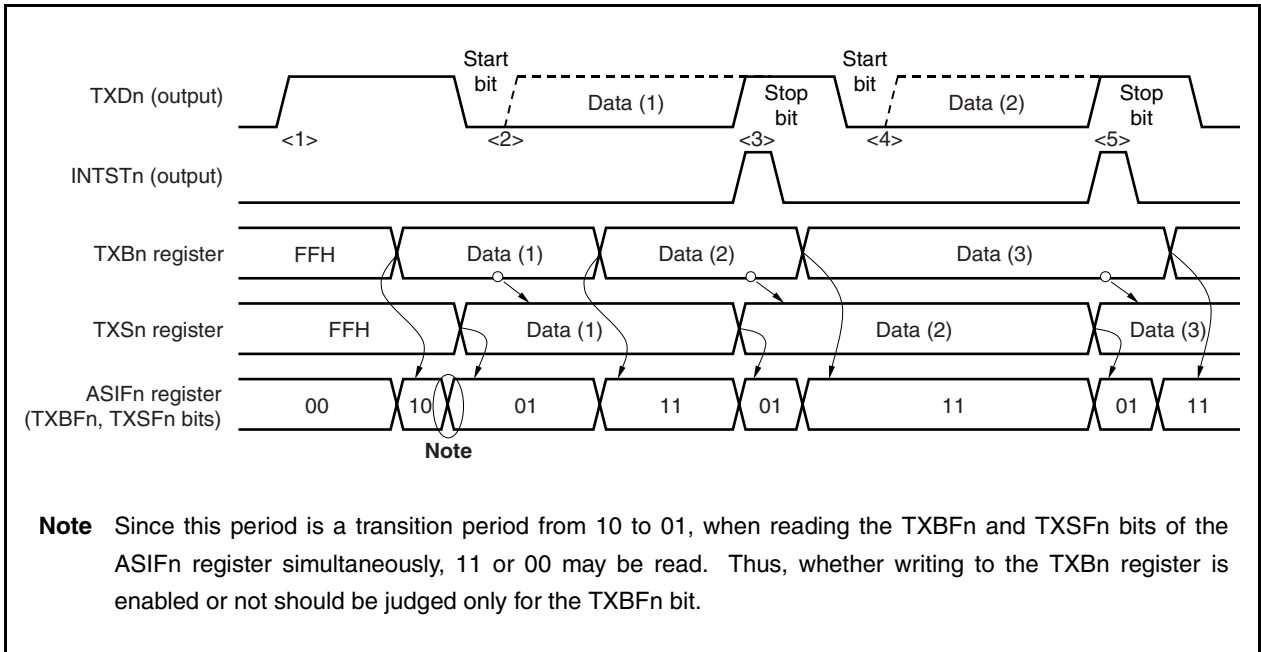
Figure 12-6. Continuous Transmission Processing Flow



(a) Starting procedure

The procedure to start continuous transmission is shown below.

Figure 12-7. Continuous Transmission Starting Procedure



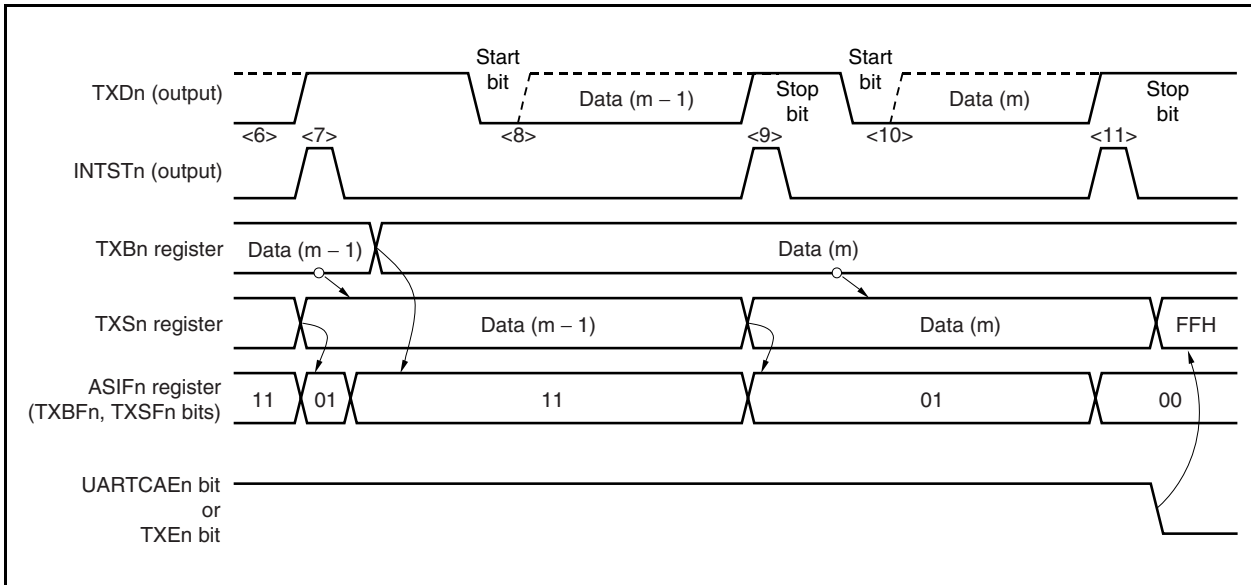
Transmission Starting Procedure	Internal Operation	ASIFn Register	
		TXBFn	TXSFn
• Set transmission mode	<1> Start transmission unit	0	0
• Write data (1)	→	1	0
	<2> Generate start bit	1	1/0 ^{Note}
	Start data (1) transmission →	0	1/0 ^{Note}
• Read ASIFn register (confirm that TXBFn bit = 0) ←	←	0	1
	←	0	1
• Write data (2)	→	1	1
	<<Transmission in progress>>		
• Read ASIFn register (confirm that TXBFn bit = 0) ←	<3> INTSTn interrupt occurs →	0	1
	←	0	1
• Write data (3)	→	1	1
	<4> Generate start bit Start data (2) transmission <<Transmission in progress>>		
• Read ASIFn register (confirm that TXBFn bit = 0) ←	<5> INTSTn interrupt occurs →	0	1
	←	0	1
• Write data (4)	→	1	1

Note Transition period

(b) Ending procedure

The procedure for ending continuous transmission is shown below.

Figure 12-8. Continuous Transmission End Procedure



Transmission End Procedure	Internal Operation	ASIFn Register	
		TXBFn	TXSFn
<ul style="list-style-type: none"> Read ASIFn register (confirm that TXBFn bit = 0) Write data (m) 	<6> Transmission of data (m - 2) is in progress <7> INTSTn interrupt occurs	1	1
		0	1
<ul style="list-style-type: none"> Read ASIFn register (confirm that TXSFn bit = 1) There is no write data 	<8> Generate start bit Start data (m - 1) transmission <<Transmission in progress>> <9> INTSTn interrupt occurs	1	1
		0	<u>1</u>
<ul style="list-style-type: none"> Read ASIFn register (confirm that TXSFn bit = 0) Clear (0) the UARTCAEn bit or TXEn bit 	<10> Generate start bit Start data (m) transmission <<Transmission in progress>> <11> Generate INTSTn interrupt	0	0
	Initialize internal circuits	0	<u>0</u>

(4) Receive operation

The awaiting reception state is set by setting the UARTCAEn bit to 1 in the ASIMn register and then setting the RXEn bit to 1 in the ASIMn register. To start the receive operation, first perform start bit detection. The start bit is detected by sampling the RXDn pin. When the receive operation begins, serial data is stored sequentially in the receive shift register according to the baud rate that was set. A reception completion interrupt (INTSRn) is generated each time the reception of one frame of data is completed. Normally, the receive data is transferred from receive buffer register n (RXBn) to memory by this interrupt servicing.

(a) Reception enabled state

The receive operation is set to the reception enabled state by setting the RXEn bit in the ASIMn register to 1.

- RXEn bit = 1: Reception enabled state
- RXEn bit = 0: Reception disabled state

In reception disabled state, the reception hardware stands by in the initial state. At this time, the contents of receive buffer register n (RXBn) are retained, and no reception completion interrupt or reception error interrupt is generated.

(b) Starting a receive operation

A receive operation is started by the detection of a start bit.

The RXDn pin is sampled using the serial clock from baud rate generator n (BRGn).

(c) Reception completion interrupt

When RXEn = 1 in the ASIMn register and the reception of one frame of data is completed (the stop bit is detected), a reception completion interrupt (INTSRn) is generated and the receive data within the receive shift register is transferred to RXBn at the same time.

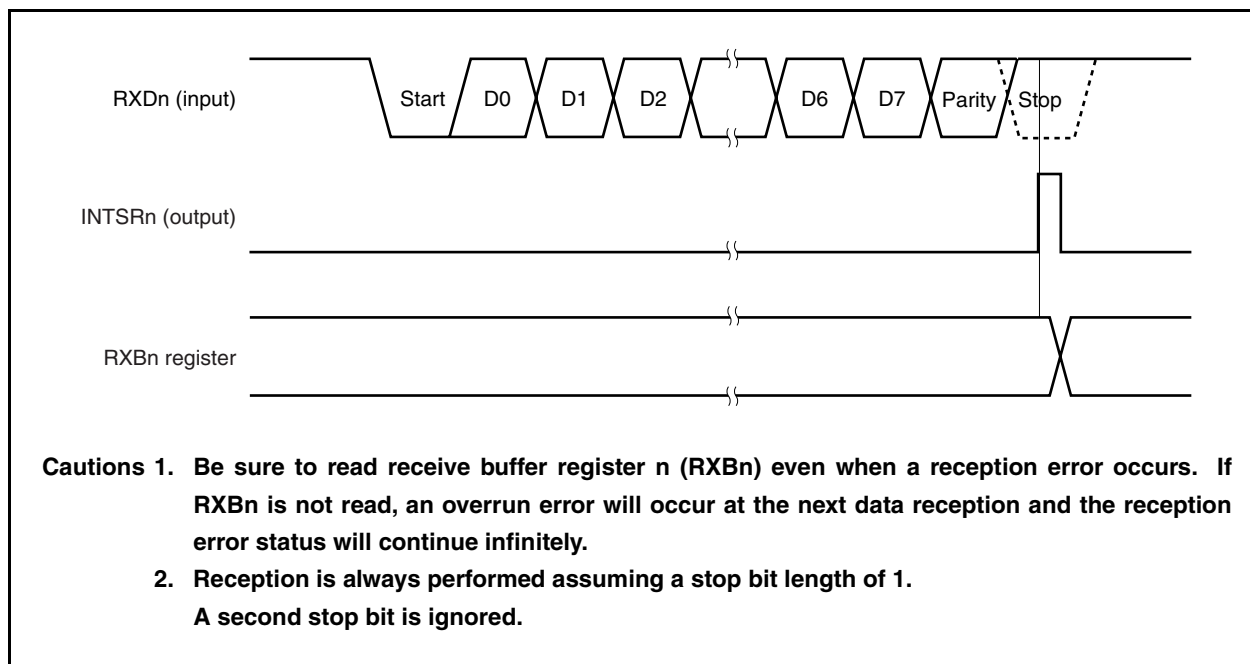
Also, if an overrun error (OVEn) occurs, the receive data at that time is not transferred to receive buffer register n (RXBn), and either a reception completion interrupt (INTSRn) or a reception error interrupt (INTSREn) is generated (the receive data within the receive shift register is transferred to RXBn) according to the ISRmN bit setting in the ASIMn register.

Even if a parity error (PEn) or framing error (FEn) occurs during a reception operation, the receive operation continues until stop bit is received, and after reception is completed, either a reception completion interrupt (INTSRn) or a reception error interrupt (INTSREn) is generated according to the ISRmN bit setting in the ASIMn register.

If the RXEn bit is reset (0) during a receive operation, the receive operation is immediately stopped. The contents of receive buffer register n (RXBn) and of the asynchronous serial interface status register (ASISn) at this time do not change, and no reception completion interrupt (INTSRn) or reception error interrupt (INTSREn) is generated.

No reception completion interrupt is generated when RXEn = 0 (reception is disabled).

Figure 12-9. Asynchronous Serial Interface Reception Completion Interrupt Timing

**(5) Reception error**

The three types of errors that can occur during a receive operation are a parity error, framing error, and overrun error. As a result of data reception, the various flags of the ASISn register are set (1), and a reception error interrupt (INTSREn) or a reception completion interrupt (INTSRn) is generated at the same time. The ISRMn bit of the ASIMn register specifies whether INTSREn or INTSRn is generated.

The type of error that occurred during reception can be detected by reading the contents of the ASISn register during the INTSREn or INTSRn interrupt servicing.

The contents of the ASISn register are reset (0) by reading the ASISn register.

Table 12-2. Reception Error Causes

Error Flag	Reception Error	Cause
PEn	Parity error	The parity specification during transmission did not match the parity of the reception data
FEn	Framing error	No stop bit was detected
OVEEn	Overrun error	The reception of the next data was completed before data was read from receive buffer register n (RXBn)

(a) Separation of reception error interrupt

A reception error interrupt can be separated from the INTSRn interrupt and generated as the INTSREn interrupt by clearing the ISRMn bit of the ASIMn register to 0.

Figure 12-10. When Reception Error Interrupt Is Separated from Reception Completion Interrupt (INTSRn) (ISRMn Bit = 0)

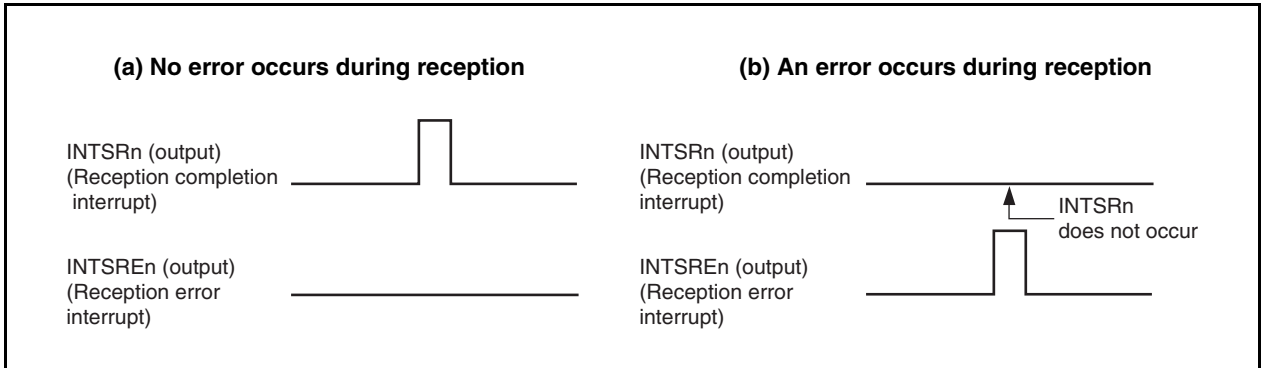
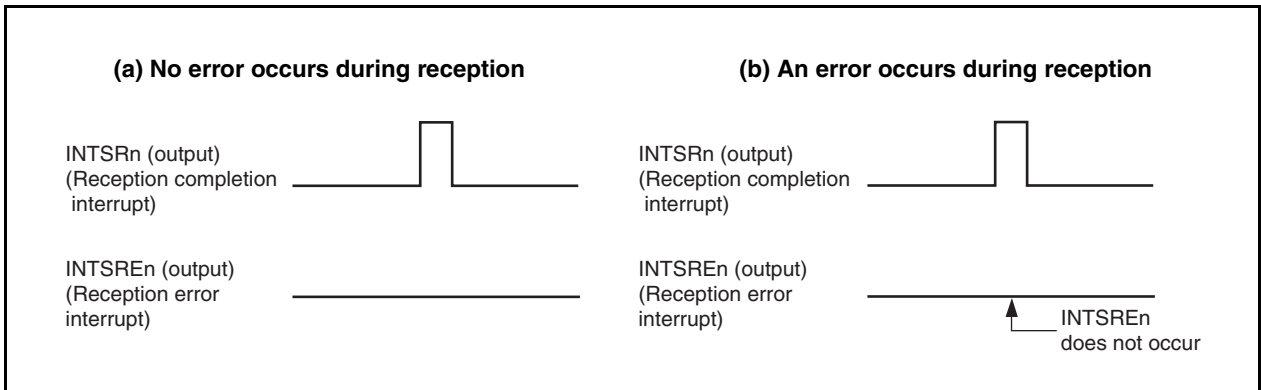


Figure 12-11. When Reception Error Interrupt Is Included in Reception Completion Interrupt (INTSRn) (ISRMn Bit = 1)



(6) Parity types and corresponding operation

A parity bit is used to detect a bit error in communication data. Normally, the same type of parity bit is used on the transmission and reception sides.

(a) Even parity**(i) During transmission**

The parity bit is controlled so that the number of bits with the value “1” within the transmit data including the parity bit is even. The parity bit value is as follows.

- If the number of bits with the value “1” within the transmit data is odd: 1
- If the number of bits with the value “1” within the transmit data is even: 0

(ii) During reception

The number of bits with the value “1” within the receive data including the parity bit is counted, and a parity error is generated if this number is odd.

(b) Odd parity**(i) During transmission**

In contrast to even parity, the parity bit is controlled so that the number of bits with the value “1” within the transmit data including the parity bit is odd. The parity bit value is as follows.

- If the number of bits with the value “1” within the transmit data is odd: 0
- If the number of bits with the value “1” within the transmit data is even: 1

(ii) During reception

The number of bits with the value “1” within the receive data including the parity bit is counted, and a parity error is generated if this number is even.

(c) 0 parity

During transmission the parity bit is set to “0” regardless of the transmit data.

During reception, no parity bit check is performed. Therefore, no parity error is generated regardless of whether the parity bit is “0” or “1”.

(d) No parity

No parity bit is added to the transmit data.

During reception, the receive operation is performed as if there were no parity bit. Since there is no parity bit, no parity error is generated.

(7) Receive data noise filter

The RXDn signal is sampled at the rising edge of the prescaler output base clock (Clock). If the same sampling value is obtained twice, the match detector output changes, and this output is sampled as input data. Therefore, data not exceeding one clock width is judged to be noise and is not delivered to the internal circuit (see **Figure 12-13**). Refer to **12.2.6 (1) (a) Base clock (Clock)** regarding the base clock.

Also, since the circuit is configured as shown in **Figure 12-12**, internal processing during a receive operation is delayed by up to 2 clocks according to the external signal status.

Figure 12-12. Noise Filter Circuit

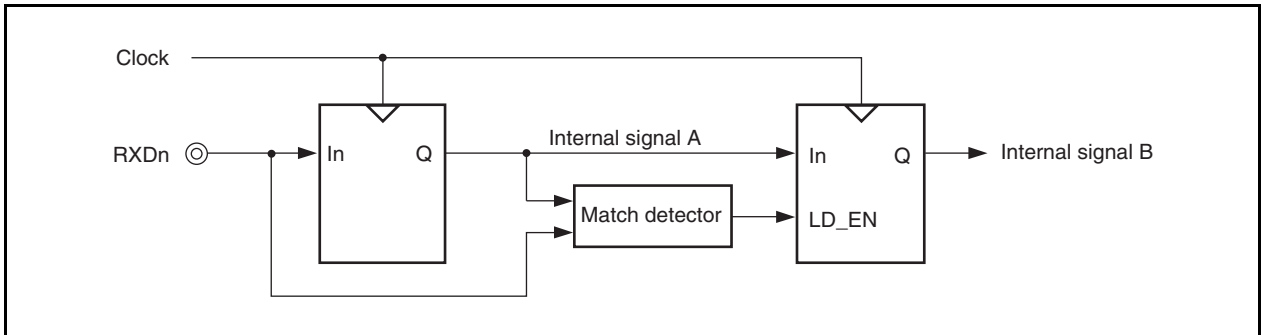
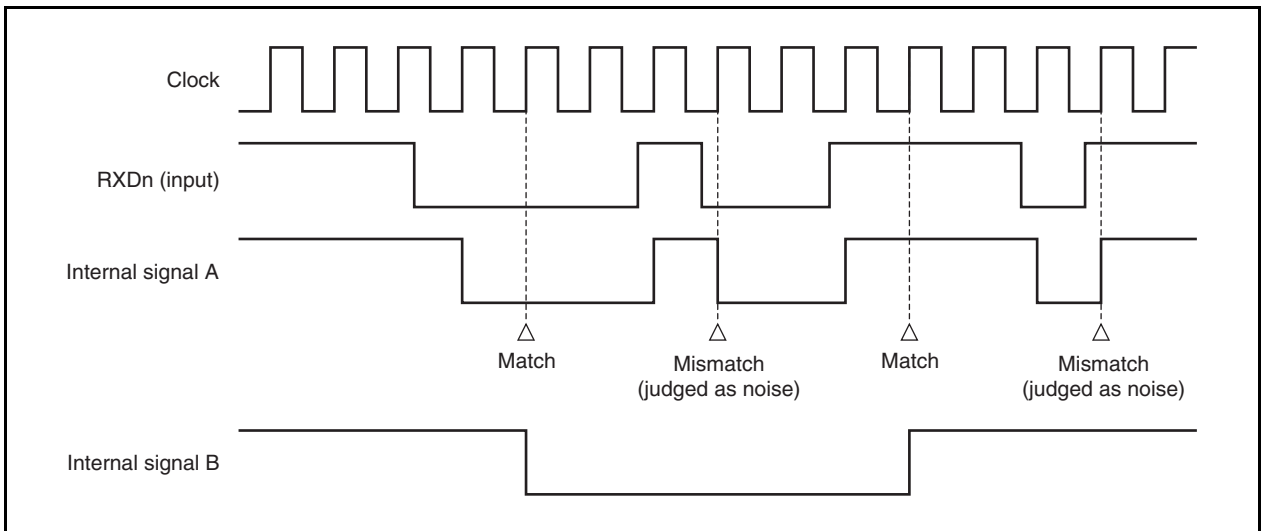


Figure 12-13. Timing of RXDn Signal Judged as Noise



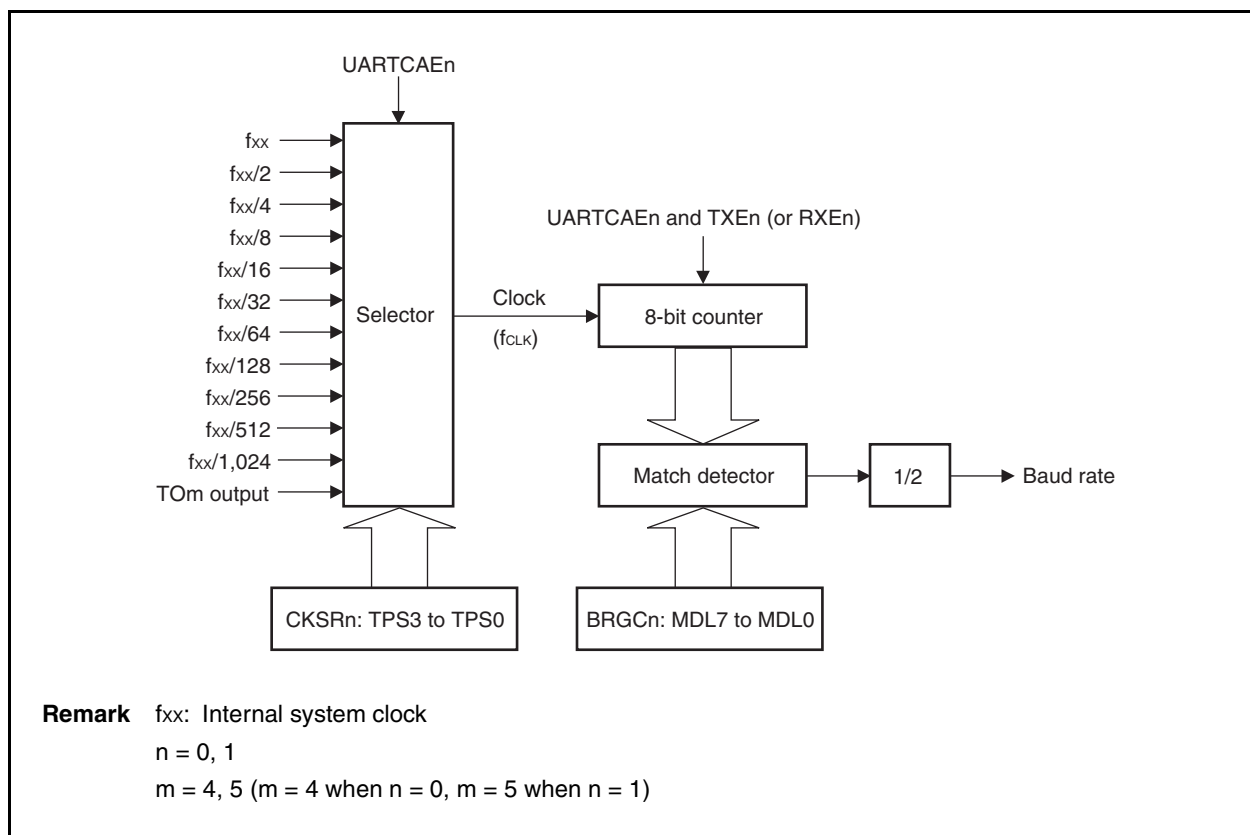
12.2.6 Dedicated baud rate generator n (BRGn)

A dedicated baud rate generator, which consists of a source clock selector and an 8-bit programmable counter, generates serial clocks during transmission/reception by UARTn. The dedicated baud rate generator output can be selected as the serial clock for each channel.

Separate 8-bit counters exist for transmission and for reception.

(1) Baud rate generator n (BRGn) configuration

Figure 12-14. Configuration of Baud Rate Generator n (BRGn)



(a) Base clock (Clock)

When the UARTCAEn bit = 1 in the ASIMn register, the clock selected according to the TPSn3 to TPSn0 bits of the CKSRn register is supplied to the transmission/reception unit. This clock is called the base clock (Clock), and its frequency is referred to as f_{CLK} . When UARTCAEn = 0, Clock is fixed to low level.

(2) Serial clock generation

A serial clock can be generated according to the settings of the CKSRn and BRGCn registers. The base clock to the 8-bit counter is selected by the TPSn3 to TPSn0 bits of the CKSRn register. The 8-bit counter divisor value can be set by the MDLn7 to MDLn0 bits of the BRGCn register.

(a) Clock select register n (CKSRn)

The CKSRn register is an 8-bit register for selecting the basic block using the TPSn3 to TPSn0 bits. The clock selected by the TPSn3 to TPSn0 bits becomes the base clock (Clock) of the transmission/reception module. Its frequency is referred to as f_{CLK} .

This register can be read or written in 8-bit units.

Caution Set the UARTCAEn bit of the ASIMn register to 0 before rewriting the TPSn3 to TPSn0 bits.

After reset: 00H R/W Address: FFFFFFFA06H, FFFFFFFA16H

	7	6	5	4	3	2	1	0
CKSRn	0	0	0	0	TPSn3	TPSn2	TPSn1	TPSn0

TPSn3	TPSn2	TPSn1	TPSn0	Receive operation
0	0	0	0	f_{xx}
0	0	0	1	$f_{xx}/2$
0	0	1	0	$f_{xx}/4$
0	0	1	1	$f_{xx}/8$
0	1	0	0	$f_{xx}/16$
0	1	0	1	$f_{xx}/32$
0	1	1	0	$f_{xx}/64$
0	1	1	1	$f_{xx}/128$
1	0	0	0	$f_{xx}/256$
1	0	0	1	$f_{xx}/512$
1	0	1	0	$f_{xx}/1,024$
1	0	1	1	TOM output
Other than above				Setting prohibited

Remark $n = 0, 1$
 $m = 4, 5$ ($m = 4$ when $n = 0$, $m = 5$ when $n = 1$)

(b) Baud rate generator control register n (BRGCn)

The BRGCn register is an 8-bit register that controls the baud rate (serial transfer speed) of UARTn. This register can be read or written in 8-bit units.

Caution If the MDLn7 to MDLn0 bits are to be overwritten, the TXEn and RXEn bits should be set to 0 in the ASIMn register first.

After reset: FFH R/W Address: FFFFA07H, FFFFA17H

	7	6	5	4	3	2	1	0
BRGCn	MDLn7	MDLn6	MDLn5	MDLn4	MDLn3	MDLn2	MDLn1	MDLn0

MD Ln7	MD Ln6	MD Ln5	MD Ln4	MD Ln3	MD Ln2	MD Ln1	MD Ln0	Division value (k)	Serial clock
0	0	0	0	0	×	×	×	–	Setting prohibited
0	0	0	0	1	0	0	0	8	f _{CLK} /8
0	0	0	0	1	0	0	1	9	f _{CLK} /9
0	0	0	0	1	0	1	0	10	f _{CLK} /10
:	:	:	:	:	:	:	:	:	:
1	1	1	1	1	0	1	0	250	f _{CLK} /250
1	1	1	1	1	0	1	1	251	f _{CLK} /251
1	1	1	1	1	1	0	0	252	f _{CLK} /252
1	1	1	1	1	1	0	1	253	f _{CLK} /253
1	1	1	1	1	1	1	0	254	f _{CLK} /254
1	1	1	1	1	1	1	1	255	f _{CLK} /255

- Remarks**
1. f_{CLK}: Frequency [Hz] of base clock (Clock) selected by TPSn3 to TPSn0 bits of CKSRn register
 2. k: Value set by MDLn7 to MDLn0 bits (k = 8, 9, 10, ..., 255)
 3. The baud rate is the output clock for the 8-bit counter divided by 2
 4. ×: Don't care

(c) Baud rate

The baud rate is the value obtained by the following formula.

$$\text{Baud rate} = \frac{f_{\text{CLK}}}{2 \times k} \text{ [bps]}$$

f_{CLK} = Frequency [Hz] of base clock (Clock) selected by TPSn3 to TPSn0 bits of CKSRn register.

k = Value set by MDLn7 to MDLn0 bits of BRGCn register ($k = 8, 9, 10, \dots, 255$)

(d) Baud rate error

The baud rate error is obtained by the following formula.

$$\text{Error (\%)} = \left(\frac{\text{Actual baud rate (baud rate with error)}}{\text{Desired baud rate (normal baud rate)}} - 1 \right) \times 100 \text{ [\%]}$$

- Cautions**
1. Make sure that the baud rate error during transmission does not exceed the allowable error of the reception destination.
 2. Make sure that the baud rate error during reception is within the allowable baud rate range described in (4) Allowable baud rate range during reception.

Example: Base clock frequency = 17 MHz = 17,000,000 Hz
 Setting of MDLn7 to MDLn0 bits in BRGC0 register = 00110111B ($k = 55$)
 Target baud rate = 153,600 bps

$$\begin{aligned} \text{Baud rate} &= 17\text{M}/(2 \times 55) \\ &= 17,000,000/(2 \times 55) = 154,545 \text{ [bps]} \end{aligned}$$

$$\begin{aligned} \text{Error} &= (154,545/153,600 - 1) \times 100 \\ &= 0.615 \text{ [\%]} \end{aligned}$$

(3) Baud rate setting example

Table 12-3. Baud Rate Generator Setting Data

Baud Rate [bps]	f _{xx} = 17 MHz			f _{xx} = 13.5 MHz			f _{xx} = 8 MHz			f _{xx} = 2 MHz		
	f _{CLK}	k	ERR	f _{CLK}	k	ERR	f _{CLK}	k	ERR	f _{CLK}	k	ERR
300	f _{xx} /128	221	0.16	f _{xx} /512	44	-0.12	f _{xx} /512	26	0.16	f _{xx} /256	13	0.16
600	f _{xx} /64	221	0.16	f _{xx} /256	44	-0.12	f _{xx} /256	26	0.16	f _{xx} /128	13	0.16
1,200	f _{xx} /32	221	0.16	f _{xx} /128	44	-0.12	f _{xx} /128	26	0.16	f _{xx} /64	13	0.16
2,400	f _{xx} /16	221	0.16	f _{xx} /64	44	-0.12	f _{xx} /64	26	0.16	f _{xx} /32	13	0.16
4,800	f _{xx} /8	221	0.16	f _{xx} /32	44	-0.12	f _{xx} /32	26	0.16	f _{xx} /16	13	0.16
9,600	f _{xx} /4	221	0.16	f _{xx} /16	44	-0.12	f _{xx} /16	26	0.16	f _{xx} /8	13	0.16
19,200	f _{xx} /2	221	0.16	f _{xx} /8	44	-0.12	f _{xx} /8	26	0.16	f _{xx} /4	13	0.16
31,250	f _{xx} /2	136	0.00	f _{xx} /4	54	0.00	f _{xx} /4	32	0.00	f _{xx} /2	16	0.00
38,400	f _{xx}	221	0.16	f _{xx} /4	44	-0.12	f _{xx} /4	26	0.16	f _{xx} /2	13	0.16
76,800	f _{xx}	111	-0.29	f _{xx} /2	44	-0.12	f _{xx} /2	26	0.16	f _{xx}	13	0.16
153,600	f _{xx}	55	0.62	f _{xx}	44	-0.12	f _{xx}	26	0.16	-	-	-
312,500	f _{xx}	27	0.74	f _{xx}	22	-1.82	f _{xx}	13	-1.54	-	-	-

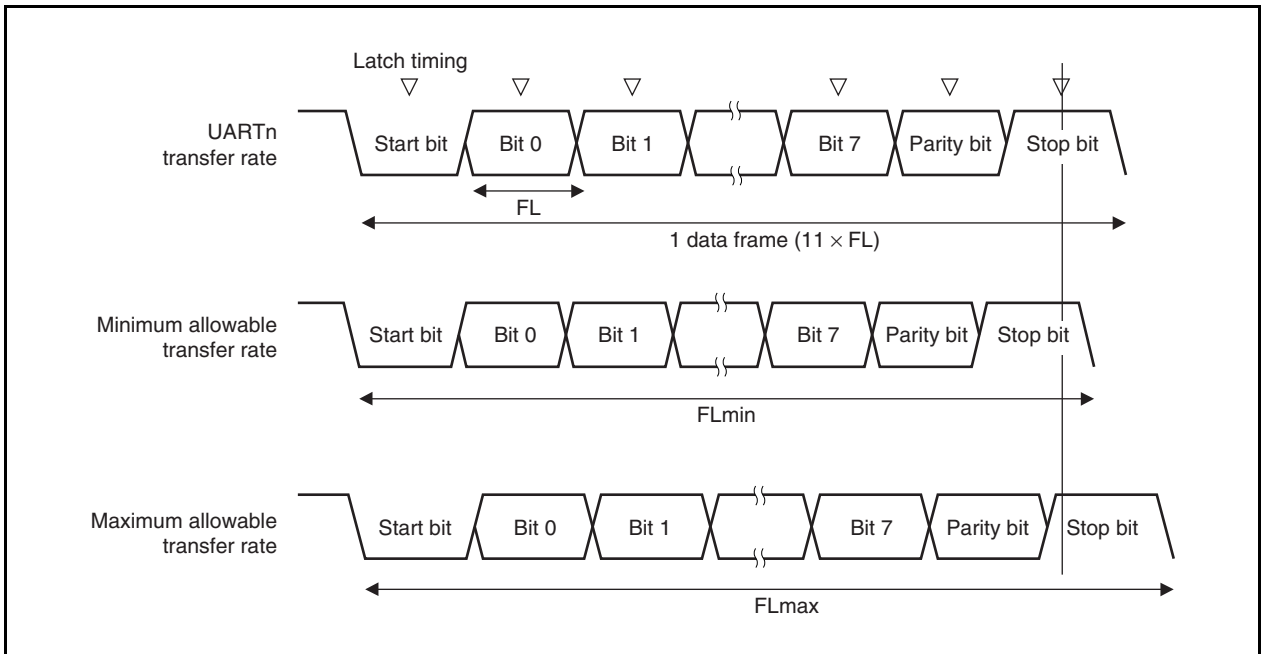
Remark f_{xx}: Internal system clock frequency
f_{CLK}: Base clock frequency
k: Setting values of MDL_n7 to MDL_n0 bits in BRGC_n register
ERR: Baud rate error [%]

(4) Allowable baud rate range during reception

The degree to which a discrepancy from the transmission destination's baud rate is allowed during reception is shown below.

Caution The equations described below should be used to set the baud rate error during reception so that it always is within the allowable error range.

Figure 12-15. Allowable Baud Rate Range During Reception



As shown in Figure 12-14, after the start bit is detected, the receive data latch timing is determined according to the counter that was set by the BRGCn register. If all data up to the final data (stop bit) is in time for this latch timing, the data can be received normally.

If this is applied to 11-bit reception, the following is theoretically true.

$$FL = (\text{Brate})^{-1}$$

- Brate: UARTn baud rate
- k: BRGCn register setting value
- FL: 1-bit data length

When the latch timing margin is 2 base clocks (Clock), the minimum allowable transfer rate (FLmin) is as follows.

$$FL_{\min} = 11 \times FL - \frac{k - 2}{2k} \times FL = \frac{21k + 2}{2k} FL$$

Therefore, the transfer destination's maximum receivable baud rate (BRmax) is as follows.

$$BR_{max} = (FL_{min}/11)^{-1} = \frac{22k}{21k + 2} \text{ Brate}$$

Similarly, the maximum allowable transfer rate (FLmax) can be obtained as follows.

$$\frac{10}{11} \times FL_{max} = 11 \times FL - \frac{k + 2}{2 \times k} \times FL = \frac{21k - 2}{2 \times k} FL$$

$$FL_{max} = \frac{21k - 2}{20k} FL \times 11$$

Therefore, the transfer destination's minimum receivable baud rate (BRmin) is as follows.

$$BR_{min} = (FL_{max}/11)^{-1} = \frac{20k}{21k - 2} \text{ Brate}$$

The allowable baud rate error of UARTn and the transfer destination can be obtained as follows from the expressions described above for computing the minimum and maximum baud rate values.

Table 12-4. Maximum and Minimum Allowable Baud Rate Error

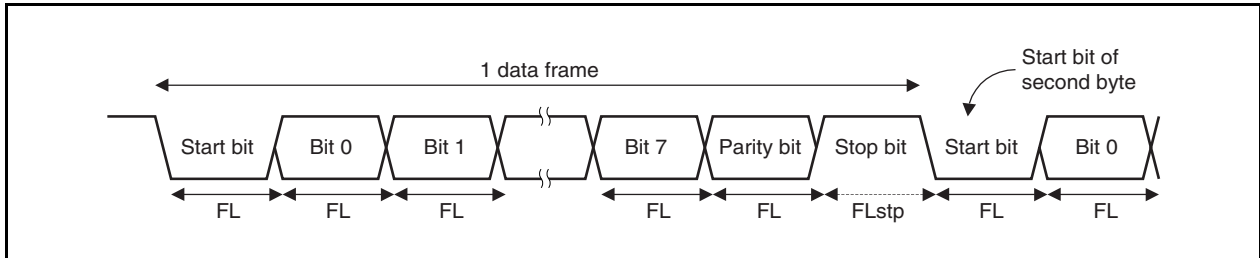
Division Ratio (k)	Maximum Allowable Baud Rate Error	Minimum Allowable Baud Rate Error
8	+3.53%	-3.61%
20	+4.26%	-4.31%
50	+4.56%	-4.58%
100	+4.66%	-4.67%
255	+4.72%	-4.73%

- Remarks**
1. The reception precision depends on the number of bits in one frame, the base clock frequency, and the division ratio (k). The higher the base clock frequency and the larger the division ratio (k), the higher the precision.
 2. k: BRGCn setting value

(5) Transfer rate during continuous transmission

During continuous transmission, the transfer rate from a stop bit to the next start bit is extended two clocks of the base clock (Clock) longer than normal. However, on the reception side, the transfer result is not affected since the timing is initialized by the detection of the start bit.

Figure 12-16. Transfer Rate During Continuous Transmission



Representing the 1-bit data length by FL, the stop bit length by FLstp, and the base clock frequency by f_{CLK} yields the following equation.

$$FL_{stp} = FL + 2/f_{CLK}$$

Therefore, the transfer rate during continuous transmission is as follows.

$$\text{Transfer rate} = 11 \times FL = 2/f_{CLK}$$

12.2.7 Cautions

Cautions to be observed when using UARTn are shown below.

- (1) When the supply of clocks to UARTn is stopped (for example, in IDLE or STOP mode), operation stops with each register retaining the value it had immediately before the supply of clocks was stopped. The TXDn pin output also holds and outputs the value it had immediately before the supply of clocks was stopped. However, operation is not guaranteed after the supply of clocks is restarted. Therefore, after the supply of clocks is restarted, the circuits should be initialized by setting $UARTCAEn = 0$, $RXEn = 0$, and $TXEn = 0$ in the ASIMn register.
- (2) UARTn has a 2-stage buffer configuration consisting of transmit buffer register n (TXBn) and the transmit shift register, and has status flags (the TXBFn and TXSFn bits of the ASIFn register) that indicate the status of each buffer. If the TXBFn and TXSFn bits are read in continuous transmission, the value changes from 10 to 01, but since this change timing is in the period in which data is shifted from TXBn to the transmit shift register, 11 or 00 may be read, depending on the timing. Thus, read only the TXBFn bit during continuous transmission.

12.3 Clocked Serial Interface n (CSIn)

12.3.1 Features

- Transfer rate: Master mode: Maximum 5 Mbps (when internal system clock operates at 10 MHz)
Slave mode: Maximum 5 Mbps
- Half-duplex communications
- Master mode and slave mode can be selected
- Transmission data length: 8 bits
- Transfer data direction can be switched between MSB first and LSB first
- Eight clock signals can be selected (7 master clocks and 1 slave clock)
- 3-wire method
 - SOn: Serial data output
 - SIn: Serial data input
 - SCKn: Serial clock input/output
- Interrupt sources: 1 type
 - Transmission/reception completion interrupt (INTCSIn)
- Transmission/reception mode or reception-only mode can be specified
- On-chip transmit buffer (SOTBn)

Remark n = 0 to 3 (V850ES/SA2)
n = 0 to 4 (V850ES/SA3)

12.3.2 Configuration

CSIn is controlled by the clocked serial interface mode register (CSIMn). Transmit/receive data can be written to or read from the SIO register.

(1) Clocked serial interface mode register n (CSIMn)

The CSIMn register is an 8-bit register for specifying the operation of CSIn.

(2) Clocked serial interface clock selection register n (CSICn)

The CSICn register is an 8-bit register for controlling the transmit operation of CSIn.

(3) Serial I/O shift register n (SIO)

The SIO register is an 8-bit register for converting between serial data and parallel data. SIO is used for both transmission and reception.

Data is shifted in (reception) or shifted out (transmission) beginning at either the MSB side or the LSB side.

Actual transmit/receive operations are controlled by reading or writing SIO.

(4) Clocked serial interface transmit buffer register n (SOTBn)

The SOTBn register is an 8-bit buffer register for storing transmit data.

(5) Selector

The selector selects the serial clock to be used.

(6) Serial clock controller

The serial clock controller controls the supply of serial clocks to the shift register. When an internal clock is used, it also controls the clocks that are output to the SCKn pin.

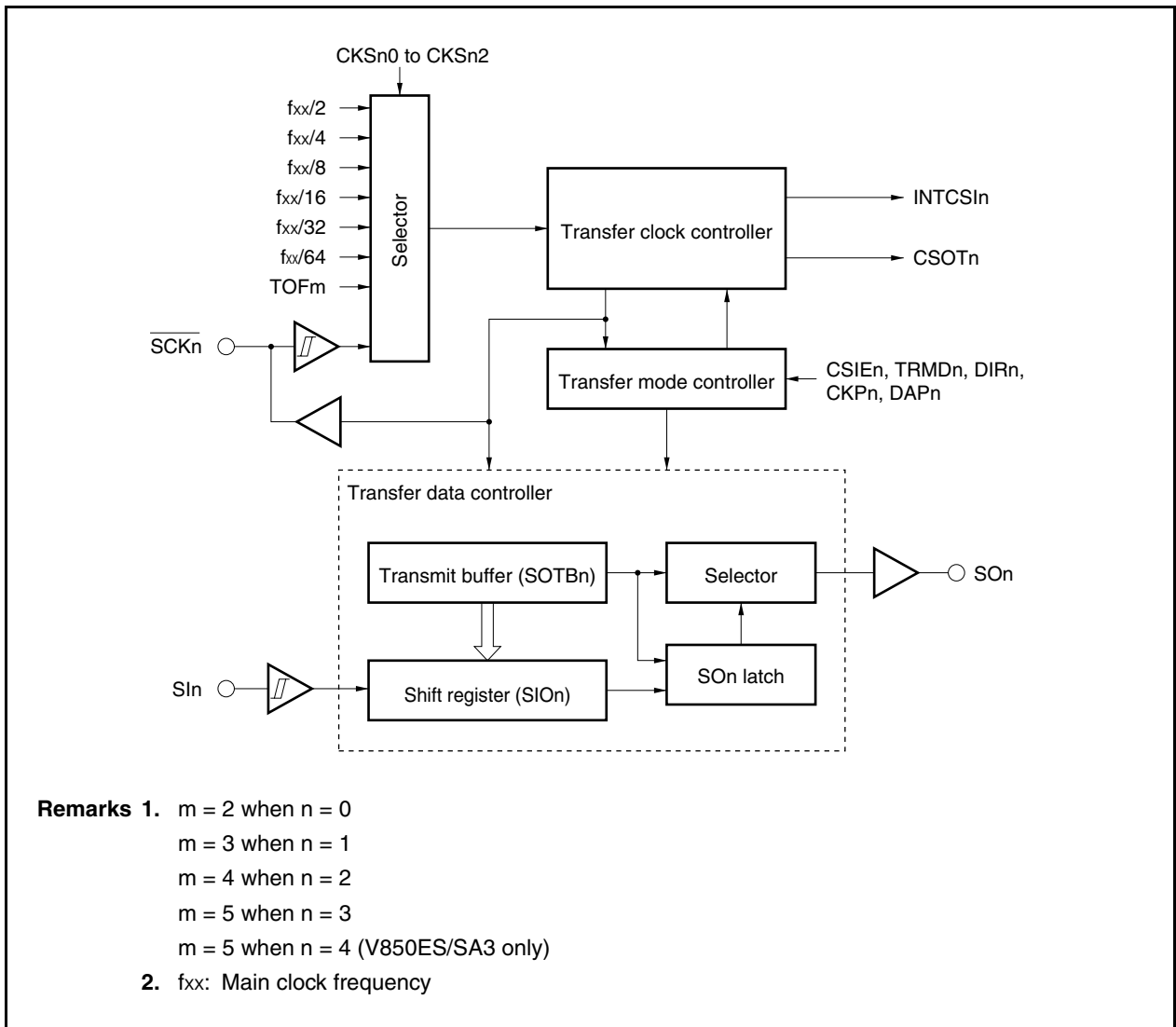
(7) Serial clock counter

The serial clock counter counts serial clocks that are output or input during transmit and receive operations and checks that 8-bit data has been transmitted or received.

(8) Interrupt controller

The interrupt controller controls whether or not an interrupt request is generated when the serial clock counter has counted eight serial clocks.

Figure 12-17. Clocked Serial Interface Block Diagram



12.3.3 Control registers

(1) Clocked serial interface mode register n (CSIMn)

The CSIn register controls the operation of CSIn.

This register can be read or written in 8-bit or 1-bit units.

Caution To use CSIn, be sure to set the external pins related to the CSIn function to control mode and set the CSICn register. Then set the CSIE_n bit to 1 before setting the other bits.

Remark n = 0 to 3 (V850ES/SA2)
n = 0 to 4 (V850ES/SA3)

After reset: 00H R/W Address: CSIM0: FFFFD00H, CSIM1: FFFFD10H, CSIM2: FFFFD20H
 CSIM3: FFFFD30H, CSIM4^{Note}: FFFFD40H

	<7>	<6>	5	4	3	2	1	<0>
CSIMn	CSIE _n	TRMD _n	0	DIR _n	0	0	0	CSOT _n

CSIE _n	CSIn operation enable/disable specification
0	CSIn operation is disabled (SOn = low level, SCK _n = high level)
1	CSIn operation is enabled
<ul style="list-style-type: none"> • If CSIE_n is set to 0, the CSIn unit can be reset asynchronously. • If CSIE_n = 0, the CSIn unit is in a reset state. Therefore, to operate CSIn, CSIE_n must be set to 1. • If the CSIE_n bit is changed from 1 to 0, all registers of the CSIn unit are initialized. To set CSIE_n to 1 again, the registers of the CSIn unit must be set again. 	

TRMD _n	Transmission mode specification
0	Reception-only mode
1	Transmission/reception mode
<ul style="list-style-type: none"> • If TRMD_n = 0, reception-only transfers are performed. In addition, the SOn pin output is fixed at low level. Data reception is started by reading the SIO_n register. If TRMD_n = 1, transmission/reception is started by writing data to the SOTB_n register. • The TRMD_n bit can be overwritten only when CSOT_n = 0. 	

DIR _n	Transfer direction mode (MSB/LSB specification)
0	MSB first
1	LSB first
<ul style="list-style-type: none"> • The DIR_n bit can be overwritten only when CSOT_n = 0. 	

CSOT _n	This is a transfer status display flag.
0	Idle status
1	Transfer execution status
<ul style="list-style-type: none"> • This flag is used to judge whether writing to the shift register (SIO_n) is enabled or not when starting serial data transmission in transmission/reception mode (TRMD_n = 1) • The CSOT_n bit is reset when the CSIE bit is cleared (0). 	

Note CSIM4: V850ES/SA3 only

Caution Be sure to set bits 5 and 3 to 1 to 0.

Remark n = 0 to 3 (V850ES/SA2)
 n = 0 to 4 (V850ES/SA3)

(2) Clocked serial interface clock selection register n (CSICn)

The CSICn register is an 8-bit register that controls the transmit operation of CSIn.

This register can be read or written in 8-bit units.

Caution The CSICn register can only be overwritten after CSIE_n is cleared to 0 in the CSIM_n register.

After reset: 00H R/W Address: CSIC0: FFFFFFFD01H, CSIC1: FFFFFFFD11H, CSIC2: FFFFFFFD21H
 CSIC3: FFFFFFFD31H, CSIC4^{Note 1}: FFFFFFFD41H

	7	6	5	4	3	2	1	0
CSICn	0	0	0	CKPn	DAPn	CKSn2	CKSn1	CKSn0

CKPn	DAPn	Specification of data transmission/reception timing for SCKn
0	0	
0	1	
1	0	
1	1	

CKSn2	CKSn1	CKSn0	Input clock	Mode
0	0	0	$f_{xx}/2$	Master mode
0	0	1	$f_{xx}/4$	Master mode
0	1	0	$f_{xx}/8$	Master mode
0	1	1	$f_{xx}/16$	Master mode
1	0	0	$f_{xx}/32$	Master mode
1	0	1	$f_{xx}/64$	Master mode
1	1	0	TOM output ^{Note 2}	Master mode
1	1	1	External clock (SCKn)	Slave mode

Notes 1. CSIC4: V850ES/SA3 only

- 2. $m = 2$ when $n = 0$
- $m = 3$ when $n = 1$
- $m = 4$ when $n = 2$
- $m = 5$ when $n = 3$
- $m = 5$ when $n = 4$ (V850ES/SA3 only)

(a) Transfer rate selection example

CKSn2	CKSn1	CKSn0	Baud Rate (bps)				
			17 MHz Operation	13.5 MHz Operation	10 MHz Operation	8 MHz Operation	4 MHz Operation
0	0	0	Setting prohibited	Setting prohibited	5,000,000	4,000,000	2,000,000
0	0	1	4,250,000	3,375,000	2,500,000	2,000,000	1,000,000
0	1	0	2,125,000	1,687,500	1,250,000	1,000,000	500,000
0	1	1	1,062,500	843,750	625,000	500,000	250,000
1	0	0	531,250	421,875	312,500	250,000	125,000
1	0	1	265,625	210,938	156,250	125,000	62,500

(3) Serial I/O shift register n (SIO_n)

The SIO_n register is an 8-bit shift register that converts parallel data to serial data. If TRMD_n = 0 in the CSIM_n register, the transfer is started by reading SIO_n.

Except when a reset is input, the SIO_n register becomes 00H even when the CSIE_n bit of the CSIM_n register is cleared (0).

SIO_n shifts data in (reception) or shifts data out (transmission) beginning at the MSB or the LSB side.

This register is read-only, in 8-bit units.

Caution The SIO_n register can be accessed only when the system is in an idle state (CSOT_n bit = 0 in the CSIM_n register).

After reset: 00H R Address: SIO0: FFFFFFFD02H, SIO1: FFFFFFFD12H, SIO2: FFFFFFFD22H
SIO3: FFFFFFFD32H, SIO4^{Note}: FFFFFFFD42H

	7	6	5	4	3	2	1	0
SIO _n	SIO _n 7	SIO _n 6	SIO _n 5	SIO _n 4	SIO _n 3	SIO _n 2	SIO _n 1	SIO _n 0

Note SIO4: V850ES/SA3 only

Remark n = 0 to 3 (V850ES/SA2)
n = 0 to 4 (V850ES/SA3)

(4) Receive-only serial I/O shift register n (SIOE_n)

The SIOE_n register is an 8-bit shift register that converts parallel data into serial data. A receive operation does not start even if the SIOE_n register is read while the TRMD_n bit of the CSIM_n register is 0. Therefore this register is used to read the value of the SIO_n register (receive data) without starting a receive operation.

SIOE_n shifts data in (reception) beginning at the MSB or the LSB side.

Except when a reset is input, the SIOE_n register becomes 00H even when the CSIE_n bit of the CSIM_n register is cleared (0).

This register is read-only, in 8-bit units.

Caution The SIOE_n register can be accessed only when the system is in an idle state (CSOT_n bit = 0 in the CSIM_n register).

After reset: 00H R Address: SIOE0: FFFFFFFD03H, SIOE1: FFFFFFFD13H, SIOE2: FFFFFFFD23H
SIOE3: FFFFFFFD33H, SIOE4^{Note}: FFFFFFFD43H

	7	6	5	4	3	2	1	0
SIOE _n	SIOE _n 7	SIOE _n 6	SIOE _n 5	SIOE _n 4	SIOE _n 3	SIOE _n 2	SIOE _n 1	SIOE _n 0

Note SIOE4: V850ES/SA3 only

Remark n = 0 to 3 (V850ES/SA2)
n = 0 to 4 (V850ES/SA3)

(5) Clocked serial interface transmit buffer register n (SOTBn)

The SOTBn register is an 8-bit buffer register for storing transmit data.

If transmission/reception mode is set (TRMDn = 1 in the CSIMn register), a transmit operation is started by writing data to the SOTBn register.

$\overline{\text{RESET}}$ input clears the SOTBn register to 00H.

This register can be read or written in 8-bit units.

Caution The SOTBn register can be accessed only when the system is in an idle state (CSOTn bit = 0 in the CSIMn register).

After reset: 00H	R/W	Address: SOTB0: FFFFFFFD04H, SOTB1: FFFFFFFD14H, SOTB2: FFFFFFFD24H SOTB3: FFFFFFFD34H, SOTB4 ^{Note} : FFFFFFFD44H						
SOTBn	7	6	5	4	3	2	1	0
	SOTBn7	SOTBn6	SOTBn5	SOTBn4	SOTBn3	SOTBn2	SOTBn1	SOTBn0

Note SOTB4: V850ES/SA3 only

Remark n = 0 to 3 (V850ES/SA2)
n = 0 to 4 (V850ES/SA3)

12.3.4 Operation

(1) Transfer mode

CSIn transmits and receives data using three lines: 1 clock line and 2 data lines.

In reception-only mode (TRMDn = 0 in the CSIMn register), the transfer is started by reading the SIO_n register.

To read the value of the SIO_n register without starting reception, read the SIOEn register.

In transmission/reception mode (TRMDn = 1 in the CSIMn register), the transfer is started by writing data to the SOTBn register.

When an 8-bit transfer of CSIn ends, the CSOTn bit of the CSIMn register becomes 0, and transfer stops automatically. Also, when the transfer ends, a transmission/reception completion interrupt (INTCSIn) is generated.

Cautions 1. When CSOTn bit = 1 in the CSIMn register, the control registers and data registers should not be accessed.

2. If transmit data is written to the SOTBn register and the TRMDn bit of the CSIMn register is changed from 0 to 1, serial transfer is not performed.

Remark n = 0 to 3 (V850ES/SA2)

n = 0 to 4 (V850ES/SA3)

(2) Serial clock

(a) When internal clock is selected as the serial clock

If reception or transmission is started, a serial clock is output from the $\overline{\text{SCKn}}$ pin, and the data of the SIn pin is taken into the SIO_n register sequentially or data is output to the SOn pin sequentially from the SIO_n register when the data is synchronized with the serial clock in accordance with the setting of the CKPn and DAPn bits of the CSICn register.

(b) When external clock is selected as the serial clock

If reception or transmission is started, the data of the SIn pin is taken into the SIO_n register sequentially or output to the SOn pin sequentially in synchronization with the serial clock that has been input to the $\overline{\text{SCKn}}$ pin following transmission/reception startup in accordance with the setting of the CKPn and DAPn bits of the CSICn register.

If serial clock is input to the $\overline{\text{SCKn}}$ pin when neither reception nor transmission is started, a shift operation will not be executed.

Remark n = 0 to 3 (V850ES/SA2)

n = 0 to 4 (V850ES/SA3)

Figure 12-18. Transfer Timing

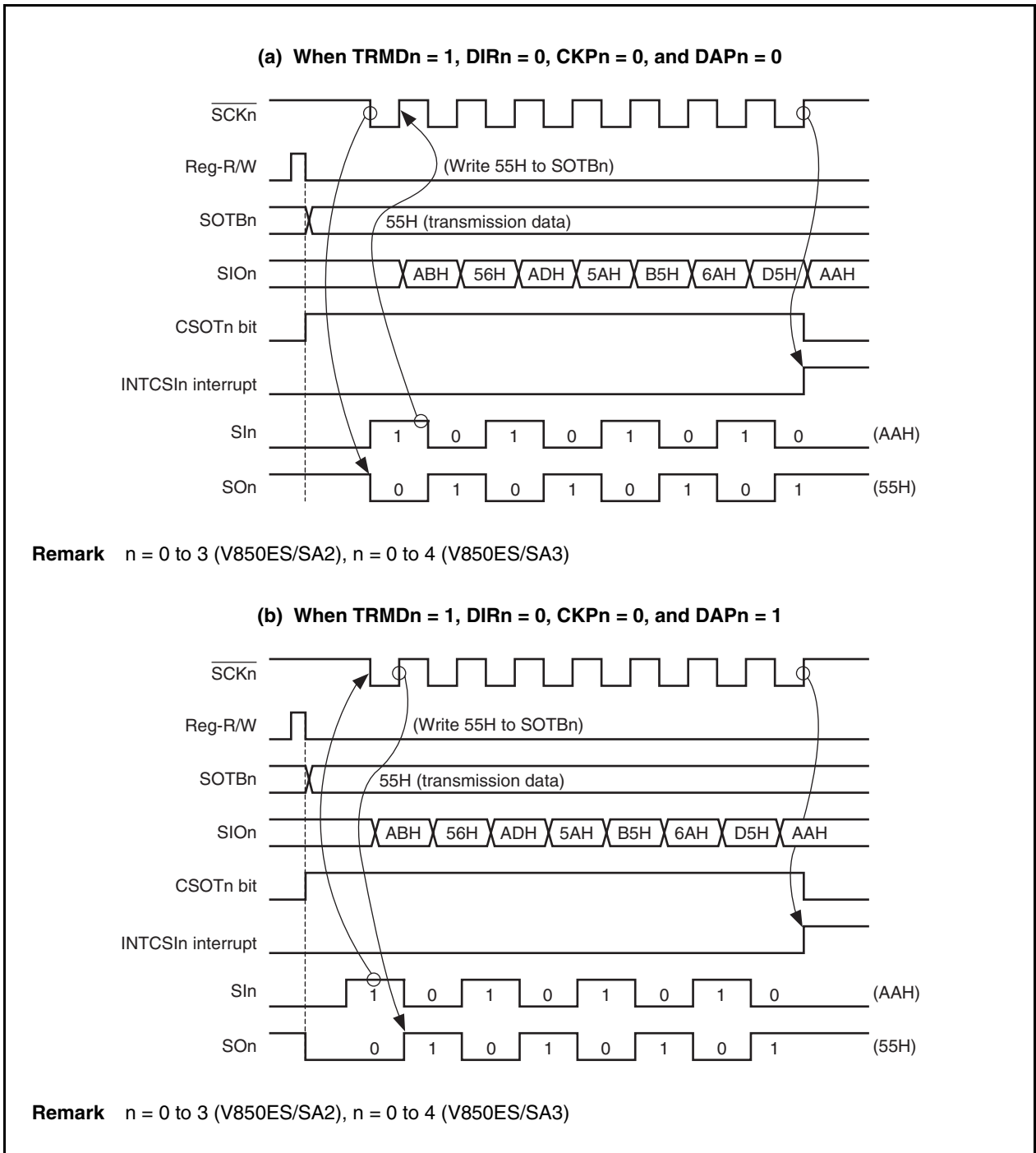
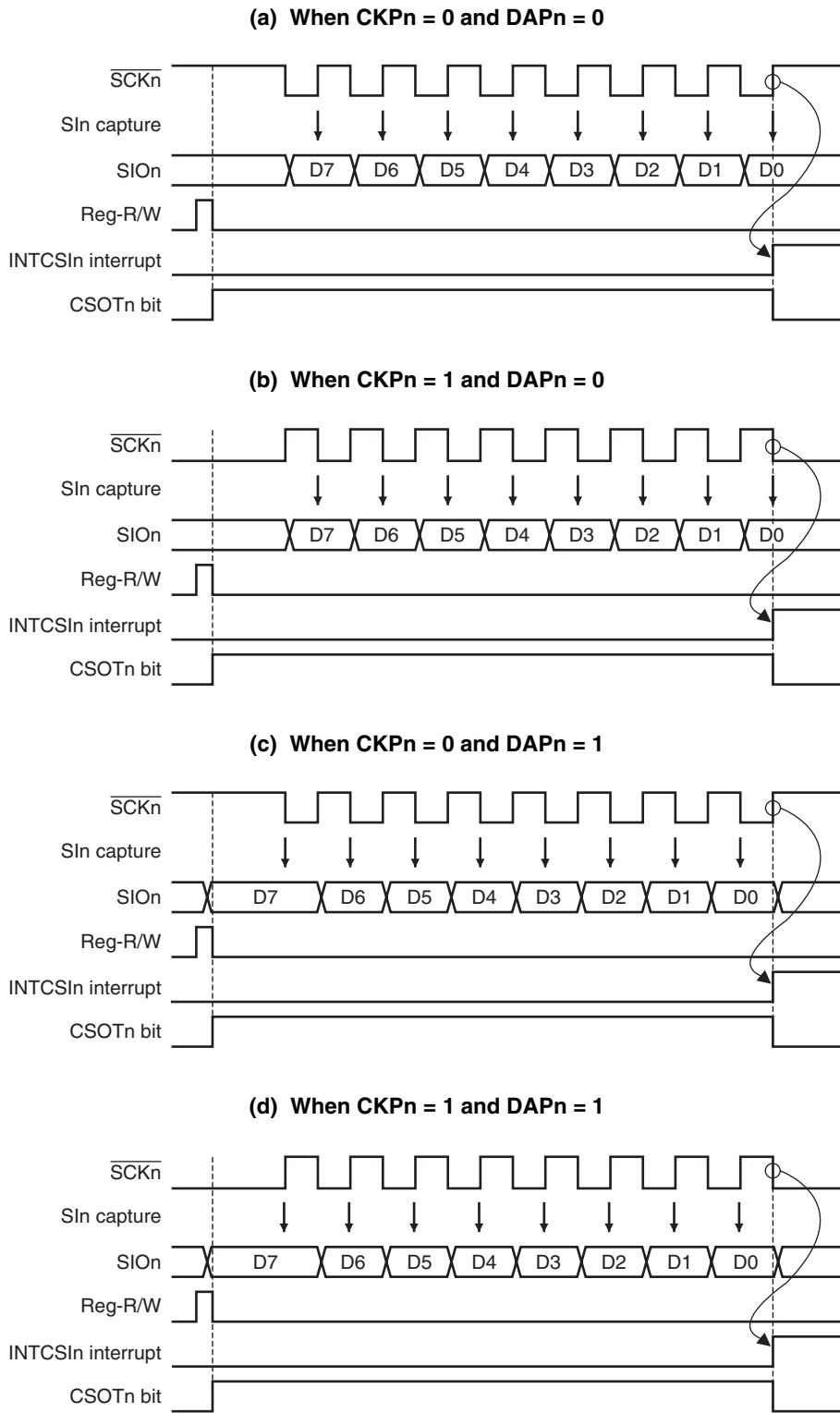


Figure 12-19. Clock Timing



Remark n = 0 to 3 (V850ES/SA2), n = 0 to 4 (V850ES/SA3)

12.3.5 Output pins

(1) $\overline{\text{SCKn}}$ pin

When CSIn operation is disabled (CSIE_n = 0), the $\overline{\text{SCKn}}$ pin output state is as follows.

CKP _n	$\overline{\text{SCKn}}$ Pin Output
0	Fixed to high level
1	Fixed to low level

- Remarks**
1. When the CKP_n bit is overwritten, the $\overline{\text{SCKn}}$ pin output changes.
 2. n = 0 to 3 (V850ES/SA2), n = 0 to 4 (V850ES/SA3)

(2) SOn pin

When CSIn operation is disabled (CSIE_n = 0), the SOn pin output state is as follows.

TRMD _n	DAP _n	DIR _n	SOn Pin Output
0	×	×	Fixed to low level
1	0	×	SOn latch value (low level)
	1	0	SOTB _{n7} value
		1	SOTB _{n0} value

- Remarks**
1. If any of the TRMD_n, DAP_n, and DIR_n bits is overwritten, the SOn pin output changes.
 2. n = 0 to 3 (V850ES/SA2), n = 0 to 4 (V850ES/SA3)
 3. ×: Don't care

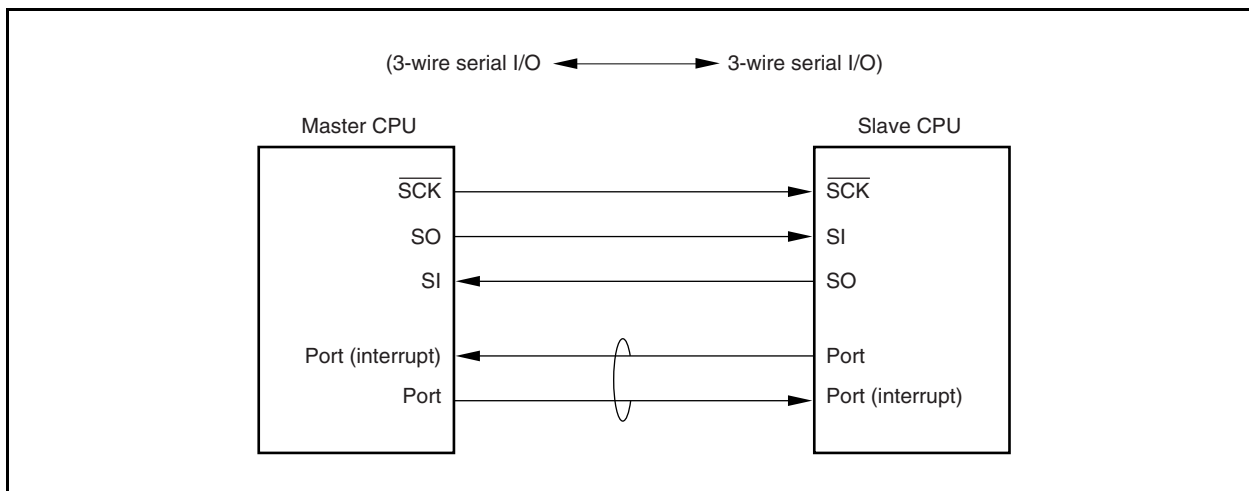
12.3.6 System configuration example

CSIn performs 8-bit length data transfer using three signal lines: a serial clock ($\overline{\text{SCKn}}$), serial input (SI_n), and serial output (SO_n). This is effective when connecting peripheral I/O that incorporate a conventional clocked serial interface, or a display controller to the V850ES/SA2 or V850ES/SA3 (n = 0 to 3 (V850ES/SA2), n = 0 to 4 (V850ES/SA3)).

When connecting the V850ES/SA2 or V850ES/SA3 to several devices, lines for handshake are required.

Since the first communication bit can be selected as MSB or LSB, communication with various devices can be achieved.

Figure 12-20. System Configuration Example of CSI



12.4 I²C Bus

To use the I²C bus function, set the P41/SO0/SDA and P42/ $\overline{\text{SCK0}}$ /SCL pins to N-ch open drain output.

I²C has the following two modes.

- Operation stopped mode
- I²C (Inter IC) bus mode (multiple masters supported)

(1) Operation stopped mode

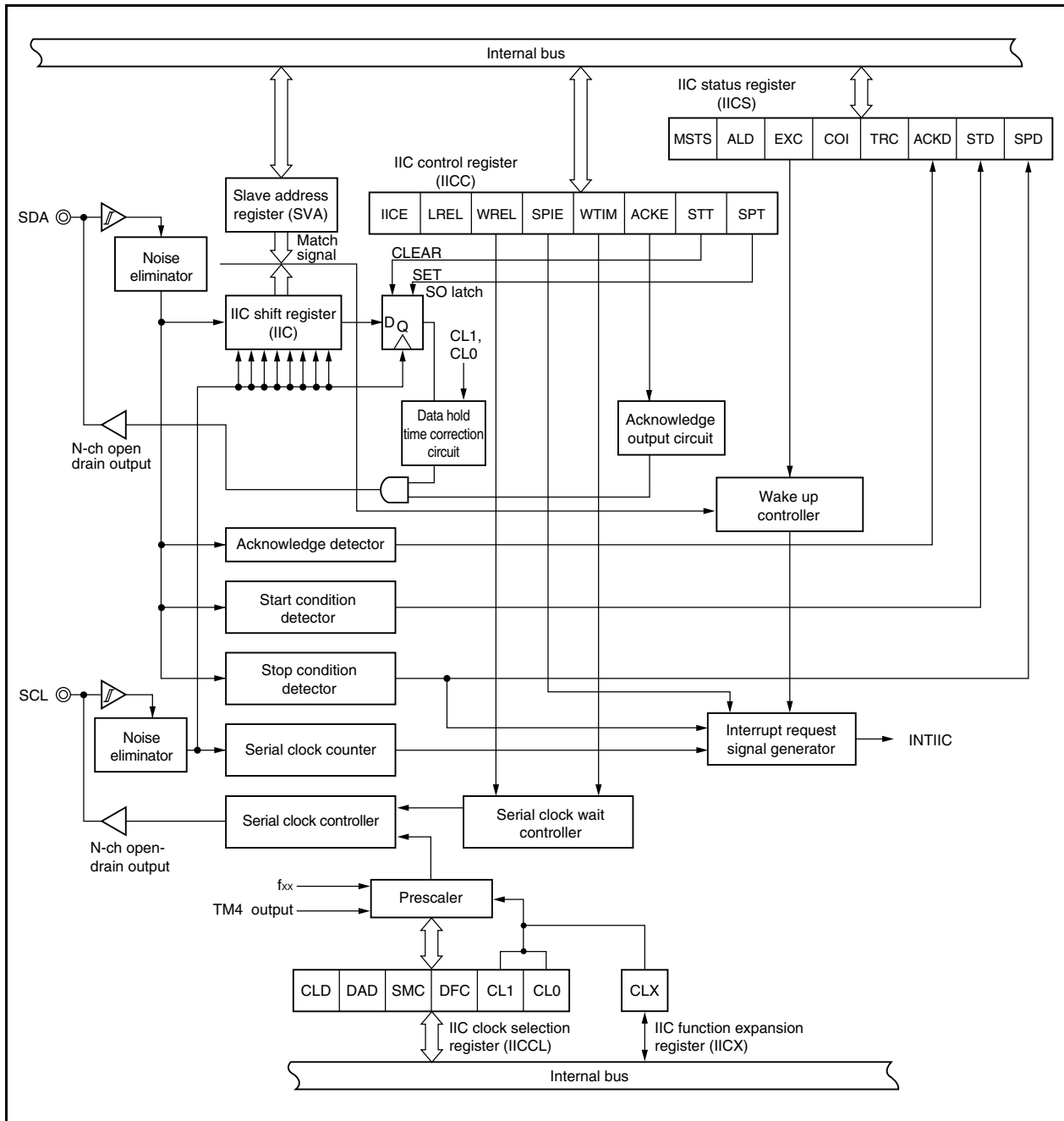
This mode is used when serial transfers are not performed. It can therefore be used to reduce power consumption.

(2) I²C bus mode (multiple masters supported)

This mode is used for 8-bit data transfers with several devices via two lines: a serial clock line (SCL) and a serial data bus line (SDA).

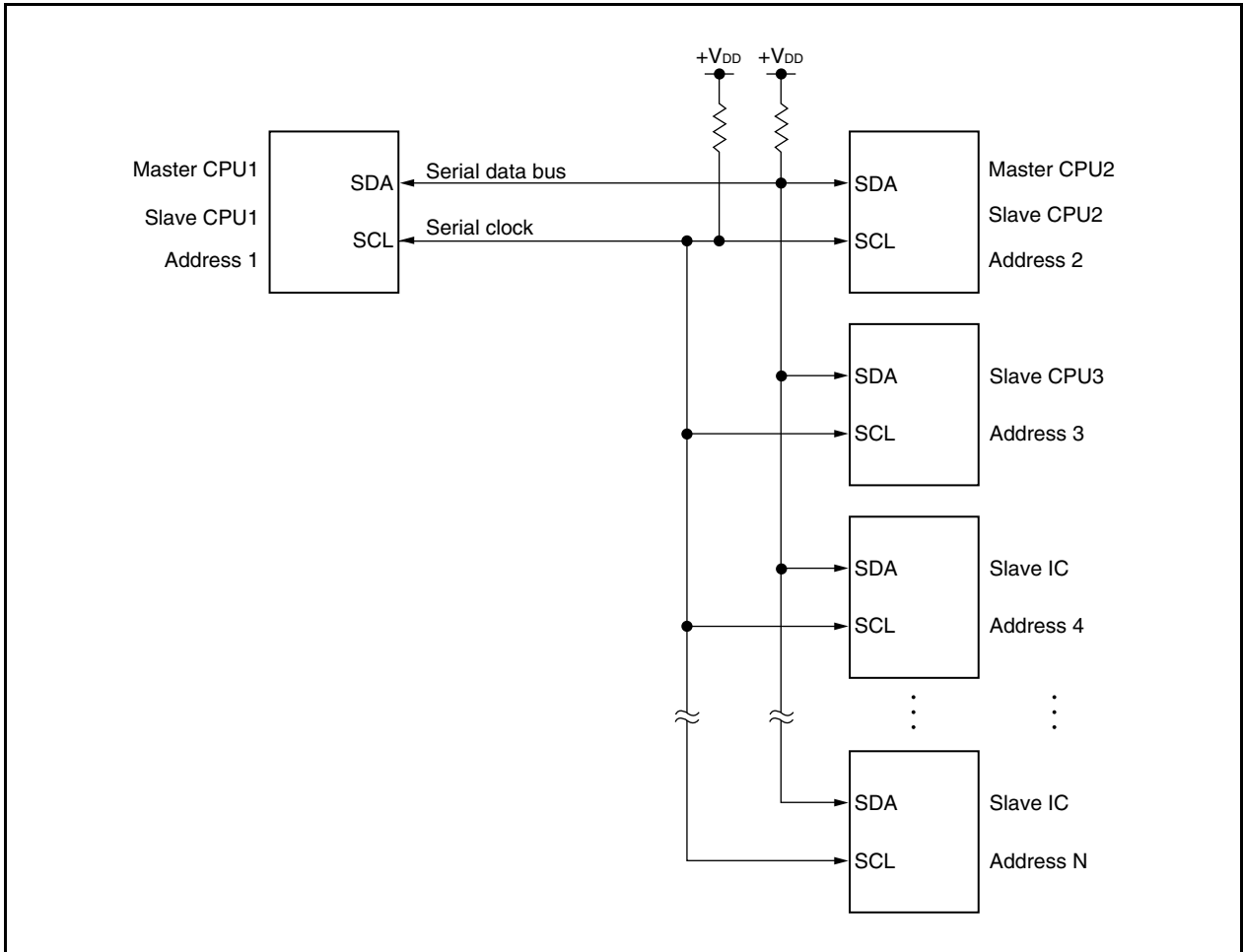
This mode complies with the I²C bus format and the master device can output “start condition”, “data”, and “stop condition” data to the slave device, via the serial data bus. The slave device automatically detects these received data by hardware. This function can simplify the part of application program that controls the I²C bus. Since SCL and SDA are open-drain outputs, the I²C bus requires pull-up resistors for the serial clock line and the serial data bus line.

Figure 12-21. Block Diagram of I²C



A serial bus configuration example is shown below.

Figure 12-22. Example of Serial Bus Configuration Using I²C Bus



12.4.1 Configuration

I²C includes the following hardware.

Table 12-5. Configuration of I²C

Item	Configuration
Registers	IIC shift register (IIC) Slave address register (SVA)
Control registers	IIC control register (IICC) IIC status register (IICS) IIC clock selection register (IICCL) IIC clock expansion register (IICCE) IICC function expansion register (IICX)

(1) IIC shift register (IIC)

The IIC register is used to convert 8-bit serial data to 8-bit parallel data and to convert 8-bit parallel data to 8-bit serial data. The IIC register can be used for both transmission and reception.

Write and read operations to the IIC register are used to control the actual transmit and receive operations.

IIC is set by an 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input clears the IIC register to 00H.

(2) Slave address register (SVA)

The SVA register sets local addresses when in slave mode.

The SVA register is set by an 8-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input clears the SVA register to 00H.

(3) SO latch

The SO latch is used to retain the SDA pin's output level.

(4) Wake-up controller

This circuit generates an interrupt request when the address received by this register matches the address value set to slave address register (SVA) or when an extension code is received.

(5) Clock selector

This selects the sampling clock to be used.

(6) Serial clock counter

This counter counts the serial clocks that are output and the serial clocks that are input during transmit/receive operations and is used to verify that 8-bit data was sent or received.

(7) Interrupt request signal generator

This circuit controls the generation of interrupt request signals (INTIIC).

An I²C interrupt is generated following either of two triggers.

- Eighth or ninth clock of the serial clock (set by WTIM bit^{Note})
- Interrupt request generated when a stop condition is detected (set by SPIE bit^{Note})

Note WTIM bit: Bit 3 of IIC control register (IICC)

SPIE bit: Bit 4 of IIC control register (IICC)

(8) Serial clock controller

In master mode, this circuit generates the clock output via the SCL pin from a sampling clock.

(9) Serial clock wait controller

This circuit controls the wait timing.

(10) ACK output circuit, stop condition detector, start condition detector, and ACK detector

These circuits are used to output and detect various control signals.

(11) Data hold time correction circuit

This circuit generates the hold time for data corresponding to the falling edge of the serial clock.

12.4.2 I²C control registers

I²C is controlled by the following registers.

- IIC control register (IICC)
- IIC status register (IICS)
- IIC clock selection register (IICCL)
- IIC function expansion register (IICX)

The following registers are also used.

- IIC shift register (IIC)
- Slave address register (SVA)

(1) IIC control register (IICC)

The IICC register is used to enable/disable I²C operations, set wait timing, and set other I²C operations.

The IICC register can be set by an 8-bit or 1-bit memory manipulation instruction.

$\overline{\text{RESET}}$ input clears the IICC register to 00H.

Caution When using the I²C bus mode, set the port in the control mode (refer to 12.1.2 CSI0 and selecting I²C mode).

Also set the N-ch open-drain output mode (refer to 4.3.5 (2) (e) Port function register 4 (PF4)).

After reset: 00H R/W Address: FFFFFFFD82H

	<7>	<6>	5	4	3	2	1	0
IICC	IICE	LREL	WREL	SPIE	WTIM	ACKE	STT	SPT

IICE	I ² C operation enable/disable specification
0	Operation stopped. IIC status register (IICS) preset. Internal operation stopped.
1	Operation enabled.
Condition for clearing (IICE = 0)	
<ul style="list-style-type: none"> • Cleared by instruction • When $\overline{\text{RESET}}$ is input 	
Condition for setting (IICE = 1)	
<ul style="list-style-type: none"> • Set by instruction 	

LREL	Exit from communications
0	Normal operation
1	This exits from the current communication operation and sets standby mode. This setting is automatically cleared after being executed. Its uses include cases in which a locally irrelevant extension code has been received. The SCL and SDA lines are set to high impedance. The following flags are cleared. • STD • ACKD • TRC • COI • EXC • MSTs • STT • SPT
The standby mode following exit from communications remains in effect until the following communication entry conditions are met.	
<ul style="list-style-type: none"> • After a stop condition is detected, restart is in master mode. • An address match or extension code reception occurs after the start condition. 	
Condition for clearing (LREL = 0) ^{Note}	
<ul style="list-style-type: none"> • Automatically cleared after execution • When $\overline{\text{RESET}}$ is input 	
Condition for setting (LREL = 1)	
<ul style="list-style-type: none"> • Set by instruction 	

Note This flag's signal is invalid when IICE = 0.

Remark STD: Bit 1 of IIC status register (IICS)
 ACKD: Bit 2 of IIC status register (IICS)
 TRC: Bit 3 of IIC status register (IICS)
 COI: Bit 4 of IIC status register (IICS)
 EXC: Bit 5 of IIC status register (IICS)
 MSTs: Bit 7 of IIC status register (IICS)

WREL	Wait cancellation control
0	Wait not canceled
1	Wait canceled. This setting is automatically cleared after wait is canceled.
Condition for clearing (WREL = 0) ^{Note}	
<ul style="list-style-type: none"> Automatically cleared after execution When RESET is input 	
Condition for setting (WREL = 1)	
<ul style="list-style-type: none"> Set by instruction 	

SPIE	Enable/disable generation of interrupt request when stop condition is detected
0	Disabled
1	Enabled
Condition for clearing (SPIE = 0) ^{Note}	
<ul style="list-style-type: none"> Cleared by instruction When RESET is input 	
Condition for setting (SPIE = 1)	
<ul style="list-style-type: none"> Set by instruction 	

WTIM	Control of wait and interrupt request generation
0	Interrupt request is generated at the eighth clock's falling edge. Master mode: After output of eight clocks, clock output is set to low level and wait is set. Slave mode: After input of eight clocks, the clock is set to low level and wait is set for master device.
1	Interrupt request is generated at the eighth clock's falling edge. Master mode: After output of eight clocks, clock output is set to low level and wait is set. Slave mode: After input of eight clocks, the clock is set to low level and wait is set for master device.
This bit's setting is invalid during an address transfer and is valid as the transfer is completed. When in master mode, a wait is inserted at the falling edge of the ninth clock during address transfers. For a slave device that has received a local address, a wait is inserted at the falling edge of the ninth clock after an ACK signal is issued. When the slave device has received an extension code, a wait is inserted at the falling edge of the eighth clock.	
Condition for clearing (WTIM = 0) ^{Note}	
<ul style="list-style-type: none"> Cleared by instruction When RESET is input 	
Condition for setting (WTIM = 1)	
<ul style="list-style-type: none"> Set by instruction 	

Note This flag's signal is invalid when IICE = 0.

ACKE	Acknowledge control	
0	Acknowledgement disable.	
1	Acknowledgement enabled. During the ninth clock period, the SDA line is set to low level. However, ACK is invalid during address transfers and is valid when EXC = 1.	
Condition for clearing (ACKE = 0)Note		Condition for setting (ACKE = 1)
<ul style="list-style-type: none"> • Cleared by instruction • When RESET is input 		<ul style="list-style-type: none"> • Set by instruction

STT	Start condition trigger	
0	Start condition not generated.	
1	<p>When bus is released (in STOP mode): Generates a start condition (for starting as master). The SDA line is changed from high level to low level and then the start condition is generated. Next, after the rated amount of time has elapsed, SCL is changed to low level.</p> <p>When bus is not used: This trigger functions as a start condition reserve flag. When set, it releases the bus and then automatically generates a start condition.</p> <p>In the wait state (when master device): Generates a restart condition after releasing the wait.</p>	
<p>Cautions concerning set timing</p> <ul style="list-style-type: none"> • For master reception: Cannot be set during transfer. Can be set only when ACKE has been set to 0 and slave has been notified of final reception. • For master transmission: A start condition cannot be generated normally during the ACK period. Set during the wait period. • Cannot be set at the same time as SPT 		
Condition for clearing (STT = 0)		Condition for setting (STT = 1)
<ul style="list-style-type: none"> • Cleared by instruction • Cleared by loss in arbitration • Cleared after start condition is generated by master device • When LREL = 1 • When IICE = 0 • Cleared when RESET is input 		<ul style="list-style-type: none"> • Set by instruction

Note This flag's signal is invalid when IICE = 0.

Remark Bit 1 (STT) is 0 if it is read immediately after data setting.

SPT	Stop condition trigger				
0	Stop condition is not generated.				
1	Stop condition is generated (termination of master device s transfer). After the SDA line goes to low level, either set the SCL line to high level or wait until it goes to high level. Next, after the rated amount of time has elapsed, the SDA line is changed from low level to high level and a stop condition is generated.				
<p>Cautions concerning set timing</p> <ul style="list-style-type: none"> • For master reception: Cannot be set during transfer. Can be set only when ACKE has been set to 0 and during the wait period after slave has been notified of final reception. • For master transmission: A stop condition cannot be generated normally during the ACK period. Set during the wait period. • Cannot be set at the same time as STT. • SPT can be set only when in master mode^{Note}. • When WTIM has been set to 0, if SPT is set during the wait period that follows output of eight clocks, note that a stop condition will be generated during the high-level period of the ninth clock. When a ninth clock must be output, WTIM should be changed from 0 to 1 during the wait period following output of eight clocks, and SPT should be set during the wait period that follows output of the ninth clock. 					
<table border="1"> <thead> <tr> <th>Condition for clearing (SPT = 0)</th> <th>Condition for setting (SPT = 1)</th> </tr> </thead> <tbody> <tr> <td> <ul style="list-style-type: none"> • Cleared by instruction • Cleared by loss in arbitration • Automatically cleared after stop condition is detected • When LREL = 1 • When IICE = 0 • Cleared when <u>RESET</u> is input </td> <td> <ul style="list-style-type: none"> • Set by instruction </td> </tr> </tbody> </table>		Condition for clearing (SPT = 0)	Condition for setting (SPT = 1)	<ul style="list-style-type: none"> • Cleared by instruction • Cleared by loss in arbitration • Automatically cleared after stop condition is detected • When LREL = 1 • When IICE = 0 • Cleared when <u>RESET</u> is input 	<ul style="list-style-type: none"> • Set by instruction
Condition for clearing (SPT = 0)	Condition for setting (SPT = 1)				
<ul style="list-style-type: none"> • Cleared by instruction • Cleared by loss in arbitration • Automatically cleared after stop condition is detected • When LREL = 1 • When IICE = 0 • Cleared when <u>RESET</u> is input 	<ul style="list-style-type: none"> • Set by instruction 				

Note Set SPT only in master mode. However, SPT must be set and a stop condition generated before the first stop condition is detected following the switch to the operation enabled status. For details, see **12.4.13**

Cautions.

Caution When bit 3 (TRC) of the IIC status register (IICS) is set to 1, WREL is set during the ninth clock and wait is canceled, after which TRC is cleared and the SDA line is set to high impedance.

Remark Bit 0 (SPT) is 0 if it is read immediately after data setting.

(2) IIC status register (IICS)

The IICS register is used to indicate the status of I²C.

The IICS register can be set by an 8-bit or 1-bit memory manipulation instruction. IICS is a read-only register.

$\overline{\text{RESET}}$ input clears the IICS register to 00H.

(1/3)

After reset: 00H R Address: FFFFFFFD86H

	7	6	5	4	3	2	1	0
IICS	MSTS	ALD	EXC	COI	TRC	ACKD	STD	SPD

MSTS	Master device status
0	Slave device status or communication standby status
1	Master device communication status
Condition for clearing (MSTS = 0)	
<ul style="list-style-type: none"> When a stop condition is detected When ALD = 1 Cleared by LREL = 1 When IICE changes from 1 to 0 When $\overline{\text{RESET}}$ is input 	
Condition for setting (MSTS = 1)	
<ul style="list-style-type: none"> When a start condition is generated 	

ALD	Detection of arbitration loss
0	This status means either that there was no arbitration or that the arbitration result was a "win".
1	This status indicates the arbitration result was a "loss". MSTS is cleared.
Condition for clearing (ALD = 0)	
<ul style="list-style-type: none"> Automatically cleared after IICS is read^{Note} When IICE changes from 1 to 0 When $\overline{\text{RESET}}$ is input 	
Condition for setting (ALD = 1)	
<ul style="list-style-type: none"> When the arbitration result is a "loss". 	

EXC	Detection of extension code reception
0	Extension code was not received.
1	Extension code was received.
Condition for clearing (EXC = 0)	
<ul style="list-style-type: none"> When a start condition is detected When a stop condition is detected Cleared by LREL = 1 When IICE changes from 1 to 0 When $\overline{\text{RESET}}$ is input 	
Condition for setting (EXC = 1)	
<ul style="list-style-type: none"> When the higher four bits of the received address data is either "0000" or "1111" (set at the rising edge of the eighth clock). 	

Note This register is also cleared when a bit manipulation instruction is executed for bits other than IICS.

Remark LREL: Bit 6 of IIC control register (IICC)
IICE: Bit 7 of IIC control register (IICC)

COI	Detection of matching addresses	
0	Addresses do not match.	
1	Addresses match.	
Condition for clearing (COI = 0)		Condition for setting (COI = 1)
<ul style="list-style-type: none"> • When a start condition is detected • When a stop condition is detected • Cleared by LREL = 1 • When IICE changes from 1 to 0 • When RESET is input 		<ul style="list-style-type: none"> • When the received address matches the local address (SVA) (set at the rising edge of the eighth clock).

TRC	Detection of transmit/receive status	
0	Receive status (other than transmit status). The SDA line is set to high impedance.	
1	Transmit status. The value in the SO latch is enabled for output to the SDA line (valid starting at the falling edge of the first byte's ninth clock).	
Condition for clearing (TRC = 0)		Condition for setting (TRC = 1)
<ul style="list-style-type: none"> • When a stop condition is detected • Cleared by LREL = 1 • When IICE changes from 1 to 0 • Cleared by WREL = 1^{Note} • When ALD changes from 0 to 1 • When RESET is input <p>Master</p> <ul style="list-style-type: none"> • When "1" is output to the first byte's LSB (transfer direction specification bit) <p>Slave</p> <ul style="list-style-type: none"> • When a start condition is detected <p>When not used for communication</p>		<p>Master</p> <ul style="list-style-type: none"> • When a start condition is generated <p>Slave</p> <ul style="list-style-type: none"> • When "1" is input by the first byte's LSB (transfer direction specification bit)

Note TRC is cleared and the SDA line becomes high impedance when bit 5 (WREL) of the IIC control register (IICC) is set and the wait state is released at ninth clock when bit 3 (TRC) of the IIC status register (IICS) = 1.

Remark WREL: Bit 5 of IIC control register (IICC)
 LREL: Bit 6 of IIC control register (IICC)
 IICE: Bit 7 of IIC control register (IICC)

ACKD	Detection of acknowledge	
0	Acknowledge was not detected.	
1	Acknowledge was detected.	
Condition for clearing (ACKD = 0)		Condition for setting (ACKD = 1)
<ul style="list-style-type: none"> • When a stop condition is detected • At the rising edge of the next byte's first clock • Cleared by LREL = 1 • When IICE changes from 1 to 0 • When RESET is input 		<ul style="list-style-type: none"> • After the SDA line is set to low level at the rising edge of the SCL's ninth clock

STD	Detection of start condition	
0	Start condition was not detected.	
1	Start condition was detected. This indicates that the address transfer period is in effect.	
Condition for clearing (STD = 0)		Condition for setting (STD = 1)
<ul style="list-style-type: none"> • When a stop condition is detected • At the rising edge of the next byte's first clock following address transfer • Cleared by LREL = 1 • When IICE changes from 1 to 0 • When $\overline{\text{RESET}}$ is input 		When a start condition is detected

SPD	Detection of stop condition	
0	Stop condition was not detected.	
1	Stop condition was detected. The master device's communication is terminated and the bus is released.	
Condition for clearing (SPD = 0)		Condition for setting (SPD = 1)
<ul style="list-style-type: none"> • At the rising edge of the address transfer byte's first clock following setting of this bit and detection of a start condition • When IICE changes from 1 to 0 • When $\overline{\text{RESET}}$ is input 		When a stop condition is detected

Remark LREL: Bit 6 of IIC control register (IICC)

IICE: Bit 7 of IIC control register (IICC)

(3) IIC clock selection register (IICCL)

The IICCL register is used to set the transfer clock for I²C.

The IICCL register can be set by an 8-bit or 1-bit memory manipulation instruction. Set the SMC, CL1, and CL0 bits in combination with the CLX bit of the IIC function expansion register (IICX) (see **Table 12-6 Selection Clock Setting**).

$\overline{\text{RESET}}$ input clears the IICCL register to 00H.

After reset: 00H R/W^{Note} Address: FFFFFFFD84H

	7	6	5	4	3	2	1	0
IICCL	0	0	CLD	DAD	SMC	DFC	CL1	CL0

CLD	Detection of SCL line level (valid only when IICE = 1)
0	SCL line was detected at low level.
1	SCL line was detected at high level.
Condition for clearing (CLD = 0)	
<ul style="list-style-type: none"> • When the SCL line is low level • When IICE = 0 • When $\overline{\text{RESET}}$ is input 	
Condition for setting (CLD = 1)	
<ul style="list-style-type: none"> • When the SCL0 line is high level 	

DAD	Detection of SDA line level (valid only when IICE = 1)
0	SDA line was detected at low level.
1	SDA line was detected at high level.
Condition for clearing (DAD = 0)	
<ul style="list-style-type: none"> • When the SDA line is low level • When IICE = 0 • When $\overline{\text{RESET}}$ is input 	
Condition for setting (DAD = 1)	
<ul style="list-style-type: none"> • When the SDA line is high level 	

SMC	Operation mode switching
0	Operates in standard mode.
1	Operates in high-speed mode.

DFC	Digital filter operation control
0	Digital filter off.
1	Digital filter on.
The digital filter can be used only in high-speed mode. In high-speed mode, the transfer clock does not vary regardless of DFC switching (on/off).	

Note Bits 4 and 5 are read-only bits.

Remark IICE: Bit 7 of IIC control register (IICC)

(4) IIC function expansion register (IICX)

The IICX register is used to set the function expansion of I²C (valid only in high-speed mode).

The IICX register is set by an 8-bit or 1-bit memory manipulation instruction. Set the CLX bit in combination with the SMC, CL1, and CL0 bits of the IIC clock selection register (IICCL) (see **Table 12-6 Transfer Clock Setting**).

RESET input clears the IICX register to 00H.

After reset: 00H		R/W		Address: FFFFFFFD85H					
IICX	7	6	5	4	3	2	1	0	
	0	0	0	0	0	0	0	CLX	

(5) I²C transfer clock setting method

The I²C transfer clock frequency (f_{SCL}) is calculated using the following expression.

$$f_{SCL} = 1/(m \times T + t_R + t_F)$$

m = 12, 24, 48, 36, 54, 44, 86, 172, 132, 198 (see **Table 12-6 Transfer Clock Setting**.)

T: 1/f_{xx}

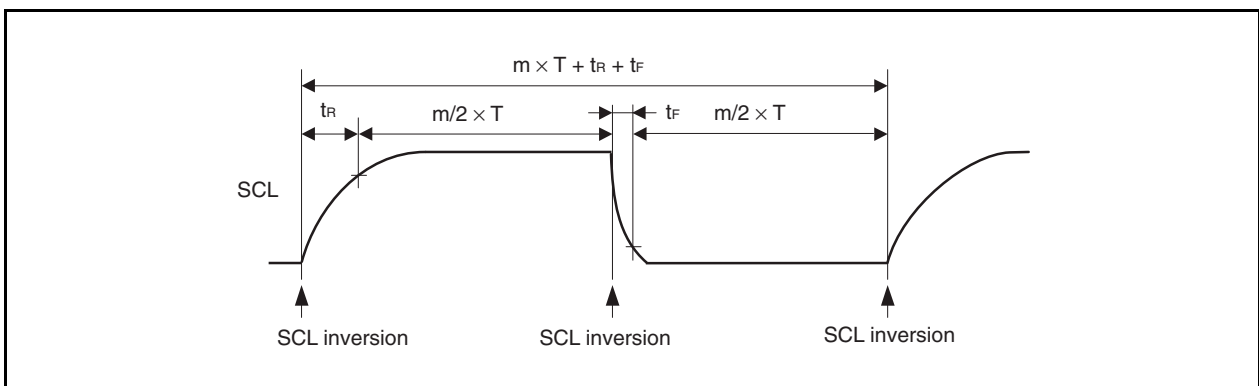
t_R: SCL rise time

t_F: SCL fall time

For example, the I²C transfer clock frequency (f_{SCL}) when f_{xx} = 16 MHz, m = 198, t_R = 200 ns, and t_F = 50 ns is calculated using the following expression.

$$f_{SCL} = 1/(198 \times 62.5 \text{ ns} + 200 \text{ ns} + 50 \text{ ns}) \cong 79.2 \text{ kHz}$$

Figure 12-23. I²C Transfer Clock Frequency (f_{SCL})



The transfer clock is set using a combination of the SMC, CL1, and CL0 bits of IIC clock select register (IICCL), the CLX bit of IIC function expansion register (IICX).

Table 12-6. Transfer Clock Setting

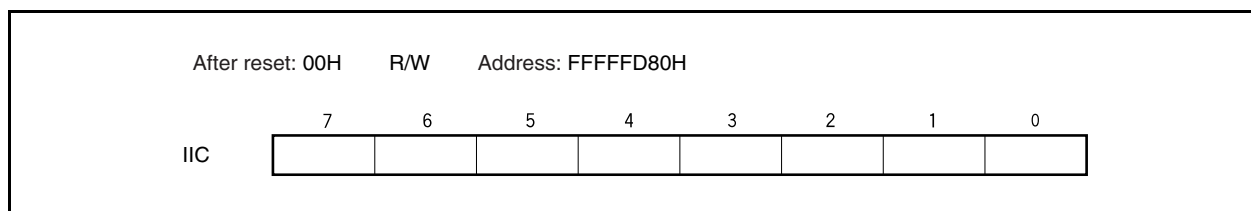
IICX	IICCL			Transfer Clock	Settable Main Clock Frequency (f _{xx}) Range	Operation Mode
	Bit 0	Bit 3	Bit1			
CLX	SMC	CL1	CL0			
0	0	0	0	f _{xx} /88	4.0 MHz to 8.38 MHz	Normal mode (SMC = 0)
0	0	0	1	f _{xx} /172	8.38 MHz to 16.76 MHz	
0	0	1	0	f _{xx} /86	4.19 MHz to 8.38 MHz	
0	0	1	1	TO4 output/66	TM4 Setting ^{Note}	
0	1	0	×	f _{xx} /48	8 MHz to 16.76 MHz	High-speed mode (SMC = 1)
0	1	1	0	f _{xx} /24	4 MHz to 8.38 MHz	
0	1	1	1	TO4 output/18	TM4 Setting ^{Note}	
1	0	×	×	Setting prohibited		
1	1	0	×	f _{xx} /24	8.00 MHz to 8.38 MHz	Normal mode (SMC = 0)
1	1	1	0	f _{xx} /12	4.00 MHz to 4.19 MHz	
1	1	1	1	Setting prohibited		

Remarks 1. ×: Don't care

- When the transfer clock is set to timer output, the P96/TO4/A6 pin does not need to be set in timer output mode.

(6) IIC shift register (IIC)

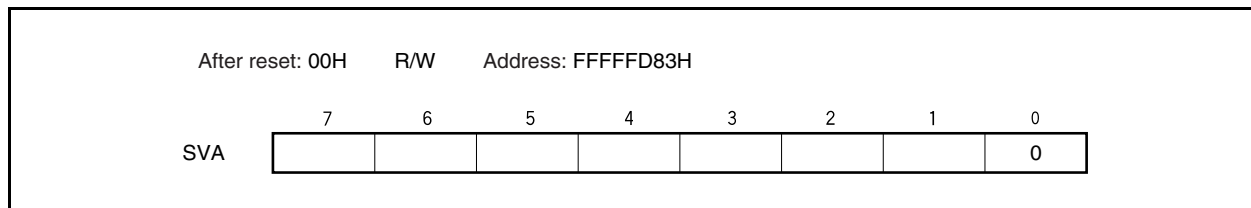
The IIC register is used for serial transmission/reception (shift operations) that are synchronized with the serial clock. It can be read from or written to in 8-bit units, but data should not be written to IIC during a data transfer.



(7) Slave address register (SVA)

The SVA register holds the I²C bus's slave addresses.

It can be read from or written to in 8-bit units, but bit 0 should be fixed to 0.



12.4.3 I²C bus mode functions

(1) Pin configuration

The serial clock pin (SCL) and serial data bus pin (SDA) are configured as follows.

SCL This pin is used for serial clock I/O.

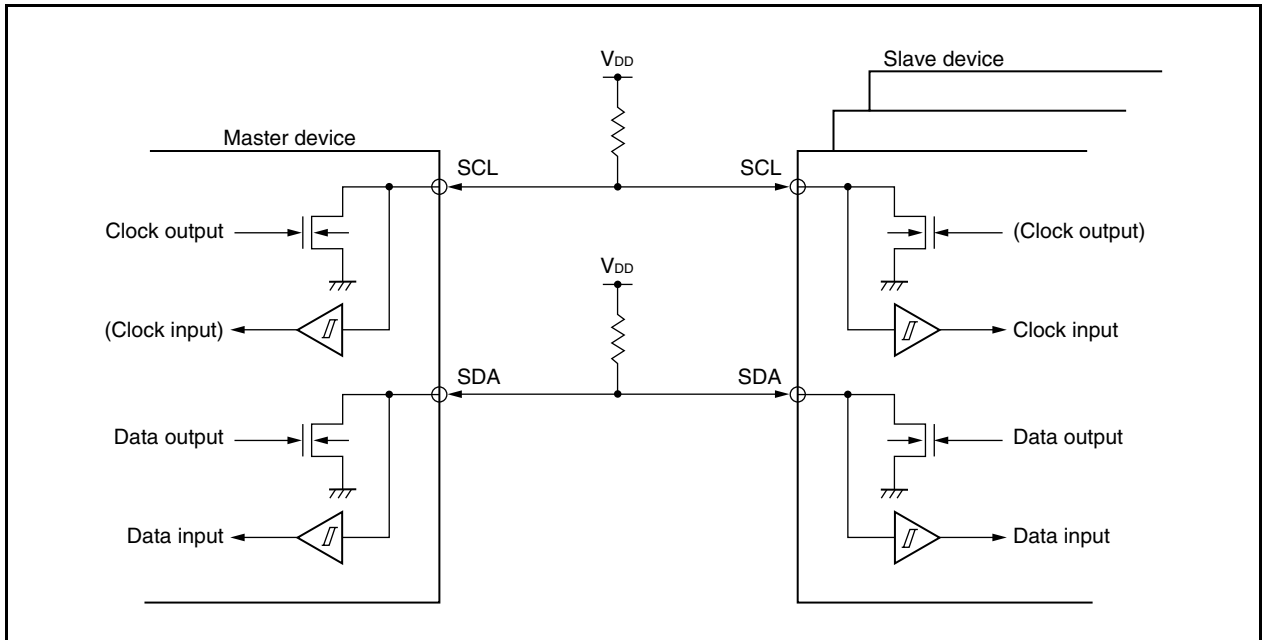
This pin is an N-ch open-drain output for both master and slave devices. Input is Schmitt input.

SDA This pin is used for serial data I/O.

This pin is an N-ch open-drain output for both master and slave devices. Input is Schmitt input.

Since outputs from the serial clock line and the serial data bus line are N-ch open-drain outputs, an external pull-up resistor is required.

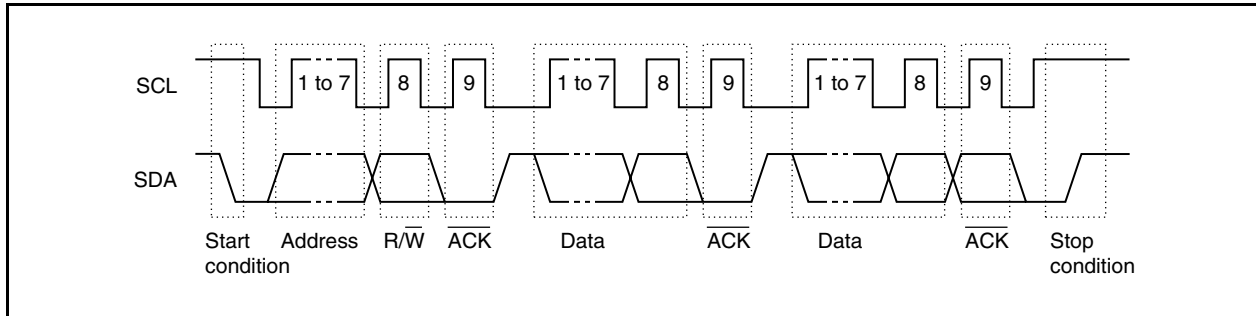
Figure 12-24. Pin Configuration Diagram



12.4.4 I²C bus definitions and control methods

The following section describes the I²C bus's serial data communication format and the signals used by the I²C bus. The transfer timing for the "start condition", "data", and "stop condition" output via the I²C bus's serial data bus is shown below.

Figure 12-25. I²C Bus Serial Data Transfer Timing



The master device outputs the start condition, slave address, and stop condition.

The acknowledge signal ($\overline{\text{ACK}}$) can be output by either the master or slave device (normally, it is output by the device that receives 8-bit data).

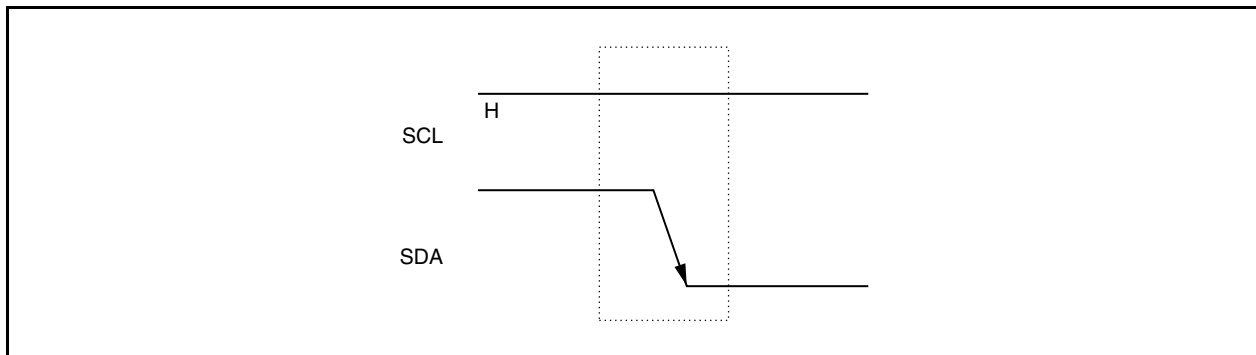
The serial clock (SCL) is continuously output by the master device. However, in the slave device, SCL's low-level period can be extended and a wait can be inserted.

(1) Start condition

A start condition is met when the SCL pin is at high level and the SDA pin changes from high level to low level.

The start conditions for the SCL pin and SDA pin are signals that the master device outputs to the slave device when starting a serial transfer. The slave device includes hardware for detecting start conditions.

Figure 12-26. Start Conditions



A start condition is output when bit 1 (STT) of the IIC control register (IICC) is set to 1 after a stop condition has been detected (SPD: Bit 0 = 1 in IIC status register (IICS)). When a start condition is detected, bit 1 (STD) of IICS is set to 1.

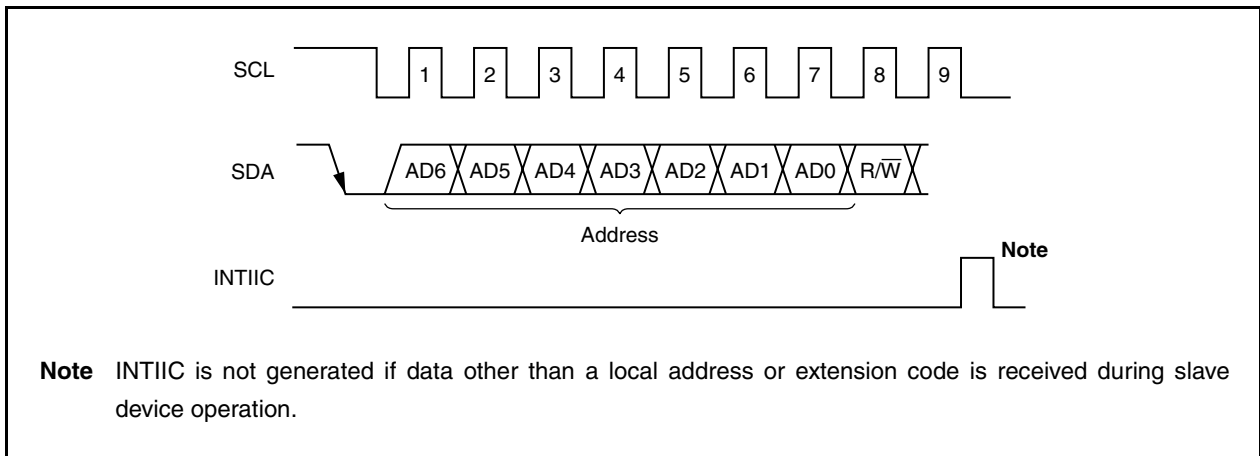
(2) Addresses

The 7 bits of data that follow the start condition are defined as an address.

An address is a 7-bit data segment that is output in order to select one of the slave devices that are connected to the master device via bus lines. Therefore, each slave device connected via the bus lines must have a unique address.

The slave devices include hardware that detects the start condition and checks whether or not the 7-bit data matches the data values stored in slave address register (SVA). If the 7-bit data matches the SVA register values, the slave device is selected and communicates with the master device until the master device transmits a start condition or stop condition.

Figure 12-27. Address



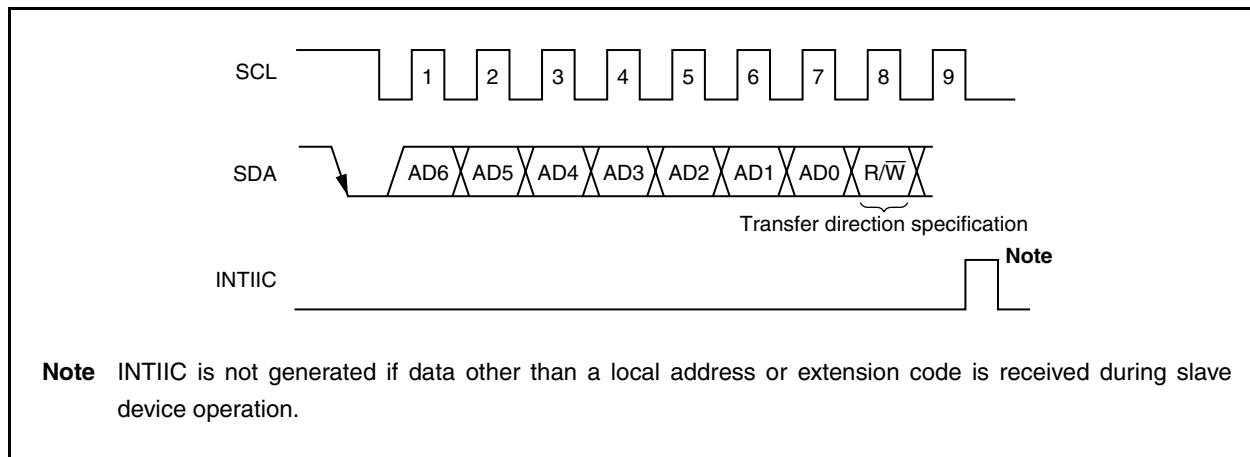
The slave address and the eighth bit, which specifies the transfer direction as described in **(3) Transfer direction specification** below, are written together to the IIC shift register (IIC) and are then output. Received addresses are written to IIC.

The slave address is assigned to the higher 7 bits of the IIC register.

(3) Transfer direction specification

In addition to the 7-bit address data, the master device sends 1 bit that specifies the transfer direction. When this transfer direction specification bit has a value of 0, it indicates that the master device is transmitting data to a slave device. When the transfer direction specification bit has a value of 1, it indicates that the master device is receiving data from a slave device.

Figure 12-28. Transfer Direction Specification



Note INTIIC is not generated if data other than a local address or extension code is received during slave device operation.

(4) Acknowledge signal ($\overline{\text{ACK}}$)

The acknowledge signal ($\overline{\text{ACK}}$) is used by the transmitting and receiving devices to confirm serial data reception.

The receiving device returns one $\overline{\text{ACK}}$ signal for each 8 bits of data it receives. The transmitting device normally receives an $\overline{\text{ACK}}$ signal after transmitting 8 bits of data. However, when the master device is the receiving device, it does not output an $\overline{\text{ACK}}$ signal after receiving the final data to be transmitted. The transmitting device detects whether or not an $\overline{\text{ACK}}$ signal is returned after it transmits 8 bits of data. When an $\overline{\text{ACK}}$ signal is returned, the reception is judged as normal and processing continues. If the slave device does not return an $\overline{\text{ACK}}$ signal, the master device outputs either a stop condition or a restart condition and then stops the current transmission. Failure to return an $\overline{\text{ACK}}$ signal may be caused by the following two factors.

- <1> Reception was not correctly performed.
- <2> The final data was received.

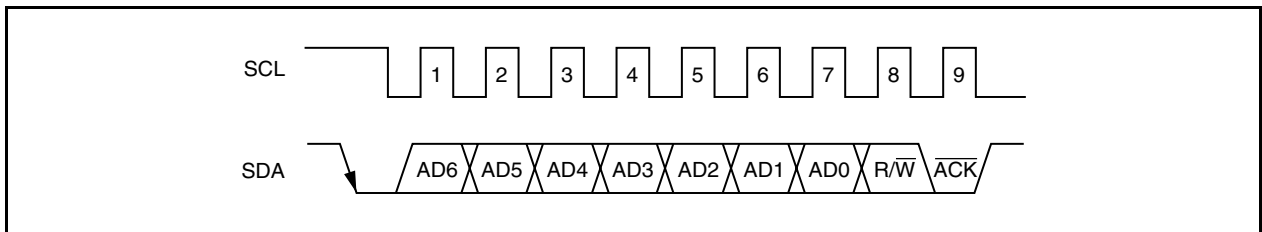
When the receiving device sets the SDA line to low level during the ninth clock, the $\overline{\text{ACK}}$ signal becomes active (normal receive response).

When bit 2 (ACKE) of the IIC control register (IICC) is set to 1, automatic $\overline{\text{ACK}}$ signal generation is enabled. Transmission of the eighth bit following the 7 address data bits causes bit 3 (TRC) of the IIC status register (IICS) to be set. When the TRC bit's value is 0, it indicates receive mode. Therefore, ACKE should be set to 1.

When the slave device is receiving (when TRC = 0), if the slave device does not need to receive any more data after receiving several bytes, setting ACKE to 0 will prevent the master device from starting transmission of the subsequent data.

Similarly, when the master device is receiving (when TRC = 0) and the subsequent data is not needed and when either a restart condition or a stop condition should therefore be output, setting ACKE to 0 will prevent the $\overline{\text{ACK}}$ signal from being returned. This prevents the MSB data from being output via the SDA line (i.e., stops transmission) during transmission from the slave device.

Figure 12-29. $\overline{\text{ACK}}$ Signal



When the local address is received, an $\overline{\text{ACK}}$ signal is automatically output in synchronization with the falling edge of the eighth clock of SCL regardless of the ACKE bit value. No $\overline{\text{ACK}}$ signal is output if the received address is not a local address.

The $\overline{\text{ACK}}$ signal output method during data reception is based on the wait timing setting, as described below.

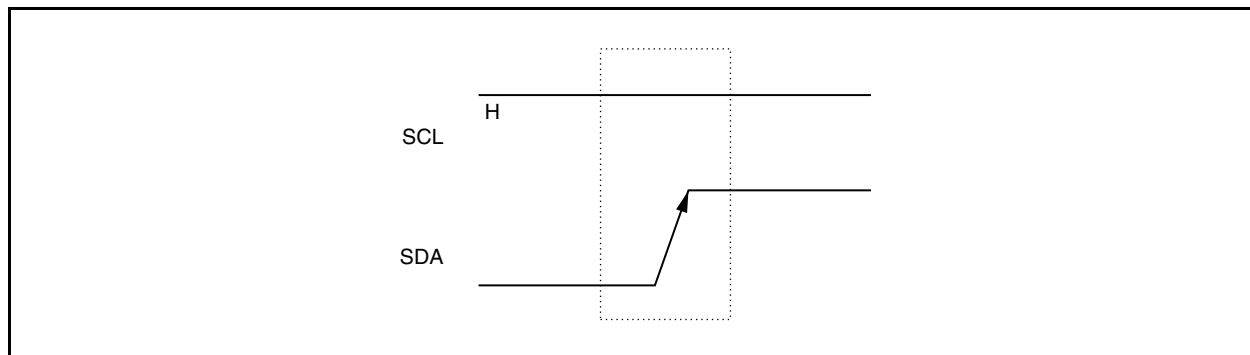
When 8-clock wait is selected: The $\overline{\text{ACK}}$ signal is output at the falling edge of the eighth clock of SCL if ACKE is set to 1 before wait cancellation.

When 9-clock wait is selected: The $\overline{\text{ACK}}$ signal is automatically output at the falling edge of the eighth clock of SCL if ACKE has already been set to 1.

(5) Stop condition

When the SCL pin is at high level, changing the SDA pin from low level to high level generates a stop condition.

A stop condition is a signal that the master device outputs to the slave device when serial transfer has been completed. The slave device includes hardware that detects stop conditions.

Figure 12-30. Stop Condition

A stop condition is generated when bit 0 (SPT) of the IIC control register (IICC) is set to 1. When the stop condition is detected, bit 0 (SPD) of the IIC status register (IICS) is set to 1 and INTIIC is generated when bit 4 (SPIE) of IICC is set to 1.

(6) Wait signal ($\overline{\text{WAIT}}$)

The wait signal ($\overline{\text{WAIT}}$) is used to notify the communication partner that a device (master or slave) is preparing to transmit or receive data (i.e., is in a wait state).

Setting the SCL pin to low level notifies the communication partner of the wait status. When the wait status has been canceled for both the master and slave devices, the next data transfer can begin.

Figure 12-31. Wait Signal (1/2)

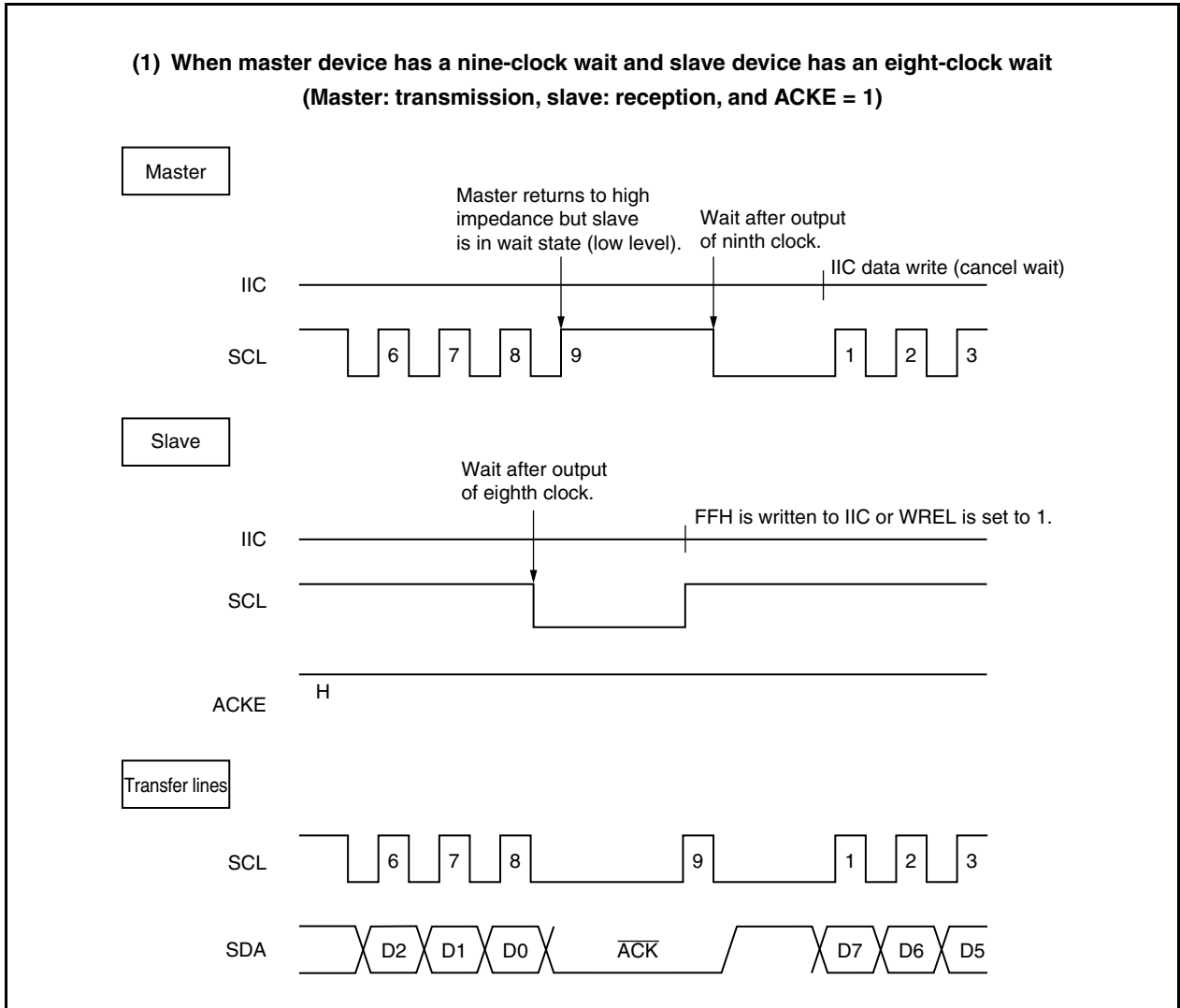
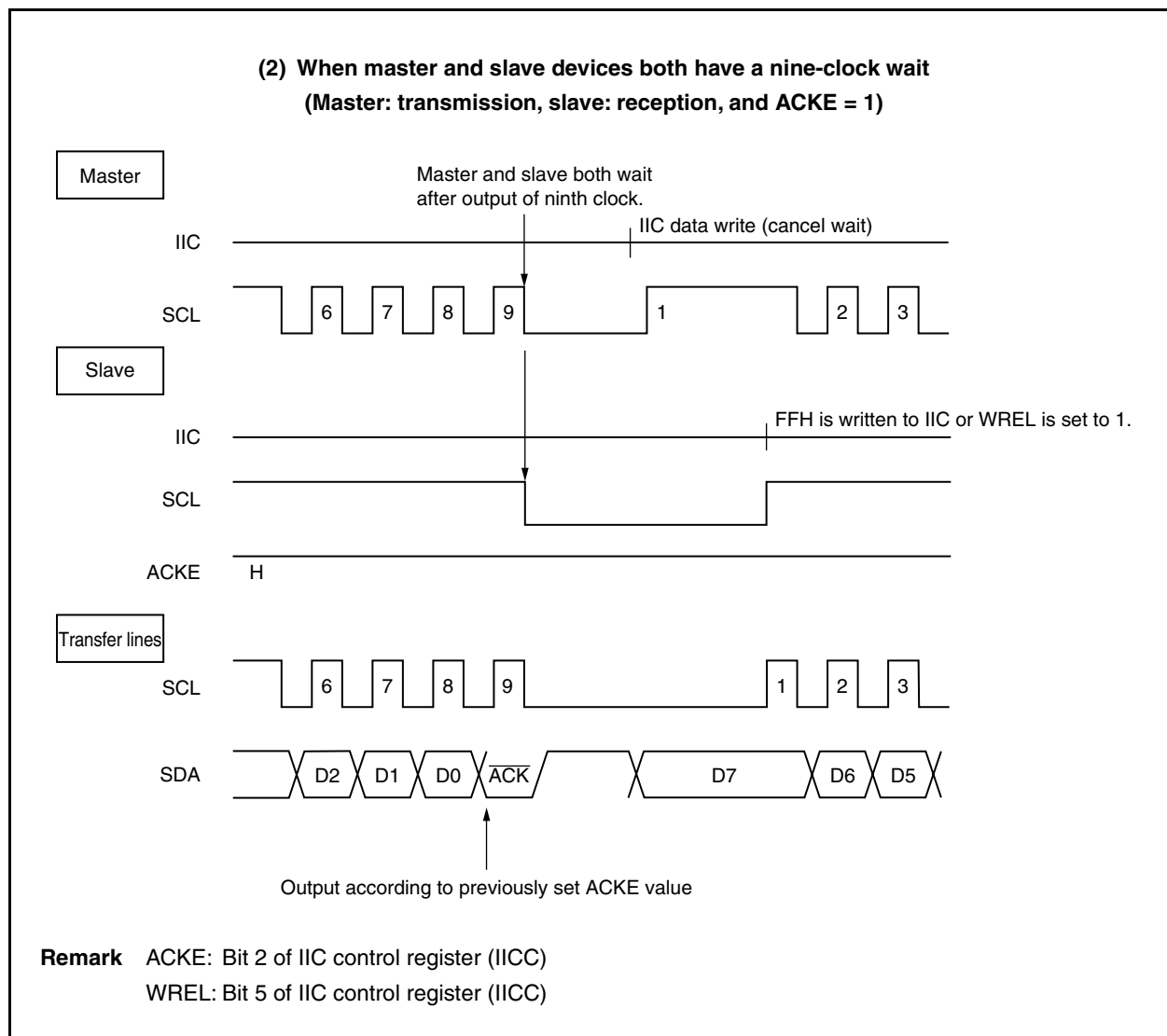


Figure 12-31. Wait Signal (2/2)



A wait may be automatically generated depending on the setting of bit 3 (WTIM) of the IIC control register (IICC).

Normally, when bit 5 (WREL) of the IICC register is set to 1 or when FFH is written to the IIC shift register (IIC), the wait status is canceled and the transmitting side writes data to the IIC register to cancel the wait status.

The master device can also cancel the wait status via either of the following methods.

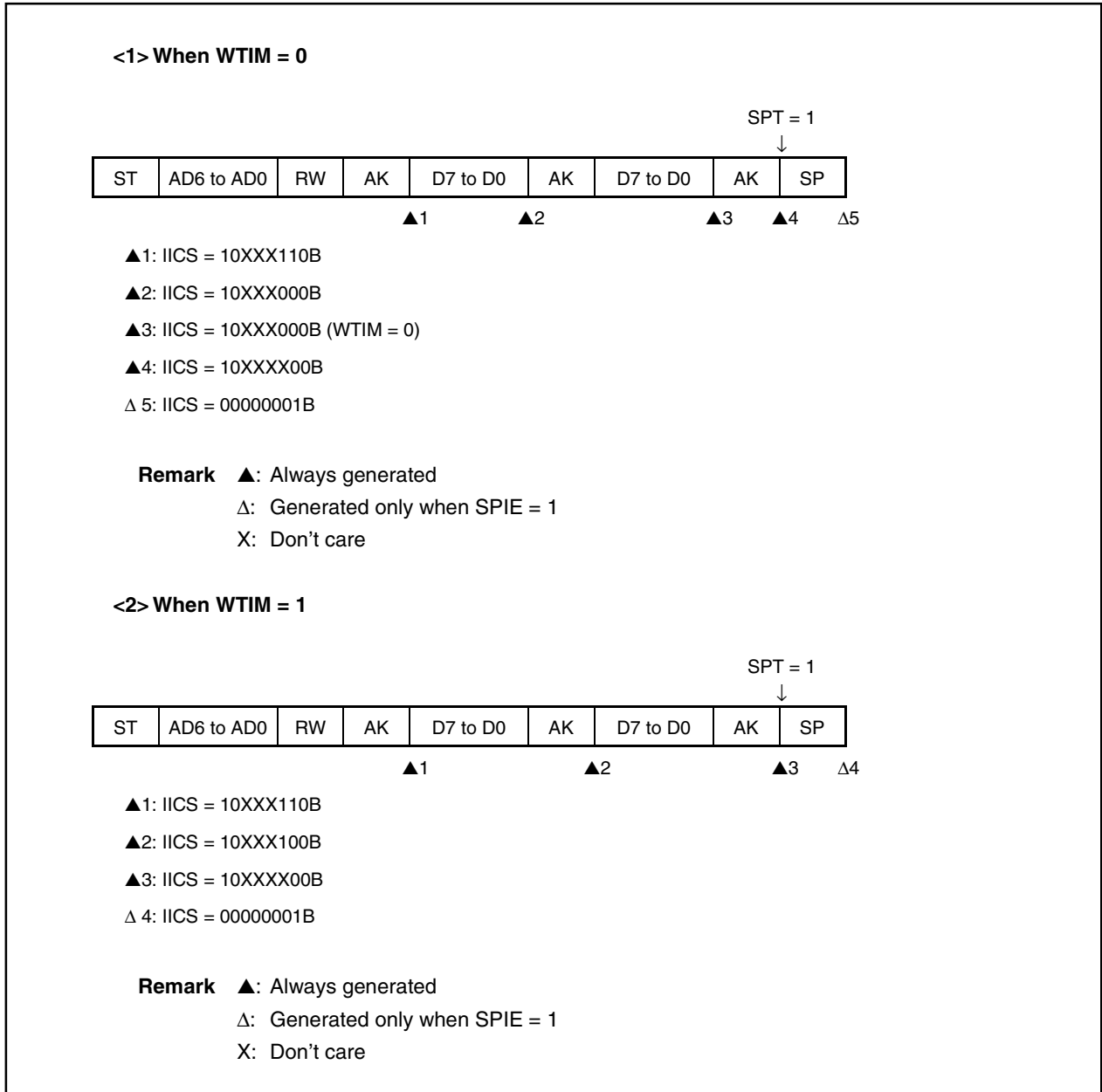
- By setting bit 1 (STT) of IICC to 1
- By setting bit 0 (SPT) of IICC to 1

12.4.5 I²C interrupt request (INTIIC)

The following shows the value of the IIC status register (IICS) at the INTIIC interrupt request generation timing and at the INTIIC interrupt timing.

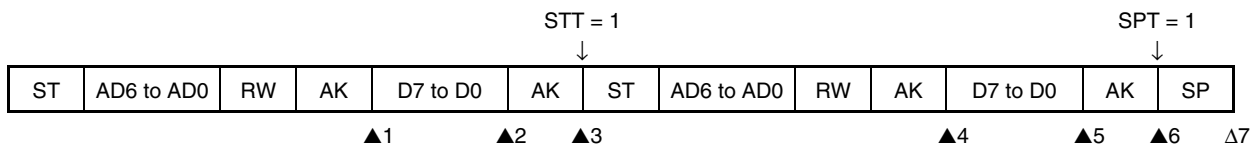
(1) Master device operation

(a) Start ~ Address ~ Data ~ Data ~ Stop (normal transmission/reception)



(b) Start ~ Address ~ Data ~ Start ~ Address ~ Data ~ Stop (restart)

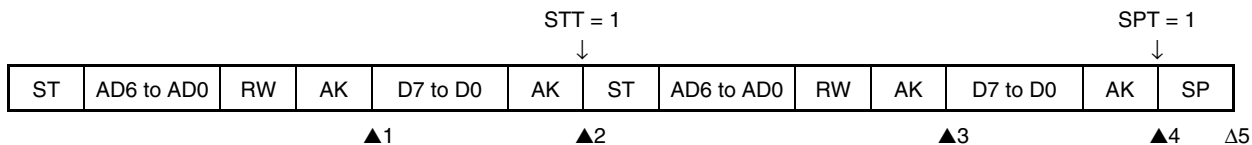
<1> When WTIM = 0



- ▲1: IICS = 10XXX110B
- ▲2: IICS = 10XXX000B (WTIM = 1)
- ▲3: IICS = 10XXX00B (WTIM = 0)
- ▲4: IICS = 10XXX110B (WTIM = 0)
- ▲5: IICS = 10XXX000B (WTIM = 1)
- ▲6: IICS = 10XXX00B
- Δ 7: IICS = 0000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

<2> When WTIM = 1

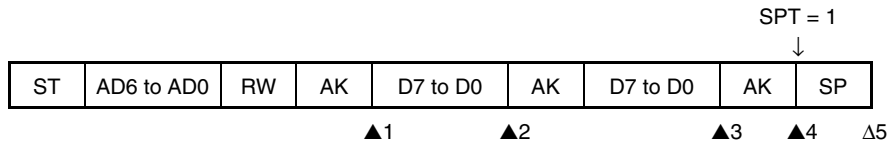


- ▲1: IICS = 10XXX110B
- ▲2: IICS = 10XXX00B
- ▲3: IICS = 10XXX110B
- ▲4: IICS = 10XXX00B
- Δ 5: IICS = 0000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

(c) Start ~ Code ~ Data ~ Data ~ Stop (extension code transmission)

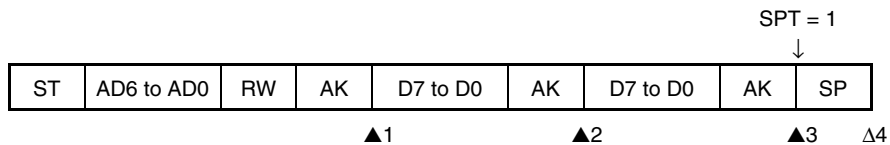
<1> When WTIM = 0



- ▲1: IICS = 1010X110B
- ▲2: IICS = 1010X000B
- ▲3: IICS = 1010X000B (WTIM = 1)
- ▲4: IICS = 1010XX00B
- Δ5: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

<2> When WTIM = 1



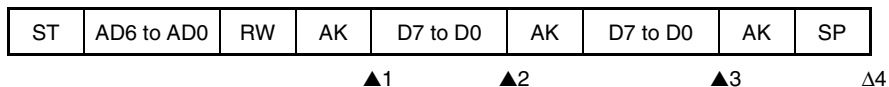
- ▲1: IICS = 1010X110B
- ▲2: IICS = 1010X100B
- ▲3: IICS = 1010XX00B
- Δ4: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

(2) Slave device operation (when receiving slave address data (matches with SVA))

(a) Start ~ Address ~ Data ~ Data ~ Stop

<1> When WTIM = 0



▲1: IICS = 0001X110B

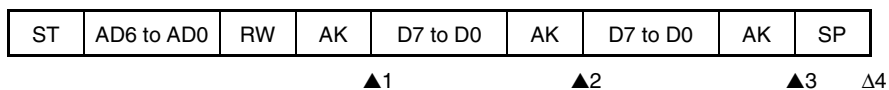
▲2: IICS = 0001X000B

▲3: IICS = 0001X000B

△4: IICS = 00000001B

Remark ▲: Always generated
 △: Generated only when SPIE = 1
 X: Don't care

<2> When WTIM = 1



▲1: IICS = 0001X110B

▲2: IICS = 0001X100B

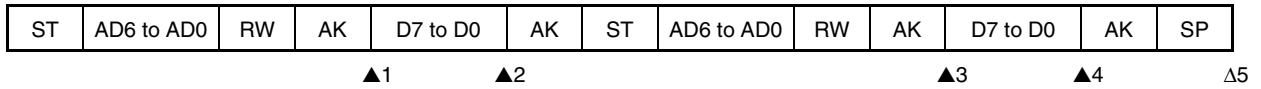
▲3: IICS = 0001XX00B

△4: IICS = 00000001B

Remark ▲: Always generated
 △: Generated only when SPIE = 1
 X: Don't care

(b) Start ~ Address ~ Data ~ Start ~ Address ~ Data ~ Stop

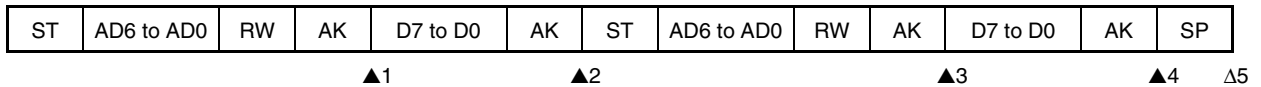
<1> When WTIM = 0 (after restart, matches with SVA)



- ▲1: IICS = 0001X110B
- ▲2: IICS = 0001X000B
- ▲3: IICS = 0001X110B
- ▲4: IICS = 0001X000B
- Δ 5: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

<2> When WTIM = 1 (after restart, matches with SVA)

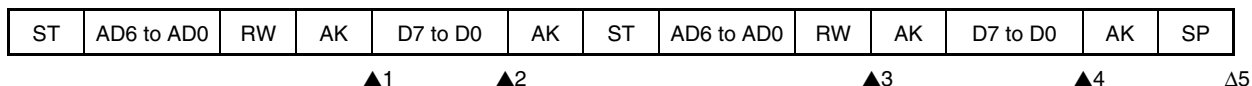


- ▲1: IICS = 0001X110B
- ▲2: IICS = 0001XX00B
- ▲3: IICS = 0001X110B
- ▲4: IICS = 0001XX00B
- Δ 5: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

(c) Start ~ Address ~ Data ~ Start ~ Code ~ Data ~ Stop

<1> When WTIM = 0 (after restart, extension code reception)



▲1: IICS = 0001X110B

▲2: IICS = 0001X000B

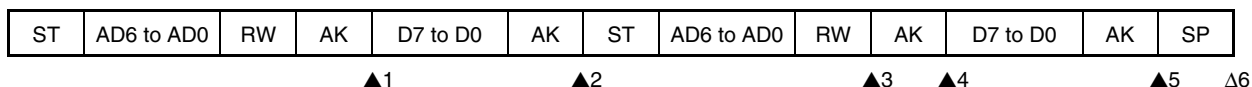
▲3: IICS = 0010X010B

▲4: IICS = 0010X000B

Δ 5: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

<2> When WTIM = 1 (after restart, extension code reception)



▲1: IICS = 0001X110B

▲2: IICS = 0001XX00B

▲3: IICS = 0010X010B

▲4: IICS = 0010X110B

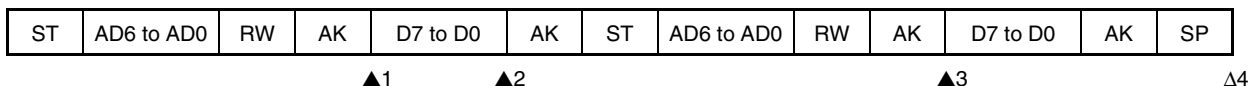
▲5: IICS = 0010XX00B

Δ 6: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

(d) Start ~ Address ~ Data ~ Start ~ Address ~ Data ~ Stop

<1> When WTIM = 0 (after restart, does not match with address (= not extension code))



▲1: IICS = 0001X110B

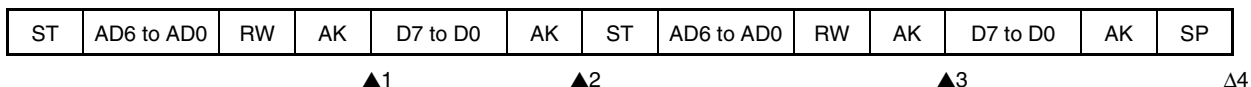
▲2: IICS = 0001X000B

▲3: IICS = 00000X10B

Δ 4: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

<2> When WTIM = 1 (after restart, does not match with address (= not extension code))



▲1: IICS = 0001X110B

▲2: IICS = 0001XX00B

▲3: IICS = 00000X10B

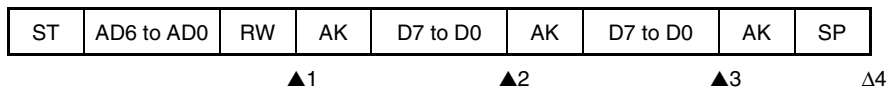
Δ 4: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

(3) Slave device operation (when receiving extension code)

(a) Start ~ Code ~ Data ~ Data ~ Stop

<1> When WTIM = 0



▲1: IICS = 0010X010B

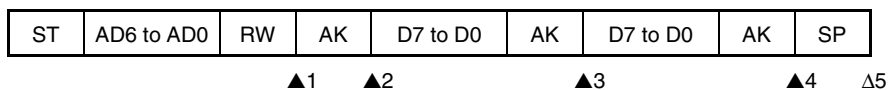
▲2: IICS = 0010X000B

▲3: IICS = 0010X000B

Δ 4: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

<2> When WTIM = 1



▲1: IICS = 0010X010B

▲2: IICS = 0010X110B

▲3: IICS = 0010X100B

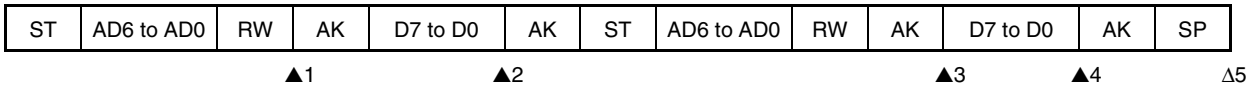
▲4: IICS = 0010XX00B

Δ 5: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

(b) Start ~ Code ~ Data ~ Start ~ Address ~ Data ~ Stop

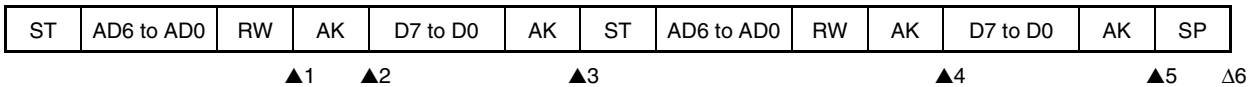
<1> When WTIM = 0 (after restart, matches with SVA)



- ▲1: IICS = 0010X010B
- ▲2: IICS = 0010X000B
- ▲3: IICS = 0001X110B
- ▲4: IICS = 0001X000B
- Δ 5: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

<2> When WTIM = 1 (after restart, matches with SVA)

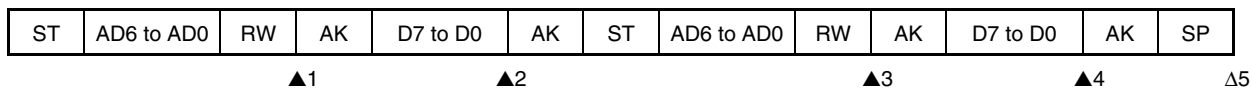


- ▲1: IICS = 0010X010B
- ▲2: IICS = 0010X110B
- ▲3: IICS = 0010XX00B
- ▲4: IICS = 0001X110B
- ▲5: IICS = 0001XX00B
- Δ 6: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

(c) Start ~ Code ~ Data ~ Start ~ Code ~ Data ~ Stop

<1> When WTIM = 0 (after restart, extension code reception)



▲1: IICS = 0010X010B

▲2: IICS = 0010X000B

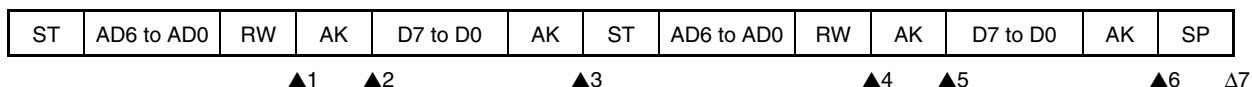
▲3: IICS = 0010X010B

▲4: IICS = 0010X000B

Δ 5: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

<2> When WTIM = 1 (after restart, extension code reception)



▲1: IICS = 0010X010B

▲2: IICS = 0010X110B

▲3: IICS = 0010XX00B

▲4: IICS = 0010X010B

▲5: IICS = 0010X110B

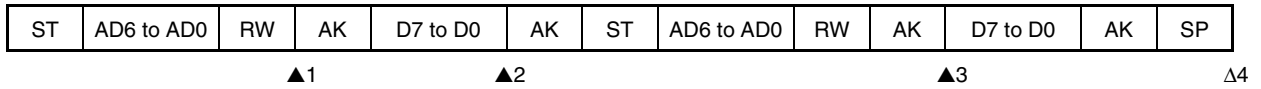
▲6: IICS = 0010XX00B

Δ 7: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

(d) Start ~ Code ~ Data ~ Start ~ Address ~ Data ~ Stop

<1> When WTIM = 0 (after restart, does not match with address (= not extension code))



▲1: IICS = 0010X010B

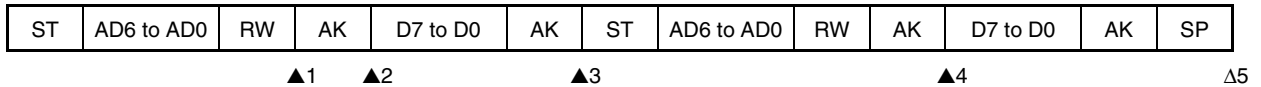
▲2: IICS = 0010X000B

▲3: IICS = 00000X10B

Δ 4: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

<2> When WTIM = 1 (after restart, does not match with address (= not extension code))



▲1: IICS = 0010X010B

▲2: IICS = 0010X110B

▲3: IICS = 0010XX00B

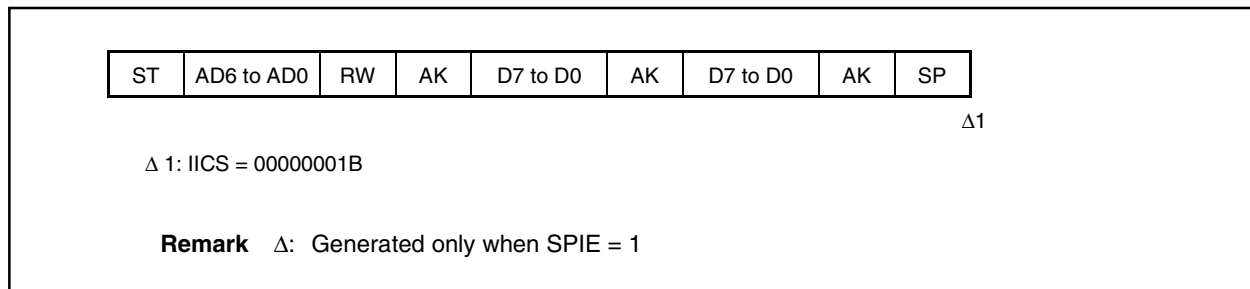
▲4: IICS = 00000X10B

Δ 5: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

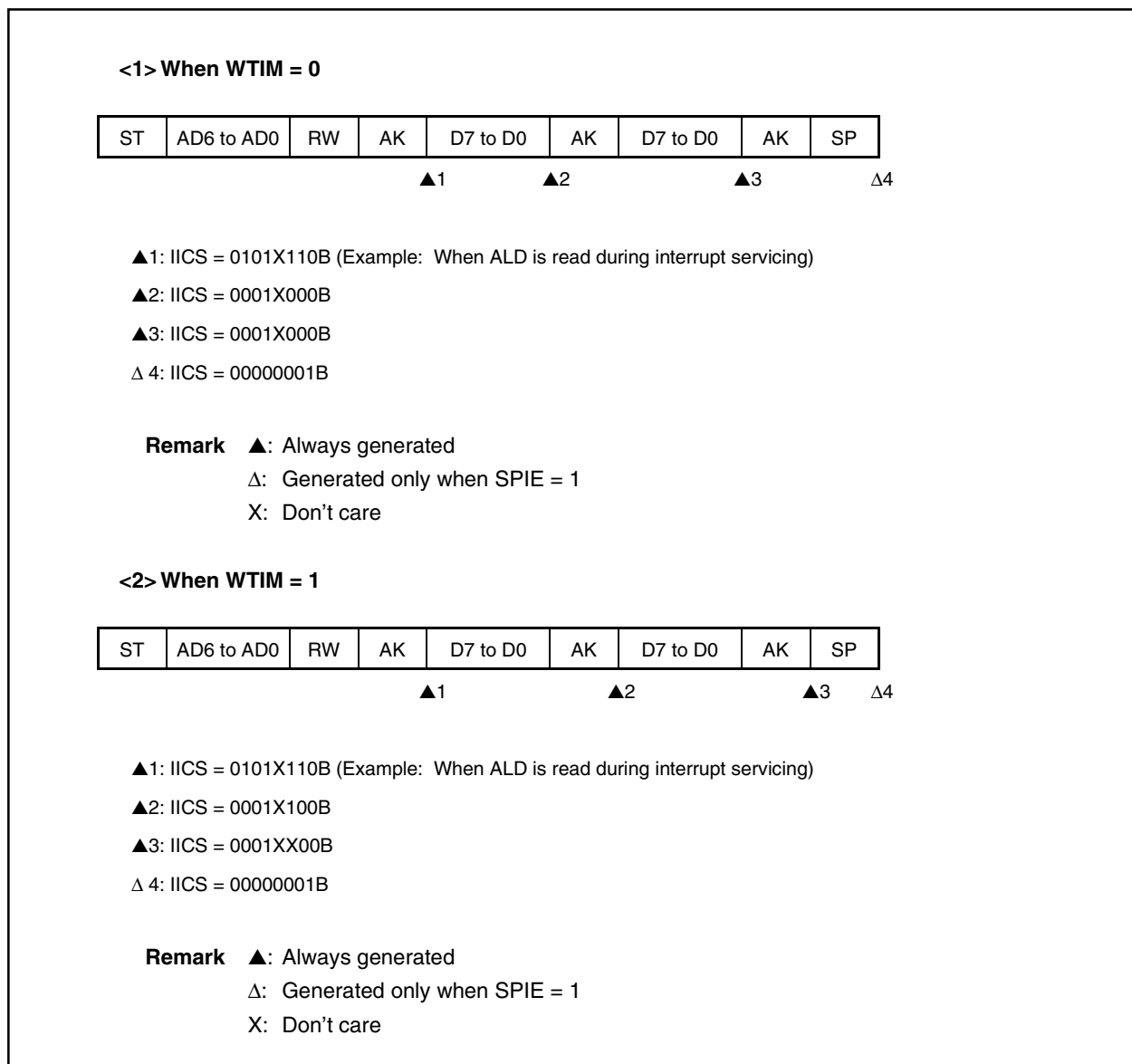
(4) Operation without communication

(a) Start ~ Code ~ Data ~ Data ~ Stop



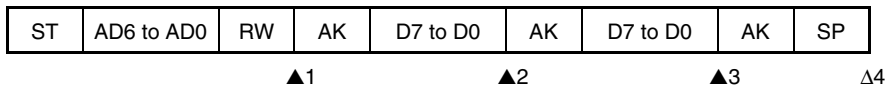
(5) Arbitration loss operation (operation as slave after arbitration loss)

(a) When arbitration loss occurs during transmission of slave address data



(b) When arbitration loss occurs during transmission of extension code

<1> When WTIM = 0



▲1: IICS = 0110X010B (Example: When ALD is read during interrupt servicing)

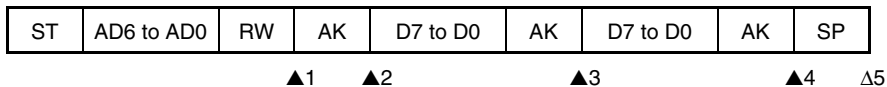
▲2: IICS = 0010X000B

▲3: IICS = 0010X000B

Δ 4: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

<2> When WTIM = 1



▲1: IICS = 0110X010B (Example: When ALD is read during interrupt servicing)

▲2: IICS = 0010X110B

▲3: IICS = 0010X100B

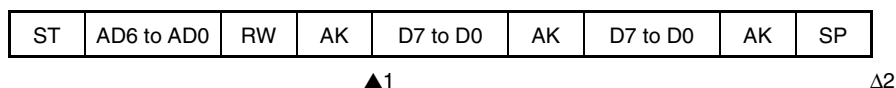
▲4: IICS = 0010XX00B

Δ 5: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

(6) Operation when arbitration loss occurs (no communication after arbitration loss)

(a) When arbitration loss occurs during transmission of slave address data

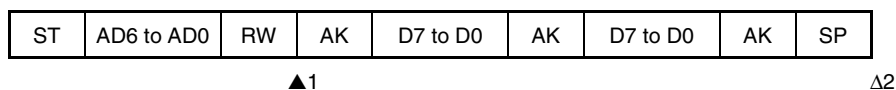


▲1: IICS = 01000110B (Example: When ALD is read during interrupt servicing)

Δ 2: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1

(b) When arbitration loss occurs during transmission of extension code



▲1: IICSn = 0110X010B (Example: When ALD is read during interrupt servicing)

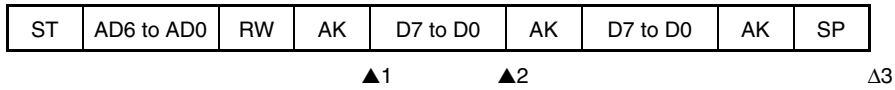
IICC's LREL is set to 1 via software

Δ 2: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care

(c) When arbitration loss occurs during data transfer

<1> When WTIM = 0



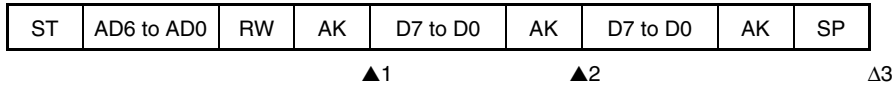
▲1: IICS = 10001110B

▲2: IICS = 01000000B (Example: When ALD is read during interrupt servicing)

Δ3: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1

<2> When WTIM = 1



▲1: IICS = 10001110B

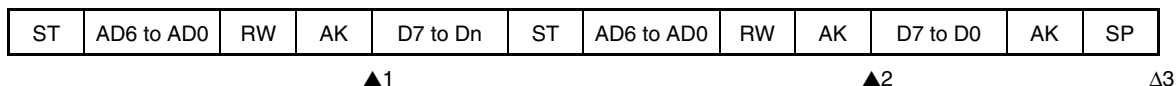
▲2: IICS = 01000100B (Example: When ALD is read during interrupt servicing)

Δ3: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1

(d) When loss occurs due to restart condition during data transfer

<1> Not extension code (Example: mismatches with SVA)



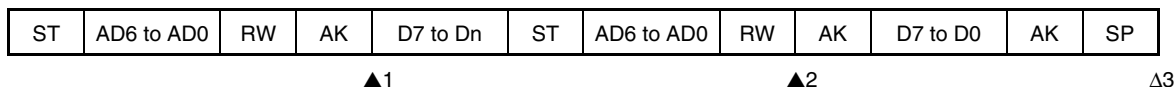
▲1: IICS = 1000X110B

▲2: IICS = 01000110B (Example: When ALD is read during interrupt servicing)

Δ 3: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care
 Dn = D6 to D0

<2> Extension code



▲1: IICS = 1000X110B

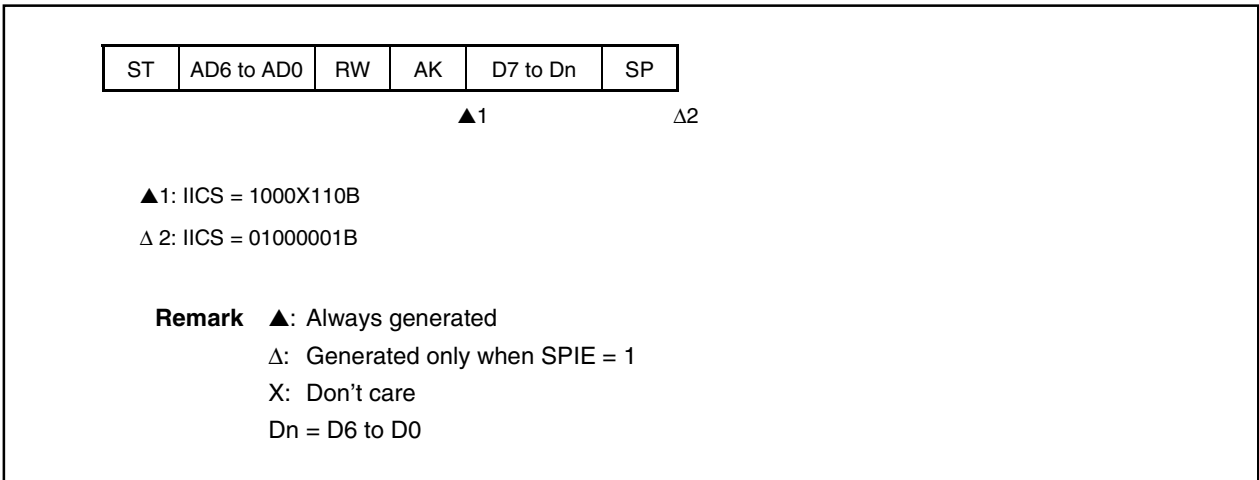
▲2: IICS = 0110X010B (Example: When ALD is read during interrupt servicing)

IICC's LREL is set to 1 via software

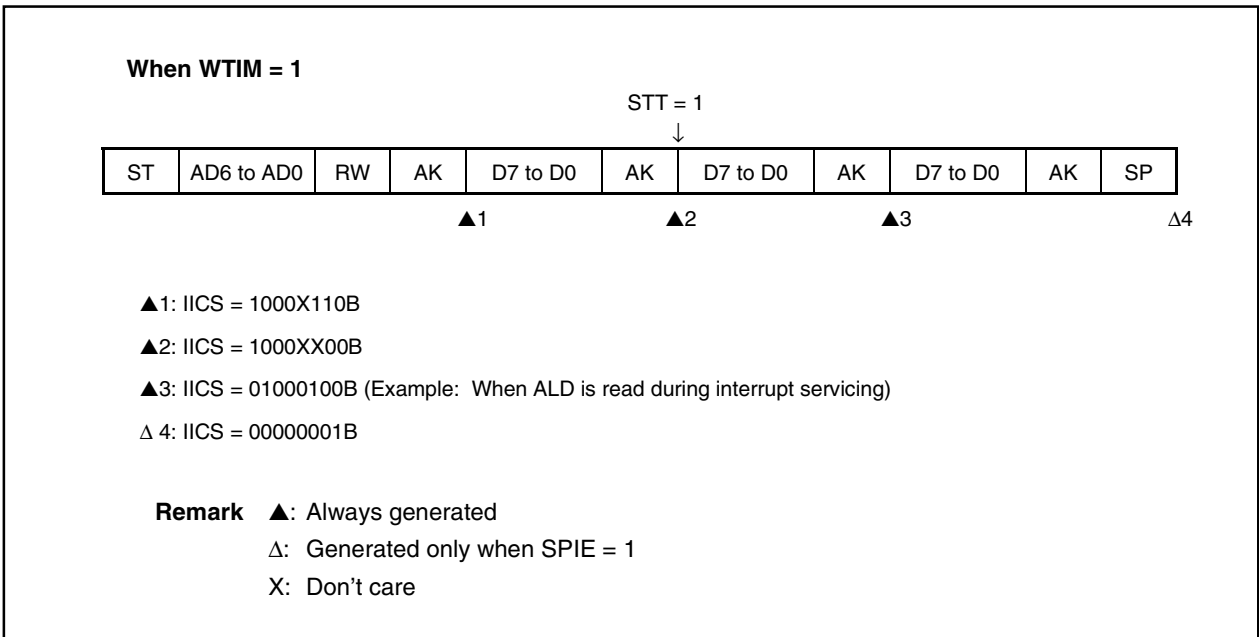
Δ 3: IICS = 00000001B

Remark ▲: Always generated
 Δ: Generated only when SPIE = 1
 X: Don't care
 Dn = D6 to D0

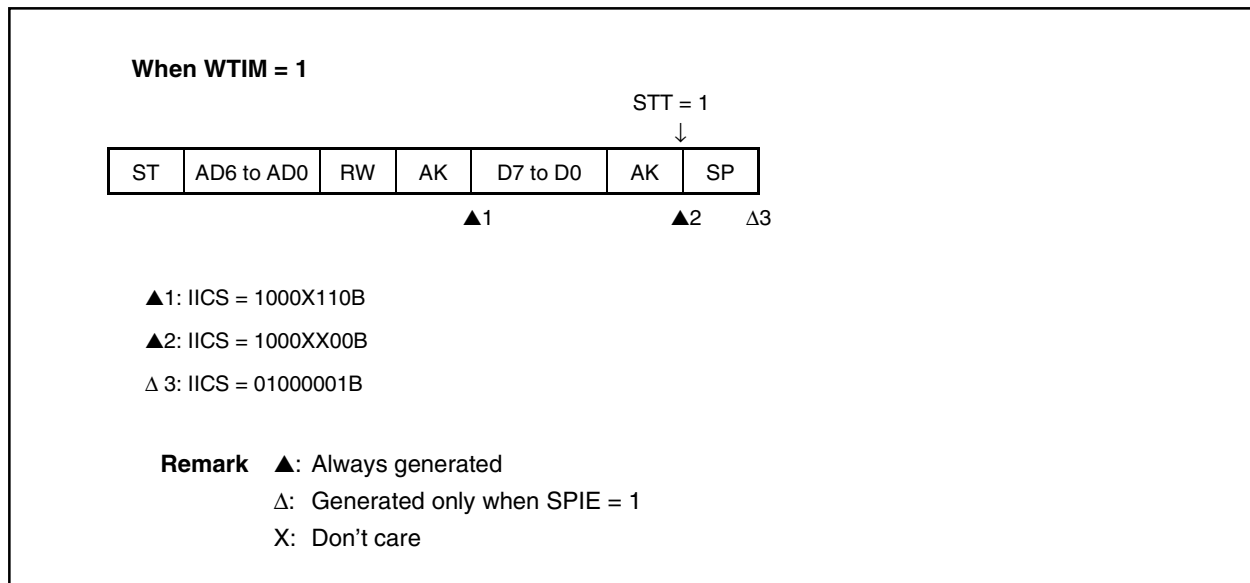
(e) When loss occurs due to stop condition during data transfer



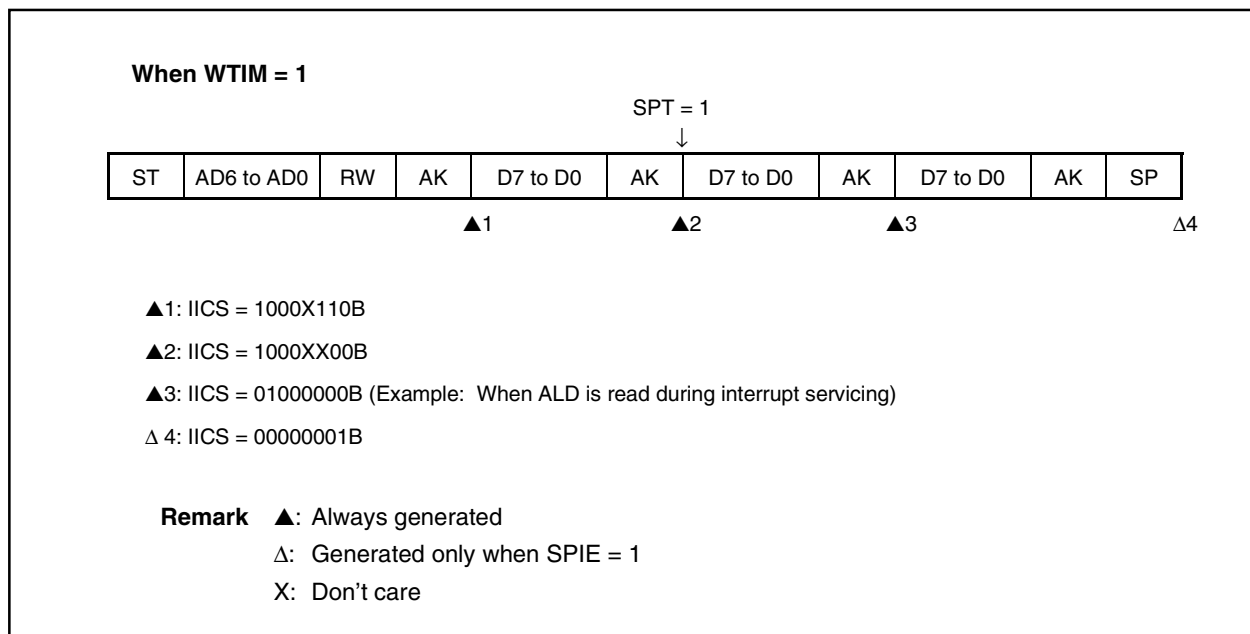
(f) When arbitration loss occurs due to low-level data when attempting to generate a restart condition



(g) When arbitration loss occurs due to a stop condition when attempting to generate a restart condition



(h) When arbitration loss occurs due to low-level data when attempting to generate a stop condition



12.4.6 Interrupt request (INTIIC) generation timing and wait control

The setting of bit 3 (WTIM) of the IIC control register (IICC) determines the timing by which INTIIC is generated and the corresponding wait control, as shown below.

Table 12-7. INTIIC Signal Generation Timing and Wait Control

WTIM	During Slave Device Operation			During Master Device Operation		
	Address	Data Reception	Data Transmission	Address	Data Reception	Data Transmission
0	g ^{Notes 1, 2}	g ^{Note 2}	g ^{Note 2}	9	8	8
1	g ^{Notes 1, 2}	g ^{Note 2}	g ^{Note 2}	9	9	9

Notes 1. The slave device's INTIIC signal and wait period occurs at the falling edge of the ninth clock only when there is a match with the address set to slave address register (SVA).

At this point, \overline{ACK} is output regardless of the value set to bit 2 (ACKE) of the IICC register. For a slave device that has received an extension code, the INTIIC signal occurs at the falling edge of the eighth clock.

2. If the received address does not match the contents of slave address register (SVA), neither the INTIIC signal nor a wait occurs.

Remark The numbers in the table indicate the number of the serial clock's clock signals. Interrupt requests and wait control are both synchronized with the falling edge of these clock signals.

(1) During address transmission/reception

- Slave device operation: The interrupt and wait timing are determined regardless of the WTIM bit.
- Master device operation: The interrupt and wait timing occur at the falling edge of the ninth clock regardless of the WTIM bit.

(2) During data reception

- Master/slave device operation: The interrupt and wait timing are determined according to the WTIM bit.

(3) During data transmission

- Master/slave device operation: The interrupt and wait timing are determined according to the WTIM bit.

(4) Wait cancellation method

The four wait cancellation methods are as follows.

- By setting bit 5 (WREL) of the IIC control register (IICC) to 1
- By writing to the IIC shift register (IIC)
- By start condition setting (bit 1 (STT) of IIC control register (IICC) = 1)
- By stop condition setting (bit 0 (SPT) of IIC control register (IICC) = 1)

When an 8-clock wait has been selected (WTIM = 0), the output level of \overline{ACK} must be determined prior to wait cancellation.

(5) Stop condition detection

INTIIC signal is generated when a stop condition is detected.

12.4.7 Address match detection method

When in I²C bus mode, the master device can select a particular slave device by transmitting the corresponding slave address.

Address match detection is performed automatically by hardware. An interrupt request (INTIIC) occurs when a local address has been set to the slave address register (SVA) and when the address set to SVA matches the slave address sent by the master device, or when an extension code has been received.

12.4.8 Error detection

In I²C bus mode, the status of the serial data bus (SDA) during data transmission is captured by the IIC shift register (IIC) of the transmitting device, so the IIC data prior to transmission can be compared with the transmitted IIC data to enable detection of transmission errors. A transmission error is judged as having occurred when the compared data values do not match.

12.4.9 Extension code

- (1) When the higher 4 bits of the receive address are either 0000 or 1111, the extension code flag (EXC) is set for extension code reception and an interrupt request (INTIIC) is issued at the falling edge of the eighth clock. The local address stored in the slave address register (SVA) is not affected.
- (2) If 11110xx0 is set to SVA by a 10-bit address transfer and 11110xx0 is transferred from the master device, the results are as follows. Note that the INTIIC signal occurs at the falling edge of the eighth clock.

Higher four bits of data match: EXC = 1^{Note}

Seven bits of data match: COI = 1^{Note}

Note EXC: Bit 5 of IIC status register (IICS)
COI: Bit 4 of IIC status register (IICS)

- (3) Since the processing after the interrupt request occurs differs according to the data that follows the extension code, such processing is performed by software. For example, when operation as a slave is not desired after the extension code is received, set bit 6 (LREL) of the IIC control register (IICC) to 1 and the CPU will enter the next communication wait state.

Table 12-8. Extension Code Bit Definitions

Slave Address	R/W Bit	Description
0000 000	0	General call address
0000 000	1	Start byte
0000 001	×	CBUS address
0000 010	×	Address that is reserved for different bus format
1111 0xx	×	10-bit slave address specification

12.4.10 Arbitration

When several master devices simultaneously output a start condition (when STT is set to 1 before STD is set to 1^{Note}), communication among the master devices is performed as the number of clocks is adjusted until the data differs. This kind of operation is called arbitration.

When one of the master devices loses in arbitration, an arbitration loss flag (ALD) in the IIC status register (IICS) is set via the timing by which the arbitration loss occurred, and the SCL and SDA lines are both set to high impedance, which releases the bus.

The arbitration loss is detected based on the timing of the next interrupt request (the eighth or ninth clock, when a stop condition is detected, etc.) and the ALD = 1 setting that has been made by software.

For details of interrupt request timing, see **12.4.5 I²C interrupt request (INTIIC)**.

Note STD: Bit 1 of IIC status register (IICS)
 STT: Bit 1 of IIC control register (IICC)

Figure 12-32. Arbitration Timing Example

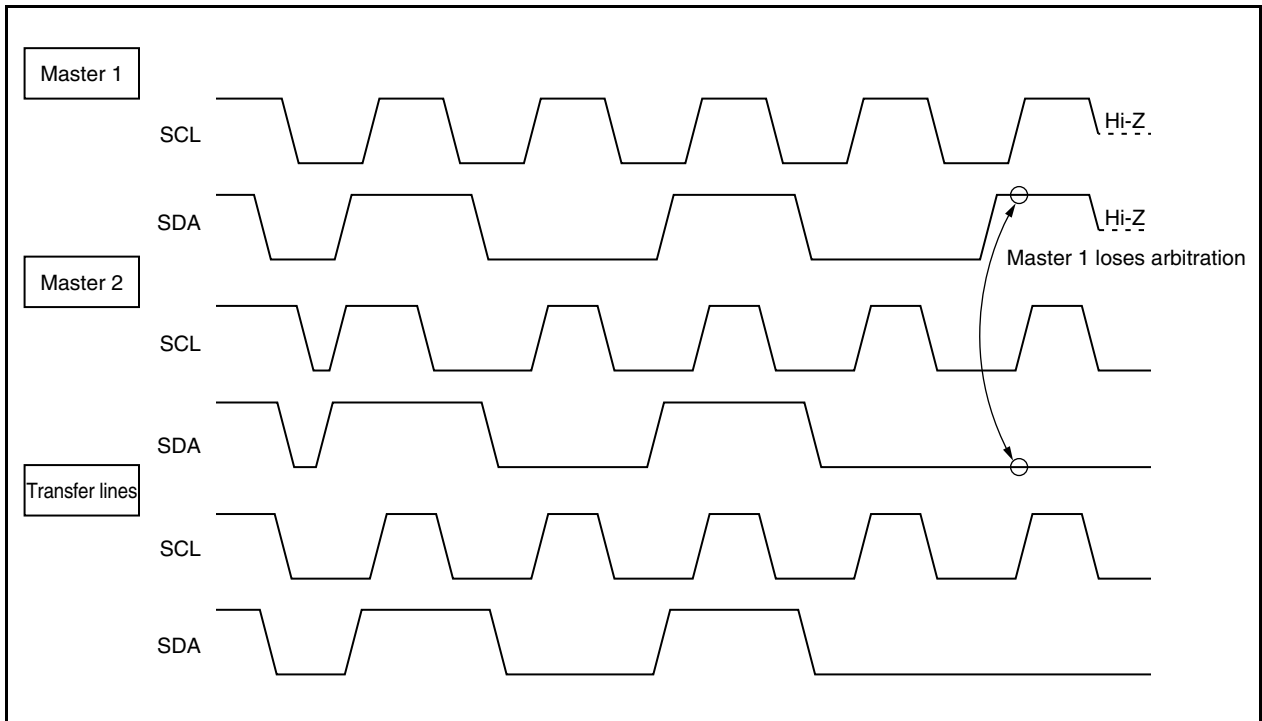


Table 12-9. Status During Arbitration and Interrupt Request Generation Timing

Status During Arbitration	Interrupt Request Generation Timing
During address transmission	At falling edge of eighth or ninth clock following byte transfer ^{Note 1}
Read/write data after address transmission	
During extension code transmission	
Read/write data after extension code transmission	
During data transmission	
During $\overline{\text{ACK}}$ signal transfer period after data transmission	
When restart condition is detected during data transfer	
When stop condition is detected during data transfer	When stop condition is output (when SPIE = 1) ^{Note 2}
When data is at low level while attempting to output a restart condition	At falling edge of eighth or ninth clock following byte transfer ^{Note 1}
When stop condition is detected while attempting to output a restart condition	When stop condition is output (when SPIE = 1) ^{Note 2}
When data is at low level while attempting to output a stop condition	At falling edge of eighth or ninth clock following byte transfer ^{Note 1}
When SCL is at low level while attempting to output a restart condition	

Notes 1. When WTIM (bit 3 of IIC control register (IICC)) = 1, an interrupt request occurs at the falling edge of the ninth clock. When WTIM = 0 and the extension code's slave address is received, an interrupt request occurs at the falling edge of the eighth clock.

2. When there is a possibility that arbitration will occur, set SPIE = 1 for master device operation.

Remark SPIE: Bit 5 of IIC control register (IICC)

12.4.11 Wakeup function

The I²C bus slave function is a function that generates an interrupt request (INTIIC) when a local address and extension code have been received.

This function makes processing more efficient by preventing unnecessary interrupt requests from occurring when addresses do not match.

When a start condition is detected, wakeup standby mode is set. This wakeup standby mode is in effect while addresses are transmitted due to the possibility that an arbitration loss may change the master device (which has output a start condition) to a slave device.

However, when a stop condition is detected, bit 5 (SPIE) of the IIC control register (IICC) is set regardless of the wakeup function, and this determines whether interrupt requests are enabled or disabled.

12.4.12 Communication reservation

To start master device communications when not currently using a bus, a communication reservation can be made to enable transmission of a start condition when the bus is released. There are two modes under which the bus is not used.

- When arbitration results in neither master nor slave operation
- When an extension code is received and slave operation is disabled (\overline{ACK} is not returned and the bus was released when bit 6 (LREL) of the IIC control register (IICC) was set to “1”).

If bit 1 (STT) of IICC is set while the bus is not being used, a start condition is automatically generated and the wait status is set after the bus is released (after a stop condition is detected).

When the bus release is detected (when a stop condition is detected), writing to the IIC shift register (IIC) causes the master’s address transfer to start. At this point, bit 4 (SPIE) of IICC should be set.

When the STT bit has been set, the operation mode (as start condition or as communication reservation) is determined according to the bus status.

If the bus has been released a start condition is generated
 If the bus has not been released (standby mode) communication reservation

To detect which operation mode has been determined for the STT bit, set the STT bit, wait for the wait period, then check the MSTS (bit 7 of IIC status register (IICS)).

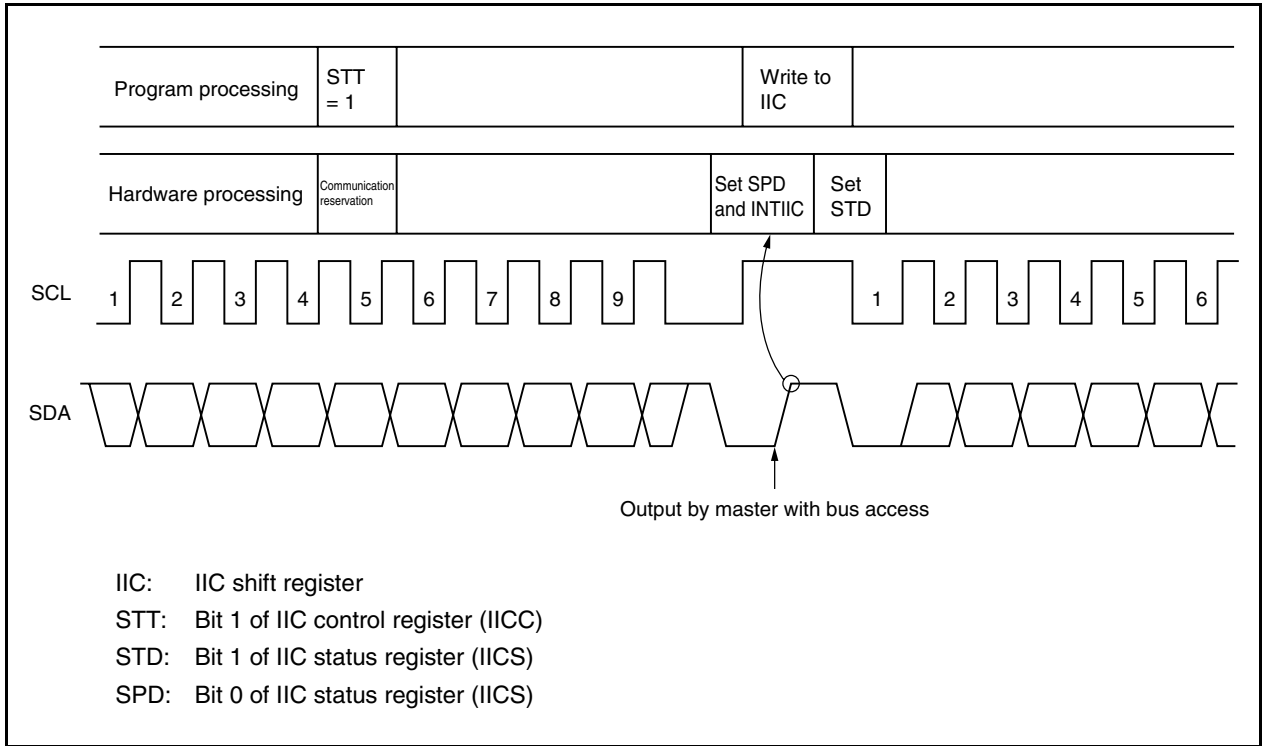
Wait periods, which should be set via software, are listed in Table 12-10. These wait periods can be set via the settings for bits 3, 1, and 0 (SMC, CL1, and CL0) in the IIC clock selection register (IICCL).

Table 12-10. Wait Periods

SMC	CL1	CL0	Wait Period
0	0	0	26 clocks
0	0	1	46 clocks
0	1	0	92 clocks
0	1	1	37 clocks
1	0	0	16 clocks
1	0	1	
1	1	0	32 clocks
1	1	1	13 clocks

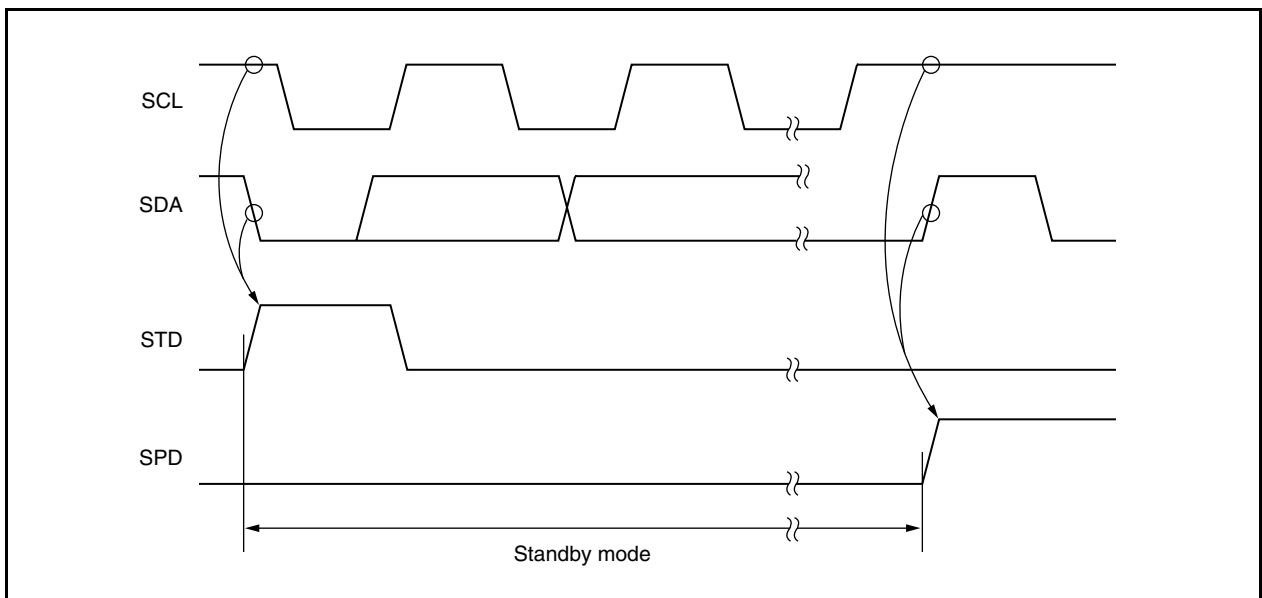
The communication reservation timing is shown below.

Figure 12-33. Communication Reservation Timing



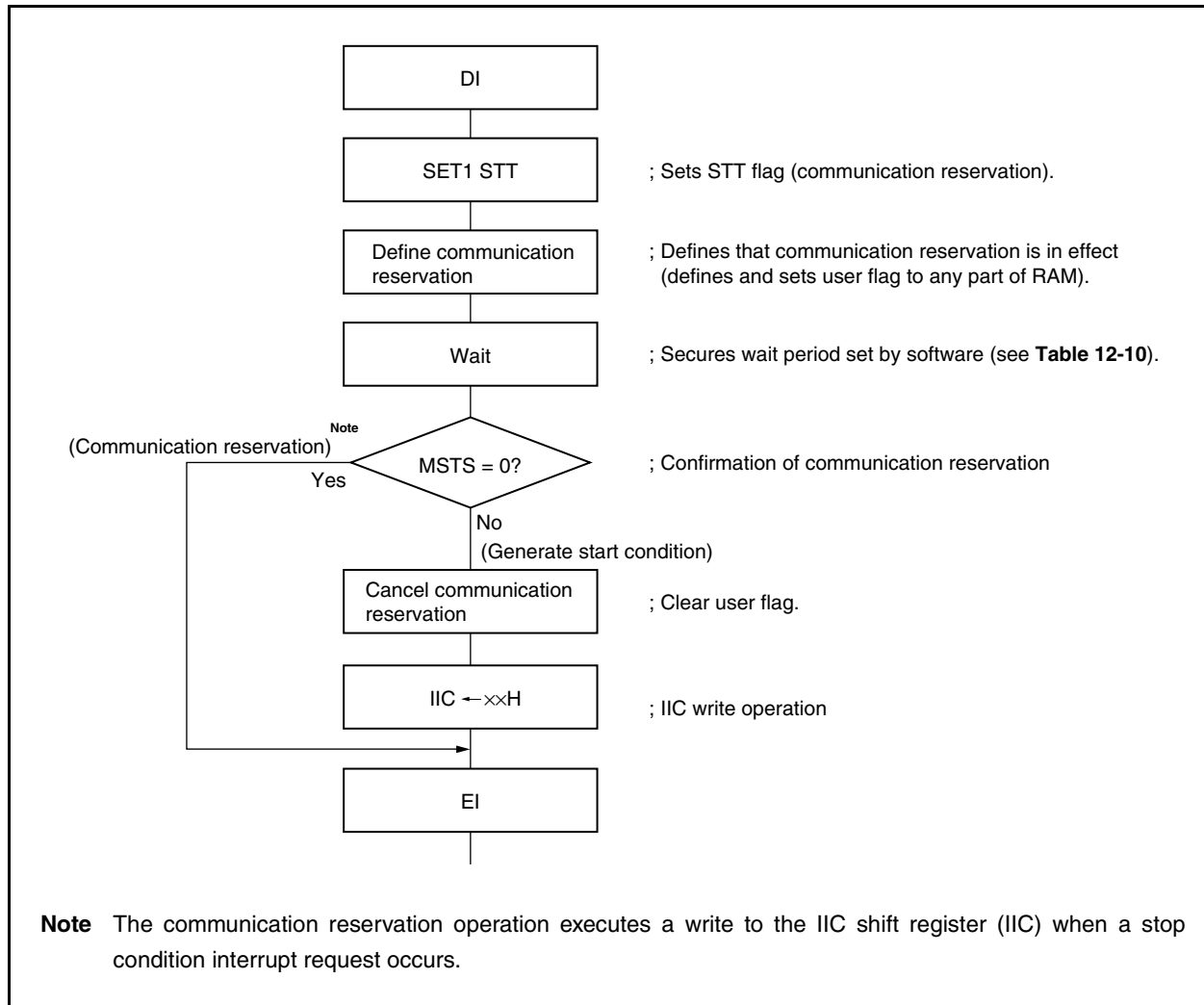
Communication reservations are accepted of the following timing. After bit 1 (STD) of the IIC status register (IICS) is set to 1, a communication reservation can be made by setting bit 1 (STT) of the IIC control register (IICC) to 1 before a stop condition is detected.

Figure 12-34. Timing for Accepting Communication Reservations



The communication reservation flow chart is illustrated below.

Figure 12-35. Communication Reservation Flow Chart



12.4.13 Cautions

After a reset, when changing from a mode in which no stop condition has been detected (the bus has not been released) to a master device communication mode, first generate a stop condition to release the bus, then perform master device communication.

When using multiple masters, it is not possible to perform master device communication when the bus has not been released (when a stop condition has not been detected).

Use the following sequence for generating a stop condition.

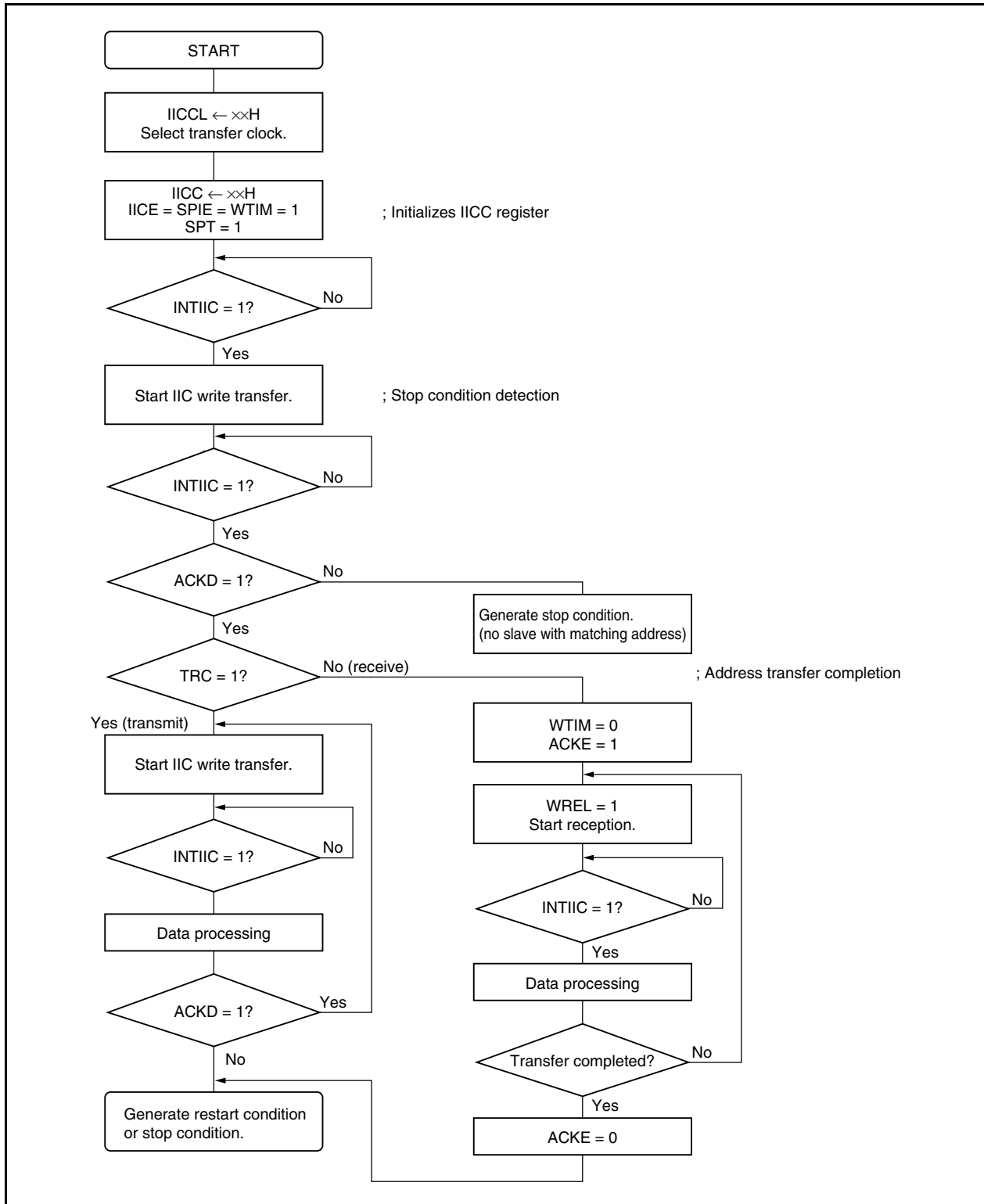
- <1> Set the IIC clock selection register (IICCL).
- <2> Set bit 7 (IICE) of the IIC control register (IICC).
- <3> Set bit 0 of IICC.

12.4.14 Communication operations

(1) Master operations

The following is a flow chart of the master operations.

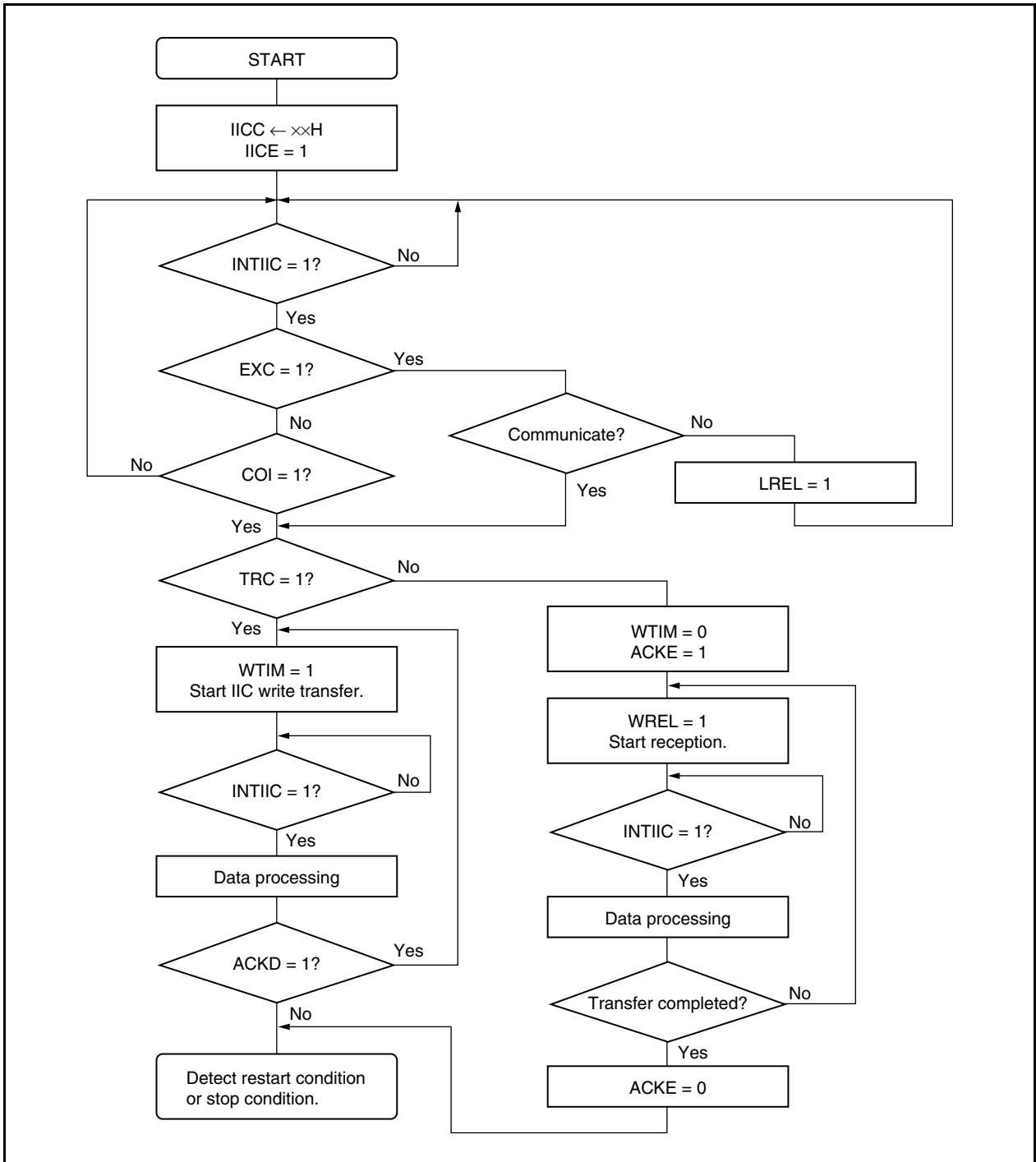
Figure 12-36. Master Operation Flow Chart



(2) Slave operation

An example of slave operation is shown below.

Figure 12-37. Slave Operation Flow Chart



12.4.15 Timing of data communication

When using I²C bus mode, the master device outputs an address via the serial bus to select one of several slave devices as its communication partner.

After outputting the slave address, the master device transmits the TRC bit (bit 3 of the IIC status register (IICS)), which specifies the data transfer direction and then starts serial communication with the slave device.

The shift operation of the IIC bus shift register (IIC) is synchronized with the falling edge of the serial clock (SCL). The transmit data is transferred to the SO latch and is output (MSB first) via the SDA pin.

Data input via the SDA pin is captured by IIC at the rising edge of SCL.

The data communication timing is shown below.

**Figure 12-38. Example of Master to Slave Communication
(When 9-Clock Wait Is Selected for Both Master and Slave) (1/3)**

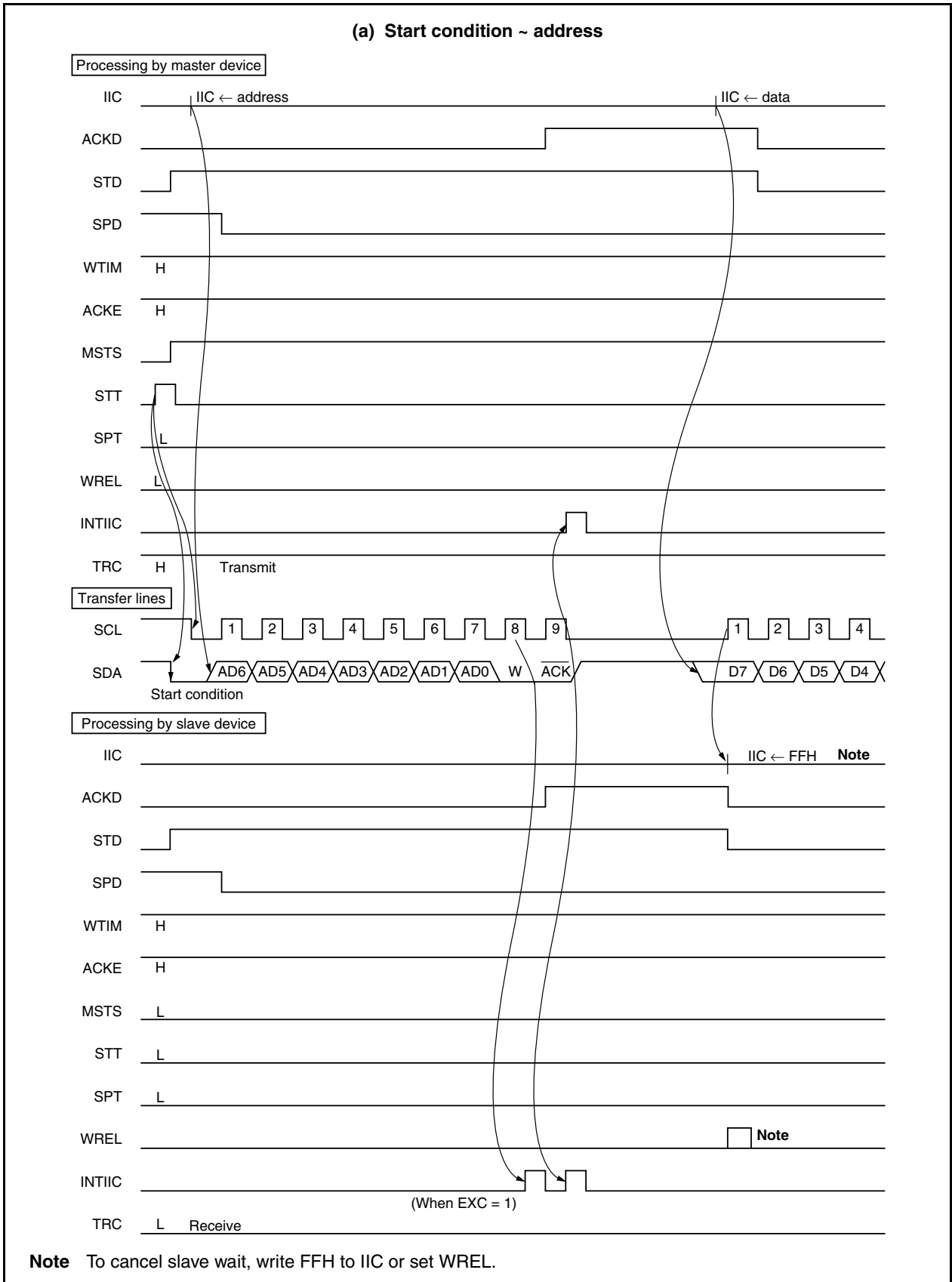
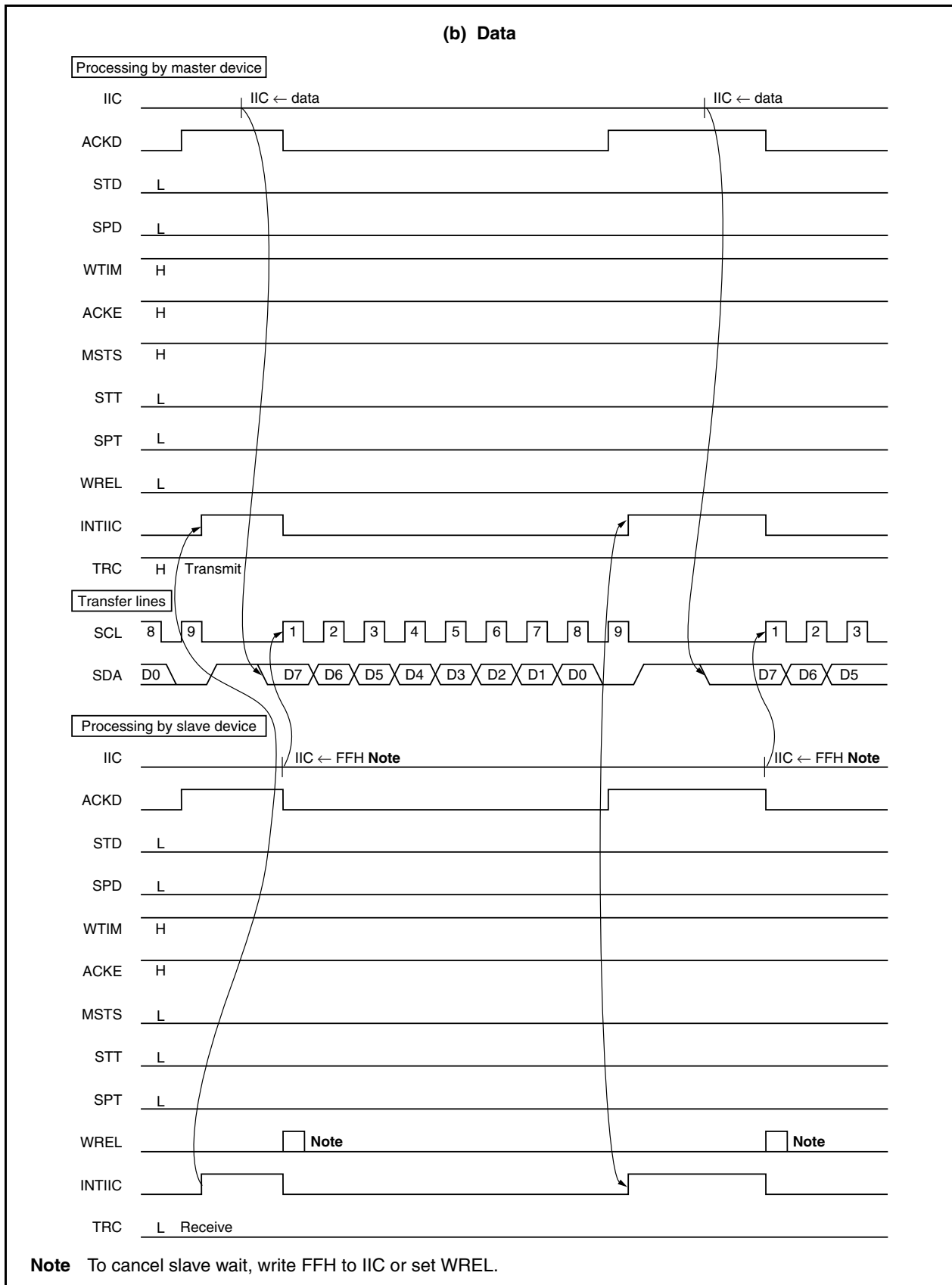


Figure 12-38. Example of Master to Slave Communication
(When 9-Clock Wait Is Selected for Both Master and Slave) (2/3)



**Figure 12-38. Example of Master to Slave Communication
(When 9-Clock Wait Is Selected for Both Master and Slave) (3/3)**

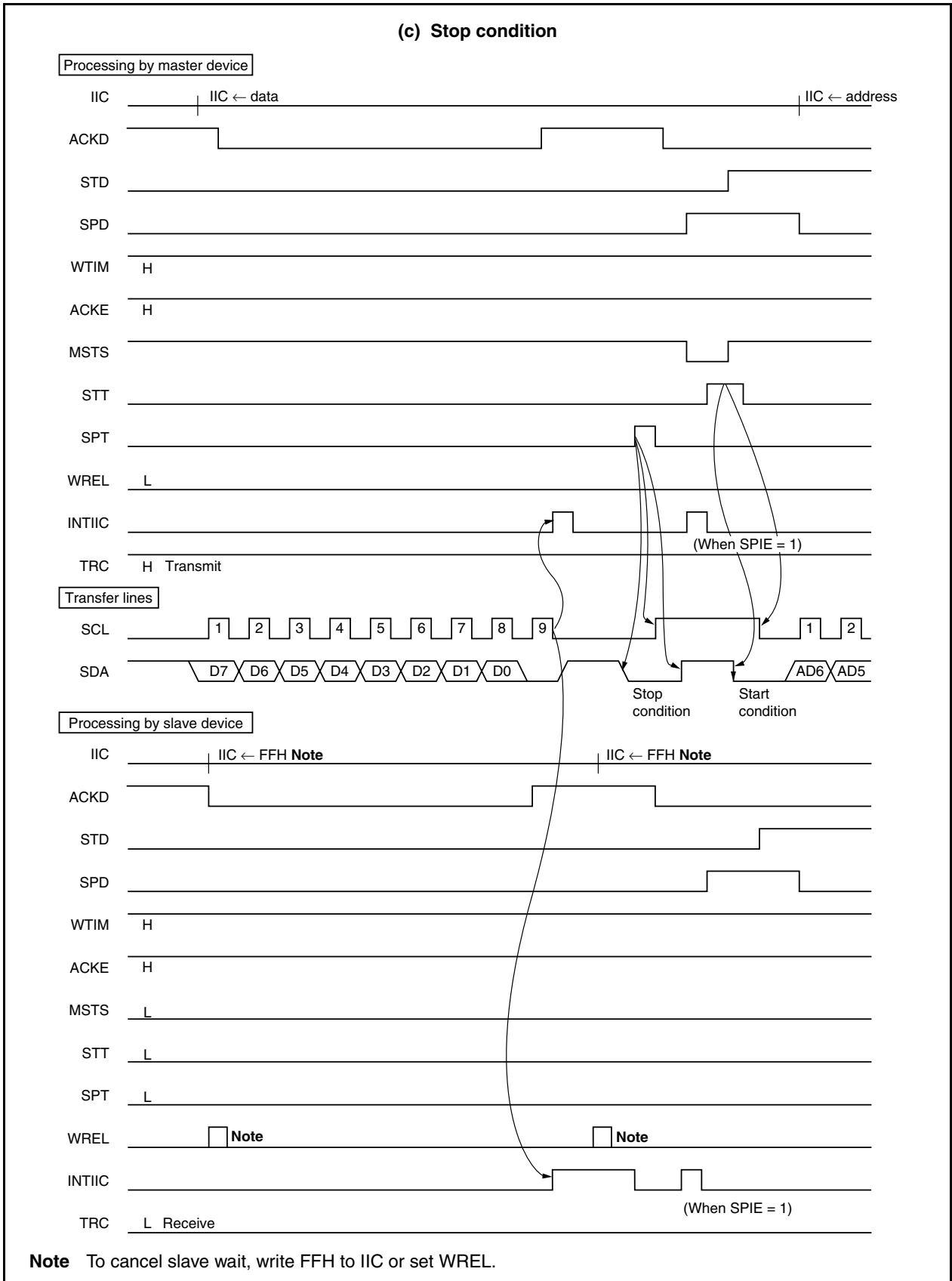
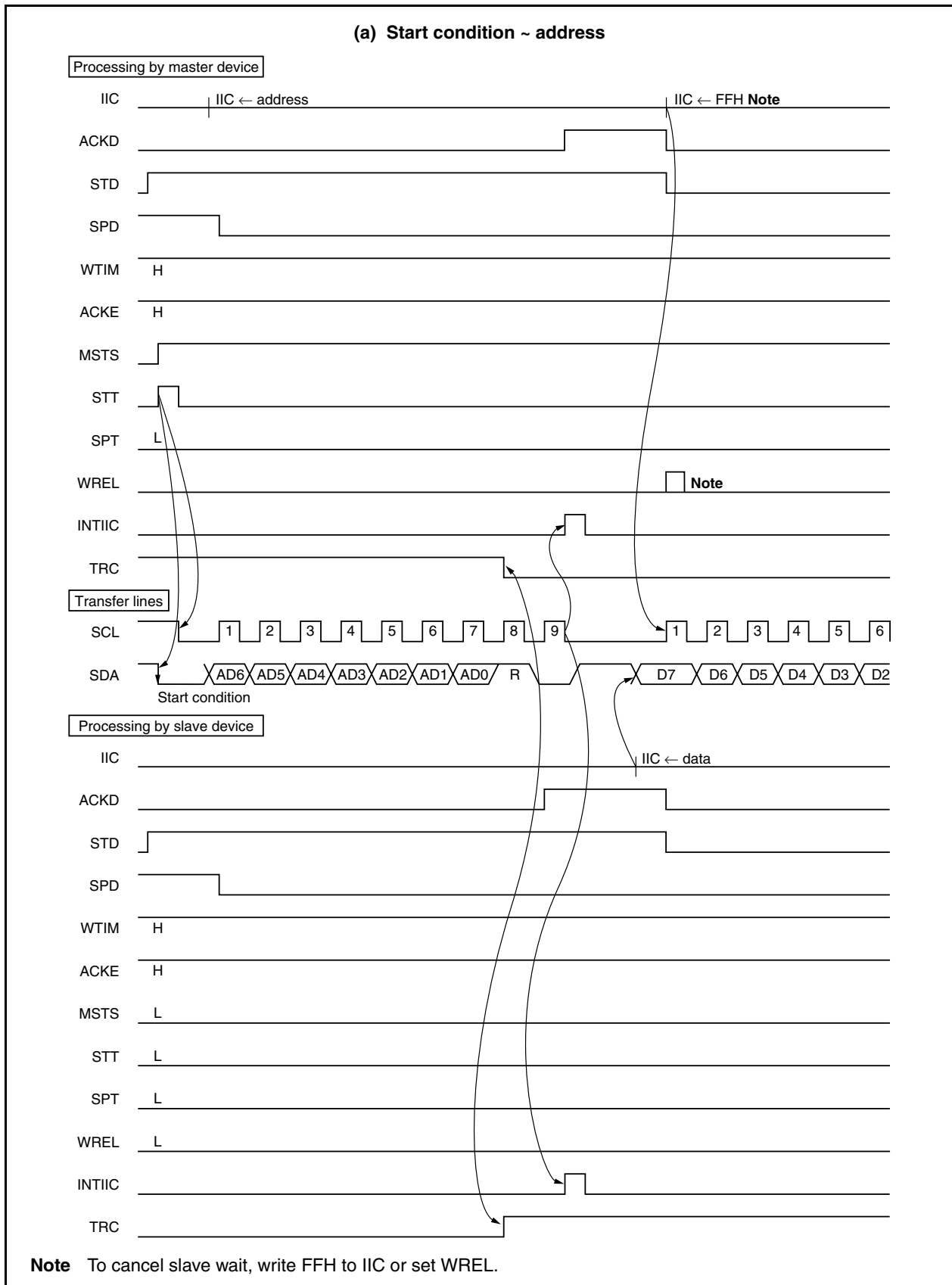


Figure 12-39. Example of Slave to Master Communication
(When 9-Clock Wait Is Selected for Both Master and Slave) (1/3)



**Figure 12-39. Example of Slave to Master Communication
(When 9-Clock Wait Is Selected for Both Master and Slave) (2/3)**

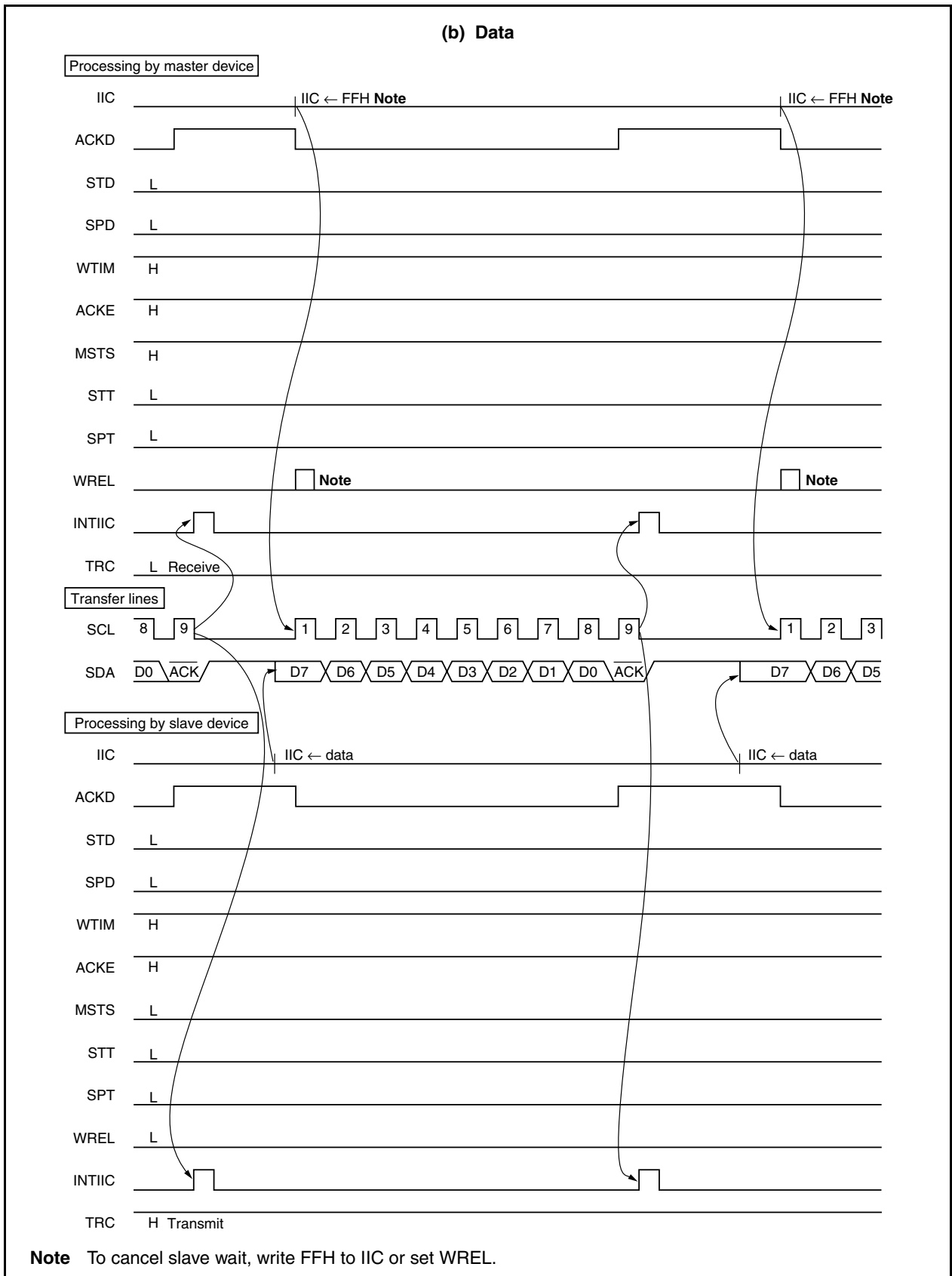
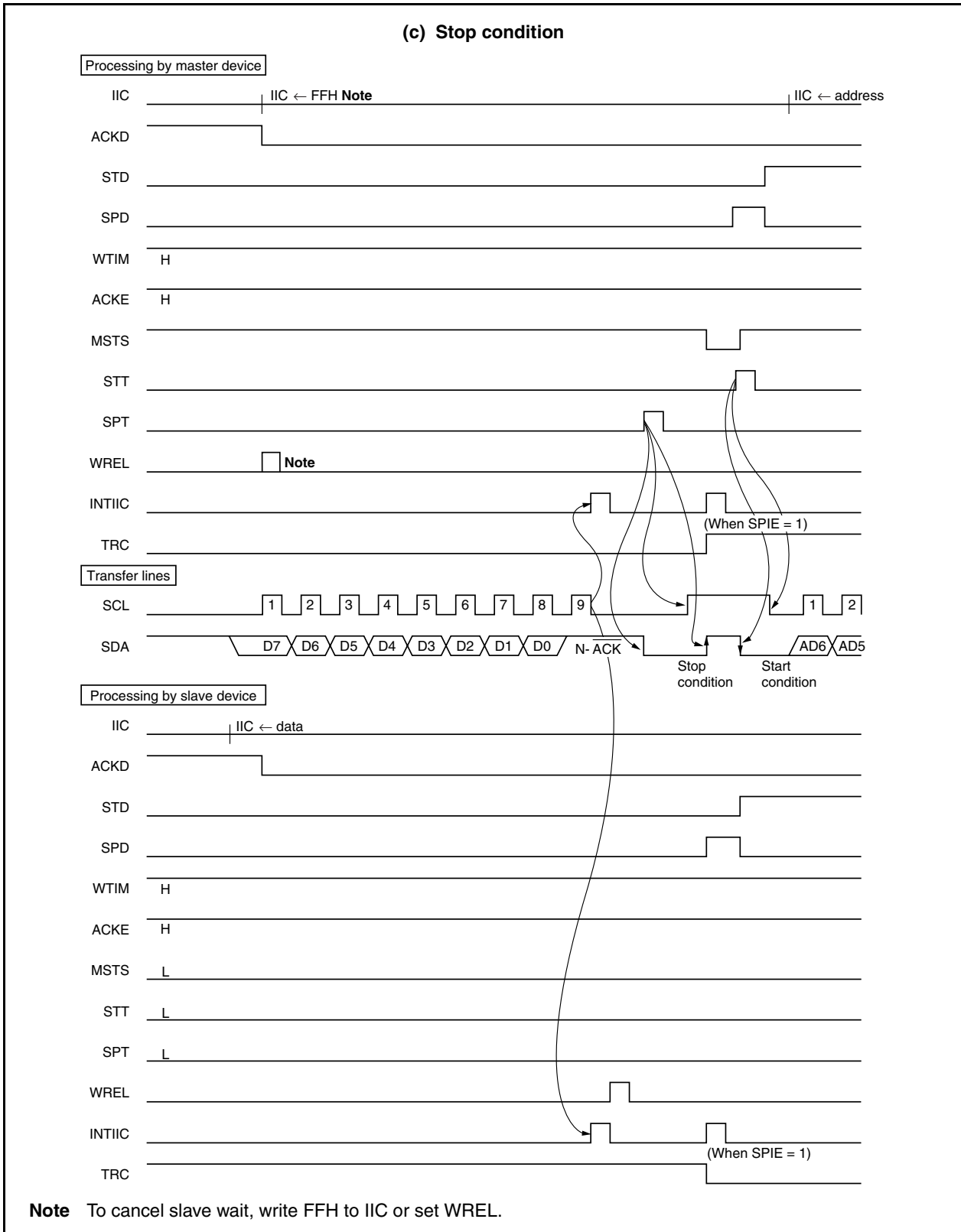


Figure 12-39. Example of Slave to Master Communication
(When 9-Clock Wait Is Selected for Both Master and Slave) (3/3)



CHAPTER 13 DMA FUNCTIONS (DMA CONTROLLER)

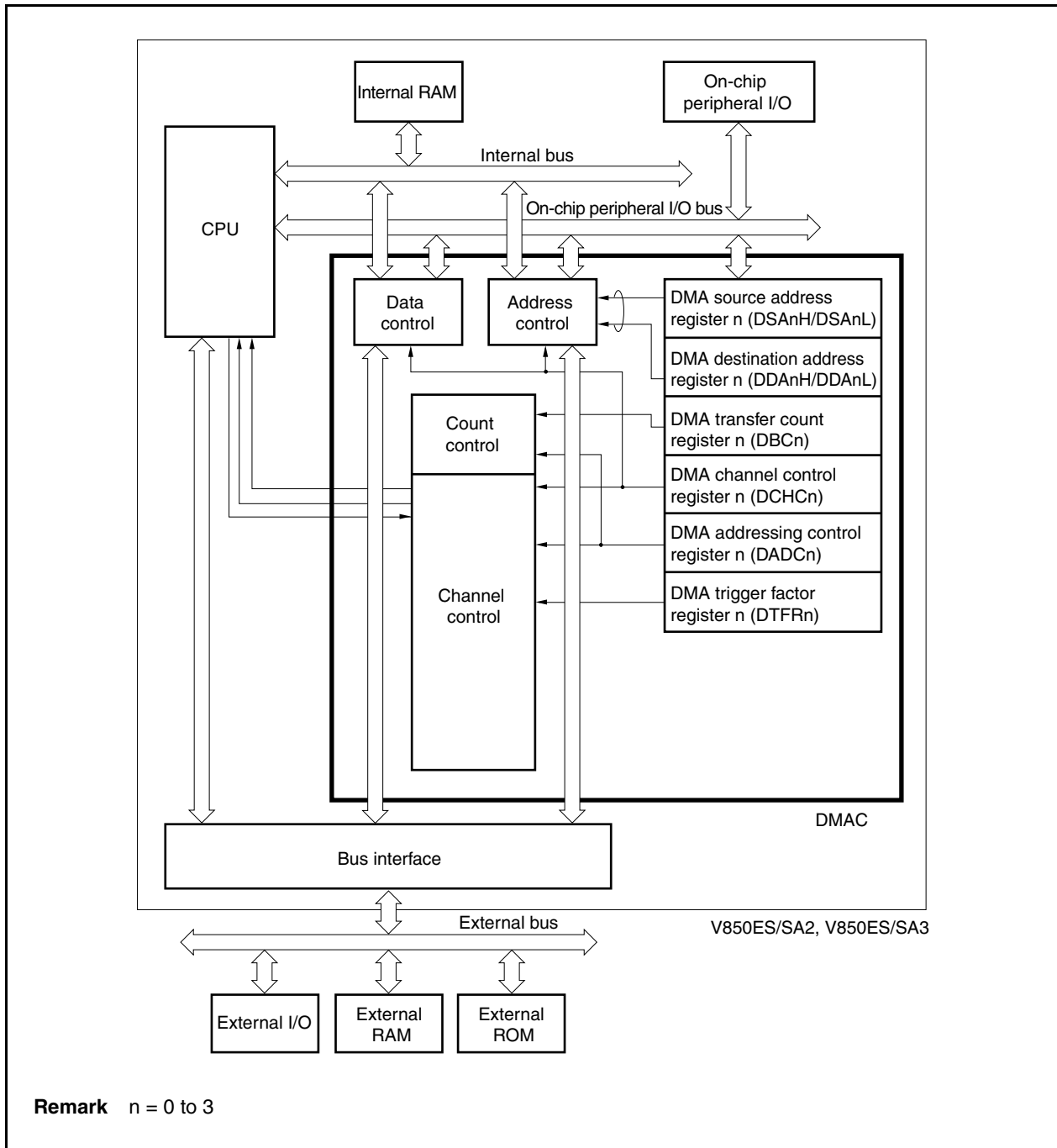
The V850ES/SA2 and V850ES/SA3 include a direct memory access (DMA) controller (DMAC) that executes and controls DMA transfer.

The DMAC controls data transfer between memory and I/O, between memories, or between I/Os based on DMA requests issued by the on-chip peripheral I/O (serial interface, real-time pulse unit, and A/D converter), interrupts from external input pins, or software triggers (memory refers to internal RAM or external memory).

13.1 Features

- 4 independent DMA channels
- Transfer unit: 8/16 bits
- Maximum transfer count: 65,536 (2^{16})
- Transfer type: Two-cycle transfer
- Transfer mode: Single transfer mode
- Transfer requests
 - Request by interrupts from on-chip peripheral I/O (serial interface, timer/counter, A/D converter) or interrupts from external input pin
 - Requests by software trigger
- Transfer objects
 - Internal RAM ↔ peripheral I/O
 - Peripheral I/O ↔ peripheral I/O
 - Internal RAM ↔ external memory
 - External memory ↔ peripheral I/O
 - External memory ↔ external memory

13.2 Configuration



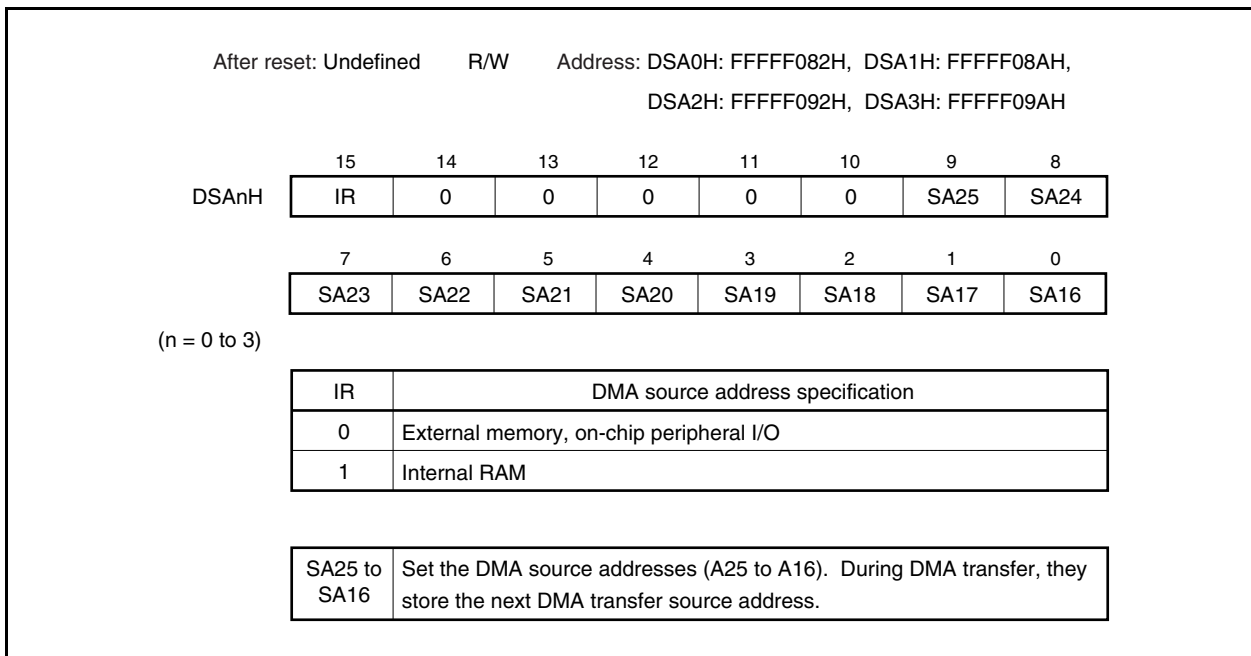
13.3 Control Registers

13.3.1 DMA source address registers 0 to 3 (DSA0 to DSA3)

These registers are used to set the DMA source addresses (28 bits each) for DMA channel n (n = 0 to 3). They are divided into two 16-bit registers, DSA_nH and DSA_nL.

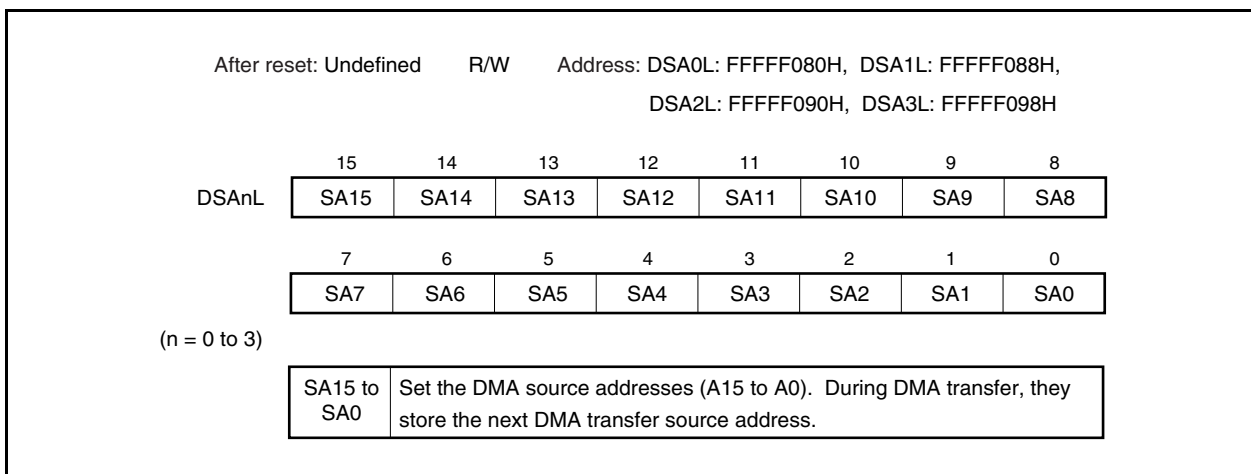
(1) DMA source address registers 0H to 3H (DSA0H to DSA3H)

These registers can be read or written in 16-bit units.



(2) DMA source address registers 0L to 3L (DSA0L to DSA3L)

These registers can be read or written in 16-bit units.

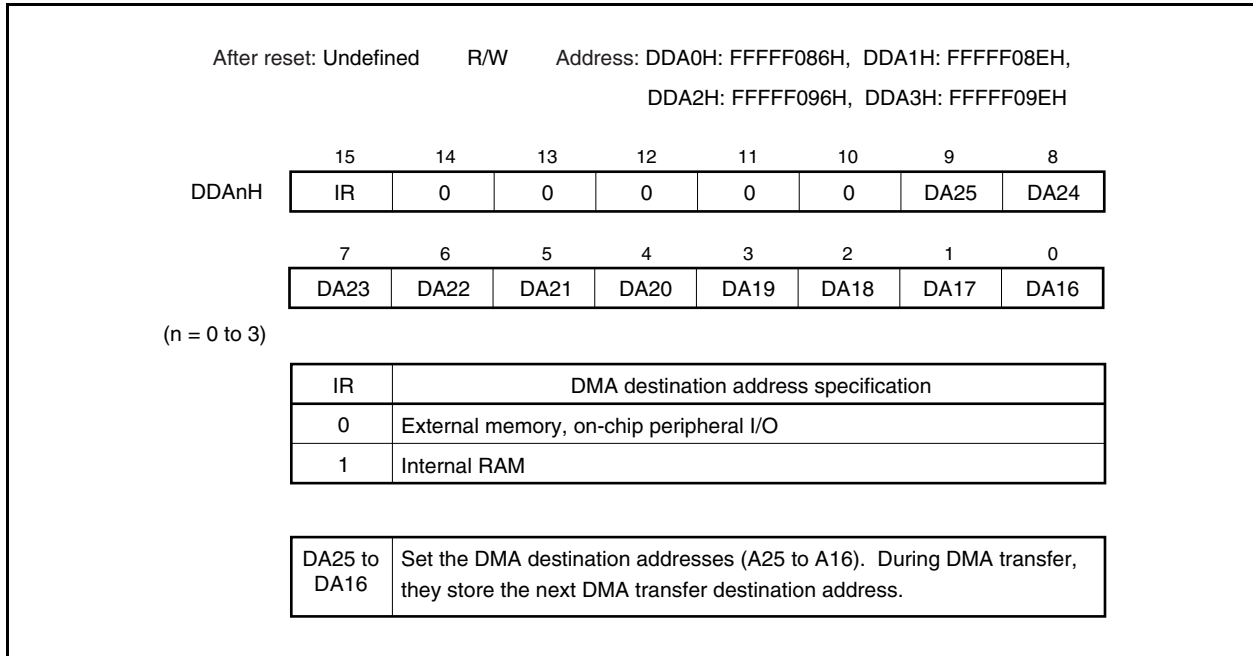


13.3.2 DMA destination address registers 0 to 3 (DDA0 to DDA3)

These registers are used to set the DMA destination address (28 bits each) for DMA channel n (n = 0 to 3). They are divided into two 16-bit registers, DDAnH and DDAnL.

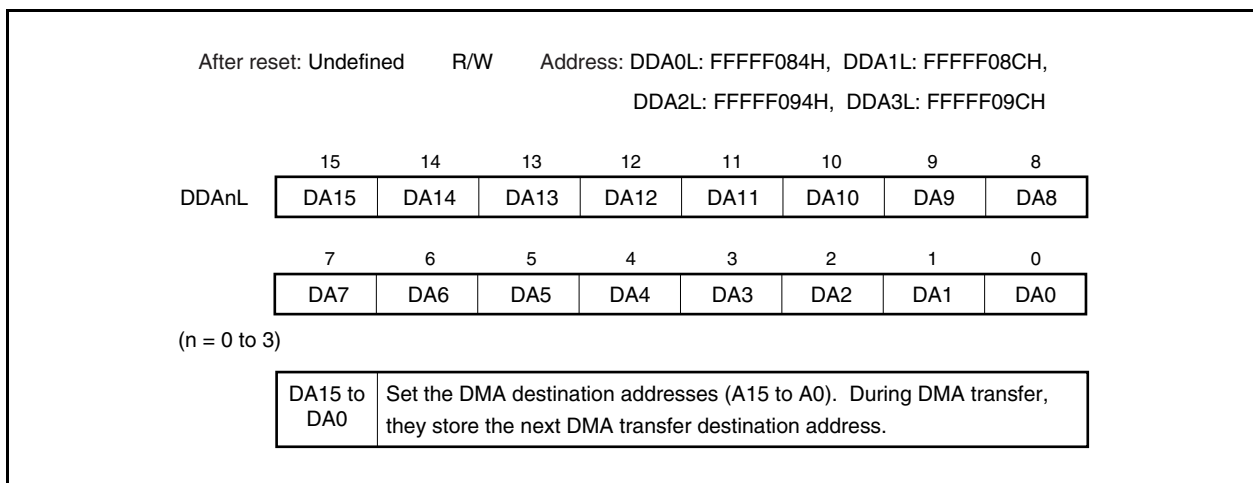
(1) DMA destination address registers 0H to 3H (DDA0H to DDA3H)

These registers can be read or written in 16-bit units.



(2) DMA destination address registers 0L to 3L (DDA0L to DDA3L)

These registers can be read or written in 16-bit units.

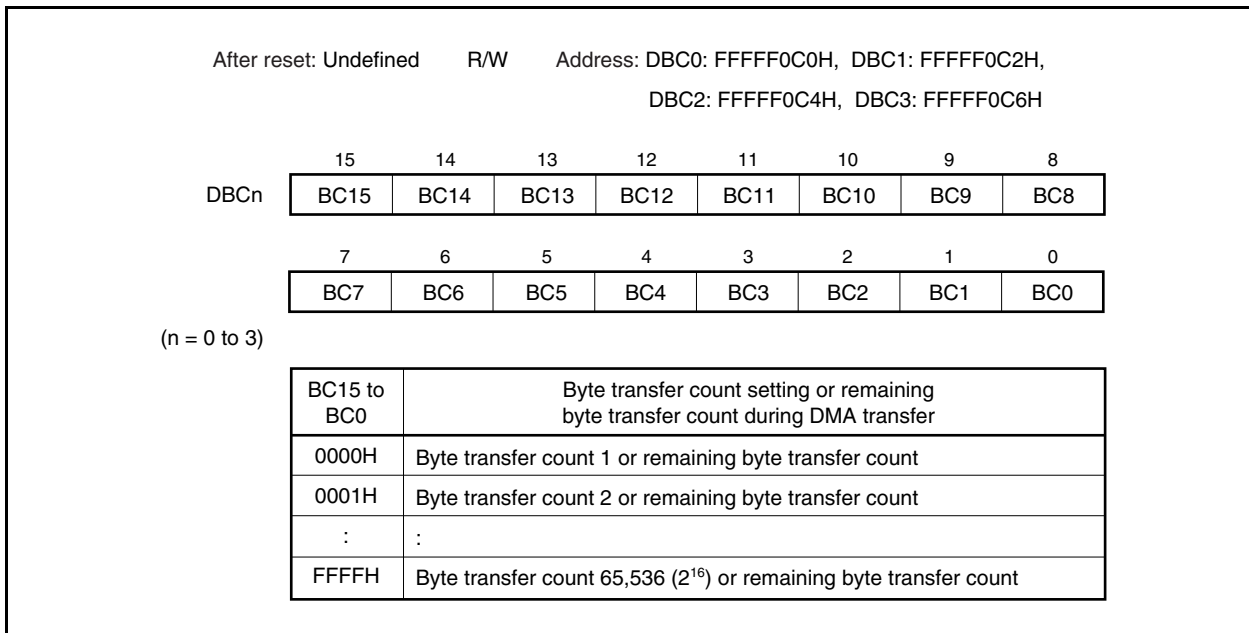


13.3.3 DMA byte count registers 0 to 3 (DBC0 to DBC3)

These 16-bit registers are used to set the byte transfer count for DMA channels n (n = 0 to 3). They store the remaining transfer count during DMA transfer.

These registers can be read or written in 16-bit units.

Remark If the DBCn register is read during DMA transfer after a terminal count has occurred without the register being overwritten, the value set immediately before the DMA transfer will be read out (0000H will not be read, even if DMA transfer has ended).



13.3.4 DMA addressing control registers 0 to 3 (DADC0 to DADC3)

These 16-bit registers are used to control the DMA transfer mode for DMA channel n (n = 0 to 3). These registers cannot be accessed during DMA operation.

They can be read or written in 16-bit units.

After reset: 0000H	R/W	Address: DADC0: FFFF0D0H, DADC1: FFFF0D2H, DADC2: FFFF0D4H, DADC3: FFFF0D6H							
DADCn	15	14	13	12	11	10	9	8	
	0	DS0	0	0	0	0	0	0	
	7	6	5	4	3	2	1	0	
	SAD1	SAD0	DAD1	DAD0	0	0	0	0	
(n = 0 to 3)									
DS0	Setting of transfer data size for DMA transfer								
0	8 bits								
1	16 bits								
SAD1	SAD0	Setting of count direction of the source address for DMA channel n							
0	0	Increment							
0	1	Decrement							
1	0	Fixed							
1	1	Setting prohibited							
DAD1	DAD0	Setting of count direction of the destination address for DMA channel n							
0	0	Increment							
0	1	Decrement							
1	0	Fixed							
1	1	Setting prohibited							

13.3.5 DMA channel control registers 0 to 3 (DCHC0 to DCHC3)

These 8-bit registers are used to control the DMA transfer operating mode for DMA channel n (n = 0 to 3).

These registers can be read or written in 8-bit or 1-bit units. (However, bit 7 is read-only and bit 1 is write-only. If bit 1 is read, the read value is always 0.)

After reset: 00H R/W Address: DCHC0: FFFFF0E0H, DCHC1: FFFFF0E2H,
DCHC2: FFFFF0E4H, DCHC3: FFFFF0E6H

	7	6	5	4	3	2	1	0
DCHCn	TCn ^{Note 1}	0	0	0	0	0	STGn	Enn ^{Note 2}

(n = 0 to 3)

TCn	Status flag indicates whether DMA transfer through DMA channel n has ended or not
0	DMA transfer had not ended.
1	DMA transfer had ended.
It is set to 1 when DMA transfer ends and cleared (to 0) when it is read.	

STGn	If this bit is set to 1 in the DMA transfer enable state (TCn bit = 0, Enn bit = 1), DMA transfer is started.
------	---

Enn	Setting of whether DMA transfer through DMA channel n is to be enabled or disabled
0	DMA transfer disabled
1	DMA transfer enabled
This bit is cleared to 0 when DMA transfer ends. It is also cleared to 0 when DMA transfer is forcibly terminated by means of NMI input.	

Notes 1. TCn bit is read-only.
2. STGn bit is write-only.

Caution Before generating a DMA transfer request by software, make sure that the TCn bit is set to 1 and then clear the TCn bit to 0.

13.3.6 DMA trigger factor registers 0 to 3 (DTFR0 to DTFR3)

These 8-bit registers are used to control the DMA transfer start trigger through interrupt requests from on-chip peripheral I/O.

The interrupt requests set with these registers serve as DMA transfer start factors.

These registers can be read or written in 8-bit or 1-bit units. However, only bit 7 (DFn) can be read/written in 1-bit units.

After reset: 00H R/W Address: DTFR0: FFFFF810H, DTFR1: FFFFF812H,
DTFR2: FFFFF814H, DTFR3: FFFFF816H

	7	6	5	4	3	2	1	0
DTFRn (n = 0 to 3)	DFn	0	IFCn5	IFCn4	IFCn3	IFCn2	IFCn1	IFCn0

DFn ^{Note}	Setting of interrupt source that serves as the DMA start factor
0	No DMA transfer request
1	DMA transfer request

Note The DFn bit is a write-only bit. Write 0 to this bit to clear a DMA transfer request if the interrupt that is specified as the cause of starting DMA transfer while DMA transfer is disabled.

- Cautions**
1. Be sure to stop DMA operation before making changes to DTFRn register settings.
 2. An interrupt request input in a standby mode (IDLE or software STOP mode) cannot be used as a DMA transfer start factor.
 3. For details of IFCn5 to IFCn0 bits, refer to Table 13-1 DMA Start Factor.

Remark n = 0 to 3

Table 13-1. DMA Start Factor

IFCn5	IFCn4	IFCn3	IFCn2	IFCn1	IFCn0	Interrupt Source
0	0	0	0	0	0	DMA request by interrupt disabled
0	0	0	0	0	1	INTWDTM
0	0	0	0	1	0	INTP0
0	0	0	0	1	1	INTP1
0	0	0	1	0	0	INTP2
0	0	0	1	0	1	INTP3
0	0	0	1	1	0	INTP4
0	0	0	1	1	1	INTP5
0	0	1	0	0	0	INTP6
0	0	1	0	0	1	INTRTC
0	0	1	0	1	0	INTCC00
0	0	1	0	1	1	INTCC01
0	0	1	1	0	0	INTOVF0
0	0	1	1	0	1	INTCC10
0	0	1	1	1	0	INTCC11
0	0	1	1	1	1	INTOVF1
0	1	0	0	0	0	INTTM2
0	1	0	0	0	1	INTTM3
0	1	0	0	1	0	INTTM4
0	1	0	0	1	1	INTTM5
0	1	0	1	0	0	INTCSI0
0	1	0	1	0	1	INTIIC
0	1	0	1	1	0	INTCSI1
0	1	0	1	1	1	INTSRE0
0	1	1	0	0	0	INTSR0
0	1	1	0	0	1	INTST0
0	1	1	0	1	0	INTCSI2
0	1	1	0	1	1	INTSRE1
0	1	1	1	0	0	INTSR1
0	1	1	1	0	1	INTST1
0	1	1	1	1	0	INTCSI3
0	1	1	1	1	1	INTCSI4
1	0	0	0	0	0	INTAD
1	0	0	0	0	1	INTOVF
1	0	0	0	1	0	INTBRG
1	0	0	1	1	1	Setting prohibited after this

Remark n = 0 to 3

13.4 DMA Bus States

13.4.1 Types of bus states

The DMAC bus states consist of the following 10 states.

(1) TI state

The TI state is an idle state, during which no access request is issued.

The DMA request signals are sampled at the rising edge of the CLKOUT signal.

(2) T0 state

DMA transfer ready state (state in which a DMA transfer request has been issued and the bus mastership is acquired for the first DMA transfer).

(3) T1R state

The bus enters the T1R state at the beginning of a read operation in the two-cycle transfer mode.

Address driving starts. After entering the T1R state, the bus invariably enters the T2R state.

(4) T1RI state

The T1RI state is a state in which the bus waits for the acknowledge signal corresponding to an external memory read request.

After entering the last T1RI state, the bus invariably enters the T2R state.

(5) T2R state

The T2R state corresponds to the last state of a read operation in the two-cycle transfer mode, or to a wait state.

In the last T2R state, read data is sampled. After entering the last T2R state, the bus invariably enters the T1W state.

(6) T2RI state

State in which the bus is ready for DMA transfer to on-chip peripheral I/O or internal RAM (state in which the bus mastership is acquired for DMA transfer to on-chip peripheral I/O or internal RAM).

After entering the last T2RI state, the bus invariably enters the T1W state.

(7) T1W state

The bus enters the T1W state at the beginning of a write operation in the two-cycle transfer mode.

Address driving starts. After entering the T1W state, the bus invariably enters the T2W state.

(8) T1WI state

State in which the bus waits for the acknowledge signal corresponding to an external memory write request.

After entering the last T1WI state, the bus invariably enters the T2W state.

(9) T2W state

The T2W state corresponds to the last state of a write operation in the two-cycle transfer mode, or to a wait state.

In the last T2W state, the write strobe signal is made inactive.

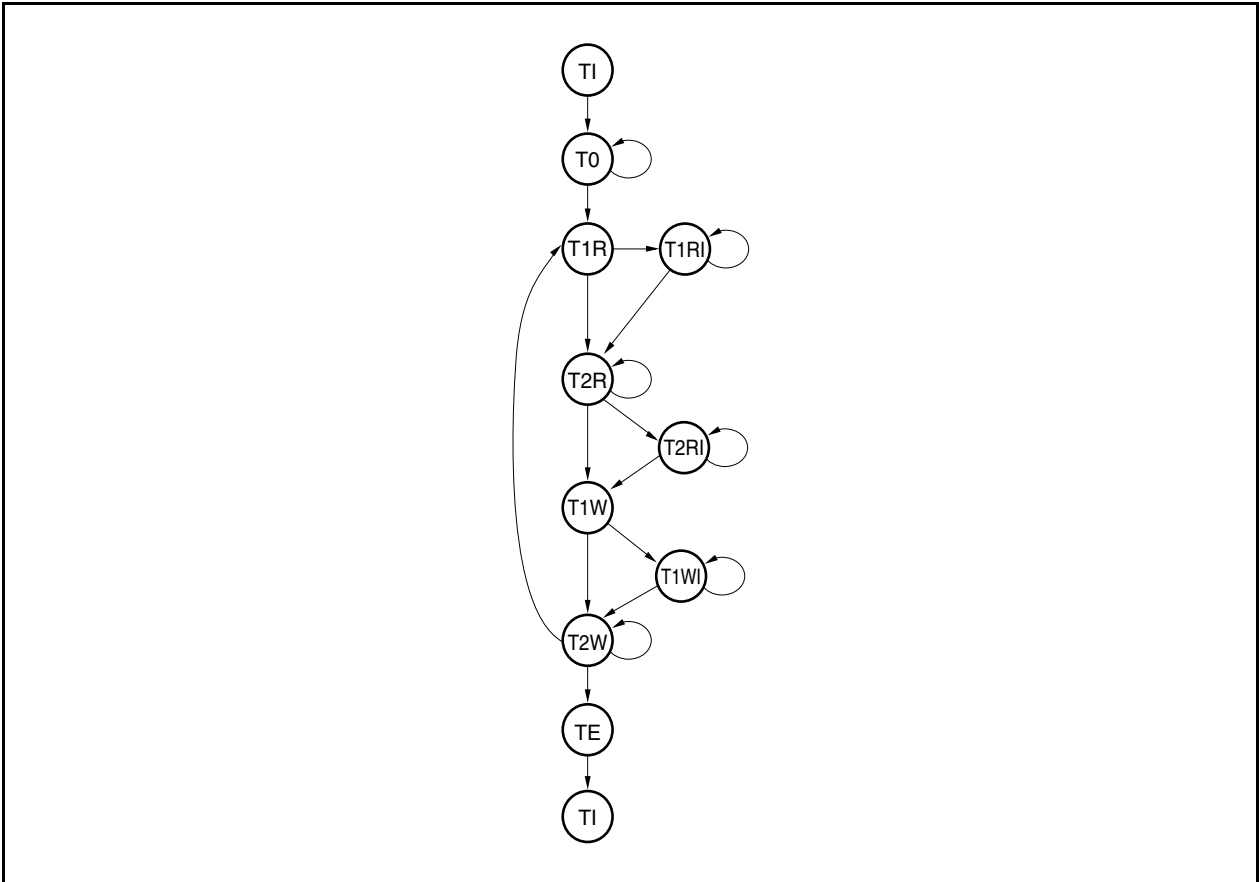
(10) TE state

The TE state corresponds to DMA transfer completion. The DMAC generates the internal DMA transfer completion signal and various internal signals are initialized ($n = 0$ to 3). After entering the TE state, the bus invariably enters the TI state.

13.4.2 DMAC bus cycle state transition

Except for the block transfer mode, each time the processing for a DMA transfer is completed, the bus mastership is released.

Figure 13-1. DMAC Bus Cycle (Two-Cycle Transfer) State Transition



13.5 Transfer Mode

13.5.1 Single transfer mode

In single transfer mode, the DMAC releases the bus at each byte/halfword transfer. If there is a subsequent DMA transfer request, transfer is performed again once. This operation continues until a terminal count occurs.

When the DMAC has released the bus, if another higher priority DMA transfer request is issued, the higher priority DMA request always takes precedence.

13.6 Transfer Types

13.6.1 Two-cycle transfer

In two-cycle transfer, data transfer is performed in two cycles, a read cycle (source to DMAC) and a write cycle (DMAC to destination).

In the first cycle, the source address is output and reading is performed from the source to the DMAC. In the second cycle, the destination address is output and writing is performed from the DMAC to the destination.

13.7 Transfer Object

13.7.1 Transfer type and transfer object

Table 13-2 shows the relationship between transfer type and transfer object (√: Transfer enabled, ×: Transfer disabled).

Table 13-2. Relationship Between Transfer Type and Transfer Object

		Destination				
		Internal ROM	On-Chip Peripheral I/O	External I/O	Internal RAM	External Memory
Source	On-chip peripheral I/O	×	√	√	√	√
	External I/O	×	√	√	√	√
	Internal RAM	×	√	√	×	√
	External memory	×	√	√	√	√
	Internal ROM	×	×	×	×	×

Caution The operation is not guaranteed for combinations of transfer destination and source marked with “x” in Table 13-2.

Remark During two-cycle 16-bit transfer, if the data bus width of the transfer source and that of the transfer destination are different, the operation becomes as follows.

In the case of transfer from a 16-bit bus to an 8-bit bus

A 16-bit read cycle is generated and then an 8-bit write cycle is generated twice.

In the case of transfer from an 8-bit bus to a 16-bit bus

An 8-bit read cycle is generated twice and then a 16-bit write cycle is generated.

13.7.2 External bus cycles during DMA transfer (two-cycle transfer)

The external bus cycles during DMA transfer (two-cycle transfer) are shown below.

Table 13-3. External Bus Cycles During DMA Transfer (Two-Cycle Transfer)

Transfer Object	External Bus Cycle	
On-chip peripheral I/O, internal RAM	None ^{Note}	–
External I/O	Yes	SRAM cycle
External memory	Yes	Memory access cycle set by the BCT register

Note Other external cycles such as a CPU-based bus cycle can be started.

13.8 DMA Channel Priorities

The DMA channel priorities are fixed as follows.

DMA channel 0 > DMA channel 1 > DMA channel 2 > DMA channel 3

These priorities are valid in the TI state only. In the block transfer mode, the channel used for transfer is never switched.

In the single-step transfer mode, if a higher priority DMA transfer request is issued while the bus is released (in the TI state), the higher priority DMA transfer request is acknowledged.

13.9 DMA Transfer Start Factors

There are two types of DMA transfer start factors, as shown below.

(1) Request from software

If the STGn, Enn, and TCn bits of the DCHCn register are set as follows, DMA transfer starts (n = 0 to 3).

- STGn bit = 1
- Enn bit = 1
- TCn bit = 0

(2) Request from on-chip peripheral I/O

If, when the Enn and TCn bits of the DCHCn register are set as shown below, an interrupt request is issued from the on-chip peripheral I/O that is set in the DTFRn register, DMA transfer starts (n = 0 to 3).

- Enn bit = 1
- TCn bit = 0

13.10 DMA Transfer End

13.10.1 DMA transfer end interrupt

When DMA transfer ends and the TCn bit of the DCHCn register is set to 1, a DMA transfer end interrupt (INTDMA_n) is issued to the interrupt controller (INTC) (n = 0 to 3).

13.10.2 Terminal count output upon DMA transfer end

The terminal count signal becomes active for one clock during the last DMA transfer cycle.

13.11 Precautions

(1) Memory boundary

The transfer operation is not guaranteed if the source or the destination address exceeds the area of DMA objects (external memory, internal RAM, or peripheral I/O) during DMA transfer.

(2) Transfer of misaligned data

DMA transfer of 16-bit bus width misaligned data is not supported.

(3) Times related to DMA transfer

The overhead before and after DMA transfer and the minimum execution clock for DMA transfer are shown below.

- Internal RAM access: 2 clocks

Note that for external memory access, the time depends on the type of external memory connected.

(4) Bus arbitration for CPU

The CPU can access external memory, on-chip peripheral I/O, and internal RAM not undergoing DMA transfer. While data transfer among external memories or to and from I/O is being performed, the CPU can access internal RAM.

While data transfer is being executed between internal RAMs, the CPU can access external memory and peripheral I/O.

13.11.1 Interrupt factors

DMA transfer is interrupted if a bus hold is issued.

If the factor (bus hold) interrupting DMA transfer disappears, DMA transfer promptly restarts.

CHAPTER 14 INTERRUPT/EXCEPTION PROCESSING FUNCTION

The V850ES/SA2 and V850ES/SA3 are provided with a dedicated interrupt controller (INTC) for interrupt servicing and can process a total of 38 to 40 interrupt requests.

An interrupt is an event that occurs independently of program execution, and an exception is an event whose occurrence is dependent on program execution.

The V850ES/SA2 and V850ES/SA3 can process interrupt requests from the on-chip peripheral hardware and external sources. Moreover, exception processing can be started by the TRAP instruction (software exception) or by generation of an exception event (i.e. fetching of an illegal opcode) (exception trap).

14.1 Features

○ Interrupts

- Non-maskable interrupts: 2 sources
- Maskable interrupts:
 - μ PD703201, 70F3201: External: 7, Internal: 29 sources
 - μ PD703201Y, 70F3201Y: External: 7, Internal: 30 sources
 - μ PD703204, 70F3204: External: 7, Internal: 30 sources
 - μ PD703204Y, 70F3204Y: External: 7, Internal: 31 sources
- 8 levels of programmable priorities (maskable interrupts)
- Multiple interrupt control according to priority
- Masks can be specified for each maskable interrupt request.
- Noise elimination, edge detection, and valid edge specification for external interrupt request signals.

○ Exceptions

- Software exceptions: 32 sources
- Exception trap: 1 source (illegal opcode exception)

Interrupt/exception sources are listed in Table 14-1.

Table 14-1. Interrupt/Exception Source List (1/2)

Type	Classification	Default Priority	Name	Trigger	Generating Unit	Exception Code	Handler Address	Restored PC	Interrupt Control Register
Reset	Interrupt	-	RESET	RESET pin input	Pin	0000H	00000000H	Undefined	-
				WDT overflow (WDTRES)	WDT				
Non-maskable	Interrupt	-	NMI	NMI pin valid edge input	Pin	0010H	00000010H	nextPC	-
		-	INTWDT	WDT overflow	WDT	0020H	00000020H	nextPC	-
Software exception	Exception	-	TRAP0 ^{Note}	TRAP instruction	-	004nH ^{Note}	00000040H	nextPC	-
		-	TRAP1n ^{Note}	TRAP instruction	-	005nH ^{Note}	00000050H	nextPC	-
Exception trap	Exception	-	ILGOP/ DBG0	Illegal opcode/ DBTRAP instruction	-	0060H	00000060H	nextPC	-
Maskable	Interrupt	0	INTWDTM	Interval timer overflow	WDT	0080H	00000080H	nextPC	WDTIC
		1	INTP0	INTP0 pin valid edge input	Pin	0090H	00000090H	nextPC	PIC0
		2	INTP1	INTP1 pin valid edge input	Pin	00A0H	000000A0H	nextPC	PIC1
		3	INTP2	INTP2 pin valid edge input	Pin	00B0H	000000B0H	nextPC	PIC2
		4	INTP3	INTP3 pin valid edge input	Pin	00C0H	000000C0H	nextPC	PIC3
		5	INTP4	INTP4 pin valid edge input	Pin	00D0H	000000D0H	nextPC	PIC4
		6	INTP5	INTP5 pin valid edge input	Pin	00E0H	000000E0H	nextPC	PIC5
		7	INTP6	INTP6 pin valid edge input	Pin	00F0H	000000F0H	nextPC	PIC6
		8	INTRTC	RTC interrupt	RTC	0100H	00000100H	nextPC	RTCIC
		9	INTCC00	CC00 capture trigger input/ TM0-CC00 match	TM0	0110H	00000110H	nextPC	CCIC00
		10	INTCC01	CC01 capture trigger input/ TM0-CC01 match	TM0	0120H	00000120H	nextPC	CCIC01
		11	INTOVF0	TM0 overflow	TM0	0130H	00000130H	nextPC	OVFIC0
		12	INTCC10	CC10 capture trigger input/ TM1-CC10 match	TM1	0140H	00000140H	nextPC	CCIC10
		13	INTCC11	CC11 capture trigger input/ TM1-CC11 match	TM1	0150H	00000150H	nextPC	CCIC11
		14	INTOVF1	TM1 overflow	TM1	0160H	00000160H	nextPC	OVFIC1
		15	INTTM2	TM2-CR2 match/ TM2 overflow	TM2	0170H	00000170H	nextPC	TMIC2
		16	INTTM3	TM3-CR3 match/ TM3 overflow	TM3	0180H	00000180H	nextPC	TMIC3
		17	INTTM4	TM4-CR4 match/ TM4 overflow	TM4	0190H	00000190H	nextPC	TMIC4
		18	INTTM5	TM5-CR5 match/ TM5 overflow	TM5	01A0H	000001AH	nextPC	TMIC5
		19	INTCSI0	CSI0 transfer completion	CSI0	01B0H	000001B0H	nextPC	CSIIC0
		20	INTIIC ^{Note 1}	I2C transfer completion	I2C	01C0H	000001C0H	nextPC	IICIC0
		21	INTCSI1	CSI1 transfer completion	CSI1	01D0H	000001D0H	nextPC	CSIIC1
		22	INTSRE0	UART0 reception error	UART0	01E0H	000001E0H	nextPC	SREIC0
		23	INTSR0	UART0 reception completion	UART0	01F0H	000001F0H	nextPC	SRIC0
		24	INTST0	UART0 transmission completion	UART0	0200H	00000200H	nextPC	STIC0
25	INTCSI2	CSI2 transfer completion	CSI2	0210H	00000210H	nextPC	CSIIC2		

Note n = 0 to FH

Table 14-1. Interrupt/Exception Source List (2/2)

Type	Classification	Default Priority	Name	Trigger	Generating Unit	Exception Code	Handler Address	Restored PC	Interrupt Control Register
Maskable	Interrupt	26	INTSRE1	UART1 reception error	UART1	0220H	00000220H	nextPC	SREIC1
		27	INTSR1	UART1 reception completion	UART1	0230H	00000230H	nextPC	SRIC1
		28	INTST1	UART1 transmission completion	UART1	0240H	00000240H	nextPC	STIC1
		29	INTCSI3	CSI3 transfer completion	CSI3	0250H	00000250H	nextPC	CSIIC3
		30	INTCSI4 ^{Note 2}	CSI4 transfer completion	CSI4	0260H	00000260H	nextPC	CSIIC4
		31	INTAD	A/D conversion completion	ADC	0270H	00000270H	nextPC	ADIC
		32	INTDMA0	DMA0 transfer completion	DMA	0280H	00000280H	nextPC	DMAIC0
		33	INTDMA1	DMA1 transfer completion	DMA	0290H	00000290H	nextPC	DMAIC1
		34	INTDMA2	DMA2 transfer completion	DMA	02A0H	000002A0H	nextPC	DMAIC2
		35	INTDMA3	DMA3 transfer completion	DMA	02B0H	000002B0H	nextPC	DMAIC3
		36	INTROV	RTC overflow	RTC	02C0H	000002C0H	nextPC	ROVIC
		37	INTBRG	BRG match	BRG	02D0H	000002D0H	nextPC	BRGIC

Notes 1. μ PD703201Y, 70F3201Y, 703204Y, 70F3204Y only

2. V850ES/SA3 only

Remarks 1. Default Priority: The priority order when two or more maskable interrupt requests occur at the same time. The highest priority is 0.

Restored PC: The value of the program counter (PC) saved to EIPC or FEPC when interrupt processing is started. Note, however, that the restored PC when a non-maskable or maskable interrupt is acknowledged while one of the following instructions is being executed does not become the nextPC (if an interrupt is acknowledged during interrupt execution, execution stops, and then resumes after the interrupt servicing has finished).

- Load instructions (SLD.B, SLD.BU, SLD.H, SLD.HU, SLD.W)
- Division instructions (DIV, DIVH, DIVU, DIVHU)
- PREPARE, DISPOSE instructions (only if an interrupt is generated before the stack pointer is updated)

nextPC: The PC value that starts the processing following interrupt/exception processing.

- 2.** The execution address of the illegal instruction when an illegal opcode exception occurs is calculated by (Restored PC – 4).

14.2 Non-Maskable Interrupts

A non-maskable interrupt request is acknowledged unconditionally, even when interrupts are in the interrupt disabled (DI) status. An NMI is not subject to priority control and takes precedence over all the other interrupts.

This product has the following two non-maskable interrupts.

- NMI pin input (NMI)
- Non-maskable interrupt request generated by overflow of watchdog timer (INTWDT)

The valid edge of the NMI pin can be selected from four types: “rising edge”, “falling edge”, “both edges”, and “no edge detection”.

The non-maskable interrupt generated by overflow of the watchdog timer (INTWDT) functions when the WDTM4 and WDTN3 bits of the watchdog timer mode register (WDTM) are set to “10”.

If two or more non-maskable interrupts occur at the same time, the interrupt with the higher priority is serviced, as follows (the interrupt with the lower priority is ignored).

INTWDT > NMI

If a new NMI or INTWDT request is issued while a NMI is being serviced, it is serviced as follows.

(1) If new NMI request is issued while NMI is being serviced

The new NMI request is held pending, regardless of the value of the NP bit of the program status word (PSW) in the CPU. The pending NMI interrupt is acknowledged after the NMI currently under execution has been serviced (after the RETI instruction has been executed).

(2) If INTWDT request is issued while NMI is being serviced

The INTWDT request is held pending if the NP bit of the PSW remains set (1) while the NMI is being serviced. The pending INTWDT request is acknowledged after the NMI currently under execution has been serviced (after the RETI instruction has been executed).

If the NP bit of PSW is cleared (0) while the NMI is being serviced, the newly generated INTWDT request is executed (the NMI servicing is stopped).

Caution If a non-maskable interrupt request is generated, the values of the PC and PSW are saved to the NMI status save registers (FEPC and FEPSW). At this time, execution can be returned by the RETI instruction only from an NMI. Execution cannot be returned while INTWDT is being serviced. Therefore, reset the system after the interrupt has been serviced.

Figure 14-1. Non-Maskable Interrupt Request Acknowledgement Operation (1/2)

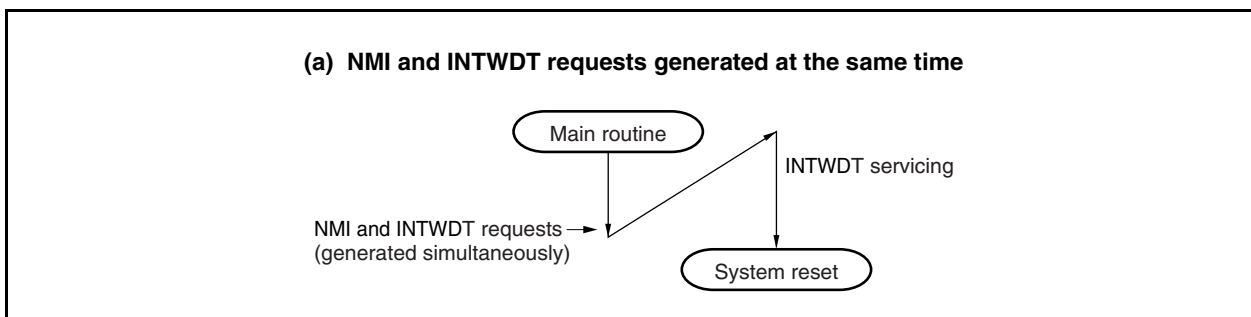
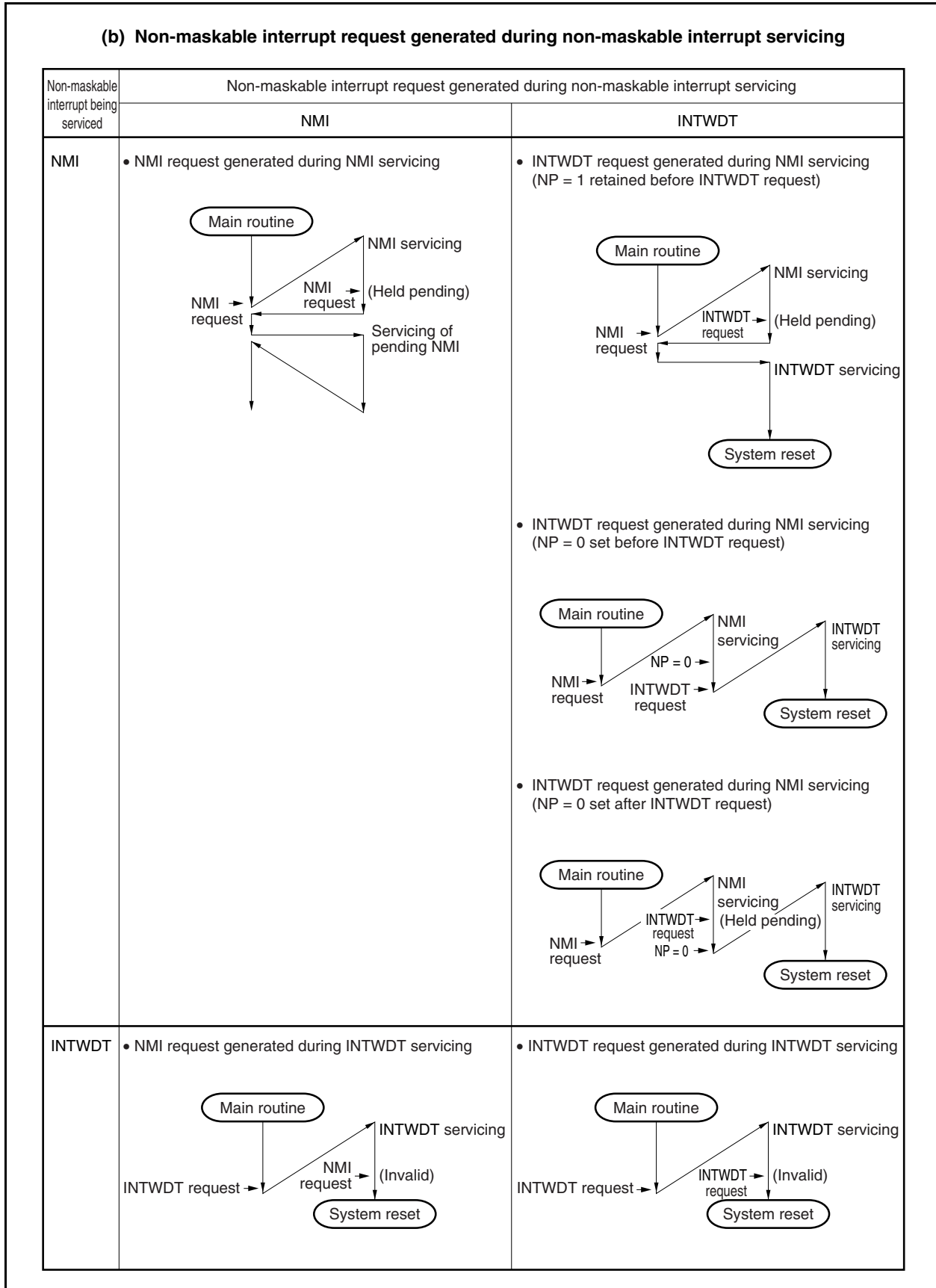


Figure 14-1. Non-Maskable Interrupt Request Acknowledgement Operation (2/2)



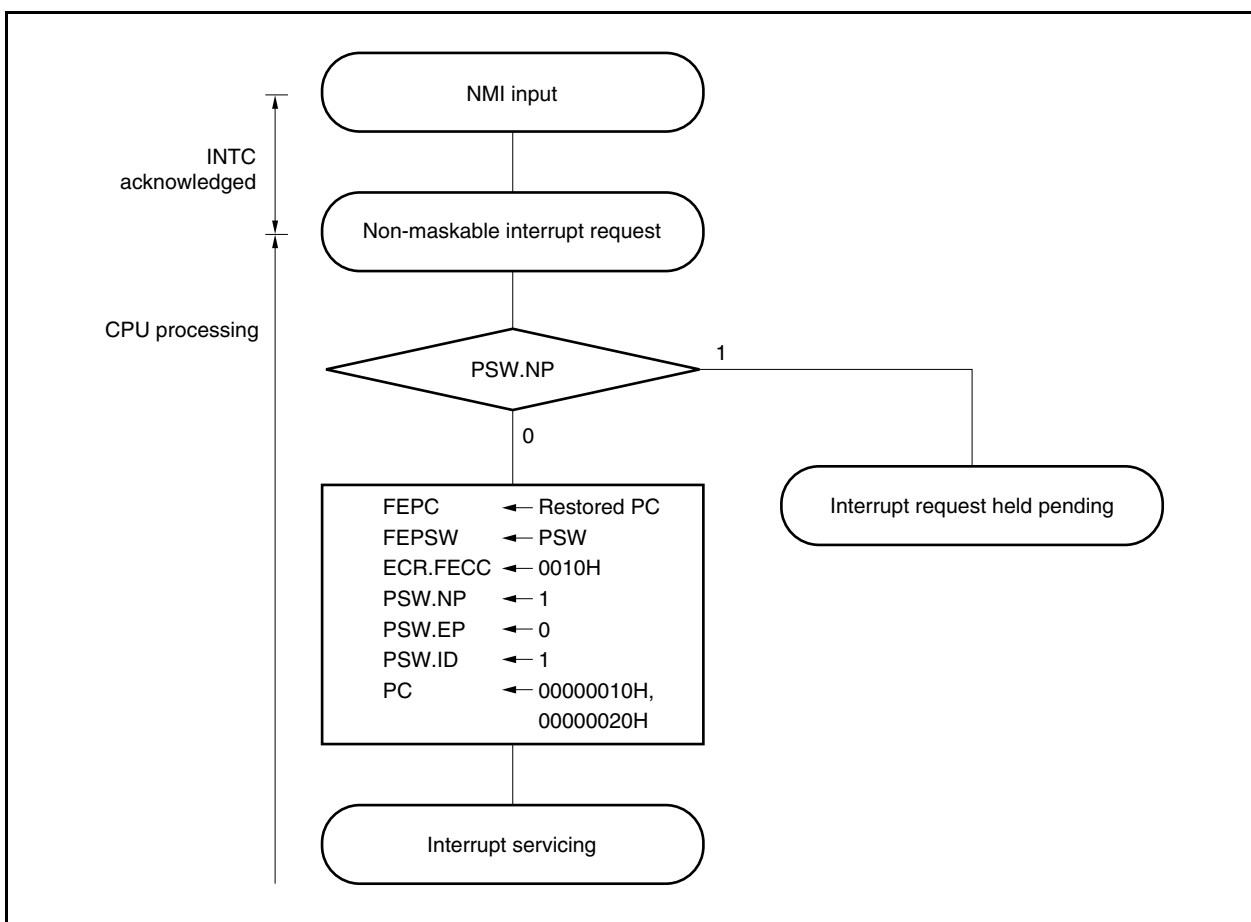
14.2.1 Operation

If a non-maskable interrupt is generated by NMI input, the CPU performs the following processing, and transfers control to the handler routine.

- <1> Saves the restored PC to FEPC.
- <2> Saves the current PSW to FEPSW.
- <3> Writes exception code 0010H to the higher halfword (FECC) of ECR.
- <4> Sets the NP and ID bits of the PSW and clears the EP bit.
- <5> Sets the handler address (00000010H, 00000020H) corresponding to the non-maskable interrupt to the PC, and transfers control.

The servicing configuration of a non-maskable interrupt is shown in Figure 14-2.

Figure 14-2. Servicing Configuration of Non-Maskable Interrupt



14.2.2 Restore

(1) From NMI

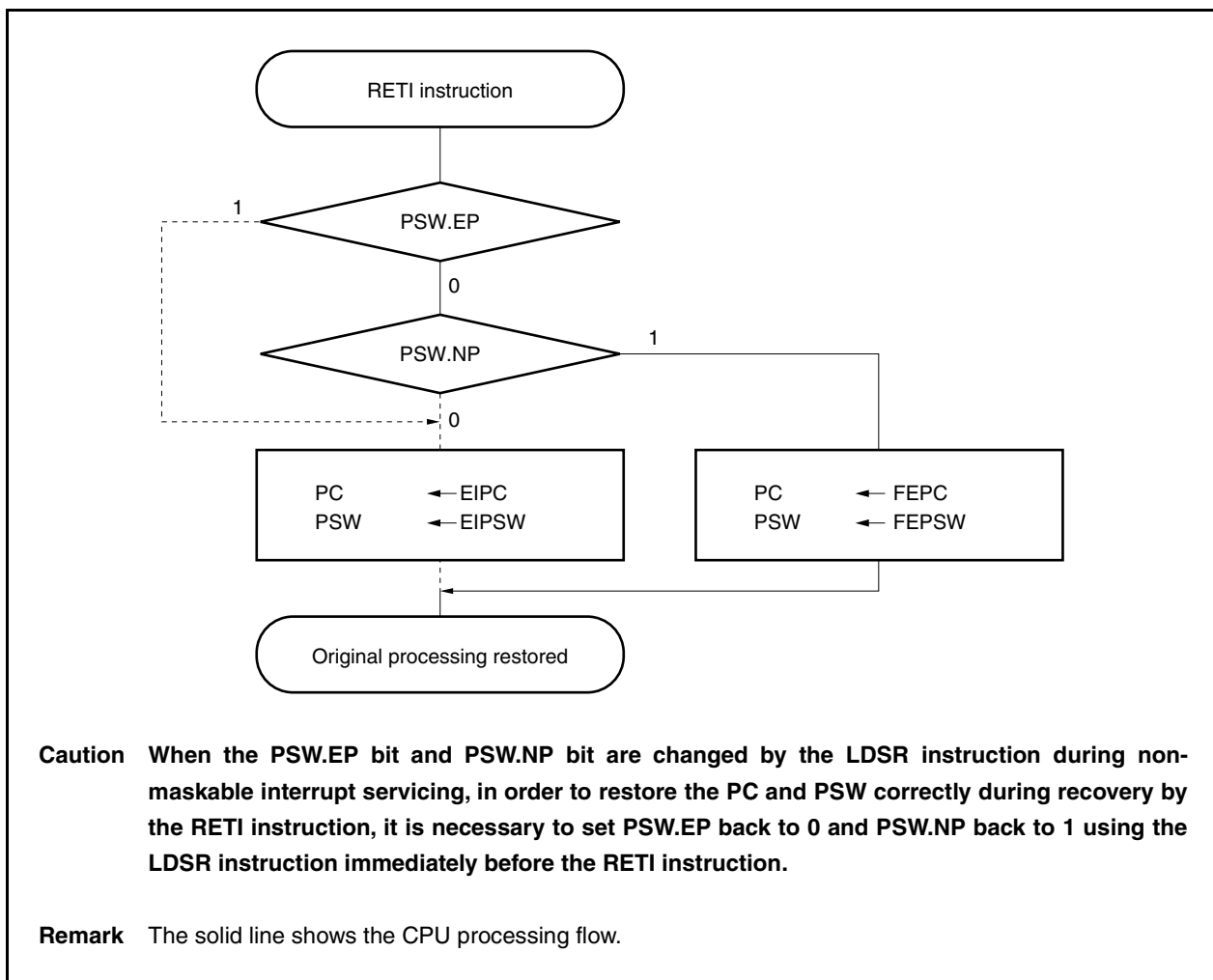
Execution is restored from the NMI by the RETI instruction.

When the RETI instruction is executed, the CPU performs the following processing, and transfers control to the address of the restored PC.

- <1> Loads the restored PC and PSW from FEPC and FEPSW, respectively, because the EP bit of the PSW is 0 and the NP bit of the PSW is 1.
- <2> Transfers control back to the address of the restored PC and PSW.

Figure 14-3 illustrates how the RETI instruction is processed.

Figure 14-3. RETI Instruction Processing



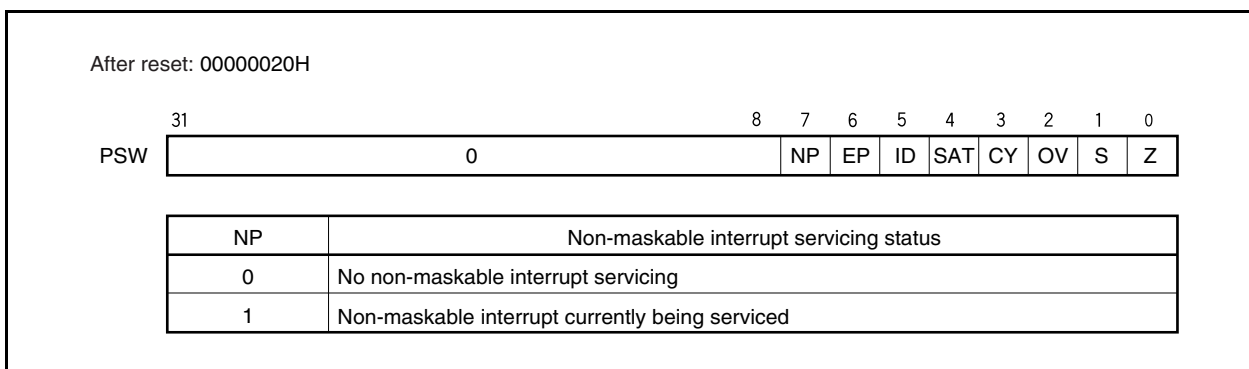
(2) From INTWDT

Execution cannot be returned from INTWDT by the RETI instruction. Execute a system reset after the interrupt has been serviced.

14.2.3 NP flag

The NP flag is a status flag that indicates that non-maskable interrupt servicing is under execution.

This flag is set when a non-maskable interrupt request has been acknowledged, and masks non-maskable interrupt requests to prohibit multiple interrupts from being acknowledged.



14.2.4 Eliminating noise on NMI pin

The NMI pin has a noise eliminator that eliminates noise using analog delay. Unless the level input to the NMI pin is held for a specific time, therefore, it cannot be detected as an edge i.e., the edge is detected after specific time.

The NMI pin is used to release the software STOP mode. Because the internal system clock is stopped in the software STOP mode, noise is not eliminated by using the system clock.

14.2.5 Function to detect edge of NMI pin

The valid edge of the NMI pin can be selected from four types: “rising edge”, “falling edge”, “both edges”, and “no edge detection”.

Specify the valid edge of the non-maskable interrupt (NMI) by using rising edge specification register 0 (INTR0) and falling edge specification register 0 (INTF0). These registers can be read or written in 8-bit or 1-bit units.

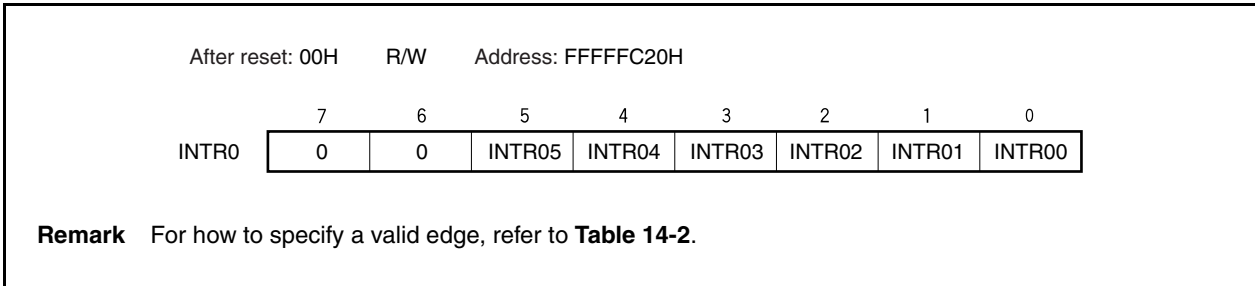
After reset, it is specified that “no edge is detected” on the NMI pin. Unless the valid edge is specified by the INTF0 and INTR0 registers, therefore, an interrupt request is not acknowledged (the NMI pin serves as a port pin).

To use the P00/NMI pin as an I/O port pin, specify that the valid edge of the NMI pin is “no edge detection”.

(1) External interrupt rising edge specification register 0 (INTR0)

This is an 8-bit register that specifies detection of the rising edge of the NMI pin.
This register can be read or written in 8-bit or 1-bit units.

Caution When the function is changed from the external interrupt function (alternate function) to the port function, an edge may be detected. Therefore, clear INTF0n and INTR0n to 0, and then set the port mode.



(2) External interrupt falling edge specification register 0 (INTF0)

This is an 8-bit register that specifies detection of the falling edge of the NMI pin.
This register can be read or written in 8-bit or 1-bit units.

Caution When the function is changed from the external interrupt function (alternate function) to the port function, an edge may be detected. Therefore, clear INTF0n and INTR0n to 0, and then set the port mode.

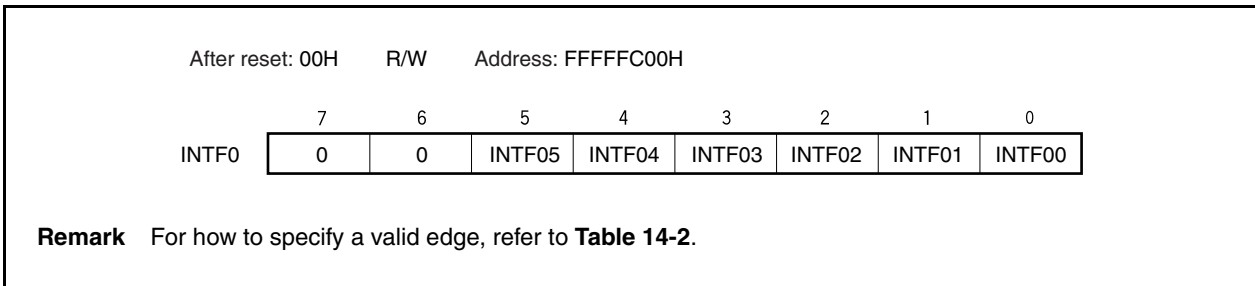


Table 14-2. Specifying Valid Edge of NMI

INTF00	INTR00	Specifying Valid Edge of NMI
0	0	No edge detected
0	1	Rising edge
1	0	Falling edge
1	1	Both edges

14.3 Maskable Interrupts

Maskable interrupt requests can be masked by interrupt control registers. The V850ES/SA2 and V850ES/SA3 have 38 to 40 maskable interrupt sources.

If two or more maskable interrupt requests are generated at the same time, they are acknowledged according to the default priority. In addition to the default priority, eight levels of priorities can be specified by using the interrupt control registers (programmable priority control).

When an interrupt request has been acknowledged, the acknowledgement of other maskable interrupt requests is disabled and the interrupt disabled (DI) status is set.

When the EI instruction is executed in an interrupt service routine, the interrupt enabled (EI) status is set, which enables servicing of interrupts having a higher priority than the interrupt request in progress (specified by the interrupt control register). Note that only interrupts with a higher priority will have this capability; interrupts with the same priority level cannot be nested.

To enable multiple interrupts, however, save EIPC and EIPSW to memory or registers before executing the EI instruction, and execute the DI instruction before the RETI instruction to restore the original values of EIPC and EIPSW.

If the WDTM4 bit of the watchdog timer mode register (WDTM) is cleared to 0, the watchdog timer overflow interrupt functions as a maskable interrupt (INTWDTM).

14.3.1 Operation

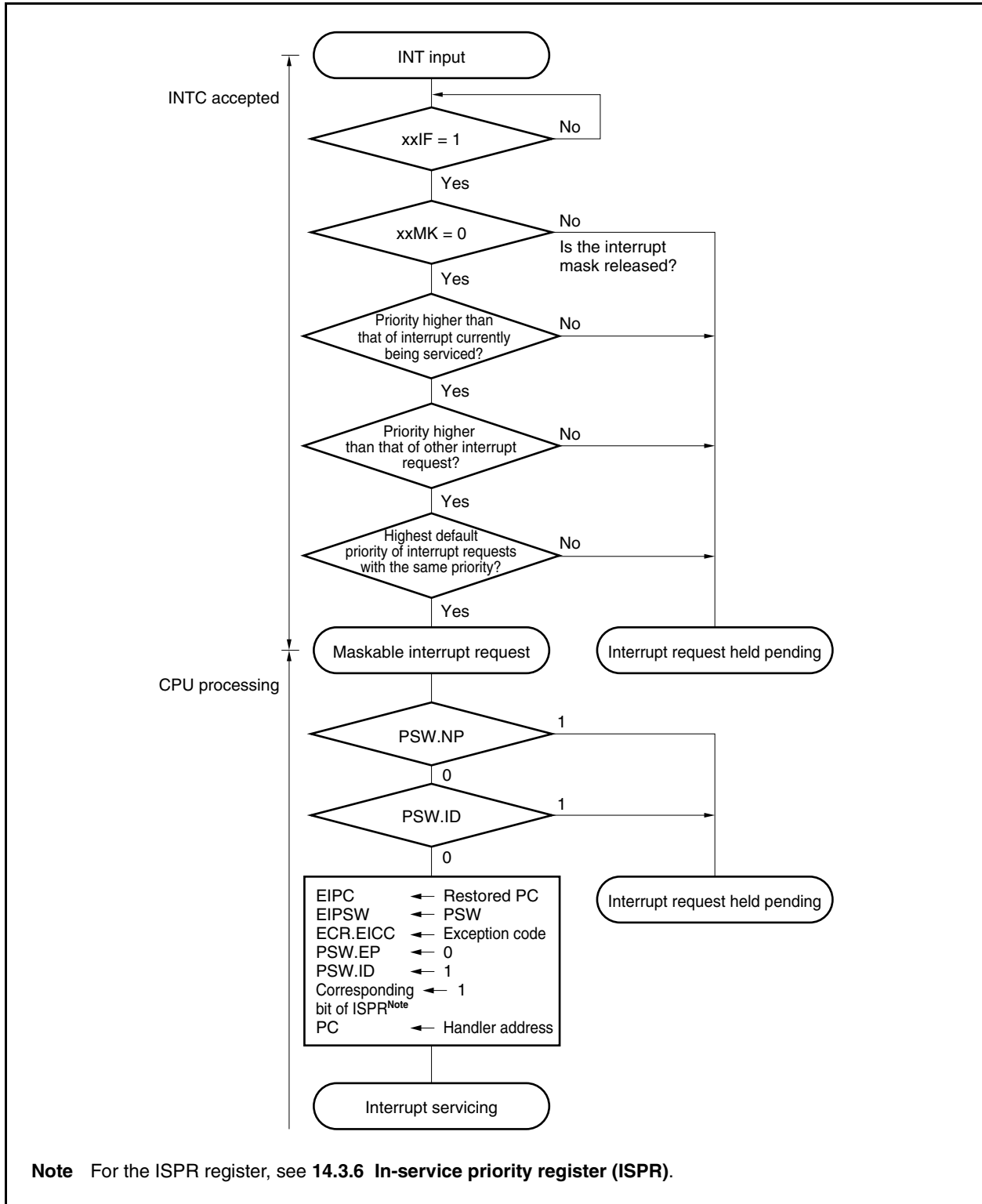
If a maskable interrupt occurs by INT input, the CPU performs the following processing, and transfers control to a handler routine.

- <1> Saves the restored PC to EIPC.
- <2> Saves the current PSW to EIPSW.
- <3> Writes an exception code to the lower halfword of ECR (EICC).
- <4> Sets the ID bit of the PSW and clears the EP bit.
- <5> Sets the handler address corresponding to each interrupt to the PC, and transfers control.

The maskable interrupt request masked by INTC and the maskable interrupt request generated while another interrupt is being serviced (while PSW.NP = 1 or PSW.ID = 1) are held pending inside INTC. In this case, servicing a new maskable interrupt is started in accordance with the priority of the pending maskable interrupt request if either the maskable interrupt is unmasked or PSW.NP and PSW.ID are cleared to 0 by using the RETI or LDSR instruction.

How maskable interrupts are serviced is illustrated below.

Figure 14-4. Maskable Interrupt Servicing



The INT input masked by the interrupt controllers and the INT input that occurs while another interrupt is being serviced (when PSW.NP = 1 or PSW.ID = 1) are held pending internally by the interrupt controller. In such case, if the interrupts are unmasked, or when PSW.NP = 0 and PSW.ID = 0 as set by the RETI and LDSR instructions, input of the pending INT starts the new maskable interrupt servicing.

14.3.2 Restore

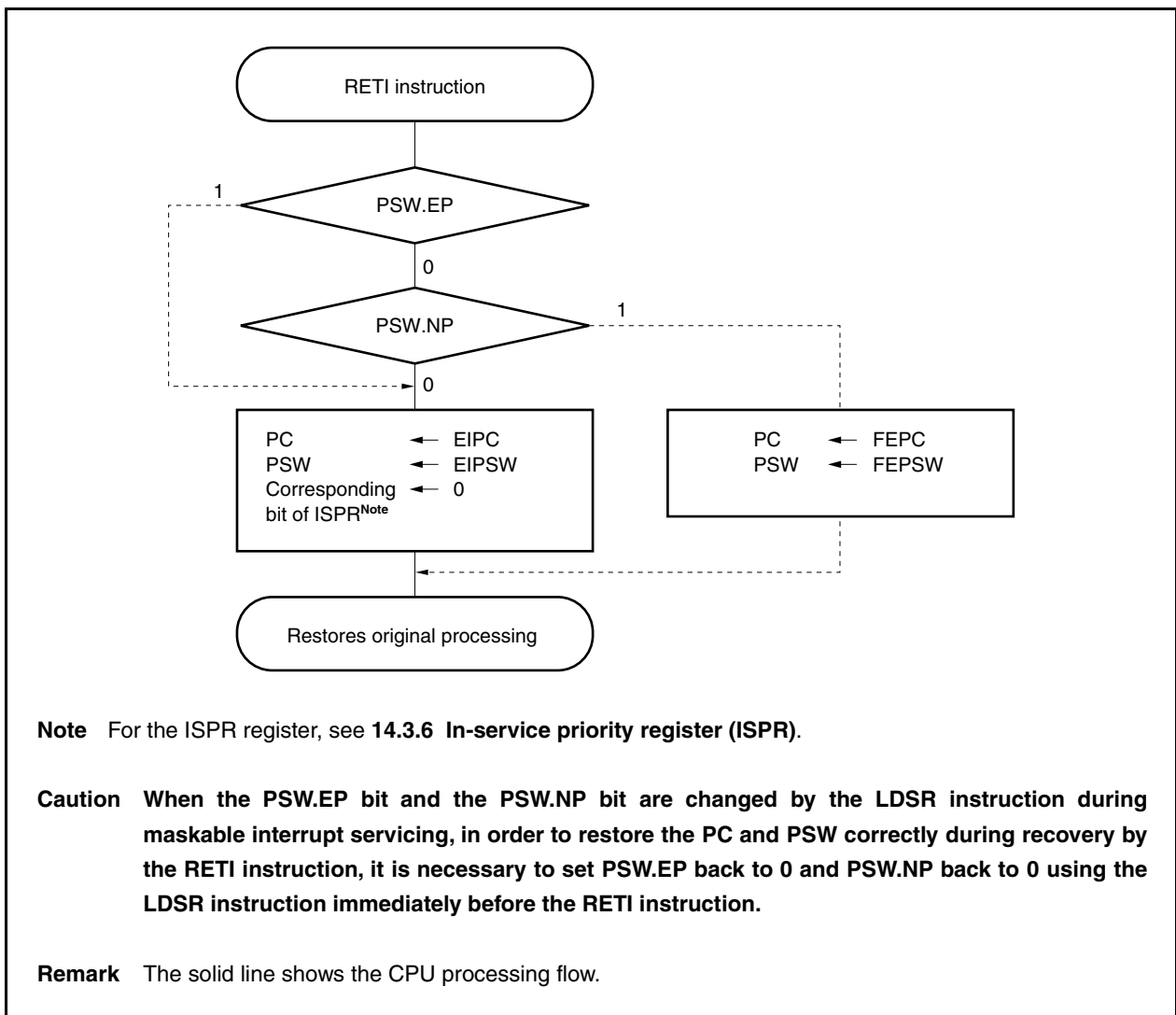
Recovery from maskable interrupt servicing is carried out by the RETI instruction.

When the RETI instruction is executed, the CPU performs the following steps, and transfers control to the address of the restored PC.

- <1> Loads the restored PC and PSW from EIPC and EIPSW because the EP bit of the PSW is 0 and the NP bit of the PSW is 0.
- <2> Transfers control to the address of the restored PC and PSW.

Figure 14-5 illustrates the processing of the RETI instruction.

Figure 14-5. RETI Instruction Processing



14.3.3 Priorities of maskable interrupts

The V850ES/SA2 and V850ES/SA3 provide multiple interrupt servicing in which an interrupt is acknowledged while another interrupt is being serviced. Multiple interrupts can be controlled by priority levels.

There are two types of priority level control: control based on the default priority levels, and control based on the programmable priority levels that are specified by the interrupt priority level specification bit (xxPRn) of the interrupt control register (xxICn). When two or more interrupts having the same priority level specified by the xxPRn bit are generated at the same time, interrupts are serviced in order depending on the priority level allocated to each interrupt request type (default priority level) beforehand. For more information, refer to **Table 14-1 Interrupt/Exception Source List**. The programmable priority control customizes interrupt requests into eight levels by setting the priority level specification flag.

Note that when an interrupt request is acknowledged, the ID flag of PSW is automatically set to 1. Therefore, when multiple interrupts are to be used, clear the ID flag to 0 beforehand (for example, by placing the EI instruction in the interrupt service program) to set the interrupt enable mode.

- Remark** xx: Identification name of each peripheral unit (AD, BRG, CC, CSI, DMA, IIC, OVF, P, ROV, RTC, SRE, ST, TM, WDT)
n: Peripheral unit number (None or 0 to 3).

Figure 14-6. Example of Processing in Which Another Interrupt Request Is Issued While an Interrupt Is Being Serviced (1/2)

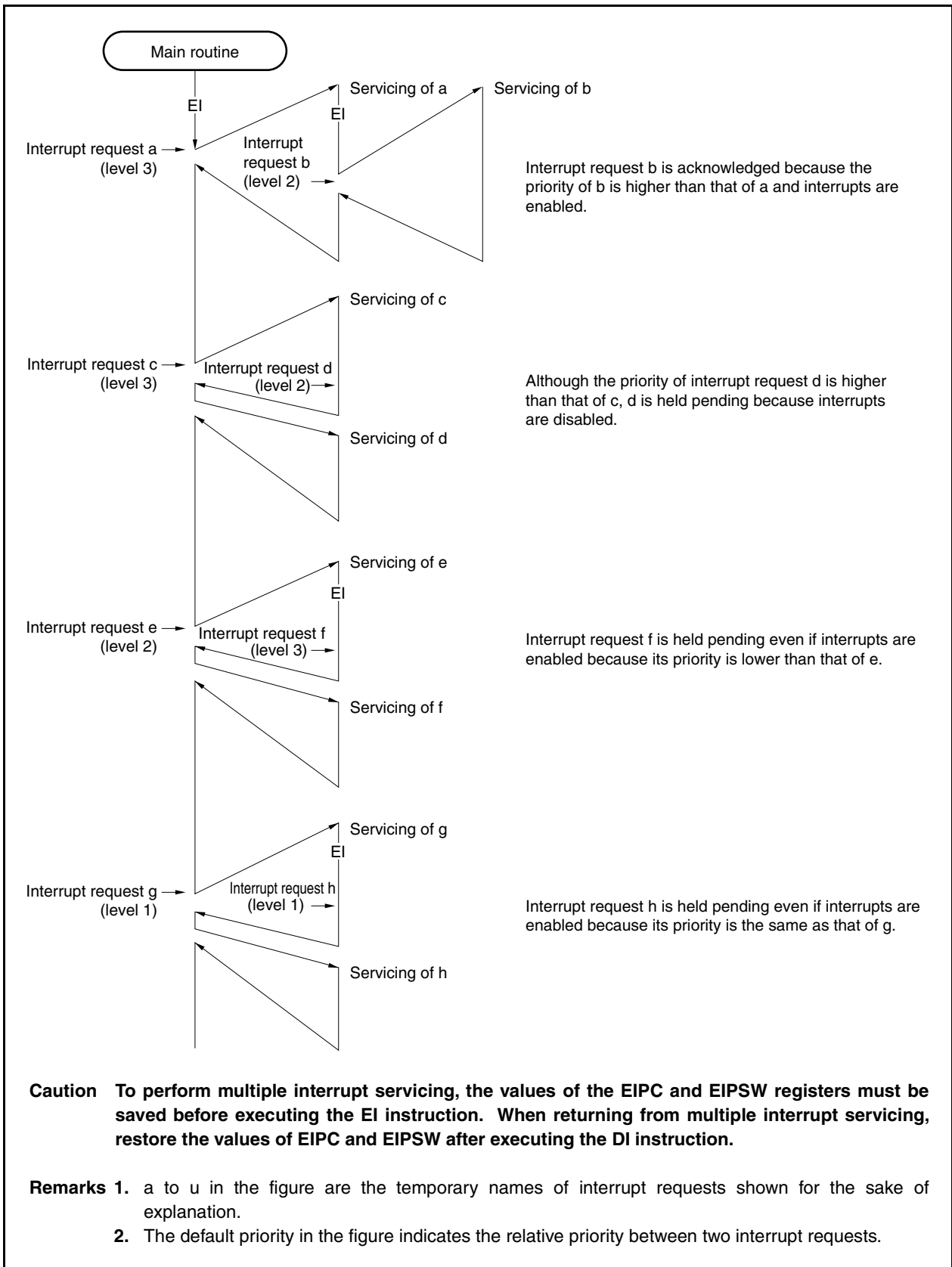


Figure 14-6. Example of Processing in Which Another Interrupt Request Is Issued While an Interrupt Is Being Serviced (2/2)

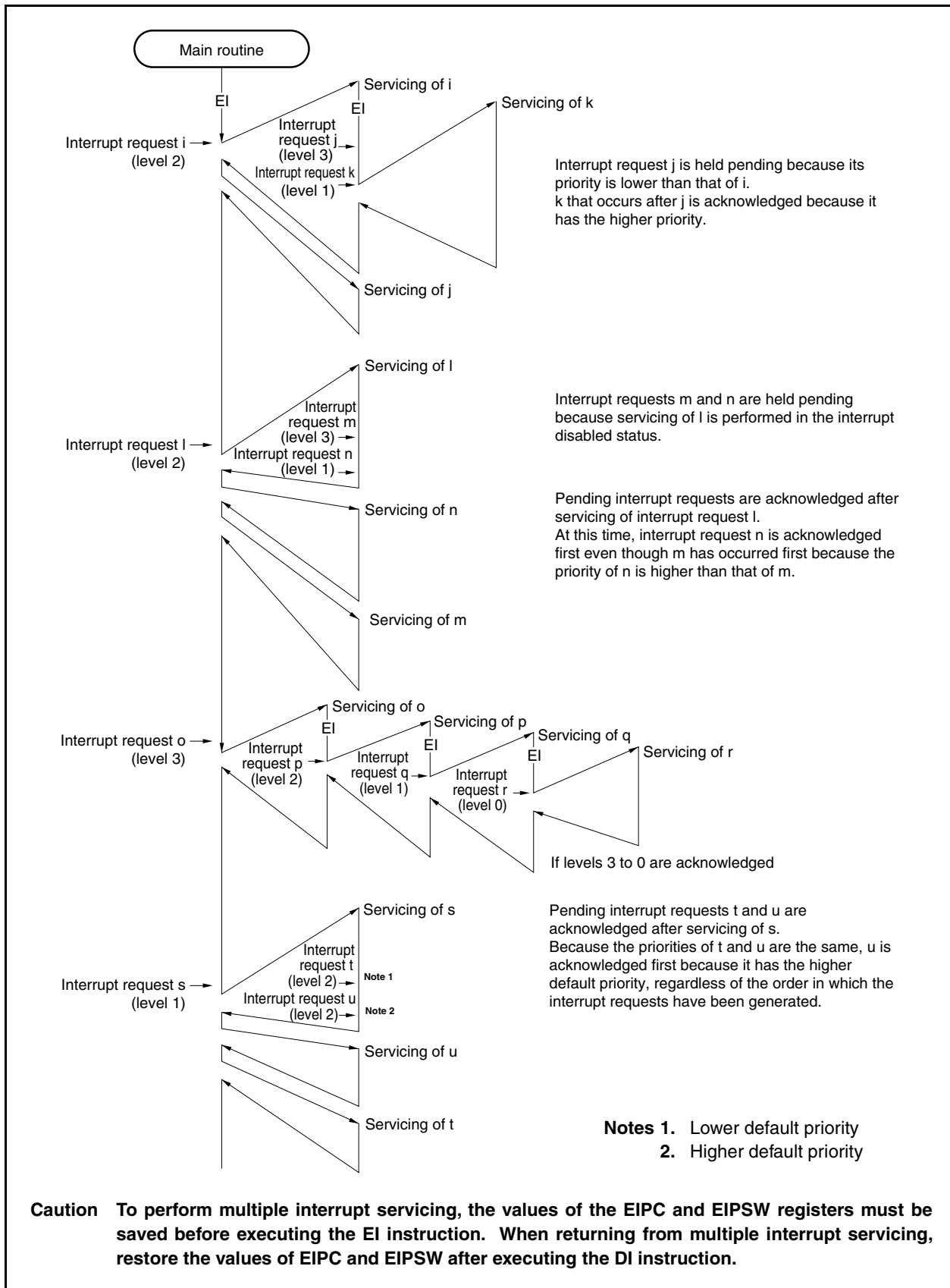
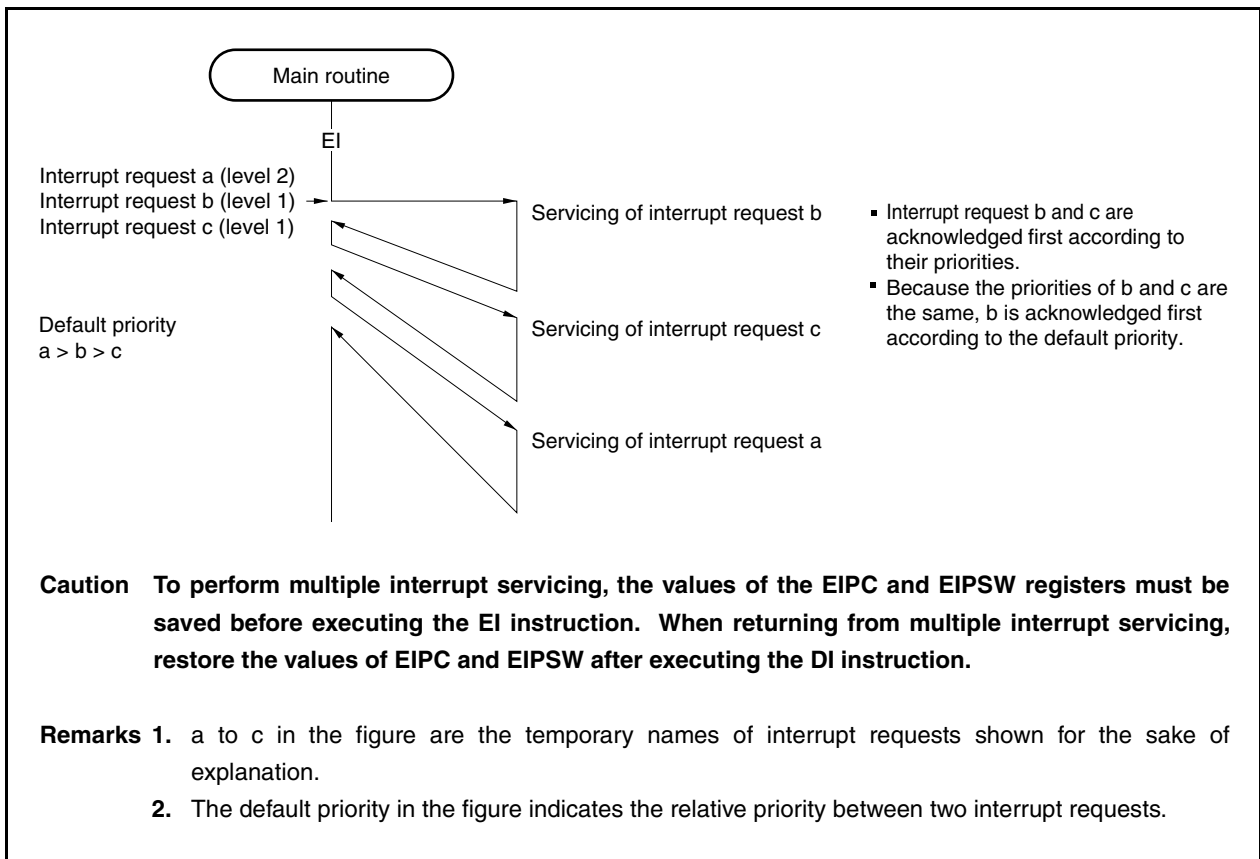


Figure 14-7. Example of Servicing Interrupt Requests Simultaneously Generated



14.3.4 Interrupt control register (xxlCn)

An interrupt control register is assigned to each interrupt request (maskable interrupt) and sets the control conditions for each maskable interrupt request.

This register can be read or written in 8-bit or 1-bit units.

After reset: 47H R/W Address: FFFFF110H to FFFFF15AH

<7>	<6>	5	4	3	2	1	0
xxlFn	xxMKn	0	0	0	xxPRn2	xxPRn1	xxPRn0

xxlFn	Interrupt request flag ^{Note}
0	Interrupt request not issued
1	Interrupt request issued

xxMKn	Interrupt mask flag
0	Interrupt servicing enabled
1	Interrupt servicing disabled (pending)

xxPRn2	xxPRn1	xxPRn0	Interrupt priority specification bit
0	0	0	Specifies level 0 (highest).
0	0	1	Specifies level 1.
0	1	0	Specifies level 2.
0	1	1	Specifies level 3.
1	0	0	Specifies level 4.
1	0	1	Specifies level 5.
1	1	0	Specifies level 6.
1	1	1	Specifies level 7 (lowest).

Note The flag xxlFn is reset automatically by the hardware if an interrupt request is acknowledged.

Remark xx: Identification name of each peripheral unit (OV, P00 to P03, P10 to P13, CM, DMA, CSI, SE, SR, ST, AD)
n: Peripheral unit number (None or 0 to 3).

The addresses and bits of the interrupt control registers are as follows.

Table 14-3. Interrupt Control Register (xxICn)

Address	Register	Bit							
		<7>	<6>	5	4	3	2	1	0
FFFFF110H	WDTIC1	WDTIF	WDTMK	0	0	0	WDTPR2	WDTPR1	WDTPR0
FFFFF112H	PIC0	PIF0	PMK0	0	0	0	PPR02	PPR01	PPR00
FFFFF114H	PIC1	PIF1	PMK1	0	0	0	PPR12	PPR11	PPR10
FFFFF116H	PIC2	PIF2	PMK2	0	0	0	PPR22	PPR21	PPR20
FFFFF118H	PIC3	PIF3	PMK3	0	0	0	PPR32	PPR31	PPR30
FFFFF11AH	PIC4	PIF4	PMK4	0	0	0	PPR42	PPR41	PPR40
FFFFF11CH	PIC5	PIF5	PMK5	0	0	0	PPR52	PPR51	PPR50
FFFFF11EH	PIC6	PIF6	PMK6	0	0	0	PPR62	PPR61	PPR60
FFFFF120H	RTCIC	RTCIF	RTCMK	0	0	0	RTCR2	RTCR1	RTCR0
FFFFF122H	CCIC00	CCIF00	CCMK00	0	0	0	CCR002	CCR001	CCR000
FFFFF124H	CCIC01	CCIF01	CCMK01	0	0	0	CCR012	CCR011	CCR010
FFFFF126H	OVFIC0	OVFIF0	OVFMK0	0	0	0	OVFR02	OVFR01	OVFR00
FFFFF128H	CCIC10	CCIF10	CCMK10	0	0	0	CCR102	CCR101	CCR100
FFFFF12AH	CCIC11	CCIF11	CCMK11	0	0	0	CCR112	CCR111	CCR110
FFFFF12CH	OVFIC1	OVFIF1	OVFMK1	0	0	0	OVFR12	OVFR11	OVFR10
FFFFF12EH	TMIC2	TMF2	TMMK2	0	0	0	TMPR22	TMPR21	TMPR20
FFFFF130H	TMIC3	TMF3	TMMK3	0	0	0	TMPR32	TMPR31	TMPR30
FFFFF132H	TMIC4	TMF4	TMMK4	0	0	0	TMPR42	TMPR41	TMPR40
FFFFF134H	TMIC5	TMF5	TMMK5	0	0	0	TMPR52	TMPR51	TMPR50
FFFFF136H	CSIIC0	CSIF0	CSIMK0	0	0	0	CSIPR02	CSIPR01	CSIPR00
FFFFF138H	IICIC ^{Note 1}	IICIF	IICMK	0	0	0	IICPR2	IICPR1	IICPR0
FFFFF13AH	CSIIC1	CSIF1	CSIMK1	0	0	0	CSIPR12	CSIPR11	CSIPR10
FFFFF13CH	SREIC0	SREIF0	SREMK0	0	0	0	SREPR02	SREPR01	SREPR00
FFFFF13EH	SRIC0	SRIF0	SRMK0	0	0	0	SRPR02	SRPR01	SRPR00
FFFFF140H	STIC0	STIF0	STMK0	0	0	0	STPR02	STPR01	STPR00
FFFFF142H	CSIIC2	CSIF2	CSIMK2	0	0	0	CSIPR22	CSIPR21	CSIPR20
FFFFF144H	SREIC1	SREIF1	SREMK1	0	0	0	SREPR12	SREPR11	SREPR10
FFFFF146H	SRIC1	SRIF1	SRMK1	0	0	0	SRPR12	SRPR11	SRPR10
FFFFF148H	STIC1	STIF1	STMK1	0	0	0	STPR12	STPR11	STPR10
FFFFF14AH	CSIIC3	CSIF3	CSIMK3	0	0	0	CSIPR32	CSIPR31	CSIPR30
FFFFF14CH	CSIIC4 ^{Note 2}	CSIF4	CSIMK4	0	0	0	CSIPR42	CSIPR41	CSIPR40
FFFFF14EH	ADIC	ADIF	ADMK	0	0	0	ADPR2	ADPR1	ADPR0
FFFFF150H	DMAIC0	DMAIF0	DMAMK0	0	0	0	DMAPR02	DMAPR01	DMAPR00
FFFFF152H	DMAIC1	DMAIF1	DMAMK1	0	0	0	DMAPR12	DMAPR11	DMAPR10
FFFFF154H	DMAIC2	DMAIF2	DMAMK2	0	0	0	DMAPR22	DMAPR21	DMAPR20
FFFFF156H	DMAIC3	DMAIF3	DMAMK3	0	0	0	DMAPR32	DMAPR31	DMAPR30
FFFFF158H	ROVIC	ROVIF	ROVMK	0	0	0	ROVPR2	ROVPR1	ROVPR0
FFFFF15AH	BRGIC	BRGIF	BRGMK	0	0	0	BRGPR2	BRGPR1	BRGPR0

Notes 1. μ PD703201Y, 703204Y, 70F3201Y, 70F30204Y only

2. V850ES/SA3 only

14.3.5 Interrupt mask registers 0 to 2 (IMR0 to IMR2)

These registers set the interrupt mask state for the maskable interrupts. The xxMKn bit of the IMR0 to IMR2 registers is equivalent to the xxMKn bit of the xxICn register.

The IMRm register can be read or written in 16-bit units (m = 0 to 2).

If the higher 8 bits of the IMRm register are used as an IMRmH register and the lower 8 bits as an IMRmL register, these registers can be read or written in 8-bit or 1-bit units (m = 0 to 2).

Bits 15 to 6 of the IMR2 register (bits 7 to 0 of the IMR2H register and bits 7 and 6 of the IMR2L register) are fixed to 1. If these bits are not 1, the operation cannot be guaranteed.

Caution The device file defines the xxMKn bit of the xxICn register as a reserved word. If a bit is manipulated using the name of xxMKn, the contents of the xxICn register, instead of the IMRm register, are rewritten (as a result, the contents of the IMRm register are also rewritten).

After reset: FFFFH R/W Address: FFFFF104H

	15	14	13	12	11	10	9	8
IMR2	1	1	1	1	1	1	1	1
	7	6	5	4	3	2	1	0
	1	1	BRGMK	OVFMK	DMAMK3	DMAMK2	DMAMK1	DMAMK0

After reset: FFFFH R/W Address: FFFFF102H

	15	14	13	12	11	10	9	8
IMR1	ADMK	CSIMK4 ^{Note}	CSIMK3	STMK1	SRMK1	SREMK1	CSIMK2	STMK0
	7	6	5	4	3	2	1	0
	SRMK0	SREMK0	CSIMK1	IICMK	CSIMK0	TMMK5	TMMK4	TMMK3

After reset: FFFFH R/W Address: FFFFF100H

	15	14	13	12	11	10	9	8
IMR0	TMMK2	OVFMK1	CCMK11	CCMK10	OVFMK0	CCMK01	CCMK00	RTCMK
	7	6	5	4	3	2	1	0
	PMK6	PMK5	PMK4	PMK3	PMK2	PMK1	PMK0	WDTMK

xxMKn	Interrupt mask flag setting
0	Interrupt servicing enabled
1	Interrupt servicing disabled

Note This bit is valid only for the V850ES/SA3. In the V850EA/SA2, be sure to set this bit to 1.

Remark xx: Identification name of each peripheral unit (AD, BRG, CC, CSI, DMA, IIC, OVF, D, ROV, RTC, SRE, ST, TM, WDT).

n: Peripheral unit number (None, or 0 to 3)

14.3.6 In-service priority register (ISPR)

This register holds the priority level of the maskable interrupt currently acknowledged. When an interrupt request is acknowledged, the bit of this register corresponding to the priority level of that interrupt request is set to 1 and remains set while the interrupt is serviced.

When the RETI instruction is executed, the bit corresponding to the interrupt request having the highest priority is automatically reset to 0 by hardware. However, it is not reset to 0 when execution is returned from non-maskable interrupt servicing or exception processing.

This register is read-only in 8-bit or 1-bit units.

After reset: 00H R Address: FFFFF1FAH

	<7>	<6>	<5>	<4>	<3>	<2>	<1>	<0>
ISPR	ISPR7	ISPR6	ISPR5	ISPR4	ISPR3	ISPR2	ISPR1	ISPR0

ISPRn	Priority of interrupt currently acknowledged
0	Interrupt request with priority n not acknowledged
1	Interrupt request with priority n acknowledged

Remark n = 0 to 7 (priority level)

14.3.7 Maskable interrupt status flag

This flag controls the maskable interrupt's operating state, and stores control information regarding enabling or disabling of interrupt requests. An interrupt disable flag (ID) is incorporated, which is assigned to the PSW.

After reset: 00000020H

	31	8	7	6	5	4	3	2	1	0				
PSW	0						NP	EP	ID	SAT	CY	OV	S	Z

ID	Maskable interrupt servicing specification ^{Note}
0	Maskable interrupt request acknowledgement enabled
1	Maskable interrupt request acknowledgement disabled (pending)

Note Interrupt disable flag (ID) function

This bit is set to 1 by the DI instruction and reset to 0 by the EI instruction. Its value is also modified by the RETI instruction or LDSR instruction when referencing the PSW.

Non-maskable interrupt requests and exceptions are acknowledged regardless of this flag. When a maskable interrupt is acknowledged, the ID flag is automatically set to 1 by hardware.

The interrupt request generated during the acknowledgement disabled period (ID = 1) is acknowledged when the xxIFn bit of xxICn is set to 1, and the ID flag is reset to 0.

14.3.8 Watchdog timer mode register (WDTM)

This register is a special register and can be written only in a specific sequence. To generate a maskable interrupt (INTWDT), clear the WDTM4 bit of this register to 0.

This register can be read or written in 8-bit or 1-bit units (for details, refer to **CHAPTER 9 WATCHDOG TIMER FUNCTION**).

After reset: 00H		R/W	Address: FFFFF6C2H					
	<7>	6	5	4	3	2	1	0
WDTM	RUN	0	0	WDTM4	WDTM3	0	0	0
	RUN	Watchdog timer operation mode selection ^{Note 1}						
	0	Stops counting.						
	1	Clears counter and starts counting.						
	WDTM4	WDTM3	Watchdog timer operation mode selection ^{Note 2}					
	0	0	Interval timer mode					
	0	1	(Maskable interrupt INTWDTM occurs if overflow occurs.)					
	1	0	Watchdog timer mode 1 (Non-maskable interrupt INTWDT occurs if overflow occurs.)					
	1	1	Watchdog timer mode 2 (Reset operation WDTRES is started if overflow occurs.)					

14.3.9 Eliminating noise on INTP0 to INTP6 pins

The INTP0 to INTP6 pins have a noise eliminator that eliminates noise using analog delay. Unless the level input to each pin is held for a specific time, therefore, it cannot be detected as a signal edge i.e., the edge is detected after specific time.

14.3.10 Function to detect edge of INTP0 to INTP6 pins

The valid edge of the INTP0 to INTP6 pins can be selected from the following four.

- Rising edge
- Falling edge
- Both edges
- No edge detection

(1) External interrupt rising edge specification register 0 (INTR0)

This is an 8-bit register that specifies detection of the rising edge of the INTP0 to INTP4 pins. This register can be read or written in 8-bit or 1-bit units.

Caution When the function is changed from the external interrupt function (alternate function) to the port function, an edge may be detected. Therefore, clear INTF0n and INTR0n to 0, and then set the port mode.

After reset: 00H	R/W	Address: FFFFC20H								
			7	6	5	4	3	2	1	0
INTR0	0	0	INTR05	INTR04	INTR03	INTR02	INTR01	INTR00		

Remark For how to specify a valid edge, refer to **Table 14-4**.

(2) External interrupt falling edge specification register 0 (INTF0)

This is an 8-bit register that specifies detection of the falling edge of the INTP0 to INTP4 pins. This register can be read or written in 8-bit or 1-bit units.

Caution When the function is changed from the external interrupt function (alternate function) to the port function, an edge may be detected. Therefore, clear INTF0n and INTR0n to 0, and then set the port mode.

After reset: 00H	R/W	Address: FFFFC00H								
			7	6	5	4	3	2	1	0
INTF0	0	0	INTF05	INTF04	INTF03	INTF02	INTF01	INTF00		

Remark For how to specify a valid edge, refer to **Table 14-4**.

Table 14-4. Valid Edge Specification

INTF0n	INTR0n	Valid Edge Specification (n = 1 to 5)
0	0	No edge detected
0	1	Rising edge
1	0	Falling edge
1	1	Both edges

Remark n = 1 to 5: Control of INTP0 to INTP4 pins

(3) External interrupt rising edge specification register 9 (INTR9)

This is an 8-bit register that specifies detection of the rising edge of the INTP5 and INTP6 pins.

This register can be read or written in 16-bit units. When the lower 8 bits of the INTR9 register are used as INTR9L register, however, it can be read or written in 8-bit or 1-bit units.

Caution When the function is changed from the external interrupt function (alternate function) to the port function, an edge may be detected. Therefore, clear INTF9n and INTR9n to 0, and then set the port mode.

After reset: 0000H R/W Address: INTR9: FFFFFFFC32H, INTR9L: FFFFFFFC32H

	15	14	13	12	11	10	9	8
INTR9	0	0	0	0	0	0	0	0
	7	6	5	4	3	2	1	0
	0	0	0	0	INTR93	INTR92	0	0

Remark For how to specify a valid edge, refer to Table 14-5.

(4) External interrupt falling edge specification register 9 (INTF9)

This is an 8-bit register that specifies detection of the falling edge of the INTP5 and INTP6 pins.

This register can be read or written in 16-bit units. When the lower 8 bits of the INTF9 register are used as INTF9L register, however, it can be read or written in 8-bit or 1-bit units.

Caution When the function is changed from the external interrupt function (alternate function) to the port function, an edge may be detected. Therefore, clear INTF9n and INTR9n to 0, and then set the port mode.

After reset: 0000H R/W Address: INTF9: FFFFFFFC12H, INTF9L: FFFFFFFC12H

	15	14	13	12	11	10	9	8
INTF9	0	0	0	0	0	0	0	0
	7	6	5	4	3	2	1	0
	0	0	0	0	INTF93	INTF92	0	0

Remark For how to specify a valid edge, refer to Table 14-5.

Table 14-5. Valid Edge Specification

INTF9n	INTR9n	Valid Edge Specification (n = 2, 3)
0	0	No edge detected
0	1	Rising edge
1	0	Falling edge
1	1	Both edges

Remark n = 2, 3: Control of INTP5 and INTP6 pins

14.4 Software Exception

A software exception is generated when the CPU executes the TRAP instruction, and can always be acknowledged.

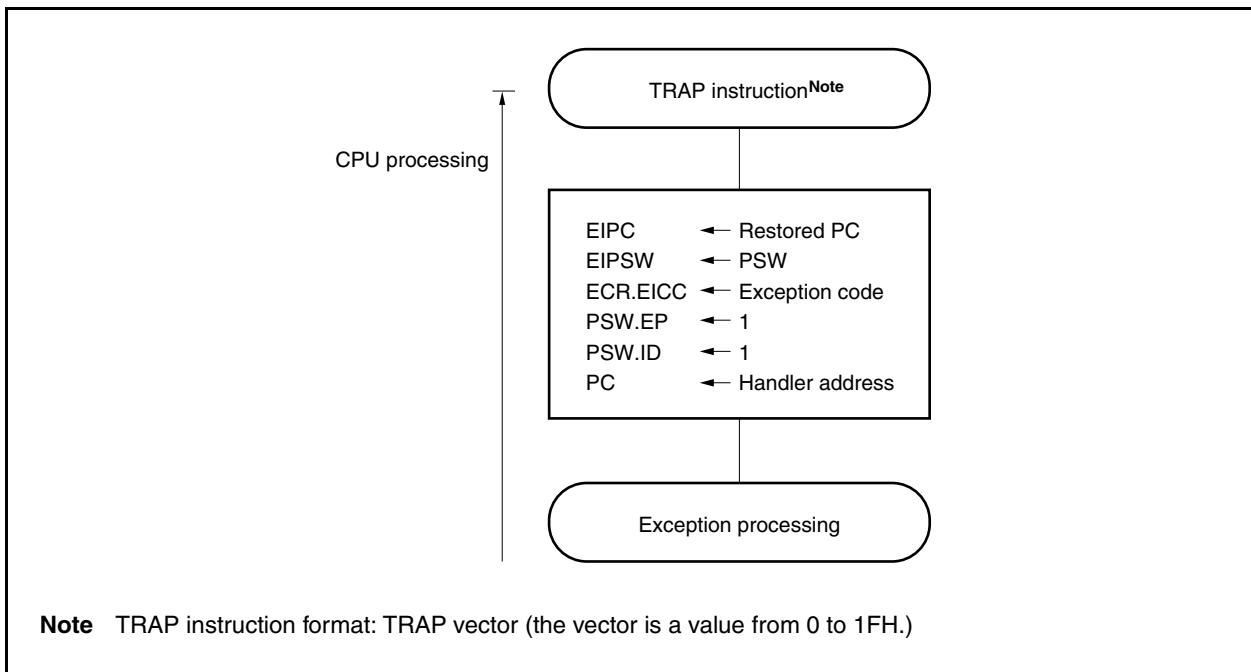
14.4.1 Operation

If a software exception occurs, the CPU performs the following processing, and transfers control to the handler routine.

- <1> Saves the restored PC to EIPC.
- <2> Saves the current PSW to EIPSW.
- <3> Writes an exception code to the lower 16 bits (EICC) of ECR (interrupt source).
- <4> Sets the EP and ID bits of the PSW.
- <5> Sets the handler address (00000040H or 00000050H) corresponding to the software exception to the PC, and transfers control.

Figure 14-8 illustrates the processing of a software exception.

Figure 14-8. Software Exception Processing



The handler address is determined by the TRAP instruction's operand (vector). If the vector is 0 to 0FH, it becomes 00000040H, and if the vector is 10H to 1FH, it becomes 00000050H.

14.4.2 Restore

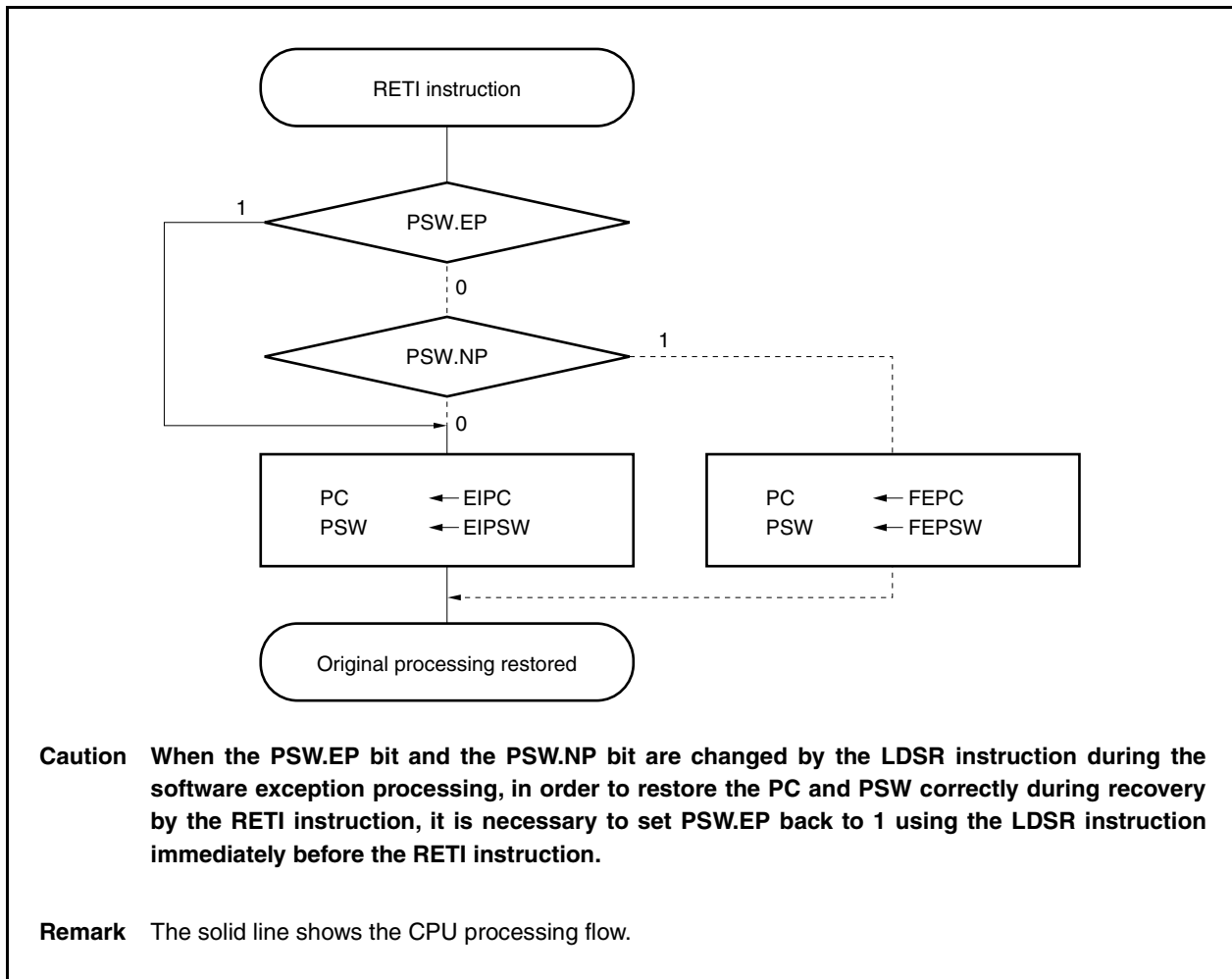
Recovery from software exception processing is carried out by the RETI instruction.

By executing the RETI instruction, the CPU carries out the following processing and shifts control to the restored PC's address.

- <1> Loads the restored PC and PSW from EIPC and EIPSW because the EP bit of the PSW is 1.
- <2> Transfers control to the address of the restored PC and PSW.

Figure 14-9 illustrates the processing of the RETI instruction.

Figure 14-9. RETI Instruction Processing



14.4.3 Exception status flag (EP)

The EP flag is bit 6 of the PSW, and is a status flag used to indicate that exception processing is in progress. It is set when an exception occurs.

After reset: 00000020H

	31		8	7	6	5	4	3	2	1	0	
PSW	0				NP	EP	ID	SAT	CY	OV	S	Z

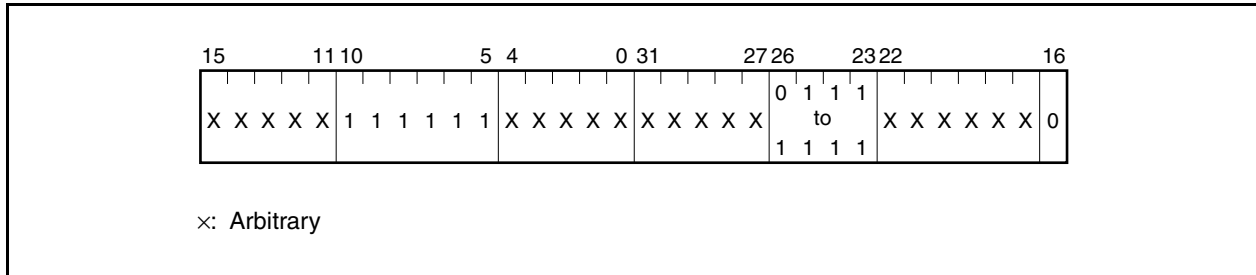
EP	Exception processing status
0	Exception processing not in progress.
1	Exception processing in progress.

14.5 Exception Trap

An exception trap is an interrupt that is requested when the illegal execution of an instruction takes place. In the V850ES/SA2 and V850ES/SA3, an illegal opcode exception (ILGOP: Illegal Opcode Trap) is considered as an exception trap.

14.5.1 Illegal opcode definition

The illegal instruction has an opcode (bits 10 to 5) of 111111B, a sub-opcode (bits 26 to 23) of 0111B to 1111B, and a sub-opcode (bit 16) of 0B. An exception trap is generated when an instruction applicable to this illegal instruction is executed.



Caution Since it is possible to assign this instruction to an illegal opcode in the future, it is recommended that it not be used.

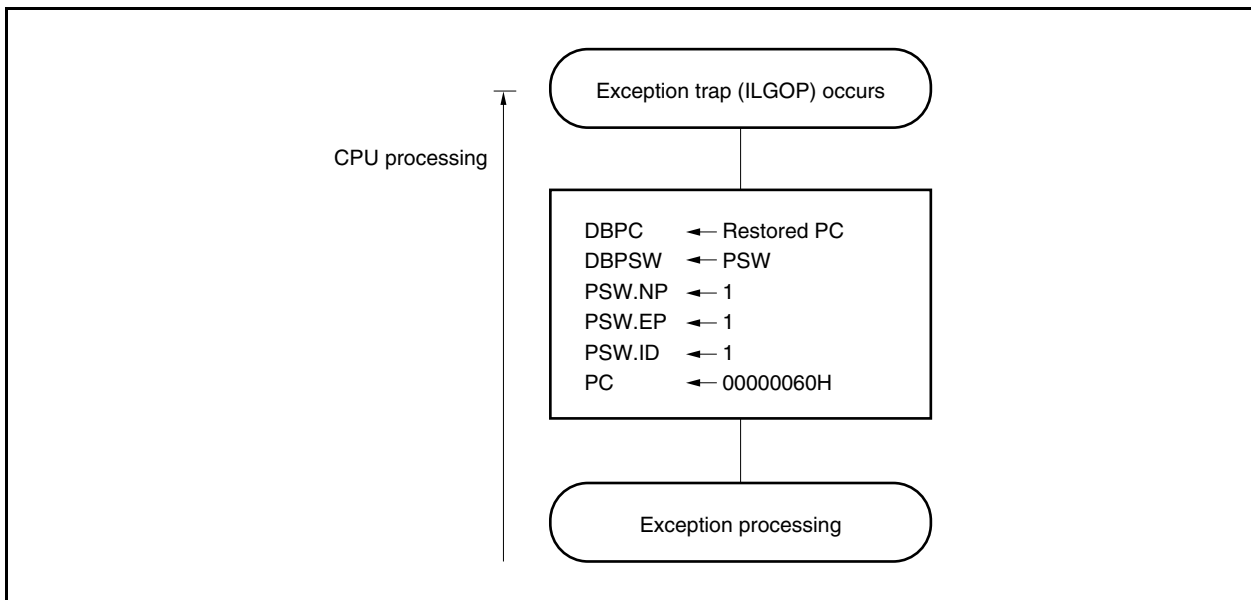
(1) Operation

If an exception trap occurs, the CPU performs the following processing, and transfers control to the handler routine.

- <1> Saves the restored PC to DBPC.
- <2> Saves the current PSW to DBPSW.
- <3> Sets the NP, EP, and ID bits of the PSW.
- <4> Sets the handler address (00000060H) corresponding to the exception trap to the PC, and transfers control.

Figure 14-10 illustrates the processing of the exception trap.

Figure 14-10. Exception Trap Processing



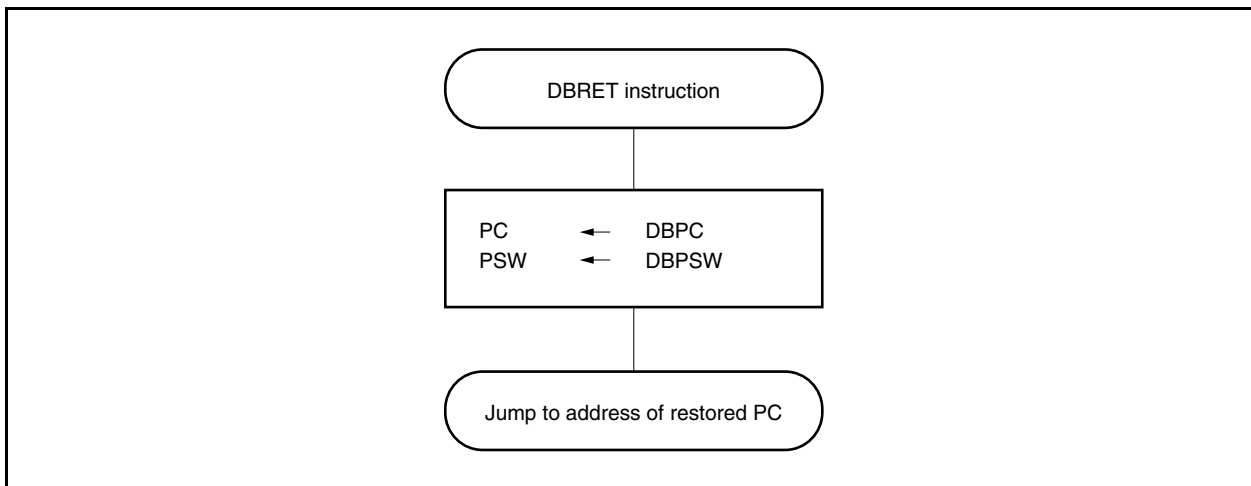
(2) Restore

Recovery from an exception trap is carried out by the DBRET instruction. By executing the DBRET instruction, the CPU carries out the following processing and controls the address of the restored PC.

- <1> Loads the restored PC and PSW from DBPC and DBPSW.
- <2> Transfers control to the address indicated by the restored PC and PSW.

Figure 14-11 illustrates the restore processing from an exception trap.

Figure 14-11. Restore Processing from Exception Trap

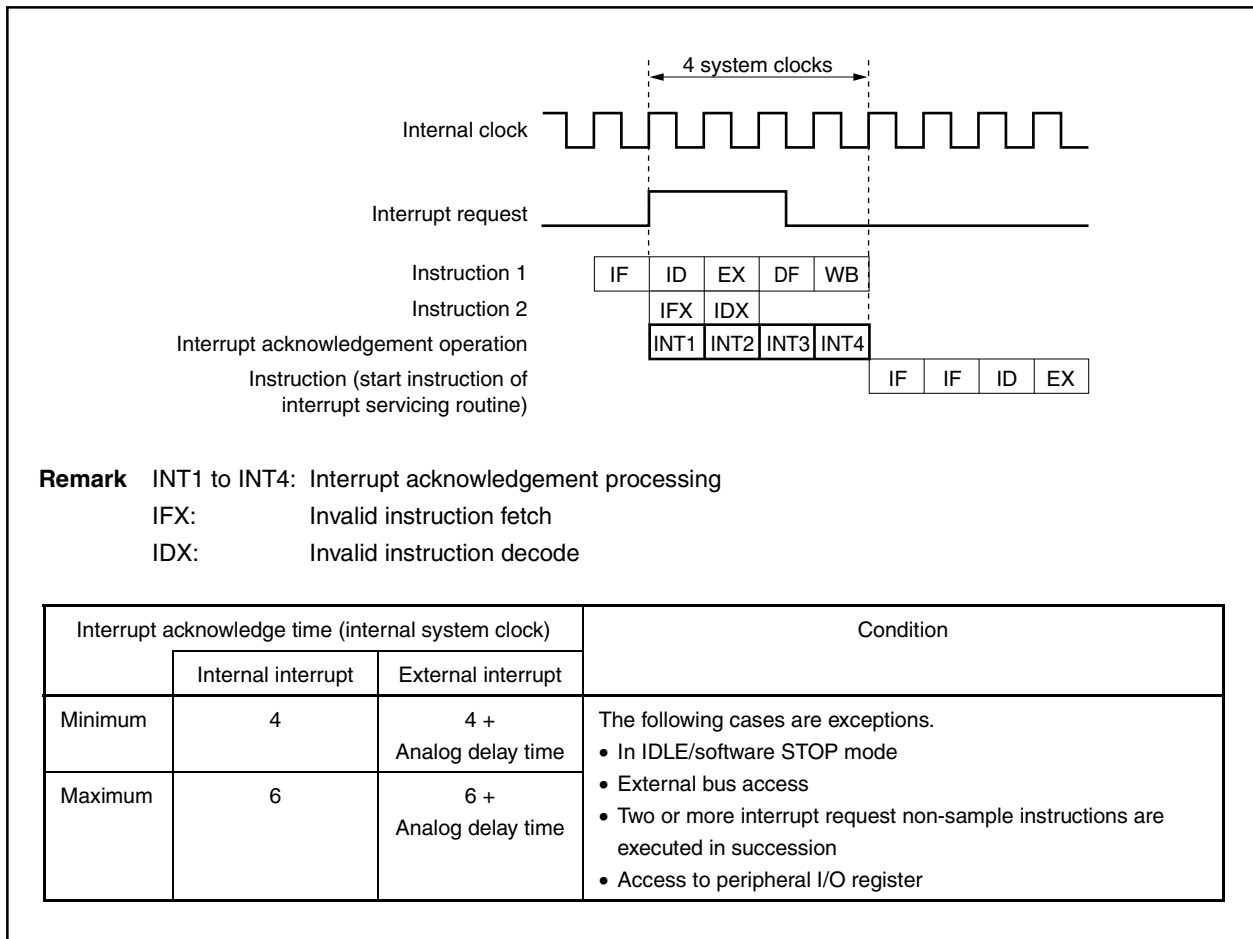


14.6 Interrupt Acknowledge Time of CPU

Except the following cases, the interrupt acknowledge time of the CPU is 5 clocks minimum. To input interrupt requests successively, input the next interrupt at least 5 clocks after the preceding interrupt.

- In software/hardware STOP mode
- When the external bus is accessed
- When interrupt request non-sampling instructions are successively executed (Refer to 14.7 Periods in Which Interrupts Are Not Acknowledged.)
- When the interrupt control register is accessed

Figure 14-12. Pipeline Operation at Interrupt Request Acknowledgement (Outline)



14.7 Periods in Which Interrupts Are Not Acknowledged by CPU

An interrupt is acknowledged by the CPU while an instruction is being executed. However, no interrupt will be acknowledged between an interrupt request non-sample instruction and the next instruction (interrupt is held pending).

The interrupt request non-sample instructions are as follows.

- EI instruction
- DI instruction
- LDSR reg2, 0x5 instruction (for PSW)
- The store instruction for the command register (PRCMD)
- The load, store, or bit manipulation instructions for the following interrupt-related registers.
Interrupt control register (xxICn), interrupt mask registers 0 to 2 (IMR0 to IMR2), in-service priority register (ISPR)

CHAPTER 15 STANDBY FUNCTION

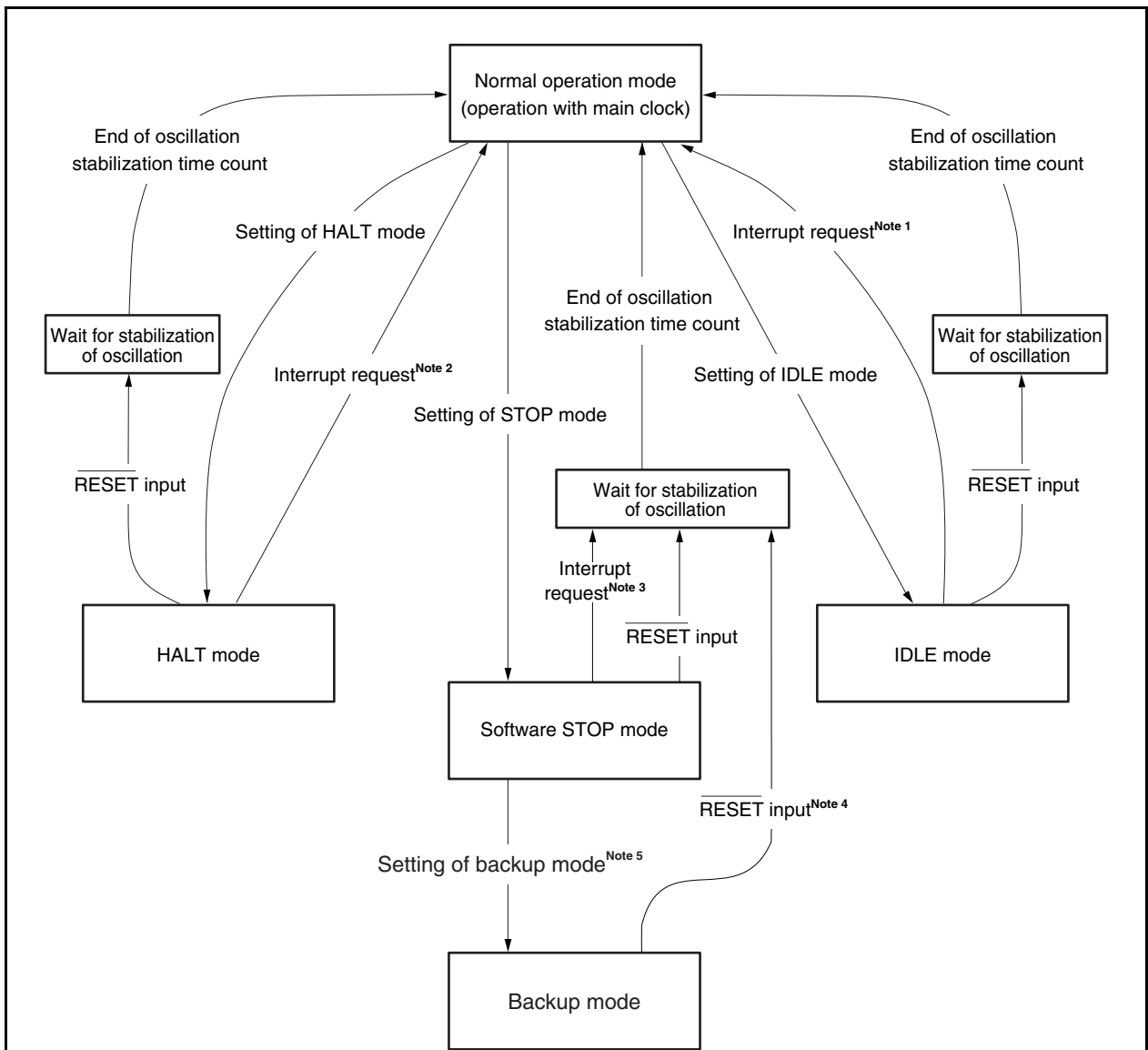
15.1 Overview

The power consumption of the system can be effectively reduced by using the standby modes in combination and selecting the appropriate mode for the application. The available standby modes are listed in Table 15-1.

Table 15-1. Standby Modes

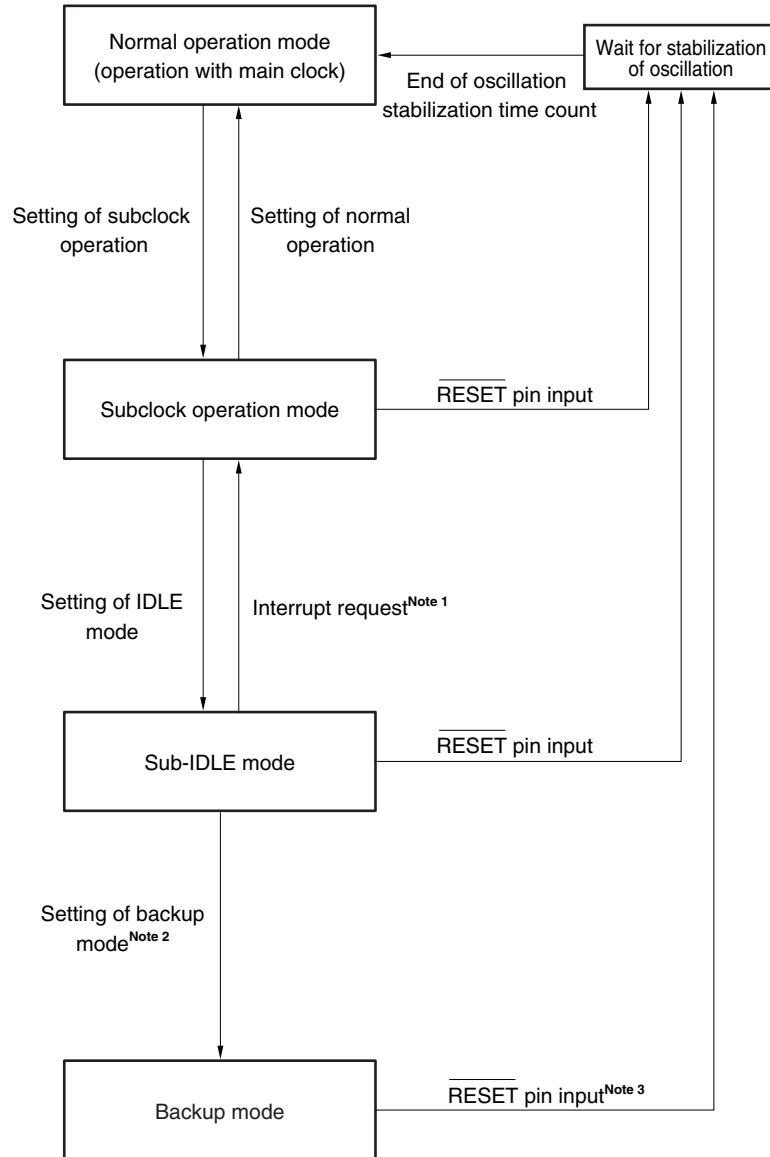
Mode	Functional Outline
HALT mode	Mode to stop only the operating clock of the CPU
IDLE mode	Mode to stop all the internal operations of the chip except the oscillator
Software STOP mode	Mode to stop all the internal operations of the chip except the subclock oscillator
Subclock operation mode	Mode to use the subclock as the internal system clock
Sub-IDLE mode	Mode to stop all the internal operations of the chip, except the oscillator, in the subclock operation mode
Backup mode	Mode to turn off the power supplied to the internal circuitry except the subclock oscillator, RTC, and internal RAM

Figure 15-1. Status Transition



- Notes 1.** Non-maskable interrupt request (NMI pin input), unmasked external interrupt request (INTP0 to INTP6 pin input), or unmasked internal interrupt request from peripheral functions operable in IDLE mode.
- 2.** Non-maskable interrupt request, unmasked maskable interrupt request, or reset input by WDT overflow.
- 3.** Non-maskable interrupt request (NMI pin input), unmasked external interrupt request (INTP0 to INTP6 pin input), or unmasked internal interrupt request from peripheral functions operable in software STOP mode.
- 4.** Make the $\overline{\text{RESET}}$ pin high after supplying and stabilizing power other than backup power.
- 5.** Turn off power other than backup power after inputting a low level to the $\overline{\text{RESET}}$ pin.

Figure 15-2. Status Transition (During Subclock Operation)



Notes 1. Non-maskable interrupt request (NMI pin input), unmasked external interrupt request (INTP0 to INTP6 pin input), or unmasked internal interrupt request from peripheral functions operable in sub-IDLE mode.

2. Turn off power other than backup power after inputting a low level to the $\overline{\text{RESET}}$ pin.

3. Make the $\overline{\text{RESET}}$ pin high after supplying and stabilizing power other than backup power.

15.2 HALT Mode

15.2.1 Setting and operation status

The HALT mode is set when a dedicated instruction (HALT) is executed in the normal operation mode.

In the HALT mode, the clock oscillator continues operating. Only clock supply to the CPU is stopped; clock supply to the other on-chip peripheral functions continues.

As a result, program execution is stopped, and the internal RAM retains the contents before the HALT mode was set. The on-chip peripheral functions that are independent of instruction processing by the CPU continue operating.

Table 15-3 shows the operation status in the HALT mode.

The average power consumption of the system can be reduced by using the HALT mode in combination with the normal operation mode for intermittent operation.

Caution Insert five or more NOP instructions after the HALT instruction.

15.2.2 Releasing HALT mode

The HALT mode is released by a non-maskable interrupt request, an unmasked maskable interrupt request, and $\overline{\text{RESET}}$ pin input.

After the HALT mode has been released, the normal operation mode is restored.

(1) Releasing HALT mode by non-maskable interrupt request or unmasked maskable interrupt request

The HALT mode is released by a non-maskable interrupt request or an unmasked maskable interrupt request, regardless of the priority of the interrupt request. If the HALT mode is set in an interrupt servicing routine, however, an interrupt request that is issued later is serviced as follows.

- (a) If an interrupt request with a priority lower than that of the interrupt request currently being serviced is issued, only the HALT mode is released, and that interrupt request is not acknowledged. The interrupt request itself is retained.
- (b) If an interrupt request with a priority higher than that of the interrupt request currently being serviced is issued (including a non-maskable interrupt request), the HALT mode is released and that interrupt request is acknowledged.

Table 15-2. Operation After Releasing HALT Mode by Interrupt Request

Release Source	Interrupt Enabled (EI) Status	Interrupt Disabled (DI) Status
Non-maskable interrupt request	Execution branches to the handler address	
Maskable interrupt request	Execution branches to the handler address or the next instruction is executed	The next instruction is executed

(2) Releasing HALT mode by RESET pin input

The same operation as the normal reset operation is performed.

Table 15-3. Operation Status in HALT Mode

Setting of HALT Mode		Operation Status	
		When Subclock Is Not Used	When Subclock Is Used
Main clock oscillator		Oscillation enabled	
Subclock oscillator		–	Oscillation enabled
CPU		Stops operation	
DMA		Operable	
Interrupt controller		Operable	
ROM correction		Stops operation	
16-bit timer/event counters (TM0, TM1)		Operable	
8-bit timer/event counters (TM2 to TM5)		Operable	
Real-timer counter		Operable when divided f _x /BRG output is selected as count clock	Operable
Watchdog timer		Operable	
Serial interface	CSI0 to CSI4	Operable	
	I ² C ^{Note}	Operable	
	UART0, UART1	Operable	
A/D converter		Operable	
D/A converter		Operable	
External bus interface		Refer to CHAPTER 5 BUS CONTROL FUNCTION .	
Port function		Retains status before HALT mode was set.	
Internal data		The CPU registers, statuses, data, and all other internal data such as the contents of the internal RAM are retained as they were before the HALT mode was set.	

Note μ PD703201Y, 703204Y, 70F3201Y, and 70F3204Y only

15.3 IDLE Mode

15.3.1 Setting and operation status

The IDLE mode is set by clearing the PSM bit of the power save mode register (PSMR) to 0 and setting the STP bit of the power save control register (PSC) to 1 in the normal operation mode.

In the IDLE mode, the clock oscillator continues operation but clock supply to the CPU and other on-chip peripheral functions stops.

As a result, program execution stops and the contents of the internal RAM before the IDLE mode was set are retained. The CPU and other on-chip peripheral functions stop operating. However, the on-chip peripheral functions that can operate with the subclock or an external clock continue operating.

Table 15-5 shows the operation status in the IDLE mode.

The IDLE mode can reduce the current consumption more than the HALT mode because it stops the operation of the on-chip peripheral functions. The main clock oscillator does not stop, so the normal operation mode can be restored without waiting for the oscillation stabilization time after the IDLE mode has been released, in the same manner as when the HALT mode is released.

Caution Insert five or more NOP instructions after the instruction that stores data in the PSC register to set the IDLE mode.

15.3.2 Releasing IDLE mode

The IDLE mode is released by a non-maskable interrupt request (NMI pin input), unmasked external interrupt request (INTP0 to INTP6 pin input), unmasked internal interrupt request from the peripheral functions operable in the IDLE mode, or $\overline{\text{RESET}}$ input.

After the IDLE mode has been released, the normal operation mode is restored.

(1) Releasing IDLE mode by non-maskable interrupt request or unmasked maskable interrupt request

The IDLE mode is released by a non-maskable interrupt request or an unmasked maskable interrupt request, regardless of the priority of the interrupt request. If the IDLE mode is set in an interrupt servicing routine, however, an interrupt request that is issued later is processed as follows.

- (a) If an interrupt request with a priority lower than that of the interrupt request currently being serviced is issued, only the IDLE mode is released, and that interrupt request is not acknowledged. The interrupt request itself is retained.
- (b) If an interrupt request with a priority higher than that of the interrupt request currently being serviced is issued (including a non-maskable interrupt request), the IDLE mode is released and that interrupt request is acknowledged.

Table 15-4. Operation After Releasing IDLE Mode by Interrupt Request

Release Source	Interrupt Enabled (EI) Status	Interrupt Disabled (DI) Status
Non-maskable interrupt request	Execution branches to the handler address	
Maskable interrupt request	Execution branches to the handler address or the next instruction is executed	The next instruction is executed

(2) Releasing IDLE mode by $\overline{\text{RESET}}$ pin input

The same operation as the normal reset operation is performed.

Table 15-5. Operation Status in IDLE Mode

Setting of IDLE Mode		Operation Status	
		When Subclock Is Not Used	When Subclock Is Used
Main clock oscillator		Oscillation enabled	
Subclock oscillator		–	Oscillation enabled
CPU		Stops operation	
DMA		Stops operation	
Interrupt controller		Stops operation	
ROM correction		Stops operation	
16-bit timer/event counters (TM0, TM1)		Stops operation	
8-bit timer/event counters (TM2 to TM5)		Stops operation	
Real-time counter		Operable when divided f_x/BRG output is selected as count clock	Operable
Watchdog timer		Stops operation	
Serial interface	CSI0 to CSI4	Operable when $\overline{\text{SCKn}}$ input clock is selected as operation clock ($n = 0$ to 4)	
	$\text{I}^2\text{C}^{\text{Note}}$	Stops operation	
	UART0, UART1	Stops operation	
A/D converter		Operable when f_{BRG} is selected as operation clock	
D/A converter		Operable	
External bus interface		Refer to CHAPTER 5 BUS CONTROL FUNCTION .	
Port function		Retains status before IDLE mode was set.	
Internal data		The CPU registers, statuses, data, and all other internal data such as the contents of the internal RAM are retained as they were before the IDLE mode was set.	

Note $\mu\text{PD703201Y}$, $703204Y$, $70F3201Y$, and $70F3204Y$ only

15.4 Software STOP Mode

15.4.1 Setting and operation status

The software STOP mode is set when the PSMR bit of the PSMR register is set to 1 and the STP bit of the PSC register is set to 1 in the normal operation mode.

In the software STOP mode, the subclock oscillator continues operating but the main clock oscillator stops. Clock supply to the CPU and the on-chip peripheral functions is stopped.

As a result, program execution is stopped, and the contents of the internal RAM before the software STOP mode was set are retained. The on-chip peripheral functions that operate with the clock oscillated by the subclock oscillator or an external clock continue operating.

Table 15-7 shows the operation status in the software STOP mode.

Because the software STOP stops operation of the main clock oscillator, it reduces the current consumption to a level lower than the IDLE mode. If the subclock oscillator and external clock are not used, the power consumption can be minimized with only leakage current flowing.

Caution Insert five or more NOP instructions after the instruction that stores data in the PSC register to set the software STOP mode.

15.4.2 Releasing software STOP mode

The software STOP mode is released by a non-maskable interrupt request (NMI pin input), unmasked external interrupt request (INTP0 to INTP6 pin input), unmasked internal interrupt request from the peripheral functions operable in the software STOP mode, or $\overline{\text{RESET}}$ pin input.

After the software STOP mode has been released, the normal operation mode is restored after the oscillation stabilization time has been secured.

(1) Releasing software STOP mode by non-maskable interrupt request or unmasked maskable interrupt request

The software STOP mode is released by a non-maskable interrupt request or an unmasked maskable interrupt request, regardless of the priority of the interrupt request. If the software STOP mode is set in an interrupt servicing routine, however, an interrupt request that is issued later is serviced as follows.

- (a) If an interrupt request with a priority lower than that of the interrupt request currently being serviced is issued, only the software STOP mode is released, and that interrupt request is not acknowledged. The interrupt request itself is retained.
- (b) If an interrupt request with a priority higher than that of the interrupt request currently being serviced is issued (including a non-maskable interrupt request), the software STOP mode is released and that interrupt request is acknowledged.

Table 15-6. Operation After Releasing Software STOP Mode by Interrupt Request

Release Source	Interrupt Enabled (EI) Status	Interrupt Disabled (DI) Status
Non-maskable interrupt request	Execution branches to the handler address	
Maskable interrupt request	Execution branches to the handler address or the next instruction is executed	The next instruction is executed

(2) Releasing software STOP mode by $\overline{\text{RESET}}$ pin input

The same operation as the normal reset operation is performed.

Table 15-7. Operation Status in Software STOP Mode

Setting of Software STOP Mode Item		Operation Status	
		When Subclock Is Not Used	When Subclock Is Used
Main clock oscillator		Stops operation	
Subclock oscillator		–	Oscillation enabled
CPU		Stops operation	
DMA		Stops operation	
Interrupt controller		Stops operation	
ROM correction		Stops operation	
16-bit timer/event counters (TM0, TM1)		Stops operation	
8-bit timer/event counters (TM2 to TM5)		Stops operation	
Real-time counter		Stops operation	Operable when f_{XT} is selected as count clock
Watchdog timer		Stops operation	
Serial interface	CSI0 to CSI4	Operable when $\overline{\text{SCKn}}$ input clock is selected as operation clock ($n = 0$ to 4)	
	I^2C ^{Note}	Stops operation	
	UART1, UART1	Stops operation	
A/D converter		Stops operation	
D/A converter		Stops operation	
External bus interface		Refer to CHAPTER 5 BUS CONTROL FUNCTION .	
Port function		Retains status before software STOP mode was set.	
Internal data		The CPU registers, statuses, data, and all other internal data such as the contents of the internal RAM are retained as they were before the software STOP mode was set.	

Note $\mu\text{PD703201Y}$, $703204Y$, $70F3201Y$, and $70F3204Y$ only

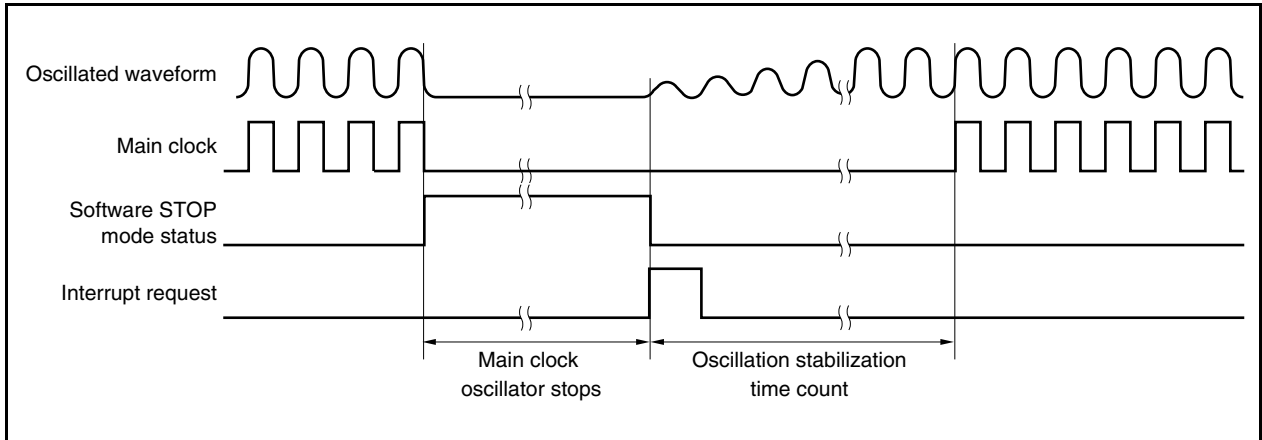
15.5 Securing Oscillation Stabilization Time

When the software STOP mode is released, only the oscillation stabilization time set by the OSTS register elapses. If the software STOP mode has been released by $\overline{\text{RESET}}$ pin input, however, the reset value of the OSTS register, $2^{19}/f_x$ elapses.

The timer for counting the oscillation stabilization time is shared with watchdog timer, so the oscillation stabilization time equal to the overflow time of the watchdog timer elapses.

Figure 15-3 shows the operation performed when the software STOP mode is released by an interrupt request.

Figure 15-3. Oscillation Stabilization Time



Caution For details of the OSTS register, refer to 9.1.3 (1) Oscillation stabilization time selection register (OSTS).

15.6 Subclock Operation Mode

15.6.1 Setting and operation status

The subclock operation mode is set when the CK3 bit of the processor clock control register (PCC) is set to 1 in the normal operation mode.

When the subclock operation mode is set, the internal system clock is changed from the main clock to the subclock.

When the MCK bit of the PCC register is set to 1, the operation of the main clock oscillator is stopped. As a result, the system operates only with the subclock. However, watchdog timer stops counting when subclock operation is started (CLS bit of PCC register = 1). (Watchdog timer retains the value before the subclock operation mode was set.)

In the subclock operation mode, the current consumption can be reduced to a level lower than in the normal operation mode because the subclock is used as the internal system clock. In addition, the current consumption can be further reduced to the level of the software STOP mode by stopping the operation of the main system clock oscillator.

Table 15-8 shows the operation status in subclock operation mode.

Caution When manipulating the CK3 bit, do not change the set values of the CK2 to CK0 bits of the PCC register (using a bit manipulation instruction to manipulate the bit is recommended). For details of the PCC register, refer to 6.3 (1) Processor clock control register (PCC).

15.6.2 Releasing subclock operation mode

The subclock operation mode is released by $\overline{\text{RESET}}$ pin input when the CK3 bit is cleared to 0. If the main clock is stopped (MCK bit = 1), set the MCK bit to 1, secure the oscillation stabilization time of the main clock by software, and clear the CK3 bit to 0.

The normal operation mode is restored when the subclock operation mode is released.

Caution When manipulating the CK3 bit, do not change the set values of the CK2 to CK0 bits (using a bit manipulation instruction to manipulate the bit is recommended). For details of the PCC register, refer to 6.3 (1) Processor clock control register (PCC).

Table 15-8. Operation Status in Subclock Operation Mode

Setting of Subclock Operation Mode Item		Operation Status	
		When Main Clock Is Oscillating	When Main Clock Is Stopped
Subclock oscillator		Oscillation enabled	
CPU		Operable	
DMA		Operable	
Interrupt controller		Operable	
ROM correction		Operable	
16-bit timer/event counters (TM0, TM1)		Stops operation	
8-bit timer/event counters (TM2 to TM5)		Stops operation	
Real-time counter		Operable	Operable when f _{XT} is selected as count clock
Watchdog timer		Stops operation	
Serial interface	CSI0 to CSI4	Operable	Operable when \overline{SCKn} input clock is selected as operation clock (n = 0 to 4)
	I ² C ^{Note}	Operable	Stops operation
	UART0, UART1	Operable	Stops operation
A/D converter		Operable	Stops operation
D/A converter		Operable	Stops operation
External bus interface		Operable	
Port function		Settable	
Internal data		Settable	

Note μ PD703201Y, 703204Y, 70F3201Y, and 70F3204Y only

15.7 Sub-IDLE Mode

15.7.1 Setting and operation status

The sub-IDLE mode is set when the PSM bit of the power save mode register (PSMR) is cleared to 0 and the STP bit of the power save control register (PSC) is set to 1 in the subclock operation mode.

In this mode, the clock oscillator continues operation but clock supply to the CPU and the other on-chip peripheral functions is stopped.

As a result, program execution is stopped and the contents of the internal RAM before the sub-IDLE mode was set are retained. The CPU and the other on-chip peripheral functions are stopped. However, the on-chip peripheral functions that can operate with the subclock or an external clock continue operating.

Because the sub-IDLE mode stops operation of the CPU and other on-chip peripheral functions, it can reduce the current consumption more than the subclock operation mode. If the sub-IDLE mode is set after the main clock has been stopped, the current consumption can be reduced to a level as low as that in the software STOP mode.

Table 15-10 shows the operation status in the sub-IDLE mode.

15.7.2 Releasing sub-IDLE mode

The sub-IDLE mode is released by a non-maskable interrupt request (NMI pin input), unmasked external interrupt request (INTP0 to INTP6 pin input), unmasked internal interrupt request from the peripheral functions operable in the sub-IDLE mode, or $\overline{\text{RESET}}$ pin input.

When the sub-IDLE mode is released by an interrupt request, the subclock operation mode is set. If it is released by $\overline{\text{RESET}}$ pin input, the normal operation mode is restored.

(1) Releasing sub-IDLE mode by non-maskable interrupt request or unmasked maskable interrupt request

The sub-IDLE mode is released by a non-maskable interrupt request or an unmasked maskable interrupt request, regardless of the priority of the interrupt request. If the sub-IDLE mode is set in an interrupt servicing routine, however, an interrupt request that is issued later is serviced as follows.

- (a) If an interrupt request with a priority lower than that of the interrupt request currently being serviced is issued, only the sub-IDLE mode is released, and that interrupt request is not acknowledged. The interrupt request itself is retained.
- (b) If an interrupt request with a priority higher than that of the interrupt request currently being serviced is issued (including a non-maskable interrupt request), the sub-IDLE mode is released and that interrupt request is acknowledged.

Table 15-9. Operation After Releasing Sub-IDLE Mode by Interrupt Request

Release Source	Interrupt Enabled (EI) Status	Interrupt Disabled (DI) Status
Non-maskable interrupt request	Execution branches to the handler address	
Maskable interrupt request	Execution branches to the handler address or the next instruction is executed	The next instruction is executed

(2) Releasing sub-IDLE mode by $\overline{\text{RESET}}$ pin input

The same operation as the normal reset operation is performed.

Table 15-10. Operation Status in Sub-IDLE Mode

Setting of Sub-IDLE Mode		Operation Status	
		When Main Clock Is Oscillating	When Main Clock Is Stopped
Subclock oscillator		Oscillation enabled	
CPU		Stops operation	
DMA		Stops operation	
Interrupt controller		Stops operation	
ROM correction		Stops operation	
16-bit timer/event counters (TM0, TM1)		Stops operation	
8-bit timer/event counters (TM2 to TM5)		Stops operation	
Real-timer counter		Operable	Operable when f_{XT} is selected as count clock
Watchdog timer		Stops operation	
Serial interface	CSI0 to CSI4	Operable when $\overline{\text{SCKn}}$ input clock is selected as operation clock (n = 0 to 4)	
	I^2C ^{Note}	Stops operation	
	UART0, UART1	Stops operation	
A/D converter		Stops operation	
D/A converter		Stops operation	
External bus interface		Refer to CHAPTER 5 BUS CONTROL FUNCTION .	
Port function		Retains status before sub-IDLE mode was set.	
Internal data		The CPU registers, statuses, data, and all other internal data such as the contents of the internal RAM are retained as they were before the sub-IDLE mode was set.	

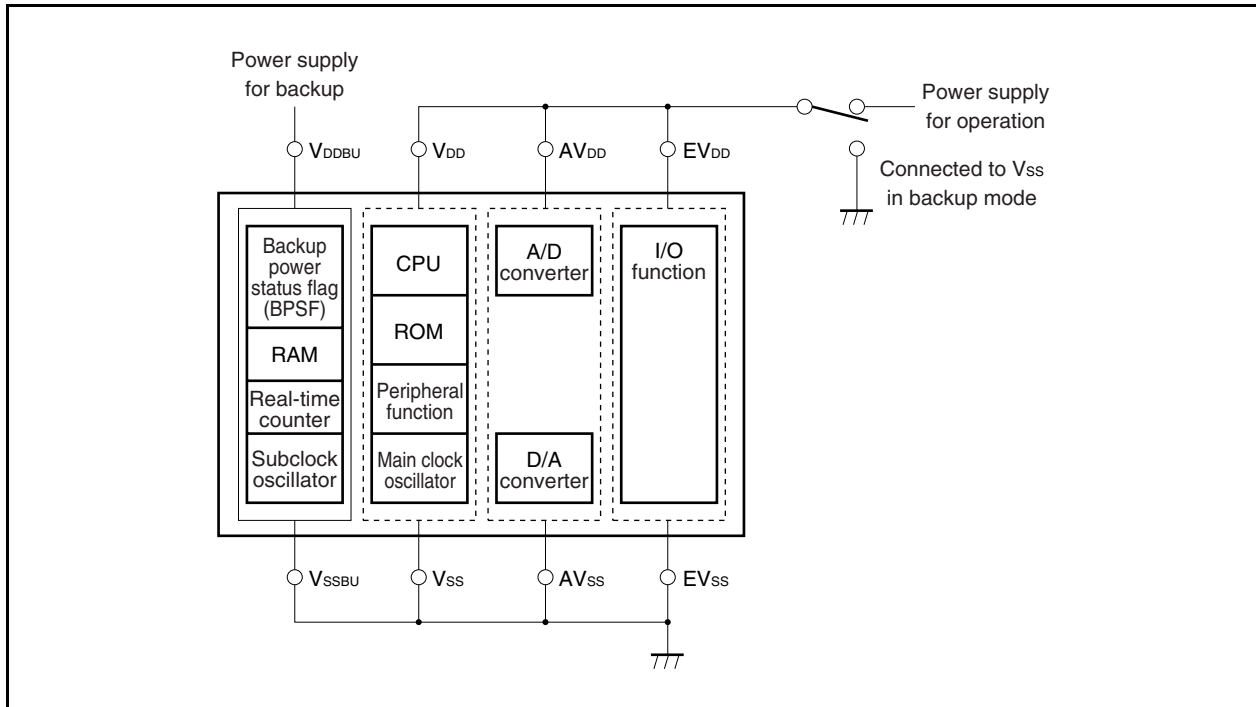
Note $\mu\text{PD703201Y}$, 703204Y , 70F3201Y , and 70F3204Y only

15.8 Backup Mode

The V850ES/SA2 and V850ES/SA3 can be placed in a backup mode by stopping power supply other than the backup power supply (V_{DDBU}) in the STOP mode.

The backup power supply supplies power only to the subclock oscillator, real-time counter, and internal RAM, as shown in Figure 15-4. All the other internal functions, including the CPU, cannot operate because the power supply is stopped.

Figure 15-4. Backup Mode



15.8.1 Setting and operation status

The backup mode is set by stopping power supply (0 V) other than the backup power supplies (V_{DDBU} and V_{SSBU}) after inputting a low level to the $\overline{\text{RESET}}$ pin in the software STOP mode.

The backup power supply is dedicated to the subclock oscillator, real-time counter, and internal RAM.

When the backup mode is set, power supply to the internal functions except the subclock oscillator, real-time counter, and internal RAM is stopped. As a result, only the real-time counter to which the subclock is supplied by the subclock oscillator continues operating, and all the other internal peripheral functions are stopped. The contents of the internal RAM before the backup mode is set are retained.

The operation procedure to set the backup mode is described below. Table 15-11 shows the operation status in the backup mode.

Cautions 1. If it is not necessary to operate the real-time counter while a voltage in the operating voltage range is supplied to V_{DDBU} , stop the subclock oscillator.

Even if the voltage on V_{DDBU} drops below the operable range, the contents of the internal RAM can be retained if the data retention voltage is maintained. A voltage drop on V_{DDBU} can be detected (i.e., whether the data of the internal RAM is valid or not) by a backup power status register (BPS) (refer to 15.9 (2)).

The BPSF bit of the BPS register is set if a change of potential greater than the data retention voltage is detected on V_{DDBU} ; it is cleared only by an instruction. To use this function, clear the BPSF bit to 0 before setting the backup mode.

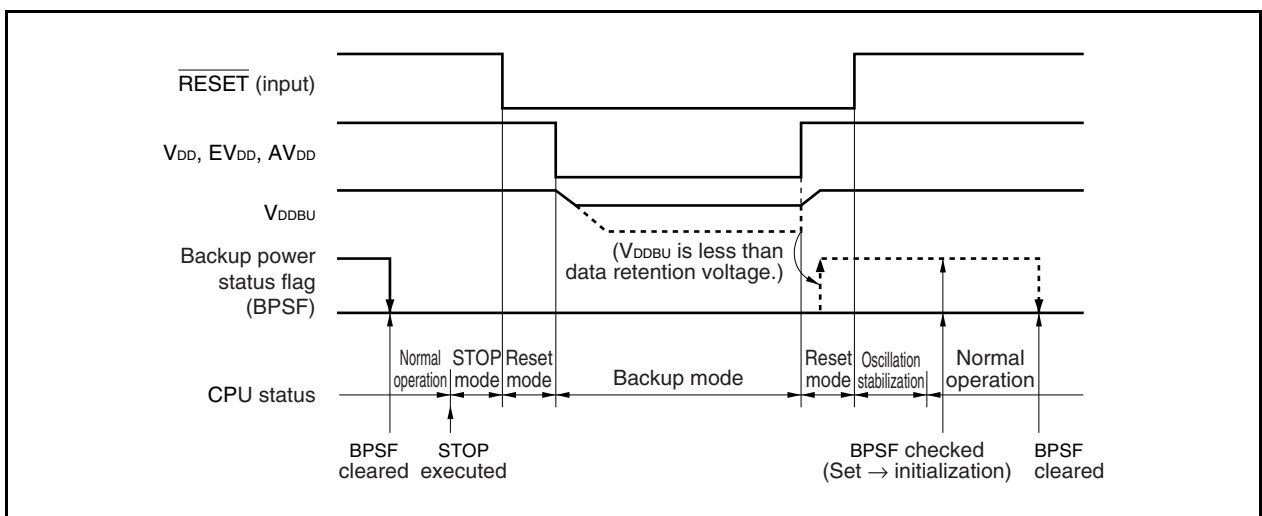
2. To set the backup mode, set V_{DDBU} as follows, depending on the main clock frequency.

- $V_{DDBU} = 2.2 \text{ V}$ or more ($f_{\text{xx}} = 17 \text{ MHz}$)

<Example of setting backup mode>

- <1> Clear the BPSF flag of the BPS register.
- <2> Set the software STOP mode.
- <3> Input a low level to the $\overline{\text{RESET}}$ pin.
- <4> Stop power supplies other than the backup power supply.

Figure 15-5. Procedure of Setting and Releasing Backup Mode



15.8.2 Releasing backup mode

The backup mode can be released by inputting a high level to the $\overline{\text{RESET}}$ pin after restarting the power supplies other than the backup power supply (V_{DDBU} and V_{SSBU}).

When the backup mode has been released, the normal operation mode is set after the lapse of the oscillation stabilization time.

Because the backup mode can be released only by the $\overline{\text{RESET}}$ signal, it must be checked if the data of the internal RAM is valid or not, by using the BPSF bit of the backup power status register (BPS). The BPSF bit is set if a change of voltage less than the data retention voltage on V_{DDBU} or greater than the data retention voltage is detected (including on power application), and cleared only by an instruction. This bit holds its value if a voltage greater than the data retention voltage is supplied to V_{DDBU} , and is not affected by a change of voltage on a power pin other than V_{DDBU} .

Therefore, it can be checked if the data of the internal RAM is valid or not by clearing the BPSF bit before the backup mode is set, and checking the status of the BPSF bit by the reset processing routine after the backup mode has been released. (If BPSF = 0, the data of the internal RAM is valid; if BPSF = 1, the data of the internal RAM is invalid.)

The backup mode can be released using the following procedure.

<Releasing backup mode>

- <1> Supply power other than backup power.
- <2> When the power supply has been stabilized, clear the reset signal (input level 1 to the $\overline{\text{RESET}}$ pin), wait for the oscillation stabilization time, and set the normal operation mode.
- <3> Read the BPSF bit of the BPS register using the reset processing routine.
 - BPSF = 0: The data of the internal RAM is valid (the data retention voltage is maintained on V_{DDBU} during the period of the backup mode).
 - BPSF = 1: The data of the internal RAM is invalid (if the voltage on V_{DDBU} drops below the data retention voltage, or on power application).

Caution To release the backup mode, set V_{DDBU} as follows, depending on the main clock frequency.

- $V_{\text{DDBU}} = V_{\text{DD}} = AV_{\text{DD}} = EV_{\text{DD}} = 2.2 \text{ V or more (} f_{\text{xx}} = 17 \text{ MHz)}$

Table 15-11. Operation Status in Backup Mode

Item		Operation Status
Main clock oscillator		Power supply stopped
Subclock oscillator		Oscillation enable
CPU		Power supply stopped
DMA		Power supply stopped
Interrupt controller		Power supply stopped
ROM correction		Power supply stopped
16-bit timer/event counters (TM0, TM1)		Power supply stopped
8-bit timer/event counters (TM2 to TM5)		Power supply stopped
Real-time counter		Operable when f _{XT} is selected as count clock
Watchdog timer		Power supply stopped
Serial interface	CSI0 to CSI4	Power supply stopped
	I ² C ^{Note}	Power supply stopped
	UART0, UART1	Power supply stopped
A/D converter		Power supply stopped
D/A converter		Power supply stopped
External bus interface		Power supply stopped
Port function		Power supply stopped
Internal data		Only the internal RAM retains the status before the software STOP mode is set. Power supply to all the other internal memories is stopped.

Note μ PD703201Y, 703204Y, 70F3201Y, and 70F3204Y only

15.9 Control Registers

(1) Power save control register (PSC)

This is an 8-bit register that controls the standby function. The STP bit of this register is used to specify the software STOP mode. The PSC register is a special register (refer to **3.4.8 Special registers**). Data can be written to this register only in a specific sequence so that its contents are not rewritten by mistake due to a program hang-up.

This register can be read or written in 8-bit or 1-bit units.

After reset: 00H		R/W	Address: FFFFF1FEH					
	7	6	5	4	3	2	1	0
PSC	0	0	0	0	0	0	STP	0
	STP		Sets software STOP mode					
	0	Normal mode						
	1	Software STOP mode						

(2) Backup power status register (BPS)

The BPS register is a special register (refer to **3.4.8 Special registers**). It can be written only in a special sequence so that its contents are not rewritten by mistake due to a program hang-up.

This register can be read or written in 8-bit or 1-bit units.

After reset: 01H		R/W	Address: FFFFF804H					
	7	6	5	4	3	2	1	0
BPC	0	0	0	0	0	0	0	BPSF
BPSF: Backup power status flag								
Setting condition: If a voltage change from a level less than the data retention voltage of the backup power supply (V_{DDBU}) to a level more than the data retention voltage is detected. This flag can also be set by an instruction.								
Clearing condition: This flag can be cleared only by an instruction. It is not affected by $\overline{\text{RESET}}$ input or a voltage change other than V_{DDBU} .								

CHAPTER 16 RESET FUNCTION

16.1 Overview

The following reset functions are available.

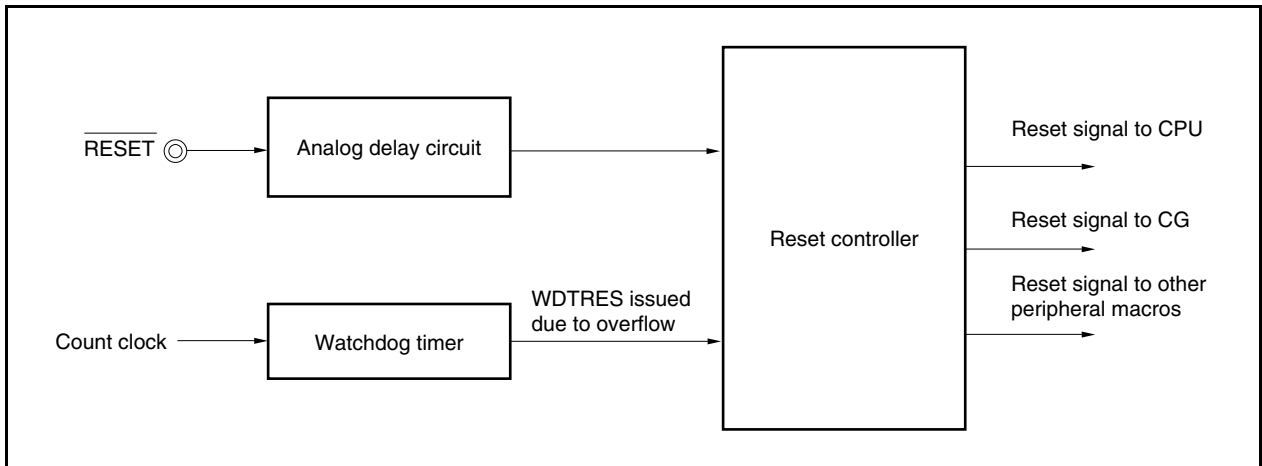
- Reset function by $\overline{\text{RESET}}$ pin input
- Reset function by WDT overflow (WDTRES)

If the $\overline{\text{RESET}}$ pin goes high, the reset status is released, and the CPU starts executing the program. Initialize the contents of each register in the program as necessary.

The $\overline{\text{RESET}}$ pin has a noise eliminator that operates by analog delay to prevent malfunction caused by noise.

16.2 Configuration

Figure 16-1. Reset Block Diagram



16.3 Operation

The system is reset, initializing each hardware unit, when a low level is input to the $\overline{\text{RESET}}$ pin by WDT overflow (WDTRES).

While a low level is being input to the $\overline{\text{RESET}}$ pin, the main clock oscillator stops. Therefore, the overall power consumption of the system can be reduced.

If the $\overline{\text{RESET}}$ pin goes high or if WDTRES is received, the reset status is released.

If the reset status is released by $\overline{\text{RESET}}$ pin input, the oscillation stabilization time elapses (reset value of OSTS register: $2^{19}/f_x$) and then the CPU starts program execution.

If the reset status is released by WDTRES, the oscillation stabilization time is not inserted because the main system clock oscillator does not stop.

Note Reset by WDT overflow (WDTRES) is valid only when the WDTM4 and WDTM3 bits of the watchdog timer mode register (WDTM) are set to “11” (refer to **9.3 (3)**).

Table 16-1. Hardware Status on $\overline{\text{RESET}}$ Pin Input

Item	During Reset	After Reset
Main clock oscillator (f_x)	Oscillation stops ($f_x = 0$ level).	Oscillation starts
Subclock oscillator (f_{XT})	Oscillation can continue without effect from reset ^{Note 1} .	
Peripheral clock (f_x to $f_x/512$), internal system clock (f_{XX}), CPU clock (f_{CPU})	Operation stops	Operation starts. However, operation stops during oscillation stabilization time count.
WDT clock (f_{XW})	Operation stops	Operation starts
Internal RAM	Undefined if power-on reset occurs or writing data to RAM and reset conflict (data loss). Otherwise, retains values immediately before reset input.	
I/O lines (ports)	High impedance	
On-chip peripheral I/O registers	Initialized to specified status	
Real-time counter	Operation can be started ^{Note 2}	
Other on-chip peripheral functions	Operation stops	Operation can be started

Notes 1. The on-chip feedback resistor is “connected” by default (refer to **6.3 (1) Processor clock control register (PCC)**).

- 2.** Reset input sets the internal peripheral I/O register of the real-time counter so that its count operation by subclock (f_{XT}) is enabled. If the subclock is supplied, therefore, the real-time counter performs a count operation on the subclock when the $\overline{\text{RESET}}$ signal is input.

If a clock resulting from dividing the main clock (f_x) by the baud rate generator (f_{BRG}) is used as the count clock, the count clock is changed to f_{XT} .

Table 16-2. Hardware Status on Occurrence of WDTRES

Item	During Reset	After Reset
Main clock oscillator (f_x)	Oscillation continues ^{Note 1}	
Subclock oscillator (f_{XT})	Oscillation can continue without effect from reset ^{Note 1} .	
Peripheral clock (f_x to $f_x/512$), internal system clock (f_{XX}), CPU clock (f_{CPU})	Operation stops	Operation starts
WDT clock (f_{XW})	Operation continues	
Internal RAM	Undefined if writing data to RAM and reset conflict (data loss). Otherwise, retains values immediately before reset input.	
I/O lines (ports)	High impedance	
On-chip peripheral I/O registers	Initialized to specified status	
Real-time counter	Operation continues ^{Note 2}	
Other on-chip peripheral functions	Operation stops	Operation can be started

Notes 1. The on-chip feedback resistor is “connected” by default (refer to **6.3 (1) Processor clock control register (PCC)**).

- 2.** Reset input sets the internal peripheral I/O register of the real-time counter so that its count operation by subclock (f_{XT}) is enabled. If the subclock is supplied, therefore, the real-time counter performs a count operation on the subclock when the $\overline{\text{RESET}}$ signal is input.

If a clock resulting from dividing the main clock (f_x) by the baud rate generator (f_{BRG}) is used as the count clock, the count clock is changed to f_{XT} .

Figure 16-2. Hardware Status on $\overline{\text{RESET}}$ Input

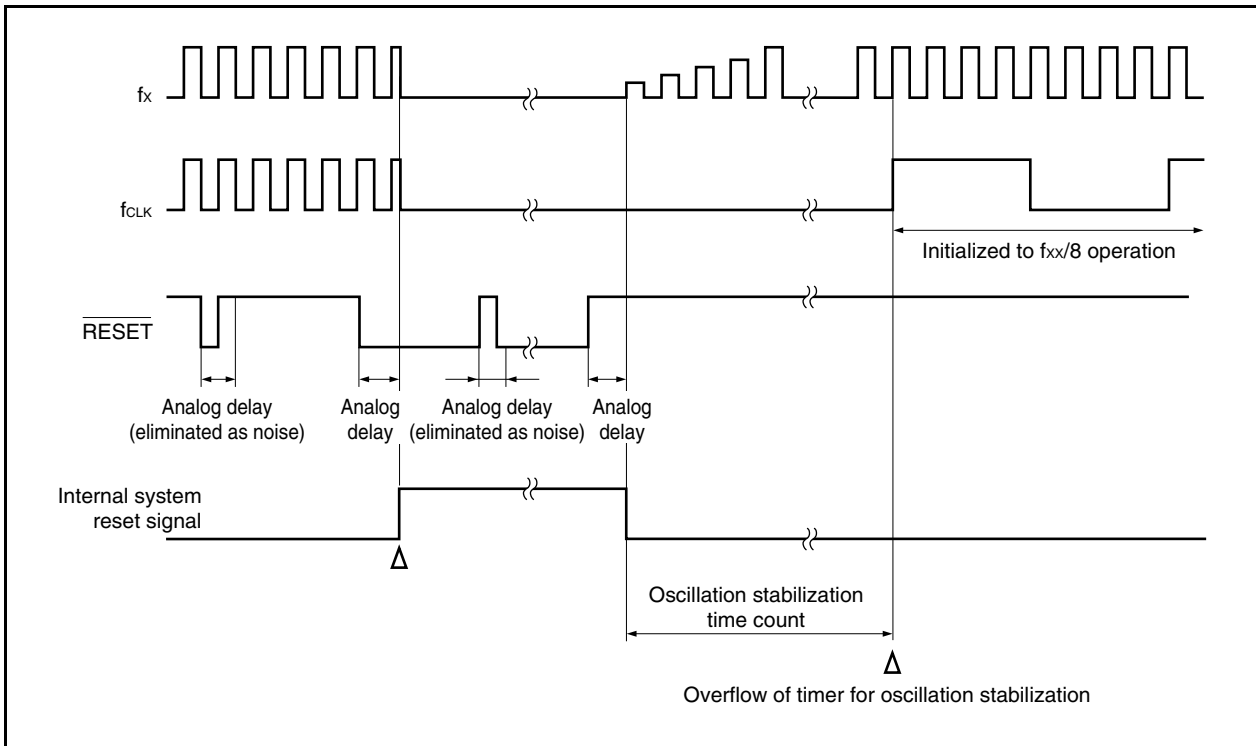
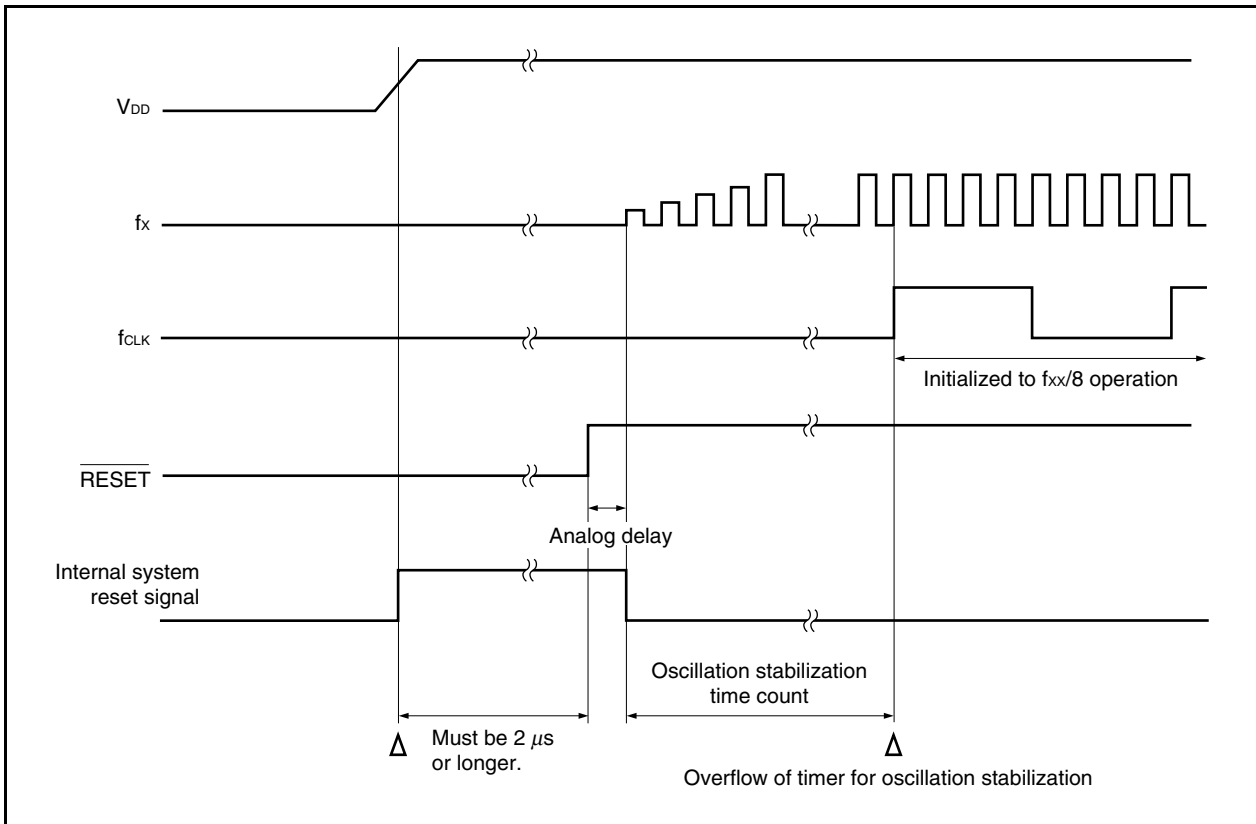


Figure 16-3. Operation on Power Application



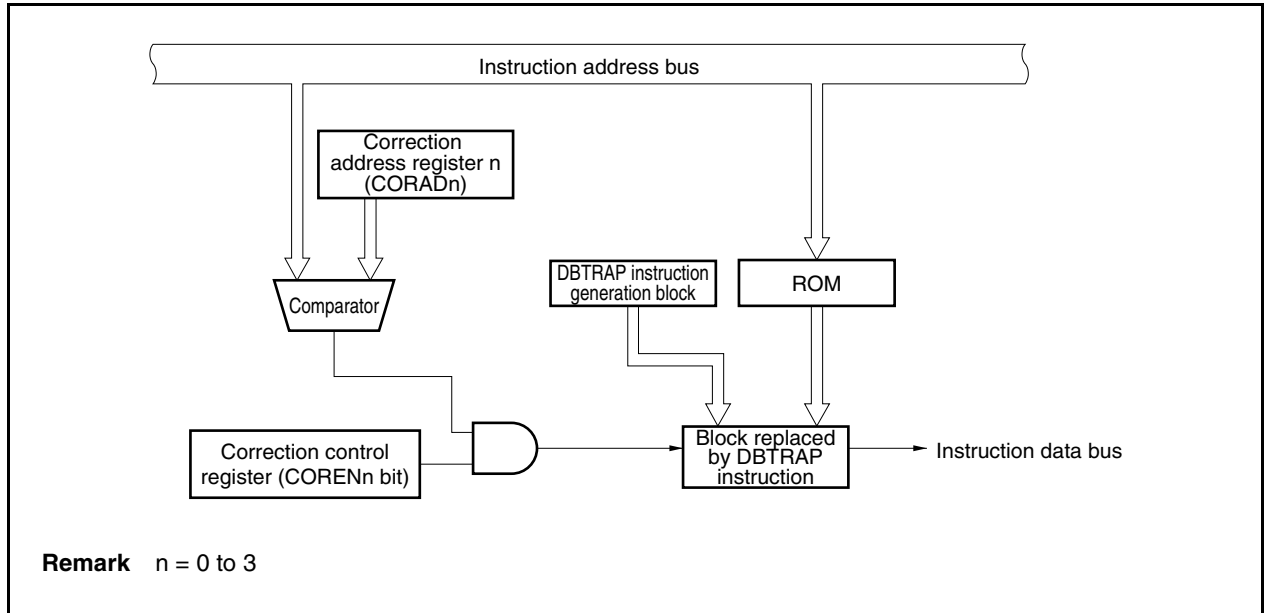
CHAPTER 17 ROM CORRECTION FUNCTION

17.1 Overview

The ROM correction function is used to replace part of the program in the mask ROM with the program of an external RAM or the internal RAM.

By using this function, instruction bugs found in the mask ROM can be corrected at up to four places.

Figure 17-1. Block Diagram of ROM Correction



17.2 Control Registers

17.2.1 Correction address registers 0 to 3 (CORAD0 to CORAD3)

These registers are used to set the first address (correction address) of the instruction to be corrected in the ROM.

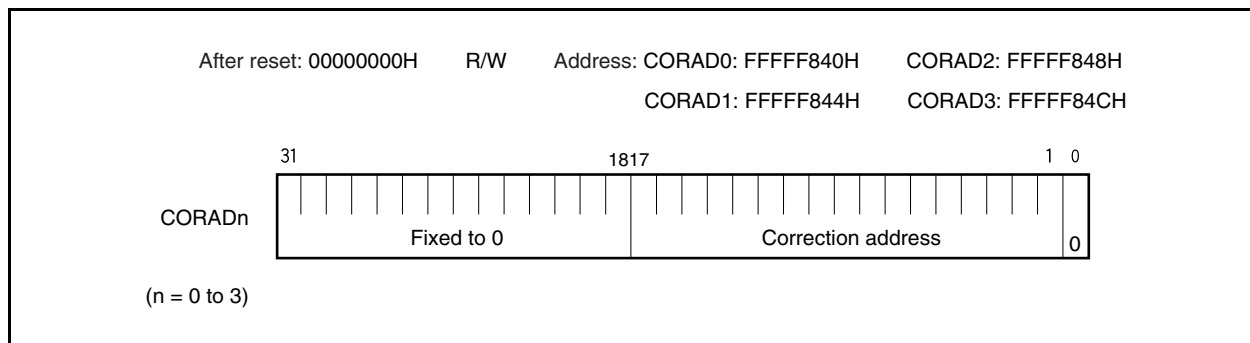
The program can be corrected at up to four places because four correction address registers (CORADn) are provided (n = 0 to 3).

The CORADn register can only be read or written in 32-bit units.

If the higher 16 bits of the CORADn register are used as the CORADnH register, and the lower 16 bits as the CORADnL register, these registers can be read or written in 16-bit units.

Set correction addresses within the range of 0000000H to 003FFFEH.

Fix bits 0 and 18 to 31 to 0.



17.2.2 Correction control register (CORCN)

This register disables or enables the correction operation of correction address register n (CORADn) (n = 0 to 3).

Each channel can be enabled or disabled by this register.

This register is set by using an 8-bit or 1-bit memory manipulation instruction.

After reset: 00H	R/W	Address: FFFFF880H						
CORCN	7	6	5	4	<3>	<2>	<1>	<0>
	0	0	0	0	COREN3	COREN2	COREN1	COREN0

CORENn	Enables/disables correction operation
0	Disabled
1	Enabled

Remark n = 0 to 3

Table 17-1. Correspondence Between CORCN Register Bits and CORADn Registers

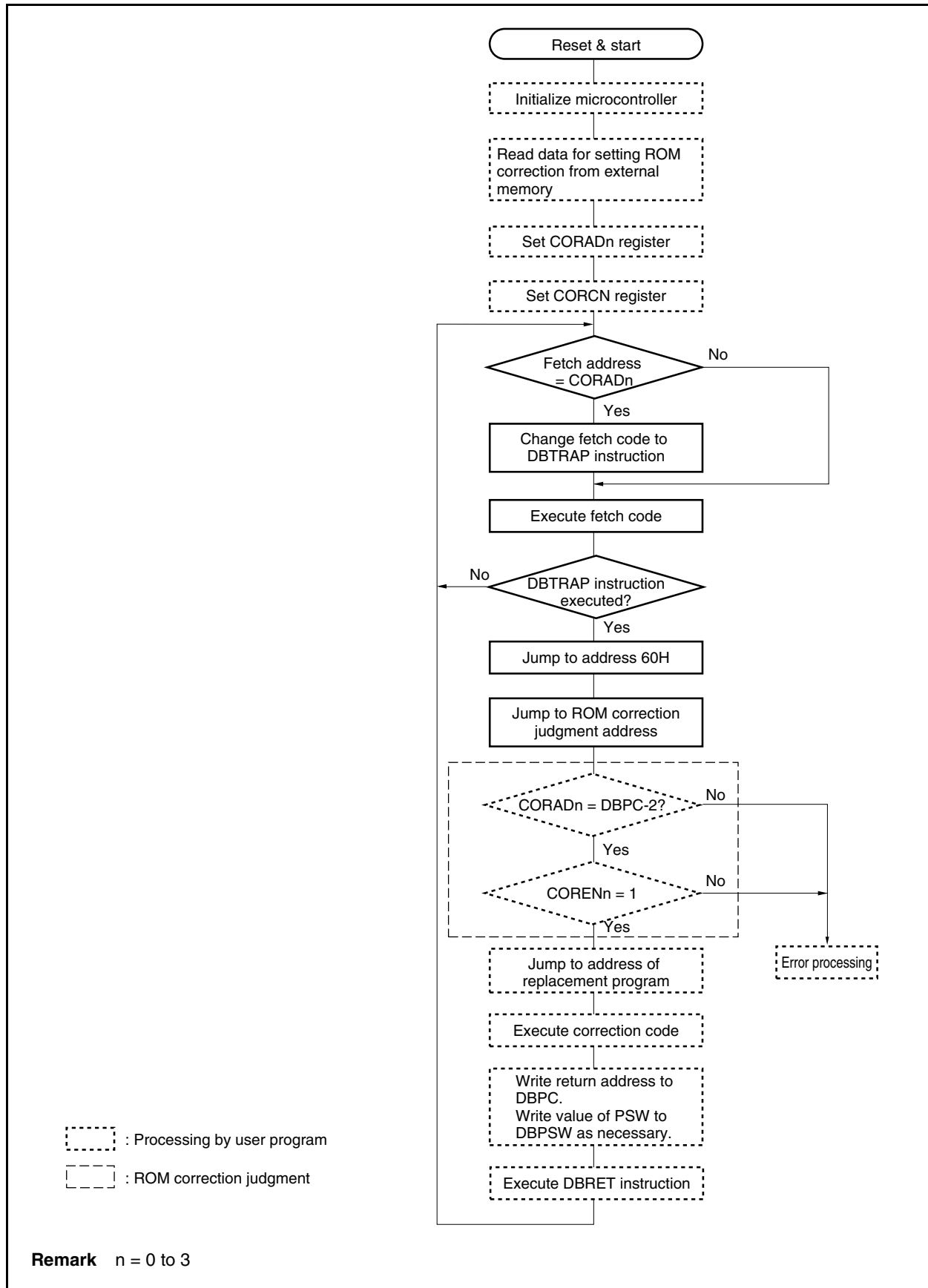
CORCN Register Bit	Corresponding CORADn Register
COREN3	CORAD3
COREN2	CORAD2
COREN1	CORAD1
COREN0	CORAD0

17.3 ROM Correction Operation and Program Flow

- <1> If the address to be corrected and the fetch address of the internal ROM match, the fetch code is replaced by the DBTRAP instruction.
- <2> When the DBTRAP instruction is executed, execution branches to address 00000060H.
- <3> Software processing after branching causes the result of ROM correction to be judged (the fetch address and ROM correction operation are confirmed) and execution to branch to the correction software.
- <4> After the correction software has been executed, the return address is set, and return processing is started by the DBRET instruction.

- Cautions**
1. The software that performs <3> and <4> must be executed in the internal ROM/RAM.
 2. Develop the program so that the ROM correction function is not used until data has been completely written to the CORCN register that controls ROM correction.
 3. When setting an address to be corrected to the CORADn register, clear the higher bits to 0 in accordance with the capacity of the internal ROM.
 4. The ROM correction function cannot be used to correct the data of the internal ROM. It can only be used to correct instruction codes. If ROM correction is used to correct data, that data is replaced with the DBTRAP instruction code.

Figure 17-2. ROM Correction Operation and Program Flow



CHAPTER 18 FLASH MEMORY

The following products are the flash memory versions of the V850ES/SA2 and V850ES/SA3.

Caution There are differences in the amount of noise tolerance and noise radiation between flash memory versions and mask ROM versions. When considering changing from a flash memory version to a mask ROM version during the process from experimental manufacturing to mass production, make sure to sufficiently evaluate commercial samples (CS) (not engineering samples (ES)) of the mask ROM versions.

(1) V850ES/SA2

μ PD70F3201, 70F3201Y: 256 KB flash memory versions

(2) V850ES/SA3

μ PD70F3204, 70F3204Y: 256 KB flash memory versions

In the instruction fetch to this flash memory, 4 bytes can be accessed by a single clock, the same as in the mask ROM version.

Writing to flash memory can be performed with the memory mounted on the target system (on board). A dedicated flash programmer is connected to the target system to perform writing.

The following can be considered as the development environment and the applications using a flash memory.

- Software can be altered after the V850ES/SA2 or V850ES/SA3 is solder-mounted on the target system.
- Small scale production of various models is made easier by differentiating software.
- Data adjustment in starting mass production is made easier.

18.1 Features

- 4-byte/1-clock access (in instruction fetch access)
- Chip erase/block unit erase
- Communication via serial interface with the dedicated flash programmer
- Erase/write voltage: Can be erased/written with a single power supply (FLMD0 = V_{DD} , FLMD1 = V_{SS}).
- On-board programming
- Flash memory programming by self-writing

18.1.1 Erasure unit

The erasure units for 256 KB flash memory versions are shown below.

(1) Chip erase

The area of xx000000H to xx03FFFFH can be erased at the same time.

(2) Block erase

Erasure can be performed in block units (60 KB × 4, 4 KB × 4).

Block 0: 4 KB
Block 1: 4 KB
Block 2: 4 KB
Block 3: 4 KB
Block 4: 60 KB
Block 5: 60 KB
Block 6: 60 KB
Block 7: 60 KB

18.2 Writing with Flash Programmer

Writing can be performed either on-board or off-board with the dedicated flash programmer.

(1) On-board programming

The contents of the flash memory are rewritten after the V850ES/SA2 or V850ES/SA3 is mounted on the target system. Mount connectors, etc., on the target system to connect the dedicated flash programmer.

(2) Off-board programming

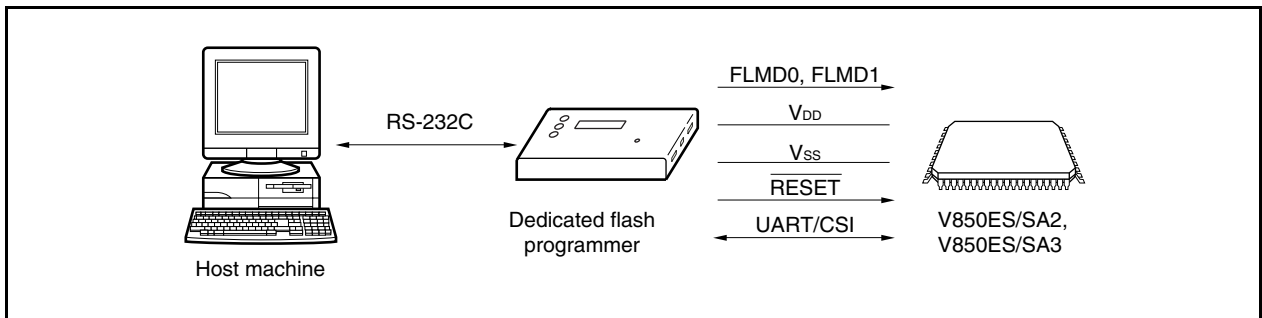
Writing to flash memory is performed by a dedicated program adapter (FA Series), etc., before mounting the V850ES/SA2 or V850ES/SA3 on the target system.

Remark FA Series is a product of Naito Densai Machida Mfg. Co., Ltd.

18.3 Programming Environment

The following shows the environment required for writing programs to the flash memory of V850ES/SA2 and V850ES/SA3.

Figure 18-1. Environment Required for Writing Programs to Flash Memory



A host machine is required for controlling the dedicated flash programmer.

UART0 or CSI0 is used for the interface between the dedicated flash programmer and the V850ES/SA2 or V850ES/SA3 to perform writing, erasing, etc. A dedicated program adapter (FA Series) required for off-board writing.

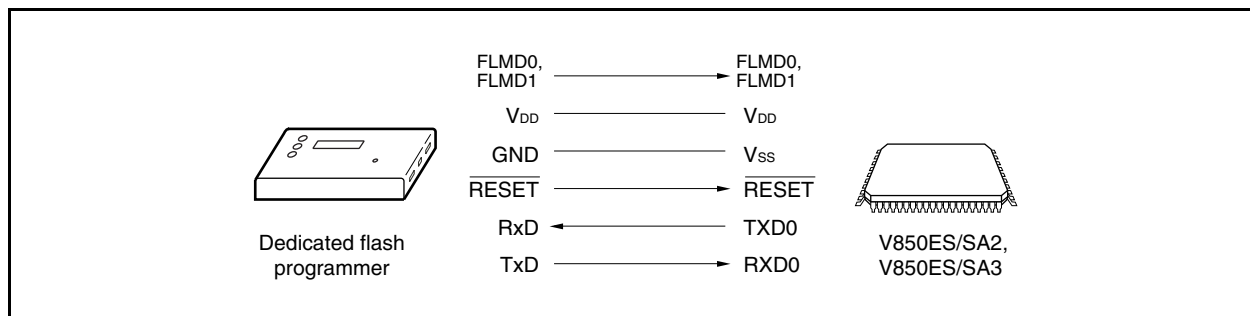
18.4 Communication Mode

The communication between the dedicated flash programmer and the V850ES/SA2 or V850ES/SA3 is performed by serial communication using UART0 or CSIO of the V850ES/SA2, V850ES/SA3.

(1) UART0

Transfer rate: 4,800 to 76,800 bps

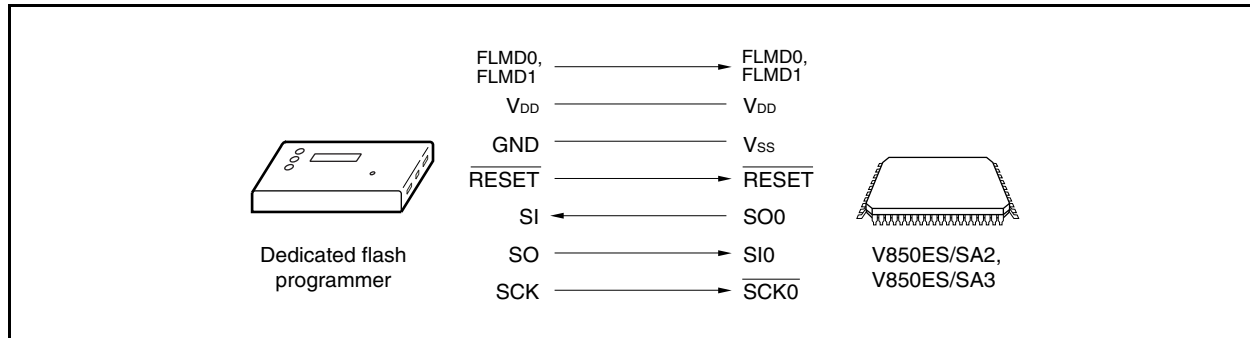
Figure 18-2. Communication with Dedicated Flash Programmer (UART0)



(2) CSIO

Serial clock: Up to 1 MHz (MSB first)

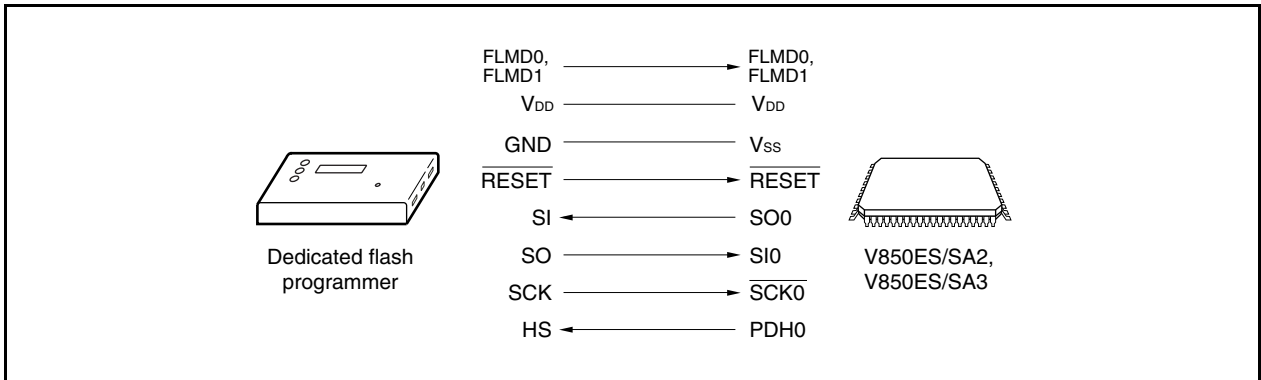
Figure 18-3. Communication with Dedicated Flash Programmer (CSIO)



(3) CSIO + HS

Serial clock: Up to 1 MHz (MSB first)

Figure 18-4. Communication with Dedicated Flash Programmer (CSIO + HS)



The dedicated flash programmer outputs the transfer clock, and the V850ES/SA2 and V850ES/SA3 operate as slaves.

When the PG-FP4 is used as the dedicated flash programmer, it generates the following signals to the V850ES/SA2 or V850ES/SA3. For details, refer to the PG-FP4 manual.

Table 18-1. Signal Generation of Dedicated Flash Programmer (PG-FP4)

PG-FP4			V850ES/SA2, V850ES/SA3	Connection Handling		
Signal Name	I/O	Pin Function	Pin Name	CSIO	UART0	CSIO + HS
FLMD0, FLMD1	Output	Writing enable/disable	FLMD0, FLMD1	⊙	⊙	⊙
V _{DD}	I/O	V _{DD} voltage generation/ voltage monitoring	V _{DD}	⊙	⊙	⊙
GND	–	Ground	V _{SS}	⊙	⊙	⊙
CLK	Output	Clock output to V850ES/SA2, V850ES/SA3	X1	×	×	×
RESET	Output	Reset signal	RESET	⊙	⊙	⊙
SI/RxD	Input	Receive signal	SO0/TxD0	⊙	⊙	⊙
SO/TxD	Output	Transmit signal	SI0/RxD0	⊙	⊙	⊙
SCK	Output	Transfer clock	SCK0	⊙	×	⊙
HS	Input	Handshake signal of CSIO + HS	PDH0	×	×	⊙

Remark ⊙: Always connected
 ×: Does not need to be connected

18.5 Pin Connection

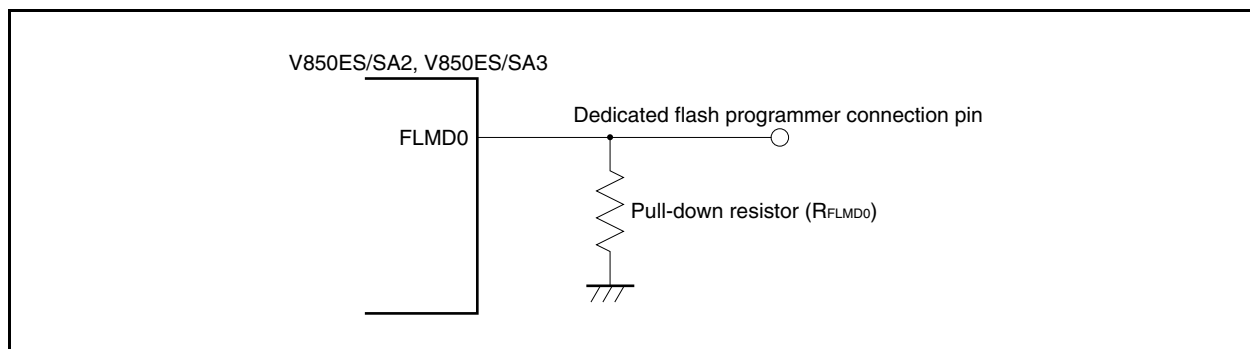
When performing on-board writing, mount a connector on the target system to connect to the dedicated flash programmer. Also, incorporate a function on-board to switch from the normal operation mode to the flash memory programming mode.

When switched to the flash memory programming mode, all the pins not used for flash memory programming become the same status as that immediately after reset. Therefore, all the ports enter the output high-impedance status, so that pin handling is required when the external device does not acknowledge the output high-impedance status.

18.5.1 FLMD0 pin

In the normal operation mode, 0 V is input to the FLMD0 pin. In the flash memory programming mode, the V_{DD} write voltage is supplied to the FLMD0 pin. The following shows an example of the connection of the FLMD0 pin.

Figure 18-5. FLMD0 Pin Connection Example



18.5.2 Serial interface pin

The following shows the pins used by each serial interface.

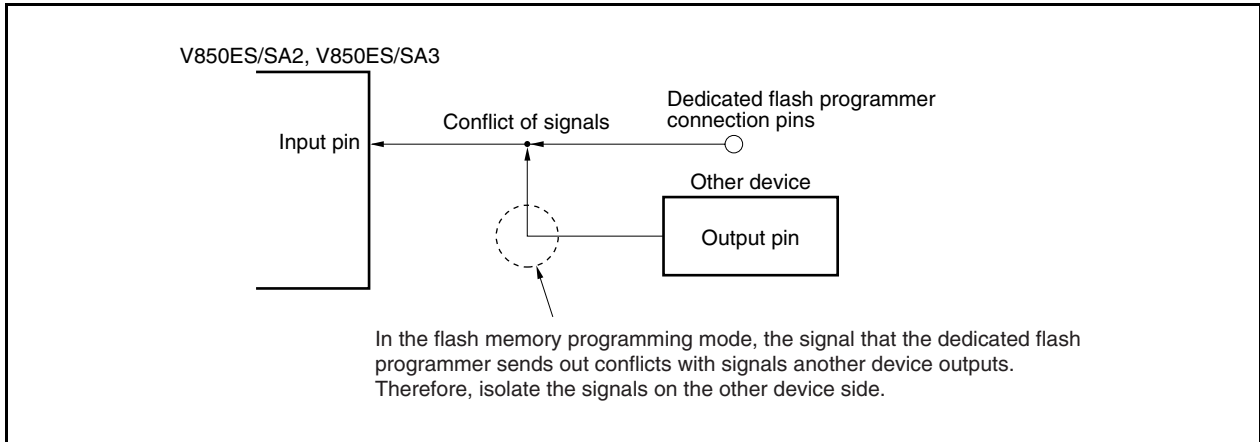
Table 18-2. Pins Used by Serial Interfaces

Serial Interface	Pins Used
CSI0	SO0, SI0, $\overline{SCK0}$
CSI0 + HS	SO0, SI0, $\overline{SCK0}$, PDH0
UART0	TXD0, RXD0

When connecting a dedicated flash programmer to a serial interface pin that is connected to another device on-board, care should be taken to avoid conflict of signals and malfunction of the other device.

(1) Conflict of signals

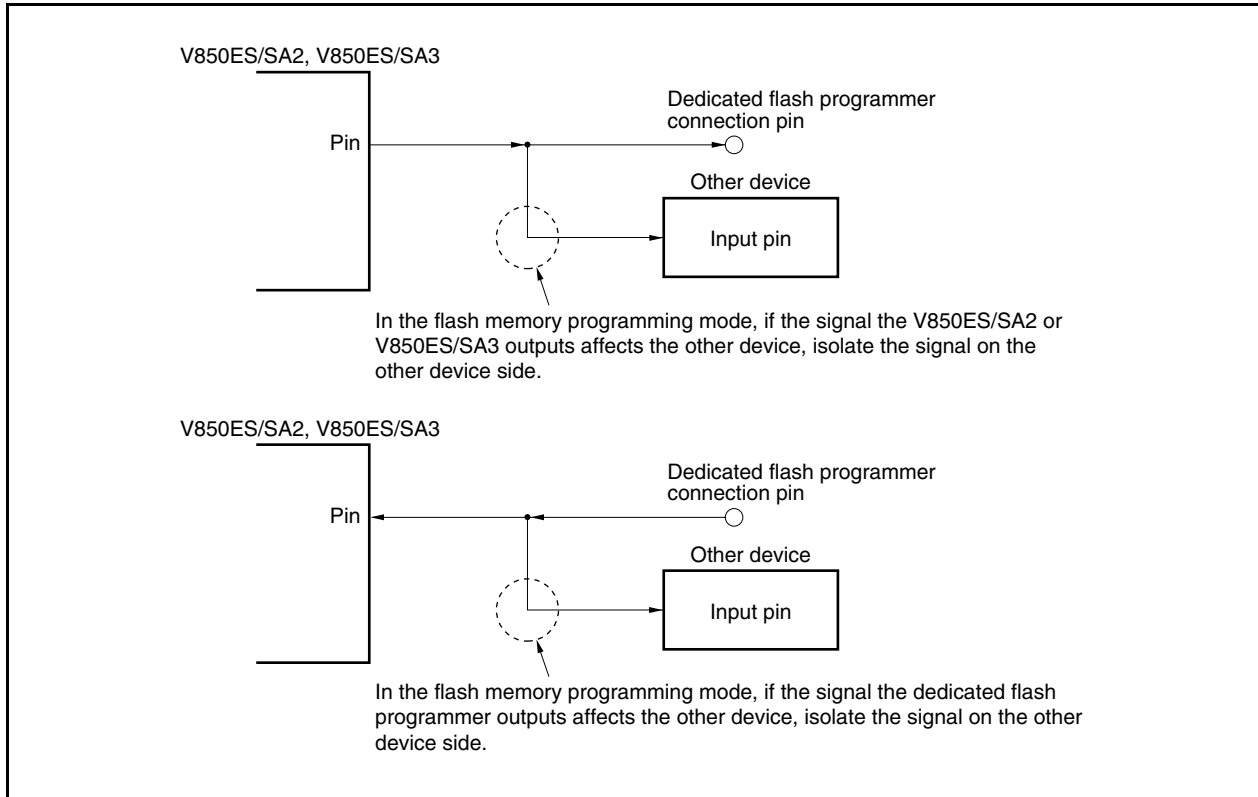
When the dedicated flash programmer (output) is connected to a serial interface pin (input) that is connected to another device (output), a conflict of signals occurs. To avoid the conflict of signals, isolate the connection to the other device or set the other device to the output high-impedance status.

Figure 18-6. Conflict of Signals (Serial Interface Input Pin)

(2) Malfunction of other device

When the dedicated flash programmer (output or input) is connected to a serial interface pin (input or output) that is connected to another device (input), the signal is output to the other device, causing the device to malfunction. To avoid this, isolate the connection to the other device or make the setting so that the input signal to the other device is ignored.

Figure 18-7. Malfunction of Other Device

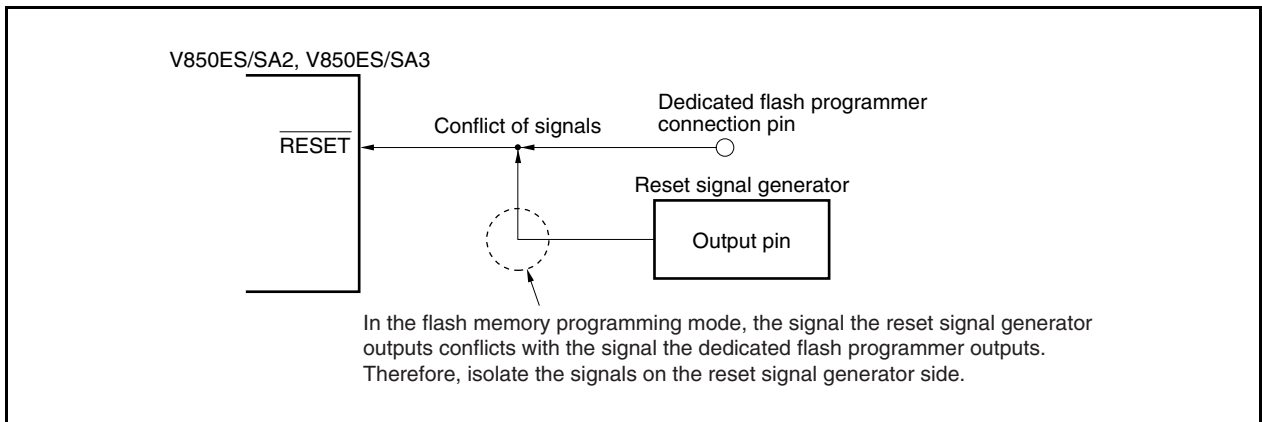


18.5.3 $\overline{\text{RESET}}$ pin

When the reset signals of the dedicated flash programmer are connected to the $\overline{\text{RESET}}$ pin that is connected to the reset signal generator on-board, a conflict of signals occurs. To avoid the conflict of signals, isolate the connection to the reset signal generator.

When a reset signal is input from the user system in the flash memory programming mode, the programming operation will not be performed correctly. Therefore, do not input signals other than the reset signals from the dedicated flash programmer.

Figure 18-8. Conflict of Signals ($\overline{\text{RESET}}$ Pin)



18.5.4 Port pins (including NMI)

When the flash memory programming mode is set, all the port pins except the pins that communicate with the dedicated flash programmer enter the output high-impedance status. If problems such as disabling output high-impedance status should occur in the external devices connected to the port, connect the port pins to V_{DD} or V_{SS} via resistors.

18.5.5 Other signal pins

Connect X1, X2, XT1, XT2, AV_{REF0} , and AV_{REF1} to the same status as that in the normal operation mode.

18.5.6 Power supply

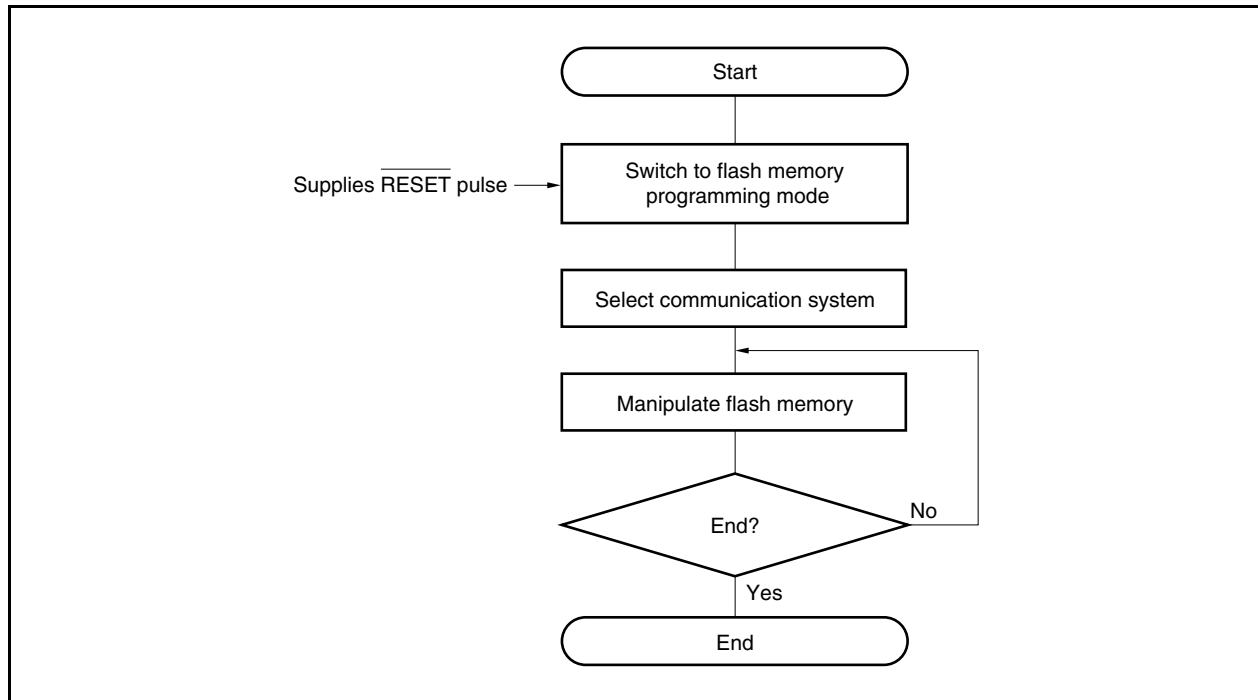
Supply the same power (V_{DD} , V_{SS} , EV_{DD} , EV_{SS} , AV_{DD} , AV_{SS} , V_{DDBU} , V_{SSBU}) as in normal operation mode.

18.6 Programming Method

18.6.1 Flash memory control

The following shows the procedure for manipulating the flash memory.

Figure 18-9. Procedure for Manipulating Flash Memory

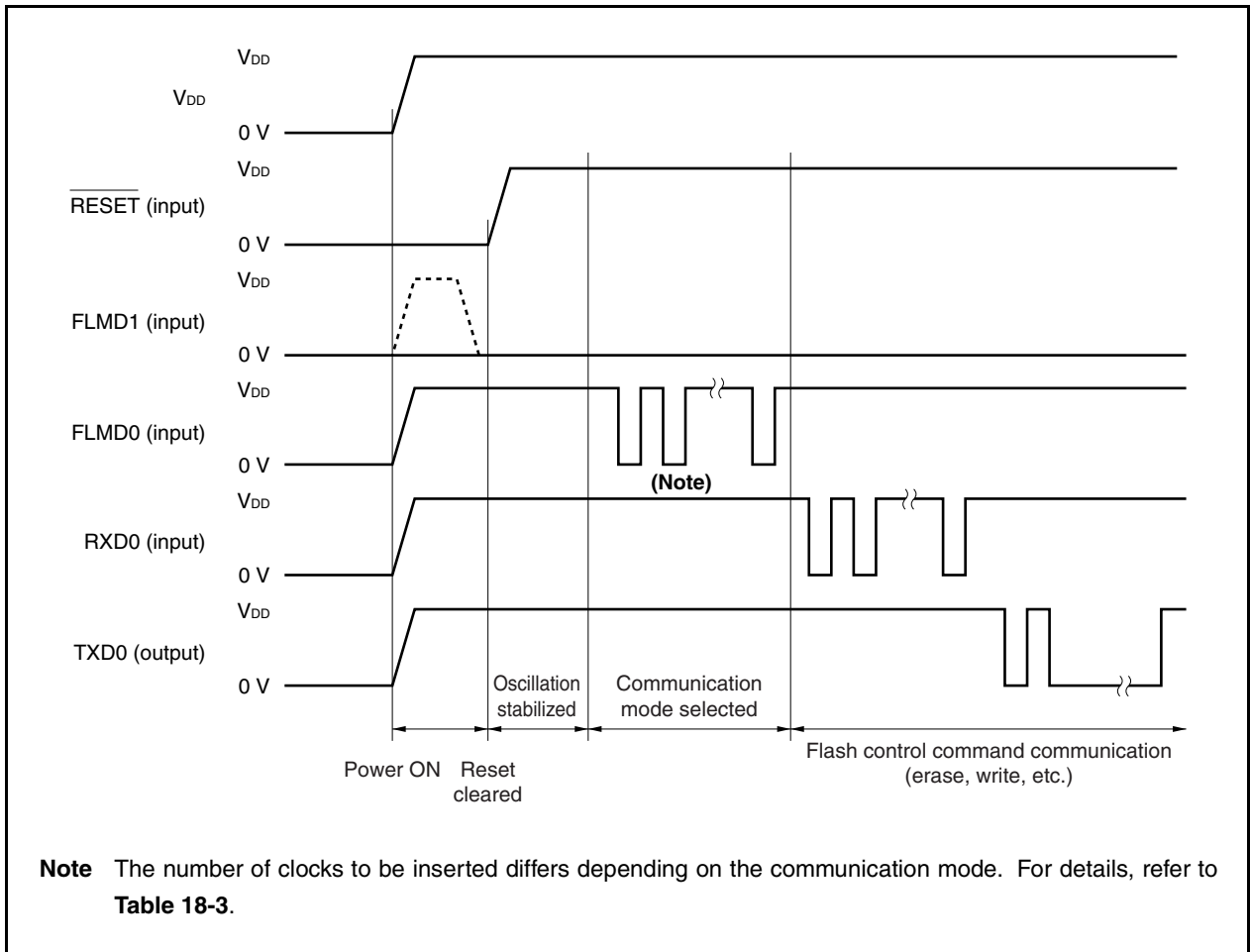


18.6.2 Flash memory programming mode

When rewriting the contents of flash memory using the dedicated flash programmer, set the V850ES/SA2 or V850ES/SA3 to the flash memory programming mode. When switching modes, set the FLMD0 and FLMD1 pins before releasing reset.

When performing on-board writing, change modes using a jumper, etc.

Figure 18-10. Flash Memory Programming Mode



18.6.3 Selection of communication mode

In the V850ES/SA2 and V850ES/SA3, the communication mode is selected by inputting pulses (16 pulses max.) to the FLMD0 pin after switching to the flash memory programming mode. The FLMD0 pulse is generated by the dedicated flash programmer.

The following shows the relationship between the number of pulses and the communication mode.

Table 18-3. List of Communication Modes

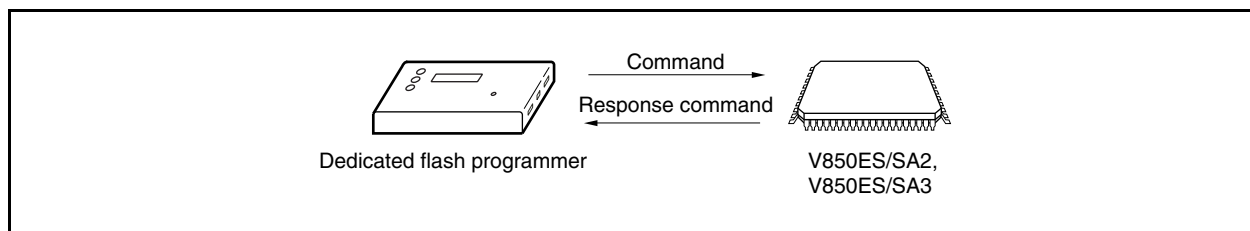
FLMD0 Pulse	Communication Mode	Remarks
0	CSI0	V850ES/SA2 and V850ES/SA3 perform slave operation, MSB first
3	CSI0 + HS	V850ES/SA2 and V850ES/SA3 perform slave operation, MSB first
8	UART0	Communication rate: 9,600 bps (at reset), LSB first
Others	RFU	Setting prohibited

Caution When UART is selected, the receive clock is calculated based on the reset command sent from the dedicated flash programmer after receiving the FLMD0 pulse.

18.6.4 Communication command

The V850ES/SA2 and V850ES/SA3 communicate with the dedicated flash programmer by means of commands. The command sent from the dedicated flash programmer to the V850ES/SA2 or V850ES/SA3 is called a “command”. The response signal sent from the V850ES/SA2 or V850ES/SA3 to the dedicated flash programmer is called a “response command”.

Figure 18-11. Communication Command



The following shows the commands for flash memory control of the V850ES/SA2 and V850ES/SA3. All of these commands are issued from the dedicated flash programmer, and the V850ES/SA2 and V850ES/SA3 perform the various processing corresponding to the commands.

Table 18-4. Flash Memory Control Command

Category	Command Name	Support			Function
		CSI	CSI + HS	UART	
Blank check	Block blank check command	√	√	√	Checks the erase state of the entire memory.
Erase	Chip erase command	√	√	√	Erases the contents of the entire memory.
	Block erase command	√	√	√	Erases the contents of the specified block memory.
Write	Write command	√	√	√	Writes data according to the specification of the write address and the number of bytes to be written, and executes a verify check.
Verify	Verify command	√	√	√	Compares the contents of the entire memory and the input data.
System setting and control	Reset command	√	√	√	Escapes from each state.
	Oscillating frequency setting command	√	√	√	Sets the oscillation frequency.
	Baud rate setting command	–	–	√	Sets the baud rate when using UART.
	Silicon signature command	√	√	√	Reads the silicon signature information.
	Version acquisition command	√	√	√	Reads the version information of the device.
	Status command	√	√	–	Acquires the operation status.
	Security setting command	√	√	√	Erases chip and blocks, and sets security of write.

The V850ES/SA2 and V850ES/SA3 return response commands to the commands issued from the dedicated flash programmer. The following shows the response commands returned by the V850ES/SA2 and V850ES/SA3.

Table 18-5. Response Commands

Response Command Name	Function
ACK (acknowledge)	Acknowledges command/data, etc.
NAK (not acknowledge)	Acknowledges illegal command/data, etc.

CHAPTER 19 ELECTRICAL SPECIFICATIONS (TARGET)

Absolute maximum ratings ($T_A = 25^\circ\text{C}$, $V_{SS} = 0\text{ V}$)

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage	V_{DD}		-0.5 to +3.6	V
	AV_{DD}		-0.5 to +3.6	V
	EV_{DD}		-0.5 to +3.6	V
	V_{DDBU}		-0.5 to +3.6	V
	AV_{SS}		-0.5 to +0.5	V
	EV_{SS}		-0.5 to +0.5	V
	V_{SSBU}		-0.5 to +0.5	V
Input voltage	V_I	Other than X1, XT1, and port 7	-0.5 to $EV_{DD} + 0.3^{\text{Note}}$	V
Clock input voltage	V_K	X1, $V_{DD} = 2.2$ to 2.7 V	-0.5 to $V_{DD} + 0.3^{\text{Note}}$	V
	V_{KT}	XT1, $V_{DDBU} = 2.2$ to 2.7 V	-0.5 to $V_{DDBU} + 0.3^{\text{Note}}$	V
Analog input voltage	V_{IAN}	Port 7	-0.5 to $AV_{DD} + 0.3^{\text{Note}}$	V
Analog reference voltage	AV_{REF}	AV_{REF0} , AV_{REF1}	-0.5 to $AV_{DD} + 0.3^{\text{Note}}$	V
Output current, low	I_{OL}	Per pin	4	mA
		Total for all pins	T.B.D.	mA
Output current, high	I_{OH}	Per pin	-4	mA
		Total for all pins	T.B.D.	mA
Output voltage	V_O	$V_{DD} = 2.5\text{ V} \pm 0.2\text{ V}$	-0.5 to $V_{DD} + 0.3\text{ V}$	V
Operating ambient temperature	T_A	Normal operation mode	-40 to +85	$^\circ\text{C}$
		Flash programming mode	T.B.D.	$^\circ\text{C}$
Storage temperature	T_{stg}		-40 to +125	$^\circ\text{C}$

Note Be sure not to exceed the absolute maximum ratings (MAX. value) of each supply voltage.

- Cautions 1.** Do not directly connect the output (or I/O) pins of IC products to each other, or to V_{DD} , V_{CC} , and GND. Open-drain pins or open-collector pins, however, can be directly connected to each other. Direct connection of the output pins between an IC product and an external circuit is possible, if the output pins can be set to the high-impedance state and the output timing of the external circuit is designed to avoid output conflict.
- 2.** Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded. The ratings and conditions indicated for DC characteristics and AC characteristics represent the quality assurance range during normal operation.

Capacitance ($T_A = 25^\circ\text{C}$, $V_{DD} = AV_{DD} = EV_{DD} = VDDBU = V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0\text{ V}$)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input capacitance	C_i	$f_x = 1\text{ MHz}$			10	pF
I/O capacitance	C_{io}	Unmeasured pins returned to 0 V			10	pF
Output capacitance	C_o				10	pF

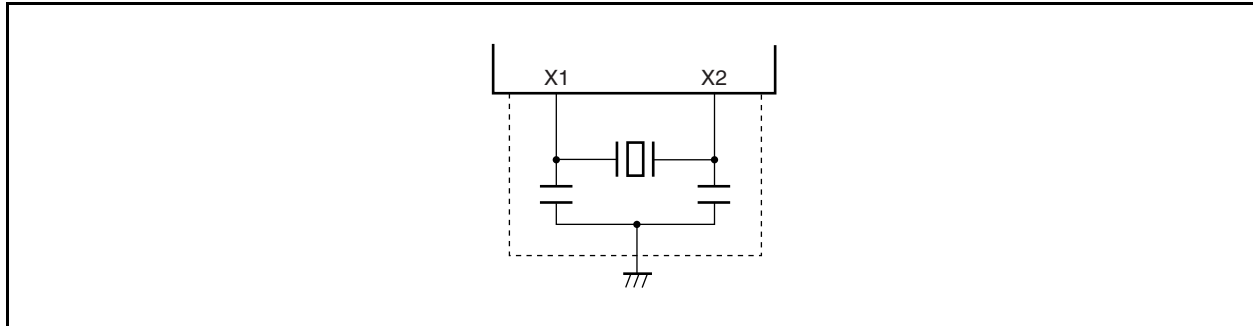
Operating conditions ($V_{DD} = AV_{DD} = EV_{DD} = VDDBU$)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Internal system clock frequency	f_{CLK}	@ $V_{DD} = 2.2$ to 2.7 V , operation with main clock	0.0625		17	MHz

Recommended oscillator

(1) Main clock oscillator ($T_A = -40$ to $+85^\circ\text{C}$)

(a) Connection of ceramic resonator or crystal resonator



Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Oscillation frequency	f_x (f_{xx})	$V_{DD} = 2.2$ to 2.7 V	2		17	MHz
Oscillation stabilization time		Upon reset release		$2^{19}/f_x$		s
		Upon STOP mode release		Note		s

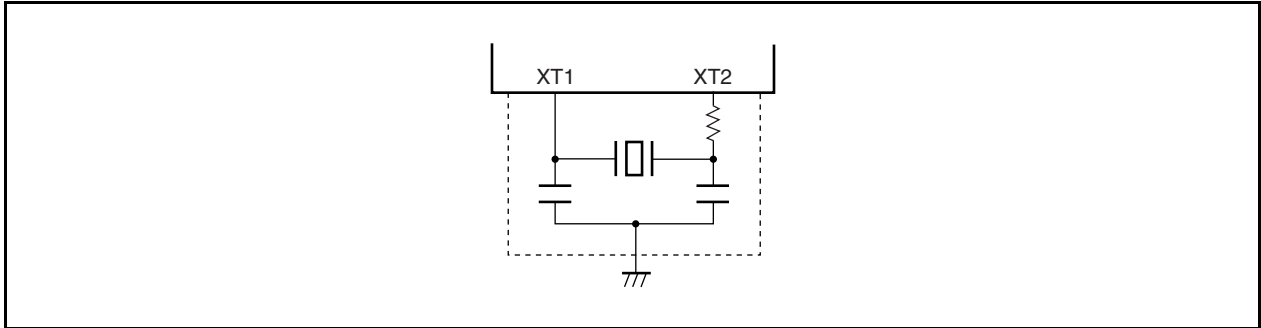
Note The TYP. value differs depending on the setting of the oscillation stabilization time select register (OSTS).

Caution Ensure that the duty of the oscillation waveform is between 45% and 55%.

- Remarks**
1. Connect the oscillator as close as possible to the X1 and X2 pins.
 2. Do not route the wiring near broken lines.
 3. For the resonator selection and oscillator constant, customers are requested to either evaluate the oscillation themselves or apply to the resonator manufacturer for evaluation.

(2) Subclock oscillator ($T_A = -40$ to $+85^\circ\text{C}$)

(a) Connection of crystal resonator



Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Oscillation frequency	f_{XT}		32	32.768	35	kHz
Oscillation stabilization time				10		s

Caution Ensure that the duty of the oscillation waveform is between 45% and 55%.

- Remarks**
1. Connect the oscillator as close as possible to the XT1 and XT2 pins.
 2. Do not route the wiring near broken lines.
 3. For the resonator selection and oscillator constant, customers are requested to either evaluate the oscillation themselves or apply to the resonator manufacturer for evaluation.

DC characteristics

 (T_A = -40 to +85°C, V_{DD} = AV_{DD} = EV_{DD} = V_{DDBU} = 2.2 to 2.7 V, V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0 V) (1/2)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input voltage, high	V _{IH1}	Note 1	0.7EV _{DD}		EV _{DD}	V
	V _{IH2}	Note 2	T.B.D.		EV _{DD}	V
	V _{IH3}	Note 3	0.7AV _{DD}		AV _{DD}	V
	V _{IH4}	X1	0.8V _{DD}		V _{DD}	V
	V _{IH5}	XT1, XT2	0.8V _{DDBU}		V _{DDBU}	V
Input voltage, low	V _{IL1}	Note 1	EV _{SS}		0.3EV _{DD}	V
	V _{IL2}	Note 2	EV _{SS}		T.B.D.	V
	V _{IL3}	Note 3	AV _{SS}		0.3AV _{DD}	V
	V _{IL4}	X1	V _{SS}		0.2V _{DD}	V
	V _{IL5}	XT1, XT2	V _{SSBU}		0.2V _{DDBU}	V
Output voltage, high	V _{OH1}	Note 4	I _{OH} = -1 mA	T.B.D.		V
	V _{OH2}	Note 5	I _{OH} = -3 mA	T.B.D.		V
Output voltage, low	V _{OL1}	Note 4 (Except pins P40 and P42)	I _{OL} = 1.6 mA		0.4	V
	V _{OL2}	P40, P42	I _{OL} = 3 mA		0.4	V
	V _{OL3}	Note 5	I _{OL} = 1.6 mA		0.4	V
Input leakage current, high	I _{LIH}	V _{IN} = V _{DD} = EV _{DD} = V _{DDBU}			5	μA
Input leakage current, low	I _{LIL}	V _{IN} = 0 V			-5	μA
Output leakage current, high	I _{LOH}	V _O = V _{DD} = EV _{DD} = V _{DDBU}			5	μA
Output leakage current, low	I _{LOL}	V _O = 0 V			-5	μA

- Notes 1.** P21, P31, P90, P91, P94 to P97, P99, P911, P914, PCD1 to PCD3, PCM0 to PCM5, PCS0 to PCS7, PCT0 to PCT7, PDH0 to PDH7, PDL0 to PDL15 (and their alternate-function pins)
- 2.** $\overline{\text{RESET}}$, P00 to P05, P20, P22, P30, P32, P40 to P46, P92, P93, P98, P910, P912, P913, P915 (and their alternate-function pins)
- 3.** P70 to P715, P80, P81 (and their alternate-function pins)
- 4.** P00 to P05, P20 to P22, P30 to P32, P40 to P46, PCD1 to PCD3, PCM4 to PCM5, PCS4 to PCS7, PCT2, PCT3, PCT5, PCT7 (and their alternate-function pins)
- 5.** P90 to P915, PCM0 to PCM3, PCS0 to PCS3, PCT0, PCT1, PCT4, PCT6, PDH0 to PDH7, PDL0 to PDL15 (and their alternate-function pins)

(T_A = -40 to +85°C, V_{DD} = AV_{DD} = EV_{DD} = V_{DDBU} = 2.2 to 2.7 V, V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0 V) (2/2)

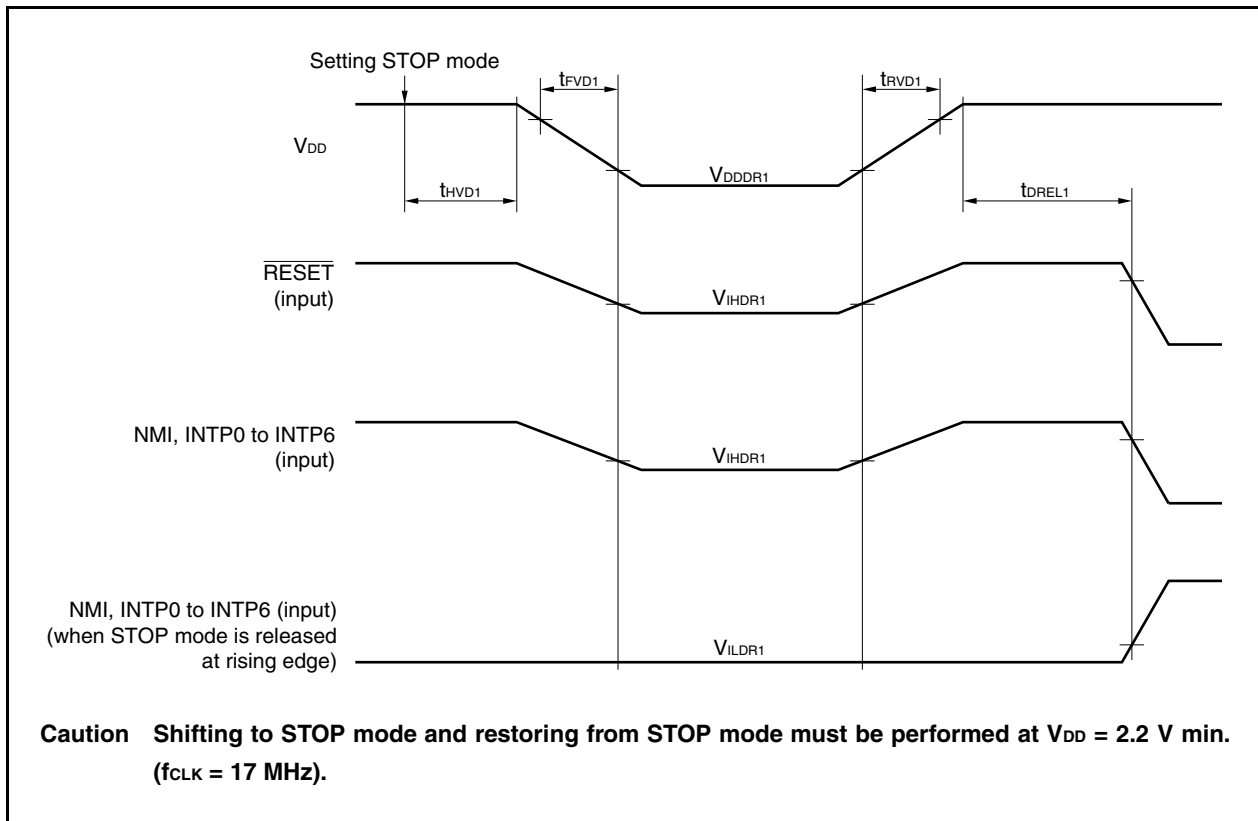
Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Supply current	I _{DD1}	Normal operation All peripheral functions operating	f _{XX} = f _{CLK} = 17 MHz		T.B.D.	T.B.D.	mA
	I _{DD2}	HALT mode All peripheral functions operating	f _{XX} = f _{CLK} = 17 MHz		T.B.D.	T.B.D.	mA
	I _{DD3}	IDLE mode RTC operating	f _{XX} = f _{CLK} = 17 MHz		T.B.D.	T.B.D.	mA
	I _{DD4}	STOP mode	Subclock oscillator, RTC operating		T.B.D.	T.B.D.	μA
			Subclock oscillator stopped (XT1 = V _{SS})		T.B.D.	T.B.D.	μA
	I _{DD5}	Subclock operation mode f _{XT} = f _{CLK} = 32.768 kHz			T.B.D.	T.B.D.	μA
	I _{DD6}	Sub-IDLE mode f _{XT} = f _{CLK} = 32.768 kHz Main clock oscillator stopped, RTC operating			T.B.D.	T.B.D.	μA
	I _{DD7}	Backup mode	f _{XT} = 32.768 kHz, RTC operating		T.B.D.	T.B.D.	μA
Subclock oscillator stopped (XT1 = V _{SS})				T.B.D.	T.B.D.	μA	
Pull-up resistance	R _L	V _{IN} = 0 V		10	30	100	kΩ

Data retention characteristics

(1) In STOP mode ($T_A = -40$ to $+85^\circ\text{C}$, $V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0$ V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Data retention voltage	V_{DDDR1}	STOP mode	1.5		2.7	V
Data retention current	I_{DDDR1}	$V_{DD} = AV_{DD} = EV_{DD} = V_{DDBU} = V_{DDDR1}$		T.B.D.	T.B.D.	μA
Supply voltage rise time	t_{rVD1}		200			μs
Supply voltage fall time	t_{fVD1}		200			μs
Supply voltage hold time (from STOP mode setting)	t_{HVD1}		0			ms
STOP release signal input time	t_{DREL1}		0			ms
Data retention high-level input voltage	V_{IHDR1}	All input ports	V_{IHn}		V_{DDDR1}	V
Data retention low-level input voltage	V_{ILDR1}	All input ports	0		V_{ILn}	V

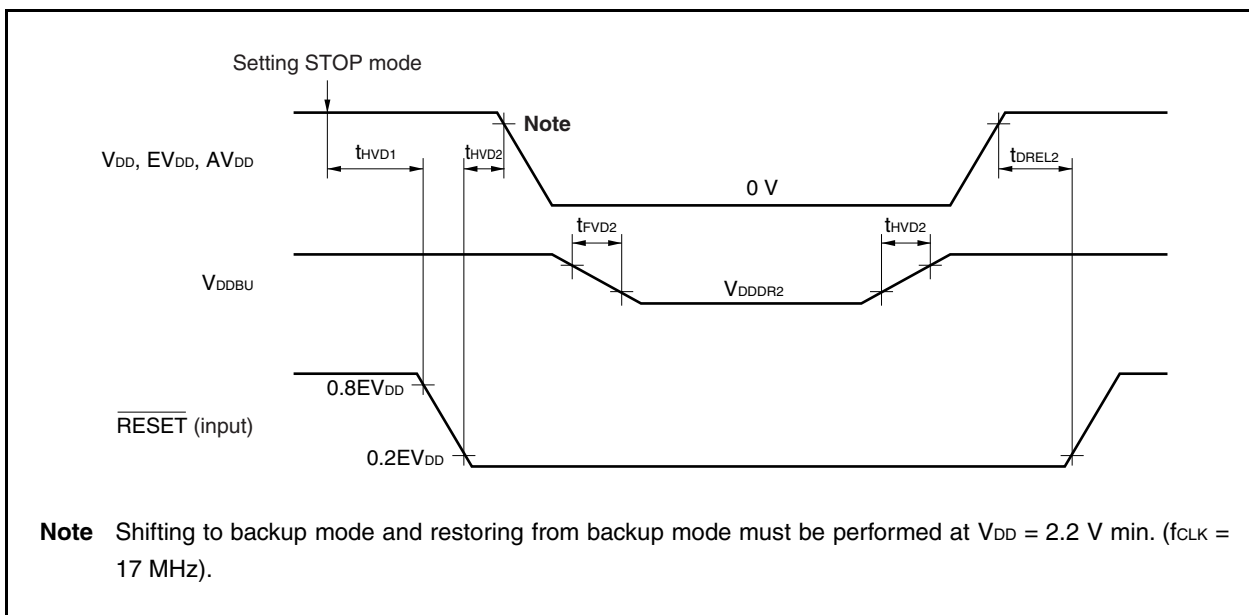
Remark n = 1 to 5



(2) In backup mode ($T_A = -40$ to $+85^\circ\text{C}$, $V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = V_{DD} = AV_{DD} = EV_{DD} = 0\text{ V}$)

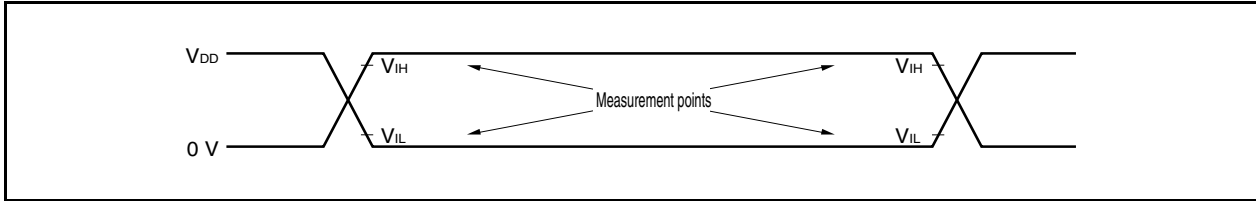
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Data retention voltage	V_{DDDR2}	Backup mode	1.6		2.7	V
Data retention current	I_{DDDR2}	$V_{DDBU} = V_{DDDR2}$		T.B.D.	T.B.D.	μA
Backup supply voltage rise time	t_{RVD2}		T.B.D.			μs
Backup supply voltage fall time	t_{FVD2}		T.B.D.			μs
Mode setting time from $\overline{\text{RESET}}\downarrow$ to $V_{DD}\downarrow$	t_{HVD2}		T.B.D.			ms
Mode release signal input time from $V_{DD}\uparrow$ to $\overline{\text{RESET}}\uparrow$	t_{DREL2}		T.B.D.			ms

Caution Shifting to backup mode and restoring from backup mode must be performed at $V_{DD} = 2.3\text{ V min.}$ ($f_{CLK} = 17\text{ MHz}$) and $V_{DD} = 2.2\text{ V min.}$ ($f_{CLK} = 13.5\text{ MHz}$), respectively.

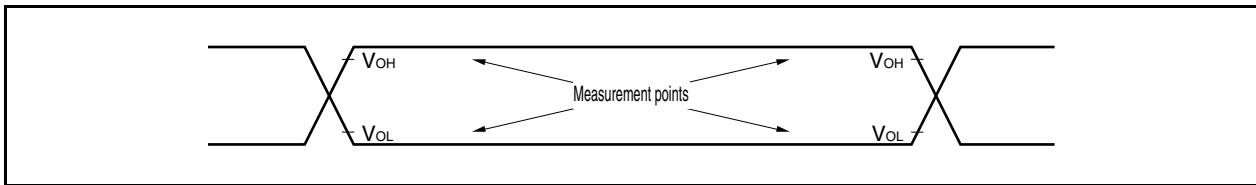


AC characteristics

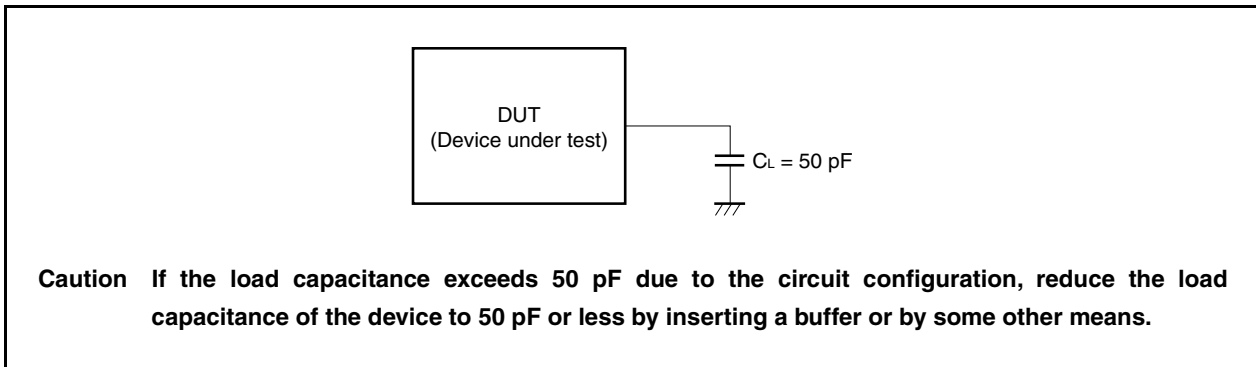
AC test input measurement points (V_{DD} , AV_{DD} , EV_{DD} , V_{DDBU})



AC test output measurement points



Load conditions



Bus timing

(1) Multiplexed bus mode

(a) CLKOUT asynchronous: In multiplexed bus mode

(T_A = -40 to +85°C, V_{DD} = AV_{DD} = EV_{DD} = V_{DDBU} = 2.2 to 2.7 V, V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0 V, C_L = 50 pF)

Parameter	Symbol	Conditions	MIN.	MAX.	Unit
Address setup time (to ASTB↓)	t _{SAST}	<1>	0.5T – 15		ns
Address hold time (from ASTB↓)	t _{HSTA}	<2>	0.5T – 15		ns
Delay time from $\overline{RD}\downarrow$ to address float	t _{FRDA}	<3>		2	ns
Data input setup time from address	t _{SAID}	<4>		(2 + n)T – 25	ns
Data input setup time from $\overline{RD}\downarrow$	t _{SRID}	<5>		(1 + n)T – 25	ns
Delay time from ASTB↓ to $\overline{RD}\downarrow$, $\overline{WRm}\downarrow$	t _{DSTRDWR}	<6>	0.5T – 15		ns
Data input hold time (from $\overline{RD}\uparrow$)	t _{HRDID}	<7>	0		ns
Address output time from $\overline{RD}\uparrow$	t _{DRDA}	<8>	(1 + i)T – 15		ns
Delay time from \overline{RD} , $\overline{WRm}\uparrow$ to ASTB↑	t _{DRDWRST}	<9>	0.5T – 15		ns
Delay time from $\overline{RD}\uparrow$ to ASTB↓	t _{DRDST}	<10>	(1.5 + i)T – 15		ns
\overline{RD} , \overline{WRm} low-level width	t _{WRDWRL}	<11>	(1 + n)T – 15		ns
ASTB high-level width	t _{WSTH}	<12>	T – 15		ns
Data output time from $\overline{WRm}\downarrow$	t _{DWROD}	<13>		15	ns
Data output setup time (to $\overline{WRm}\uparrow$)	t _{SODWR}	<14>	(1 + n)T – 20		ns
Data output hold time (from $\overline{WRm}\uparrow$)	t _{HWROD}	<15>	T – 15		ns
\overline{WAIT} setup time (to address)	t _{SAWT1}	<16> n ≥ 1		1.5T – 25	ns
	t _{SAWT2}	<17> n ≥ 1		(1.5 + n)T – 25	ns
\overline{WAIT} hold time (from address)	t _{HAWT1}	<18> n ≥ 1	(0.5 + n)T		ns
	t _{HAWT2}	<19> n ≥ 1	(1.5 + n)T		ns
\overline{WAIT} setup time (to ASTB↓)	t _{SSTWT1}	<20> n ≥ 1		T – 25	ns
	t _{SSTWT2}	<21> n ≥ 1		(1 + n)T – 25	ns
\overline{WAIT} hold time (from ASTB↓)	t _{HSTWT1}	<22> n ≥ 1	nT		ns
	t _{HSTWT2}	<23> n ≥ 1	(1 + n)T		ns
HLD \overline{RQ} high-level width	t _{WHQH}	<24>	T + 10		ns
HLD \overline{AK} low-level width	t _{WHAL}	<25>	T – 15		ns
Delay time from HLD $\overline{AK}\uparrow$ to bus output	t _{DHAC}	<26>	-3		ns
Delay time from HLD $\overline{RQ}\downarrow$ to HLD $\overline{AK}\downarrow$	t _{DHQHA1}	<27>	1.5T	(2n + 7.5)T + 25	ns
Delay time from HLD $\overline{RQ}\uparrow$ to HLD $\overline{AK}\uparrow$	t _{DHQHA2}	<28>	0.5T	1.5T + 25	ns

Remarks 1. T = 1/f_{CPU} (f_{CPU}: CPU operation clock frequency)**2.** n: Number of wait clocks inserted in the bus cycle.

The sampling timing changes when a programmable wait is inserted.

3. m = 0, 1**4.** i: Number of idle states inserted after the read cycle (0 or 1).**5.** The values in the above specifications are values for when clocks with a 1:1 duty ratio are input from X1.

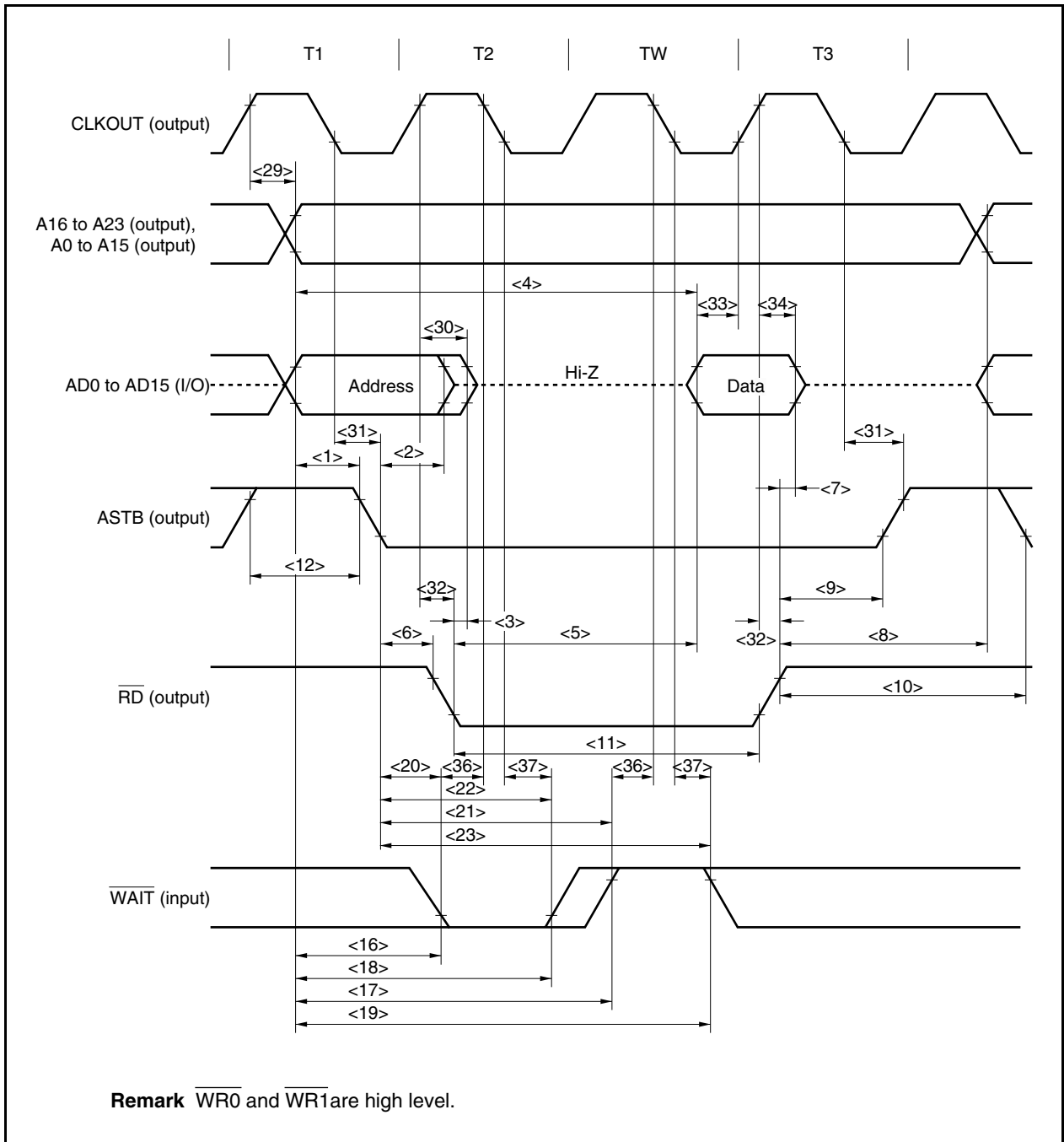
(b) CLKOUT synchronous: In multiplexed bus mode**($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = EV_{DD} = V_{DDBU} = 2.2$ to 2.7 V, $V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0$ V, $C_L = 50$ pF)**

Parameter	Symbol	Conditions	MIN.	MAX.	Unit
Delay time from CLKOUT \uparrow to address	t_{DKA}	<29>	0	19	ns
Delay time from CLKOUT \uparrow to address float	t_{FKA}	<30>	-12	7	ns
Delay time from CLKOUT \downarrow to ASTB	t_{DKST}	<31>	-12	7	ns
Delay time from CLKOUT \uparrow to \overline{RD} , \overline{WR}_m	t_{DKRDWR}	<32>	-5	14	ns
Data input setup time (to CLKOUT \uparrow)	t_{SIDK}	<33>	15		ns
Data input hold time (from CLKOUT \uparrow)	t_{HKID}	<34>	5		ns
Data output delay time from CLKOUT \uparrow	t_{DKOD}	<35>		19	ns
\overline{WAIT} setup time (to CLKOUT \downarrow)	t_{SWTK}	<36>	15		ns
\overline{WAIT} hold time (from CLKOUT \downarrow)	t_{HKWT}	<37>	5		ns
\overline{HLDRQ} setup time (to CLKOUT \downarrow)	t_{SHQK}	<38>	15		ns
\overline{HLDRQ} hold time (from CLKOUT \downarrow)	t_{HKHQ}	<39>	5		ns
Delay time from CLKOUT \uparrow to bus float	t_{DKF}	<40>		19	ns
Delay time from CLKOUT \uparrow to \overline{HLDAK}	t_{DKHA}	<41>		19	ns

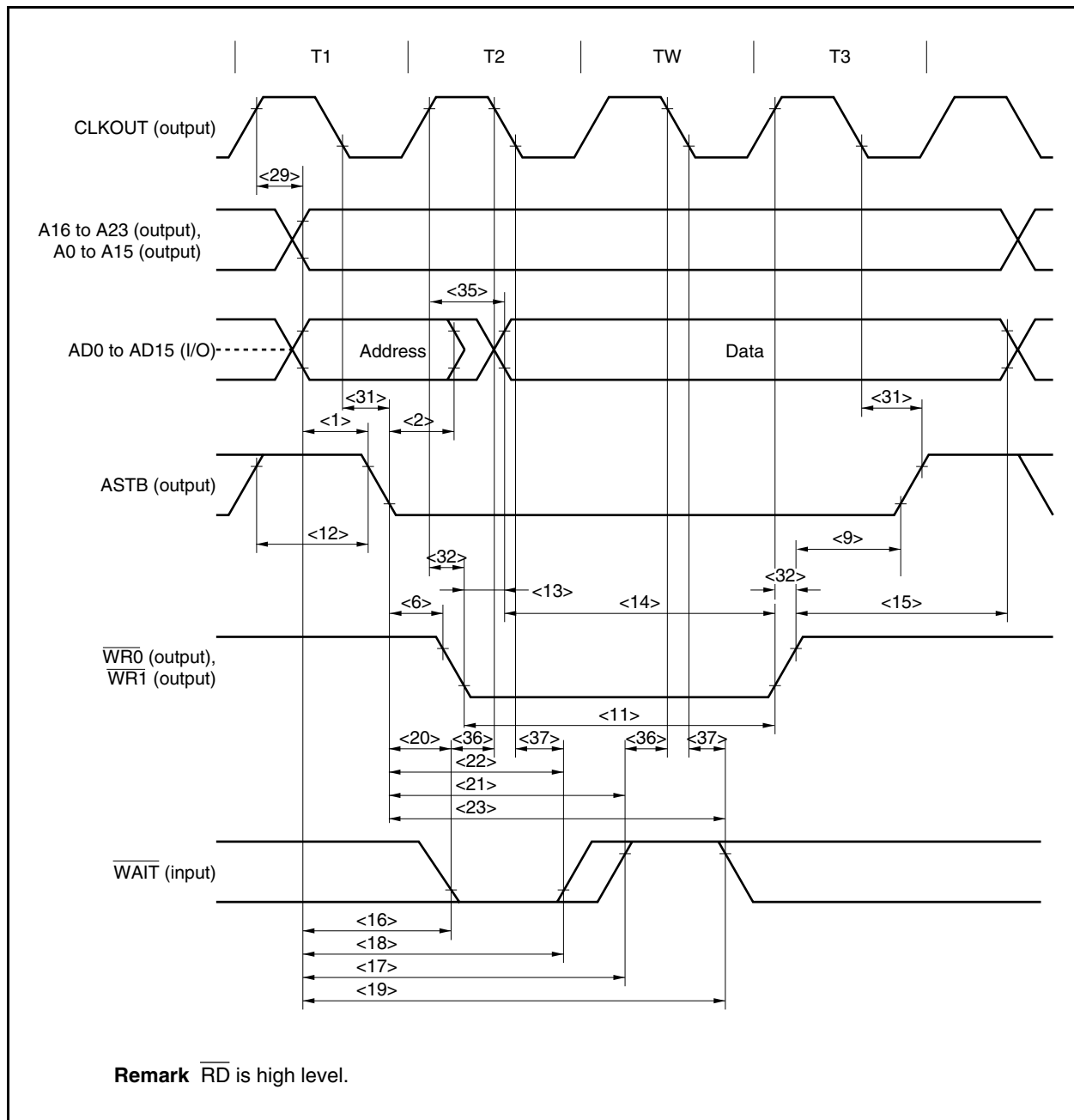
Remarks 1. $m = 0, 1$

- The values in the above specifications are values for when clocks with a 1:1 duty ratio are input from X1.

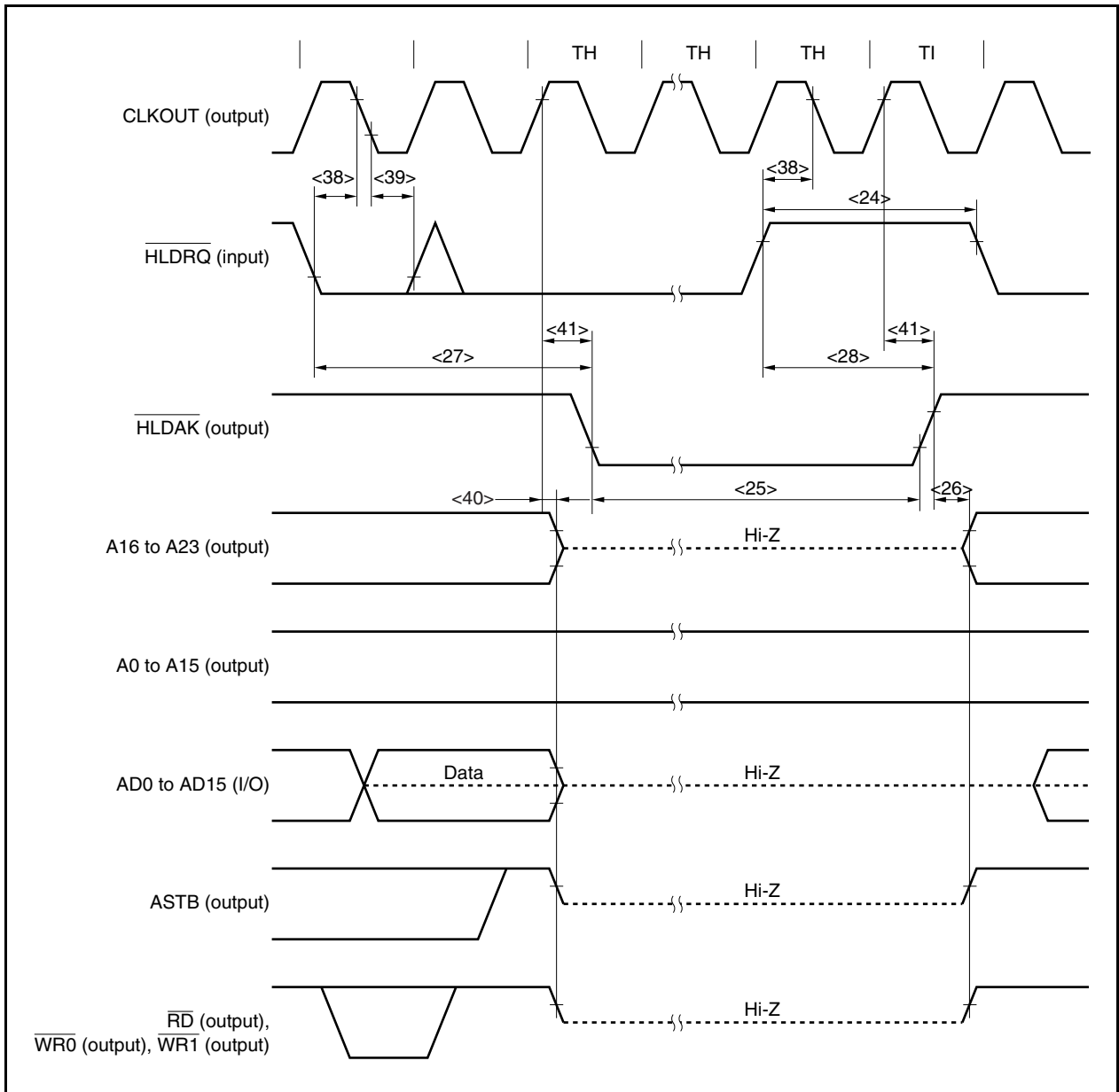
Read cycle (CLKOUT synchronous/asynchronous, 1 wait): In multiplexed bus mode



Write cycle (CLKOUT synchronous/asynchronous, 1 wait): In multiplexed bus mode



Bus hold: In multiplexed bus mode



(2) In separate bus mode
(a) Read cycle (CLKOUT asynchronous): In separate bus mode
($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = EV_{DD} = V_{DDBU} = 2.2$ to 2.7 V, $V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0$ V, $C_L = 50$ pF)

Parameter	Symbol		Conditions	MIN.	MAX.	Unit
Address setup time (to $\overline{RD}\downarrow$)	t_{SARD}	<42>		$0.5T - 15$		ns
Address hold time (from $\overline{RD}\uparrow$)	t_{HARD}	<43>		T.B.D.		ns
\overline{RD} low-level width	t_{WRDL}	<44>		$(1.5 + n) T - 10$		ns
Data setup time (to $\overline{RD}\uparrow$)	t_{SISD}	<45>		20		ns
Data hold time (from $\overline{RD}\uparrow$)	t_{HISD}	<46>		0		ns
Data setup time (to address)	t_{SAID}	<47>			T.B.D.	ns
\overline{WAIT} setup time (to $\overline{RD}\downarrow$)	t_{SRDWT1}	<48>			T.B.D.	ns
	t_{SRDWT2}	<49>			T.B.D.	ns
\overline{WAIT} hold time (from $\overline{RD}\downarrow$)	t_{HRDWT1}	<50>		$0.5T$		ns
	t_{HRDWT2}	<51>		$(0.5 + n) T$		ns
\overline{WAIT} setup time (to address)	t_{SAWT1}	<52>			T.B.D.	ns
	t_{SAWT2}	<53>			$(1 + n) T - 20$	ns
\overline{WAIT} hold time (from address)	t_{HAWT1}	<54>		T		ns
	t_{HAWT2}	<55>		$(1 + n) T$		ns

Remarks 1. $T = 1/f_{CPU}$ (f_{CPU} : CPU operation clock frequency)

2. n : Number of wait clocks inserted in bus cycle

The sampling timing changes when a programmable wait is inserted.

3. The values in the above specifications are the values for when clocks with a 1:1 duty ratio are input from X1.

(b) Read cycle (CLKOUT synchronous): In separate bus mode
($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = EV_{DD} = V_{DDBU} = 2.2$ to 2.7 V, $V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0$ V, $C_L = 50$ pF)

Parameter	Symbol		Conditions	MIN.	MAX.	Unit
Delay time from $\text{CLKOUT}\uparrow$ to address, CS	t_{DKSA}	<56>		0	19	ns
Data input setup time (to $\text{CLKOUT}\uparrow$)	t_{SISDK}	<57>		15		ns
Data input hold time (from $\text{CLKOUT}\uparrow$)	t_{HKISD}	<58>		5		ns
Delay time from $\text{CLKOUT}\downarrow$ to \overline{RD}	t_{DKSR}	<59>		0	19	ns
\overline{WAIT} setup time (to $\text{CLKOUT}\uparrow$)	t_{SWTK}	<60>		15		ns
\overline{WAIT} hold time (from $\text{CLKOUT}\uparrow$)	t_{HKWT}	<61>		5		ns

Remark The values in the above specifications are the values for when clocks with a 1:1 duty ratio are input from X1.

(c) Write cycle (CLKOUT asynchronous): In separate bus mode
($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = EV_{DD} = V_{DDBU} = 2.2$ to 2.7 V, $V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0$ V, $C_L = 50$ pF)

Parameter	Symbol		Conditions	MIN.	MAX.	Unit
Address setup time (to $\overline{WRm}\downarrow$)	t_{SAW}	<62>		$T - 15$		ns
Address hold time (from $\overline{WRm}\uparrow$)	t_{HAW}	<63>		$0.5T - 10$		ns
\overline{WRm} low-level width	t_{WWRL}	<64>		$(0.5 + n)T - 10$		ns
Data output time from $\overline{WRm}\downarrow$	t_{DOSDW}	<65>		-5		ns
Data setup time (to $\overline{WRm}\uparrow$)	t_{SOSDW}	<66>		T.B.D.		ns
Data hold time (from $\overline{WRm}\uparrow$)	t_{HOSDW}	<67>		$0.5T - 10$		ns
Data setup time (to address)	t_{SAOD}	<68>		$T - 25$		ns
\overline{WAIT} setup time (to $\overline{WRm}\downarrow$)	t_{SWRWT1}	<69>		20		ns
	t_{SWRWT2}	<70>		$nT - 20$		ns
\overline{WAIT} hold time (from $\overline{WRm}\downarrow$)	t_{HWRWT1}	<71>		0		ns
	t_{HWRWT2}	<72>		nT		ns
\overline{WAIT} setup time (to address)	t_{SAWT1}	<73>			$T - 20$	ns
	t_{SAWT2}	<74>			$(1 + n)T - 20$	ns
\overline{WAIT} hold time (from address)	t_{HAWT1}	<75>		T		ns
	t_{HAWT2}	<76>		$(1 + n)T$		ns

Remarks 1. $m = 0, 1$
2. $T = 1/f_{CPU}$ (f_{CPU} : CPU operation clock frequency)

3. n : Number of wait clocks inserted in bus cycle

The sampling timing changes when a programmable wait is inserted.

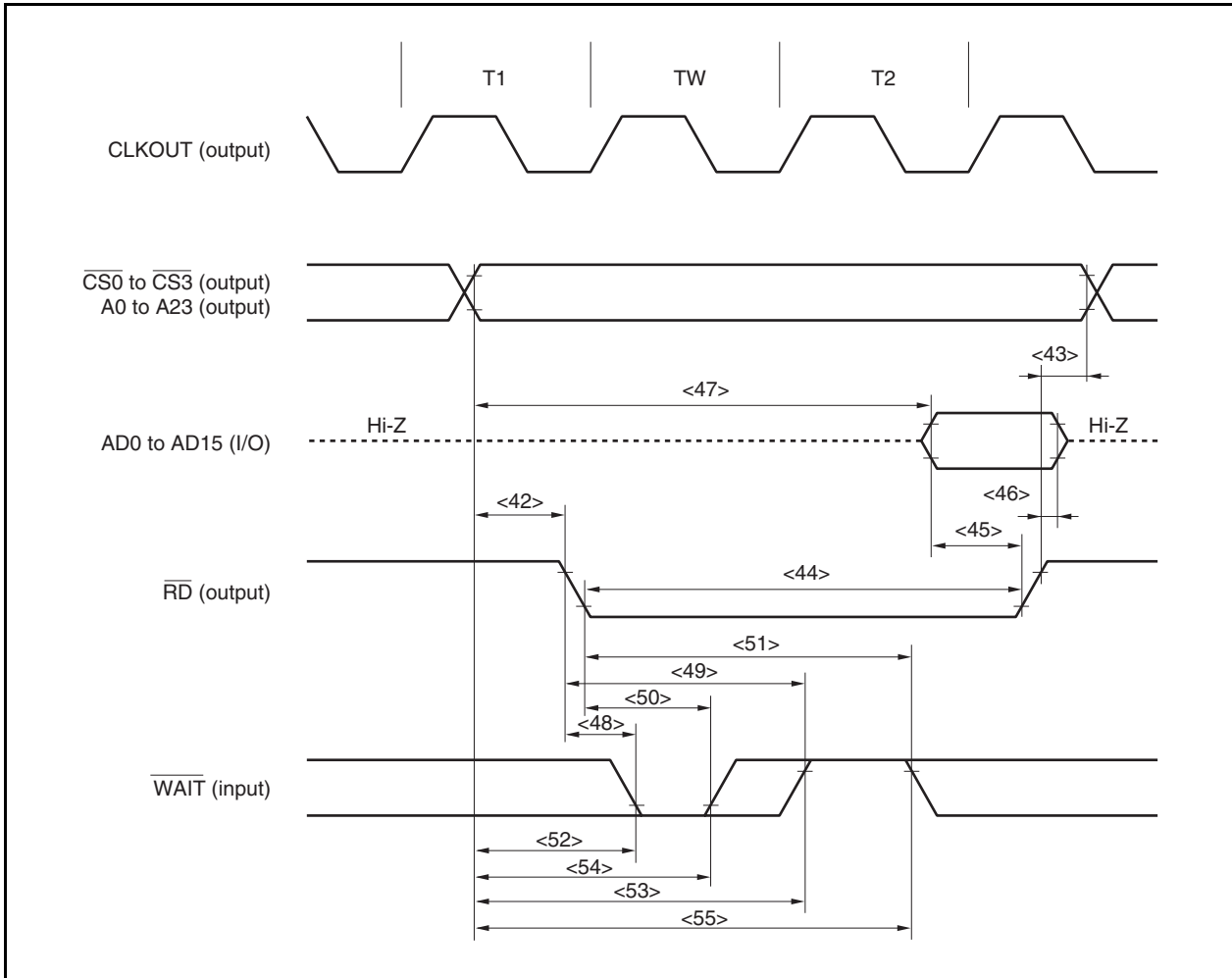
4. The values in the above specifications are the values for when clocks with a 1:1 duty ratio are input from X1.

(d) Write cycle (CLKOUT synchronous): In separate bus mode
($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = EV_{DD} = V_{DDBU} = 2.2$ to 2.7 V, $V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0$ V, $C_L = 50$ pF)

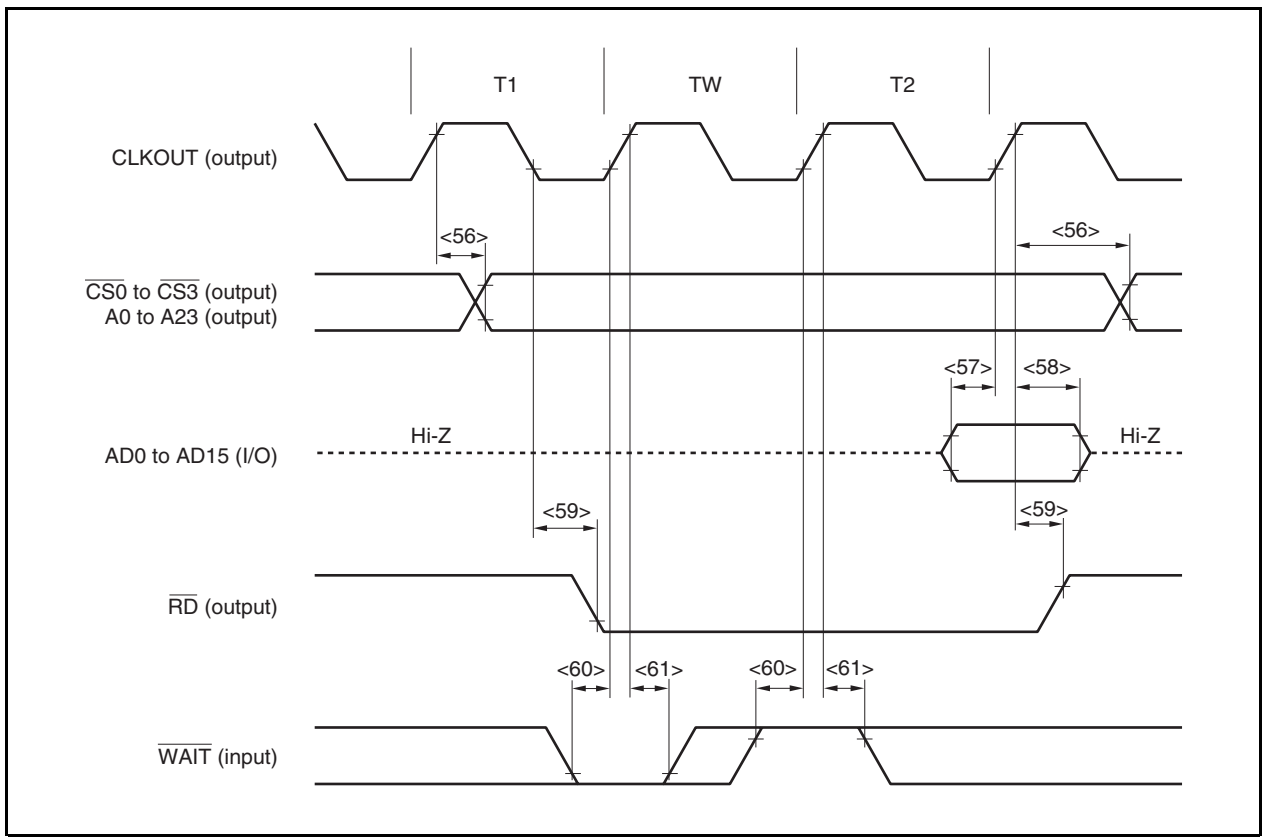
Parameter	Symbol		Conditions	MIN.	MAX.	Unit
Delay time from $\text{CLKOUT}\uparrow$ to address, CS	t_{DKSA}	<77>		0	19	ns
Delay time from $\text{CLKOUT}\uparrow$ to data output	t_{DKSD}	<78>		0	19	ns
Delay time from $\text{CLKOUT}\uparrow\downarrow$ to \overline{WRm}	t_{DKSW}	<79>		0	19	ns
\overline{WAIT} setup time (to $\text{CLKOUT}\uparrow$)	t_{SWTK}	<90>		15		ns
\overline{WAIT} hold time (from $\text{CLKOUT}\uparrow$)	t_{HKWT}	<81>		5		ns

Remarks 1. $m = 0, 1$
2. The values in the above specifications are the values for when clocks with a 1:1 duty ratio are input from X1.

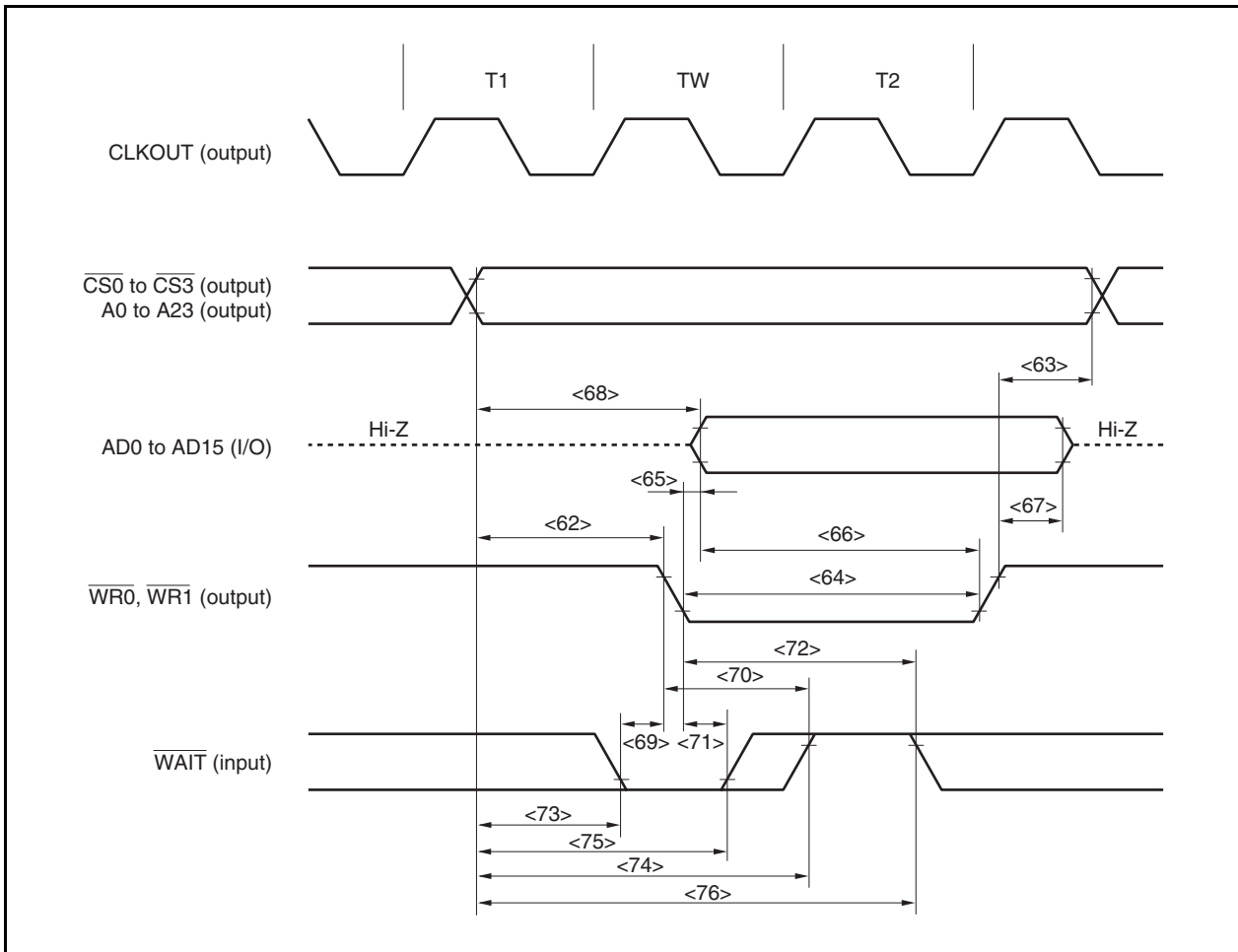
Read cycle (CLKOUT asynchronous, 1 wait): In separate bus mode



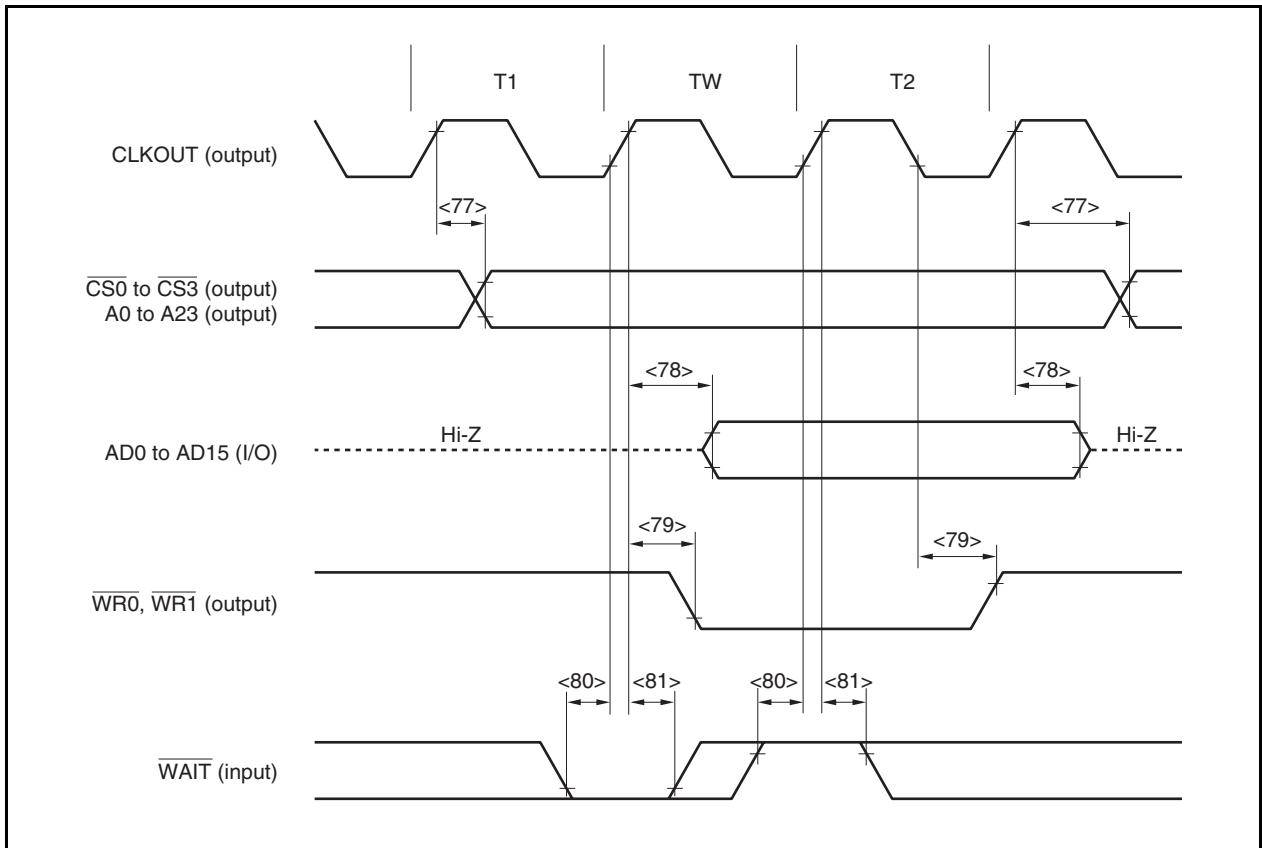
Read cycle (CLKOUT synchronous, 1 wait): In separate bus mode



Write cycle (CLKOUT asynchronous, 1 wait): In separate bus mode



Write cycle (CLKOUT synchronous, 1 wait): In separate bus mode



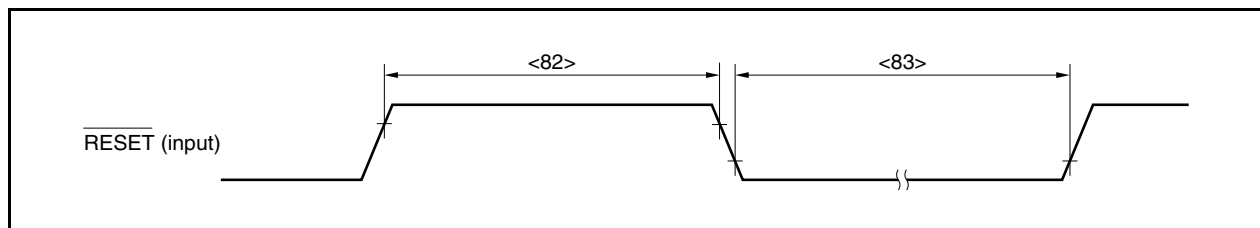
Reset/interrupt timing

($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = EV_{DD} = V_{DDBU} = 2.2$ to 2.7 V, $V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0$ V, $C_L = 50$ pF)

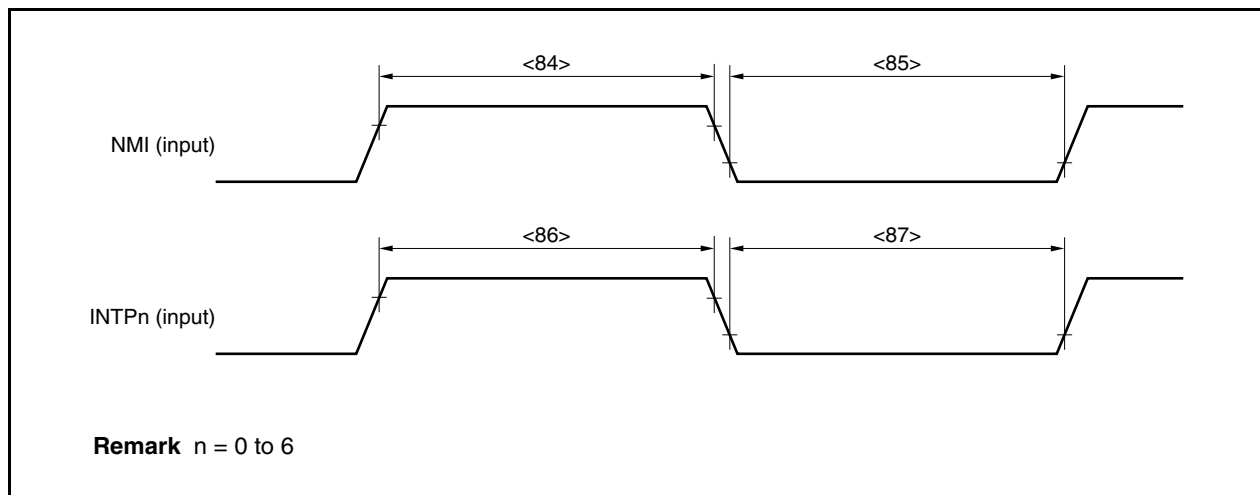
Parameter	Symbol	Conditions	MIN.	MAX.	Unit
$\overline{\text{RESET}}$ high-level width	t_{WRSH}	<82>	500		ns
$\overline{\text{RESET}}$ low-level width	t_{WRSL}	<83>	500		ns
NMI high-level width	t_{WNIH}	<84>	500		ns
NMI low-level width	t_{WNIL}	<85>	500		ns
INTPn high-level width	t_{WITH}	<86>	500		ns
INTPn low-level width	t_{WITL}	<87>	500		ns

Remark $T = 1/f_{xx}$

Reset



Interrupt



Remark $n = 0$ to 6

Timer timing

($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = EV_{DD} = VDDBU = 2.2$ to 2.7 V, $V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0$ V, $C_L = 50$ pF)

Parameter	Symbol	Conditions	MIN.	MAX.	Unit
TIn high-level width		n = 0, 1	2T + 20		ns
		n = 2 to 5	40		ns
TIn low-level width		n = 0, 1	2T + 20		ns
		n = 2 to 5	40		ns
TCLRn high-level width		n = 0, 1	2T + 20		ns
TCLRn low-level width		n = 0, 1	2T + 20		ns
INTPnm high-level width	t _{WITH}	nm = 00, 01, 10, 11	2T + 20		ns
INTPnm low-level width	t _{WITL}	nm = 00, 01, 10, 11	2T + 20		ns

Remark T = 1/f_{xx}

CSI timing

(1) Master mode

($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = EV_{DD} = V_{DDBU} = 2.2$ to 2.7 V, $V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0$ V, $C_L = 50$ pF)

Parameter	Symbol	Conditions	MIN.	MAX.	Unit
$\overline{\text{SCKn}}$ cycle time	t_{KCY1}	<88>	200		ns
$\overline{\text{SCKn}}$ high-/low-level width	t_{KH1} , t_{KL1}	<89>	$t_{\text{KCY1}}/2 - 10$		ns
SIn setup time (to $\overline{\text{SCKn}}\uparrow$)	t_{SIK1}	<90>	30		ns
SIn hold time (from $\overline{\text{SCKn}}\uparrow$)	t_{KSI1}	<91>	30		ns
Delay time from $\overline{\text{SCKn}}\downarrow$ to SOn output	t_{KSO1}	<92>		30	ns

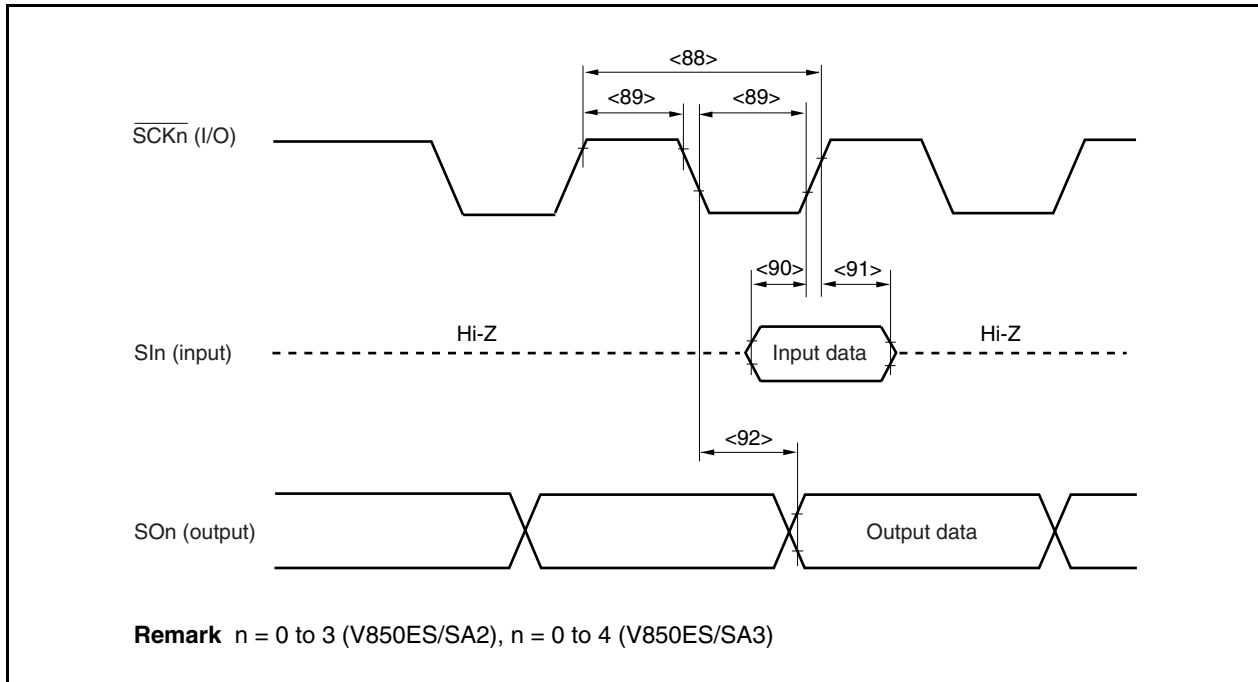
Remark n = 0 to 3 (V850ES/SA2), n = 0 to 4 (V850ES/SA3)

(2) Slave mode

($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = EV_{DD} = V_{DDBU} = 2.2$ to 2.7 V, $V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0$ V, $C_L = 50$ pF)

Parameter	Symbol	Conditions	MIN.	MAX.	Unit
$\overline{\text{SCKn}}$ cycle time	t_{KCY2}	<88>	200		ns
$\overline{\text{SCKn}}$ high-/low-level width	t_{KH2} , t_{KL2}	<89>	90		ns
SIn setup time (to $\overline{\text{SCKn}}\uparrow$)	t_{SIK2}	<90>	50		ns
SIn hold time (from $\overline{\text{SCKn}}\uparrow$)	t_{KSI2}	<91>	50		ns
Delay time from $\overline{\text{SCKn}}\downarrow$ to SOn output	t_{KSO2}	<92>		50	ns

Remark n = 0 to 3 (V850ES/SA2), n = 0 to 4 (V850ES/SA3)



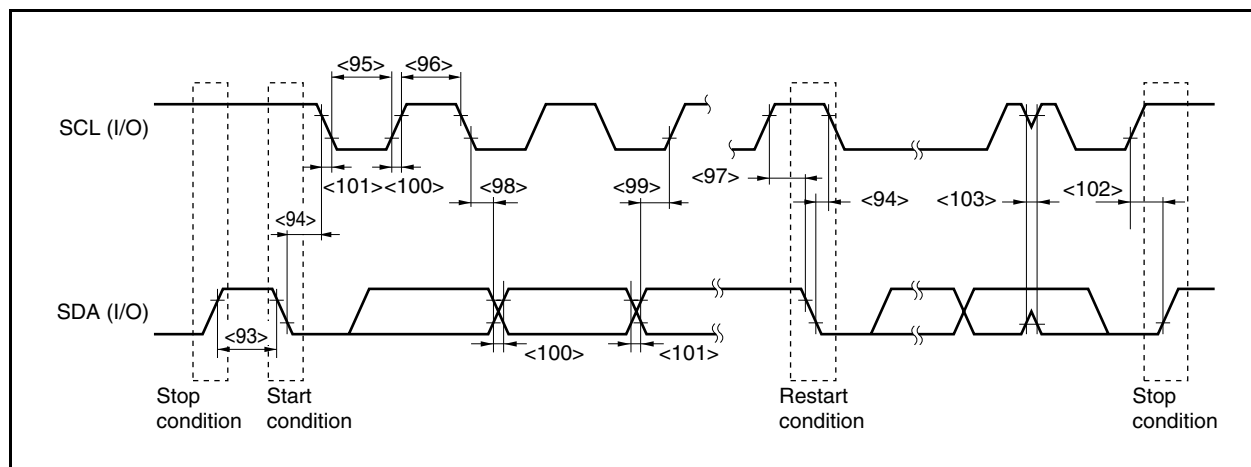
Remark n = 0 to 3 (V850ES/SA2), n = 0 to 4 (V850ES/SA3)

I²C bus mode (μPD703201Y, 703204Y, 70F3201Y, 70F3204Y only)(T_A = –40 to +85°C, V_{DD} = AV_{DD} = EV_{DD} = V_{DDBU} = 2.2 to 2.7 V, V_{SS} = AV_{SS} = EV_{SS} = V_{SSBU} = 0 V)

Parameter		Symbol		Normal Mode		High-Speed Mode		Unit
				MIN.	MAX.	MIN.	MAX.	
SCL clock frequency		f _{CLK}		0	100	0	400	kHz
Bus-free time (between stop/start conditions)		t _{BUF}	<93>	4.7	–	1.3	–	μs
Hold time ^{Note 1}		t _{HD:STA}	<94>	4.0	–	0.6	–	μs
SCL clock low-level width		t _{LOW}	<95>	4.7	–	1.3	–	μs
SCL clock high-level width		t _{HIGH}	<96>	4.0	–	0.6	–	μs
Setup time for start/restart conditions		t _{SU:STA}	<97>	4.7	–	0.6	–	μs
Data hold time	CBUS compatible master	t _{HD:DAT}	<98>	5.0	–	–	–	μs
	I ² C mode			0 ^{Note 2}	–	0 ^{Note 2}	0.9 ^{Note 3}	μs
Data setup time		t _{SU:DAT}	<99>	250	–	100 ^{Note 4}	–	ns
SDA and SCL signal rise time		t _R	<100>	–	1,000	20 + 0.1Cb ^{Note 5}	300	ns
SDA and SCL signal fall time		t _F	<101>	–	300	20 + 0.1Cb ^{Note 5}	300	ns
Stop condition setup time		t _{SU:STO}	<102>	4.0	–	0.6	–	μs
Pulse width with spike suppressed by input filter		t _{SP}	<103>	–	–	0	50	ns
Capacitance load of each bus line		Cb		–	400	–	400	pF

Notes 1. At the start condition, the first clock pulse is generated after the hold time.

- 2.** The system requires a minimum of 300 ns hold time internally for the SDA signal (at V_{IHmin.} of SCL signal) in order to occupy the undefined area at the falling edge of SCL.
- 3.** If the system does not extend the SCL signal low hold time (t_{LOW}), only the maximum data hold time (t_{HD:DAT}) needs to be satisfied.
- 4.** The high-speed-mode I²C bus can be used in a normal-mode I²C bus system. In this case, set the high-speed-mode I²C bus so that it meets the following conditions.
 - If the system does not extend the SCL signal's low state hold time:
t_{SU:DAT} ≥ 250 ns
 - If the system extends the SCL signal's low state hold time:
Transmit the next data bit to the SDA line prior to releasing the SCL line (t_{Rmax.} + t_{SU:DAT} = 1,000 + 250 = 1,250 ns: Normal mode I²C bus specification).
- 5.** Cb: Total capacitance of one bus line (unit: pF)

I²C bus mode (μ PD703201Y, 703204Y, 70F3201Y, 70F3204Y only)

A/D converter

 ($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = AV_{REF0} = 2.2$ to 2.7 V, $AV_{SS} = V_{SS} = 0$ V, $C_L = 50$ pF)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Resolution			10	10	10	bit
Overall error ^{Note 1}					T.B.D.	%FSR
Conversion time	t_{CONV}		T.B.D.		T.B.D.	μs
Zero-scale error ^{Note 1}					T.B.D.	%FSR
Full-scale error ^{Note 1}					T.B.D.	%FSR
Integral linearity error ^{Note 2}					T.B.D.	LSB
Differential linearity error ^{Note 2}					T.B.D.	LSB
Analog reference voltage	AV_{REF}	$AV_{REF0} = AV_{DD}$	2.2		2.7	V
Analog input voltage	V_{IAN}		AV_{SS}		AV_{REF}	V
AV_{REF0} current	AI_{REF0}			T.B.D.		μA
AV_{DD} power supply current	AI_{DD}			T.B.D.		mA

Notes 1. Excluding quantization error (± 0.05 %FSR)

2. Excluding quantization error (± 0.5 LSB)

Remark LSB: Least significant bit

FSR: Full-scale range

D/A converter**($T_A = -40$ to $+85^\circ\text{C}$, $V_{DD} = AV_{DD} = AV_{REF1} = 2.2$ to 2.7 V, $AV_{SS} = V_{SS} = 0$ V, $C_L = 50$ pF)**

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Resolution			8	8	8	bit
Overall error ^{Note}		Load conditions: 2 M Ω , 30 pF $AV_{REF1} = V_{DD}$			T.B.D.	%FSR
Settling time					T.B.D.	μs
Output resistance				T.B.D.		k Ω
Analog reference voltage	AV_{REF}	$AV_{REF1} = V_{DD}$	2.2		2.7	V
AV_{REF1} current	AV_{REF1}	Per channel		T.B.D.		mA

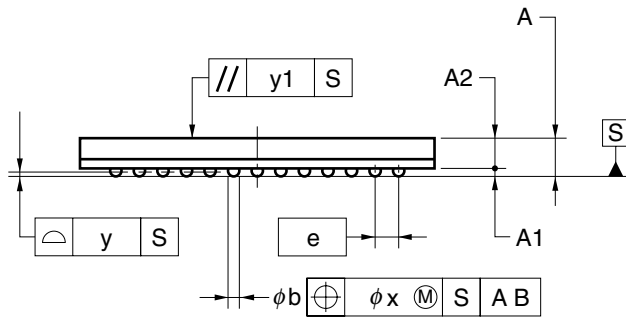
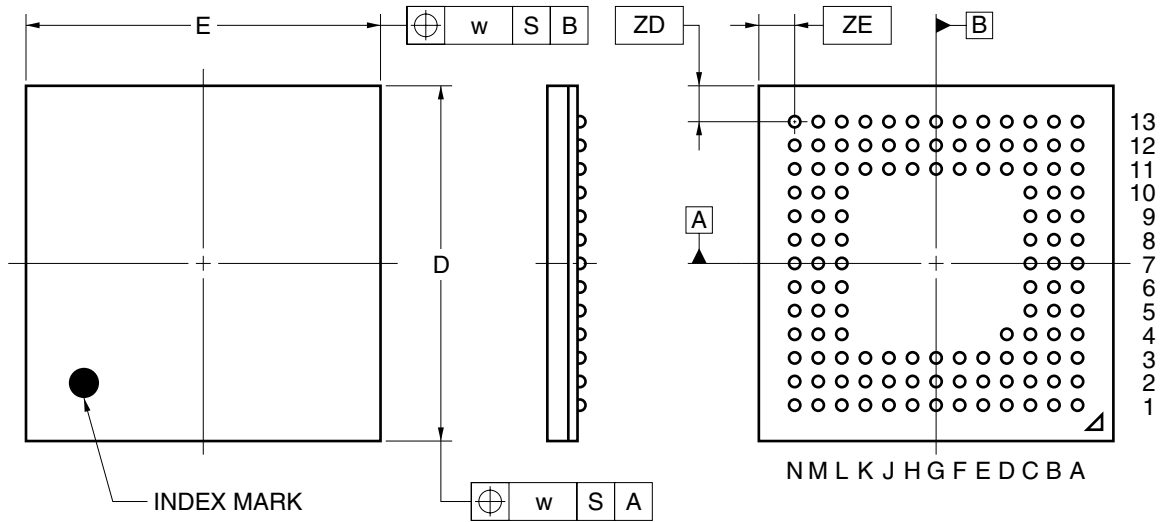
Note Excludes quantization error ($\pm 0.05\%$ FSR).

CHAPTER 20 PACKAGE DRAWINGS

100-PIN PLASTIC LQFP (FINE PITCH) (14x14)

Package drawing not available (resin thickness: 1.0 mm, 0.5-mm pitch)

121-PIN PLASTIC FBGA (12x12)



ITEM	MILLIMETERS
D	12.00±0.10
E	12.00±0.10
w	0.20
A	1.48±0.10
A1	0.35±0.06
A2	1.13
e	0.80
b	0.50 ^{+0.05} _{-0.10}
x	0.08
y	0.10
y1	0.20
ZD	1.20
ZE	1.20

P121F1-80-EA6

[MEMO]

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